PHILIPS

Data handbook

Electronic components and materials

Components and materials

Part 1 June 1977

Functional units

PLC modules

Input/output devices

Hybrid circuits

Peripheral devices

Ferrite core memory products

COMPONENTS AND MATERIALS

Part 1 June 1977

DATA HANDBOOK SYSTEM

Our Data Handbook System is a comprehensive source of information on electronic components, subassemblies and materials; it is made up of three series of handbooks each comprising several parts.

ELECTRON TUBES	**BLUE**
SEMICONDUCTORS AND INTEGRATED CIRCUITS	**RED**
COMPONENTS AND MATERIALS	**GREEN**

The several parts contain all pertinent data available at the time of publication, and each is revised and reissued periodically.

Where ratings or specifications differ from those published in the preceding edition they are pointed out by arrows. Where application information is given it is advisory and does not form part of the product specification.

If you need confirmation that the published data about any of our products are the latest available, please contact our representative. He is at your service and will be glad to answer your inquiries.

December 1972

ELECTRON TUBES (BLUE SERIES)

This series consists of the following parts, issued on the dates indicated.

Part 1a	**Transmitting tubes for communication** **Tubes for r.f. heating** Types PE05/25 – TBW15/25		December 1975
Part 1b	**Transmitting tubes for communication** **Tubes for r.f. heating** **Amplifier circuit assemblies**		January 1976
Part 2	**Microwave products**		May 1976
	Communication magnetrons Magnetrons for microwave heating Klystrons Travelling-wave tubes Isolators, Circulators	Diodes Triodes T-R switches Microwave semiconductor devices	
Part 3	**Special Quality tubes** **Miscellaneous devices**		January 1975
Part 4	**Receiving tubes**		March 1975
Part 5a	**Cathode-ray tubes**		August 1976
Part 5b	**Camera tubes** **Image intensifier tubes**		May 1975
Part 6	**Products for nuclear technology**		January 1977
	Channel electron multipliers Neutron tubes	Geiger-Müller tubes	
Part 7a	**Gas-filled tubes**		March 1977
	Thyratrons Industrial rectifying tubes	Ignitrons High-voltage rectifying tubes	
Part 7b	**Gas-filled tubes**		March 1977
	Segment indicator tubes Indicator tubes	Switching diodes Dry reed contact units	
Part 8	**TV picture tubes**		May 1977
Part 9	**Photomultiplier tubes** **Phototubes (diodes)**		June 1976

SEMICONDUCTORS AND INTEGRATED CIRCUITS (RED SERIES)

This series consists of the following parts, issued on the dates indicated.

Part 1a **Rectifier diodes, thyristors, triacs** — **March 1976**

Rectifier diodes
Voltage regulator diodes (> 1,5 W)
Transient suppressor diodes
Rectifier stacks
Thyristors
Triacs

Part 1b **Diodes** — **May 1977**

Small signal germanium diodes
Small signal silicon diodes
Special diodes
Voltage regulator diodes (< 1,5 W)
Voltage reference diodes
Tuner diodes

Part 2 **Low-frequency transistors** — **December 1975**

Part 3 **High-frequency and switching transistors** — **April 1976**

Part 4a **Special semiconductors** — **June 1976**

Transmitting transistors
Microwave devices
Field-effect transistors
Dual transistors
Microminiature devices for thick- and thin-film circuits

Part 4b **Devices for optoelectronics** — **July 1976**

Photosensitive diodes and transistors
Light emitting diodes
Displays
Photocouplers
Infrared sensitive devices
Photoconductive devices

Part 5a **Professional analogue integrated circuits** — **November 1976**

Part 5b **Consumer integrated circuits** — **March 1977**

Radio - Audio
Television

Part 6 **Digital integrated circuits** — **May 1976**

LOCMOS HE family
GZ family

COMPONENTS AND MATERIALS (GREEN SERIES)

This series consists of the following parts, issued on the dates indicated.

Part 1 **Assemblies for industrial use** — June 1977

- High noise immunity logic FZ/30-Series
- Counter modules 50-Series
- NORbits 60-Series, 61-Series
- Circuit blocks 90-Series
- Circuit block CSA70 (L)
- PLC modules
- Input/output devices
- Hybrid circuits
- Peripheral devices
- Ferrite core memory products

Part 2a **Resistors** — February 1976

- Fixed resistors
- Variable resistors
- Voltage dependent resistors (VDR)
- Light dependent resistors (LDR)
- Negative temperature coefficient thermistors (NTC)
- Positive temperature coefficient thermistors (PTC)
- Test switches

Part 2b **Capacitors** — April 1976

- Electrolytic and solid capacitors
- Paper capacitors and film capacitors
- Ceramic capacitors
- Variable capacitors

Part 3 **Radio, Audio, Television** — January 1977

- FM tuners
- Loudspeakers
- Television tuners and aerial input assemblies
- Components for black and white television
- Components for colour television

Part 4a **Soft ferrites** — October 1976

- Ferrites for radio, audio and television
- Beads and chokes
- Ferroxcube potcores and square cores
- Ferroxcube transformer cores

Part 4b **Piezoelectric ceramics, Permanent magnet materials** — December 1976

Part 5 **Ferrite core memory products** — July 1975

- Ferroxcube memory cores
- Matrix planes and stacks
- Core memory systems

Part 6 **Electric motors and accessories** — April 1977

- Small synchronous motors
- Stepper motors
- Miniature direct current motors

Part 7 **Circuit blocks** — September 1971

- Circuit blocks 100 kHz-Series
- Circuit blocks 1-Series
- Circuit blocks 10-Series
- Circuit blocks for ferrite core memory drive

Part 8 **Variable mains transformers** — February 1977

Part 9 **Piezoelectric quartz devices** — March 1976

Part 10 **Connectors** — November 1975

HNIL FZ/30-Series

High noise immunity logic

HIGH NOISE IMMUNITY LOGIC

INTRODUCTION

In noisy environments - in data handling and processing, in industrial control, in computer peripherals - you need High Noise Immunity Logic. You need the FZ/30-Series. It gives you a comprehensive range of logic elements - plus such indispensable ancillaries as timers, power amplifiers, lamp or relay drive modules, and interface modules. And they have one outstanding advantage, by adding a capacitor you can slow-down the system response and raise the a.c. noise threshold to meet your needs.

The modules are small, over a hundred would fit on this page, and have an operating temperature range up to 70 °C. Wide voltage tolerances make these circuits first choice for a host of industrial and professional applications. And they're easy to use - a simple loading table tells you what each unit can drive, and what's needed to drive it. And we supply a full set of bits to go round them - input/output devices - printed-wiring boards - connectors - sticker symbols - name it - its in the FZ/30-Series range of auxiliaries.

Check with us for full details of the FZ/30-Series. You get fast, reliable deliveries, attractive quotations, and an applications service that is second to none.

SURVEY OF TYPES

type	description	catalogue number
FZH101/4.NAND32	Quad 2-input NAND gate	2722 006 01081
FZH111/4.NAND30	Quad 2-input NAND gate Two gates can be slowed down	2722 006 01001
FZH121/2.NAND30	Dual 5-input NAND gate	2722 006 01061
FZH131/2.NAND31	Dual 5-input NAND gate Both gates can be slowed down	2722 006 01011
FZH141/2.NAND32	Dual 5-input power NAND gate Both gates can be slowed down	2722 006 01021
FZH151/2.AOR30	Dual 5-input AND-AND-OR gate One gate can be slowed down	2722 006 02001
FZH161/4.LI31	Quad logic interface gate HNIL to 5 V logic; all gates can be slowed down	2722 006 04011
FZH171/2.NAND33	Dual 4-input NAND gate With expandable inputs; both gates can be slowed down	2722 006 01091

SURVEY OF TYPES (continued)

type	description	catalogue number
FZH181/4.LI30	Quad logic interface gate 5 V logic to HNIL	2722 006 04001
FZH191/3.NAND33	Triple 3-input NAND gate Two gates can be slowed down	2722 006 01031
FZH201/6.IN30	Sextuple inverter with strobe input	2722 006 07001
FZH211/4.NAND34	Quad 2-input NAND gate Two gates can be slowed down, outputs have open collectors	2722 006 01041
FZH231/2.NAND35	Dual 5-input NAND gate Both outputs can be slowed down, outputs have open collectors	2722 006 01051
FZH241/2.AST30	Dual 4-input NAND Schmitt trigger with expandable inputs; output can be slowed down	2722 006 12001
FZH251/4.AND30	Quad 2-input AND gate Two gates can be slowed down	2722 006 13001
FZH261/2.N-4.I30	Dual NAND gate/quad inverter	2722 006 08001
FZH271/4.EO30	Quad EXCLUSIVE-OR gate Two gates can be slowed down	2722 006 11001
FZH281/4.NOR30	Quad NOR gate Two gates can be slowed down	2722 006 10001
FZH291/4.OR30	Quad OR gate Two gates can be slowed down	2722 006 09001
FZJ101/FF30	Single JK flip-flop Slave can be slowed down	2722 006 00001
FZJ111/FF31	Single JK flip-flop Master and slave can be slowed down	2722 006 00011
FZJ121/2.FF32	Dual JK master-slave flip- flop	2722 006 00021
FZJ131/4.FF33	Quad D-type latch flip-flop	2722 006 00031

SURVEY OF TYPES (continued)

type	description	catalogue number
FZJ141/FF34	Single synchronous decimal counter Has parallel-set and common reset inputs	2722 006 00041
FZJ151/FF35	Single synchronous 4-bit binary counter. Has parallel-set and common reset inputs	2722 006 00051
FZJ161/FF36	Single synchronous 4-bit shift register. Two gates can be slowed down	2722 006 00061
FZK101/OS30	Single monostable multivibrator Input can be slowed down	2722 006 03001
FZL101/ND30	Single BCD-decimal decoder numerical indicator tube driver	2722 006 06021
FZL111/SD30	BCD 7-segment decoder-driver with open collector outputs	2722 006 14001
2.LRD30	Dual lamp/relay driver Can be slowed down	2722 006 06011
PA30	Power amplifier Can be slowed down	2722 032 00091
TU30	Single timer unit	2722 006 05001

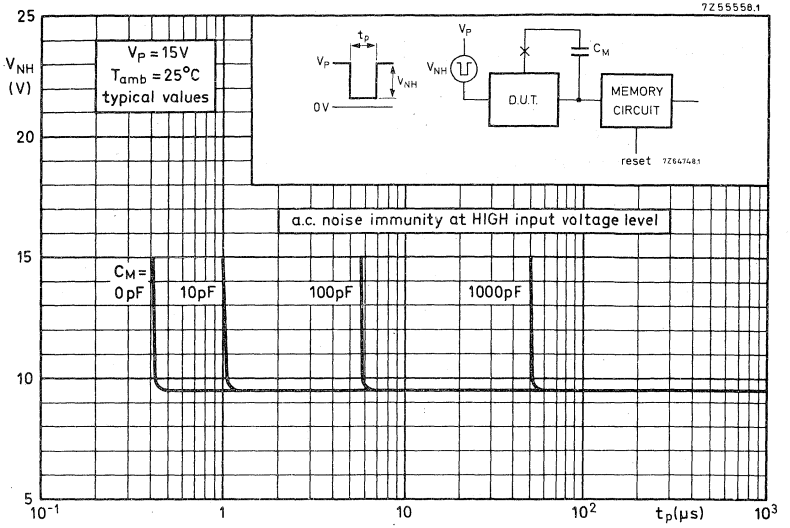
MAIN CHARACTERISTICS

Operating ambient temperature (range I)			0 to +70	°C
Storage temperature			-65 to +150	°C
Package outline			dual in-line	
Supply voltage : range I			12 $^{+12\frac{1}{2}\%}_{-5\%}$	V 1)
range II			15 $^{+13\%}_{-10\%}$	V 1)
Power consumption (per gate)	typ.		30	mW
(per flip-flop)	typ.		165	mW
Counting rate (flip-flops) can be slowed down	<		500	kHz
Fan-out (in gate loads) : NAND gates and flip-flops	N_{aL}		10	
POWER-NAND gates	N_{aL}		30	
for all units	N_{aH}		100	
Propagation delay : (gates)	typ.		150	ns 2)
(flip-flops)	typ.		430	ns 2)
Output short circuit duration non-repetitive value	t_{Qsc}	max.	1	s 3)
D.C. noise margin	typ.		5	V
A.C. noise threshold (With an external capacitor the response time of a function can be slowed down, resulting in an increased a.c. noise threshold.)			see curves next page	

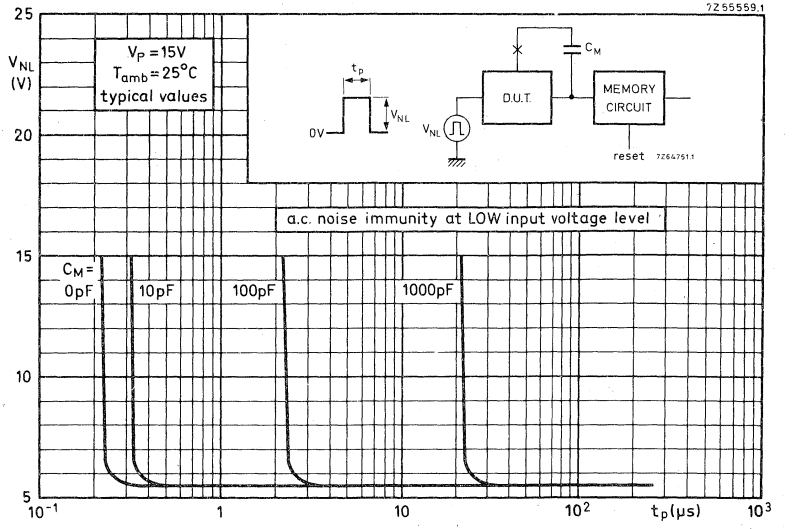
1) Voltage steps within the specified supply limits are allowed.

2) Can be increased to raise a.c. noise threshold.

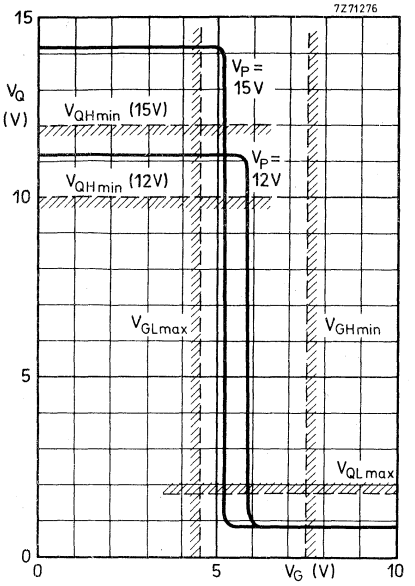
3) Only one output may be shorted at a time.

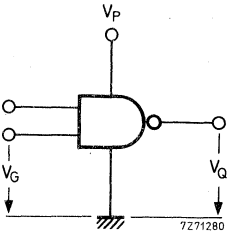


Typical curves for HIGH-input voltage level.

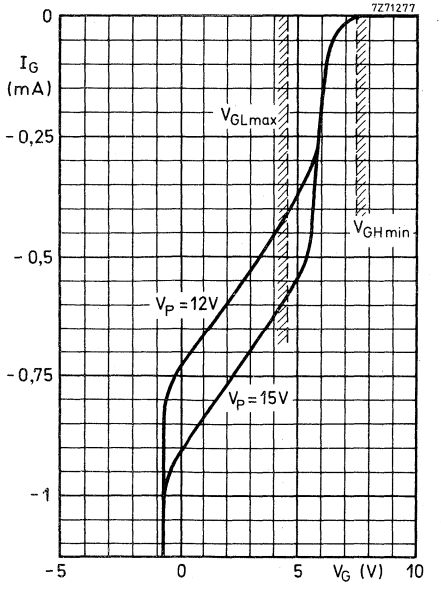


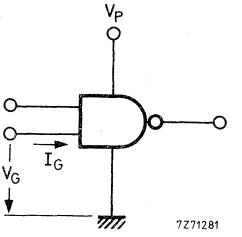
Typical curves for LOW-input voltage level.



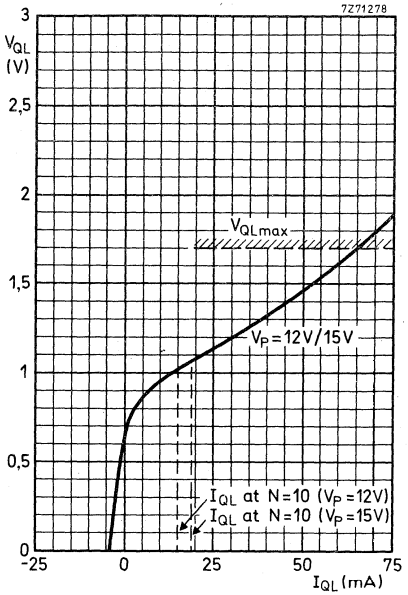


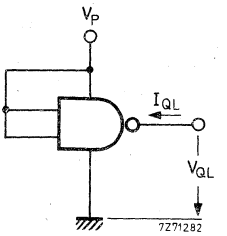
Typical transfer function of NAND gates at V_P = 12 V and V_P = 15 V.



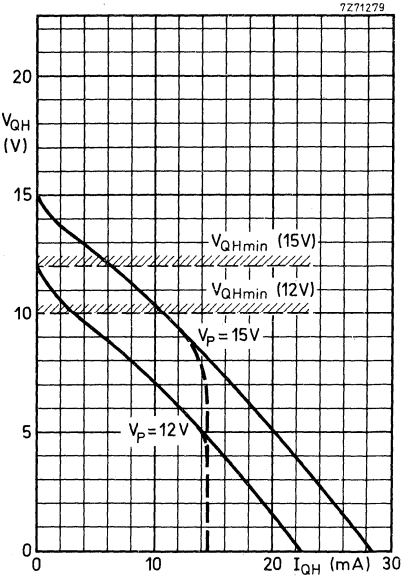


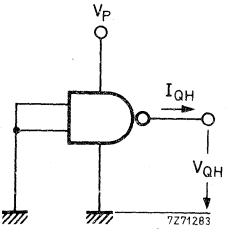
Typical input characteristic of NAND gates.





Typical output characteristic of the LOW-state outputs at V_P = 12 V, 15 V.





Typical output characteristic of the HIGH-state
—— FZH101 to FZH171, FZJ101 and FZJ111
---- FZH191 to FZH291, FZJ121 to FZJ161, and FZK101.

LOADING TABLE (T_{amb} = 0 to +70 °C; V_P = 15 V)

type	function	input (D.U.)		output (D.U.)	
		terminal	required	terminal	available
FZH101/4.NAND32	Quad 2-input NAND	G_1 - G_8	1	Q_1 - Q_4	10
FZH111/4.NAND30	Quad 2-input NAND	G_1 - G_8	1	Q_1 - Q_4	10
FZH121/2.NAND30	Dual 5-input NAND	G_1 - G_{10}	1	Q_1 ; Q_2	10
FZH131/2.NAND31	Dual 5-input NAND	G_1 - G_{10}	1	Q_1 ; Q_2	10
FZH141/2.NAND32	Dual 5-input power NAND	G_1 - G_{10}	1	Q_1 ; Q_2	30
FZH151/2.AOR30	Dual AND-AND-OR	G_2, G_3, G_9, G_{10}	1, 5	Q_1 ; Q_2	16
		other gates	1		
FZH161/4.LI31	Quad logic interface HNIL to 5 V logic	G_2 - G_5	1	Q_1 - Q_4	$V_{QL} \leq 0,4$ V I_{QL} = 20 mA V_P = 13,5 V
		G_1, G_6	2		
FZH171/2.NAND33	Dual 4-input NAND	G_1 - G_8	1	Q_1 ; Q_2	10
FZH181/4.LI30	Quad logic interface 5 V to HNIL	G_1 - G_8	1	Q_1 - Q_4	27
FZH191/3.NAND33	Triple 3-input NAND	G_1 - G_9	1	Q_1 - Q_3	10
FZH201/6.IN30	Sextuple inverter with strobe input	G_1 - G_6	1	Q_1 - Q_6	10
FZH211/4.NAND34	Quad 2-input NAND	G_1 - G_8	1	Q_1 - Q_4	10
FZH231/2.NAND35	Dual 5-input NAND	G_1 - G_{10}	1	Q_1 ; Q_2	10
FZH241/2.AST30	Dual 4-input NAND Schmitt trigger	G_1 - G_8	1	Q_1 ; Q_2	10
FZH251/4.AND30	Quad 2-input AND	G_1 - G_8	1	Q_1 - Q_4	10
FZH261/2.N-4.I30	Dual NAND/Quad inverter	G_1 - G_8	1	Q_1 - Q_6	10
FZH271/4.EO30	Quad EXCLUSIVE-OR	G_1 - G_8	1	Q_1 - Q_4	10

LOADING TABLE (continued)

type	function	input (D.U.)		output (D.U.)	
		terminal	required	terminal	available
FZH281/4.NOR30	Quad NOR	G_1-G_8	1	Q_1-Q_4	10
FZH291/4.OR30	Quad OR	G_1-G_8	1	Q_1-Q_4	10
FZJ101/FF30	Single JK master-slave flip-flop	J_1;J_2;K_1;K_2	1	Q_1;Q_2	10
		T	2		
		S_1;S_2	1, 5		
FZJ111/FF31	Single JK master-slave flip-flop	J_1;J_2;K	1	Q_1;Q_2	10
		T	2		
		S_1;S_2	1, 5		
FZJ121/2.FF32	Dual JK master-slave flip-flop	J_1;J_2;K_1;K_2	1	Q_1-Q_4	10
		T_1;T_2	2		
		S_1-S_4	1, 5		
FZJ131/4.FF33	Quad D-type latch flip-flop	D_1-D_4	2	Q_1-Q_8	10
		T_1;T_2	4		
FZJ141/FF34	Single synchronous decimal counter	all inputs	1	Q_A;Q_B;Q_C;Q_D	10
FZJ151/FF35	Single synchronous 4-bit binary counter	all inputs	1	Q_A;Q_B;Q_C;Q_D	10
FZJ161/FF36	Single synchronous 4-bit shift register	C_S input	4	Q_A;Q_B;Q_C;Q_D	10
		all other inputs	1		
FZK101/OS30	Monostable multivibrator	G_1-G_4	1	Q	10
FZL101/ND30	Single BCD-decimal decoder N.I.T. driver	I_1;I_2;I_4;I_8	1	Q_0-Q_9	I_{QH} = 50 mA, V_{QH} = 70 V: input comb. 0 to 9 I_{QH} = 5 mA, V_{QH} = 60 V: input comb. 10 to 15

LOADING TABLE (continued)

type	function	input (D.U.)		output (D.U.)	
		terminal	required	terminal	available
2. LRD30	Dual lamp/relay driver	G_1;G_2 E_1;E_2	3 3 (max 15 Si-diodes)	Q_1;Q_2	$I_{QL} \leq 200$ mA $V_{Pmax} = 17$ V
PA30	Power amplifier	G	$I_{GL} = 5,1$ mA; $V_{GL} = 1,7$ V	Q	$I_{QL} = 2$ A $V_{QL} = 1,3$ V
TU	Timer unit	G	$I_{GL} = 0,95$ mA, $V_P = 11,4$ V } V_{GL}= 1,7 V $I_{GL} = 1,6$ mA, $V_P = 17$ V } V_{GL}= 1,7 V	Q	22

NOTE

The figures quoted above for the fan-out in Drive Units (D.U.) are calculated for worst-case conditions: input Drive Units are simply added together to find the output Drive Units that the driving stage should be capable of supplying. To interface with other sorts of circuit, Drive Units can be interpreted as having the values shown below. These values are not applicable to the table.

LOW level:

1 input D.U. : 1,8 mA at 0 to 1,7 V
1 output D.U. : 1,5 mA at 1,7 V

HIGH level:

input voltage = between 10 V and V_P
output voltage = between 0,75 x V_P and V_P

LETTER SYMBOLS

1. General

The voltages and currents are related to the terminals to which they are applied or at which they appear. Each terminal is indicated by a letter relating to the function of the device or the function of the pertinent signal.
In order to avoid confusion by any ambiguity in logical conventions, signal levels are indicated by H (= HIGH, for the more positive potential) and L (= LOW, for the less positive potential). Where circuit functions or logical equations are involved, the logical convention is mentioned specifically (for positive logic: H = 1, and for negative logic: H = 0).

2. Terminal designations

CE = condition enable for output QE
C_Q = slow-down terminal
CT = condition enable trigger at input T
D = D input of D-type latch flip-flops
E = expander input (if necessary, this letter may be followed by a subscript, e.g. E_1 or E_2 or by one of the input letters, such as EG = gate expander input)
G = gate input
J, K = J, K input of JK flip-flops
N = negative supply
P = positive supply
Q = output
QE = output enable
R = direct Reset input
S = direct Set input
T = trigger (or toggle) input
ϕ = common supply return and voltage reference

3. Subscript sequence for voltages and currents

First subscript : terminal designation letter.
Second subscript : H (for HIGH) or L (for LOW), if applicable.
Third subscript : min or max, if applicable.
Examples : V_P, I_{QL}, V_{QHmin}, I_{PH} (in the latter case H denotes that the output level is HIGH).

4. Polarity of current and voltage

A current is defined as positive when its conventional direction of flow is into the device.
Unless otherwise specified, a voltage is measured with respect to the reference terminal (ϕ). Its polarity is defined as positive when the potential is higher than that of the reference terminal.

5. Time designations

If required for reasons of unambiguity, the related terminals may be included in the designations given below (e.g. t_{fQ1}).

t_f = fall time (transition from HIGH to LOW, see Fig. 1)

t_{hold} = hold time

t_H = signal HIGH duration (Fig. 1)

t_L = signal LOW duration (Fig. 1)

t_{pd} = average propagation delay time, defined as $\frac{t_{pdr} + t_{pdf}}{2}$

t_{pdf} = fall propagation delay time (output voltage falling, see Fig. 2)

t_{pdr} = rise propagation delay time (output voltage rising, see Fig. 2)

t_r = rise time (transition from LOW to HIGH, see Fig. 1)

t_{rec} = recovery time

t_{sc} = duration of short circuit (from relevant terminal to common return terminal)

t_{su} = set-up time

V_{pd} = reference voltage level for propagation delay measurement

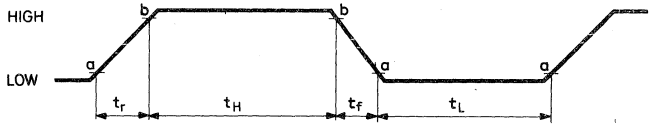


Fig. 1

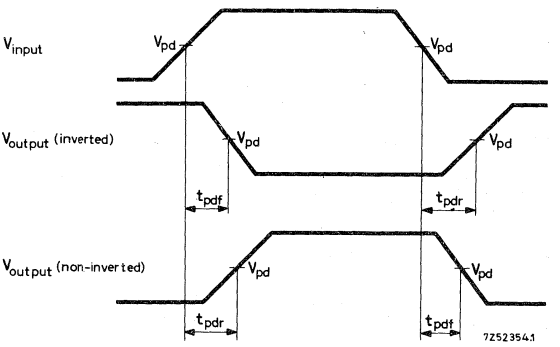


Fig. 2

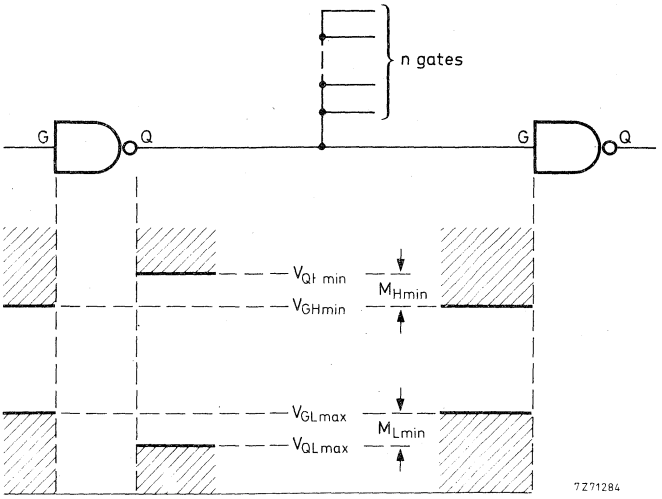
6. Other designations

i.c. = internally connected
Terminals with this indication should be left open. Otherwise correct working cannot be ensured; the device may even be damaged

I_P = supply current
The logic state of the device indicated by H of L is normally referred to the output level, unless otherwise specified

I_{Pmax} = supply current
Maximum d.c. value under defined conditions

M = d.c. noise margin



M_L = d.c. noise margin, signal level LOW
(defined as: $M_L = V_{GLmax} - V_{QLmax}$ under defined loading, temperature and supply voltage conditions)

M_H = d.c. noise margin, signal level HIGH
(calculated from: $M_H = V_{QHmin} - V_{GHmin}$ under defined loading, temperature and supply voltage conditions)

Na_L = available d.c. fan-out (defined as: $N_{aL} = \frac{I_{QLmax}}{-I_{GLmax}}$ under defined temperature and supply voltage conditions)

N_{aH} = available d.c. fan-out (defined as: $N_{aH} = \frac{-I_{QHmax}}{I_{GHmax}}$ under defined temperature and supply voltage conditions)

P_H;P_L = power consumption, defined as the product of the supply current(s) and of the corresponding supply voltage(s). The logical state of the device, indicated by a letter subscript H or L, is normally referred to the output level, unless otherwise specified

P_{av} = average power consumption at 50% duty cycle, unless otherwise specified. It is defined as: $P_{av} = V_P \cdot \frac{I_{PH} + I_{PL}}{2}$

P_{tot} = power dissipation, defined as the total power dissipated by the device. It is the sum of the products of all currents and voltages at each of the input, output and supply terminals, their polarities being taken into account. The logical state of the device indicated by a letter subscript H or L is normally referred to the output level, unless otherwise specified

T_{amb} = operating ambient temperature, i.e. the temperature of the free air in which the normally operating device is placed without external heat conduction, unless otherwise specified

T_{stg} = storage temperature, i.e. the temperature of the ambient medium in which the non-operating device is stored

V_{GLmax} = input voltage LOW at terminal G. With the specified level applied to the input of an inverting gate the output level will not be lower than the specified value V_{QHmin} at given I_{QH}.

V_{GHmin} = input voltage HIGH at terminal G. With the specified level applied to the input of an inverting gate the output level will not exceed the specified value V_{QLmax} at given I_{QL}.

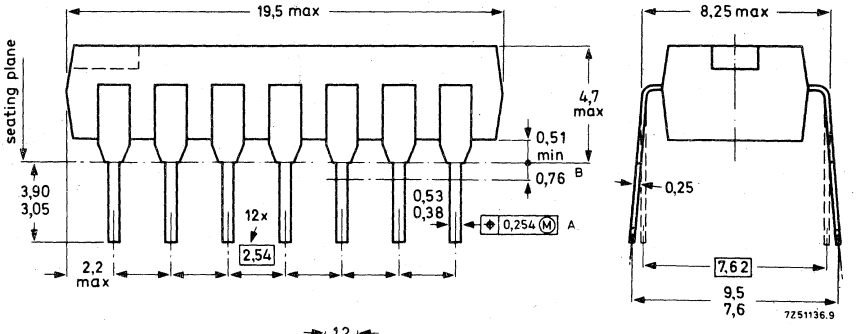
V_H = hysteresis ($V_H = V_{TP} - V_{TN}$)

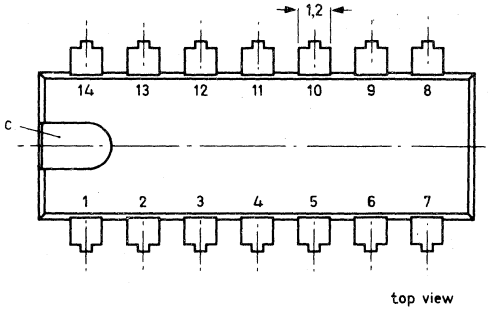
V_{TP} = positive-going threshold voltage

V_{TN} = negative-going threshold voltage

ΔV_Q = change of output voltage caused by a specified change of output current

14-LEAD DUAL IN-LINE; PLASTIC (SOT-27)





Dimensions in mm

⊕ Positional accuracy.

Ⓜ Maximum Material Condition.

A Centre-lines of all leads are within ±0,127 mm of the nominal position shown; in the worst case, the spacing between any two leads may deviate from nominal by ± 0,254 mm.

B Lead spacing tolerances apply from seating plane to the line indicated.

C Index may be horizontal as shown, or vertical.

SOLDERING

1. By hand

   Apply the soldering iron below the seating plane (or not more than 2 mm above it). If its temperature is below 300 °C it must not be in contact for more than 10 seconds; if between 300 °C and 400 °C, for not more than 5 seconds.

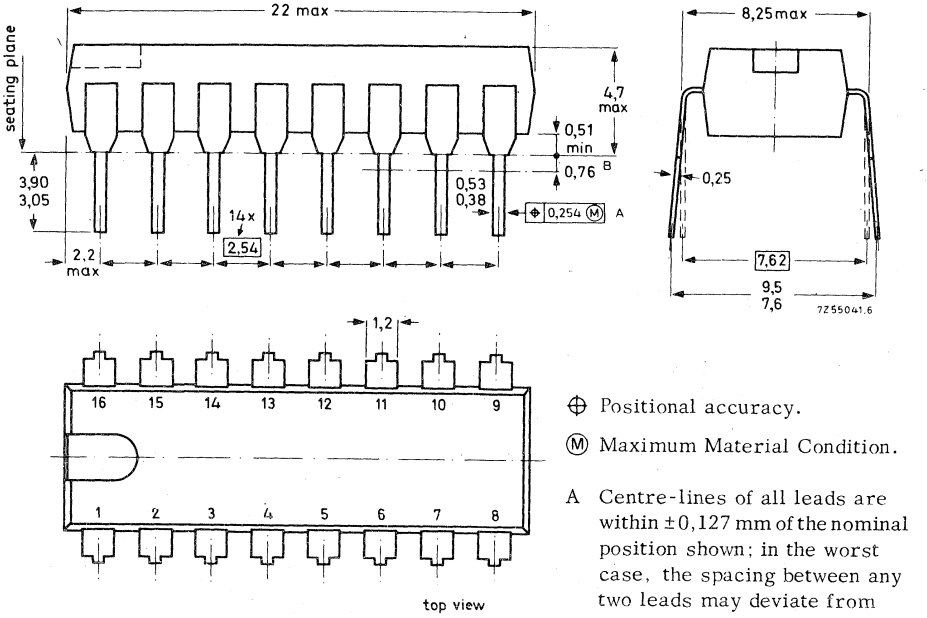
2. By dip or wave

   260 °C is the maximum allowable temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.
   The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified storage maximum. If the printed circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the allowable limit.

3. Repairing soldered joints

   The same precautions and limits apply as in (1) above.

16-LEAD DUAL IN-LINE; PLASTIC (SOT-38)



Dimensions in mm

⊕ Positional accuracy.

Ⓜ Maximum Material Condition.

A Centre-lines of all leads are within ± 0,127 mm of the nominal position shown; in the worst case, the spacing between any two leads may deviate from nominal by ± 0,254 mm.

B Lead spacing tolerances apply from seating plane to the line indicated.

SOLDERING

1. By hand

   Apply the soldering iron below the seating plane (or not more than 2 mm above it). If its temperature is below 300 °C it must not be in contact for more than 10 seconds; if between 300 °C and 400 °C, for not more than 5 seconds.

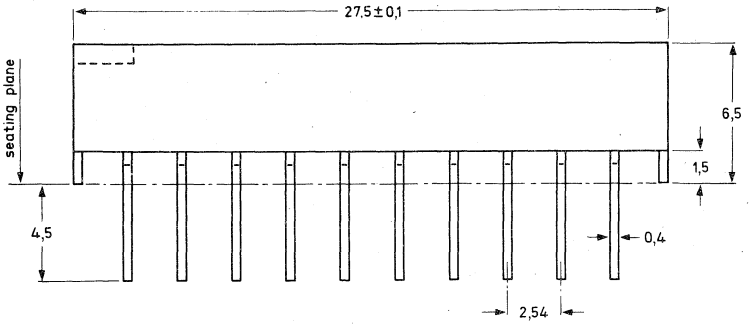
2. By dip or wave

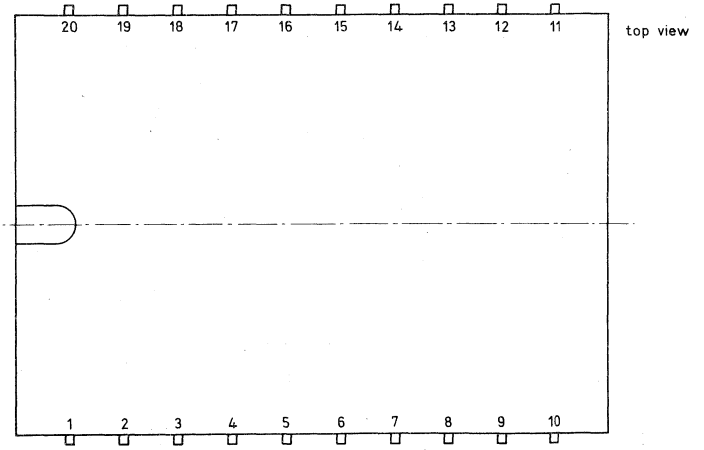
   260 °C is the maximum allowable temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.
   The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified storage maximum. If the printed circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the allowable limit.

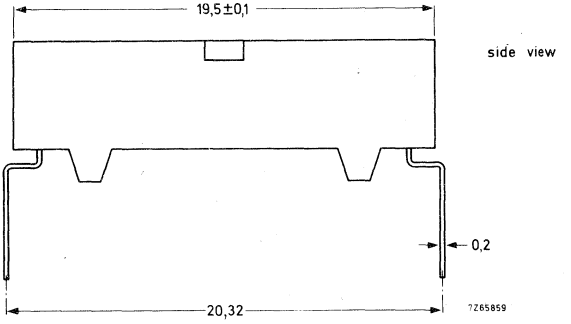
3. Repairing soldered joints

   The same precautions and limits apply as in (1) above.

20 LEAD DUAL IN-LINE

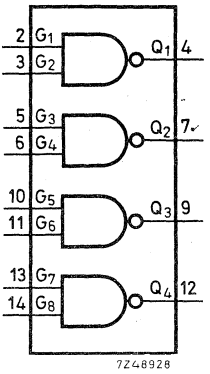




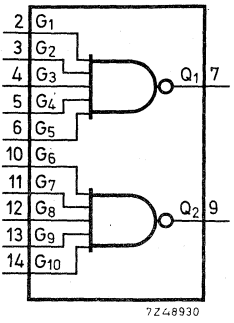


The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

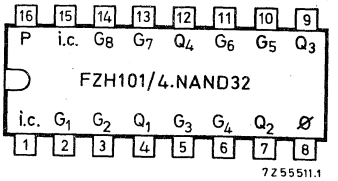
QUADRUPLE 2-INPUT NAND GATE
DUAL 5-INPUT NAND GATE

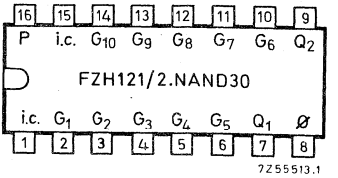


FZH101/4.NAND32



FZH121/2.NAND30





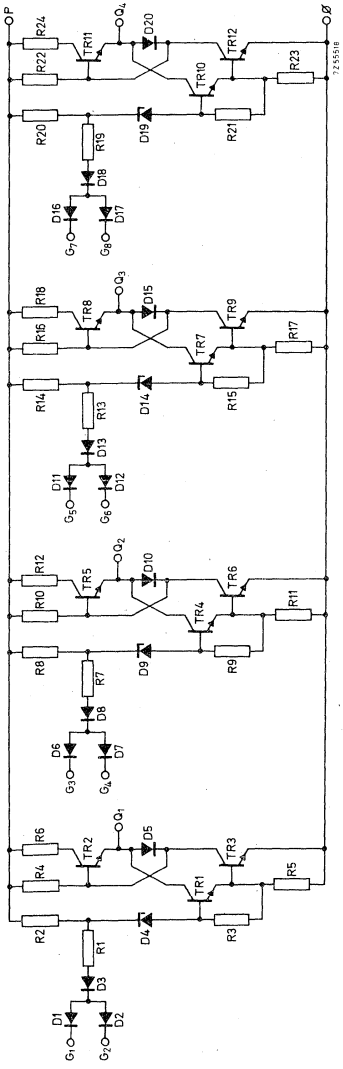
QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}	0 to +70		°C
Average propagation delay ($N = 1$; $C_L = 10$ pF; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V)	t_{pd}	typ.	170	ns
Available d.c. fan-out ($T_{amb} = 0$ to +70 °C) LOW state	N_{aL}	max.	10	
D.C. noise margin at $T_{amb} = 25$ °C				
range I : $V_P = 12$ V	$M_L = M_H$	typ.	5	V
range II: $V_P = 15$ V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at $T_{amb} = 25$ °C (50% duty cycle) range I : $V_P = 12$ V	P_{av}	typ.	16	mW
range II: $V_P = 15$ V	P_{av}	typ.	27	mW

The FZH101/4.NAND32 and FZH121/2.NAND30 consists of a number of independent NAND gates without slow-down capability.

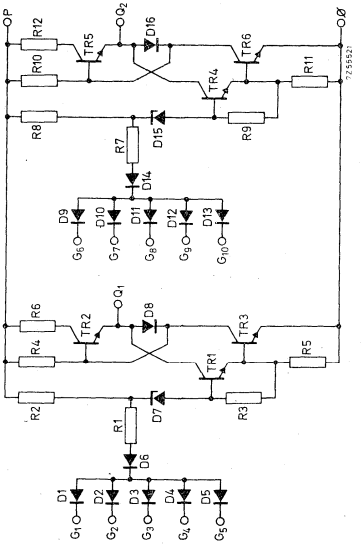
PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAMS

FZH101/4.NAND32

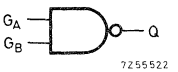


FZH121/2.NAND30



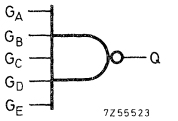
LOGIC FUNCTION

FZH101/4.NAND32



$Q = \overline{G_A \cdot G_B}$ (positive logic)

FZH121/2.NAND30



$Q = \overline{G_A \cdot G_B \cdot G_C \cdot G_D \cdot G_E}$

(positive logic)

Function tables

G_A	G_B	Q
L	X	H
X	L	H
H	H	L

G_A	G_B	G_C	G_D	G_E	Q
L	X	X	X	X	H
X	L	X	X	X	H
X	X	L	X	X	H
X	X	X	L	X	H
X	X	X	X	L	H
H	H	H	H	H	L

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_G	max.	18	V
Input current at V_P = 17 V	$-I_{GL}$	max.	25	mA
Voltage difference between any two inputs		max	18	V
Storage temperature	T_{stg}	−65 to	+150	°C
Operating ambient temperature	T_{amb}	0 to	+70	°C
Output short-circuit duration	t_{Qsc}	max.	1	s [1]

[1]) Only one output may be shorted at a time.

SYSTEM DESIGN DATA

Uniform system temperature		T_{amb}	0 to	+70	°C
Uniform system supply voltage (range I)		V_P	11,4 to	13,5	V
(range II)		V_P	13,5 to	17	V
Available d.c. fan-out		N_{aL}	max.	10	
		N_{aH}	max.	100	
D.C. noise margin; range I at V_{Pmin}		M_L	min.	2,8	V
		M_H	min.	2,5	V
range II at V_{Pmin}		M_L	min.	2,8	V
		M_H	min.	4,5	V
Supply current per gate	range I ; output HIGH	I_{Pav}	typ.	0,9	mA
	output LOW	I_{Pav}	typ.	1,7	mA
	range II; output HIGH	I_{Pav}	typ.	1,2	mA
	output LOW	I_{Pav}	typ.	2,3	mA
Power consumption per gate (50% duty cycle) at range I ; V_{Pmax}		P_{tot}	max.	31	mW
at range II; V_{Pmax}		P_{tot}	max.	52	mW
Thermal resistance from system to ambient		R_{th}	max.	150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ.[1]	max.	Conditions and references: V_P (V)	Conditions and references
Static data						
Voltages						
Input HIGH	V_{GH}	7,5	–	– V	11,4	$V_{QL} \leq 1,7$ V; I_{QL} = 15 mA
Input LOW	V_{GL}	–	–	4,5 V	11,4 and 13,5	$V_{QH} \geq 10$ V; $-I_{QH}$ = 15 mA
Output HIGH	V_{QH}	10,0	11,3	– V	11,4 and 13,5	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	0,9	1,7 V	11,4	V_{GH} = 7,5 V; I_{QL} = 15 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	– V	11,4	
LOW	M_L	2,8	5,0	– V	11,4	
Currents (per gate)						
Input HIGH	I_{GH}	–	–	1,0 µA	13,5	V_{GH} = 13,5 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	0,8	1,5 mA	13,5	V_{GL} = 1,7 V; other inputs 13,5 V
Output HIGH	$-I_{QH}$	0,1	–	– mA	11,4 and 13,5	V_{GL} = 4,5 V; V_{QH} = 10 V
Output LOW	I_{QL}	15	–	– mA	11,4	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited[2]	$-I_{Qsc}$	10	30	50 mA	13,5	V_G = 0 V; V_Q = 0 V
Supply data						
Currents (per gate)						
at V_{QH}	I_P	–	0,9	1,6 mA	13,5	V_G = 0 V
at V_{QL}	I_P	–	1,7	3,0 mA	13,5	V_G = 13,5 V
Dynamic data						
Times						
Propagation delay:						
fall time	t_{pdf}	90	175	310 ns	12	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_{pd} = 4,5 V
rise time	t_{pdr}	90	175	310 ns	12	
output rise time	t_r	200	340	570 ns	12	
output fall time	t_f	70	120	210 ns	12	

1) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.
2) Short-circuit duration max. 1 s.

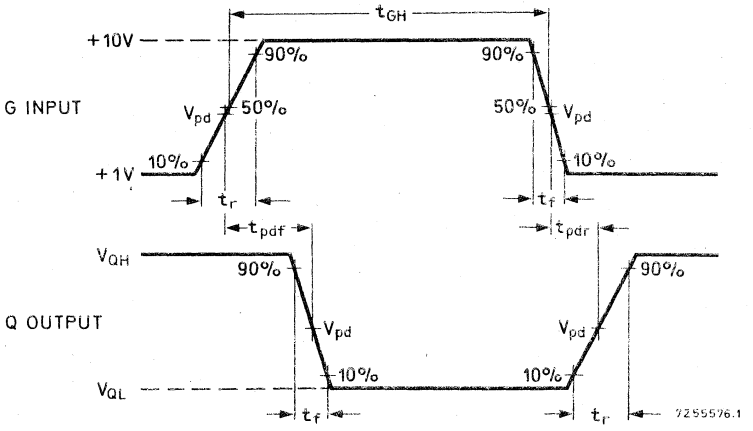
CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ.[1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	13,5	$V_{QL} \leq 1,7$ V; I_{QL} = 18 mA
Input LOW	V_{GL}	–	–	4,5	V	13,5 and 17	$V_{QH} \geq 12$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	12,0	14,3	–	V	13,5 and 17	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1,0	1,7	V	13,5	V_{GH} = 7,5 V; I_{QL} = 18 mA
D.C. noise margin: HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	μA	17	V_{GH} = 17 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	1,0	1,8	mA	17	V_{GL} = 1,7 V; other inputs 17 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	13,5 and 17	V_{GL} = 4,5 V; V_{QH} = 12 V
Output LOW	$-I_{QL}$	18	–	–	mA	13,5	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited[2]	$-I_{Qsc}$	15	37	60	mA	17	V_G = 0 V; V_Q = 0 V
Supply data							
Currents (per gate)							
at V_{QH}	I_P	–	1,2	2,1	mA	17	V_G = 0 V
at V_{QL}	I_P	–	2,3	4,0	mA	17	V_G = 17 V
Dynamic data							
Times							
Propagation delay:							
fall time	t_{pdf}	–	140	–	ns	15	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_{pd} = 4,5 V
rise time	t_{pdr}	–	195	–	ns	15	
output rise time	t_r	–	410	–	ns	15	
output fall time	t_f	–	75	–	ns	15	

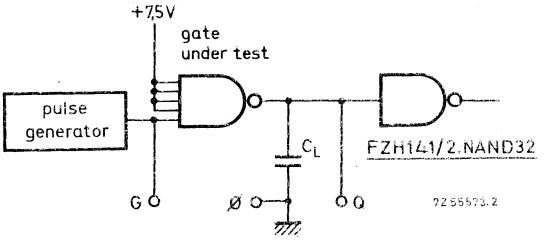
[1] All typical values under test conditions : T_{amb} = 25 °C and V_P = 15 V.
[2] Short-circuit duration max. 1 s.

CHARACTERISTICS (continued)

Dynamic data



Pulse generator (G-input): t_r = 350 ns V_{pd} = + 4,5 V
t_f = 120 ns
t_{GH} = 1 µs

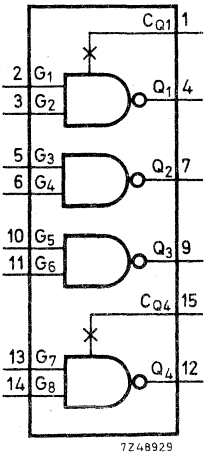


Measuring conditions: V_P = + 12 V; + 15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C

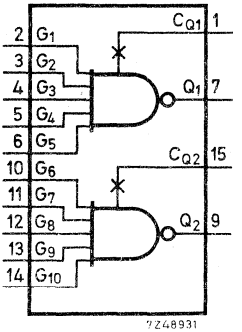
Waveforms and loading circuit illustrating measurement of t_{pdr} and t_{pdf}

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

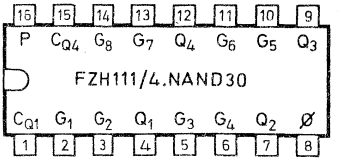
QUADRUPLE 2-INPUT NAND GATE
DUAL 5-INPUT NAND GATE
both having slow-down capability

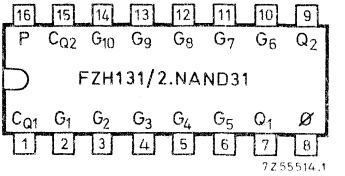


FZH111/4.NAND30



FZH131/2.NAND31





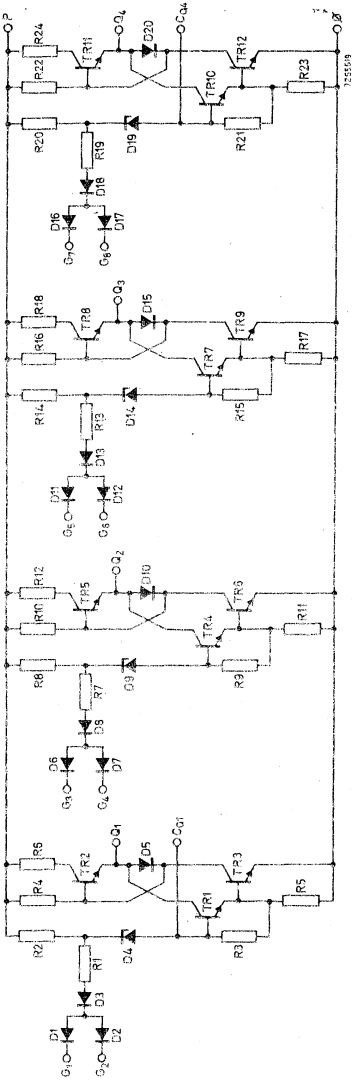
QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}	0 to +70		°C
Average propagation delay ($N = 1$; $C_L = 10$ pF; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V)	t_{pd}	typ.	170	ns
Available d.c. fan-out ($T_{amb} = 0$ to +70 °C) LOW state	N_{aL}	max.	10	
D.C. noise margin at $T_{amb} = 25$ °C				
range I ; $V_P = 12$ V	$M_L = M_H$	typ.	5	V
range II; $V_P = 15$ V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at $T_{amb} = 25$ °C				
(50% duty cycle) range I : $V_P = 12$ V	P_{av}	typ.	16	mW
range II: $V_P = 15$ V	P_{av}	typ.	27	mW

The FZH111/4.NAND30 and FZH131/2.NAND31 consist of a number of independent NAND gates at which two NAND gates per type have a special terminal (C_Q). It is possible to connect a capacitor between the output (Q) and the corresponding slow-down terminal (C_Q) to increase the propagation delay.

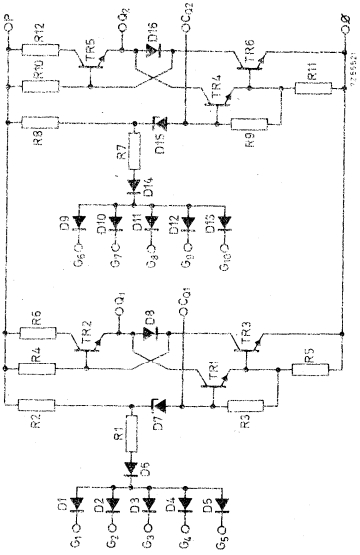
PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAMS

FZH111/4.NAND30

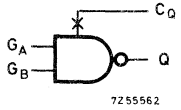


FZH131/2.NAND31



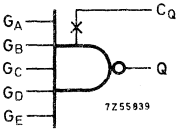
LOGIC FUNCTION

FZH111/4.NAND30



$Q = \overline{G_A \cdot G_B}$ (positive logic)

FZH131/2.NAND31



$Q = \overline{G_A \cdot G_B \cdot G_C \cdot G_D \cdot G_E}$ (positive logic)

Function tables

G_A	G_B	Q
L	X	H
X	L	H
H	H	L

G_A	G_B	G_C	G_D	G_E	Q
L	X	X	X	X	H
X	L	X	X	X	H
X	X	L	X	X	H
X	X	X	L	X	H
X	X	X	X	L	H
H	H	H	H	H	L

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_G	max.	18	V
Input current at V_P = 17 V	$-I_{GL}$	max.	25	mA
Voltage difference between any two inputs		max.	18	V
Storage temperature	T_{stg}	−65 to +150		°C
Operating ambient temperature	T_{amb}	0 to +70		°C
Output short-circuit duration	t_{Qsc}	max.	1	s [1]
Slow-down input voltage	$+V_{CQ}$	max.	0,6	V
	$-V_{CQ}$	max.	1,0	V
Slow-down input current	$+I_{CQ}$	max.	2,0	mA
	$-I_{CQ}$	max.	10,0	mA

[1]) Only one output may be shorted at a time.

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}	0 to +70	°C
Uniform system supply voltage (range I)	V_P	11,4 to 13,5	V
(range II)	V_P	13,5 to 17	V
Available d.c. fan-out	N_{aL}	max. 10	
	N_{aH}	max. 100	
D.C. noise margin; range I at V_{Pmin}	M_L	min. 2,8	V
	M_H	min. 2,5	V
range II at V_{Pmin}	M_L	min. 2,8	V
	M_H	min. 4,5	V
Supply current per gate; range I ; output HIGH	I_{Pav}	typ. 0,9	mA
output LOW	I_{Pav}	typ. 1,7	mA
range II; output HIGH	I_{Pav}	typ. 1,2	mA
output LOW	I_{Pav}	typ. 2,3	mA
Power consumption per gate (50% duty cycle) at range I ; V_{Pmax}	P_{tot}	max. 31	mW
at range II ; V_{Pmax}	P_{tot}	max. 52	mW
Thermal resistance from system to ambient	R_{th}	max. 150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ.[1]	max.	Conditions and references: V_P (V)	
Static data						
Voltages						
Input HIGH	V_{GH}	7,5	–	– V	11,4	$V_{QL} \leq 1,7$ V; I_{QL} = 15 mA
Input LOW	V_{GL}	–	–	4,5 V	11,4 and 13,5	$V_{QH} \geq 10$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	10,0	11,3	– V	11,4 and 13,5	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	0,9	1,7 V	11,4	V_{GH} = 7,5 V; I_{QL} = 15 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	– V	11,4	
LOW	M_L	2,8	5,0	– V	11,4	
Currents (per gate)						
Input HIGH	I_{GH}	–	–	1,0 μA	13,5	V_{GH} = 13,5 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	0,8	1,5 mA	13,5	V_{GL} = 1,7 V; other inputs 13,5 V
Output HIGH	$-I_{QH}$	0,1	–	– mA	11,4 and 13,5	V_{GL} = 4,5 V; V_{QH} = 10 V
Output LOW	I_{QL}	15	–	– mA	11,4	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited[2]	$-I_{Qsc}$	10	30	50 mA	13,5	V_G = 0 V; V_Q = 0 V
Supply data						
Currents (per gate)						
at V_{QH}	I_P	–	0,9	1,6 mA	13,5	V_G = 0 V
at V_{QL}	I_P	–	1,7	3,0 mA	13,5	V_G = 13,5 V
Dynamic data						
Times						
Propagation delay						
fall time	t_{pdf}	90	175	310 ns	12	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_{pd} = 4,5 V
rise time	t_{pdr}	90	175	310 ns	12	
output rise time	t_r	200	340	570 ns	12	
output fall time	t_f	70	120	210 ns	12	

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.
[2]) Short-circuit duration max. 1 s.

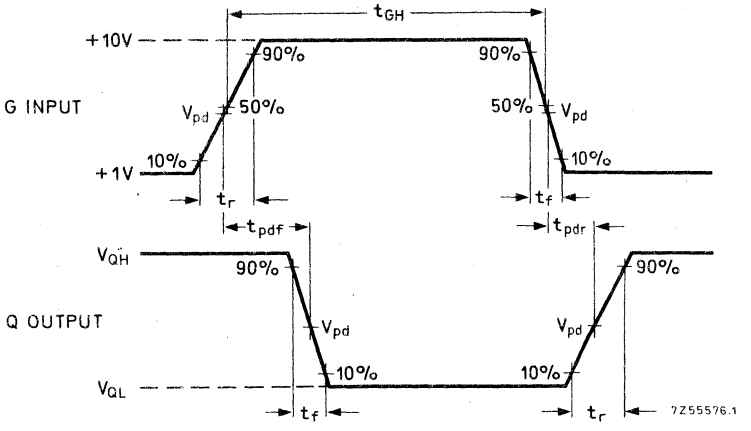
CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ.[1]	max.	Conditions and references: V_P (V)	Conditions and references
Static data						
Voltages						
Input HIGH	V_{GH}	7,5	–	– V	13,5	$V_{QL} \leqslant 1,7$ V; I_{QL} = 18 mA
Input LOW	V_{GL}	–	–	4,5 V	13,5 and 17	$V_{QH} \geqslant 12$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	12,0	14,3	– V	13,5 and 17	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1,0	1,7 V	13,5	V_{GH} = 7,5 V; I_{QL} = 18 mA
D.C. noise margin: HIGH	M_H	4,5	8,0	– V	13,5	
LOW	M_L	2,8	5,0	– V	13,5	
Currents (per gate)						
Input HIGH	I_{GH}	–	–	1,0 μA	17	V_{GH} = 17 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	1,0	1,8 mA	17	V_{GL} = 1,7 V; other inputs 17 V
Output HIGH	$-I_{QH}$	0,1	–	– mA	13,5 and 17	V_{GL} = 4,5 V; V_{QH} = 12 V
Output LOW	I_{QL}	18	–	– mA	13,5	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2]	$-I_{Qsc}$	15	37	60 mA	17	V_G = 0 V; V_Q = 0 V
Supply data						
Currents (per gate)						
at V_{QH}	I_P	–	1,2	2,1 mA	17	V_G = 0 V
at V_{QL}	I_P	–	2,3	4,0 mA	17	V_G = 17 V
Dynamic data						
Times						
Propagation delay						
fall time	t_{pdf}	–	140	– ns	15	C_L = 10 pF; N = 1; T_{amb} = 25 °C; Vdp = 4,5 V
rise time	t_{pdr}	–	195	– ns	15	
output rise time	t_r	–	410	– ns	15	
output fall time	t_f	–	75	– ns	15	

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.
[2] Short-circuit duration max. 1 s.

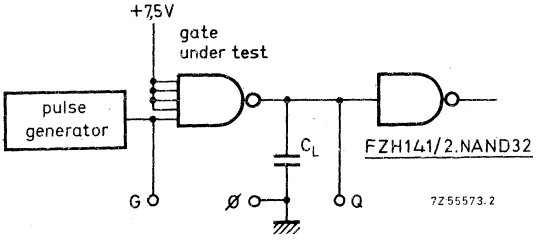
CHARACTERISTICS (continued)

Dynamic data



Pulse generator (G-input): t_r = 350 ns
t_f = 120 ns
t_{GH} = 1 µs

V_{pd} = + 4,5 V



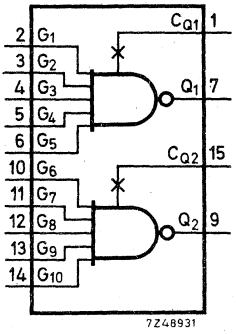
Measuring conditions: V_P = + 12 V; + 15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C
Slow-down terminals are not connected

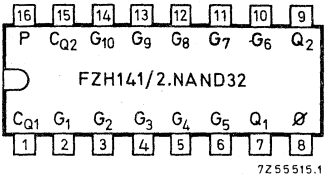
Waveforms and loading circuit illustrating measurement of t_{pdr} and t_{pdf}

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

DUAL 5-INPUT POWER NAND GATE

with slow-down capability



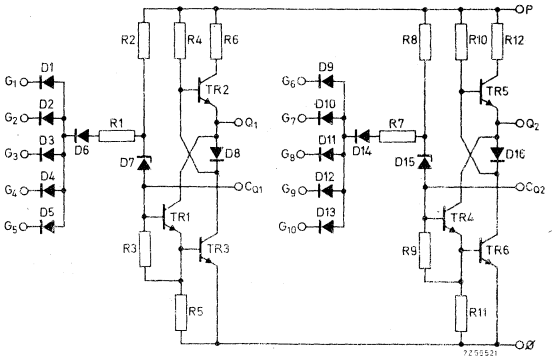


QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}	0 to +70		°C
Average propagation delay ($N = 1$; $C_L = 10$ pF; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V)	t_{pd}	typ.	170	ns
Available d.c. fan-out ($T_{amb} = 0$ to +70 °C) LOW state	N_{aL}	max.	30	
D.C. noise margin at $T_{amb} = 25$ °C				
range I : $V_P = 12$ V	$M_L = M_H$	typ.	5	V
range II: $V_P = 15$ V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at $T_{amb} = 25$ °C				
(50% duty cycle) range I : $V_P = 12$ V	P_{av}	typ.	16	mW
range II: $V_P = 15$ V	P_{av}	typ.	27	mW

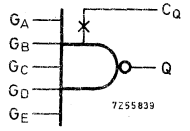
The FZH141/2.NAND32 is a dual 5-input power NAND gate with on each gate a special base connection (C_Q). It is possible to connect a capacitor between the output (Q) and the corresponding slow-down terminal (C_Q) to increase the propagation delay.

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAM



LOGIC FUNCTION



$$Q = \overline{G_A \cdot G_B \cdot G_C \cdot G_D \cdot G_E}$$

(positive logic)

Function table

G_A	G_B	G_C	G_D	G_E	Q
L	X	X	X	X	H
X	L	X	X	X	H
X	X	L	X	X	H
X	X	X	L	X	H
X	X	X	X	L	H
H	H	H	H	H	L

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_G	max.	18	V
Input current at V_P = 17 V	$-I_{GL}$	max.	25	mA
Voltage difference between any two inputs		max.	18	V
Storage temperature	T_{stg}	-65 to +150		°C
Operating ambient temperature	T_{amb}	0 to +70		°C
Output short-circuit duration	t_{Qsc}	max.	1	s [1]
Slow-down input voltage	$+V_{CQ}$	max.	0,6	V
	$-V_{CQ}$	max.	1,0	V
Slow-down input current	$+I_{CQ}$	max.	2,0	mA
	$-I_{CQ}$	max.	10,0	mA

[1]) Only one output may be shorted at a time.

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}	0 to +70	°C	
Uniform system supply voltage (range I)	V_P	11,4 to 13,5	V	
(range II)	V_P	13,5 to 17	V	
Available d.c. fan-out	N_{aL}	max.	30	
	N_{aH}	max.	100	
D.C. noise margin; range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Supply current per gate; range I; output HIGH	I_{Pav}	typ.	0,9	mA
output LOW	I_{Pav}	typ.	1,7	mA
range II; output HIGH	I_{Pav}	typ.	1,2	mA
output LOW	I_{Pav}	typ.	2,3	mA
Power consumption per gate (50% duty cycle) at range I ; V_{Pmax}	P_{tot}	max.	31	mW
at range II ; V_{Pmax}	P_{tot}	max.	52	mW
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max.	Conditions and references: V_P (V)	Conditions and references
Static data						
Voltages						
Input HIGH	V_{GH}	7,5	-	- V	11,4	$V_{QL} \leq 1,7$ V; I_{QL} = 45 mA
Input LOW	V_{GL}	-	-	4,5 V	11,4 and 13,5	$V_{QH} \geq 10$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	10,0	11,3	- V	11,4 and 13,5	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	-	1,3	1,7 V	11,4	V_{GH} = 7,5 V; I_{QL} = 45 mA
D. C. noise margin: HIGH	M_H	2,5	5,0	- V	11,4	
LOW	M_L	2,8	5,0	- V	11,4	
Currents (per gate)						
Input HIGH	I_{GH}	-	-	1,0 µA	13,5	V_{GH} = 13,5 V; other inputs 0 V
Input LOW	$-I_{GL}$	-	0,8	1,5 mA	13,5	V_{GL} = 1,7 V; other inputs 13,5 V
Output HIGH	$-I_{QH}$	0,1	-	- mA	11,4 and 13,5	V_{GL} = 4,5 V; V_{QH} = 10 V
Output LOW	I_{QL}	45	-	- mA	11,4	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2]	$-I_{Qsc}$	10	30	50 mA	13,5	V_G = 0 V; V_Q = 0 V
Supply data						
Currents (per gate)						
at V_{QH}	I_P	-	0,9	1,6 mA	13,5	V_G = 0 V
at V_{QL}	I_P	-	1,7	3,0 mA	13,5	V_G = 13,5 V
Dynamic data						
Times						
Propagation delay						
fall time	t_{pdf}	90	175	310 ns	12	C_L = 10 pF; N = 1; T_{amb} = 25 °C
rise time	t_{pdr}	90	175	310 ns	12	
output rise rime	t_r	200	340	570 ns	12	V_{pd} = 4,5 V
output fall time	t_f	70	120	210 ns	12	

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.
[2]) Short-circuit duration max. 1 s.

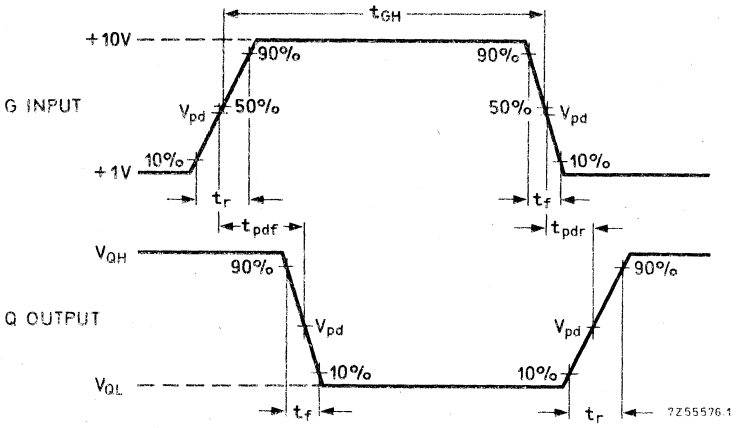
CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ. [1]	max.	Conditions and references: V_P (V)	Conditions and references:
Static data						
Voltages						
Input HIGH	V_{GH}	7,5	-	- V	13,5	$V_{QL} \leq 1,7$ V; I_{QL} = 54 mA
Input LOW	V_{GL}	-	-	4,5 V	13,5 and 17	$V_{QH} \geq 12$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	12,0	14,3	- V	13,5 and 17	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	-	1,4	1,7 V	13,5	V_{GH} = 7,5 V; I_{QL} = 54 mA
D.C. noise margin: HIGH	M_H	4,5	8,0	- V	13,5	
LOW	M_L	2,8	5,0	- V	13,5	
Currents (per gate)						
Input HIGH	I_{GH}	-	-	1,0 µA	17	V_{GH} = 17 V; other inputs 0 V
Input LOW	$-I_{GL}$	-	-	1,8 mA	17	V_{GL} = 1,7 V; other inputs 17 V
Output HIGH	$-I_{QH}$	0,1	-	- mA	13,5 and 17	V_{GL} = 4,5 V; V_{QH} = 12 V
Output LOW	I_{QL}	54	-	- mA	13,5	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2]	$-I_{Qsc}$	15	37	60 mA	17	V_G = 0 V; V_Q = 0 V
Supply data						
Currents (per gate)						
at V_{QH}	I_P	-	1,2	2,1 mA	17	V_G = 0 V
at V_{QL}	I_P	-	2,3	4,0 mA	17	V_G = 17 V
Dynamic data						
Times						
Propagation delay fall time	t_{pdf}	-	140	- ns	15	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_{dp} = 4,5 V
rise time	t_{pdr}	-	195	- ns	15	
output rise time	t_r	-	410	- ns	15	
output fall time	t_f	-	75	- ns	15	

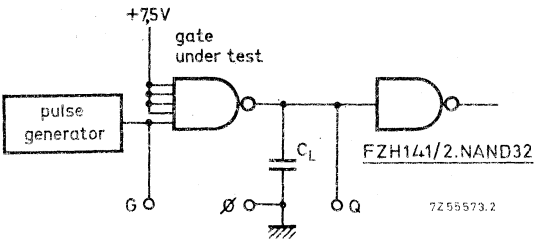
[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.
[2] Short-circuit duration max. 1 s.

CHARACTERISTICS (continued)

Dynamic data



Pulse generator (G-input): t_r = 350 ns V_{pd} = +4,5 V
t_f = 120 ns
t_{GH} = 1 µs

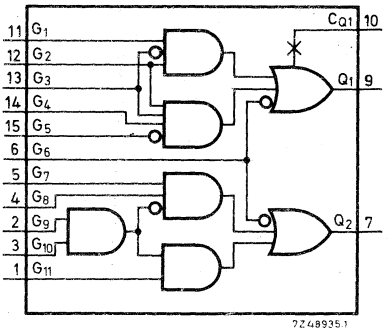


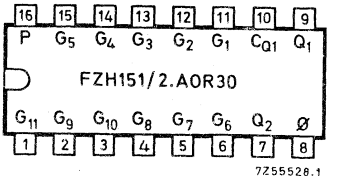
Measuring conditions: V_P = + 12 V; + 15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C
Slow-down terminals are not connected

Waveforms and loading circuit illustrating measurement of t_{pdr} and t_{pdf}

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

DUAL AND-AND-OR GATE
with slow-down capability





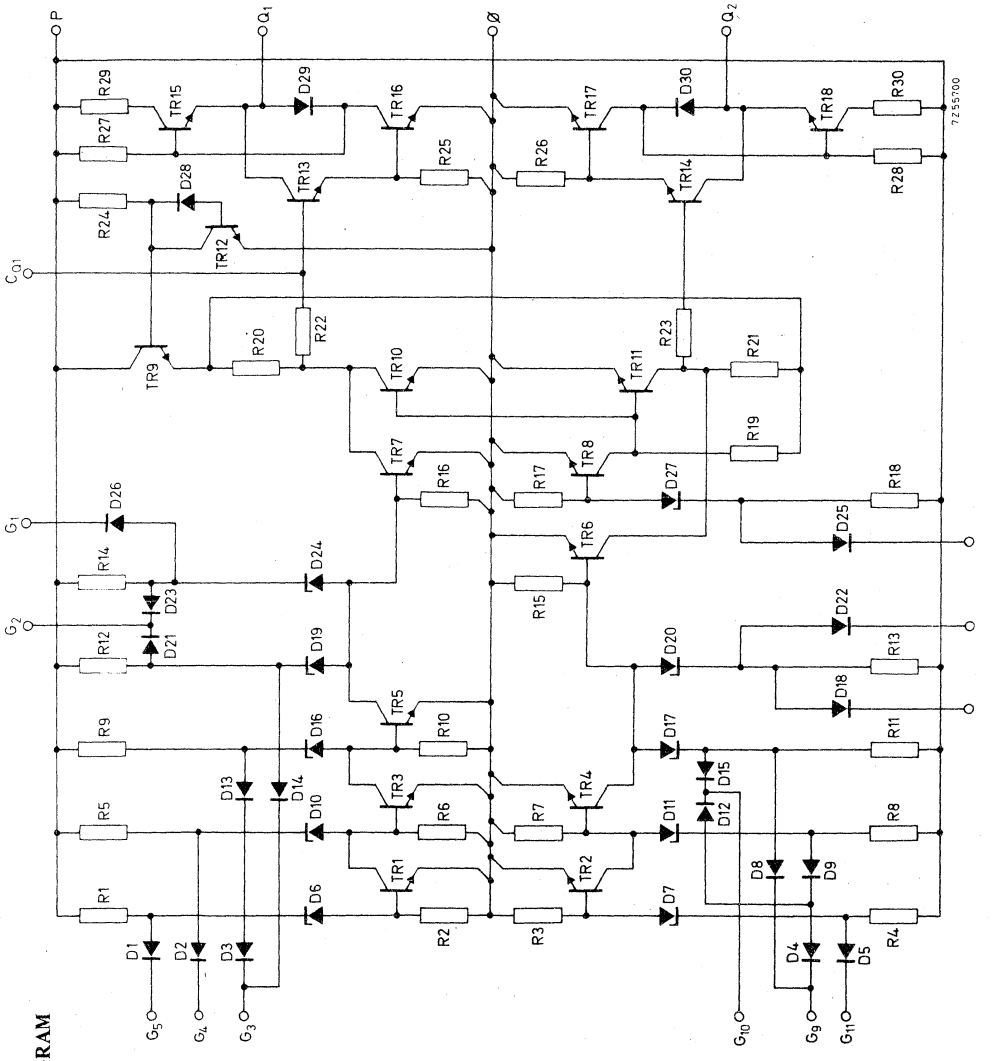
QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}	0 to +70		°C
Average propagation delay ($N = 1$; $C_L = 10$ pF; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V)	t_{pd}	typ.	380	ns
Available d.c. fan-out ($T_{amb} = 0$ to +70 °C) LOW state	N_{aL}	max.	20	1)
	N_{aL}	max.	16	2)
D.C. noise margin at $T_{amb} = 25$ °C range I : $V_P = 12$ V	$M_L = M_H$	typ.	5	V
range II: $V_P = 15$ V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at $T_{amb} = 25$ °C (50% duty cycle) range I : $V_P = 12$ V	P_{av}	typ.	132	mW
range II: $V_P = 15$ V	P_{av}	typ.	225	mW

1) At FZH151/2.AOR30 load.
2) At HNIL gate load.

G_2, G_3, G_9 and G_{10} count for two inputs.

The FZH151/2.AOR30 consists of two combinations AND and OR gates with some common inputs to the AND gates and a common override input to the OR gates. One of the OR gates has a special terminal (C_{Q1}) to provide slow-down capability.

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).



CIRCUIT DIAGRAM

LOGIC FUNCTION

$$Q_1 = G_1 \cdot G_2 \cdot \overline{G_3} + G_2 \cdot G_3 \cdot G_4 \cdot \overline{G_5} + \overline{G_6}$$
$$Q_2 = G_7 \cdot G_8 \cdot \overline{G_9 \cdot G_{10}} + G_9 \cdot G_{10} \cdot G_{11} + \overline{G_6}$$

} for positive logic

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_G	max.	18	V
Input current at V_P = 17 V	$-I_{GL}$	max.	25	mA
Voltage difference between any two inputs		max.	18	V
Slow-down input voltage	$+V_{CQ}$	max.	0,6	V
	$-V_{CQ}$	max.	1,0	V
Slow-down input current	$+I_{CQ}$	max.	2,0	mA
	$-I_{CQ}$	max.	10,0	mA
Storage temperature	T_{stg}		−65 to +150	°C
Operating ambient temperature	T_{amb}		0 to +70	°C
Output short-circuit duration	t_{Qsc}	max.	1	s [1]

[1] Only one output may be shorted at a time.

SYSTEM DESIGN DATA

Uniform system temperature		T_{amb}	0 to	70	°C
Uniform system supply voltage (range I)		V_P	11,4 to	13,5	V
(range II)		V_P	13,5 to	17	V
Available d.c. fan-out: at FZH151/2.AOR30		N_{aL}	max.	20	*)
at HNIL gate load		N_{aL}	max.	16	
		N_{aH}	max.	100	
D.C. noise margin; range I at V_{Pmin}		M_L	min.	2,8	V
		M_H	min.	2,5	V
range II at V_{Pmin}		M_L	min.	2,8	V
		M_H	min.	4,5	V
Supply current per gate	range I ; output HIGH	I_{Pav}	typ.	14	mA
	output LOW	I_{Pav}	typ.	8,0	mA
	range II; output HIGH	I_{Pav}	typ.	18	mA
	output LOW	I_{Pav}	typ.	12	mA
Power consumption per gate (50% duty cycle) at range I, V_{Pmax}		P_{tot}	max.	250	mW
at range II, V_{Pmax}		P_{tot}	max.	425	mW
Thermal resistance from system to ambient		R_{th}	max.	150	°C/W

*) G_2, G_3, G_9 and G_{10} count for two inputs.

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ.[1])	max.		Conditions and references	
						V_P (V)	
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	11,4	V_{QL} = max 1,7 V; I_{QL} = 30 mA
Input LOW	V_{GL}	–	–	4,5	V	11,4	V_{QH} = min 10 V; $-I_{GH}$ = 0,1 mA
Output HIGH	V_{QH}	10,0	11,3	–	V	11,4	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	0,9	1,7	V	11,4	V_{GH} = 7,5 V; I_{QL} = 30 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	–	V		
LOW	M_L	2,8	5,0	–	V		
Currents							
Input HIGH: $G_2;G_3;G_9;G_{10}$	I_{GH}	–	–	2	μA	13,5	V_{GH} = 13,5 V; other inputs 0 V
at other G inputs	I_{GH}	–	–	1	μA		
Input LOW: $G_2;G_3;G_9;G_{10}$	$-I_{GL}$	–	1,0	2,5	mA	13,5	V_{GL} = 1,7 V; other inputs 13,5V
at other G inputs	$-I_{GL}$	–	0,5	1,25	mA		
Output HIGH	$-I_{QH}$	0,1	–	–	mA	11,4	V_{GL} = 4,5 V; V_{QH} = 10 V
Output LOW	I_{QL}	30	–	–	mA	11,4	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2])	$-I_{Qsc}$	10	30	50	mA	13,5	V_G = 0 V; V_Q = 0 V
Supply data							
Currents							
at V_{QH}	I_P	–	14,0	22,0	mA	13,5	V_G = 0 V
at V_{QL}	I_P	–	8,0	15,0	mA	13,5	V_{G11} = V_{GL}; other G inputs: V_{GH}

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.
[2]) Short-circuit duration max. 1 s.

CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ.[1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	13,5	V_{QL} = max. 1,7 V; I_{QL} = 36 mA
Input LOW	V_{GL}	–	–	4,5	V	13,5	V_{QH} = min. 12 V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	12,0	14,3	–	V	13,5	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1,0	1,7	V	13,5	V_{GH} = 7,5 V; I_{QL} = 36 mA
D.C. noise margin: HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents							
Input HIGH: $G_2;G_3;G_9;G_{10}$	I_{GH}	–	–	2,0	μA	17	V_{GH} = 17 V; other inputs 0 V
at other G inputs	I_{GH}	–	–	1,0	μA		
Input LOW: $G_2;G_3;G_9;G_{10}$	$-I_{GL}$	–	1,2	3,0	mA	17	V_{GL} = 1,7 V; other inputs 17 V
at other G inputs	$-I_{GL}$	–	0,6	1,5	mA		
Output HIGH	$-I_{QH}$	0,1	–	–	mA	13,5	V_{GL} = 4,5 V; V_{QH} = 12 V
Output LOW	I_{QL}	30	–	–	mA	13,5	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2]	$-I_{Qsc}$	15	37	60	mA	17	V_G = 0 V; V_Q = 0 V
Supply data							
Currents							
at V_{QH}	I_P	–	18	29	mA	17	V_G = 0 V
at V_{QL}	I_P	–	12	21	mA	17	$V_{G11} = V_{GL}$; other G inputs: V_{GH}

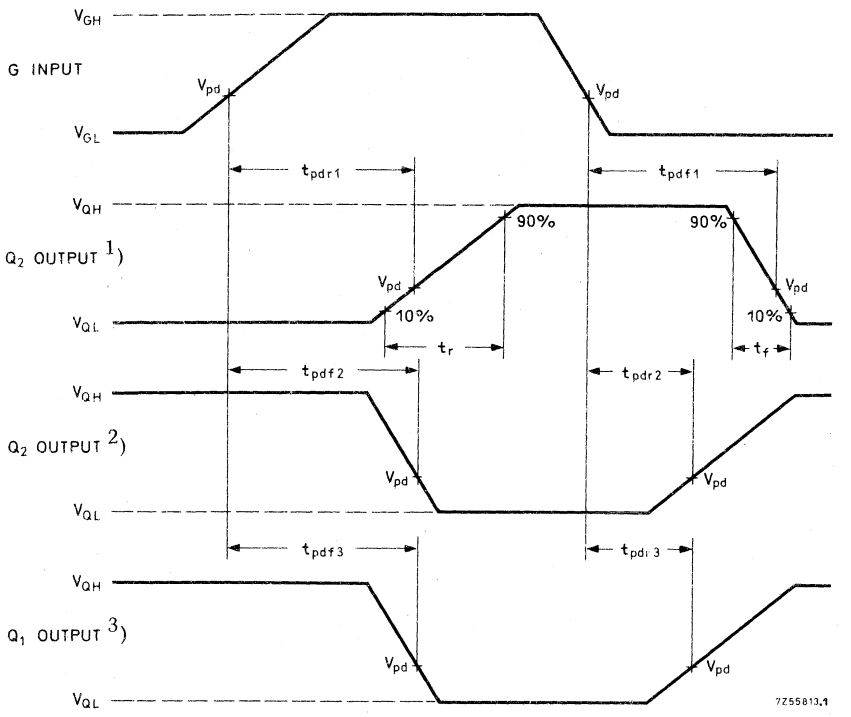
[1] All typical values under test condiotions: T_{amb} = 25 °C and V_P = 15 V.
[2] Short-circuit duration max. 1 s.

CHARACTERISTICS (continued)

	Sym-bol	min.	typ.[1]	max.		Conditions and references	
						V_P (V)	
Dynamic data							
Times							
Propagation delay							
fall times at output Q	t_{pdf1}	–	230	–	ns	12	C_L = 10 pF N = 1 T_{amb} = 25 °C V_{pd} = 4,5 V
at output $\overline{Q}$	t_{pdf2}	–	300	–	ns	12	
at input G_5	t_{pdf3}	–	400	–	ns	12	
rise times at output Q	t_{pdr1}	–	340	–	ns	12	
at output $\overline{Q}$	t_{pdr2}	–	340	–	ns	12	
at input G_5	t_{pdr3}	–	270	–	ns	12	
Output rise time	t_r	–	330	–	ns	12	
Output fall time	t_f	–	200	–	ns	12	

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

CHARACTERISTICS (continued)



Waveforms illustrating measurement of t_{pdr} and t_{pdf}

1) If G input = G_7, G_8, G_{11}.

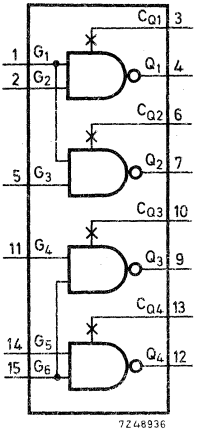
2) If G input = G_6.

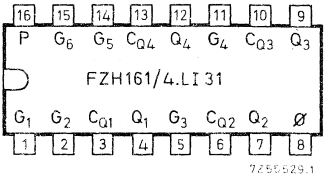
3) If G input = G_5.

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

QUADRUPLE LOGIC INTERFACE GATE

HNIL to 5 V logic; with slow-down capability



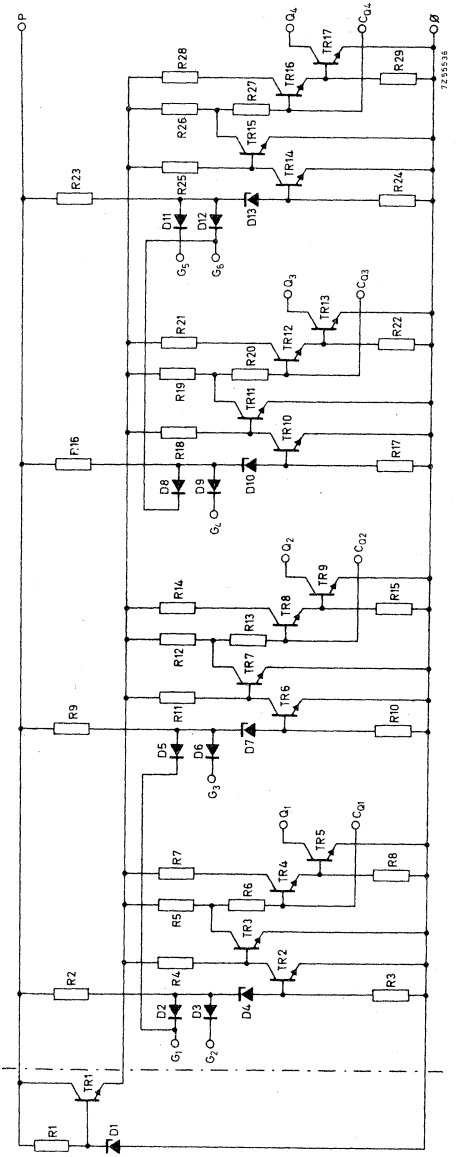


QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}	0 to +70		°C
Average propagation delay				
V_P = 12 V; N = 1 ; V_Q = 12 V	t_{pd1}	typ.	115	ns
V_{pd} = 4,5 V; T_{amb} = 25 °C ; V_Q = 5 V	t_{pd2}	typ.	105	ns
D.C. noise margin at T_{amb} = 25 °C				
range I : V_P = 12 V	$M_L = M_H$	typ.	5	V
range II: V_P = 15 V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at T_{amb} = 25 °C				
(50% duty cycle) range I : V_P = 12 V	P_{av}	typ.	39	mW
range II: V_P = 15 V	P_{av}	typ.	55	mW

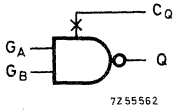
The FZH161/4. LI31 is a level converter with open-collector outputs for HNIL to TTL and consists of 4 gates and some common inputs.
Each gate has slow-down capability.

PACKAGE OUTLINE 16 leads plastic dual in-line (see general section).

CIRCUIT DIAGRAM



LOGIC FUNCTION



$Q = \overline{G_A \cdot G_B}$

(for positive logic)

Function table

G_A	G_B	Q
L	X	H
X	L	H
H	H	L

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage (HIGH state)	V_Q	max.	V_P	
Input voltage	V_G	max.	18	V
Input current at V_P = 17 V	$-I_{GL}$	max.	25	mA
Voltage difference between any two inputs		max.	18	V
Slow-down input voltage	$+V_{CQ}$	max.	0,6	V
	$-V_{CQ}$	max.	1,0	V
Slow-down input current	$+I_{CQ}$	max.	2,0	mA
	$-I_{CQ}$	max.	10,0	mA
Storage temperature	T_{stg}	-65 to +150		°C
Operating ambient temperature	T_{amb}	0 to + 70		°C

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}		0 to +70	°C
Uniform system supply voltage (range I)	V_P		11,4 to 13,5	V
(range II)	V_P		13,5 to 17	V
Available output current	I_{QL}	min.	20	mA
	I_{QH}	max.	50	µA
D.C. noise margin; range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Supply current per gate: range I; output HIGH	I_{Pav}	typ.	2,5	mA
output LOW	I_{Pav}	typ.	4,0	mA
range II; output HIGH	I_{Pav}	typ.	2,8	mA
output LOW	I_{Pav}	typ.	4,5	mA
Power consumption per gate (50% duty cycle) at range I; V_{Pmax}	P_{tot}	max.	71	mW
at range II; V_{Pmax}	P_{tot}	max.	98	mW
Average propagation delay at V_{pd1} = 4,5 V; (V_Q = 12 V)	t_{pd1}	max.	275	ns
at V_{pd2} = 1,5 V; (V_Q = 5 V)	t_{pd2}	max.	275	ns
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C.

	Sym-bol	min.	typ. [1])	max.	Conditions and references: V_P (V)	
Static data						
Voltages						
Input HIGH	V_{GH}	7,5	–	– V	11,4	V_{QL} = 0,4 V; I_{QL} = 20 mA
Input LOW	V_{GL}	–	–	4,5 V	11,4	V_{QH} = 13,5 V; I_{QH} = 40 µA
Output LOW	V_{QL}	–	–	0,4 V	11,4	V_{GH} = 7,5 V; I_{QL} = 20 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	–	11,4	
LOW	M_L	2,8	5,0	–	11,4	
Currents (per gate)						
Input HIGH; G_2; G_3; G_4; G_5	I_{GH}	–	–	1,0 µA	13,5	V_{GH} = 13,5 V; other inputs 0V
G_1; G_6	I_{GH}	–	–	2,0 µA		
Input LOW; G_2;G_3; G_4; G_5	$-I_{GL}$	–	0,8	1,5 mA	13,5	V_{GL} = 1,7 V; other inputs 13,5V
G_1; G_6	$-I_{GL}$	–	1,6	3,0 mA		
Output HIGH	I_{QH}	–	–	80 µA	11,4	V_{QH} = 13,5 V; V_{GH} = 4,5 V
Output LOW	I_{QL}	20	–	– mA	11,4	V_{QL} = 0,4 V; V_{GH} = 7,5 V
Supply data						
Currents (per gate)						
at V_{QH}	I_P	–	2,5	4,5 mA	13,5	V_G = 0 V
at V_{QL}	I_P	–	4,0	6,0 mA	13,5	V_G = 13,5 V
Dynamic data						
Times						
Propagation delay						
fall time: V_Q = 12 V	t_{pdf1}	–	100	250 ns		R_L =390 Ω; N = 1; T_{amb} = 25 °C
V_Q = 5 V	t_{pdf2}	–	90	250 ns		
rise time: V_Q = 12 V	t_{pdr1}	–	130	300 ns		R_L =3,9kΩ; N = 1; T_{amb} = 25 °C
V_Q = 5 V	t_{pdr2}	–	120	300 ns		

[1]) All typ. values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ. [1])	max.		Conditions and references V_P (V)	
Static data							
Input HIGH	V_{GH}	7,5	–	–	V	13,5	V_{QL} = 0,4 V; I_{QL} = 20 mA
Input LOW	V_{GL}	–	–	4,5	V	13,5	V_{QH} = 17 V; I_{QH} = 40 µA
Output LOW	V_{QL}	–	–	0,4	V	13,5	V_{GH} = 7,5 V; I_{QL} = 20 mA
D.C. noise margin: HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents (per gate)							
Input HIGH: G_2;G_3;G_4;G_5	I_{GH}	–	–	1,0	µA	17	V_{GH} = 17 V; other inputs 0 V
G_1;G_6	I_{GH}	–	–	2,0	µA		
Input LOW: G_2;G_3;G_4;G_5	$-I_{GL}$	–	1,0	1,8	mA	17	V_{GL} = 1,7 V; other inputs 17V
G_1;G_6	$-I_{GL}$	–	2,0	3,6	mA		
Output HIGH	I_{QH}	–	–	80	µA	13,5	V_{QH} = 17 V; V_{GL} = 4,5 V
Output LOW	I_{QL}	20	–	–	mA	13,5	V_{QL} = 0,4 V; V_{GL} = 7,5 V
Supply data							
Currents (per gate)							
at V_{QH}	I_P	–	2,8	4,5	mA	17	V_G = 0 V
at V_{QL}	I_P	–	4,5	7,0	mA	17	V_G = 17 V

[1]) All typ. values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

CHARACTERISTICS (continued)

Calculation of collector resistor R_Q

The collector resistor R_Q has to be calculated from voltages and input- and output currents of the gates.

$$R_{Qmax} = \frac{V_P - V_{QH} \quad (V)}{m \cdot I_{QH} + N \cdot I_{GH} \quad (\mu A)} \qquad R_{Qmin} = \frac{V_P - V_{QL} \quad (V)}{I_{QLmax} - N \cdot I_{GL} \quad (mA)}$$

m = number of interconnected outputs
N = number of used inputs
V_P = supply voltage of TTL-inputs
V_{QH} = output voltage HIGH of TTL-circuit
V_{QL} = output voltage LOW of TTL-circuit
I_{GH} = input current HIGH of TTL-circuit
I_{GL} = input current LOW of TTL-circuit

For interfacing HNIL to TTL:

$$R_{Qmax} = \frac{5 - 2,4 \quad (V)}{m \cdot 80 + N \cdot 80 \, (\mu A)} \qquad R_{Qmin} = \frac{5 - 0,4 \quad (V)}{20 - N \cdot 1,6 \quad (mA)}$$

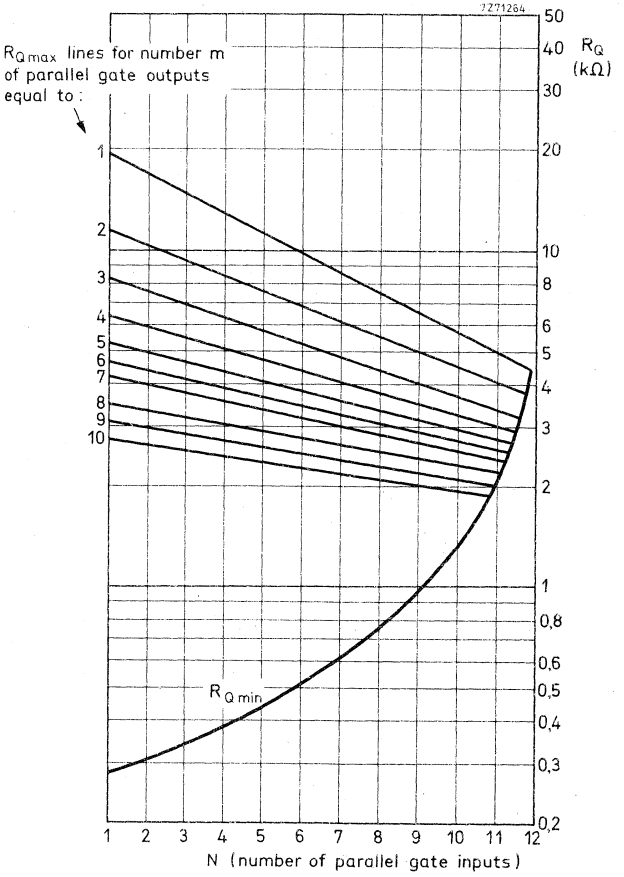
If FZH161/4. LI31 is used as wired-OR combination

for range I: $V_P = 12$ V

$$R_{Qmax} = \frac{12 - 10 \quad (V)}{m \cdot 80 + N \cdot 1 \, (\mu A)} \qquad R_{Qmin} = \frac{12 - 0,4 \quad (V)}{20 - N \cdot 1,5 \quad (mA)}$$

for range II: $V_P = 15$ V

$$R_{Qmax} = \frac{15 - 12 \quad (V)}{m \cdot 80 + N \cdot 1 \, (\mu A)} \qquad R_{Qmin} = \frac{15 - 0,4 \quad (V)}{20 - N \cdot 1,8 \quad (mA)}$$

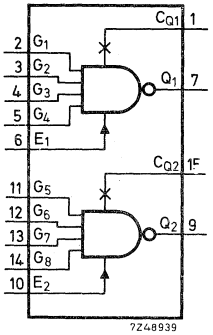


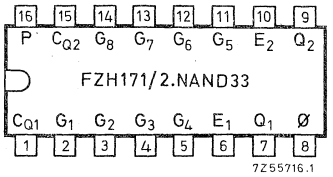
R_Q as a function of m and N loaded with TTL gates.

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

DUAL 4-INPUT NAND GATE

with slow-down capability and expandable inputs



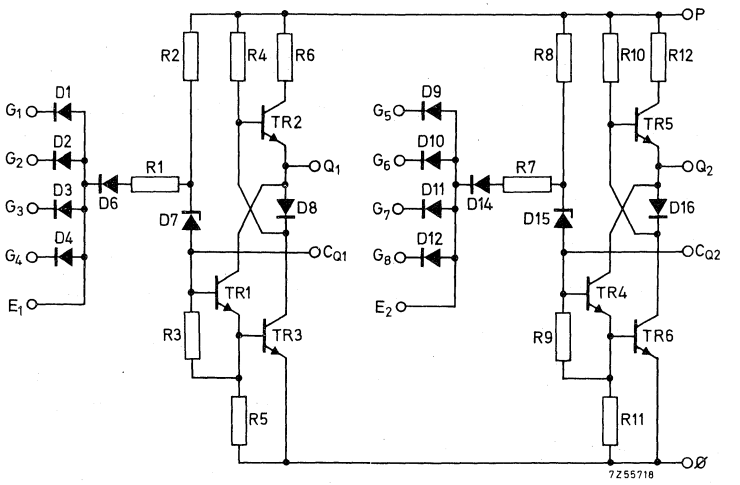


QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}	0 to +70		°C
Average propagation delay ($N = 1$; $C_L = 10$ pF; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V)	t_{pd}	typ.	170	ns
Available d.c. fan-out, $T_{amb} = 0$ to +70 °C } LOW state	N_{aL}	max.	10	
D.C. noise margin at $T_{amb} = 25$ °C				
range I : $V_P = 12$ V	$M_L = M_H$	typ.	5	V
range II: $V_P = 15$ V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at $T_{amb} = 25$ °C (50% duty cycle) range I : $V_P = 12$ V	P_{av}	typ.	16	mW
range II: $V_P = 15$ V	P_{av}	typ.	27	mW

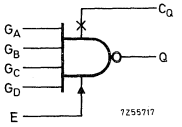
The FZH171/2.NAND33 consists of two independent NAND gates and each gate has a special terminal (C_Q). It is possible to connect a capacitor between the output (Q) and the corresponding slow-down terminal (C_Q) to increase the propagation delay.
Non-used expander inputs E_1 and E_2 must be left floating.

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAM



LOGIC FUNCTION



$$Q = \overline{G_A \cdot G_B \cdot G_C \cdot G_D \cdot E}\ ^{*})$$

(positive logic)

*) When provided with a diode

G_A	G_B	G_C	G_D	Q
L	X	X	X	H
X	L	X	X	H
X	X	L	X	H
X	X	X	L	H
H	H	H	H	L

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_G	max.	18	V
Input current at V_P = 17 V	$-I_{GL}$	max.	25	mA
Voltage difference between any two inputs		max.	18	V
Storage temperature	T_{stg}	−65 to	+150	°C
Operating ambient temperature	T_{amb}	0 to	+70	°C
Output short-circuit duration	t_{Qsc}	max.	1	s [1]
Slow-down input voltage	$+V_{CQ}$	max.	0,6	V
	$-V_{CQ}$	max.	1,0	V
Slow-down input current	$+I_{CQ}$	max.	2,0	mA
	$-I_{CQ}$	max.	10,0	mA
Expandable input voltage	V_E	min.	0	V
Expandable input current	$-I_E$	max.	25	mA

[1]) Only one output may be shorted at a time.

SYSTEM DESIGN DATA

Uniform system temperature		T_{amb}	0 to +70	°C
Uniform system supply voltage (range I)		V_P	11,4 to 13,5	V
	(range II)	V_P	13,5 to 17	V
Available d.c. fan-out		N_{aL}	max. 10	
		N_{aH}	max. 100	
D.C. noise margin; range I at V_{Pmin}		M_L	min. 2,8	V
		M_H	min. 2,5	V
	range II at V_{Pmin}	M_L	min. 2,8	V
		M_H	min. 4,5	V
Supply current per gate	range I; output HIGH	I_{Pav}	typ. 0,9	mA
	output LOW	I_{Pav}	typ. 1,7	mA
	range II; output HIGH	I_{Pav}	typ. 1,2	mA
	output LOW	I_{Pav}	typ. 2,3	mA
Power consumption per gate (50% duty cycle) at range I; V_{Pmax}		P_{tot}	max. 31	mW
	at range II; V_{Pmax}	P_{tot}	max. 52	mW
Thermal resistance from system to ambient		R_{th}	max. 150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ.[1])	max.		Conditions and references: V_P (V)	
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	11,4	$V_{QL} \leq 1,7$ V; I_{QL} = 15 mA
Input LOW	V_{GL}	–	–	4,5	V	11,4 and 13,5	$V_{QH} \geq 10$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	10,0	11,3	–	V	11,4 and 13,5	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	0,9	1,7	V	11,4	V_{GH} = 7,5 V; I_{QL} = 15 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	–	V	11,4	
LOW	M_L	2,8	5,0	–	V	11,4	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	µA	13,5	V_{GH} = 13,5 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	0,8	1,5	mA	13,5	V_{GL} = 1,7 V; other inputs 13,5 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	11,4 and 13,5	V_{GL} = 4,5 V; V_{QH} = 10 V
Output LOW	I_{QL}	15	–	–	mA	11,4	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2])	$-I_{Qsc}$	10	30	50	mA	13,5	V_G = 0 V; V_Q = 0 V
Supply data							
Currents (per gate)							
at V_{QH}	I_P	–	0,9	1,6	mA	13,5	V_G = 0 V
at V_{QL}	I_P	–	1,7	3,0	mA	13,5	V_G = 13,5 V
Dynamic data							
Times							
Propagation delay							
fall time	t_{pdf}	90	175	310	ns	12	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_{pd} = 4,5 V
rise time	t_{pdr}	90	175	310	ns	12	
output rise time	t_r	200	340	570	ns	12	
output fall time	t_f	70	120	210	ns	12	

[1]) All typ. values under test conditions: T_{amb} = 25 °C and V_P = 12 V.
[2]) Short-circuit duration max. 1 s.

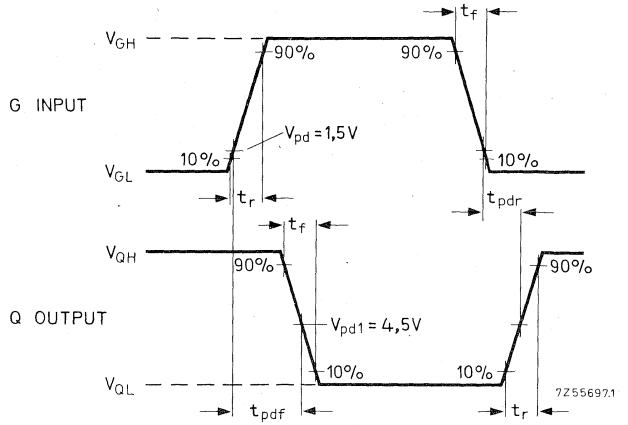
CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ.[1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	13,5	$V_{QL} \leq 1,7$ V; I_{QL} = 18 mA
Input LOW	V_{GL}	–	–	4,5	V	13,5 and 17	$V_{QH} \geq 12$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	12,0	14,3	–	V	13,5 and 17	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1,0	1,7	V	13,5	V_{GH} = 7,5 V; I_{QL} = 18 mA
D.C. noise margin: HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	µA	17	V_{GH} = 17 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	1,0	1,8	mA	17	V_{GL} = 1,7 V; other inputs 17 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	13,5 and 17	V_{GL} = 4,5 V; V_{QH} = 12 V
Output LOW	I_{QL}	18	–	–	mA	13,5	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2]	$-I_{Qsc}$	15	37	60	mA	17	V_G = 0 V; V_Q = 0 V
Supply data							
Currents (per gate)							
at V_{QH}	I_P	–	1,2	2,1	mA	17	V_G = 0 V
at V_{QL}	I_P	–	2,3	4,0	mA	17	V_G = 17 V
Dynamic data							
Times							
Propagation delay							
fall time	t_{pdf}	–	140	–	ns	15	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_{pd} = 4,5 V
rise time	t_{pdr}	–	195	–	ns	15	
output rise time	t_r	–	410	–	ns	15	
output fall time	t_f	–	75	–	ns	15	

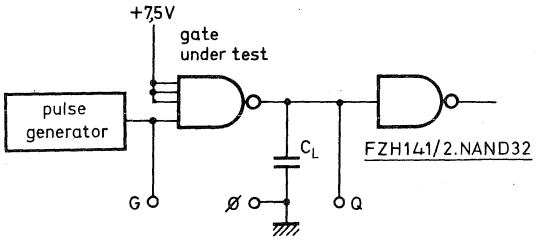
[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.
[2] Short-circuit duration max. 1 s.

CHARACTERISTICS (continued)

Dynamic data



Pulse generator (G-input): t_r = 350 ns V_{pd} = +4,5 V
t_f = 120 ns
t_{GH} = 1 µs



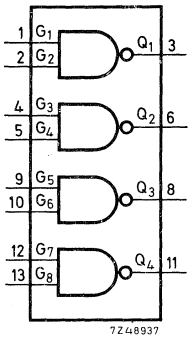
Measuring conditions: V_P = + 12 V; + 15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C
Slow-down terminals are not connected

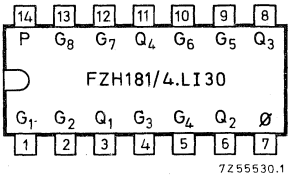
Waveforms and loading circuit illustrating measurement of t_{pdr} and t_{pdf}

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

QUADRUPLE LOGIC INTERFACE GATE

5 V logic to HNIL



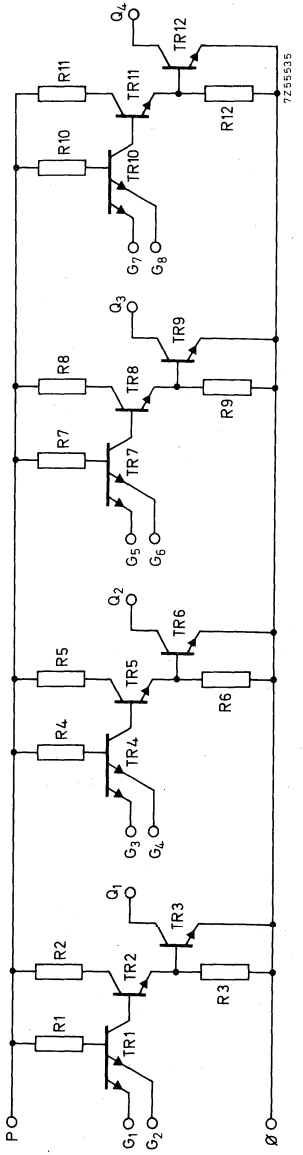


QUICK REFERENCE DATA				
Supply voltage	V_P		5±5%	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Available d.c. fan-out (T_{amb} = 0 to +70 °C) LOW state	N_{aL}	max.	27	
Power consumption per gate at T_{amb} = 25 °C (50% duty cycle)	P_{av}	typ.	24	mW

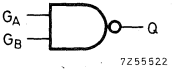
The FZH181/4. LI30 is a level converter with open-collector outputs for interfacing TTL to HNIL and consists of 4 gates.

PACKAGE OUTLINE 14 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAM



LOGIC FUNCTION



$Q = \overline{G_A \cdot G_B}$ (for positive logic)

Function table

G_A	G_B	Q
L	X	H
X	L	H
H	H	L

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	7	V
Output voltage	V_Q	max.	V_P	1)
Input voltage	V_G	max.	5,5	V
Input current (V_P = 5 V)	$-I_{GL}$	max.	25	mA
Voltage difference between any two inputs		max.	5,5	V
Storage temperature	T_{stg}	−65 to	+150	°C
Operating ambient temperature	T_{amb}	0 to	+70	°C

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}	0 to	+70	°C
Uniform system supply voltage	V_P	4,75 to	5,25	V
Available d.c. fan-out	N_a	max.	27	
D.C. noise margin	M	min.	0,4	V
Supply current per gate; output HIGH (V_P = 5 V; V_G = 0 V)	I_{Pav}	max.	2,0	mA
output LOW (V_P = 5 V; V_G = 5 V)	I_{Pav}	max.	12,0	mA
Power consumption per gate at V_{Pmax} (50% duty cycle)	P_{tot}	max.	37	mW
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

1) For HNIL.

CHARACTERISTICS Test conditions: V_P = 5 V; T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ. [1]	max.	Conditions and references: V_P (V)	Conditions and references:
Static data						
Voltages						
Input HIGH	V_{GH}	2,0	–	– V	4,75	V_{QL} = 1,0 V; I_{QL} = 50 mA
Input LOW	V_{GL}	–	–	0,8 V	4,75	V_{QH} = 18,0 V; I_{QH} = 250 µA
Output LOW	V_{QL}	–	–	0,4 V	4,75	V_{GH} = 2 V; I_{QL} = 16 mA
	V_{QL}	–	–	1,0 V	4,75	V_{GH} = 2 V; I_{QL} = 50 mA
D.C. noise margin: HIGH	M_H	0,4	–	– V		
LOW	M_L	0,4	–	– V		
Currents (per gate)						
Input HIGH	I_{GH}	–	–	40 µA	5,25	V_{GH} = 2,4 V
Input LOW	$-I_{GL}$	–	–	1,6 mA	5,25	V_{GL} = 0,4 V
Output HIGH	I_{QH}	–	–	250 µA	4,75	V_{QH} = 18 V; V_{GL} = 0,8 V
Output LOW	I_{QL}	50	–	– mA	4,75	V_{GH} = 2 V; V_{QL} = 1,0 V
Supply data						
Currents (per gate)						
at V_{QH}	I_P	–	1,0	2,0 mA	5	V_{GL} = 0 V
at V_{QL}	I_P	–	8,5	12,0 mA	5	V_{GH} = 5 V
Dynamic data						
Times						
Propagation						
fall time	t_{pdf}	–	20	60 ns	12	V_Q = 12 V; R_L = 390 Ω
rise time	t_{pdr}	–	130	300 ns	12	V_Q = 12 V; R_L = 3,9 kΩ

[1]) All typ. values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

CHARACTERISTICS (continued)

Calculation of collector resistor R_Q

The collector resistor R_Q has to be calculated from voltages and input - and output currents of the gates.

$$R_{Qmax} = \frac{V_P - V_{QH} \quad (V)}{m \cdot I_{QH} + N \cdot I_{GH} \quad (\mu A)} \qquad R_{Qmin} = \frac{V_P - V_{QL} \quad (V)}{I_{QLmax} - N \cdot I_{GL} \quad (mA)}$$

m = number of interconnected outputs
N = number of used inputs
V_P = supply voltage of HNIL inputs
V_{QH} = output voltage HIGH of HNIL-circuit
V_{QL} = output voltage LOW of HNIL-circuit
I_{GH} = input current HIGH of HNIL-circuit
I_{GL} = input current LOW of HNIL-circuit

For interfacing TTL to HNIL (range I; V_P = 12 V)

$$R_{Qmax} = \frac{12 - 10 \quad (V)}{m \cdot 250 + N \cdot 1 \quad (\mu A)} \qquad R_{Qmin} = \frac{12 - 1,0 \quad (V)}{50 - N \cdot 1,5 \quad (mA)}$$

For interfacing TTL to HNIL (range II; V_P = 15 V)

$$R_{Qmax} = \frac{15 - 12 \quad (V)}{m \cdot 250 - N \cdot 1 \ (\mu A)} \qquad R_{Qmin} = \frac{15 - 1,0 \quad (V)}{50 - N \cdot 1,8 \quad (mA)}$$

If FZH181/4. LI30 is used as wired-OR combination

HIGH state

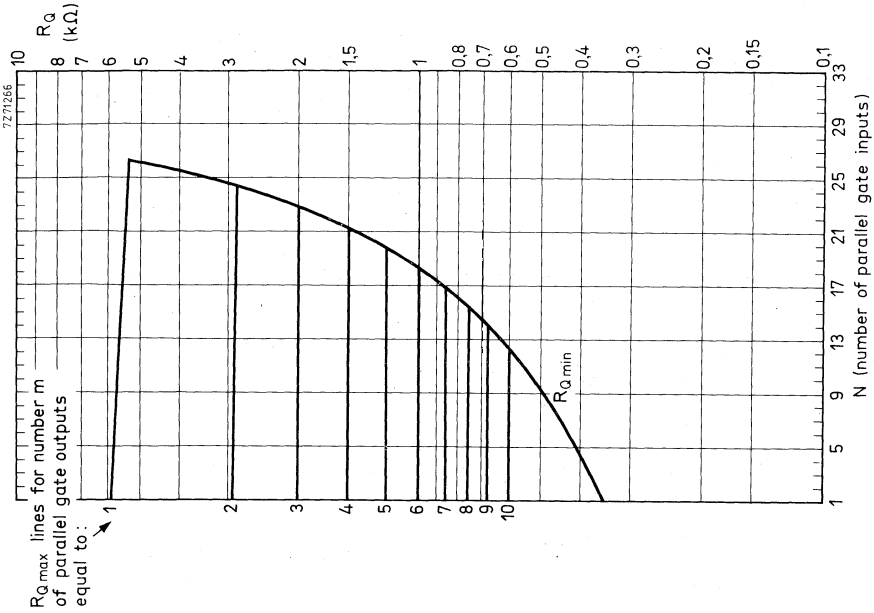
$$R_{Qmax} = \frac{V_P - 2,4 \quad (V)}{m \cdot 250 - N \cdot 40 \ (\mu A)}$$

LOW state

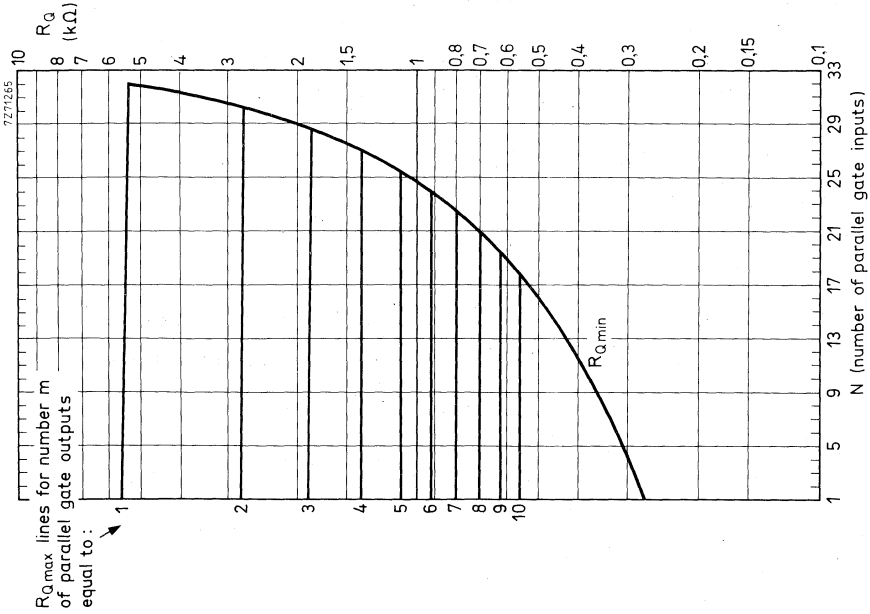
$$R_{Qmin} = \frac{V_P - 0,4 \quad (V)}{16 - N \cdot 1,6 \quad (mA)}$$

of which m = number of FZH181/4. LI30 OR combinations

N = number of used inputs



R_Q as a function of m and N at V_P = 15 V (range II).

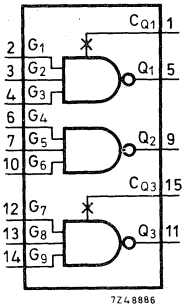


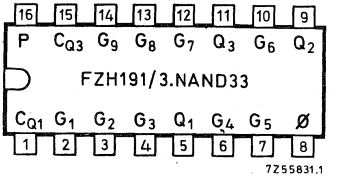
R_Q as a function of m and N at V_P = 12 V (range I).

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

TRIPLE 3-INPUT NAND GATE

with slow-down capability



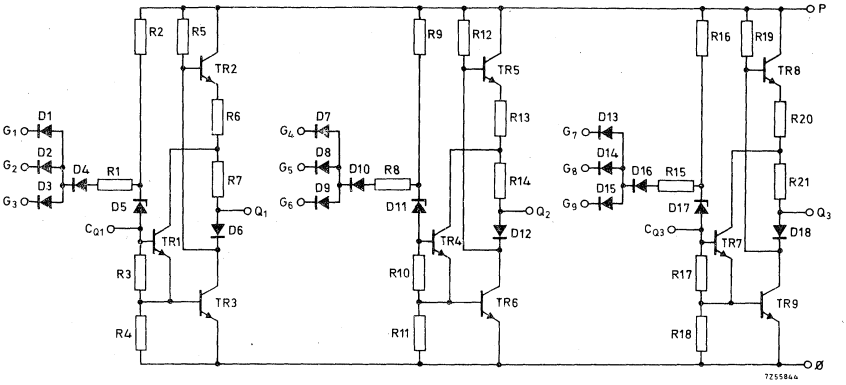


QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}	0 to +70		°C
Average propagation delay ($N = 1$; $C_L = 10$ pF; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V)	t_{pd}	typ.	170	ns
Available d.c. fan-out, $T_{amb} = 0$ to +70 °C } LOW state	N_{aL}	max.	10	
D.C. noise margin at $T_{amb} = 25$ °C				
range I : $V_P = 12$ V	$M_L = M_H$	typ.	5	V
range II: $V_P = 15$ V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at $T_{amb} = 25$ °C (50% duty cycle) range I : $V_P = 12$ V	P_{av}	typ.	16	mW
range II: $V_P = 15$ V	P_{av}	typ.	27	mW

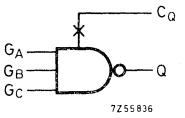
The FZH191/3.NAND33 consists of a number of independent NAND gates at which two NAND gates have a special terminal (C_Q). It is possible to connect a capacitor between the output (Q) and the corresponding slow-down terminal (C_Q) to increase the propagation delay.

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAM



LOGIC FUNCTION



$Q = \overline{G_A . G_B . G_C}$
(positive logic)

Function table

G_A	G_B	G_C	Q
L	X	X	H
X	L	X	H
X	X	L	H
H	H	H	L

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_G	max.	18	V
Input current at V_P = 17 V	$-I_{GL}$	max.	25	mA
Voltage difference between any two inputs		max.	18	V
Storage temperature	T_{stg}	−65 to +150		°C
Operating ambient temperature	T_{amb}	0 to +70		°C
Output short-circuit duration	t_{Qsc}	max.	1	s [1]
Slow-down input voltage	$+V_{CQ}$	max.	0,6	V
	$-V_{CQ}$	max.	1,0	V
Slow-down input current	$+I_{CQ}$	max.	2,0	mA
	$-I_{CQ}$	max.	10,0	mA

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}	0 to +70		°C
Uniform system supply voltage (range I)	V_P	11,4 to 13,5		V
(range II)	V_P	13,5 to	17	V
Available d.c. fan-out	N_{aL}	max.	10	
	N_{aH}	max.	100	
D.C. noise margin; range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Supply current at range I ; output HIGH	I_{Pav}	typ.	0,9	mA
output LOW	I_{Pav}	typ.	1,7	mA
at range II ; output HIGH	I_{Pav}	typ.	1,2	mA
output LOW	I_{Pav}	typ.	2,3	mA
Power consumption per gate (50% duty cycle) at range I ; V_{Pmax}	P_{tot}	max.	31	mW
at range II ; V_{Pmax}	P_{tot}	max.	52	mW
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

[1]) Only one output may be shorted at a time.

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ.[1]	max.	Conditions and references: V_P (V)	Conditions and references
Static data						
Voltages						
Input HIGH	V_{GH}	7,5	–	– V	11,4	$V_{QL} \leqslant 1,7$ V; I_{QL} = 15 mA
Input LOW	V_{GL}	–	–	4,5 V	11,4 and 13,5	$V_{QH} \geqslant 10$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	10,0	11,3	– V	11,4 and 13,5	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	0,9	1,7 V	11,4	V_{GH} = 7,5 V; I_{QL} = 15 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	– V	11,4	
LOW	M_L	2,8	5,0	– V	11,4	
Currents (per gate)						
Input HIGH	I_{GH}	–	–	1,0 μA	13,5	V_{GH} = 13,5 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	0,8	1,5 mA	13,5	V_{GL} = 1,7 V; other inputs 13,5 V
Output HIGH	$-I_{QH}$	0,1	–	– mA	11,4 and 13,5	V_{GL} = 4,5 V; V_{QH} = 10 V
Output LOW	I_{QL}	15	–	– mA	11,4	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25 mA	13,5	V_G = 0 V; V_Q = 0 V
Supply data						
Currents (per gate)						
at V_{QH}	I_P	–	0,9	1,6 mA	13,5	V_G = 0 V
at V_{QL}	I_P	–	1,7	3,0 mA	13,5	V_G = 13,5 V
Dynamic data						
Times						
Propagation delay						
fall time	t_{pdf}	90	175	310 ns	12	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_{pd} = 4,5 V
rise time	t_{pdr}	90	175	310 ns	12	
output rise time	t_r	200	340	570 ns	12	
output fall time	t_f	70	120	210 ns	12	

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

[2]) Short-circuited duration max. 1 s.

CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

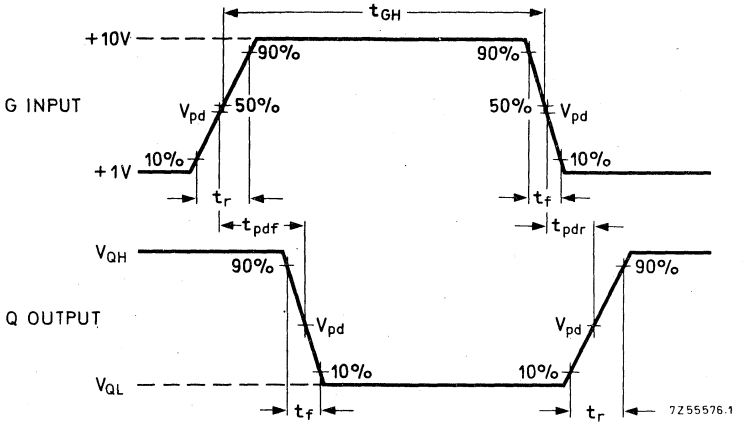
	Sym-bol	min.	typ.[1]	max.	Conditions and references: V_P (V)	Conditions and references
Static data						
Voltages						
Input HIGH	V_{GH}	7,5	–	– V	13,5	$V_{QL} \leqslant 1,7$ V; I_{QL} = 18 mA
Input LOW	V_{GL}	–	–	4,5 V	13,5 and 17	$V_{QH} \geqslant 12$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	12,0	14,3	– V	13,5 and 17	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1,0	1,7 V	13,5	V_{GH} = 7,5 V; I_{QL} = 18 mA
D.C. noise margin: HIGH	M_H	4,5	8,0	– V	13,5	
LOW	M_L	2,8	5,0	– V	13,5	
Currents (per gate)						
Input HIGH	I_{GH}	–	–	1,0 μA	17	V_{GH} = 17 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	1,0	1,8 mA	17	V_{GL} = 1,7 V; other inputs 17 V
Output HIGH	$-I_{QH}$	0,1	–	– mA	13,5 and 17	V_{GL} = 4,5 V; V_{QH} = 12 V
Output LOW	I_{QL}	18	–	– mA	13,5	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25 mA	17	V_G = 0 V; V_Q = 0 V
Supply data						
Currents (per gate)						
at V_{QH}	I_P	–	1,2	2,1 mA	17	V_G = 0 V
at V_{QL}	I_P	–	2,3	4,0 mA	17	V_G = 17 V
Dynamic data						
Times						
Propagation delay fall time	t_{pdf}	–	140	– ns	15	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_{dp} = 4,5 V
rise time	t_{pdr}	–	195	– ns	15	
output rise time	t_r	–	410	– ns	15	
output fall time	t_f	–	75	– ns	15	

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

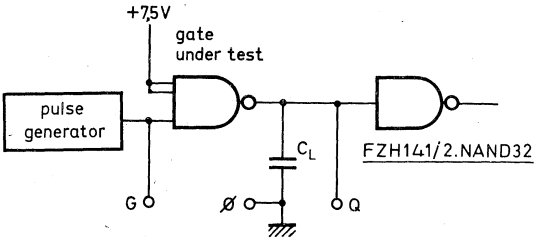
[2]) Short-circuited duration max. 1 s.

CHARACTERISTICS (continued)

Dynamic data



Pulse generator (G-input): t_r = 350 ns V_{pd} = + 4,5 V
t_f = 120 ns
tGH = 1 µs

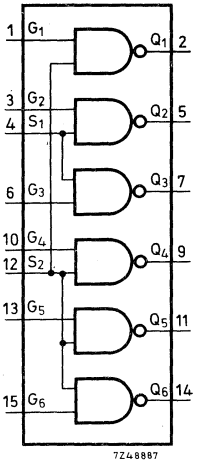


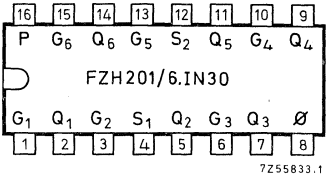
Measuring conditions: V_P = + 12 V; + 15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C
Slow-down terminals are not connected

Waveforms and loading circuit illustrating measurement of t_{pdr} and t_{pdf}

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

SEXTUPLE INVERTER WITH STROBE INPUT



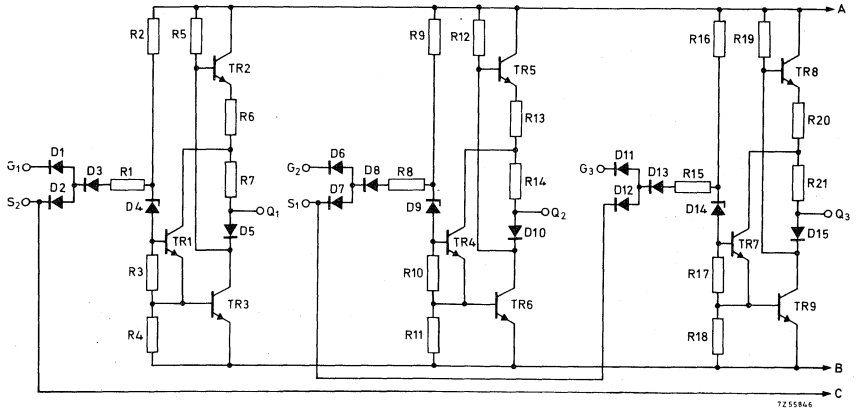


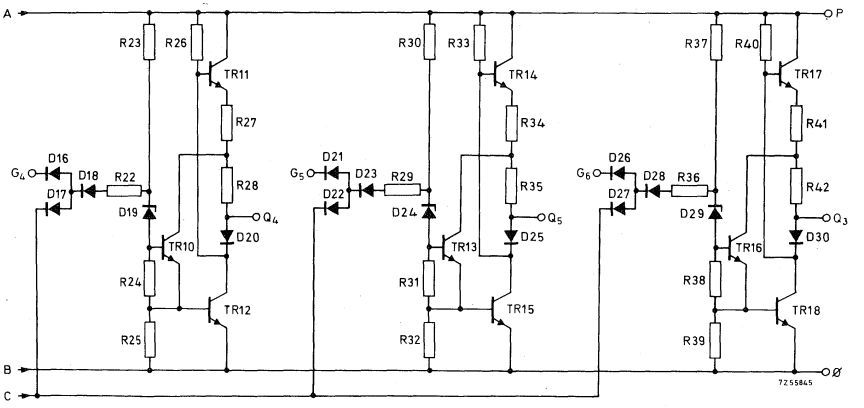
QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Average propagation delay time ($N = 1$; $C_L = 10$ pF; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V)	t_{pd}	typ.	170	ns
Available d.c. fan-out, $T_{amb} = 0$ to +70 °C; LOW state	N_{aL}	max.	10	
D.C. noise margin at $T_{amb} = 25$ °C				
range I : $V_P = 12$ V	$M_L = M_H$	typ.	5	V
range II: $V_P = 15$ V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at $T_{amb} = 25$ °C (50% duty cycle) range I : $V_P = 12$ V	P_{av}	typ.	16	mW
range II: $V_P = 15$ V	P_{av}	typ.	27	mW

The FZH201/6.IN30 consists of a number of independent inverters without slow-down capability, but with a common strobe input.

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAM





LOGIC FUNCTION

$Q = \overline{G_A \cdot S}$ (positive logic)

Function table

G_A	S	Q
L	X	H
X	L	H
H	H	L

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Supply voltage	V_P	max.		18	V
Output voltage	V_Q	max.		Vp	
Input voltage	V_G	max.		18	V
Input current at V_P = 17 V	$-I_{GL}$	max.		25	mA
Voltage difference between any two inputs		max.		18	V
Storage temperature	T_{stg}	−65	to	+150	°C
Operating ambient temperature	T_{amb}	0	to	+70	°C
Output short-circuit duration	t_{Qsc}	max.		1	s [1]

[1] Only one output may be shorted at a time.

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}	0 to +70		°C
Uniform system supply voltage (range I)	V_P	11,4 to 13,5		V
(range II)	V_P	13,5 to 17		V
Available d.c. fan-out	N_{aL}	max.	10	
	N_{aH}	max.	100	
D.C. noise margin; range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Supply current per gate; range I ; output HIGH	I_{Pav}	typ.	0,9	mA
output LOW	I_{Pav}	typ.	1,7	mA
range II; output HIGH	I_{Pav}	typ.	1,2	mA
output LOW	I_{Pav}	typ.	2,3	mA
Power consumption per gate (50% duty cycle) at range I ; V_{Pmax}	P_{tot}	max.	31	mW
at range II; V_{Pmax}	P_{tot}	max.	52	mW
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max.	Conditions and references: V_P (V)	Conditions and references
Static data						
Voltages						
Input HIGH	V_{GH}	7,5	–	– V	11,4	$V_{QL} \leqslant 1,7$ V; I_{QL} = 15 mA
Input LOW	V_{GL}	–	–	4,5 V	11,4 and 13,5	$V_{QH} \geqslant 10$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	10,0	11,3	– V	11,4 and 13,5	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	0,9	1,7 V	11,4	V_{GH} = 7,5 V; I_{QL} = 15 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	– V	11,4	
LOW	M_L	2,8	5,0	– V	11,4	
Currents (per gate)						
Input HIGH	I_{GH}	–	–	1,0 μA	13,5	V_{GH} = 13,5 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	0,8	1,5 mA	13,5	V_{GL} = 1,7 V; other inputs 13,5 V
Output HIGH	$-I_{QH}$	0,1	–	– mA	11,4 and 13,5	V_{GL} = 4,5 V; V_{QH} = 10 V
Output LOW	I_{QL}	15	–	– mA	11,4	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25 mA	13,5	V_G = 0 V; V_Q = 0 V
Supply data						
Currents (per gate)						
at V_{QH}	I_P	–	0,9	1,6 mA	13,5	V_G = 0 V
at V_{QL}	I_P	–	1,7	3,0 mA	13,5	V_G = 13,5 V
Dynamic data						
Times						
Propagation delay:						
fall time	t_{pdf}	90	175	310 ns	12	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_{pd} = 4,5 V
rise time	t_{pdr}	90	175	310 ns	12	
output rise time	t_r	200	340	570 ns	12	
output fall time	t_f	70	120	210 ns	12	

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

[2] Short-circuited duration max. 1 s.

CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

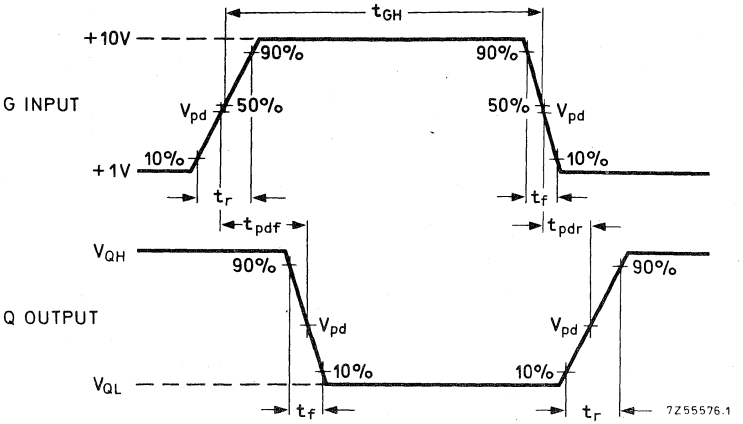
	Sym-bol	min.	typ.[1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	13,5	$V_{QL} \leq 1,7$ V; I_{QL} = 18 mA
Input LOW	V_{GL}	–	–	4,5	V	13,5 and 17	$V_{QH} \geq 12$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	12,0	14,3	–	V	13,5 and 17	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1,0	1,7	V	13,5	V_{GH} = 7,5 V; I_{QL} = 18 mA
D.C. noise margin: HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	μA	17	V_{GH} = 17 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	1,0	1,8	mA	17	V_{GL} = 1,7 V; other inputs 17 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	13,5 and 17	V_{GL} = 4,5 V; V_{QH} = 12 V
Output LOW	I_{QL}	18	–	–	mA	13,5	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25	mA	17	V_G = 0 V; V_Q = 0 V
Dynamic data							
Currents (per gate)							
at V_{QH}	I_P	–	1,2	2,1	mA	17	V_G = 0 V
at V_{QL}	I_P	–	2,3	4,0	mA	17	V_G = 17 V
Supply data							
Times							
Propagation delay:							
fall time	t_{pdf}	–	140	–	ns	15	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_{pd} = 4,5 V
rise time	t_{pdr}	–	195	–	ns	15	
output rise time	t_r	–	410	–	ns	15	
output fall time	t_f	–	75	–	ns	15	

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

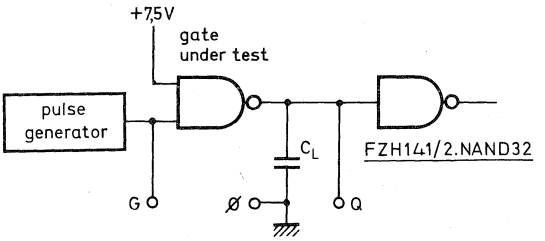
[2] Short-circuited duration max. 1 s.

CHARACTERISTICS (continued)

Dynamic data



Pulse generator (G-input): t_r = 350 ns V_{pd} = + 4,5 V
t_f = 120 ns
t_{GH} = 1 µs



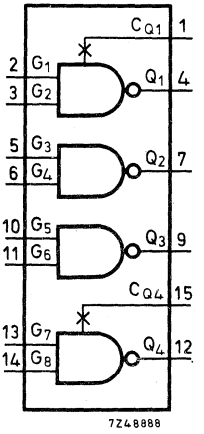
Measuring conditions: V_P = + 12 V; + 15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C

Waveforms and loading circuit illustrating measurement of t_{pdr} and t_{pdf}

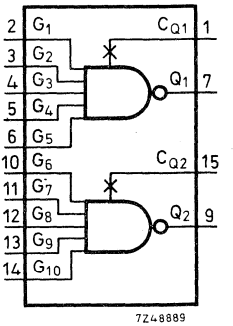
The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

QUADRUPLE 2-INPUT NAND GATE
DUAL 5-INPUT NAND GATE

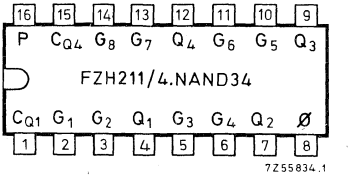
both having slow-down capability and open collector

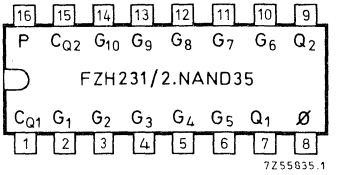


FZH211/4.NAND34



FZH231/2.NAND35





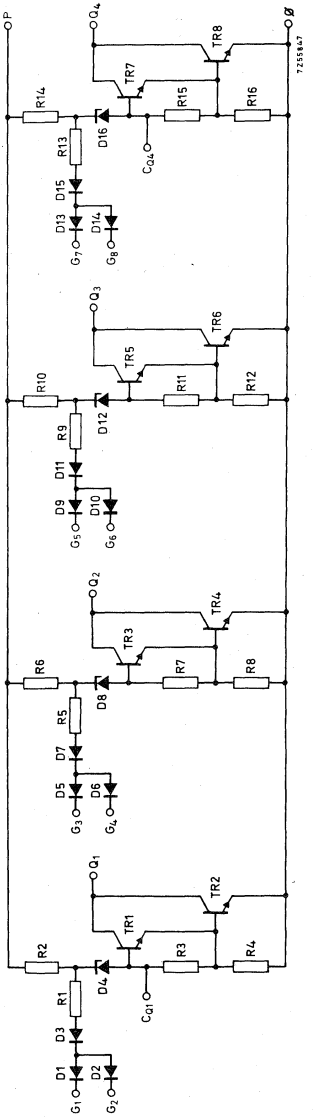
QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Available d.c. fan-out T_{amb} = 0 to +70 °C } LOW state	N_{aL}	max.	10	
D.C. noise margin at T_{amb} = 25 °C				
range I : V_P = 12 V	$M_L = M_H$	typ.	5	V
range II: V_P = 15 V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at T_{amb} = 25 °C				
(50% duty cycle) range I: V_P = 12 V	P_{av}	typ.	8,5	mW
range II: V_P = 15 V	P_{av}	typ.	15	mW

The FZH211/4.NAND34 and FZH231/2.NAND35 consist of a number of independent NAND gates with open collector and two gates of each circuit have a slow-down terminal. It is possible to connect a capacitor between the output Q and the corresponding slow-down terminal C_Q to increase the propagation delay.
The outputs of these gates may be interconnected to perform the AND-OR-NOT function.

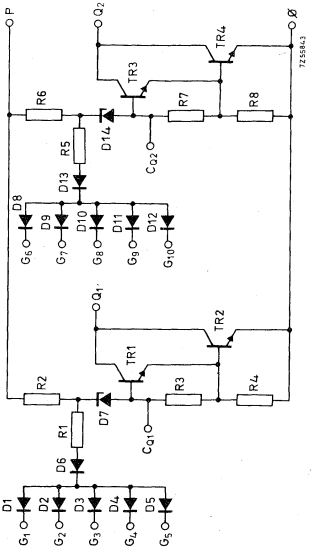
PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAMS

FZH211/4.NAND34



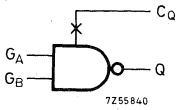
FZH231/2.NAND35



LOGIC FUNCTION

1. Individual gate operation

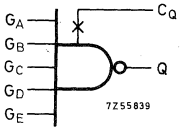
FZH211/4.NAND34



$$Q = \overline{G_A \cdot G_B}$$

(positive logic)

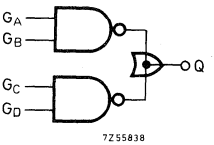
FZH231/2.NAND35



$$Q = \overline{G_A \cdot G_B \cdot G_C \cdot G_D \cdot G_E}$$

(positive logic)

2. Wired-OR combination



$$Q = \overline{(G_A \cdot G_B)} \cdot \overline{(G_C \cdot G_D)} = \overline{(G_A \cdot G_B) + (G_C \cdot G_D)}$$

(positive logic)

FUNCTION TABLES

G_A	G_B	Q
L	X	H
X	L	H
H	H	L

G_A	G_B	G_C	G_D	G_E	Q
L	X	X	X	X	H
X	L	X	X	X	H
X	X	L	X	X	H
X	X	X	L	X	H
X	X	X	X	L	H
H	H	H	H	H	L

G_A	G_B	G_C	G_D	Q
L	X	L	X	H
L	X	X	L	H
X	L	X	L	H
X	L	L	X	H
H	H	X	X	L
X	X	H	H	L

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_G	max.	18	V
Voltage difference between any two inputs		max.	18	V
Storage temperature	T_{stg}	−65 to +150		°C
Operating ambient temperature	T_{amb}	0 to +70		°C
Input current at V_P = 17 V	$-I_{GL}$	max.	25	mA
Slow-down input voltage	$+V_{CQ}$	max.	0,6	V
	$-V_{CQ}$	max.	1,0	V
Slow-down input current	$+I_{CQ}$	max.	2,0	mA
	$-I_{CQ}$	max.	10,0	mA

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}	0 to +70		°C
Uniform system supply voltage (range I)	V_P	11,4 to 13,5		V
(range II)	V_P	13,5 to 17		V
Available d.c. fan-out	N_{aL}	max.	10	
D.C. noise margin; range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Supply current per gate; range I; output HIGH	I_{Pav}	max.	2,1	mA
output LOW	I_{Pav}	max.	1,2	mA
range II; output HIGH	I_{Pav}	max.	2,1	mA
output LOW	I_{Pav}	max.	1,4	mA
Power consumption per gate (50% duty cycle) at range I; V_{Pmax}	P_{tot}	max.	18	mW
at range II; V_{Pmax}	P_{tot}	max.	30	mW
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ.[1])	max.	Conditions and references: V_P (V)	Conditions and references:
Static data						
Voltages						
Input HIGH	V_{GH}	7,5	–	– V	11,4	$V_{QL} \leq 1,7$ V; I_{QL} = 15 mA
Input LOW	V_{GL}	–	–	4,5 V	11,4 and 13,5	$V_{QH} \geq 10$ V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	0,9	1,7 V	11,4	V_{GH} = 7,5 V; I_{QL} = 15 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	– V	11,4	
LOW	M_L	2,8	5,0	– V	11,4	
Currents (per gate)						
Input HIGH	I_{GH}	–	–	1,0 µA	13,5	V_{GH} = 13,5 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	0,8	1,5 mA	13,5	V_{GL} = 1,7 V; other inputs 13,5 V
Output HIGH	I_{QH}	–	–	80 µA	11,4	V_{GL} = 4,5 V; V_{QH} = 18 V
Output LOW	I_{QL}	15	–	– mA	11,4	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Supply data						
Currents (per gate)						
at V_{QH}	I_P	–	1,0	1,7 mA	13,5	V_G = 0 V
at V_{QL}	I_P	–	0,4	1,0 mA	13,5	V_G = 13,5 V

[1]) All typ. values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ.[1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	13,5	$V_{QL} \leq 1,7$ V; I_{QL} = 18 mA
Input LOW	V_{GL}	–	–	4,5	V	13,5 and 17	$V_{QH} \geq 12$ V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1,0	1,7	V	13,5	V_{GH} = 7,5 V; I_{QL} = 18 mA
D.C. noise margin: HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	µA	17	V_{GH} = 17 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	1,0	1,8	mA	17	V_{GL} = 1,7 V; other inputs 17 V
Output HIGH	I_{QH}	–	–	80	µA	13,5	V_{GL} = 4,5 V; V_{QH} = 18 V
Output LOW	I_{QL}	18	–	–	mA	13,5	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Supply data							
Currents (per gate)							
at V_{QH}	I_P	–	1,3	2,1	mA	17	V_G = 0 V
at V_{QL}	I_P	–	0,7	1,4	mA	17	V_G = 17 V

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

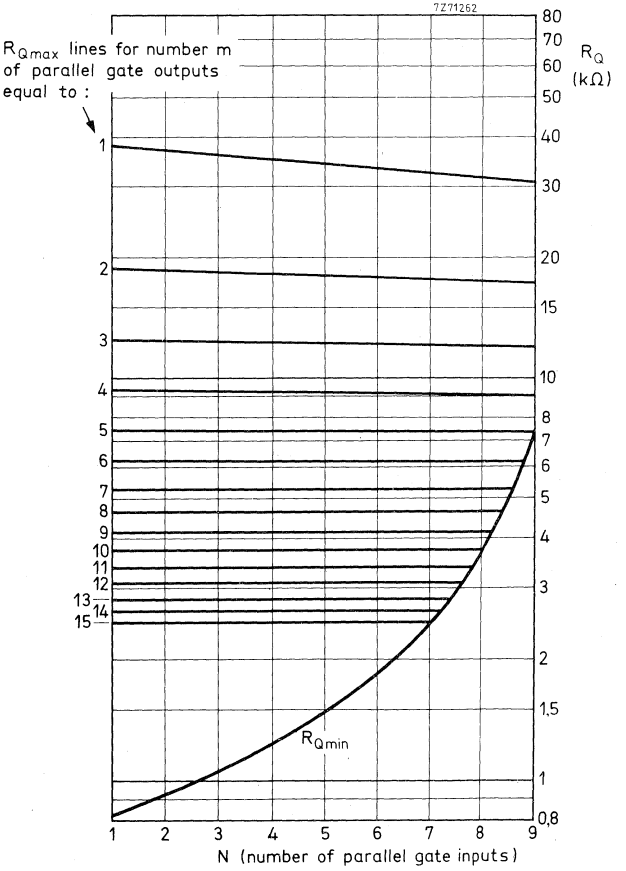
CHARACTERISTICS (continued)

Calculation of collector resistor R_Q

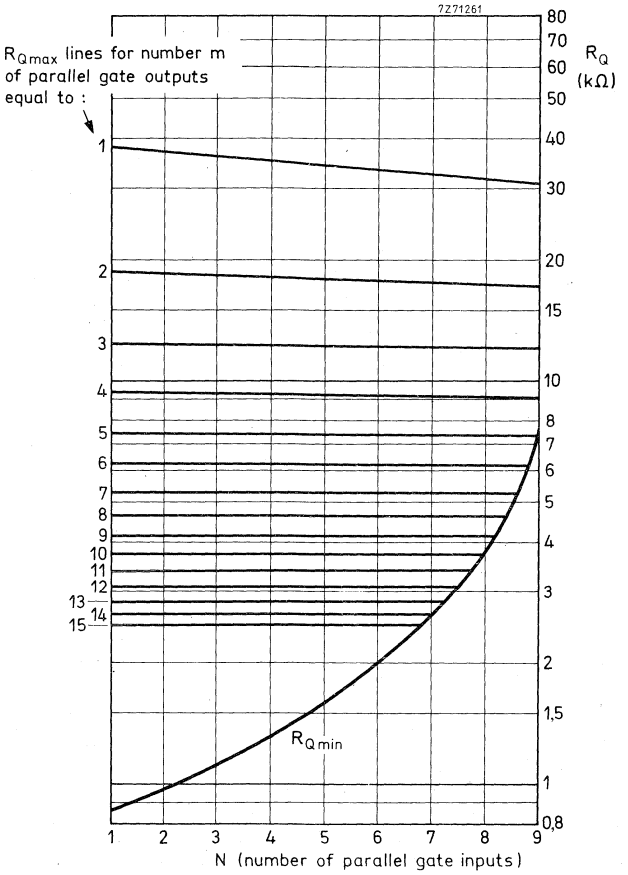
The collector resistor R_Q has to be calculated from voltages and input- and output currents of the gates.

$$R_{Qmax} = \frac{V_P - V_{QH} \quad (V)}{m \cdot I_{QH} + N \cdot I_{GH} \quad (\mu A)} \qquad R_{Qmin} = \frac{V_P - V_{QL} \quad (V)}{I_{QLmax} - N \cdot I_{GL} \quad (mA)}$$

m = number of interconnected outputs
N = number of used inputs
V_P = supply voltage of HNIL inputs
V_{QH} = output voltage HIGH of HNIL - circuit
V_{QL} = output voltage LOW of HNIL - circuit



R_Q as a function of m and N at V_P = 12 V (range I).

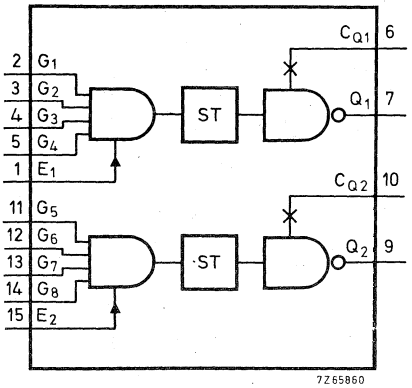


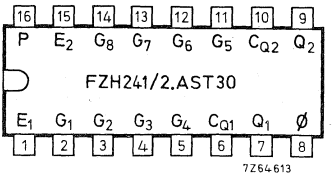
R_Q as a function of m and N at V_P = 15 V (range II).

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

DUAL 4-INPUT NAND SCHMITT TRIGGER

with slow-down capability and expandable inputs



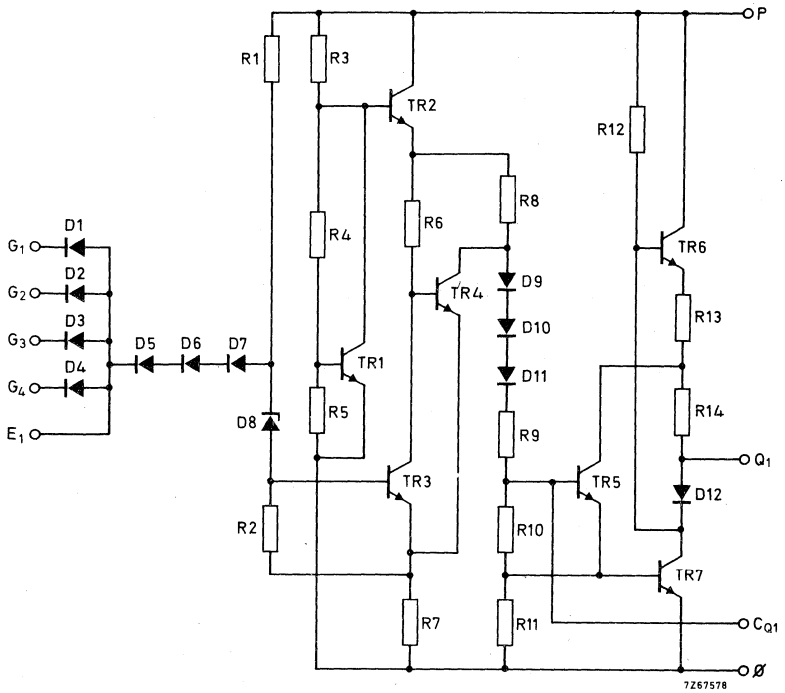


QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Available d.c. fan-out T_{amb} = 0 to +70 °C } LOW state	N_{aL}	max.	10	
D.C. noise margin at T_{amb} = 25 °C				
range I : V_P = 12 V	$M_L = M_H$	typ.	5	V
range II: V_P = 15 V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at T_{amb} = 25 °C (50% duty cycle) range I : V_P = 12 V	P_{av}	typ.	48	mW
range II: V_P = 15 V	P_{av}	typ.	72	mW

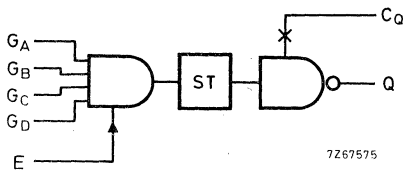
The FZH241/2.AST30 consists of two identical 4-input NAND SCHMITT triggers with slow-down capability and expandable inputs.
Each circuit functions as a 4-input NAND gate (without using the expandable input), but because of the SCHMITT action, the gate has different input threshold levels for positive- and negative-going signals. The hysteresis, which is the difference between the two threshold levels, is typically 900 mV.

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAM



LOGIC FUNCTION



$$Q = \overline{G_A \cdot G_B \cdot G_C \cdot G_D \cdot E}$$

FUNCTION TABLE

G_A	G_B	G_C	G_D	E	Q
L	X	X	X	X	H
X	L	X	X	X	H
X	X	L	X	X	H
X	X	X	L	X	H
X	X	X	X	L	H
H	H	H	H	H	L

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_G	max.	18	V
Input current at V_P = 17 V	$-I_{GL}$	max.	25	mA
Voltage difference between any two inputs		max.	18	V
Storage temperature	T_{stg}		−65 to +150	°C
Operating ambient temperature	T_{amb}		0 to +70	°C
Output short-circuit duration	t_{Qsc}	max.	1	s [1]
Slow-down input voltage	$+V_{CQ}$	max.	0,6	V
	$-V_{CQ}$	max.	1,0	V
Slow-down input current	$+I_{CQ}$	max.	2,0	mA
	$-I_{CQ}$	max.	10,0	mA

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}		0 to +70	°C
Uniform system supply voltage (range I)	V_P		11,4 to 13,5	V
(range II)	V_P		13,5 to 17	V
Available d.c. fan-out; LOW state	N_{aL}	max.	10	
HIGH state	N_{aH}	max.	100	
D.C. noise margin; range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Supply current per gate: range I : output HIGH	I_{Pav}	typ.	4,0	mA
output LOW	I_{Pav}	typ.	3,8	mA
range II: output HIGH	I_{Pav}	typ.	4,5	mA
output LOW	I_{Pav}	typ.	5,0	mA
Power consumption per gate (50% duty cycle) at range I ; V_{Pmax}	P_{tot}	max.	85	mW
at range II; V_{Pmax}	P_{tot}	max.	105	mW
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

[1]) Only one output may be shorted at a time.

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ.[1]	max.		Conditions and references	
						V_P (V)	
Static data							
Voltages							
Input HIGH	V_{GH}	8,0	–	–	V	11,4	$V_{QL} \leq 1,7$ V; I_{QL} = 15 mA
Input LOW	V_{GL}	–	–	5,0	V	11,4 and 13,5	$V_{QH} \geq 10$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	10,0	11,3	–	V	11,4 and 13,5	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1,0	1,7	V	11,4	V_{GH} = 8,0 V; I_{QL} = 15 mA
Positive-going threshold voltage	V_{TP}	–	7,1	–	V	12	
Negative-going threshold voltage	V_{TN}	–	6,2	–	V	12	
Hysteresis [2]	V_H	–	0,9	–	V	12	
D.C. noise margin: HIGH	M_H	2,5	5,0	–	V	11,4	
LOW	M_L	2,8	5,0	–	V	11,4	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	µA	13,5	V_{GH} = 13,5 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	–	1,5	mA	13,5	V_{GL} = 1,7 V; other inputs 13,5 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	11,4 and 13,5	V_{GL} = 5,0 V; V_{QH} = 10 V
Output LOW	I_{QL}	15	–	–	mA	11,4	V_{GH} = 8,0 V; V_{QL} = 1,7 V
Output short-circuited [3]	$-I_{Qsc}$	9	15	25	mA	13,5	V_G = 0 V; V_Q = 0 V
Supply data							
Currents (per gate)							
at V_{QH}	I_P	–	4,0	6,3	mA	13,5	V_G = 0 V
at V_{QL}	I_P	–	3,8	6,0	mA	13,5	V_G = 13,5 V

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.
[2] $V_H = V_{TP} - V_{TN}$.
[3] Short-circuit duration max. 1 s.

CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

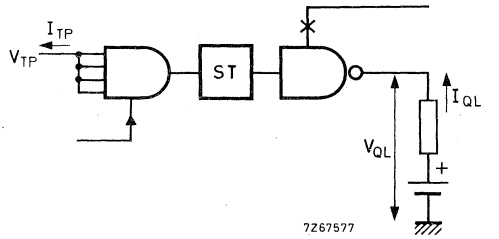
	Symbol	min.	typ. [1])	max.		Conditions and references	
						V_P (V)	
Static data							
Voltages							
Input HIGH	V_{GH}	8,0	–	–	V	13,5	$V_{QL} \leq 1,7$ V; I_{QL} = 18 mA
Input LOW	V_{GL}	–	–	5,0	V	13,5 and 17	$V_{QH} \geq 12$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	12,0	14,3	–	V	13,5 and 17	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1,1	1,7	V	13,5	V_{GH} = 8,0 V; I_{QL} = 18 mA
Positive-going threshold voltage	V_{TP}	–	7,05	–	V	15	
Negative-going threshold voltage	V_{TN}	–	6,15	–	V	15	
Hysteresis [2])	V_H	–	0,9	–	V	15	
D.C. noise margin: HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	μA	17	V_{GH} = 17 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	–	1,8	mA	17	V_{GL} = 1,7 V; other inputs 17 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	13,5 and 17	V_{GL} = 5,0 V; V_{QH} = 12 V
Output LOW	I_{QL}	18	–	–	mA	13,5	V_{GH} = 8,0 V; V_{QL} = 1,7 V
Output short-circuited [3])	$-I_{Qsc}$	9	15	25	mA	17	V_G = 0 V; V_Q = 0 V
Supply data							
Currents (per gate)							
at V_{QH}	I_P	–	4,5	7,3	mA	17	V_G = 0 V
at V_{QL}	I_P	–	5,0	8,0	mA	17	V_G = 17 V

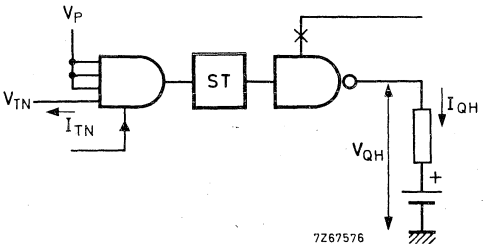
1) All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.
2) $V_H = V_{TP} - V_{TN}$.
3) Short-circuit duration max. 1 s.

CHARACTERISTICS

D.C. test circuit for V_{TP}, V_{TN} and V_H

conditions: V_P = 12 V (range I); ϕ to earth;
V_P = 15 V (range II); T_{amb} = 25 °C

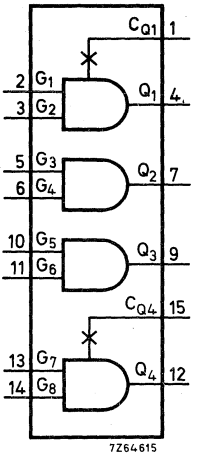


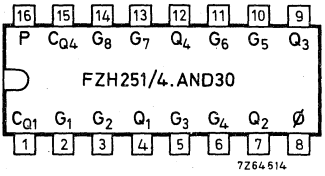


The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

QUADRUPLE 2—INPUT AND GATE

with slow-down capability



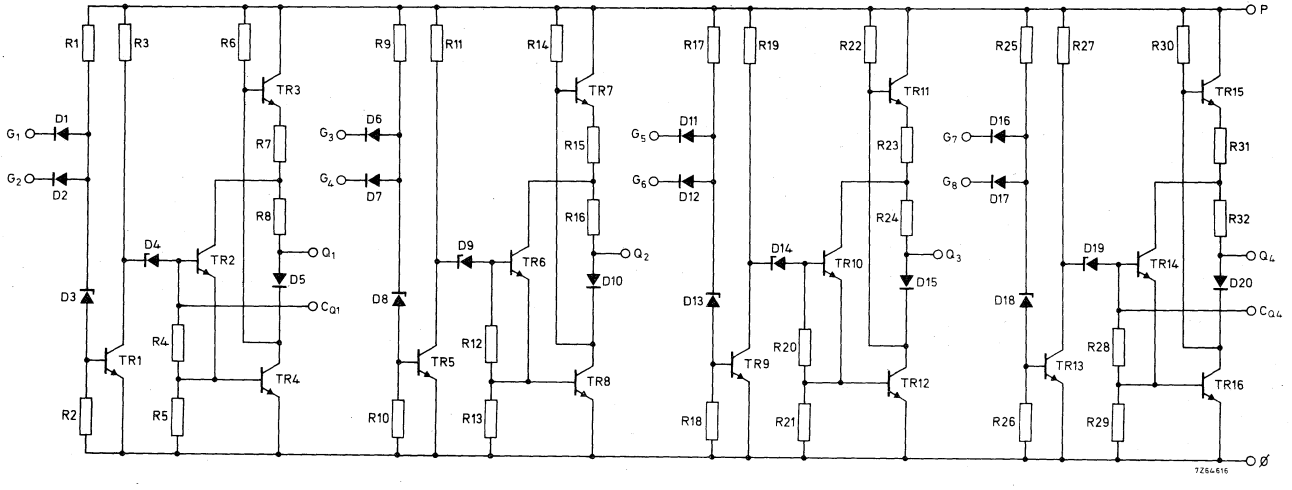


QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Average propagation delay N = 1; C_L = 10 pF; T_{amb} = 25 °C; V_{pd} = 4,5 V	t_{pd}	typ.	260	ns
Available d.c. fan-out T_{amb} = 0 to +70 °C } LOW state	N_{aL}	max.	10	
D.C. noise margin at T_{amb} = 25 °C				
range I : V_P = 12 V	$M_L = M_H$	typ.	5	V
range II: V_P = 15 V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at T_{amb} = 25 °C (50% duty cycle) range I : V_P = 12 V	P_{av}	typ.	24	mW
range II: V_P = 15 V	P_{av}	typ.	42,8	mW

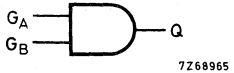
The FZH251/4.AND30 consists of four 2-input AND gates, two of which may be slowed down.

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAM



LOGIC FUNCTIONS



Function table

G_A	G_B	Q
L	X	L
X	L	L
H	H	H

$Q = G_A . G_B$ (positive logic)

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_G	max.	18	V
Input current at V_P = 17 V	$-I_{GL}$	max.	25	mA
Voltage difference between any two inputs		max.	18	V
Storage temperature	T_{stg}	−65 to +150		°C
Operating ambient temperature	T_{amb}	0 to +70		°C
Output short-circuit duration	t_{Qsc}	max.	1	s [1]
Slow-down input voltage	$+V_{CQ}$	max.	0,6	V
	$-V_{CQ}$	max.	1,0	V
Slow-down input current	$+I_{CQ}$	max.	2,0	mA
	$-I_{CQ}$	max.	10,0	mA

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}	0 to +70		°C
Uniform system supply voltage (range I)	V_P	11,4 to 13,5		V
(range II)	V_P	13,5 to	17	V
Available d.c. fan-out	N_{aL}	max.	10	
	N_{aH}	max.	100	
D.C. noise margin; range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Supply current per gate; range I; output HIGH	I_{Pav}	typ.	1,6	mA
output LOW	I_{Pav}	typ.	2,4	mA
range II; output HIGH	I_{Pav}	typ.	2,2	mA
output LOW	I_{Pav}	typ.	3,5	mA
Power consumption per gate (50% duty cycle) at range I ; V_{Pmax}	P_{tot}	max.	51,5	mW
at range II; V_{Pmax}	P_{tot}	max.	84	mW
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

[1]) Only one output may be shorted at a time.

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ. [1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	11,4	$V_{QL} \leq 1,7$ V; $I_{QL} = 15$ mA
Input LOW	V_{GL}	–	–	4,5	V	11,4 and 13,5	$V_{QH} \geq 10$ V; $-I_{QH} = 0,1$ mA
Output HIGH	V_{QH}	10,0	11,3	–	V	11,4 and 13,5	$V_{GL} = 4,5$ V; $-I_{QH} = 0,1$ mA
Output LOW	V_{QL}	–	0,9	1,7	V	11,4	$V_{GH} = 7,5$ V; $I_{QL} = 15$ mA
D.C. noise margin: HIGH	M_H	2,5	5,0	–	V	11,4	
LOW	M_L	2,8	5,0	–	V	11,4	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	µA	13,5	$V_{GH} = 13,5$ V; other inputs 0 V
Input LOW	$-I_{GL}$	–	0,8	1,5	mA	13,5	$V_{GL} = 1,7$ V; other inputs 13,5 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	11,4 and 13,5	$V_{GL} = 4,5$ V; $V_{QH} = 10$ V
Output LOW	I_{QL}	15	–	–	mA	11,4	$V_{GH} = 7,5$ V; $V_{QL} = 1,7$ V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25	mA	13,5	$V_G = 0$ V; $V_Q = 0$ V
Supply data							
Currents (per gate)							
at V_{QL}	I_P	–	3	4,5	mA	13,5	$V_G = 0$ V
Dynamic data							
Times							
Propagation delay							
fall time	t_{pdf}	90	175	310	ns	12	$C_L = 10$ pF; N = 1; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V
rise time	t_{pdr}	200	340	570	ns	12	
output rise time	t_r	200	340	570	ns	12	
output fall time	t_f	70	120	210	ns	12	

1) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.
2) Short-circuit duration max. 1 s.

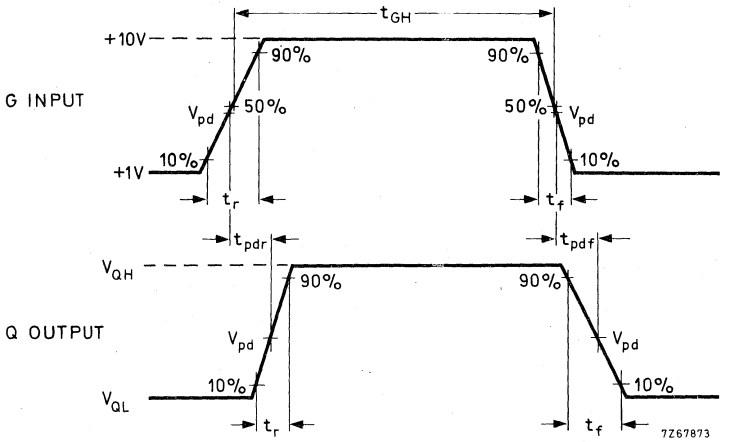
CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ. [1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	13,5	$V_{QL} \leq 1,7$ V; $I_{QL} = 18$ mA
Input LOW	V_{GL}	–	–	4,5	V	13,5 and 17	$V_{QH} \geq 12$ V; $-I_{QH} = 0,1$ mA
Output HIGH	V_{QH}	12,0	14,3	–	V	13,5 and 17	$V_{GL} = 4,5$ V; $-I_{QH} = 0,1$ mA
Output LOW	V_{QL}	–	1,0	1,7	V	13,5	$V_{GH} = 7,5$ V; $I_{QL} = 18$ mA
D.C. noise margin: HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	μA	17	$V_{GH} = 17$ V; other inputs 0 V
Input LOW	$-I_{GL}$	–	1,0	1,8	mA	17	$V_{GL} = 1,7$ V; other inputs 17 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	13,5 and 17	$V_{GL} = 4,5$ V; $V_{QH} = 12$ V
Output LOW	I_{QL}	18	–	–	mA	13,5	$V_{GH} = 7,5$ V; $V_{QL} = 1,7$ V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25	mA	17	$V_G = 0$ V; $V_Q = 0$ V
Supply data							
Currents (per gate)							
at V_{QL}	I_P	–	3,7	6	mA	17	$V_G = 0$ V
Dynamic data							
Times							
Propagation delay							
fall time	t_{pdf}	–	t.b.f.	–	ns	15	$C_L = 10$ pF; N = 1; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V
rise time	t_{pdr}	–	t.b.f.	–	ns	15	
output rise time	t_r	–	t.b.f.	–	ns	15	
output all time	t_f	–	t.b.f.	–	ns	15	

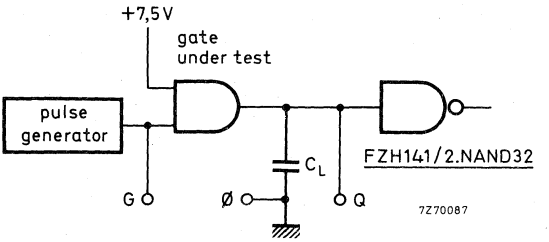
[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.
[2]) Short-circuit duration max. 1 s.

CHARACTERISTICS

Dynamic data



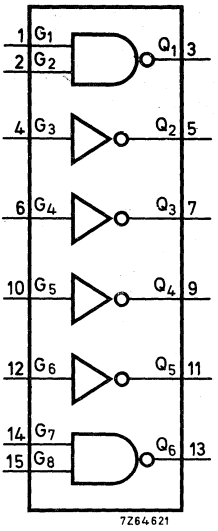
Pulse generator (G-input): t_r = 350 ns V_{pd} = +4,5 V
t_f = 120 ns
t_{GH} = 1 µs



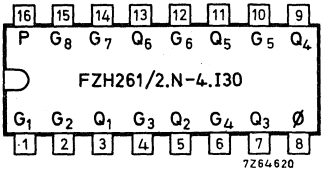
Measuring conditions: Vp = + 12 V; + 15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C

Waveforms and loading circuit illustrating measurement of t_{pdr} and t_{pdf}

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.



DUAL NAND GATE/ QUADRUPLE INVERTER

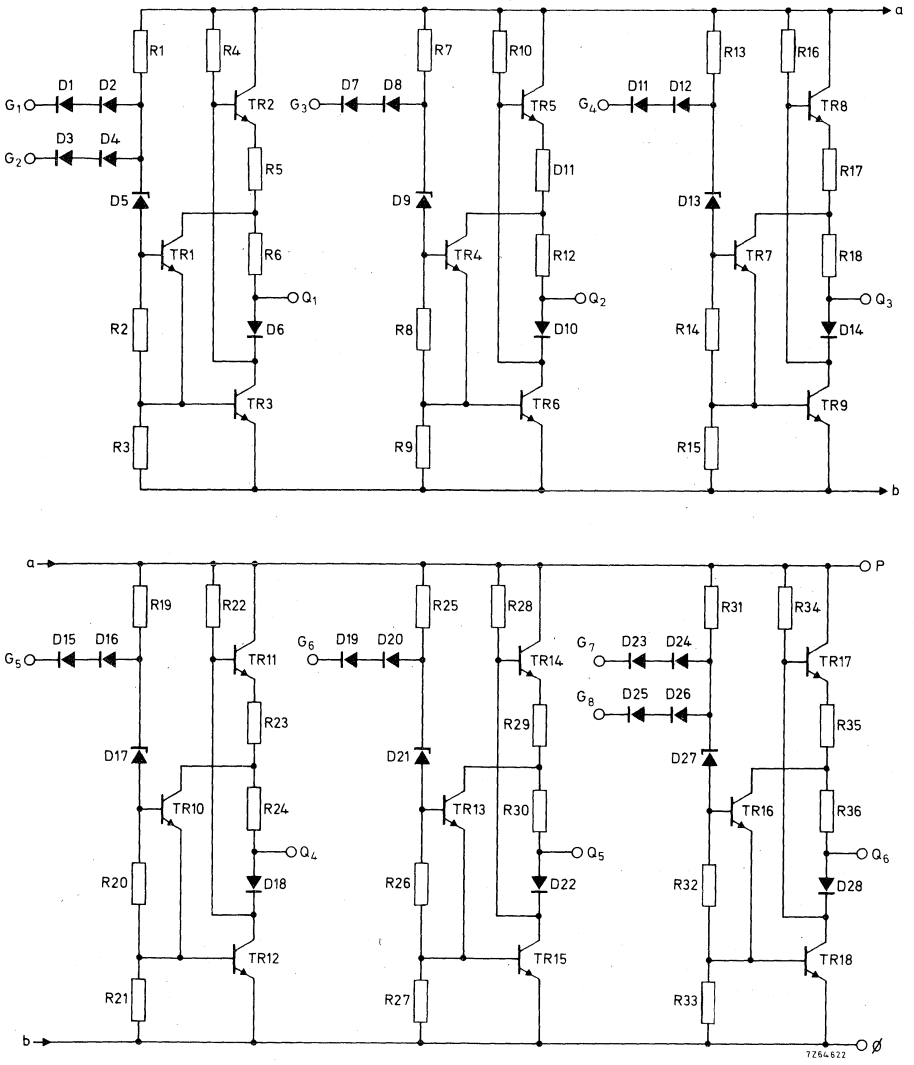


QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Average propagation delay ($N = 1$; $C_L = 10$ pF; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V)	t_{pd}	typ.	175	ns
Available d.c. fan-out $T_{amb} = 0$ to +70 °C } LOW state	N_{aL}	max.	10	
D.C. noise margin at $T_{amb} = 25$ °C				
range I : $V_P = 12$ V	$M_L = M_H$	typ.	5	V
range II: $V_P = 15$ V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at $T_{amb} = 25$ °C (50% duty cycle) range I : $V_P = 12$ V	P_{av}	typ.	16,2	mW
range II: $V_P = 15$ V	P_{av}	typ.	28,5	mW

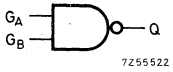
The FZH261/2.N-4.I30 consists of two 2-input NAND gates and four inverters, none of which have the slow-down facility.

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAM



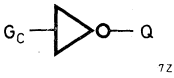
LOGIC FUNCTION



$Q = \overline{G_A . G_B}$ (positive logic)

Function table

G_A	G_B	Q
L	X	H
X	L	H
H	H	L



$Q = \overline{G}_C$ (positive logic)

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_G	max.	18	V
Input current at V_P = 17 V	$-I_{GL}$	max.	25	mA
Voltage difference between any two inputs		max.	18	V
Storage temperature	T_{stg}		−65 to +150	°C
Operating ambient temperature	T_{amb}		0 to +70	°C
Output short-circuit duration	t_{Qsc}	max.	1	s [1]

[1]) Only one output may be shorted at a time.

SYSTEM DESIGN DATA

Uniform system temperature		T_{amb}		0 to +70	°C
Uniform system supply voltage (range I)		V_P		11,4 to 13,5	V
	(range II)	V_P		13,5 to 17	V
Available d.c. fan-out		N_{aL}	max.	10	
		N_{aH}	max.	100	
D.C. noise margin; range I at V_{Pmin}		M_L	min.	2,8	V
		M_H	min.	2,5	V
	range II at V_{Pmin}	M_L	min	2,8	V
		M_H	min	4,5	V
Supply current per gate	range I; output HIGH	I_{Pav}	typ.	1,0	mA
	output LOW	I_{Pav}	typ.	1,7	mA
	range II; output HIGH	I_{Pav}	typ.	1,4	mA
	output LOW	I_{Pav}	typ.	2,4	mA
Power consumption per gate (50% duty cycle) at range I ; V_{Pmax}		P_{tot}	max.	34,3	mW
	at range II; V_{Pmax}	P_{tot}	max.	56	mW
Thermal resistance from system to ambient		R_{th}	max.	150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max.		Conditions and references: V_P (V)	
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	11,4	$V_{QL} \leq 1,7$ V; $I_{QL} = 15$ mA
Input LOW	V_{GL}	–	–	4,5	V	11,4 and 13,5	$V_{QH} \geq 10$ V; $-I_{QH} = 0,1$ mA
Output HIGH	V_{QH}	10,0	11,3	–	V	11,4 and 13,5	$V_{GL} = 4,5$ V; $-I_{QH} = 0,1$ mA
Output LOW	V_{QL}	–	0,9	1,7	V	11,4	$V_{GH} = 7,5$ V; $I_{QL} = 15$ mA
D.C. noise margin: HIGH	M_H	2,5	5,0	–	V	11,4	
LOW	M_L	2,8	5,0	–	V	11,4	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	µA	13,5	$V_{GH} = 13,5$ V; other inputs 0 V
Input LOW	$-I_{GL}$	–	0,8	1,5	mA	13,5	$V_{GL} = 1,7$ V; other inputs 13,5 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	11,4 and 13,5	$V_{GL} = 4,5$ V; $V_{QH} = 10$ V
Output LOW	I_{QL}	15	–	–	mA	11,4	$V_{GH} = 7,5$ V; $V_{QL} = 1,7$ V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25	mA	13,5	$V_G = 0$ V; $V_Q = 0$ V
Supply data							
Currents (per gate)							
at V_{QL}	I_P	–	1,7	3	mA	13,5	$V_G = 13,5$ V
Dynamic data							
Times							
Propagation delay							
fall time	t_{pdf}	90	175	310	ns	12	$C_L = 10$ pF; N = 1; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V
rise time	t_{pdr}	90	175	310	ns	12	
output rise time	t_r	200	340	570	ns	12	
output fall time	t_f	70	120	210	ns	12	

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

[2] Short-circuit duration max. 1 s.

CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

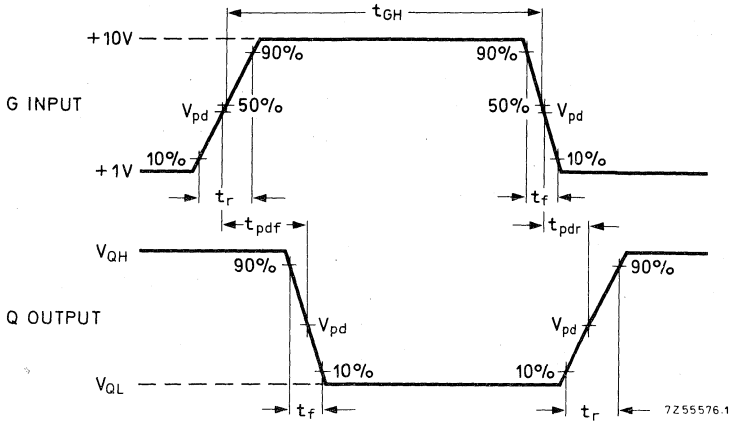
	Sym-bol	min.	typ. [1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	13,5	$V_{QL} \leq 1,7$ V; I_{QL} = 18 mA
Input LOW	V_{GL}	–	–	4,5	V	13,5 and 17	$V_{QH} \geq 12$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	12,0	14,3	–	V	13,5 and 17	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1,0	1,7	V	13,5	V_{GH} = 7,5 V; I_{QL} = 18 mA
D.C. noise margin: HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	µA	17	V_{GH} = 17 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	1,0	1,8	mA	17	V_{GL} = 1,7 V; other inputs 17 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	13,5 and 17	V_{GL} = 4,5 V; V_{QH} = 12 V
Output LOW	I_{QL}	18	–	–	mA	13,5	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25	mA	17	V_G = 0 V; V_Q = 0 V
Supply data							
Currents (per gate)							
at V_{QL}	I_P	–	2,4	4	mA	17	V_G = 17 V
Dynamic data							
Times							
Propagation delay fall time	t_{pdf}	–	t.b.f.	–	ns	15	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_{pd} = 4,5 V
Propagation delay rise time	t_{pdr}	–	t.b.f.	–	ns	15	
output rise time	t_r	–	t.b.f.	–	ns	15	
output fall time	t_f	–	t.b.f.	–	ns	15	

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

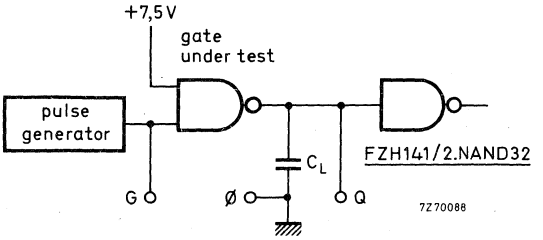
[2]) Short-circuit duration max. 1 s.

CHARACTERISTICS (continued)

Dynamic data



Pulse generator (G-input): t_r = 350 ns V_{pd} = +4,5 V
t_f = 120 ns
t_{GH} = 1 µs

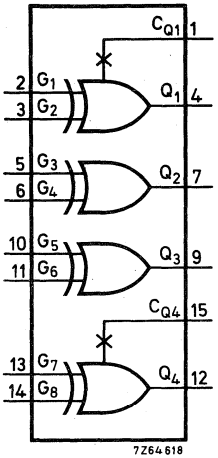


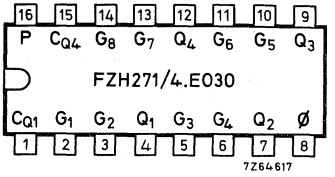
Measuring conditions: V_P = +12 V; +15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C

Waveforms and loading circuit illustrating measurement of t_{pdr} and t_{pdf}

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

QUADRUPLE EXCLUSIVE-OR GATE
with slow-down capability



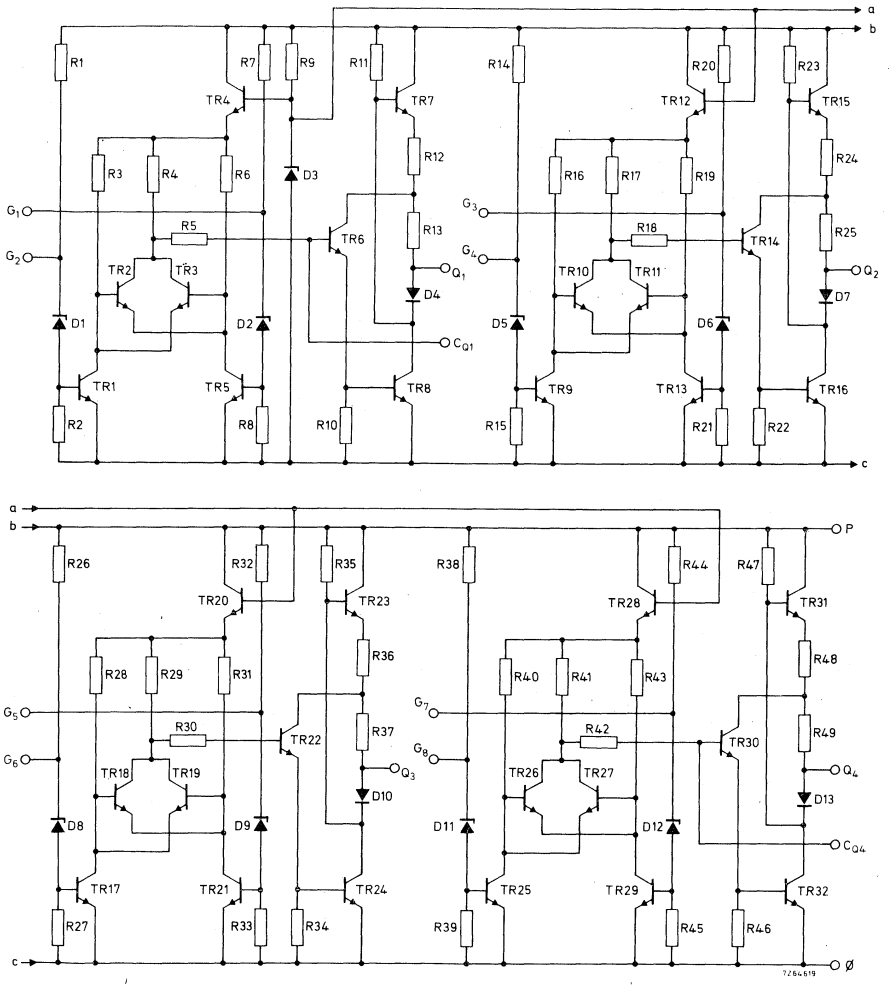


QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Average propagation delay N = 1; C_L = 10 pF; T_{amb} = 25 °C; V_{pd} = 4,5 V	t_{pd}	typ.	260	ns
Available d.c. fan-out T_{amb} = 0 to +70 °C } LOW state	N_{aL}	max.	10	
D.C. noise margin at T_{amb} = 25 °C				
range I : V_P = 12 V	$M_L = M_H$	typ.	5	V
range II: V_P = 15 V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at T_{amb} = 25 °C				
(50% duty cycle) range I : V_P = 12 V	P_{av}	typ.	43,5	mW
range II: V_P = 15 V	P_{av}	typ.	66,8	mW

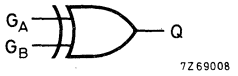
The FZH271/4.EO30 consists of four 2-input EXCLUSIVE-OR gates, two of which may be slowed down.

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAM



LOGIC FUNCTION



$Q = G_A.\overline{G}_B + \overline{G}_A.G_B$ (positive logic)

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)

Function table

G_A	G_B	Q
L	L	L
H	L	H
L	H	H
H	H	L

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_G	max.	18	V
Input current at V_P = 17 V	$-I_{GL}$	max.	25	mA
Voltage difference between any two inputs		max.	18	V
Storage temperature	T_{stg}		−65 to +150	°C
Operating ambient temperature	T_{amb}		0 to +70	°C
Output short-circuit duration	t_{Qsc}	max.	1	s [1]
Slow-down input voltage	$+V_{CQ}$	max.	0,6	V
	$-V_{CQ}$	max.	1,0	V
Slow-down input current	$+I_{CQ}$	max.	2,0	mA
	$-I_{CQ}$	max.	10,0	mA

[1]) Only one output may be shorted at a time.

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}		0 to +70	°C
Uniform system supply voltage (range I)	V_P		11,4 to 13,5	V
(range II)	V_P		13,5 to 17	V
Available d.c. fan-out	N_{aL}	max.	10	
	N_{aH}	max.	100	
D.C. noise margin; range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Suppy current per gate: range I ; output HIGH	I_{Pav}	typ.	3,45	mA
output LOW	I_{Pav}	typ.	3,8	mA
range II; output HIGH	I_{Pav}	typ.	4,1	mA
output LOW	I_{Pav}	typ.	4,8	mA
Power consumption per gate (50% duty cycle) at range I ; V_{Pmax}	P_{tot}	max.	76,8	mW
at range II; V_{Pmax}	P_{tot}	max.	114,8	mW
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ. [1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	11,4	$V_{QL} \leq 1,7$ V; I_{QL} = 15 mA
Input LOW	V_{GL}	–	–	4,5	V	11,4 and 13,5	$V_{QH} \geq 10$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	10,0	11,3	–	V	11,4 and 13,5	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	0,9	1,7	V	11,4	V_{GH} = 7,5 V; I_{QL} = 15 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	–	V	11,4	
LOW	M_L	2,8	5,0	–	V	11,4	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	μA	13,5	V_{GH} = 13,5 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	0,8	1,5	mA	13,5	V_{GL} = 1,7 V; other inputs 13,5 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	11,4 and 13,5	V_{GL} = 4,5 V; V_{QH} = 10 V
Output LOW	I_{QL}	15	–	–	mA	11,4	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25	mA	13,5	V_G = 0 V; V_Q = 0 V
Supply data							
Currents (per gate)							
at V_{QL}	I_P	–	3,8	6	mA	13,5	V_G = 13,5 V
Dynamic data							
Times							
Propagation delay fall time	t_{pdf}	90	175	310	ns	12	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_{pd} = 4,5 V
rise time	t_{pdr}	200	340	570	ns	12	
output rise time	t_r	200	340	570	ns	12	
output fall time	t_f	70	120	210	ns	12	

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

[2]) Short-circuit duration max. 1 s.

CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

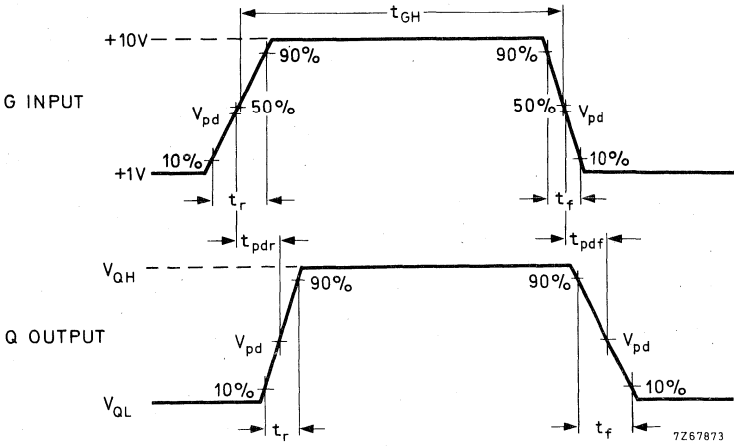
	Sym-bol	min.	typ.	[1] max.		Conditions and references: V_P (V)	
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	13,5	$V_{QL} \leq 1,7$ V; $I_{QL} = 18$ mA
Input LOW	V_{GL}	–	–	4,5	V	13,5 and 17	$V_{QH} \geq 12$ V; $-I_{QH} = 0,1$ mA
Output HIGH	V_{QH}	12,0	14,3	–	V	13,5 and 17	$V_{GL} = 4,5$ V; $-I_{QH} = 0,1$ mA
Output LOW	V_{QL}	–	1,0	1,7	V	13,5	$V_{GH} = 7,5$ V; $I_{QL} = 18$ mA
D.C. noise margin: HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	μA	17	$V_{GH} = 17$ V; other inputs 0 V
Input LOW	$-I_{GL}$	–	1,0	1,8	mA	17	$V_{GL} = 1,7$ V; other inputs 17 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	13,5 and 17	$V_{GL} = 4,5$ V; $V_{QH} = 12$ V
Output LOW	I_{QL}	18	–	–	mA	13,5	$V_{GH} = 7,5$ V; $V_{QL} = 1,7$ V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25	mA	17	$V_G = 0$ V; $V_Q = 0$ V
Supply data							
Currents (per gate)							
at V_{QL}	I_P	–	4,8	7,5	mA	17	$V_G = 17$ V
Dynamic data							
Times							
Propagation delay							
fall time	t_{pdf}	–	t.b.f.	–	ns	15	$C_L = 10$ pF; N = 1; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V
rise time	t_{pdr}	–	t.b.f.	–	ns	15	
output rise time	t_r	–	t.b.f.	–	ns	15	
output fall time	t_f	–	t.b.f.	–	ns	15	

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

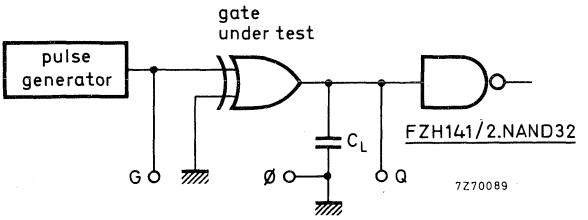
[2] Short-circuit duration max. 1 s.

CHARACTERISTICS (continued)

Dynamic data



Pulse generator (G-input): t_r = 350 ns V_{pd} = +4,5 V
t_f = 120 ns
t_{GH} = 1 µs

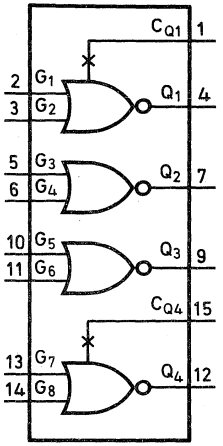


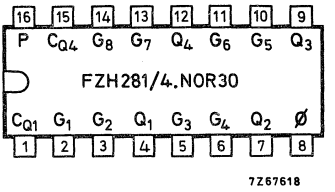
Measuring conditions: V_P = +12 V; +15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C

Waveforms and loading circuit illustrating measurement of t_{pdr} and t_{pdf}

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

QUADRUPLE NOR GATE
with slow-down capability



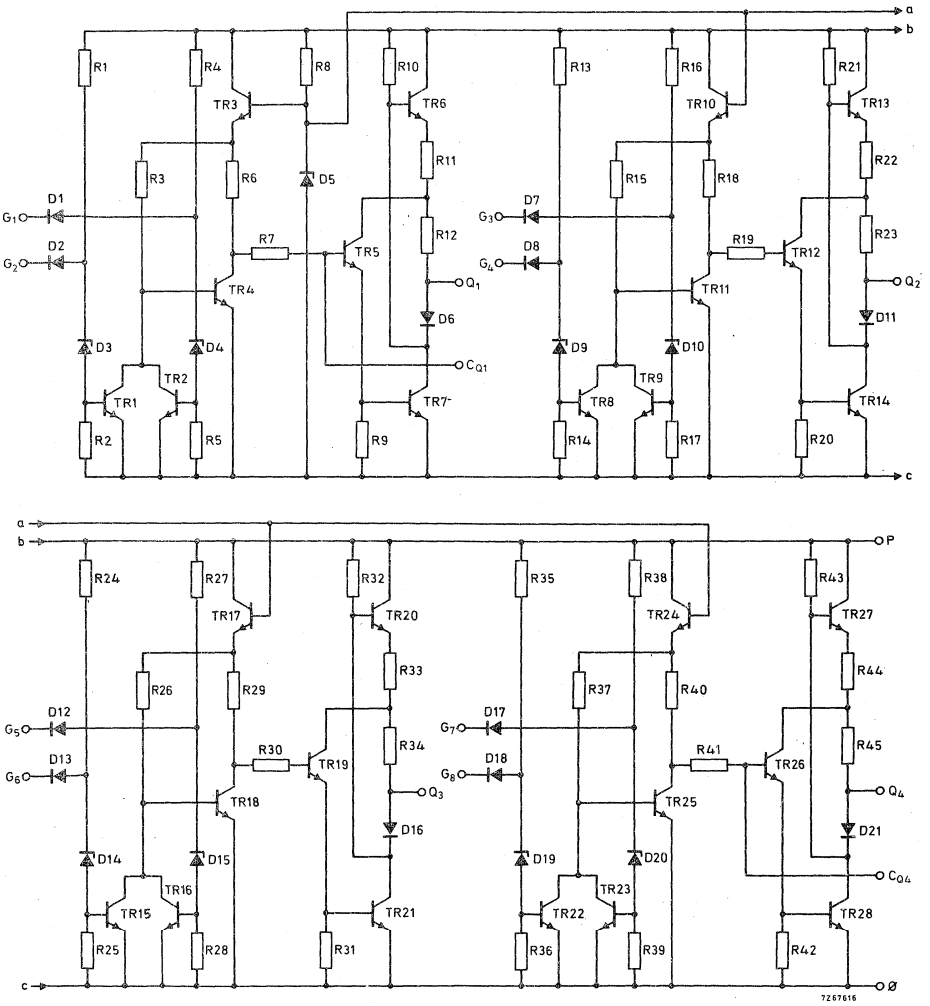


QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Average propagation delay ($N = 1$; $C_L = 10$ pF; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V)	t_{pd}	typ.	260	ns
Available d.c. fan-out, $T_{amb} = 0$ to +70 °C; LOW state	N_{aL}	max.	10	
D.C. noise margin at $T_{amb} = 25$ °C				
range I : $V_P = 12$ V	$M_L = M_H$	typ.	5	V
range II: $V_P = 15$ V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at $T_{amb} = 25$ °C (50% duty cycle) range I : $V_P = 12$ V	P_{av}	typ.	42	mW
range II: $V_P = 15$ V	P_{av}	typ.	63,8	mW

The FZH281/4.NOR30 consists of four 2-input NOR gates, two of which have the slow-down facility.

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAM



LOGIC FUNCTION

$Q = \overline{G_A + G_B}$ (positive logic)

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

Function table

G_A	G_B	Q
L	L	H
H	X	L
X	H	L

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_G	max.	18	V
Input current at V_P = 17 V	$-I_{GL}$	max.	25	mA
Voltage difference between any two inputs		max.	18	V
Storage temperature	T_{stg}		−65 to +150	°C
Operating ambient temperature	T_{amb}		0 to +70	°C
Output short-circuit duration	t_{Qsc}	max.	1	s [1]
Slow-down input voltage	$+V_{CQ}$	max.	0,6	V
	$-V_{CQ}$	max.	1,0	V
Slow-down input current	$+I_{CQ}$	max.	2,0	mA
	$-I_{CQ}$	max.	10,0	mA

[1]) Only one output may be shorted at a time.

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}		0 to +70	°C
Uniform system supply voltage (range I)	V_P		11,4 to 13,5	V
(range II)	V_P		13,5 to 17	V
Available d.c. fan-out	N_{aL}	max.	10	
	N_{aH}	max.	100	
D.C. noise margin; range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Supply current per gate; range I ; output HIGH	I_{Pav}	typ.	3,3	mA
output LOW	I_{Pav}	typ.	3,7	mA
range II; output HIGH	I_{Pav}	typ.	3,8	mA
output LOW	I_{Pav}	typ.	4,7	mA
Power consumption per gate (50% duty cycle) at range I ; V_{Pmax}	P_{tot}	max.	76,8	mW
at range II; V_{Pmax}	P_{tot}	max.	114,8	mW
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	11,4	$V_{QL} \leq 1,7$ V; I_{QL} = 15 mA
Input LOW	V_{GL}	–	–	4,5	V	11,4 and 13,5	$V_{QH} \geq 10$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	10,0	11,3	–	V	11,4 and 13,5	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	0,9	1,7	V	11,4	V_{GH} = 7,5 V; I_{QL} = 15 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	–	V	11,4	
LOW	M_L	2,8	5,0	–	V	11,4	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	µA	13,5	V_{GH} = 13,5 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	0,8	1,5	mA	13,5	V_{GL} = 1,7 V; other inputs 13,5 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	11,4 and 13,5	V_{GL} = 4,5 V; V_{QH} = 10 V
Output LOW	I_{QL}	15	–	–	mA	11,4	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25	mA	13,5	V_G = 0 V; V_Q = 0 V
Supply data							
Currents (per gate)							
at V_{QL}	I_P	–	3,7	6	mA	13,5	V_G = 13,5 V
Dynamic data							
Times							
Propagation delay							
fall time	t_{pdf}	200	340	570	ns	12	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_{pd} = 4,5 V
rise time	t_{pdr}	90	175	310	ns	12	
output rise time	t_r	200	340	570	ns	12	
output fall time	t_f	70	120	210	ns	12	

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

[2] Short-circuit duration max. 1 s.

CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

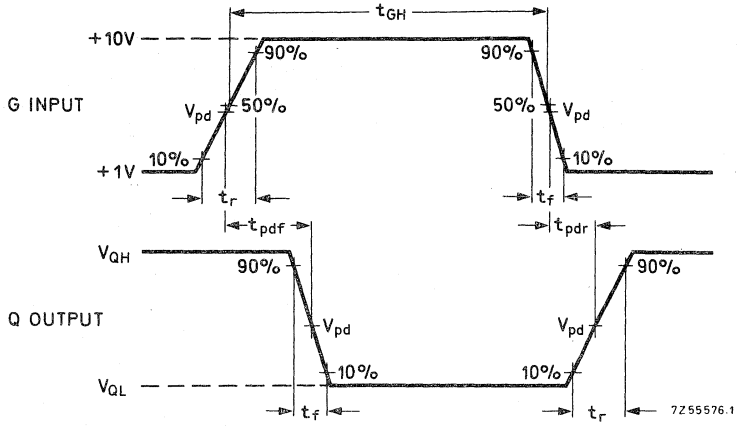
	Sym-bol	min.	typ. [1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	13,5	$V_{QL} \leq 1,7$ V; $I_{QL} = 18$ mA
Input LOW	V_{GL}	–	–	4,5	V	13,5 and 17	$V_{QH} \geq 12$ V; $-I_{QH} = 0,1$ mA
Output HIGH	V_{QH}	12,0	14,3	–	V	13,5 and 17	$V_{GL} = 4,5$ V; $-I_{QH} = 0,1$ mA
Output LOW	V_{QL}	–	1,0	1,7	V	13,5	$V_{GH} = 7,5$ V; $I_{QL} = 18$ mA
D.C. noise margin: HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	μA	17	$V_{GH} = 17$ V; other inputs 0 V
Input LOW	$-I_{GL}$	–	1,0	1,8	mA	17	$V_{GL} = 1,7$ V; other inputs 17 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	13,5 and 17	$V_{GL} = 4,5$ V; $V_{QH} = 12$ V
Output LOW	I_{QL}	18	–	–	mA	13,5	$V_{GH} = 7,5$ V; $V_{QL} = 1,7$ V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25	mA	17	$V_G = 0$ V; $V_Q = 0$ V
Supply data							
Currents (per gate)							
at V_{QL}	I_P	–	4,7	7,5	mA	17	$V_G = 17$ V
Dynamic data							
Times							
Propagation delay							
fall time	t_{pdf}	–	t.b.f.	–	ns	15	$C_L = 10$ pF; N = 1; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V
rise time	t_{pdr}	–	t.b.f.	–	ns	15	
output rise time	t_r	–	t.b.f.	–	ns	15	
output fall time	t_f	–	t.b.f.	–	ns	15	

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

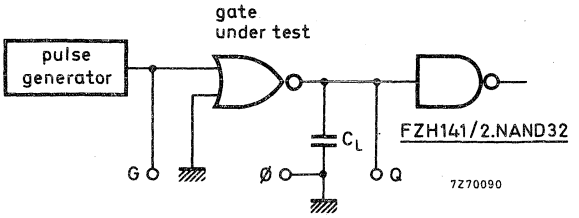
[2] Short-circuit duration max. 1 s.

CHARACTERISTICS (continued)

Dynamic data



Pulse generator (G-input): t_r = 350 ns V_{pd} = +4,5 V
t_f = 120 ns
t_{GH} = 1 µs

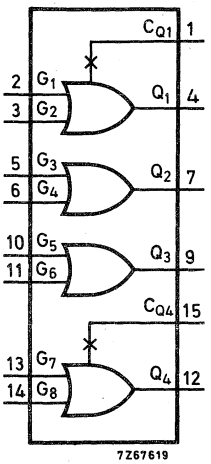


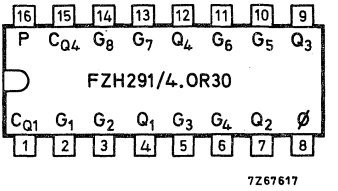
Measuring conditions: V_P = +12 V; +15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C

Waveforms and loading circuit illustrating measurement of t_{pdr} and t_{pdf}

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

QUADRUPLE OR GATE
with slow-down capability



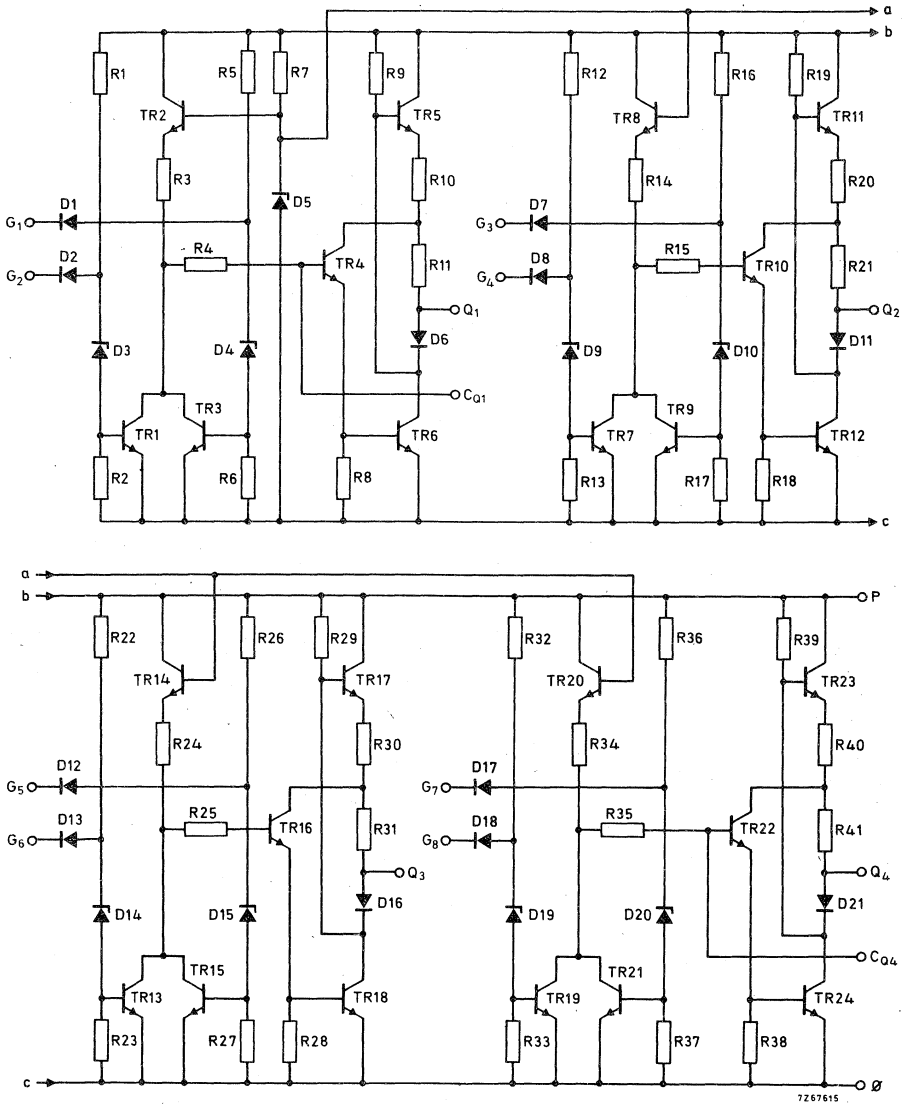


QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Average propagation delay ($N = 1$; $C_L = 10$ pF; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V)	t_{pd}	typ.	260	ns
Available d.c. fan-out $T_{amb} = 0$ to +70 °C } LOW state	N_{aL}	max.	10	
D.C. noise margin at $T_{amb} = 25$ °C				
range I : $V_P = 12$ V	$M_L = M_H$	typ.	5	V
range II: $V_P = 15$ V	M_L	typ.	5	V
	M_H	typ.	8	V
Power consumption per gate at $T_{amb} = 25$ °C (50% duty cycle) range I : $V_P = 12$ V	P_{av}	typ.	35,1	mW
range II: $V_P = 15$ V	P_{av}	typ.	54	mW

The FZH291/4.OR30 consists of four 2-input OR gates, two of which may be slowed down.

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAM



LOGIC FUNCTION

$Q = G_A + G_B$ (positive logic)

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

Function table

G_A	G_B	Q
L	L	L
H	X	H
X	H	H

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_G	max.	18	V
Input current at V_P = 17 V	$-I_{GL}$	max.	25	mA
Voltage difference between any two inputs		max.	18	V
Storage temperature	T_{stg}		−65 to +150	°C
Operating ambient temperature	T_{amb}		0 to +70	°C
Output short-circuit duration	t_{Qsc}	max.	1	s [1]
Slow-down input voltage	$+V_{CQ}$	max.	0,6	V
	$-V_{CQ}$	max.	1,0	V
Slow-down input current	$+I_{CQ}$	max.	2,0	mA
	$-I_{CQ}$	max.	10,0	mA

[1]) Only one output may be shorted at a time.

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}		0 to +70	°C
Uniform system supply voltage (range I)	V_P		11,4 to 13,5	V
(range II)	V_P		13,5 to 17	V
Available d.c. fan-out	N_{aL}	max.	10	
	N_{aH}	max.	100	
D.C. noise margin; range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Supply current per gate; range I ; output HIGH	I_{Pav}	typ.	2,25	mA
output LOW	I_{Pav}	typ.	3,6	mA
range II; output HIGH	I_{Pav}	typ.	2,6	mA
output LOW	I_{Pav}	typ.	4,6	mA
Power consumption per gate (50% duty cycle) at range I ; V_{Pmax}	P_{tot}	max.	64,1	mW
at range II; V_{Pmax}	P_{tot}	max.	104,1	mW
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ.	[1] max.		Conditions and references: V_P (V)	
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	11,4	$V_{QL} \leq 1,7$ V; I_{QL} = 15 mA
Input LOW	V_{GL}	–	–	4,5	V	11,4 and 13,5	$V_{QH} \geq 10$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	10,0	11,3	–	V	11,4 and 13,5	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	0,9	1,7	V	11,4	V_{GH} = 7,5 V; I_{QL} = 15 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	–	V	11,4	
LOW	M_L	2,8	5,0	–	V	11,4	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	μA	13,5	V_{GH} = 13,5 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	0,8	1,5	mA	13,5	V_{GL} = 1,7 V; other inputs 13,5 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	11,4 and 13,5	V_{GL} = 4,5 V; V_{QH} = 10 V
Output LOW	I_{QL}	15	–	–	mA	11,4	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25	mA	13,5	V_G = 0 V; V_Q = 0 V
Supply data							
Currents (per gate)							
at V_{QH}	I_P	–	3,6	5,8	mA	13,5	V_G = 13,5 V
Dynamic data							
Times							
Propagation delay							
fall time	t_{pdf}	90	175	310	ns	12	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_{pd} = 4,5 V
rise time	t_{pdr}	200	340	570	ns	12	
output rise time	t_r	200	340	570	ns	12	
output fall time	t_f	70	120	210	ns	12	

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

[2] Short-circuit duration max. 1 s.

CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

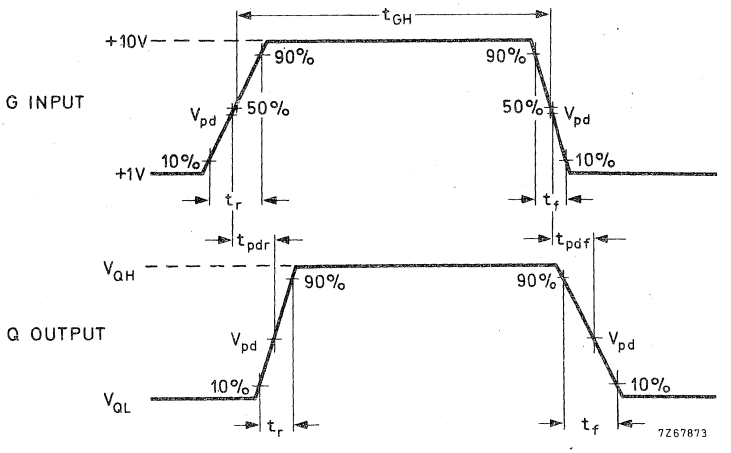
	Sym-bol	min.	typ. [1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	13,5	$V_{QL} \leq 1,7$ V; $I_{QL} = 18$ mA
Input LOW	V_{GL}	–	–	4,5	V	13,5 and 17	$V_{QH} \geq 12$ V; $-I_{QH} = 0,1$ mA
Output HIGH	V_{QH}	12,0	14,3	–	V	13,5 and 17	$V_{GL} = 4,5$ V; $-I_{QH} = 0,1$ mA
Output LOW	V_{QL}	–	1,0	1,7	V	13,5	$V_{GH} = 7,5$ V; $I_{QL} = 18$ mA
D.C. noise margin: HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents (per gate)							
Input HIGH	I_{GH}	–	–	1,0	μA	17	$V_{GH} = 17$ V; other inputs 0 V
Input LOW	$-I_{GL}$	–	1,0	1,8	mA	17	$V_{GL} = 1,7$ V; other inputs 17 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	13,5 and 17	$V_{GL} = 4,5$ V; $V_{QH} = 12$ V
Output LOW	I_{QL}	18	–	–	mA	13,5	$V_{GH} = 7,5$ V; $V_{QL} = 1,7$ V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25	mA	17	$V_G = 0$ V; $V_Q = 0$ V
Supply data							
Currents (per gate)							
at V_{QH}	I_P	–	4,6	7,3	mA	17	$V_G = 17$ V
Dynamic data							
Times							
Propagation delay							
fall time	t_{pdf}	–	t.b.f.	–	ns	15	$C_L = 10$ pF; N = 1; $T_{amb} = 25$ °C; $V_{pd} = 4,5$ V
rise time	t_{pdr}	–	t.b.f.	–	ns	15	
output rise time	t_r	–	t.b.f.	–	ns	15	
output fall time	t_f	–	t.b.f.	–	ns	15	

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

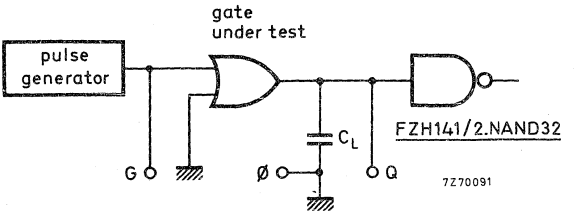
[2] Short-circuit duration max. 1 s.

CHARACTERISTICS (continued)

Dynamic data



Pulse generator (G-input): t_r = 350 ns $V_{pd} = +4,5$ V
t_f = 120 ns
t_{GH} = 1 µs



Measuring conditions: V_P = +12 V; +15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C

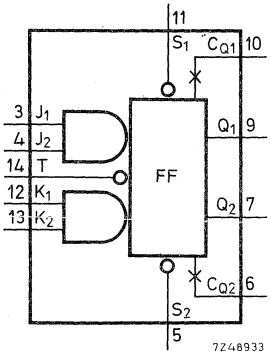
Waveforms and loading circuit illustrating measurement of t_{pdr} and t_{pdf}

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

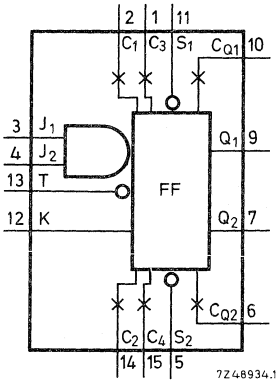
SINGLE JK MASTER-SLAVE FLIP-FLOPS

FZJ101/FF30: with slow-down capability on the slave

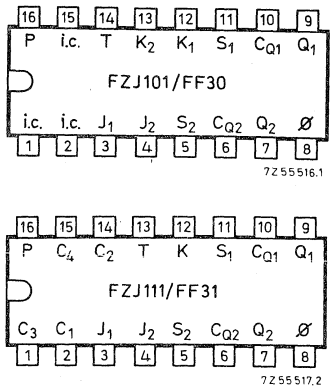
FZJ111/FF31: with slow-down capability on master and slave



FZJ101/FF30



FZJ111/FF31

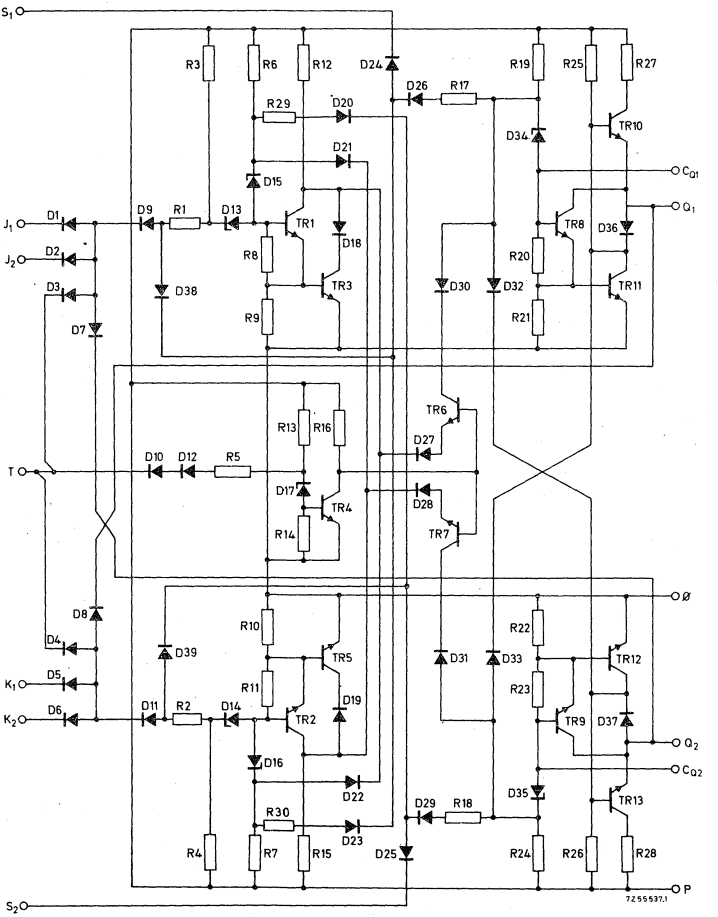


QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Available d.c. fan-out (T_{amb} = 0 to +70 °C) LOW state	N_{aL}	max.	10	
Operating frequency at T_{amb} = 25 °C; duty cycle 50%; range I/II	f_c	typ.	0,5	MHz
Average supply current at T_{amb} = 25 °C				
V_P = 13,5 V	I_{Pav}	typ.	8	mA
V_P = 17 V	I_{Pav}	typ.	11	mA
D.C. noise margin at T_{amb} = 25 °C				
range I : V_P = 12 V	$M_L = M_H$	typ.	5	V
range II : V_P = 15 V	M_L	typ.	5	V
	M_H	typ.	8	V

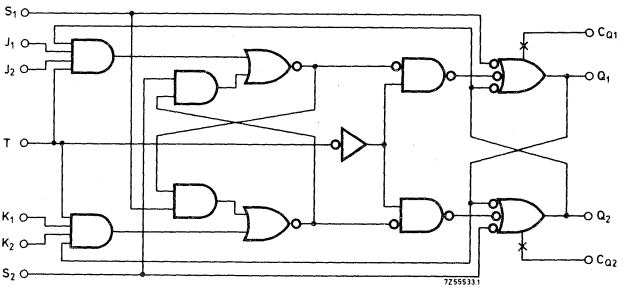
PACKAGE OUTLINE 16-lead plastic dual in-line (see general section).

CIRCUIT DIAGRAM

FZJ101/FF30

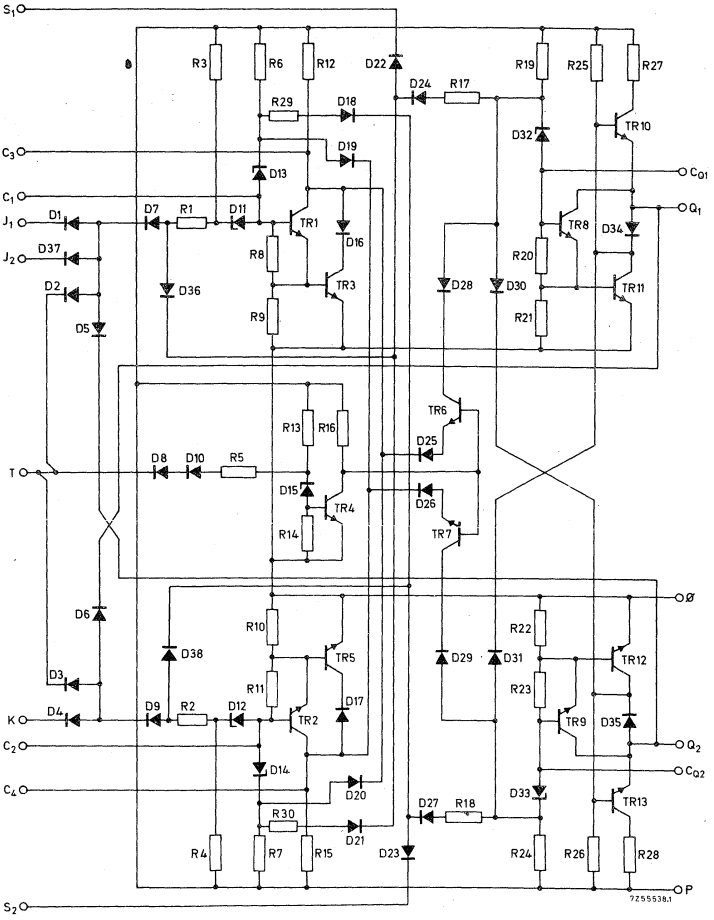


LOGIC DIAGRAM

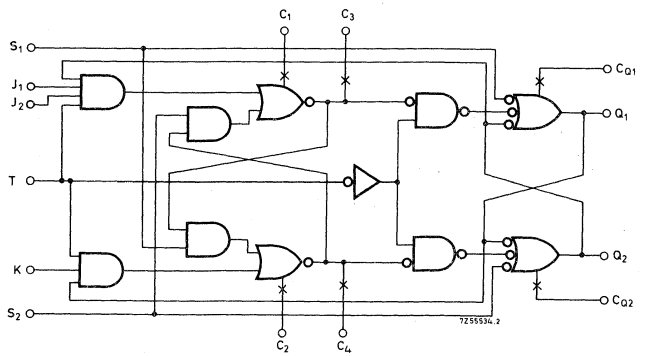


CIRCUIT DIAGRAM

FZJ111/FF31



LOGIC DIAGRAM



GENERAL DESCRIPTION

The FZJ101/FF30 consists of a single JK master-slave flip-flop with two J and K inputs and also has a slow-down capability on the slave of the flip-flop. So the reaction time of the slave to the negative-going clock-edge can be increased. This can be achieved by connecting external capacitors between the output terminals and their associated slow-down terminals.

The FZJ111/FF31 consists of a single JK master-slave flip-flop with two J inputs and one K input and has a slow-down capability both on the master and the slave of the flip-flop. For slowing down the slave see FZJ101/FF30.

The reaction time of the master to the positive-going clock-edge can be increased by connecting external capacitors between the slow-down terminals C_1, C_3 and C_2, C_4 respectively. Furthermore a minimum slope of the T-signal is required.

LOGIC FUNCTIONS

FZJ101/FF30

$J = J_1 \cdot J_2$

$K = K_1 \cdot K_2$

FZJ111/FF31

$J = J_1 \cdot J_2$

$K = K$

Function tables

t_n		t_{n+1}	
J	K	Q_1	Q_2
L	L	Q_{1n}	Q_{2n}
L	H	L	H
H	L	H	L
H	H	Q_{2n}	Q_{1n}
Q_2 is opposite Q_1			

The set inputs S_1 and S_2 override all the other inputs.

S_1	S_2	Q_1	Q_2
L	H	H	L
H	L	L	H
H	H	Q_1	Q_2 [1]
L	L	H	H [2]

H = HIGH state (the more positive voltage)

L = LOW state (the less positive voltage)

[1] Q_2 is opposite Q_1

[2] If S_1 and S_2 return to HIGH simultaneously the Q-states will be indeterminate.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	12	V
Input voltage	V_J, V_K, V_T	max.	18	V
Input current at V_P = 17 V	$-I_{IL}$	max.	25	mA [1]
Storage temperature	T_{stg}		−65 to +150	°C
Operating ambient temperature	T_{amb}		0 to +70	°C

[1] All inputs except slow-down inputs.

NOTE

The slow-down terminals indicated by crosses are for slow-down purposes only; they are not to be connected to any other terminal.

RATINGS (continued)

Output short-circuit duration	t_{Qsc}	max.	1	s [1]
Slow-down input voltage	$+V_{CQ}$	max.	0,6	V
	$-V_{CQ}$	max.	1,0	V
Slow-down input current	$+I_{CQ}$	max.	2,0	V
	$-I_{CQ}$	max.	10,0	V

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}	0 to +70		°C
Uniform system supply voltage (range I)	V_P	11,4 to 13,5		V
(range II)	V_P	13,5 to	17	V
Available d.c. fan-out	N_{aL}	max.	10	
D.C. noise margin to all inputs: range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Average propagation delay time at V_{pd} = 4,5 V				
T ⟶ Q: at range I ; V_P = 12 V	t_{pd}	max.	645	ns
at range II; V_P = 15 V	t_{pd}	typ.	400	ns
S ⟶ Q: at range I ; V_P = 12 V	t_{pd}	max.	455	ns
at range II; V_P = 15 V	t_{pd}	typ.	265	ns
Maximum clock rate at T_{amb} = 25 °C duty cycle 50%; range I/II	f_c	typ.	0,5	MHz
		min.	0,2	MHz
Supply current at range I : V_P = 12 V	I_P	typ.	8	mA
range II : V_P = 15 V	I_P	typ.	11	mA
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

[1]) Only one output may be shorted at a time.

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ.[1]	max.	Conditions and references: V_P (V)	
Static data						
Voltages						
Input HIGH: J, K, T, S	V_{IH}	7,5	–	– V	11,4	$V_{QL} \leq 1,7$ V; I_{QL} = 15 mA
Input LOW: J, K, S	V_{IL}	–	–	4,5 V	11,4 and 13,5	$V_{QH} \geq 10$ V; $-I_{QH}$=0,1mA
T	V_{TL}	–	–	4,0 V		
Output HIGH	V_{QH}	10	11,3	– V	11,4 and 13,5	V_{IL} = 4,5 V; $-I_{QH}$=0,1mA
Output LOW	V_{QL}	–	0,9	1,7 V	11,4	V_{IH} = 7,5 V; I_{QL} =15 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	– V	11,4	
LOW	M_L	2,8	5,0	– V	11,4	
Currents						
Input HIGH: J, K, S	I_{IH}	–	–	1 µA	13,5	V_{IH} = 13,5 V (other inputs 0V)
T	I_{TH}	–	–	3 µA		
Input LOW: J, K	$-I_{IL}$	–	0,8	1,5 mA	13,5	$V_{JL}=V_{KL}$=1,7V
T	$-I_{TL}$	–	1,6	3,0 mA	13,5	V_{TL} = 1,7 V
S[2])	$-I_{SL}$	–	0,8	1,5 mA	13,5	V_{SL} = 1,7 V
Output HIGH	$-I_{QH}$	0,1	–	– mA	11,4 and 13,5	V_{QH} = 10 V
Output LOW	I_{QL}	15	–	– mA	11,4	V_{QL} = 1,7 V
Output short-circuited[3])	$-I_{Qsc}$	10	30	50 mA	13,5	V_I=0V; V_Q=0V
Supply data						
Supply current	I_P	–	8,0	– mA	13,5	

1) All typ. values under test conditions: T_{amb} = 25 °C and V_P = 12 V.
2) For dynamic: $-I_{SL}$ = 1,5 x specified values.
3) Short-circuited duration max. 1 s.

CHARACTERISTICS (continued)

Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max.		Conditions and references
Dynamic data						
Times						
Propagation delay:						
T ⟶ Q						
fall time	t_{pdf}	270	450	770	ns	
rise time	t_{pdr}	160	290	520	ns	
S ⟶ Q						
fall time	t_{pdf}	180	330	580	ns	
rise time	t_{pdr}	70	165	330	ns	
output rise time	t_r	200	340	570	ns	
output fall time	t_f	70	120	210	ns	C_L = 10 pF
Clock rate						N = 1
(duty cycle 50%)	f_c	0,2	0,5	–	MHz	T_{amb} = 25 °C
Input times						V_{pd} = 4,5 V
T input	t_{TH}	0,6	–	–	µs	
	t_{TL}	0,6	–	–	µs	
S input	t_{SL}	1,0	–	–	µs	
J or K input						
hold time	t_{hold}	0	–	–	ns	
set-up time	t_{su}	0	–	–	ns	
T input slope	$(-dV/dt)_{Tmin}$			1	V/µs	

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

CHARACTERISTICS (continued)

Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ. [1]	max.		Conditions and references: V_P (V)	
Static data							
Voltages							
Input HIGH: J, K, T, S	V_{IH}	7,5	–	–	V	13,5	$V_{QL} \leq 1,7$ V; I_{QL} = 18 mA
Input LOW: J, K, S	V_{IL}	–	–	4,5	V	13,5 and 17	$V_{QH} \leq 12$ V; $-I_{QH}$ = 0,1 mA
T	V_{TL}	–	–	4,0	V		
Output HIGH	V_{QH}	12	14,3	–	V	13,5 and 17	V_{IL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1,0	1,7	V	13,5	V_{IH} = 7,5 V; I_{QL} = 18 mA
D.C. noise margin: HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents							
Input HIGH: J, K, S	I_{IH}	–	–	1,0	μA	17	V_{IH} = 17 V; (other inputs 0 V)
T	I_{TH}	–	–	3,0	μA		
Input LOW: J, K	$-I_{IL}$	–	1,0	1,8	mA	17	$V_{JL} = V_{KL}$ = 1,7 V
T	$-I_{TL}$	–	2,0	3,6	mA	17	V_{TL} = 1,7 V
S [2]	$-I_{SL}$	–	1,0	1,8	mA	17	V_{SL} = 1,7 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	13,5 and 17	V_{QH} = 12 V
Output LOW	I_{QL}	18	–	–	mA	13,5	V_{QL} = 1,7 V
Output short-circuited	$-I_{Qsc}$ [3]	15	37	60	mA	17	V_I = 0 V; V_Q = 0 V
Supply data							
Supply current	I_P	–	11	–	mA	17	

[1] All typ. values under test conditions: T_{amb} = 25 °C and V_P = 15 V.
[2] For dynamic: $-I_{SL}$ = 1,5 x specified values.
[3] Short-circuit duration max. 1 s.

CHARACTERISTICS (continued)

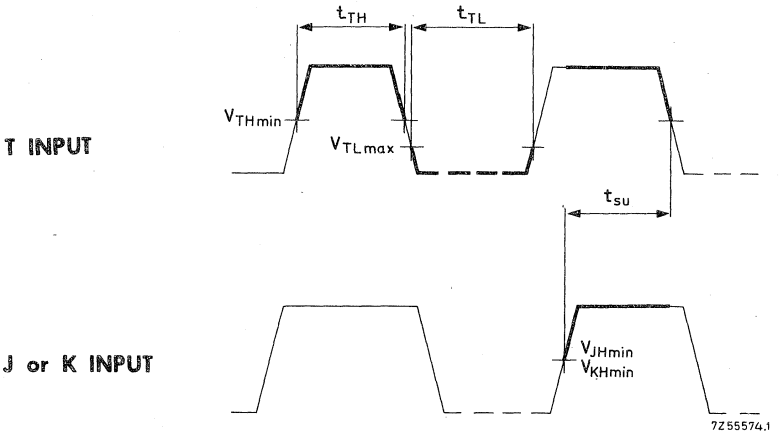
Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max.		Conditions and references
Dynamic data						
Times						
Propagation delay:						
T ⟶ Q						
fall time	t_{pdf}	–	470	–	ns	
rise time	t_{pdr}	–	330	–	ns	
S ⟶ Q						
fall time	t_{pdf}	–	340	–	ns	
rise time	t_{pdr}	–	195	–	ns	
output rise time	t_r	–	410	–	ns	
output fall time	t_f	–	75	–	ns	C_L = 10 pF
Clock rate						N = 1
(duty cycle 50%)	f_c	–	0,5	–	MHz	T_{amb} = 25 °C
Input times						V_{pd} = 4,5 V
T input	t_{TH}	0,6	–	–	µs	
	t_{TL}	0,6	–	–	µs	
S input	t_{SL}	1,0	–	–	µs	
J or K input						
hold time	t_{hold}	0	–	–	µs	
set-up time	t_{su}	0	–	–	µs	
T input slope	$(-dV/dt)_{Tmin}$			1	V/µs	

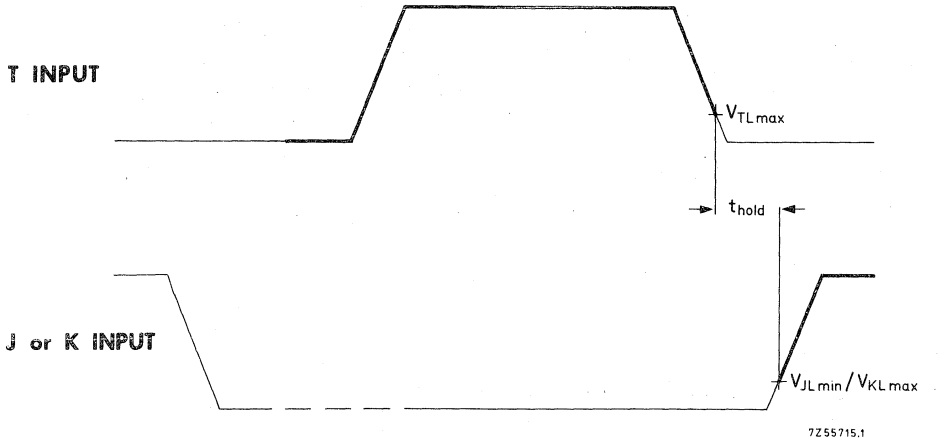
[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

CHARACTERISTICS (continued)

Dynamic data



Waveforms illustrating conditions for change of state



Waveforms illustrating conditions for no change of state

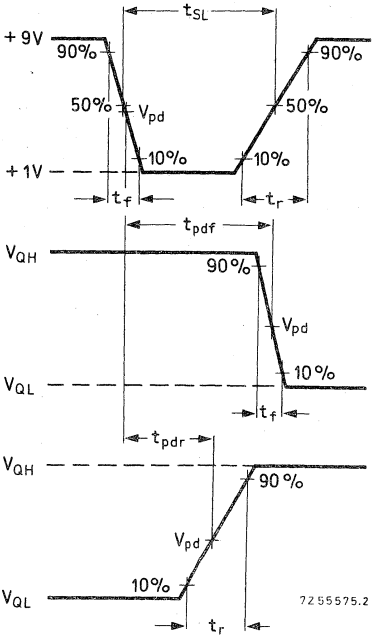
CHARACTERISTICS (continued)

Dynamic data

$S_2(S_1)$ INPUT

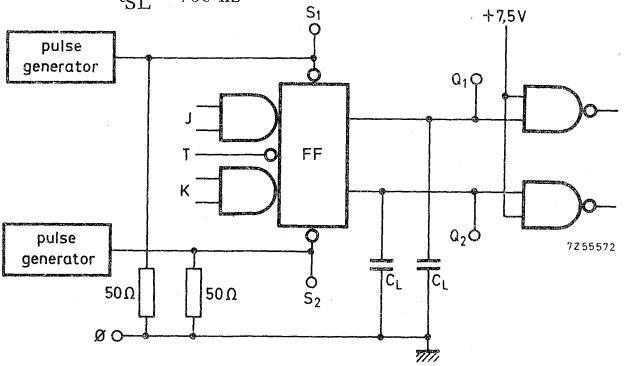
$Q_1(Q_2)$ OUTPUT

$Q_2(Q_1)$ OUTPUT



Pulse generator (S-input): t_r = 350 ns
t_f = 120 ns
t_{SL} = 700 ns

$V_{pd} = +4,5$ V

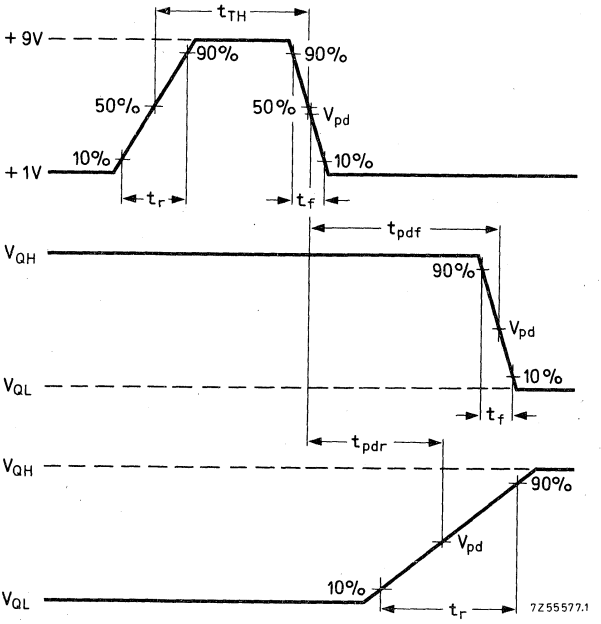


Measuring conditions: V_P = +12 V; +15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C
Slow-down terminals are not connected
All other inputs are floating.

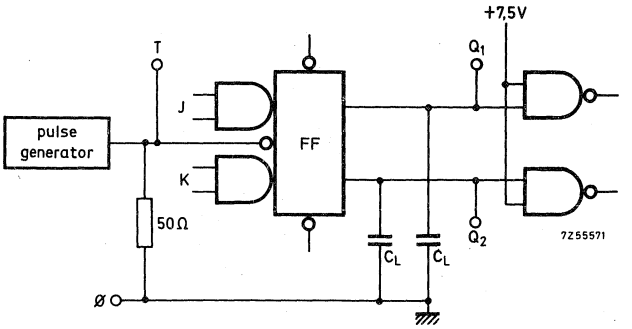
Waveforms illustrating conditions for set inputs. Set input signals are not supplied simultaneously.

CHARACTERISTICS (continued)

Dynamic data



Pulse generator (T-input): t_r = 350 ns V_{pd} = +4, 5 V
t_f = 120 ns
t_{TH} = 400 ns

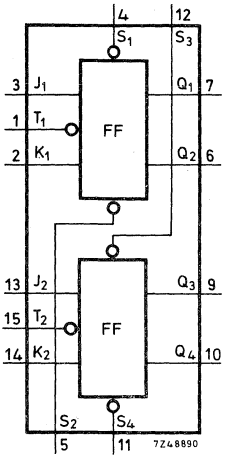


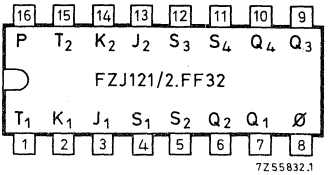
Measuring conditions: V_P = +12 V; +15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C
Slow-down terminals are not connected
All other inputs are floating.

Waveforms and loading circuit illustrating measurement of t_{pdr} and t_{pdf}.

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

DUAL JK MASTER-SLAVE FLIP-FLOP





QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Available d.c. fan-out T_{amb} = 0 to +70 °C } LOW state	N_{aL}	max.	10	
Operating frequency at T_{amb} = 25 °C duty cycle 50%: range I/II	f_c	typ.	0,5	MHz
Average supply current at T_{amb} = 25 °C				
V_P = 13,5 V	I_{Pav}	typ.	15	mA
V_P = 17 V	I_{Pav}	typ.	20	mA
D.C. noise margin at T_{amb} = 25 °C				
range I : V_P = 12 V	$M_L = M_H$	typ.	5	V
range II : V_P = 15 V	M_L	typ.	5	V
	M_H	typ.	8	V

PACKAGE OUTLINE 16-lead plastic dual in-line (see general section).

GENERAL DESCRIPTION

The FZJ121/2.FF32 comprises two independent JK flip-flops, operating on the master-slave principle. Operation depends on voltage levels only, e.g. rise and fall times of all input signals including the trigger signals are immaterial.
The set and reset inputs (overriding any other input) are active at LOW level. There are no slow-down terminals.
Typical applications include counters and shift registers.

FUNCTION TABLES

t_n		$t_n + 1$
J_1 J_2	K_1 K_2	Q_1 Q_3
L	L	Q_n
L	H	L
H	L	H
H	H	$\overline{Q_n}$
Q_2 is opposite Q_1 Q_4 is opposite Q_3		

S_1 S_3	S_2 S_4	Q_1 Q_3	Q_2 Q_4
L	H	H	L
H	L	L	H
H	H	$Q_1(Q_3)$	$Q_2(Q_4)$ 1)
L	L	X	X 2)

1) $Q_2(Q_4)$ is opposite $Q_1(Q_3)$
2) If S_1 (S_3) and S_2 (S_4) return to HIGH simultaneously the Q-states will be indeterminate.

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_J, V_K, V_T	max.	18	V
Input current at V_P = 17 V	$-I_{IL}$	max.	25	mA
Storage temperature	T_{stg}		−65 to +150	°C
Operating ambient temperature	T_{amb}		0 to +70	°C
Output short-circuit duration	t_{Qsc}	max.	1	s 1)

1) Only one output may be shorted at a time.

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}	0	to	+70	°C
Uniform system supply voltage (range I)	V_P	11,4	to	13,5	V
(range II)	V_P	13,5	to	17	V
Available d.c. fan-out	N_{aL}	max.		10	
D.C. noise margin to all inputs: range I at V_{Pmin}	M_L	min.		2,8	V
	M_H	min.		2,8	V
range II at V_{Pmin}	M_L	min.		2,8	V
	M_H	min.		4,5	V
Supply current at range I : V_P = 12 V	I_P	typ.		15	mA
range II : V_P = 15 V	I_P	typ.		20	mA
Thermal resistance from system to ambient	R_{th}	max.		150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ. [1]	max.		Conditions and references	
						V_P (V)	
Static data							
Voltages							
Input HIGH: T	V_{TH}	6,5	-	-	V	11,4	$V_{QL} \leq 1,7$ V; I_{QL} = 15 mA
J; K	V_{IH}	8,0	-	-	V	11,4	
S	V_{SH}	7,5	-	-	V	11,4	
Input LOW: T	V_{TL}	-	-	4,0	V	11,4	$V_{QH} \geq 10$ V; $-I_{QH}$ = 0,1 mA
J; K	V_{IL}	-	-	5,5	V	and	
S	V_{SL}	-	-	4,5	V	13,5	
Output HIGH	V_{QH}	10,0	11,3	-	V	11,4 and 13,5	$V_{IL} \leq 4,5$ V [2]; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	-	0,9	1,7	V	11,4	$V_{IH} \geq 7,5$ V [2]; I_{QL} = 15 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	-	V	11,4	
LOW	M_L	2,8	5,0	-	V	11,4	
Currents							
Input HIGH: T	I_{TH}	-	-	3	µA	13,5	V_{IH} = 13,5 V (other inputs 0V)
J; K; S	I_{IH}	-	-	1	µA		
Input LOW: T	$-I_{TL}$	-	1,6	3,0	mA	13,5	V_{IL} = 1,7 V
J; K; S [3]	$-I_{IL}$	-	0,8	1,5	mA	13,5	V_{IL} = 1,7 V
Output HIGH	$-I_{QH}$	0,1	-	-	mA	11,4 and 13,5	V_{QH} = 10 V
Output LOW	I_{QL}	15	-	-	mA	11,4	V_{QL} = 1,7 V
Supply data							
Supply current	I_P	-	15	24	mA	13,5	

1) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.
2) Measured to S_2 and S_1.
3) For dynamic: $-I_{SL}$ = 1,5 x specified values.

CHARACTERISTICS (continued)

Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max.		Conditions and references
Dynamic data						
Times						
Propagation delay:						
T ⟶ Q						
fall time	t_{pdf}	270	450	770	ns	
rise time	t_{pdr}	160	290	520	ns	
R or S ⟶ Q						
fall time	t_{pdf}	180	330	580	ns	
rise time	t_{pdr}	70	165	330	ns	
output fall time	t_f	70	120	210	ns	
output rise time	t_r	200	340	570	ns	C_L = 10 pF
Clock rate						N = 1
(duty cycle 50%)	f_c	0,2	0,5	–	MHz	T_{amb} = 25 °C
Input times						V_{pd} = 4,5 V
T input	t_{TH}	0,6	–	–	µs	
R input	t_{RL}	1,0	–	–	µs	
S input	t_{SL}	1,0	–	–	µs	
J or K input						
hold time	t_{hold}	0	–	–	ns	
set-up time	t_{su}	0	–	–	ns	
T input slope	$(-dV/dt)_{Tmin}$			1	V/µs	

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

CHARACTERISTICS (continued)

Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ. [1]	max.		Conditions and references	
						V_P (V)	
Static data							
Voltages							
Input HIGH: T	V_{TH}	6,5	-	-	V	13,5	$V_{QL} \leq 1,7$ V; I_{QL} = 18 mA
J; K	V_{IH}	8,0	-	-	V	13,5	
S	V_{SH}	7,5	-	-	V	13,5	
Input LOW: T	V_{TL}	-	-	4,0	V	11,4 and 13,5	$V_{QH} \geq 12$ V; $-I_{QH}$ = 0,1 mA
J; K	V_{IL}	-	-	5,5	V		
S	V_{SL}	-	-	4,5	V		
Output HIGH	V_{QH}	12,0	14,3	-	V	11,4 and 13,5	$V_{IL} \leq 4,5$ V [2]; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	-	1,1	1,7	V	13,5	$V_{IH} \geq 7,5$ V [2]; I_{QL} = 18 mA
D.C. noise margin: HIGH	M_H	4,5	8,0	-	V	13,5	
LOW	M_L	2,8	5,0	-	V	13,5	
Currents							
Input HIGH: T	I_{TH}	-	-	3,0	µA	17	V_{IH} = 17 V (other inputs 0V)
J; K; S	I_{IH}	-	-	1,0	µA		
Input LOW: T	$-I_{TL}$	-	2,0	3,6	mA	17	V_{IL} = 1,7 V
J; K; S [3]	$-I_{IL}$	-	1,0	1,8	mA	17	
Output HIGH	$-I_{QH}$	0,1	-	-	mA	13,5 and 17	V_{QH} = 12 V
Output LOW	I_{QL}	18	-	-	mA	13,5	V_{QL} = 1,7 V
Supply data							
Supply current	I_P	-	20	32	mA	17	

1) All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.
2) Measured to S_2 and S_1.
3) For dynamic: $-I_{SL}$ = 1,5 x specified values.

CHARACTERISTICS (continued)

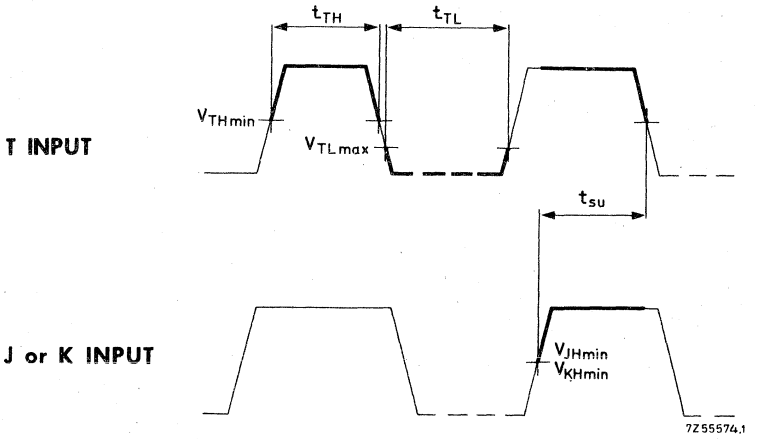
Test conditions at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max.		Conditions and references
Dynamic data						
Times						
Propagation delay:						
T ⟶ Q						
fall time	t_{pdf}	–	470	–	ns	
rise time	t_{pdr}	–	330	–	ns	
R or S ⟶ Q						
fall time	t_{pdf}	–	340	–	ns	
rise time	t_{pdr}	–	195	–	ns	
output fall time	t_f	–	75	–	ns	
output rise time	t_r	–	410	–	ns	C_L = 10 pF
Clock rate						N = 1
(duty cycle 50%)	f_c	0,2	0,5	–	MHz	T_{amb} = 25 °C
Input times						V_{pd} = 4,5 V
T input	t_{TH}	0,6	–	–	µs	
R input	t_{RL}	0,6	–	–	µs	
S input	t_{SL}	1,0	–	–	µs	
J or K input						
hold time	t_{hold}	0	–	–	ns	
set-up time	t_{su}	0	–	–	ns	
T input slope	$(-dV/dt)_{Tmin}$			1	V/µs	

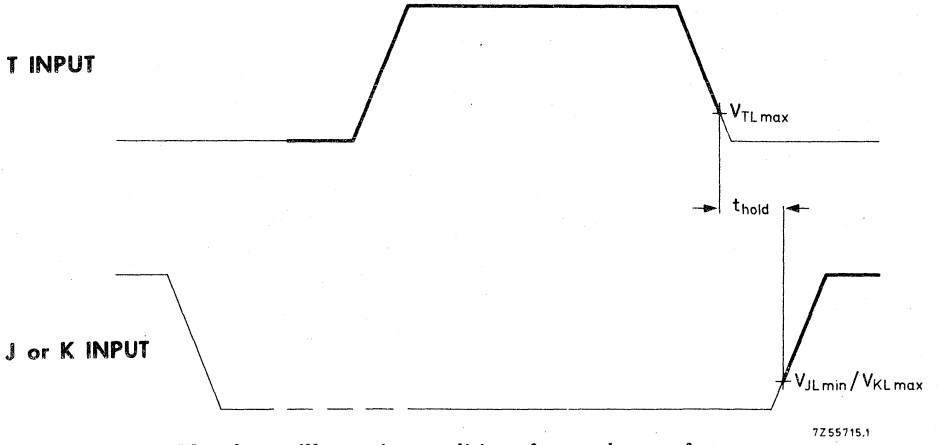
[1]) All typical values under test conditions : T_{amb} = 25 °C and V_P = 15 V.

CHARACTERISTICS (continued)

Dynamic data



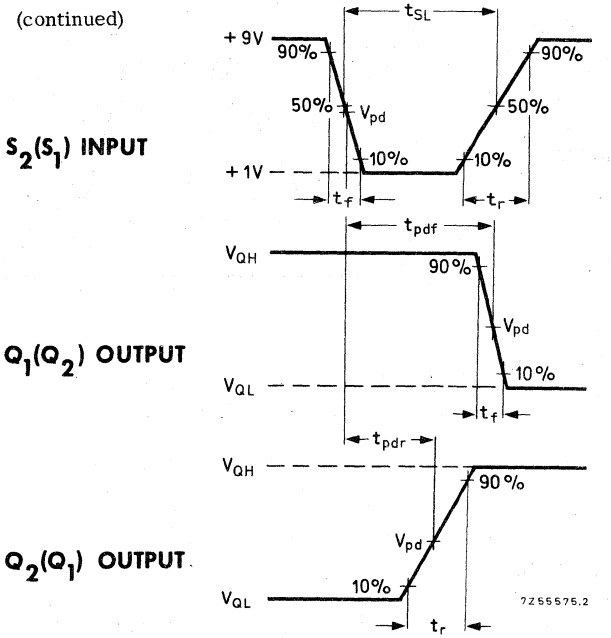
Waveforms illustrating conditions for change of state



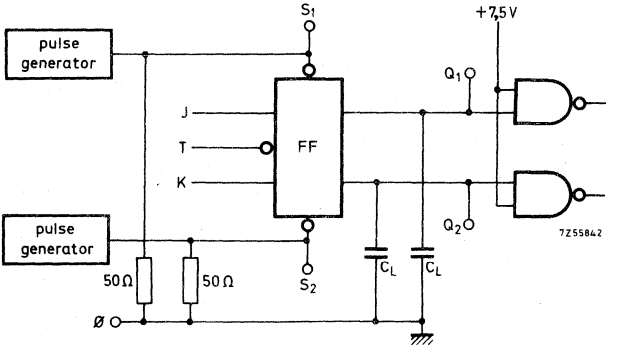
Waveforms illustrating conditions for no change of state

CHARACTERISTICS (continued)

Dynamic data



Pulse generator (S-input): t_r = 350 ns; t_f = 120 ns; t_{SL} = 700 ns; V_{pd} =+4, 5 V

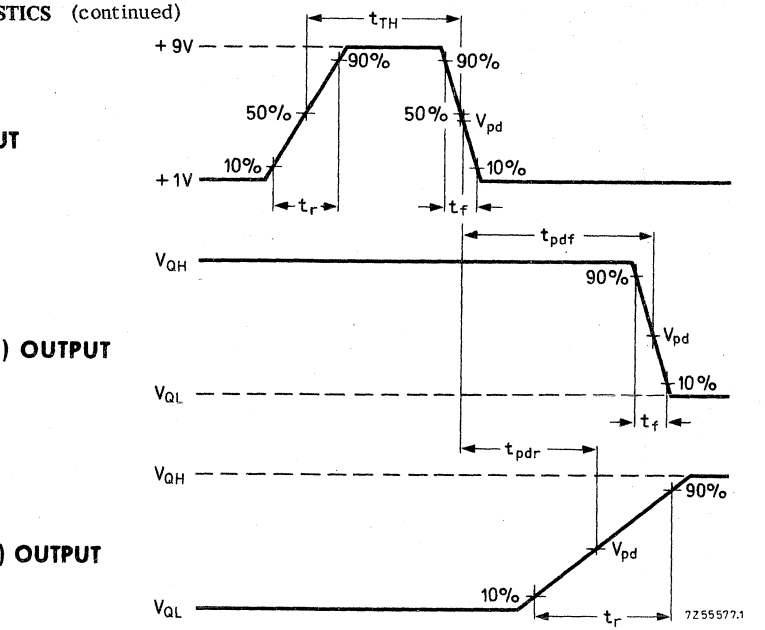


Measuring conditions: V_P = +12 V; +15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C
All other inputs are floating.

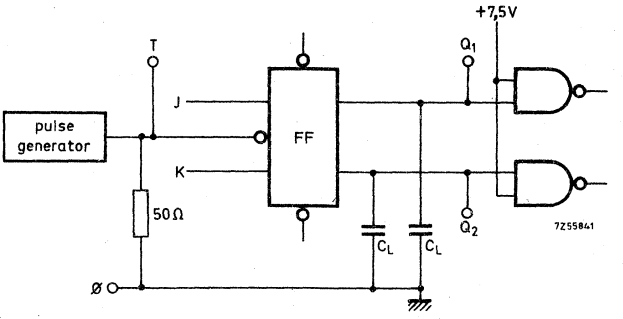
Waveforms illustrating conditions for set inputs. Set input signals are not supplied simultaneously.

CHARACTERISTICS (continued)

Dynamic data



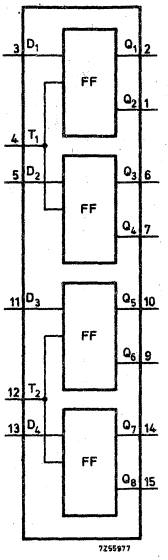
Pulse generator (T-input): t_r = 350 ns; t_f = 120 ns; t_{TH} = 400 ns; V_{pd} = +4,5 V



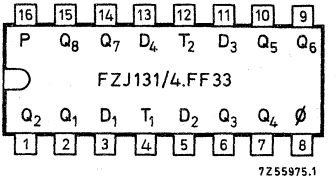
Measuring conditions: V_P = +12 V; +15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = 25 °C
All other inputs are floating.

Waveforms and loading circuit illustrating measurement of t_{pdr} and t_{pdf}.

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.



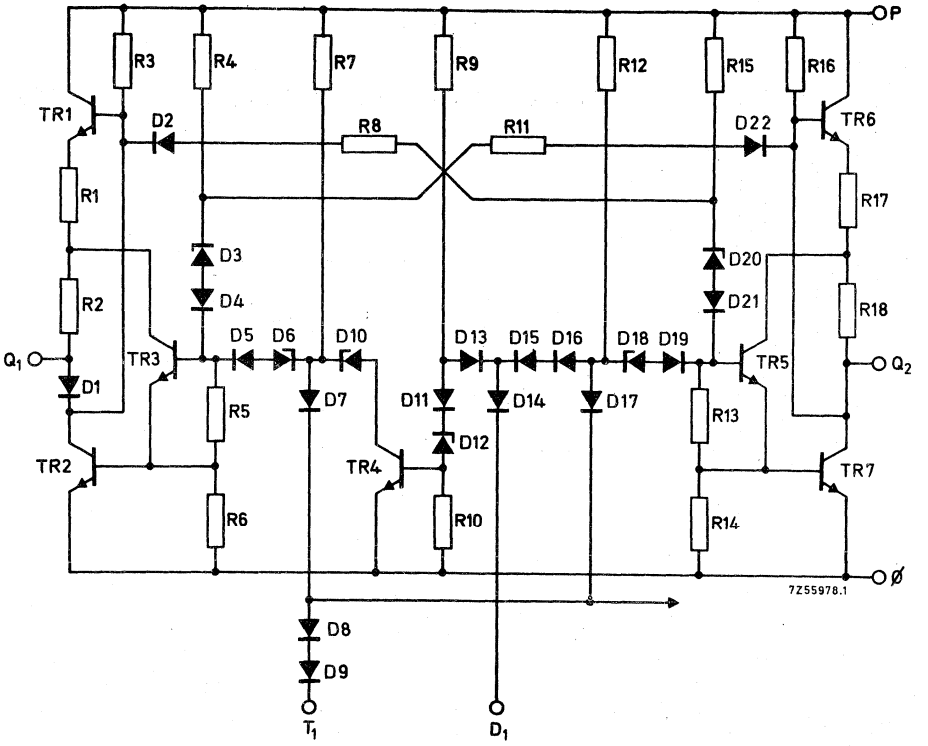
QUADRUPLE D-TYPE LATCH FLIP-FLOP



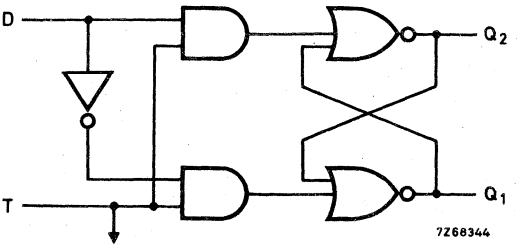
QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Available d.c. fan-out T_{amb} = 0 to +70 °C } LOW state	N_{aL}	max.	10	
Average supply current at T_{amb} = 25 °C				
V_P = 13,5 V	I_{Pav}	typ.	22	mA
V_P = 17 V	I_{Pav}	typ.	28	mA
D.C. noise margin at T_{amb} = 25 °C				
range I : V_P = 12 V	$M_L = M_H$	typ.	5	V
range II : V_P = 15 V	M_L	typ.	5	V
	M_H	typ.	8	V
Average power consumption				
(50% duty cycle) range I : V_P = 12 V	P_{av}	typ.	264	mW
range II : V_P = 15 V	P_{av}	typ.	420	mW

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAM



LOGIC DIAGRAM



LOGIC FUNCTIONS

The FZJ131/4.FF33 comprises four D-type latch flip-flops. Information present at a data input D, is transferred to Q as long as T is HIGH.
When T is LOW, D does not affect Q.

Function table

input		output
T	D (t_n)	Q ($t_n + 1$)
L	L	Q_n
L	H	Q_n
H	L	L
H	H	H

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)

t_n = bit-time before trigger pulse
t_{n+1} = bit-time after trigger pulse

RATING Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_D, V_T	max.	18	V
Storage temperature	T_{stg}		−65 to +150	°C
Operating ambient temperature	T_{amb}		0 to +70	°C
Output short-circuit duration	t_{Qsc}	max.	1	s [1]

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}		0 to +70	°C
Uniform system supply voltage (range I)	V_P		11,4 to 13,5	V
(range II)	V_P		13,5 to 17	V
Available d.c. fan-out	N_{aL}	max.	10	
D.C. noise margin to all inputs: range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Power consumption (50% duty cycle) at range I : V_{Pmax}	P_{av}	max.	432	mW
at range II : V_{Pmax}	P_{av}	max.	720	mW
Supply surrent at range I : V_P = 12 V	I_P	max.	32	mA
range II : V_P = 15 V	I_P	max.	42	mA
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

1) Only one output may be shorted at a time.

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ.[1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH: D, T	V_{IH}	7,5	–	–	V		
Input LOW: D, T	V_{IL}	–	–	4,5	V		
Output HIGH	V_{QH}	10	11,3	–	V	11,4	V_I = 7,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	0,9	1,7	V	11,4	V_{TH} = 7,5 V; V_{DL} = 4,5 V; I_{QL} = 15 mA
D.C. noise margin							
HIGH	M_H	2,5	5,0	–	V	11,4	
LOW	M_L	2,8	5,0	–	V	11,4	
Currents							
Input HIGH: D, T	I_{IH}	–	–	1	μA	13,5	V_{IH} = 13,5 V other inputs 0 V
Input LOW: D	$-I_{DL}$	–	–	3	mA	13,5	V_{DL} = 1,7 V
T	$-I_{TL}$	–	–	6	mA	13,5	V_{TL} = 1,7 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	11,4	V_{QH} = 10 V
Output LOW	I_{QL}	15	–	–	mA	11,4	V_{QL} = 1,7 V
Output short-circuited	$-I_{Qsc}$	9	15	25	mA	13,5	V_I = 0; V_Q = 0
Supply data							
Supply current	I_P	–	22	32	mA	13,5	V_I = 0

1) All typ. values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

CHARACTERISTICS (continued)

Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max.		conditions and references
Dynamic data						
Times						
Propagation delay:						
$T_1 \longrightarrow Q_1$						
fall time	t_{pdf}	70	120	210	ns	
rise time	t_{pdr}	90	160	310	ns	
$T_1 \longrightarrow Q_2$						
fall time	t_{pdf}	70	120	210	ns	
rise time	t_{pdr}	90	150	310	ns	
$D_1 \longrightarrow Q_1$						
fall time	t_{pdf}	30	70	150	ns	
rise time	t_{pdr}	90	175	310	ns	
$D_1 \longrightarrow Q_2$						
fall time	t_{pdf}	70	130	290	ns	
rise time	t_{pdr}	30	70	150	ns	C_L = 10 pF N = 1
output fall time	t_f	15	35	60	ns	T_{amb} = 25 °C
output rise time	t_r	50	90	170	ns	V_{pd} = 4,5 V
Clock rate (duty cycle 50%)	f_c	0,5	-	-	MHz	
D input						
hold time	t_{holdH}	150	-	-	ns	
	t_{holdL}	50	-	-	ns	
set-up time	t_{suH}	300	-	-	ns	
	t_{suL}	500	-	-	ns	
T input	$(-dV/dt)_{Tmin}$			1	V/µs	

1) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

CHARACTERISTICS (continued)

Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ.[1]	max.		Conditions and references	
						V_P (V)	
Static data							
Voltages							
Input HIGH: D, T	V_{IH}	7,5	–	–	V		
Input LOW: D, T	V_{IL}	–	–	4,5	V		
Output HIGH	V_{QH}	12	14,3	–	V	13,5	V_I = 7,5 V $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1,0	1,7	V	13,5	V_{TH} = 7,5 V V_{DL} = 4,5 V I_{QL} = 18 mA
D.C. noise margin							
HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents							
Input HIGH: D, T	I_{IH}	–	–	1,0	µA	17	V_{IH} = 17 V (other inputs 0 V)
Input LOW: D	$-I_{DL}$	–	–	3,6	mA	17	V_{DL} = 1,7 V
T	$-I_{TL}$	–	–	7,2	mA	17	V_{TL} = 1,7 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	13,5	V_{QH} = 12 V
Output LOW	I_{QL}	18	–	–	mA	13,5	V_{QL} = 1,7 V
Output short-circuited	$-I_{Qsc}$	9	15	25	mA	17	V_I = 0; V_Q = 0
Supply data							
Supply current	I_P	–	28	42	mA	17	V_I = 0

1) All typ. values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

CHARACTERISTICS (continued)

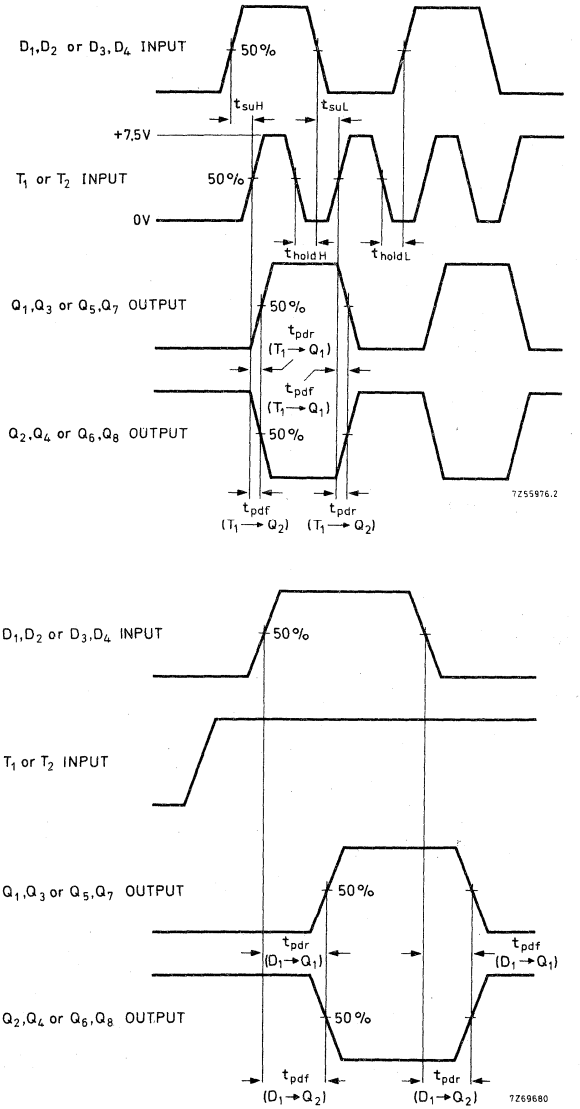
Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max	conditions and references
Dynamic data					
Times					
Propagation delay:					
$T_1 \rightarrow Q_1$					
fall time	t_{pdf}				
rise time	t_{pdr}				
$T_1 \rightarrow Q_2$					
fall time	t_{pdf}				
rise time	t_{pdr}				
$D_1 \rightarrow Q_1$					
fall time	t_{pdf}				
rise time	t_{pdr}				
$D_1 \rightarrow Q_2$					
fall time	t_{pdf}				C_L = 10 pF N = 1 T_{amb} = 25 °C V_{pd} = 4,5 V
rise time	t_{pdr}		t.b.f.		
output fall time	t_f				
output rise time	t_r				
Clock rate (duty cycle 50%)	f_c				
D input hold time					
set-up time					
T input slope	$(-dV/dt)_{Tmin}$	-	-	1 V/µs	

[1] All typ. values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

CHARACTERISTICS (continued)

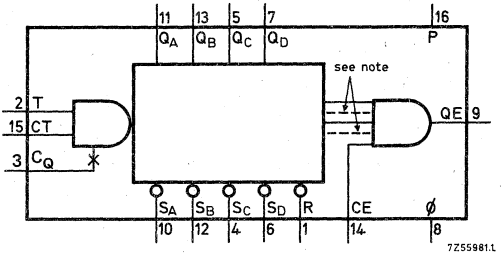
Dynamic data

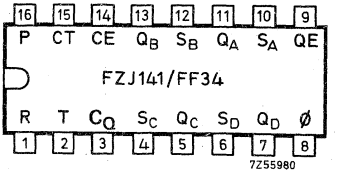


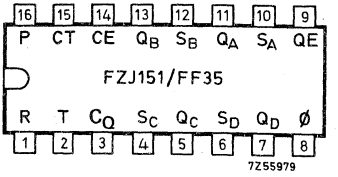
Waveforms illustrating measurement of t_{pdr} and t_{pdf} (T→Q): (D→Q)

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

SINGLE SYNCHRONOUS DECIMAL COUNTER
SINGLE SYNCHRONOUS 4-BIT BINARY COUNTER







Note

FZJ141/FF34: without connections indicated by dotted line
FZJ151/FF35: with connections indicated by dotted line

QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Available d.c. fan-out T_{amb} = 0 to +70 °C } LOW state	N_{aL}	max.	10	
Operating frequency at T_{amb} = 25 °C duty cycle 50%: range I/II	f_c	max.	1,5	MHz
Average supply current at T_{amb} = 25 °C				
V_P = 13,5 V at V_{QL}	I_{Pav}	typ.	20	mA
V_P = 17 V at V_{QL}	I_{Pav}	typ.	23	mA
D.C. noise margin at T_{amb} = 25 °C				
range I : V_P = 12 V	$M_L = M_H$	typ.	5	V
range II : V_P = 15 V	M_L	typ.	5	V
	M_H	typ.	8	V

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

GENERAL DESCRIPTION

The FZJ141/FF34 and FZJ151/FF35 are synchronous counters consisting of 4 master-slave flip-flops.
The FZJ141/FF34 is a decimal counter with common T and R input and a set (S) input for each bit. The condition input (CE) and output (QE) are for coupling these circuits.
The FZJ151/FF35 is a 4-bit binary counter with a common T and R input and a set input per bit. The direct reset inhibits the count and simultaneously all flip-flops return to LOW. The output information of each flip-flop of both circuits changes when T goes from HIGH to LOW.

LOGIC FUNCTIONS

Count condition: $S_A = S_B = S_C = S_D = CT = CE = R = HIGH$

FZJ141/FF34

count	outputs				
	Q_A	Q_B	Q_C	Q_D	QE
0	L	L	L	L	L
1	H	L	L	L	L
2	L	H	L	L	L
3	H	H	L	L	L
4	L	L	H	L	L
5	H	L	H	L	L
6	L	H	H	L	L
7	H	H	H	L	L
8	L	L	L	H	L
9	H	L	L	H	H

FZJ151/FF35

count	outputs				
	Q_A	Q_B	Q_C	Q_D	QE
0	L	L	L	L	L
1	H	L	L	L	L
2	L	H	L	L	L
3	H	H	L	L	L
4	L	L	H	L	L
5	H	L	H	L	L
6	L	H	H	L	L
7	H	H	H	L	L
8	L	L	L	H	L
9	H	L	L	H	L
10	L	H	L	H	L
11	H	H	L	H	L
12	L	L	H	H	L
13	H	L	H	H	L
14	L	H	H	H	L
15	H	H	H	H	H

Pin description

CT = condition enable trigger at input T
CE = condition enable for output QE
QE = output enable

Set and reset conditions

inputs					outputs			
R	S_A	S_B	S_C	S_D	Q_A	Q_B	Q_C	Q_D
L	H	H	H	H	L	L	L	L
L	L	X	X	X	H	X	X	X
L	X	L	X	X	X	H	X	X
L	X	X	L	X	X	X	H	X
L	X	X	X	L	X	X	X	H

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

All set and reset inputs, when LOW, override the count input signal and set the flip-flops corresponding to the table at the left.
Set and reset terminals may not be left floating but must be connected to the supply voltage V_P.

LOGIC FUNCTIONS (continued)

Enable conditions

input CT	
L	no count
H	count

input CE	enable output QE
L	L
H	X *)

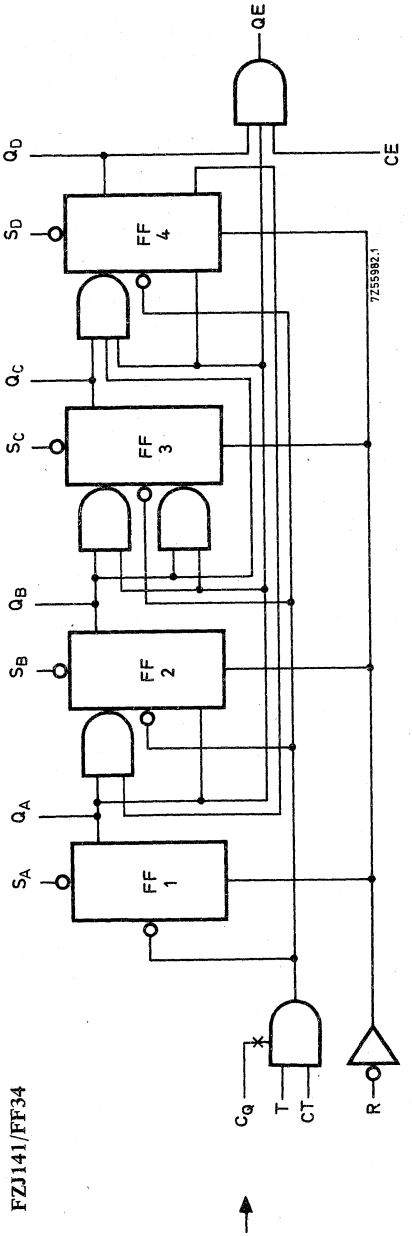
*) Depends on logic state of other inputs of the final gate.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

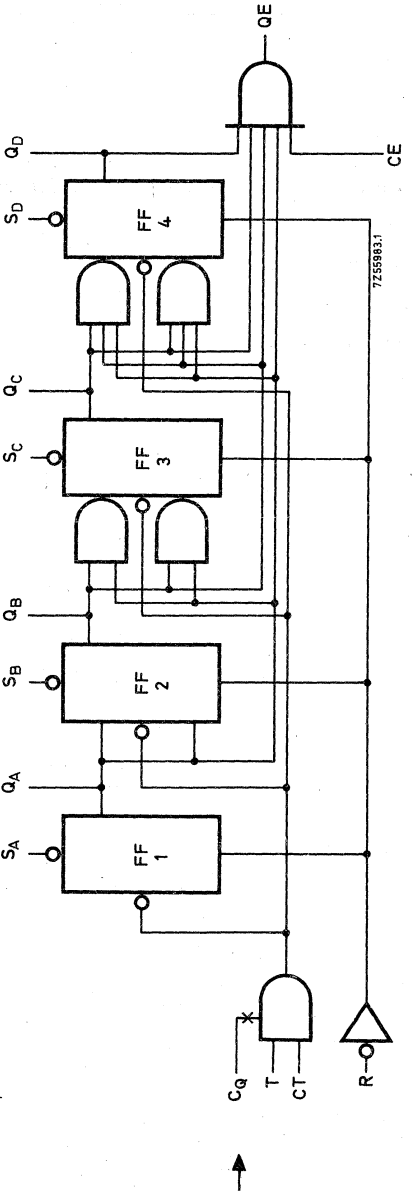
Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_I	max.	18	V
Input current at V_P = 17 V	$-I_{IL}$	max.	25	mA
Storage temperature	T_{stg}	−65 to	+150	°C
Operating ambient temperature	T_{amb}	0 to	+70	°C

LOGIC DIAGRAMS

FZJ141/FF34



FZJ151/FF35



SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}	0 to	+70	°C
Uniform system supply voltage (range I)	V_P	11,4 to	13,5	V
(range II)	V_P	13,5 to	17	V
Available d.c. fan-out	N_{aL}	max.	10	
D.C. noise margin to all inputs: range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Clock rate at T_{amb} = 25 °C duty cycle 50%; range I/II	f_c	min.	0,5	MHz
	f_c	typ.	1,5	MHz
Supply current at range I : V_P = 12 V				
at V_{QH}	I_P	typ.	12	mA
at V_{QL}	I_P	typ.	20	mA
at range II : V_P = 15 V				
at V_{QH}	I_P	typ.	15	mA
at V_{QL}	I_P	typ.	23	mA
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ. [1])	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{IH}	7,5	–	–	V	11,4	
Input LOW	V_{IL}	–	–	4,5	V	13,5	
Output HIGH	V_{QH}	10	11,3	–	V	11,4	V_{IL} = 4,5 V; $-I_Q$ = 0,1 mA
Output LOW	V_{QL}	–	0,9	1,7	V	11,4	V_{IH} = 7,5 V; I_Q = 15 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	–	V	11,4	
LOW	M_L	2,8	5,0	–	V	11,4	
Currents							
Input HIGH	I_{IH}	–	–	1	µA	13,5	V_{IH} = 13,5 V
Input LOW	$-I_{IL}$	–	0,8	1,5	mA	13,5	V_{IL} = 1,7 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	11,4 and 13,5	V_{QH} = 10 V
Output LOW	I_{QL}	15	–	–	mA	11,4	V_{QL} = 1,7 V
Output short-circuited	$-I_{Qsc}$	9	15	25	mA	13,5	V_I = 0; V_Q = 0
Supply data							
Supply current at V_{QH}	I_P	–	12	–	mA	13,5	V_I = 13,5 V
at V_{QL}	I_P	–	20	–	mA	13,5	V_R = 0 V; other inputs 13,5 V

1) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

CHARACTERISTICS (continued)

Test conditions: at range I (V_P = 12 V)

	Symbol	min.	typ. [1]	max.		Conditions and references
Dynamic data						
Times						
Propagation delay:						
$T \rightarrow Q_A; Q_B; Q_C; Q_D$						
fall time	t_{pdf}	90	200	450	ns	V_{pd} = 4,5 V; N = 1; C_L = 10 pF; T_{amb} = 25 °C
rise time	t_{pdr}	90	200	450	ns	
$T \rightarrow QE$						
fall time	t_{pdf}	150	300	500	ns	
rise time	t_{pdr}	200	400	700	ns	
$CE \rightarrow QE$						
fall time	t_{pdf}	25	60	200	ns	
rise time	t_{pdr}	90	200	450	ns	
$R \rightarrow Q_A; Q_B; Q_C; Q_D$						
fall time	t_{pdf}	70	150	310	ns	
$S_A \rightarrow Q_A$; $S_B \rightarrow Q_B$; $S_C \rightarrow Q_C$; $S_D \rightarrow Q_D$						
rise time	t_{pdr}	30	120	210	ns	
Clock pulse duration	t_T	0,5	–	–	µs	V_{pd} = 4,5 V; N = 1
Clock rate	f_c	0,5	–	–	MHz	duty cycle 50%
Reset pulse duration	t_{RL}	0,5	–	–	µs	V_{pd} = 4,5 V; N = 1; T_{amb} = 25 °C
Reset recovery time (T input)	t_{Rrec}	–	–	2	µs	
Reset pulse duration during set operation	t_{RLS}	1	–	–	µs	
Set inputs (S_A; S_B; S_C; S_D) set-up time	t_{su}	1	–	–	µs	
Set inputs (S_A; S_B; S_C; S_D) hold time	t_{hold}	1	–	–	µs	
Output fall time (at Q)	t_f	5	20	60	ns	
Output rise time (at Q)	t_r	90	250	450	ns	
Output fall time (at QE)	t_f	30	60	210	ns	
Output rise time (at QE)	t_r	70	140	310	ns	
T input slope	$(-dV/dt)_{Tmin}$			1	V/µs	

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

CHARACTERISTICS (continued)

Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{IH}	7,5	–	–	V	13,5	
Input LOW	V_{IL}	–	–	4,5	V	17,0	
Output HIGH	V_{QH}	12	14,3	–	V	13,5	V_{IL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1	1,7	V	13,5	V_{IH} = 7,5 V; I_{QL} = 18 mA
D.C. noise margin: HIGH	M_H	4,5	8	–	V	13,5	
LOW	M_L	2,8	5	–	V	13,5	
Currents							
Input HIGH	I_{IH}	–	–	1	µA	17,0	V_I = 17,0 V
Input LOW	$-I_{IL}$	–	1,0	1,8	mA	17,0	V_I = 1,7 V
Output HIGH	$-I_{QH}$	0,1	–	–	mA	13,5	V_{QH} = 12 V
Output LOW	I_{QL}	18	–	–	mA	13,5	V_{QL} = 1,7 V
Output short-circuited	$-I_{Qsc}$	9	15	25	mA	17,0	V_I = 0; V_Q = 0
Supply data							
Supply current at V_{QH}	I_P	–	15	23	mA	17,0	V_I = 17,0 V
at V_{QL}	I_P	–	23	36,5	mA	17,0	V_R = 0 V; other inputs 17,0 V

1) All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

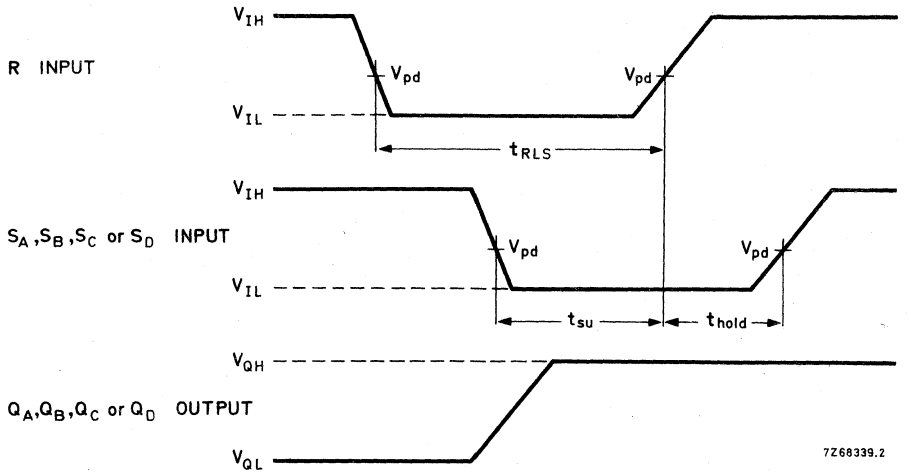
CHARACTERISTICS (continued)

Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max.		Conditions and references
Dynamic data						
Times						
Propagation delay:						
T → Q						
fall time	t_{pdf}				ns	C_L = 10 pF N = 1 T_{amb} = 25 °C V_{pd} = 4,5 V
rise time	t_{pdr}				ns	
T → QE						
fall time	t_{pdf}				ns	
rise time	t_{pdr}				ns	
C_E → QE						
fall time	t_{pdf}				ns	
rise time	t_{pdr}				ns	
R → Q						
fall time	t_{pdf}		t.b.f.		ns	
S_A → Q_A, S_B → Q_B						
rise time	t_{pdr}				ns	
S_C → Q_C, S_D → Q_D						
fall time	t_{pdf}				ns	
output fall time } at Q	t_f				ns	
output rise time } at Q	t_r				ns	
output fall time } at QE						
output rise time } at QE						
T input slope	$(-dV/dt)_{Tmin}$		1		V/µs	

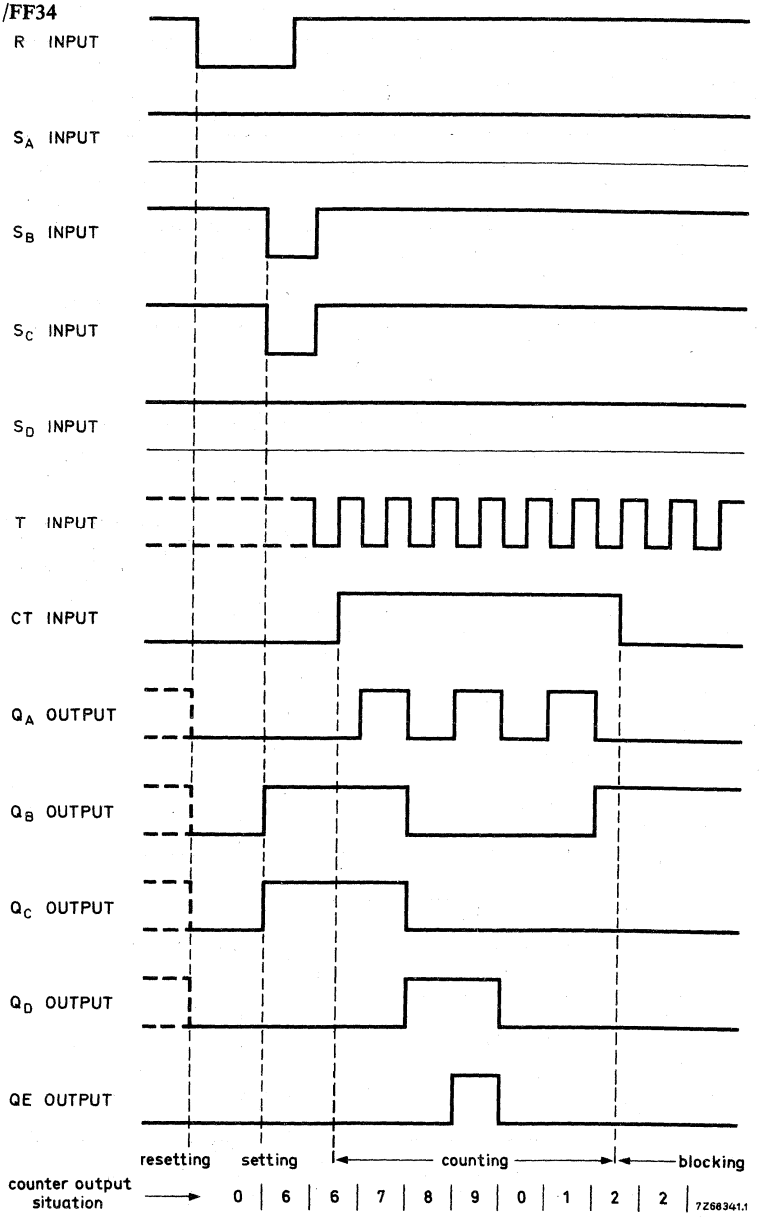
[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

CHARACTERISTIC (continued)



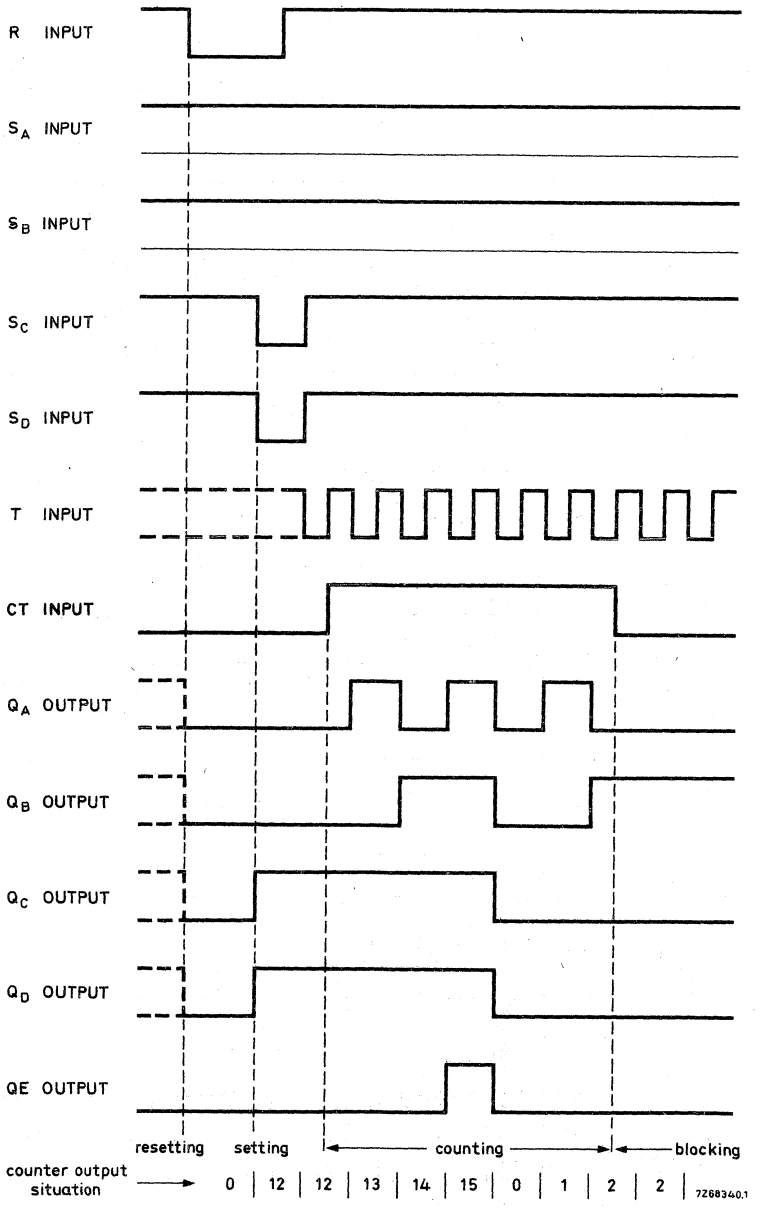
CHARACTERISTICS (continued)

FZJ141/FF34



CHARACTERISTICS (continued)

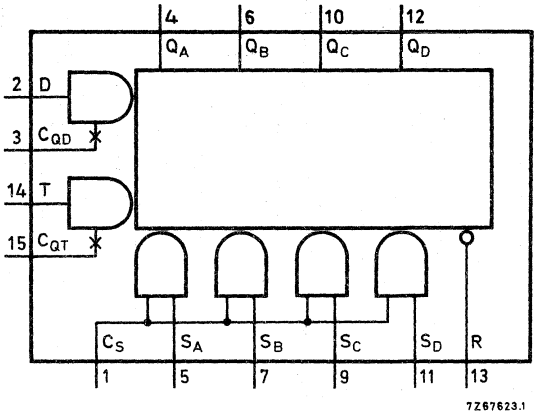
FZJ151/FF35

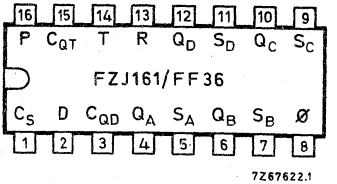


The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

SINGLE SYNCHRONOUS 4-BIT SHIFT REGISTER

with slow-down capability





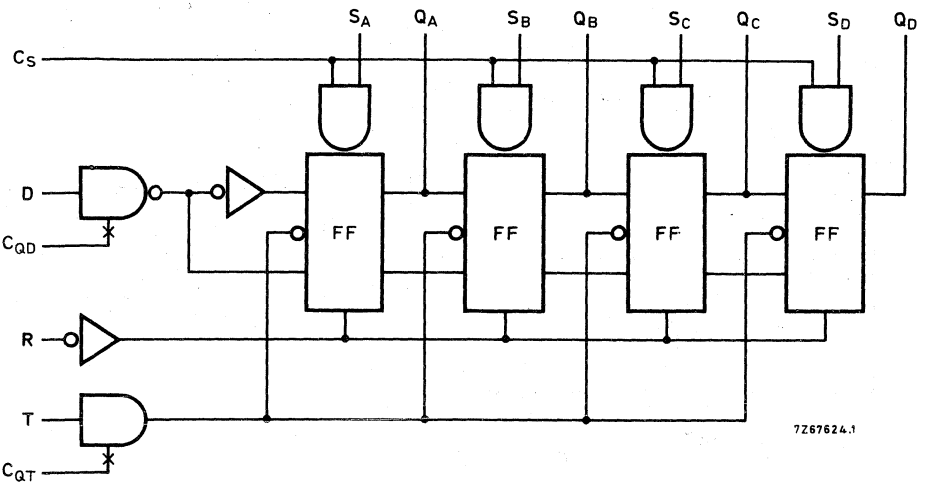
QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Available d.c. fan-out T_{amb} = 0 to +70 °C — LOW state	N_{aL}	max.	10	
Average supply current at T_{amb} = 25 °C				
V_P = 13,5 V	I_{Pav}	typ.	21	mA
V_P = 17 V	I_{Pav}	typ.	26	mA
D.C. noise margin at T_{amb} = 25 °C				
range I : V_P = 12 V	$M_L = M_H$	typ.	5	V
range II : V_P = 15 V	M_L	typ.	5	V
	M_H	typ.	8	V
Average power consumption				
(50% duty cycle) range I : V_P = 12 V	P_{av}	typ.	180	mW
range II : V_P = 15 V	P_{av}	typ.	390	mW

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

GENERAL DESCRIPTION

The FZJ161/FF36 consists of a synchronous 4-bit shift register with serial or parallel inputs and serial or parallel outputs.
It is used as serial to parallel or parallel to serial converter, register and memory.
The device has slow-down inputs (C_{QD} and C_{QT}).

LOGIC DIAGRAM



Pin description

C_S = condition set input
D = data input
C_{QD} = slow-down data input
R = reset input
T = trigger input
C_{QT} = slow-down trigger input
S = set input
Q = output

FUNCTION TABLE

inputs						outputs			
C_S	R	S_A	S_B	S_C	S_D	Q_A	Q_B	Q_C	Q_D
L	L	X	X	X	X	L	L	L	L
H	L	H	L	H	H	H	L	H	H
L	H	X	X	X	X	shift			

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Supply voltage	V_P	max.	18	V
Output voltage	V_Q	max.	V_P	
Input voltage	V_I	max.	18	V
Input current at V_P = 17 V	$-I_{IL}$	max.	25	mA
Storage temperature	T_{stg}		−65 to +150	°C
Operating ambient temperature	T_{amb}		0 to +70	°C
Output short-circuit duration	t_{Qsc}	max.	1	s [1]

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}		0 to +70	°C
Uniform system supply voltage (range I)	V_P		11,4 to 13,5	V
(range II)	V_P		13,5 to 17	V
Available d.c. fan-out	N_{aL}	max.	10	
D.C. noise margin to all inputs: range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Power consumption (50% duty cycle) at range I : V_{Pmax}	P_{av}	max.	340	mW
at range II : V_{Pmax}	P_{av}	max.	715	mW
Supply current at range I : V_P = 12 V	I_P	max.	33	mA
range II : V_P = 15 V	I_P	max.	42	mA
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

[1]) Only one output may be shorted at a time.

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ.[1]	max.	Conditions and references: V_P (V)	
Static data						
Voltages						
Input HIGH	V_{IH}	7,5	–	– V	11,4	
Input LOW	V_{IL}	–	–	4,5 V	11,4 and 13,5	
Output HIGH	V_{QH}	10	11,3	– V	11,4	V_{IL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	0,9	1,7 V	11,4	V_{IH} = 7,5 V; I_{QL} = 15 mA
D.C. noise margin: HIGH	M_H	2,5	5,0	– V	11,4	
LOW	M_L	2,8	5,0	– V	11,4	
Currents						
Input HIGH	I_{IH}	–	–	1 µA	13,5	V_{IH} = 13,5 V
Input LOW						
C_S-input	$-I_{CSL}$	–	–	6 mA	13,5	V_{IL} = 1,7 V
other inputs	$-I_{IL}$	–	–	1,5 mA	13,5	V_{IL} = 1,7 V
Output short-circuited [2]	$-I_{Qsc}$	9	15	25 mA	13,5	V_I = 0; V_Q = 0
Supply data						
Supply current	I_P	–	21	33 mA	13,5	V_I = 0

1) All typ. values under test conditions: T_{amb} = 25 °C and V_P = 12 V.
2) Short-circuit duration max. 1 s.

CHARACTERISTICS (continued)

Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C.

	Symbol	min.	typ. [1]	max.		Conditions and references
Dynamic data						
Times						
Propagation delay:						
T → Q						
fall time	t_{pdf}	90	140	450	ns	
rise time	t_{pdr}	90	140	450	ns	
R → Q						
fall time	t_{pdf}	0,6	0,85	1,3	µs	V_{pd} = 4,5 V
$C_S \rightarrow Q$, $S_A \rightarrow Q_A$, $S_B \rightarrow Q_B$, $S_C \rightarrow Q_C$, $S_D \rightarrow Q_D$						N = 1
fall time	t_{pdf}	90	140	450	ns	C_L = 10 pF
rise time	t_{pdr}	100	240	500	ns	T_{amb} = 25 °C
output fall time	t_f	5	20	60	ns	
output rise time	t_r	70	150	290	ns	
Clock pulse duration	t_T	0,5	–	–	µs	V_{pd} = 4,5 V; N = 1
Clock rate	f_c	0,5	1,5	–	MHz	duty cycle 50%
Reset pulse duration	t_{RL}	0,5	–	–	µs	
Reset pulse duration during set operation	t_{RLS}	1	–	–	µs	
Set-up times at						V_{pd} = 4,5 V
S_A; S_B; S_C; S_D; C_S	t_{su}	1	–	–	µs	N = 1
D	t_{su}	0	–	–	µs	T_{amb} = 25 °C
Hold times at						
S_A; S_B; S_C; S_D; C_S	t_{hold}	1	–	–	µs	
D	t_{hold}	0,5	–	–	µs	
T input slope	$(-dV/dt)_{Tmin}$			1	V/µs	

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

CHARACTERISTICS (continued)

Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ. [1]	max.	Conditions and references: V_P (V)	
Static data						
Voltages						
Input HIGH	V_{IH}	7,5	–	– V	13,5	
Input LOW	V_{IL}	–	–	4,5 V	13,5 and 17,0	
Output HIGH	V_{QH}	12,0	14,3	– V	13,5	V_{IL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1,0	1,7 V	13,5	V_{IH} = 7,5 V; I_{QL} = 18 mA
D.C. noise margin: HIGH	M_H	4,5	8,0	– V	13,5	
LOW	M_L	2,8	5,0	– V	13,5	
Currents						
Input HIGH	I_{IH}	–	–	1 µA	17,0	V_I = 17,0 V
Input LOW						
C_S-input	$-I_{CSL}$	–	–	7,2 mA	17,0	V_I = 1,7 V
other inputs	$-I_{IL}$	–	–	1,8 mA	17,0	V_I = 1,7 V
Output short-circuited [2]	I_{Qsc}	9	15	25 mA	17,0	V_I = 0; V_Q = 0
Supply data						
Supply current	I_P	–	26	42 mA	17,0	V_I = 0

[1] All typ. values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

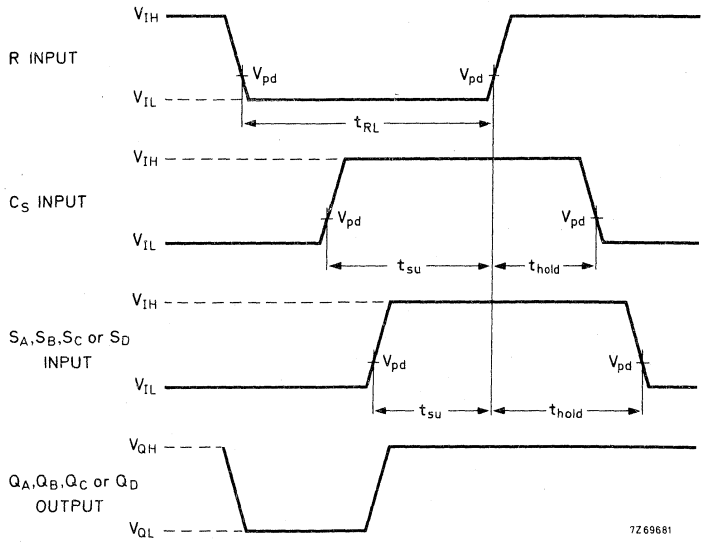
[2] Short-circuit duration max. 1 s.

CHARACTERISTICS (continued)

Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max.		Conditions and references
Dynamic data						
Times						
Propagation delay:						
T → Q						
fall time	t_{pdf}				ns	C_L = 10 pF N = 1 T_{amb} = 25 °C V_{pd} = 4,5 V
rise time	t_{pdr}				ns	
R → Q						
fall time	t_{pdf}				µs	
C_S → Q, S_A → Q_A, S_B → Q_B, S_C → Q_C, S_D → Q_D			t.b.f.			
rise time	t_{pdr}				ns	
fall time	t_{pdf}				ns	
output fall time	t_f				ns	
output rise time	t_r				ns	
T input slope	$(-dV/dt)_{Tmin}$	1			V/µs	

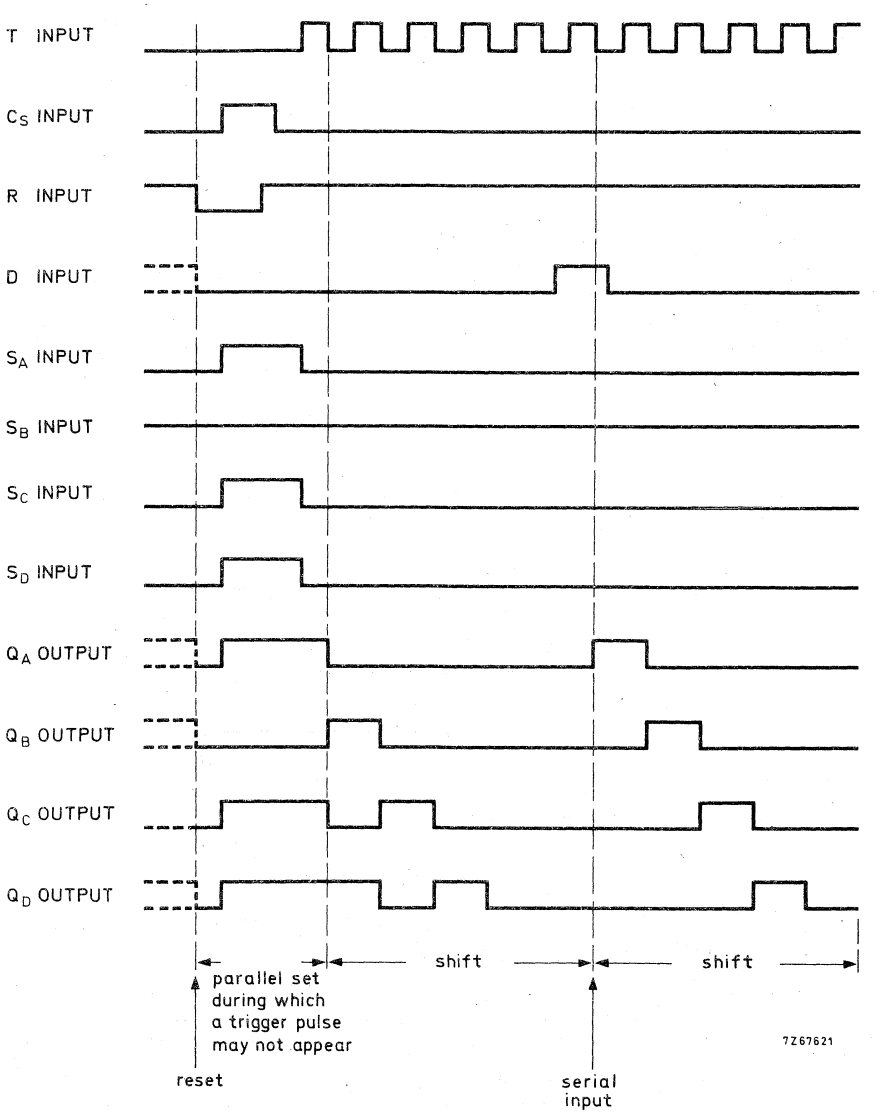
Waveforms for set operation



[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

CHARACTERISTICS (continued)

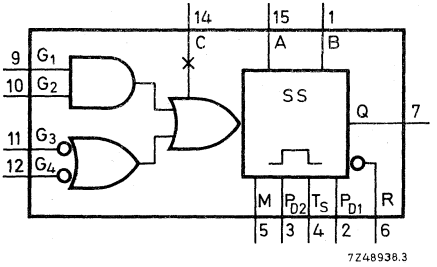
Dynamic data

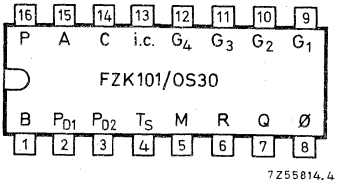


The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

MONOSTABLE MULTIVIBRATOR

with slow-down capability

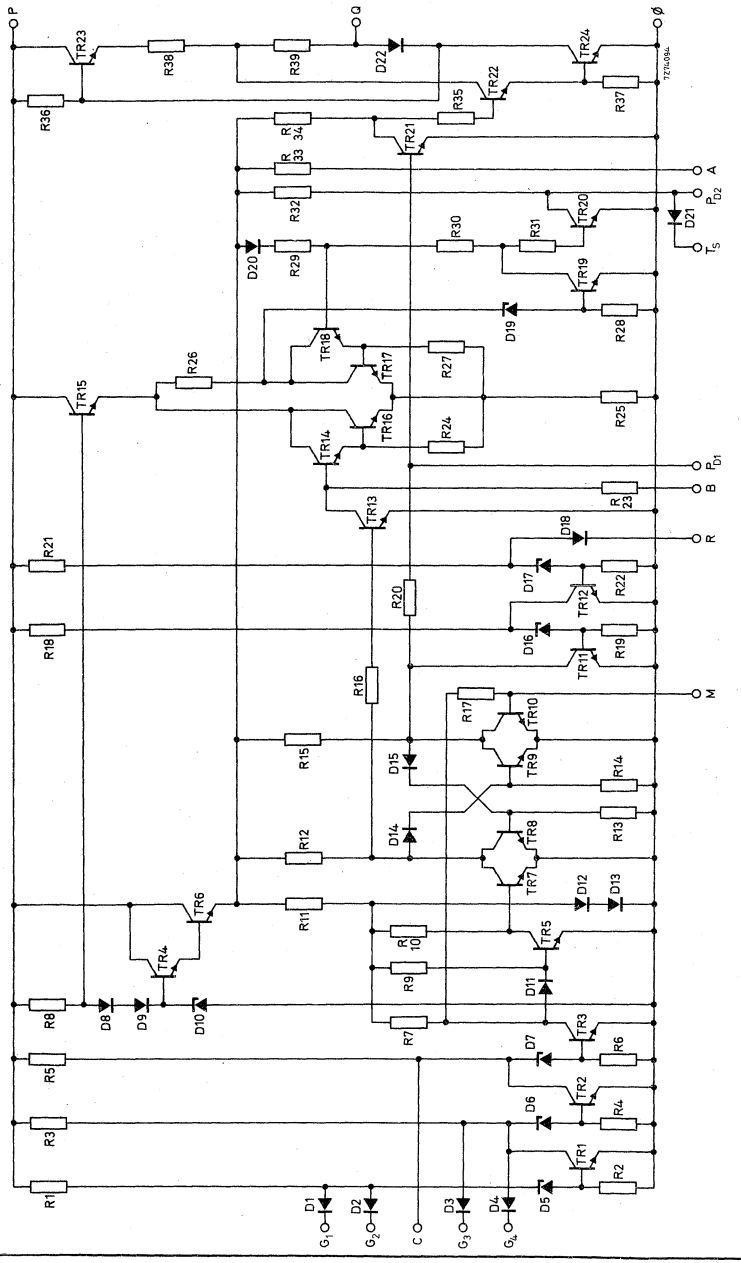




QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Average propagation delay: T_{amb} = 25 °C; V_{pd} = 4,5 V (ranges I and II)	t_{pdr}	typ.	270	ns
Available d.c. fan-out: LOW state	N_{aL}	max.	10	
D.C. noise margin at T_{amb} = 25 °C				
range I : V_P = 12 V	M_L=M_H	typ.	5	V
	M_L	typ.	5	V
range II : VP = 15 V	M_H	typ.	8	V
Average power consumption				
(50% duty cycle) range I : V_P = 12 V	P_{av}	typ.	145	mW
range II: V_P = 15 V	P_{av}	typ.	180	mW

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

CIRCUIT DIAGRAM



GENERAL DESCRIPTION

The FZK101/OS30 has the following electrical functions and properties.

If the FZK101/OS30 is used as :

a. Monostable multivibrator: P_{D2}, T_S and M have to be interconnected
b. Pulse delaying circuit : P_{D1} and P_{D2} have to be interconnected
c. Pulse shortening circuit : T_S and M have to be interconnected.
d. Delay switch : P_{D1} with P_{D2} and M with ϕ have to be interconnected.

The output-pulse duration and pulse-delaying duration depend upon a resistor R_t which is externally connected between A and B and a capacitor C_t between B and ϕ. Output pulse durations and propagation delay are very stable with temperature and supply voltage changes.
The LOW state of output Q can be obtained by a LOW signal at input R.
The noise immunity of the G-inputs will be increased by connecting a capacitor (max. 500 pF) between slow-down terminal C and ϕ.
To the terminals P_{D1}, P_{D2}, T_S and M no voltages or currents may be applied.
External interconnections between these terminals have to be as short as possible.
If input signals are applied to the inputs G_3 and G_4, inputs G_1 and/or G_2 have to be LOW.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Supply voltage	V_P	max.	18	V	
Output voltage	V_Q	max.	V_P		
Input voltage	V_G	max.	18	V	
Voltage difference between any two inputs		max.	18	V	
Storage temperature	T_{stg}	−65 to +150		°C	
Operating ambient temperature	T_{amb}	0 to +70		°C	
Slow-down input voltage	$+V_C$	max.	0,6	V	
	$-V_C$	max.	1,0	V	
Slow-down input current	$+I_C$	max.	2,0	mA	
	$-I_C$	max.	10,0	mA	
Output short-circuit duration	t_{Qsc}	max.	1	s	1)

1) Only one output may be shorted at a time.

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}	0	to	+70	°C
Uniform system supply voltage (range I)	V_P	11,4	to	13,5	V
(range II)	V_P	13,5	to	17	V
D.C. noise margin; range I at V_{Pmin}	M_L	min.		2,8	V
	M_H	min.		2,5	V
range II at V_{Pmin}	M_L	min.		2,8	V
	M_H	min.		4,5	V
Supply current at range I; output HIGH	I_{Pav}	typ.		12	mA
output LOW	I_{Pav}	typ.		13	mA
at range II; output HIGH	I_{Pav}	typ.		14	mA
output LOW	I_{Pav}	typ.		15	mA
Power consumption (50% duty cycle) at range I = V_{Pmax}	P_{av}	max.		257	mW
at range II = V_{Pmax}	P_{av}	max.		391	mW
Slow-down capacitor	C_M	max.		500	pF
Thermal resistance from system to ambient	R_{th}	max.		150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ.[1])	max.	Conditions and references: V_P (V)	Conditions and references
Static data						
Voltages						
Input HIGH	V_{GH}	7,5	–	– V	11,4	$V_{QL} \leq 1,7$ V; I_{QL} = 15 mA
Input LOW	V_{GL}	–	–	4,5 V	11,4 and 13,5	$V_{QH} \geq 10$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	10,0	11,3	– V	11,4 and 13,5	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	0,9	1,7 V	11,4	V_{GH} = 7,5 V; I_{QL} = 15 mA
D.C.noise margin: HIGH	M_H	2,5	5,0	– V	11,4	
LOW	M_L	2,8	5,0	– V	11,4	
Currents (per input)						
Input HIGH	I_{GH}	–	–	1,0 µA	13,5	V_G = 13,5 V (other inputs 0 V)
Input LOW	$-I_{GL}$	–	0,8	1,5 mA	13,5	V_{GL} = 1,7 V other inputs 13,5V
Output HIGH	$-I_{QH}$	–	–	0,1 mA	11,4 and 13,5	V_{GL} = 4,5 V; V_{QH} = 10 V
Output LOW	I_{QL}	15	–	– mA	11,4	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited	$-I_{Qsc}$	10	30	50 mA	13,5	V_G= 0 V; V_Q= 0 V
Supply data						
Currents						
at V_{GL}	I_P	–	13,0	18,5 mA	13,5	
at V_{GH}	I_P	–	12,0	17,0 mA	13,5	

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

CHARACTERISTICS (continued)

Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	symbol	min.	typ. [1]	max.		conditions and references
Dynamic data						
Times						
Propagation delay:						
G → Q						
fall time	t_{pdf}	110	180	450	ns	C_L = 10 pF
rise time	t_{pdr}	220	270	740	ns	N = 1
R → Q						
fall time	t_{pdf}	150	300	550	ns	T_{amb} = 25 °C
Output fall time	t_f	30	80	150	ns	V_{pd} = 4,5 V
Output rise time	t_r	50	100	200	ns	
Input pulse duration	t_{GH}	0,5	-	-	µs	
Reset pulse duration	t_{RL}	0,5	-	-	µs	
Recovery time	t_{rec}	$(C_o + C_t) \times 10^3$			s/F	C_o = 10 pF
Set-up time						between B and ϕ
at G_1, G_2	t_{su}	0	-	-	µs	
at G_3, G_4	t_{su}	0,5	-	-	µs	
→ Output pulse duration	t_{QHmin}	400			ns	V_P = 11,4 V
→ Output pulse duration	t_{QH}	650	700	780	µs	R_t = 0,5 MΩ
Capacitor	C_t	0	-	∞	µF	C_t = 2 nF
Resistor	R_t	5	-	500	kΩ	see note 2
Input slope, G_1, G_2	$(dV/dt)_T$	0,1			V/µs	
G_3, G_4		1			V/µs	

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.
[2] For higher accuracy R_t = 40 to 200 kΩ.

CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	13,5	$V_{QL} \leq 1,7$ V; I_{QL} = 18 mA
Input LOW	V_{GL}	–	–	4,5	V	13,5 and 17	$V_{QH} \geq 12$ V; $-I_{QH}$ = 0,1 mA
Output HIGH	V_{QH}	12,0	14,3	–	V	13,5 and 17	V_{GL} = 4,5 V; $-I_{QH}$ = 0,1 mA
Output LOW	V_{QL}	–	1,0	1,7	V	13,5	V_{GH} = 7,5 V; I_{QL} = 18 mA
D.C. noise margin: HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents (per input)							
Input HIGH	I_{GH}	–	–	1,0	µA	17	V_G = 17 V; other inputs 0 V
Input LOW	$-I_{GL}$	–	1,0	1,8	mA	17	V_{GL} = 1,7 V; other inputs 17V
Output HIGH	$-I_{QH}$	–	–	0,1	mA	13,5 and 17	V_{GL} = 4,5 V; V_{QH} = 12 V
Output LOW	I_{QL}	18	–	–	mA	13,5	V_{GH} = 7,5 V; V_{QL} = 1,7 V
Output short-circuited	$-I_{Qsc}$	15	37	50	mA	17	V_G = 0 V; V_Q = 0V
Supply data							
Currents							
at V_{GH}	I_P	–	14,0	20,0	mA	17	
at V_{GL}	I_P	–	15,0	21,5	mA	17	

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

CHARACTERISTICS (continued)

Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	symbol	min.	typ. [1]	max.		conditions and references
Dynamic data						
Times						
Propagation delay:						
G → Q						
fall time	t_{pdf}		t.b.f.		ns	C_L = 10 pF
rise time	t_{pdr}				ns	N = 1
R → Q						
fall time	t_{pdf}				ns	T_{amb} = 25 °C
Output fall time	t_f				ns	V_{pd} = 4,5 V
Output rise time	t_r				ns	
Input pulse duration	t_{GH}	0,5	–	–	µs	
Reset pulse duration	t_{RL}	0,5	–	–	µs	
Recovery time	t_{rec}		$(C_o + C_t) \times 10^3$		s/F	C_o = 10 pF
Set-up time						between B and ϕ
at G_1, G_2	t_{su}	0	–	–	µs	
at G_3, G_4	t_{su}	0,5	–	–	µs	
Output pulse duration	t_{QHmin}	400	700		ns	V_P = 13,5 V
→ Output pulse duration	t_{QH}	650	700	780	µs	R_t = 0,5 MΩ
Capacitor	C_t	0	–	∞	µF	C_t = 2 nF
Resistor	R_t	5	–	500	kΩ	see note 2
Input slope, G_1, G_2	$(dV/dt)_T$	0,1			V/µs	
G_3, G_4		1			V/µs	

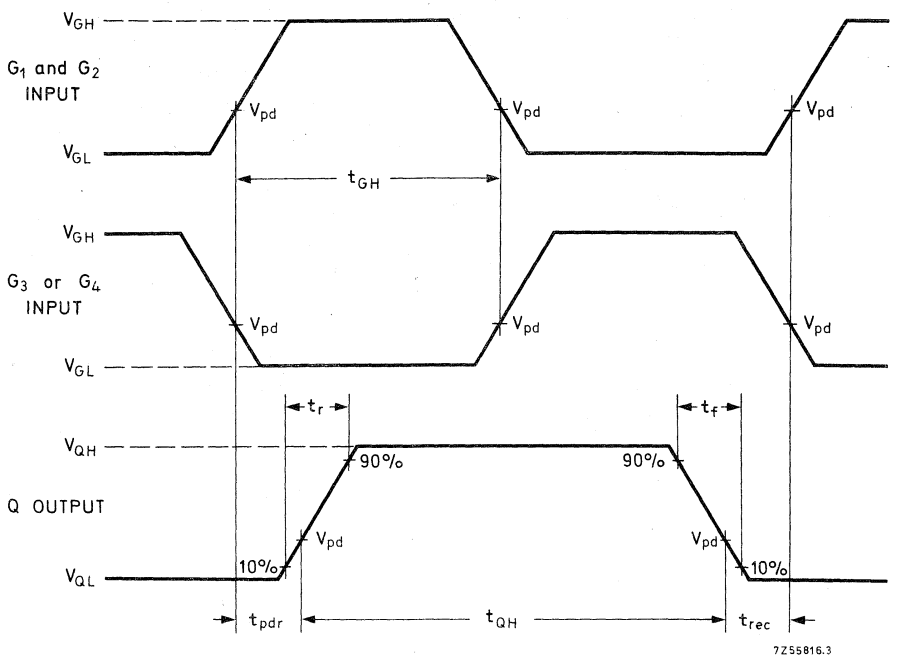
1) All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

2) For higher accuracy R_t = 40 to 200 kΩ.

CHARACTERISTICS (continued)

Dynamic data

FZK101/OS30 used as monostable multivibrator

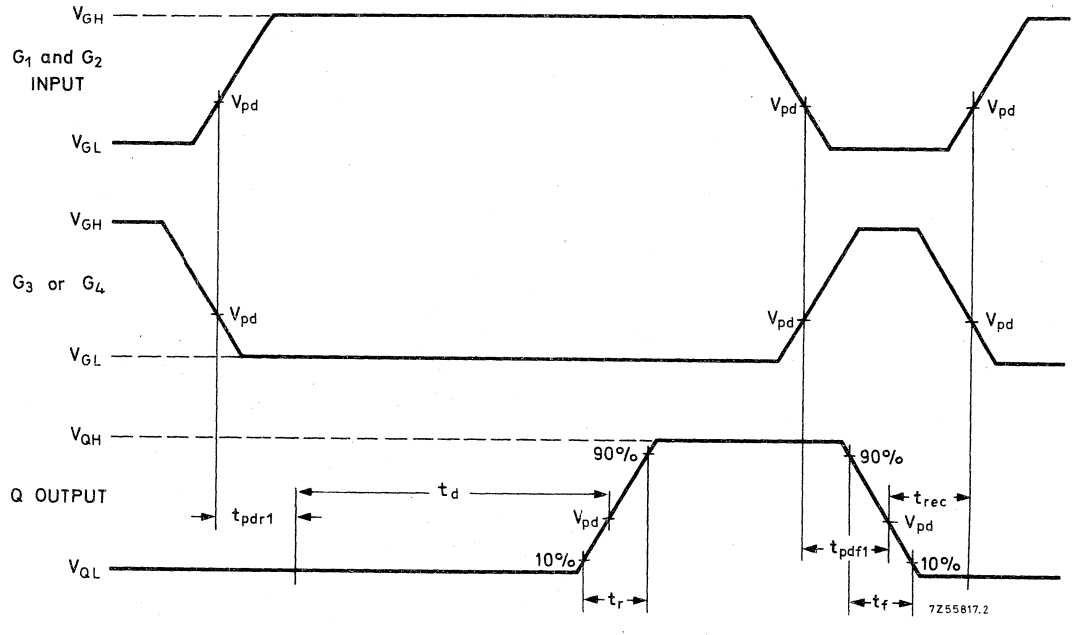


Conditions: P_{D2} and M interconnected
$t_{QH} = 0,7 \times R_t \ (C_o + C_t)$

CHARACTERISTICS (continued)

Dynamic data

FZK101/OS30 used as pulse delayed circuit

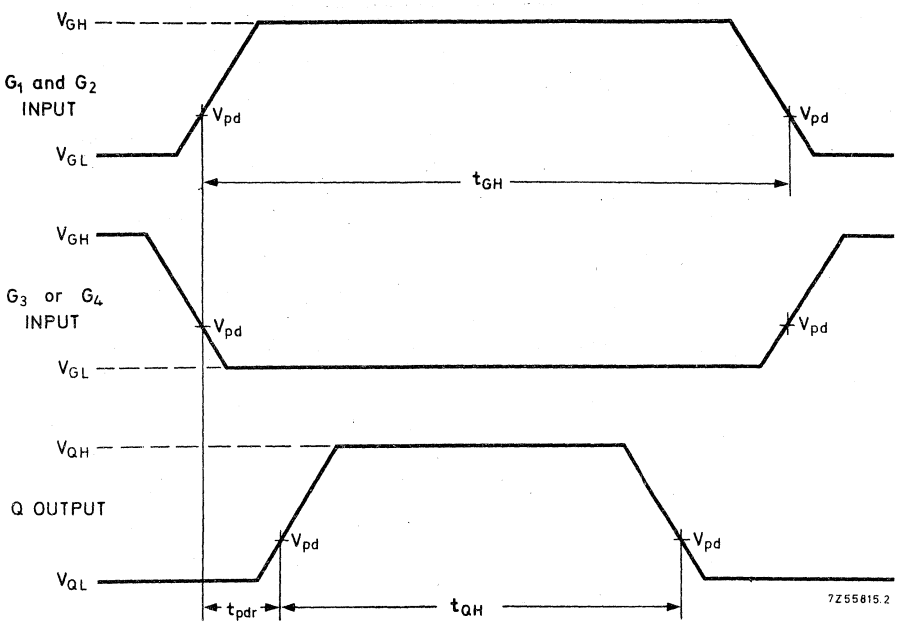


Conditions: P_{D1} and P_{D2} interconnected
$t_d = 0,7 \times R_t \ (C_o + C_t)$

CHARACTERISTICS (continued)

Dynamic data

FZK101/OS30 used as pulse shortened circuit



Conditions: T_S and M interconnected

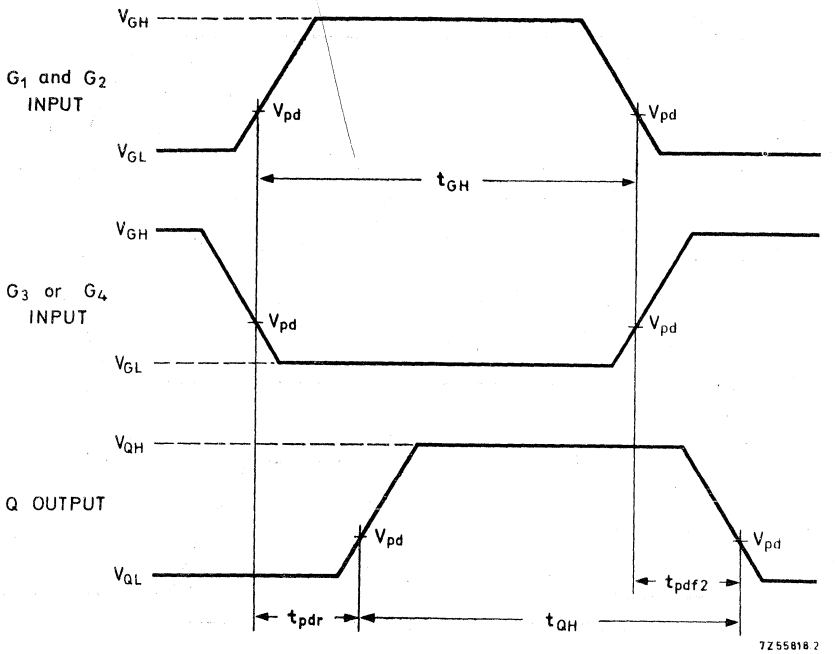
$t_{GH} > 0,7 \times R_t (C_o + C_t)$

$t_{QH} = 0,7 \times R_t (C_o + C_t)$

CHARACTERISTICS (continued)

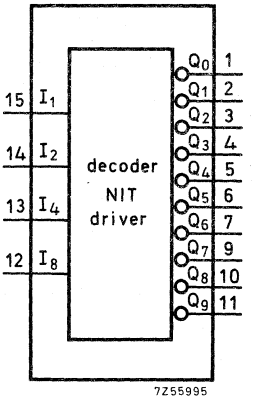
Dynamic data

FZK101/OS30 used as pulse shortened circuit

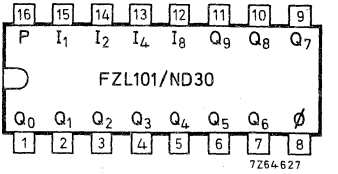


Conditions: T_S and M interconnected
$t_{GH} \leq 0,7 \times R_t (C_o + C_t)$
$t_{QH} = t_{GH}$

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.



SINGLE BCD-DECIMAL DECODER N.I.T.[1] DRIVER



QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Output current (per output):				
output transistor in off-state	I_Q	max.	2	mA
output transistor in on-state	I_Q	max.	20	mA
Output voltage at any output (output transistor in cut-off)	V_Q	max.	80	V
Average supply current at T_{amb} = 25 °C				
V_P = 13,5 V	I_{Pav}	typ.	17	mA
V_P = 17 V	I_{Pav}	typ.	18	mA
D.C. noise margin at T_{amb} = 25 °C				
range I : V_P = 12 V	M_L	typ.	5,5	V
	M_H	typ.	4,5	V
range II : V_P = 15 V	M_L	typ.	5,5	V
	M_H	typ.	7,5	V
Average power consumption (50% duty cycle) range I : V_P = 12 V	P_{av}	typ.	205	mW
range II : V_P = 15 V	P_{av}	typ.	270	mW

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section).

[1]) N.I.T. = numerical indicator tube.

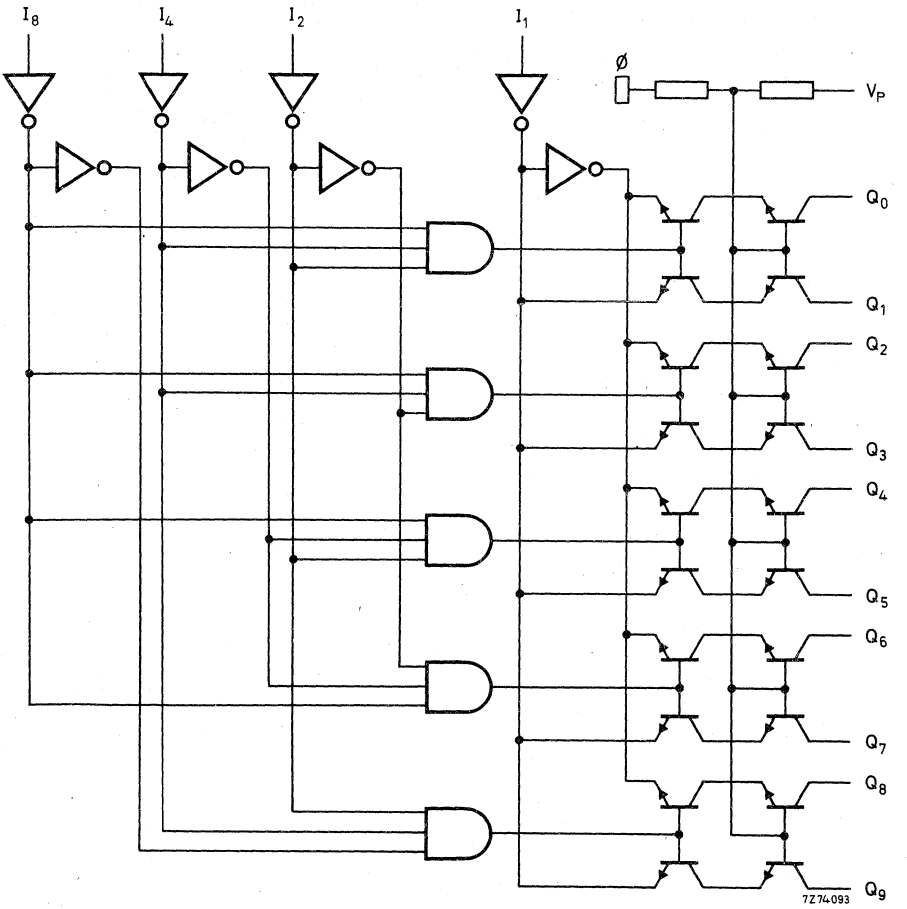
GENERAL DESCRIPTION

The FZL101/ND30 is a BCD (1-2-4-8 code) to decimal decoder incorporating high voltage output transistors for driving numerical indicator tubes.

Note

When used as HNIL decoder for every output a 10 kΩ resistor, connected to V_P, is required. At the outputs hazard pulses can appear during transition stages.

LOGIC DIAGRAM



FUNCTION TABLE

inputs				outputs (on-state = L)									
I_1	I_2	I_4	I_8	Q_0	Q_1	Q_2	Q_3	Q_4	Q_5	Q_6	Q_7	Q_8	Q_9
L	L	L	L	L	H	H	H	H	H	H	H	H	H
H	L	L	L	H	L	H	H	H	H	H	H	H	H
L	H	L	L	H	H	L	H	H	H	H	H	H	H
H	H	L	L	H	H	H	L	H	H	H	H	H	H
L	L	H	L	H	H	H	H	L	H	H	H	H	H
H	L	H	L	H	H	H	H	H	L	H	H	H	H
L	H	H	L	H	H	H	H	H	H	L	H	H	H
H	H	H	L	H	H	H	H	H	H	H	L	H	H
L	L	L	H	H	H	H	H	H	H	H	H	L	H
H	L	L	H	H	H	H	H	H	H	H	H	H	L
L	H	L	H	H	H	H	H	H	H	H	H	H	H
H	H	L	H	H	H	H	H	H	H	H	H	H	H
L	L	H	H	H	H	H	H	H	H	H	H	H	H
H	L	H	H	H	H	H	H	H	H	H	H	H	H
L	H	H	H	H	H	H	H	H	H	H	H	H	H
H	H	H	H	H	H	H	H	H	H	H	H	H	H

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage (at any output)	V_Q	max.	80	V
Input voltage	V_I	max.	18	V
Current into any output (off-state)	I_Q	max.	2	mA
Current into any output (on-state)	I_Q	max.	20	mA
Storage temperature	T_{stg}	−65 to +150		°C
Operating ambient temperature	T_{amb}	0 to +70		°C

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}		0 to +70	°C
Uniform system supply voltage (range I)	V_P		11,4 to 13,5	V
(range II)	V_P		13,5 to 17	V
D.C. noise margin to all inputs: range I at V_{Pmin}	M_L	min.	3,3	V
	M_H	min.	2,0	V
range II at V_{Pmin}	M_L	min.	3,3	V
	M_H	min.	4,0	V
Power consumption (50% duty cycle) at range I : V_{Pmax}	P_{av}	max.	340	mW
at range II : V_{Pmax}	P_{av}	max.	460	mW
Supply current at range I : V_P = 12 V	I_P	max.	25	mA
range II : V_P = 15 V	I_P	max.	27	mA
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

CHARACTERISTICS Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ.[1]	max.		Conditions and references	
						V_P (V)	
Static data							
Voltages							
Input HIGH	V_{IH}	8,0	–	–	V		
Input LOW	V_{IL}	–	–	5,0	V		
Output HIGH	V_{QH}	80	–	–	V	13,5	$-I_{QH}$ = 1 mA
Output LOW	V_{QL}	–	–	2,5	V	11,4	I_{QL} = 9 mA
D.C. noise margin							
HIGH	M_H	2,0	4,5	–	V	11,4	
LOW	M_L	3,3	5,5	–	V	11,4	
Currents							
Input HIGH	I_{IH}	–	–	1,0	μA	13,5	V_{IH} = 13,5 V
Input LOW	$-I_{IL}$	–	0,8	1,5	mA	13,5	V_{IL} = 0 V
Output HIGH: input combination 0 to 9	$-I_{QH}$	–	–	50	μA	13,5	V_{QH} = 70 V
input combination 10 to 15	$-I_{QH}$	–	–	5	μA	13,5	V_{QH} = 60 V
Supply data							
Supply current	I_P	–	17	25	mA	13,5	input voltage at I_1, I_4, I_8 = 0 V and at I_2 = 13,5 V

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

CHARACTERISTICS (continued)

Test conditions: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C.

	Symbol	min.	typ. [1]	max.		Conditions and references
Dynamic data						
Times						
Propagation delay:						
$I_2 \rightarrow Q_2$						
fall time	t_{pdf}	60	150	280	ns	C_L = 10 pF; N = 1; T_{amb} = 25 °C; V_L = 12 V; R_L = 1 kΩ
rise time	t_{pdr}	30	70	210	ns	
$I_2 \rightarrow Q_0$						
fall time	t_{pdf}	30	70	210	ns	
rise time	t_{pdr}	60	150	280	ns	

[1] All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

CHARACTERISTICS (continued)

Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

	Symbol	min.	typ. [1]	max.		Conditions and references	
						V_P (V)	
Static data							
Voltages							
Input HIGH	V_{IH}	8,0	–	–	V		
Input LOW	V_{IL}	–	–	5,0	V		
Output HIGH	V_{QH}	80	–	–	V	17,0	$-I_{QH}$ = 1 mA
Output LOW	V_{QL}	–	–	2,5	V	13,5	I_{QL} = 9 mA
D.C. noise margin							
HIGH	M_H	4,0	7,5	–	V	13,5	
LOW	M_L	3,3	5,5	–	V	13,5	
Currents							
Input HIGH	I_{IH}	–	–	1,0	µA	17,0	V_I = 17,0 V
Input LOW	$-I_{IL}$	–	1,0	1,8	mA	17,0	V_I = 0 V
Output HIGH:							
input combination 0 to 9	$-I_{QH}$	–	–	50	µA	17,0	V_{QH} = 70 V
input combination 10 to 15	$-I_{QH}$	–	–	5	µA	17,0	V_{QH} = 60 V
Supply data							
Supply current	I_P	–	18	27	mA	17,0	input voltage at I_1, I_4, I_8 = 0 V and at I_2 = 13,5 V

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

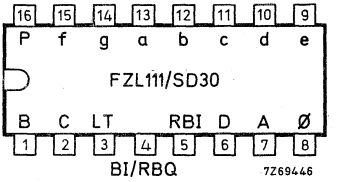
CHARACTERISTICS (continued)

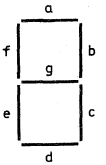
	Symbol	min. typ. [1] max.	Conditions and references
Dynamic data			
Propagation delay:			
$I_2 \rightarrow Q_2$			
fall time	t_{pdf}	t.b.f.	
rise time	t_{pdr}		
$I_2 \rightarrow Q_0$			
fall time	t_{pdf}		
rise time	t_{pdr}		

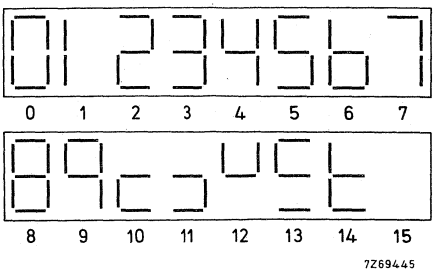
[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

BCD 7-SEGMENT DECODER-DRIVER
with open collector outputs







QUICK REFERENCE DATA				
Supply voltage (range I)	V_P	nom.	12	V
(range II)	V_P	nom.	15	V
Operating ambient temperature	T_{amb}		0 to +70	°C
Output current per output				
output transistor in off-state	I_Q	max.	25	µA
output transistor in on-state	I_Q	max.	20	mA
Output voltage at any output (output transistor in off-state)	V_Q	max.	16,5	V
Average supply current at T_{amb} = 25 °C				
V_P = 13,5 V	I_{Pav}	<	40	mA
V_P = 16,5 V	I_{Pav}	<	44	mA
D.C. noise margin at T_{amb} = 25 °C				
range I : V_P = 12 V	$M_L = M_H$	typ.	5,0	V
range II: V_P = 15 V	M_L	typ.	5,0	V
	M_H	typ.	8,0	V
Average power consumption				
(50% duty cycle) range I : V_P = 13,5 V	P_{av}	max.	540	mW
range II: V_P = 16,5 V	P_{av}	max.	725	mW

PACKAGE OUTLINE 16 lead plastic dual in-line (see general section)

GENERAL DESCRIPTION

The FZL111/SD30 transforms 4-bit BCD-words at the inputs A, B, C, D into the 7-segment code. Control functions are provided by means of three auxiliary inputs; BI, RBI, LT. A LOW signal at the ripple-blanking input (RBI) suppresses the decimal 0-signal at the outputs. The ripple-blanking output (RBQ; internally connected with BI) provides an automatic 0-suppression over several decades. When the blanking input (BI) is supplied with a LOW signal, all outputs are blocked. A LOW signal at the lamp-test input (LT) forces all outputs into conduction.

FUNCTION TABLE

function	inputs						BI or RBQ	segment outputs (on-state = L)						
	LT	RBI	D	C	B	A		a	b	c	d	e	f	g
0 [1]	H	H	L	L	L	L	H	L	L	L	L	L	L	H
1	H	X	L	L	L	H	H	H	H	H	H	L	L	H
2	H	X	L	L	H	L	H	L	L	H	L	L	H	L
3	H	X	L	L	H	H	H	L	L	L	L	H	H	L
4	H	X	L	H	L	L	H	H	L	L	H	H	L	L
5	H	X	L	H	L	H	H	L	H	L	L	H	L	L
6	H	X	L	H	H	L	H	H	H	L	L	L	L	L
7	H	X	L	H	H	H	H	L	L	L	H	H	H	H
8	H	X	H	L	L	L	H	L	L	L	L	L	L	L
9	H	X	H	L	L	H	H	L	L	L	H	H	L	L
10	H	X	H	L	H	L	H	H	H	H	L	L	H	L
11	H	X	H	L	H	H	H	H	H	L	L	H	H	L
12	H	X	H	H	L	L	H	H	L	H	H	H	L	L
13	H	X	H	H	L	H	H	L	H	H	L	H	L	L
14	H	X	H	H	H	L	H	H	H	H	L	L	L	L
15	H	X	H	H	H	H	H	H	H	H	H	H	H	H
BI [2]	X	X	X	X	X	X	L	H	H	H	H	H	H	H
RBI [3]	H	L	L	L	L	L	L	H	H	H	H	H	H	H
LT [4]	L	X	X	X	X	X	H	L	L	L	L	L	L	L

H = HIGH state (the more positive voltage)
L = LOW state (the less positive voltage)
X = state is immaterial

[1] If 0-indication is desired, RBI must be supplied with a HIGH signal.

[2] A LOW signal at BI forces all segment outputs into HIGH state independent of the other input conditions.

[3] If a LOW signal is supplied to RBI and A, B, C, D; HIGH signals result at all outputs and LOW signal at RBQ (zero condition).

[4] A LOW signal at LT switches all outputs to L only if BI/RBQ is supplied with a HIGH signal regardless of the input condition at A, B, C, D and RBI.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage (outputs a to g; off-state)	V_Q	max.	16,5	V
Output current (outputs a to g; off-state)	I_Q	max.	25	µA
Output current (outputs a to g; on-state)	I_Q	max.	20	mA
with 50% duty cycle	I_Q	max.	40	mA
Storage temperature	T_{stg}		−65 to +150	°C
Operating ambient temperature	T_{amb}		0 to +70	°C

SYSTEM DESIGN DATA

Uniform system temperature	T_{amb}		0 to +70	°C
Uniform system supply voltage (range I)	V_P		11,4 to 13,5	V
(range II)	V_P		13,5 to 16,5	V
D.C. noise margin to all inputs: range I at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	2,5	V
range II at V_{Pmin}	M_L	min.	2,8	V
	M_H	min.	4,5	V
Power consumption (50% duty cycle) at range I : V_{Pmax}	P_{av}	max.	540	mW
at range II: V_{Pmax}	P_{av}	max.	725	mW
Supply current at range I : V_P = 12 V	I_P	max.	40	mA
at range II: V_P = 15 V	I_P	max.	44	mA
Thermal resistance from system to ambient	R_{th}	max.	150	°C/W

CHARACTERISTICS Test conditons: at range I (V_P = 12 V); T_{amb} = 0 to +70 °C

	Sym-bol	min.	typ. [1]	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{IH}	7,5	–	–	V	11,4	
Input LOW	V_{IL}	–	–	4,5	V	11,4 and 13,5	
Outputs a to g	V_Q	–	–	16,5	V	11,4	I_Q = 25 µA
Output HIGH at BI/RBQ	V_{QH}	10	11,3	–	V	13,5	$-I_{QH}$ = 0,1 mA
Output LOW at outputs a to g	V_{QL}	–	0,4	0,7	V	11,4	I_{QL} = 20 mA
	V_{QL}	–	0,7	1,0	V	11,4	I_{QL} = 40 mA
at outputs BI/RBQ	V_{QL}	–	–	1,7	V	11,4	I_{QL} = 7,5 mA
D.C. noise margin HIGH	M_H	2,5	5,0	–	V	11,4	
LOW	M_L	2,8	5,0	–	V	11,4	
Currents							
Input HIGH at A, B, C, D, RBI	I_{IH}	–	–	10	µA	13,5	V_{IH} = 13,5 V
at BI/RBQ	I_{IH}	–	–	20	µA	13,5	
at LT	I_{IH}	–	–	30	µA	13,5	
Input LOW at A, B, C, D, RBI	I_{IL}	–	1,0	2,1	mA	13,5	V_{IL} = 1,7 V
at BI/RBQ	I_{IL}	–	2,0	4,2	mA	13,5	
at LT	I_{IL}	–	3,0	5,3	mA	13,5	
Supply data							
Supply current	I_P	–	–	40	mA	13,5	outputs open

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 12 V.

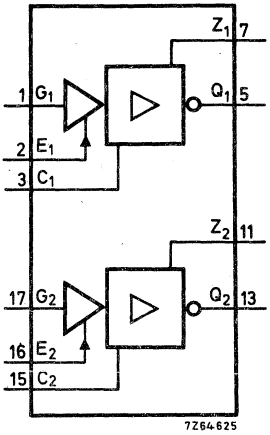
CHARACTERISTICS Test conditions: at range II (V_P = 15 V); T_{amb} = 0 to +70 °C

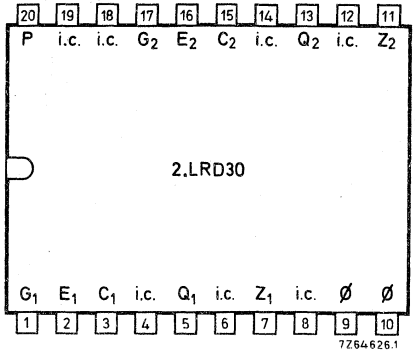
	Symbol	min.	typ. [1])	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{IH}	7,5	–	–	V	13,5	
Input LOW	V_{IL}	–	–	4,5	V	13,5 and 16,5	
Outputs a to g	V_Q	–	–	16,5	V	13,5	I_Q = 25 µA
Output HIGH at BI/RBQ	V_{QH}	12	14,3	–	V	16,5	$-I_{QH}$ = 0,1 mA
Output LOW at outputs a to g	V_{QL}	–	0,4	0,7	V	13,5	I_{QL} = 20 mA
	V_{QL}	–	0,7	1,0	V	13,5	I_{QL} = 40 mA
at output BI/RBQ	V_{QL}	–	–	1,7	V	13,5	I_{QL} = 9 mA
D.C. noise margin HIGH	M_H	4,5	8,0	–	V	13,5	
LOW	M_L	2,8	5,0	–	V	13,5	
Currents							
Input HIGH at A, B, C, D, RBI	I_{IH}	–	–	10	µA	16,5	V_{IH} = 16,5 V
at BI/RBQ	I_{IH}	–	–	20	µA	16,5	
at LT	I_{IH}	–	–	30	µA	16,5	
Input LOW at A, B, C, D, RBI	I_{IL}	–	–	2,6	mA	16,5	V_{IL} = 1,7 V
at BI/RBQ	I_{IL}	–	–	5,2	mA	16,5	
at LT	I_{IL}	–	–	7,8	mA	16,5	
Supply data							
Supply current	I_P	–	–	44	mA	16,5	outputs open

[1]) All typical values under test conditions: T_{amb} = 25 °C and V_P = 15 V.

The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

DUAL LAMP/RELAY DRIVER





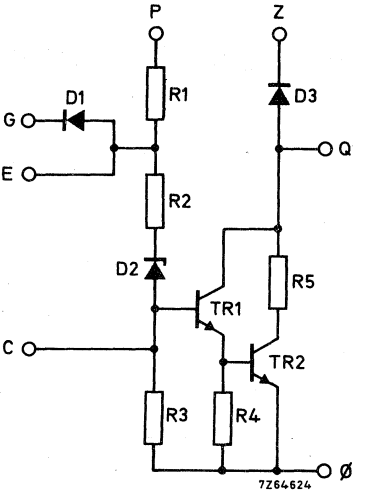
QUICK REFERENCE DATA				
Supply voltage	V_P	11,4 to 17,0		V
when loaded	V_{Pload}	max.	30	V
Operating ambient temperature	T_{amb}	−30 to + 75		°C
Output current (d.c.) T_{amb} = − 35 to +75 °C; V_{Pload} = 30 V	I_{QL}	max.	200	mA
Non-repetitive peak output current t_{max} = 20 ms	I_{QLM}	max.	400	mA
D.C. noise margin at T_{amb} = 25 °C	M_L	typ.	6	V
	M_H	typ.	7	V
Average power consumption T_{amb} = 25 °C; Vp = 15 V; Q = unloaded	P_{av}	typ.	40	mW

Note

Necessary input drive equal to 3 gate loads.

PACKAGE OUTLINE 20 lead dual in-line (see general section).

CIRCUIT DIAGRAM



GENERAL DESCRIPTION

The 2.LRD30 is a dual driver for output currents up to 200 mA at a supply voltage of maximum 30 V; it is used for driving lamps and relays.
The number of gate inputs can be extended by connecting up to 15 Si diodes to the expander terminal E (connect anodes of diodes to E) *).
With inductive loads the built-in clamping diode D3 must be used. This is done by connecting terminal Z to the load supply voltage, to protect the output transistor against damage caused by high inductive voltages.
To improve the a.c. noise immunity by increasing the propagation delay time, a capacitor has to be connected between terminals C and ϕ.
With a resistive load, the capacitor is connected between C and Q.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134).

Supply voltage	V_P	max.	20 V
when loaded	V_{Pload}	max.	30 V
Output voltage	V_{QH}	max.	30 V
Input voltage	V_{GH}	max.	30 V
Negative input voltage	$-V_G$	max.	4 V
Storage temperature	T_{stg}		−30 to + 85 °C
Operating ambient temperature	T_{amb}		−30 to + 75 °C

*) Diode leads should be kept as short as possible.

CHARACTERISTICS

Test conditions: T_{amb} = −30 to +70 °C

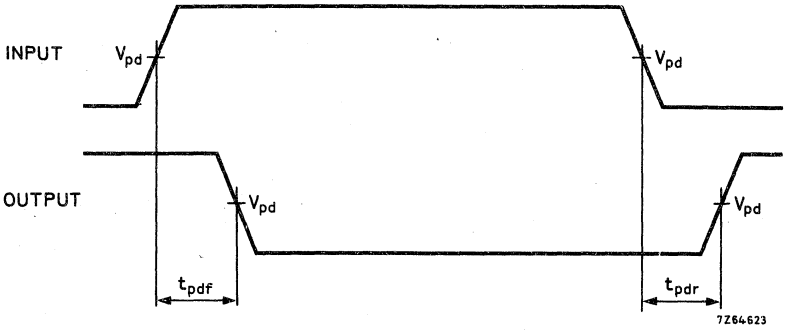
	sym-bol	min.	typ.[1])	max.		Conditions and references	
						V_P (V)	
Static data							
Voltages							
Input HIGH	V_{GH}	8,0	–	–	V	11,4 and 17,0	V_Q = LOW
Input LOW	V_{GL}	–	–	4,5	V	11,4 and 17,0	I_Q = 0,5 mA
Output LOW	V_{QL}	–	0,9	1,3	V	11,4	$V_{GH} \geq 8,0$ V; I_Q = 200 mA
D.C. noise margin: HIGH	M_H	2,0	7	–	V	11,4	
LOW	M_L	2,8	6	–	V	11,4 and 17,0	
Currents							
Input HIGH	I_{GH}	–	0,1	10	µA	11,4 and 17,0	V_G = 17,0 V
Input LOW	$-I_{GL}$	–	–	5,4	mA	17,0	V_{GL} = 1,7 V
Output HIGH	I_{QH}	–	–	0,5	mA	11,4 and 17,0	$V_{GL} \leq 4,5$ V; V_{Pload} = 30 V
Output LOW	I_{QL}	–	–	200	mA	11,4 and 17,0	$V_G \geq 8,0$ V
Non-repetitive peak value; t_{max} = 20 ms	I_{QLM}	–	–	400	mA	11,4 and 17,0	$V_{GH} \geq 8,0$ V
Supply data							
Currents							
at V_{QH}	I_P	–	4,2	4,9	mA	17,0	V_G = 1,7 V
at V_{QL}	I_P	–	2,2	3,4	mA	17,0	$V_G \geq 8,0$ V
Dynamic data							
Input rise time	t_r	0,1	–	–	V/µs		
Input fall time	t_f	0,1	–	–	V/µs		

[1]) Typical values specified at V_P = 15 V and T_{amb} = 25 °C.

CHARACTERISTICS (continued)

Dynamic data

Loading capacitor connected between C and ø.



Waveforms illustrating measurement of t_{pdr} and t_{pdf}.

Measuring conditions: V_P = 15 V
I_{QL} = 200 mA
C_L = 10 pF
resistive load

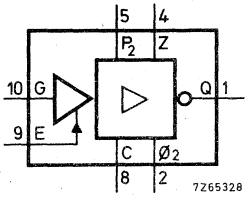
input waveform: $V_{pd} = \frac{1}{2} V_P$
output waveform: $V_{pd} = \frac{1}{2} V_{Pload}$

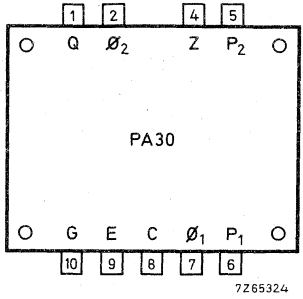
$t_{pdf} = (0,55 + 0,55 \times C_L)$ ns
$t_{pdr} = (0,30 + 0,30 \times C_L)$ ns

C_L in nF; C_L is 10 to 1000 nF

The 30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

POWER AMPLIFIER





top view

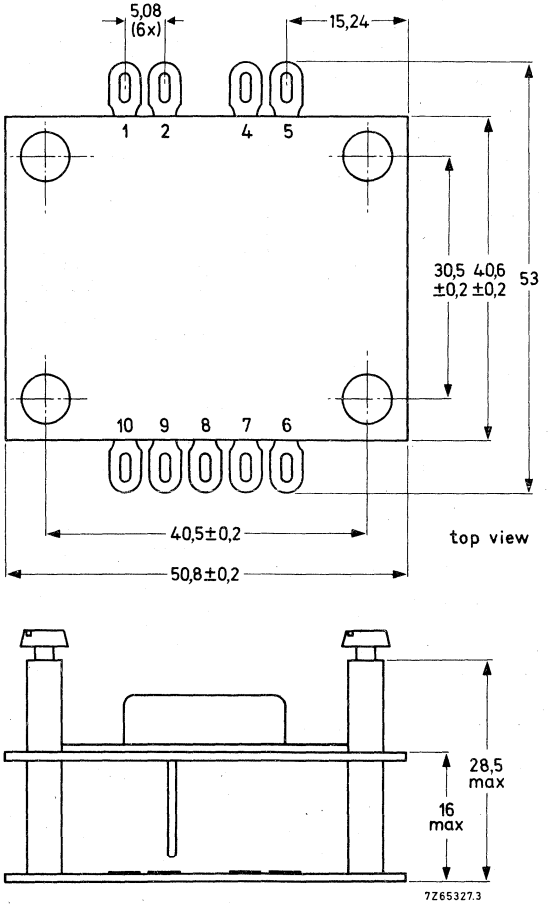
QUICK REFERENCE DATA				
Supply voltage	V_{P1}		11,4 to 17,0	V
	V_{PS}		11,4 to 55	V
Operating ambient temperature	T_{amb}		−30 to +75	°C
Output current (t_{av} = 20 ms)	I_{QL}	max.	2	A
Repetitive peak output current	I_{QLM}	max.	5	A
D.C. noise margin at T_{amb} = 25 °C	M_L	typ.	5	V
	M_H	typ.	8	V
Average power consumption at T_{amb} = 25 °C V_{P1} = 15 V; Q = unloaded; V_{PS} = 15 V; R_v = 0	P_{av}	typ.	240	mW

PACKAGE OUTLINE 9 leads special execution (see next page).

PACKAGE OUTLINE

Dimensions in mm

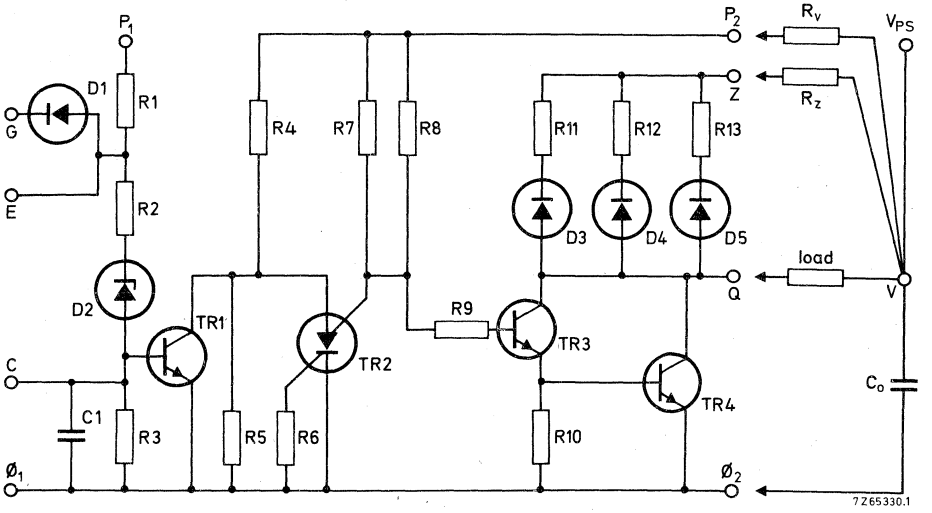
9 leads special execution



GENERAL DESCRIPTION

The PA30 is a power amplifier for output currents up to 2 A and output voltages up to 55 V, intended for driving heavy resistive and inductive loads.
The number of gate inputs can be extended by connecting up to 15 diodes (type BAW62) to the expander terminal E (connect anode of diode to E). *)
To increase the a.c. noise immunity, a capacitor can be connected between terminals C and ϕ_1 (see also "Operating notes"). The load has to be connected between Q and point V.
For inductive loads, terminal Z must also be connected to V, if necessary via a series resistor R_Z (see note 3 of "Operating notes").
Dependent on the V_{PS} value, a resistor R_V must be connected between terminal P_2 and point V (see note 1 of "Operating notes").
When the wire connection between V and supply voltage unit V_{PS} has some inductance, it is necessary to connect a capacitor C_o (≈ 10 µF per metre of wire) between V and ϕ_2 as close as possible to the unit.

CIRCUIT DIAGRAM



*) Diode leads should be kept as short as possible.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltages	V_{P1}	max.	20	V	[1]
	V_{PS}	max.	55	V	
Output voltage	V_{QH}	max.	55	V	
Input voltage	V_{GH}	max.	30	V	
Negative input voltage	$-V_{GL}$	max.	4	V	
Output current (average; t_{av} = 20 ms)	I_{QL}	max.	2	A	
Output current (peak value)	I_{QLM}	max.	5	A	
Storage temperature	T_{stg}		−40 to +85	°C	
Operating ambient temperature	T_{amb}		−30 to +75	°C	

1) See note 1 of "Operating notes".

CHARACTERISTICS Test conditions: T_{amb} = −30 to +75 °C

	Sym-bol	min.	typ. [1]	max.		Conditions and references	
						V_P (V)	
Static data							
Voltages							
Input HIGH	V_{GH}	7,5	–	–	V	11,4 and 17,0	V_Q = LOW
Input LOW	V_{GL}	–	–	4,5	V	11,4 and 17,0	V_Q = HIGH
Output HIGH	V_{QH}	–	–	55	V	11,4 and 17,0	I_Q = 5 mA $V_G \leq 4,5$ V
Output LOW	V_{QL}	–	0,9	1,3	V	11,4 and 17,0	I_Q = 2 A $V_G \geq 7,5$ V
D.C. noise margin: LOW	M_L	2,8	5	–	V	11,4 and 17,0	
HIGH	M_H	2,5	8	–	V	11,4	
Currents							
Input HIGH	I_{GH}	–	0,1	10	μA	17,0	V_G = 17 V
Input LOW	$-I_{GL}$	–	–	5,1	mA	17,0	V_G = 1,7 V
Output HIGH	I_{QH}	–	1 μA	5	mA	11,4 and 17,0	V_{QH} = 55 V $V_G \leq 4,5$ V
Output LOW (t_{av} = 20 ms)	I_{QL}	–	–	2	A	11,4 and 17,0	V_{QL} = 1,3 V $V_G \geq 7,5$ V
(peak value)	I_{QLM}	–	–	5	A	11,4 and 17,0	V_{QL} = 1,3 V

[1]) All typical values under test conditions: V_{P1} = 15 V; V_{PS} = 15 V; R_v = 0; T_{amb} = 25 °C.

CHARACTERISTICS (continued) Test conditions: T_{amb} = −30 to +75 °C

	Sym-bol	min.	typ.	[1]) max.		Conditions and references	
						V_P (V)	
Supply data							
Currents	I_{P1}	–	4,3	–	mA	15	V_G = 1,7 V
	I_{P1}	–	2,6	–	mA	15	V_G ≥ 7,5 V
	I_{P2}	–	14,5	–	mA	15	V_G ≤ 4,5 V
	I_{P2}	–	12,5	–	mA	15	V_G ≥ 7,5 V

[1]) All typical values under test conditions: V_{P1} = 15 V; V_{PS} = 15 V; R_v = 0; T_{amb} = 25 °C.

OPERATING NOTES

1. Supply voltage V_{PS}

When terminal P_2 is directly connected to point V the value of V_{PS} must be between 11,4 V and 19 V (15,2 V ± 25%).
By connecting a suitable resistor (R_V) between P_2 and V, any supply voltage V_{PS} between 11,4 and 55 V may be used, having a tolerance of ± 25%.
The values of R_V can be calculated from:

$$R_V = 75\ (V_{PSnom} - 15)\ \Omega \pm 8\%$$

2. For capacitor C_o see "General description"

3. Unit loaded with an inductive load

When an inductive load is switched, the built-in diodes (which protect the output transistor against voltage transients) have to be connected (Z to point V).
This protection is realized at the expense of a very long decay time of the current in the load.
At V_{PS} below 55 V a resistor R_Z may be connected in series with the protection diodes to decrease this decay time.

The maximum permissible value of R_Z can be calculated from:

$$R_Z < \frac{1}{I_Q}\ (55 - V_{PSmax})\ \Omega$$

Where: I_Q = the load current at switching-off.

The decay time of the load current can be calculated from:

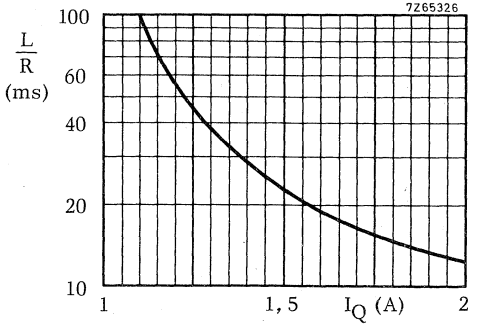
$$I_L = I_Q \exp - \frac{t}{L/R}$$

Where: I_Q = the load current at switching-off in amperes
L = inductance of the load in henrys
R = sum resistance of load and possible applied R_Z in ohms

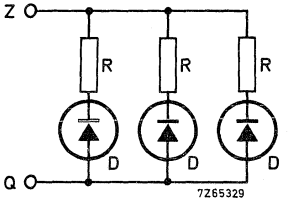
Note: V may be connected directly to Z ($R_Z = 0$) if there are no problems with decay time.

OPERATING NOTES (continued)

4. Inductance of the load



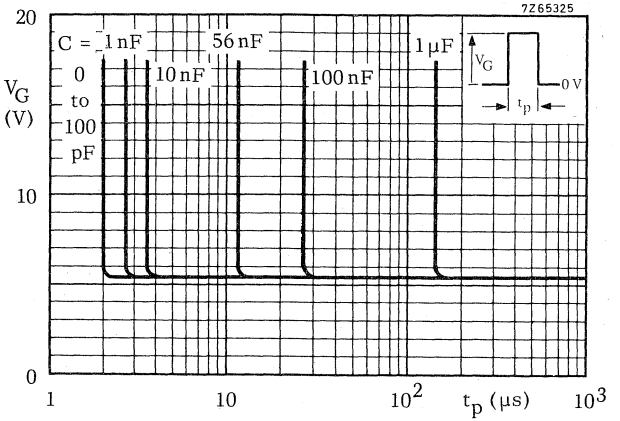
The maximum allowable inductance of the load can be calculated from the maximum permissible value of L/R as follows from the graph above.
I_Q = the load current at switching-off.
R = sum resistance of load and possible applied R_Z.



R = 1,5 Ω
D = BAX12

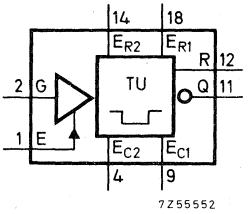
When the above circuit is connected between the terminals Z and Q, loads with any inductance value and currents up to 2 A can be applied.

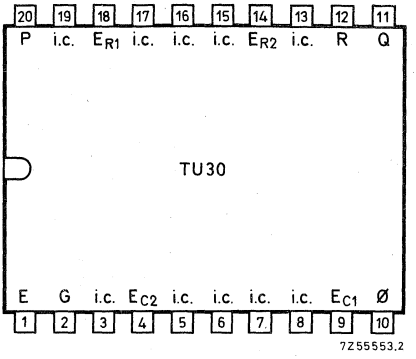
5. Input voltage versus input pulse duration as a function of a capacitor between terminals C and ϕ_1.



The FZ/30-Series has been designed for high noise immunity low speed digital applications in industrial control, computer periphery equipment and data processing.

TIMER UNIT

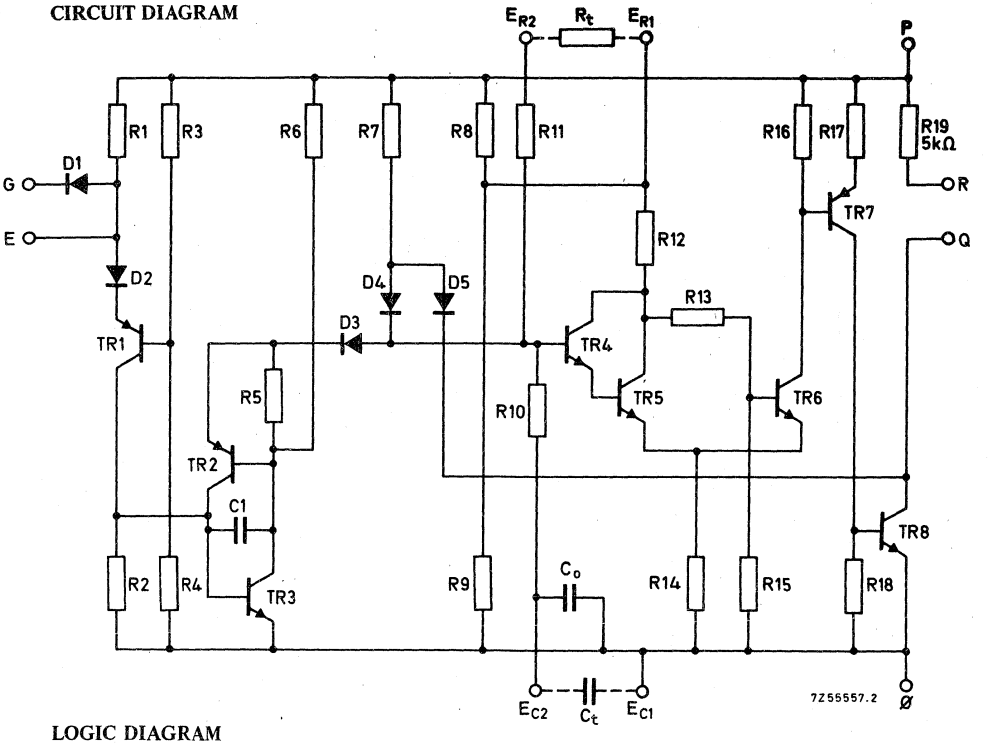




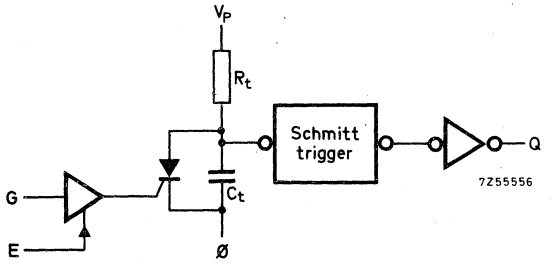
QUICK REFERENCE DATA				
Supply voltage	V_P	11,4 to 17,0		V
Operating ambient temperature	T_{amb}	−30 to +75		°C
Delay time; T_{amb} = 25 °C	t_d	max.	10	s/µF
Available d.c. fan-out (T_{amb} = −25 to +70 °C) LOW state	N_{aL}	max.	22	
D.C. noise margin at T_{amb} = 25 °C; V_P = 15 V	M_L	typ.	6,5	V
	M_H	typ.	6,5	V
Power consumption at T_{amb} = 25 °C	P_{av}	typ.	300	mW

PACKAGE OUTLINE 20 lead dual in-line (see general section).

CIRCUIT DIAGRAM



LOGIC DIAGRAM



GENERAL DESCRIPTION

The TU30 is a direct-coupled timer that gives a constant delay irrespective of the duration of the gate input signal. The delay begins when the gate input changes from HIGH to LOW (see timing diagram). When the gate input changes from LOW to HIGH, the output goes LOW. A gate input signal during a delay cycle will restart the delay.

The length of the delay is determined by an external capacitor connected across terminals E_{C1} and E_{C2}, and an external resistor connected across terminals E_{R1} and E_{R2}.

The number of gate inputs can be extended by connecting up to 15 diodes (BAW62) to the expander input terminal E (connect anode of diode to terminal E). *)
To prevent capacitive coupling with other lines the connection between the diodes and expander inputs must be as short as possible.

When using the TU30 to drive other members of the FZ/30-Series, interconnect terminals Q and R.

When using it to drive a small relay, connect the relay across terminals Q and P, and leave terminal R unconnected (floating).

When driving an inductive load (also relays), connect a clamping diode (such as a BAW62) across terminals Q and P (anode of diode to terminal Q). *)

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	V_P	max.	18	V
Output voltage	V_{QH}	max.	V_P	
Output current (Q and R not interconnected)	I_{QL}	max.	46	mA
Input voltages	V_G	max.	18	V
	$-V_G$	max.	1	V
Input current (for negative input voltage)	$-I_G$	max.	2,0	mA
Output capacitance	C_L	max.	500	pF
Storage temperature	T_{stg}	−25 to +85		°C
Operating ambient temperature	T_{amb}	−25 to +70		°C

*) Diode leads should be kept as short as possible.

CHARACTERISTICS Test conditions: T_{amb} = −25 to +70 °C.

	Sym-bol	min.	typ [1])	max.		Conditions and references: V_P (V)	Conditions and references
Static data							
Voltages							
Input HIGH	V_{GH}	6,8	–	–	V	11,4	I_{QL} = 43 mA *)
	V_{GH}	9,3	–	–	V	17,0	I_{QL} = 46 mA **)
Input LOW	V_{GL}	–	–	4,5	V	11,4	V_{QHmin} = 0,9 V_P
	V_{GL}	–	–	7,3	V	17,0	$-I_{QH}$ = 0,25 mA
Output HIGH	V_{QH}	10	13	–	V	11,4	V_{GL} = 4,5 V; $-I_{QH}$ = 0,25 mA
	V_{QH}	15,3	–	–	V	17,0	V_{GL} = 4,5 V; $-I_{QH}$ = 0,25 mA
Output LOW	V_{QL}	–	–	0,5	V	11,4	V_{GH} = 6,8 V; I_{QL} = 43 mA *); I_{QL} = 46 mA **)
D.C. noise margin: HIGH	M_H	3,2	–	–	V	11,4	V_{GH} = 10 V
LOW	M_L	2,8	–	–	V	11,4	V_{GL} = 1,7 V
HIGH	M_H	–	6,5	–	V	15,0	V_{GH} = 1,4 V
LOW	M_L	–	6,5	–	V	15,0	V_{GL} = 1,0 V
Currents							
Input HIGH	I_{GH}	–	–	1	µA	17,0	V_{GH} = 17,0 V
Input LOW	$-I_{GL}$	–	–	0,95	mA	11,4	V_{GL} = 1,7 V
	$-I_{GL}$	–	–	1,6	mA	17,0	V_{GL} = 1,7 V
Output HIGH	$-I_{QH}$	–	–	0,50	mA	11,4	V_{GL} = 4,5 V; V_{QH} = 10 V *)
	$-I_{QH}$	–	–	0,50	mA	17,0	V_{GL} = 7,3 V; V_{QH} = 15,3 V *)
Output LOW	I_{QL}	–	–	43	mA	11,4 and 17,0	V_{GH} = 0,6 V_P; V_{QL} = 0,5 V *)
	I_{QL}	–	–	46		11,4 and 17,0	V_{GH} = 0,6 V_P; V_{QL} = 0,5 V **)
Supply data							
Currents							
Output HIGH	I_P	–	6,5	7,5	mA	17,0	V_G = 0 V
Output LOW	I_P	–	17	20	mA	17,0	V_G = 17 V

[1]) Typ. values specified at V_P = 15 V and T_{amb} = 25 °C.
*) Terminal R connected to terminal Q.
**) Terminal R not connected.

CHARACTERISTICS at V_P = 15 V; T_{amb} = 25 °C

Dynamic data

Gate input HIGH duration	T_{GH}	>	5	µs	
Output rise time for C_L = 10 pF	t_{Qr}	typ.	110	ns	1)
Output fall time for R_C = 5 kΩ; C_L = 10 pF	t_{Qf}	typ.	50	ns	
Fall propagation delay time	t_{pdf}	typ.	3	µs	
Delay time (C_t in F; R_t in Ω)	t_d	>	1	ms	
		typ.	$C_t(R_t + 10\,k\Omega)$	s	
Timing resistor	R_t		0 Ω to 10	MΩ	
Timing capacitor	C_t	no limit			2)
Change in delay time versus temperature (R_t = 1 MΩ; V_P = 15 V)		typ.	−0,1	%/°C	
Change in delay time versus supply voltage (T_{amb} = 25 °C; R_t = 1 MΩ)		typ.	−0,5	%/°C	

1) t_{Qr} = (11 x C_L) ns. C_L is the wiring capacitance in pF with a maximum permissible value of 500 pF.

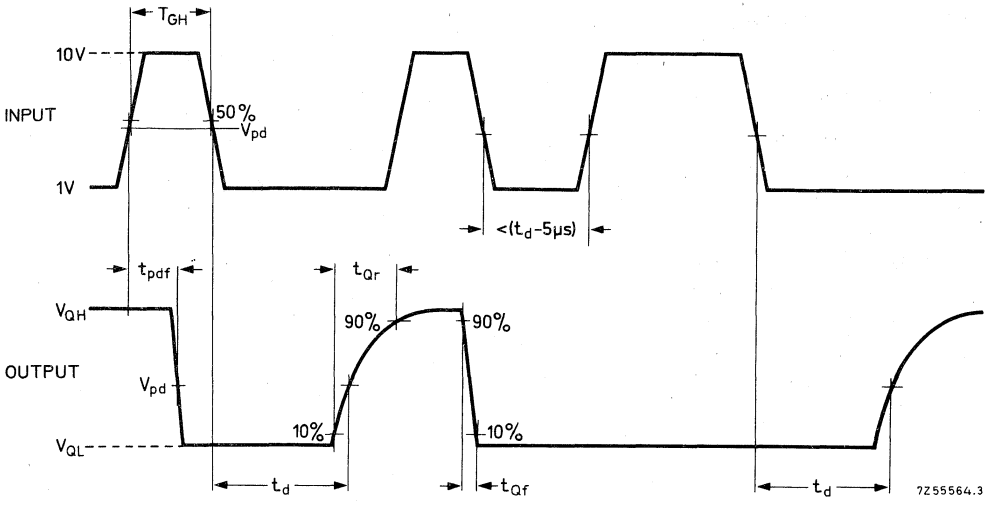
2) Preferred value for C_t: > 1 nF.
The circuit is not developed for electrolytic capacitors because of their high leakage currents. However, electrolytic capacitors may be used (+ side connected to terminal E_{C2}), provided that the charge current is large compared to the leakage current of the capacitor e.g.:

$$I_{charge} > 10.I_{leakage}$$

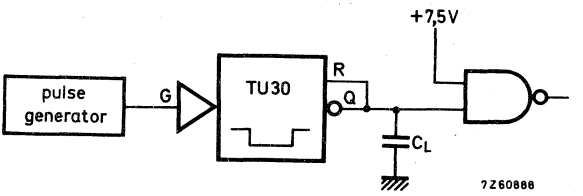
$$\text{where } I_{charge} = \frac{0,3\,V_P}{R_t + 10\,k\Omega}$$

CHARACTERISTICS (continued)

Dynamic data



Pulse generator (G-input): t_r = 350 ns
t_f = 120 ns
t_{GH} = 5 µs
V_{pd} = 4,5 V



Measuring conditions: V_P = +15 V
C_L = 10 pF (including probe and jig capacitance)
T_{amb} = +25 °C

Waveforms and loading circuit illustrating measurement of t_{Qr}, t_{Qf} and t_{pdf}.

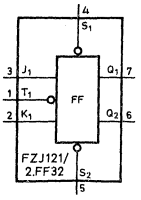
Accessories for HNIL FZ/30-Series

STICKERS

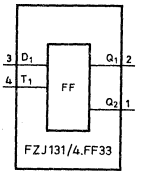
The **drawing** of circuit diagrams is simplified by the use of stickers of the drawing symbols of the FZ/30-Series. These stickers, printed on self-adhesive transparant material, are available in sheets. Each sticker can be separately detached from the sheet without cutting.

sheets with symbols for type	catalogue number for 25 sheets	symbols per sheet
FZH101/4.NAND32 FZH111/4.NAND30 FZH121/2.NAND30 FZH131/2.NAND31 FZH141/2.NAND32	4322 026 75420	5 x NAND 10 x NAND* 10 x OR* ● 5 x OR ●
FZH151/2.AOR30	4322 026 75460	12 x
FZH161/4.LI31 FZH171/2.NAND33 FZH181/4.LI30 FZH191/3.NAND33 FZH201/6.IN30 FZH211/4.NAND34 FZH231/2.NAND35	4322 026 75420	5 x NAND 10 x NAND* 10 x OR* ● 5 x OR ●
FZH241/2.AST30	4322 026 74350	9 x
FZH251/4.AND30 FZH261/2.N-4.I30 FZH271/4.EO30 FZH281/4.NOR30 FZH291/4.OR30	4322 026 74380	5 x AND 5 x OR 5 x NOR 5 x EXCLUSIVE-OR 5 x INVERTER
FZJ101/FF30	4322 026 75430	15 x
FZJ111/FF31	4322 026 75440	15 x
FZJ121/2.FF32	4322 026 74100	8 x
FZJ131/4.FF33	4322 026 74110	4 x
FZJ141/FF34 FZJ151/FF35	4322 026 74120	12 x
FZJ161/FF36	4322 026 74360	12 x
FFK101/OS30	4322 026 75450	6 x
FZL101/ND30	4322 026 74370	12 x
TU30	4322 026 75450	10 x
2.LRD30	4322 026 75490	12 x
PA30	4322 026 75480	16 x

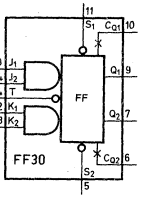
*With slow-down terminal.
●With inverted inputs.



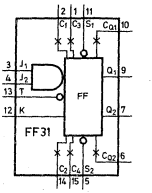
4322 026 74100



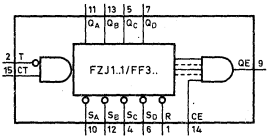
4322 026 74110



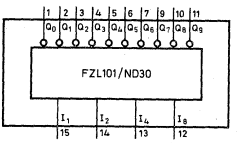
4322 026 75430



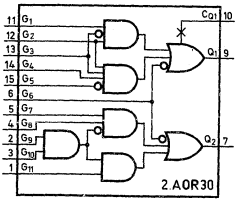
4322 026 75440



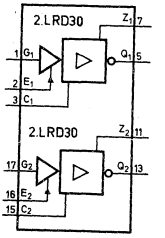
4322 026 74120



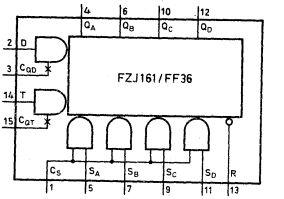
4322 026 74370



4322 026 75460

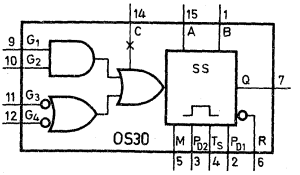


4322 026 75490

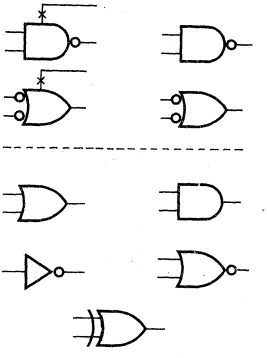


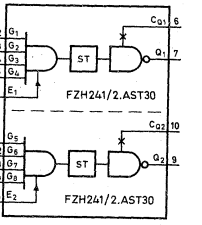
4322 026 74370

4322 026 75450

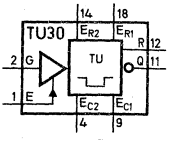


4322 026 75420

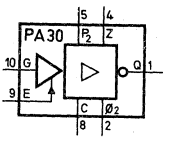




4322 026 74350



4322 026 75450



4322 026 75480

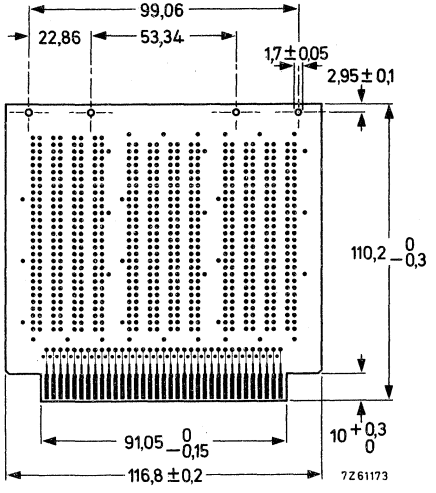
4322 026 74380

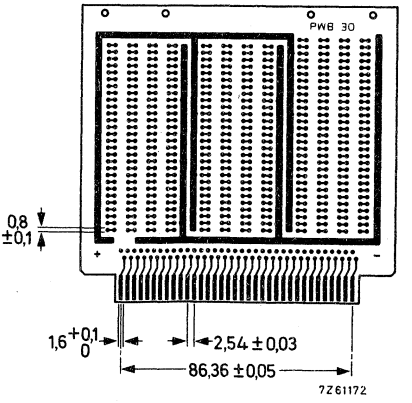
EXPERIMENTERS' PRINTED-WIRING BOARD

for integrated circuits in dual-in-line package

This printed-wiring board has been designed for dual-in-line packages with a different number of pins; the packages are connected with each other and with the connector by means of insulated wires. The packages are mounted perpendicular to the connector, so the wires to the connector can run parallel to the rows of pins of the packages, instead of between the pins.
The maximum number of packages which can be mounted is given below:

number of pins of the package	max. number of packages per board
2 x 7	24
2 x 8	18
2 x 9	18
2 x 10	12
2 x 11	12

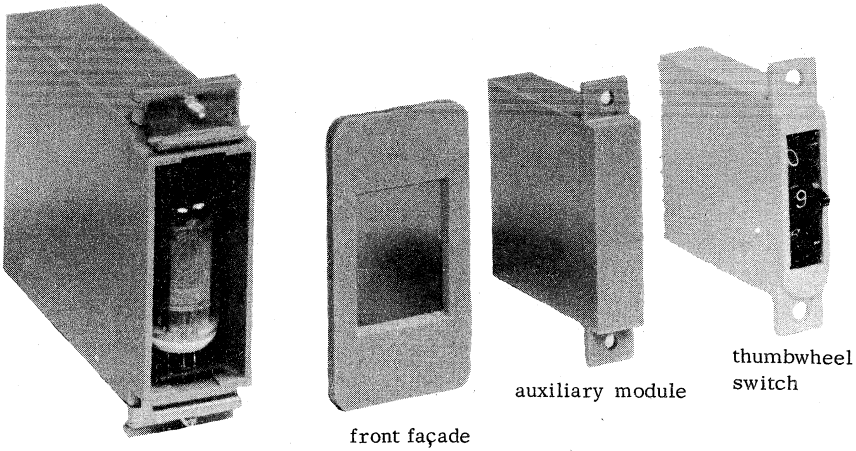




Material	glass-epoxy
Board thickness	1,6 mm
Holes	plated-through, 0,8 mm diameter, provided with soldering lands
Contact pads	2 x 35, gold-plated

Counter modules 50-Series

INTRODUCTION



indicator module

front façade

auxiliary module

thumbwheel switch

RZ 24173

The 50-Series contains uni-directional and bi-directional decade counters with direct display and a number of auxiliary modules offering a complete range of building modules for industrial automation and control.
The use of silicon semiconductors, including silicon-controlled switches (SCS), ensures reliable operation over a wide temperature range.
The simple rules regarding electrical interconnections, mounting accessories and interwiring of the compact self-contained cases, make the 50-Series ideal for immediate installation and assembly in a large variety of applications. Preset programmed control with the aid of compatible preset switches and input/output devices offer excellent possibilities for:

- industrial batch counting
- automatic winding machines
- sequential control and timing
- numerical control systems
- automatic weighing and dosing
- speed control, etc.

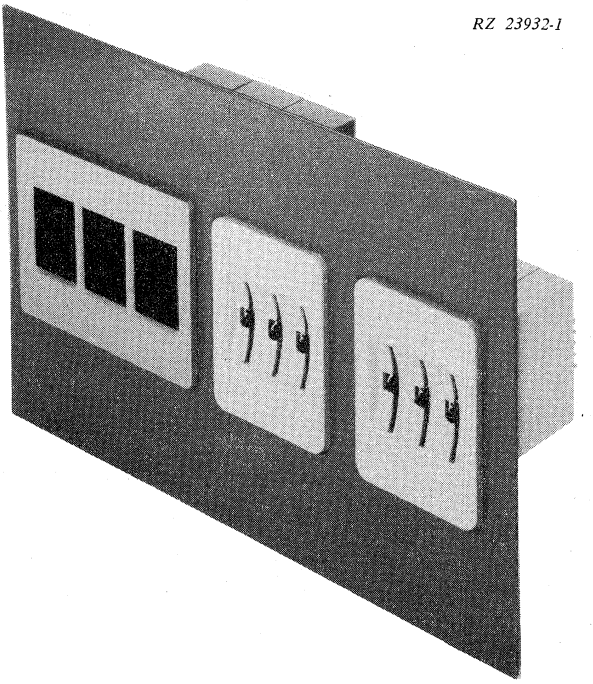
MODULES

The 50-Series comprises the following modules:

type	description	catalogue number
NIC50	Uni-directional decade counter with decimal outputs and direct display. The use of silicon controlled switches allows for direct drive of the numerical indicator tube.	2722 007 03001
RIC50	Bi-directional decade counter with decimal outputs and direct display. The use of silicon controlled switches allows for direct drive of the numerical indicator tube.	2722 007 04001
MID50	Integral buffer memory with direct display. Accepts decimal information from NIC50 and RIC50.	2722 007 05001
SID50	+ and − sign indicator driver with direct display.	2722 007 06001
SU50	10 position thumbwheel switch for preset counting (type 10P1C).	4311 027 82321
3.NOR50	Buffer adaptation stage and double NOR for sequential and combinational logic operations. The latter can be cross connected to form a d.c. memory function.	2722 007 00001
4.NOR51	Quadruple NOR for sequential and/or combinational logic operations. Two d.c. memory functions can be made from the four NOR's.	2722 007 00011
PSR50	Pulse shaper combined with an automatic/manual reset unit.	2722 007 01001
LRD50	300 mA, 30 V output stage for lamp and relay drive.	2722 007 02001
PDU50A and PDU50B	Printer drive units	2722 007 08001 2722 007 08011

type	description	catalogue number
PSU50	Power supply unit Input: 110, 220, 230, 240 V_{ac} $\pm$10%, -15%; 45 to 65 Hz Output: a) 24 V_{dc}, $\pm$5%, 250 mA (logic supply) b) 250 V_{dc}, $\pm$18% (supply for 12 indicator tubes)	2722 151 00061
DCD50	General purpose decade counter and divider	2722 007 07001
ECA50	Empty case assembly	2722 007 89001

For detailed electrical information on the above-mentioned modules, see the relevant data sheets; for data on the SU50, see the data sheets of thumbwheel switches 4311 027 82...
For detailed application information the Application Book "Design with 50-series modules", print number 9399 263 06001, should be consulted.



→ MOUNTING ACCESSORIES

Front façades for indicator modules (NIC50, RIC50, MID50 and SID50)

Front façades are available for one up to and including six indicator modules. They are provided with a coloured polarised screen.

type	number of indicator modules	catalogue number
FIC 1	1	4322 026 70340
FIC 2	2	70350
FIC 3	3	70360
FIC 4	4	70370
FIC 5	5	70380
FIC 6	6	70390

Mounting façades for thumbwheel switches (SU50)

Mounting façades, giving facilities for mounting one up to and including six switches, are available.

type	number of switches	catalogue number
FMF 1	1	4311 027 80598
FMF 2	2	80608
FMF 3	3	80618
FMF 4	4	80628
FMF 5	5	80638
FMF 6	6	80648

Mounting aids for auxiliary modules (3.NOR50, 4.NOR51, PSR50, LRD50, PDU50A, PDU50B and DCD50)

Mounting bar, catalogue number 4322 026 70170
Self tapping screws (2 pieces), 4Nx$\frac{1}{4}$", catalogue number 2522 163 01005
Washer (M3), catalogue number 2522 600 16016

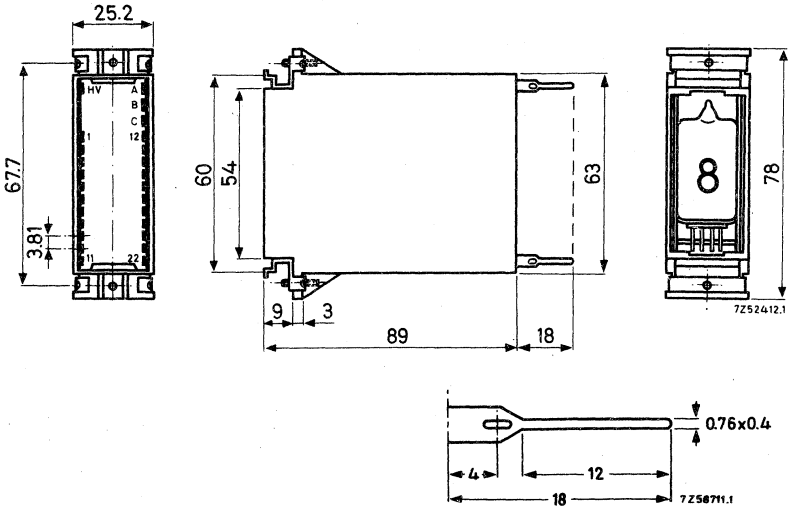
CONSTRUCTION

The various functions are housed in plastic cases, of which the dimensions and terminal locations are shown below.
Each module is provided with pins for soldering and wire-wrapping.

DIMENSIONS

The dimensions in the figures are given in mm; for inch values see the tables.

Indicator modules (NIC50, RIC50, MID50 and SID50)

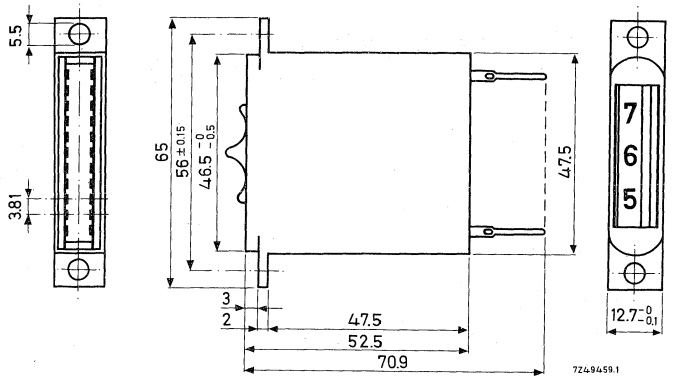


mm	inches
3	0.118
3.81	0.150
4	0.158
9	0.354
12	0.472
18	0.708
25.2	0.992
54	2.126

mm	inches
60	2.362
63	2.480
67.7	2.665
78	3.070
89	3.504

For detailed information on wire-wrapping, see the Application Book "Design with 50-Series modules, print number 9399 263 06001.

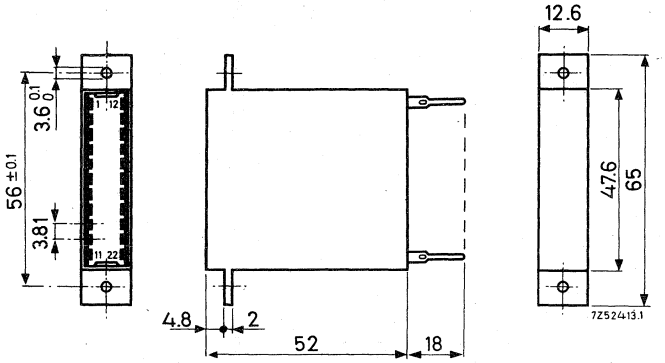
Thumbwheel switch (SU50)



mm	inches
2	0.078
3	0.118
3.81	0.150
5.5	0.216
12.7 -0 -0.1	0.5 -0 -0.004

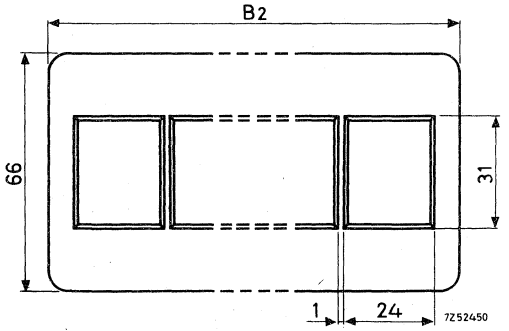
mm	inches
46.5 -0 -0.5	1.831 -0 -0.02
47.5	1.870
52.5	2.067
56 ± 0.15	2.205 ± 0.006
65	2.559
70.9	2.791

Auxiliary modules (3.NOR50, 4.NOR51, PSR50, LRD50, PDU50A, PDU50B and DCD50)

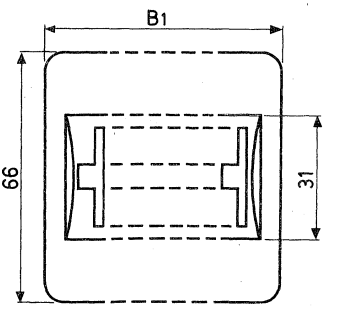


mm	inches	mm	inches
2	0.078	18	0.708
3.6 0.1 0	0.142 0.004 0	47.6	1.874
3.81	0.150	52	2.047
4.8	0.189	56 ± 0.1	2.205 ± 0.004
12.6	0.496	65	2.559

Façades



Front façade for indicator modules
(For B_2 see next page)



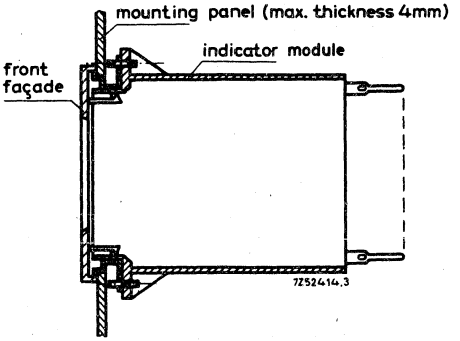
Mounting façade for thumbwheel switches
(For B_1 see next page)

mm	inches
1	0.039
24	0.945
31	1.220
66	2.598

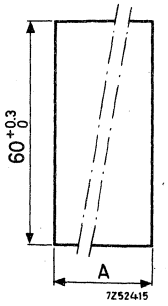
number of modules	indicator modules width B_2		thumbwheel switches width B_1	
	mm	inches	mm	inches
1	35.4	1.394	24	0.945
2	60.8	2.394	36.7	1.445
3	86.2	3.394	49.4	1.945
4	111.6	4.394	62.1	2.445
5	137.0	5.394	74.8	2.945
6	162.4	6.394	87.5	3.445

MOUNTING

Indicator modules (NIC50, RIC50, MID50 and SID50)



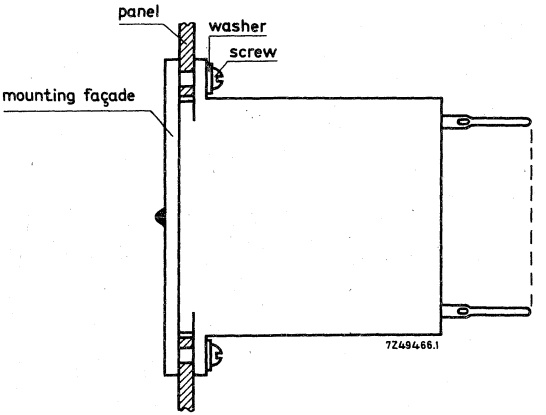
The module is fixed to a mounting panel by means of two screws. The maximum thickness of the mounting panel is 4 mm (0.157 inch). The aperture in the mounting panel is proportional to the number of indicator modules (see table below).
The front façades clip in to the indicator modules.



number of modules	width A	
	mm	inches
1	25.4 + 0.5	1 + 0.02
2	50.8 + 0.5	2 + 0.02
3	76.2 + 0.5	3 + 0.02
4	101.6 + 0.5	4 + 0.02
5	127.0 + 0.5	5 + 0.02
6	152.4 + 0.5	6 + 0.02

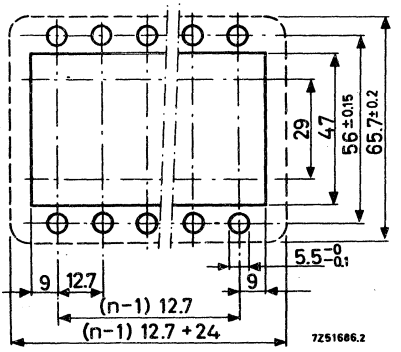
$(60^{+0.3}_{0}$ mm = $2.362^{+0.012}_{0}$ inch)

Thumbwheel switches (SU50)



The switches can be mounted in panels with a thickness up to 4 mm by means of mounting façades and the screws and washers supplied. When the panel thickness is less than 4 mm (0.157 inch), additional washers must be used between the panel and the switch.

The dimensions of the necessary apertures in the mounting panel are given in the drawing below; the outline of the mounting façade is indicated by a dash-line.

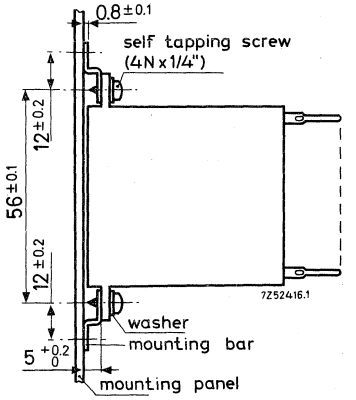


(n = number of switches)

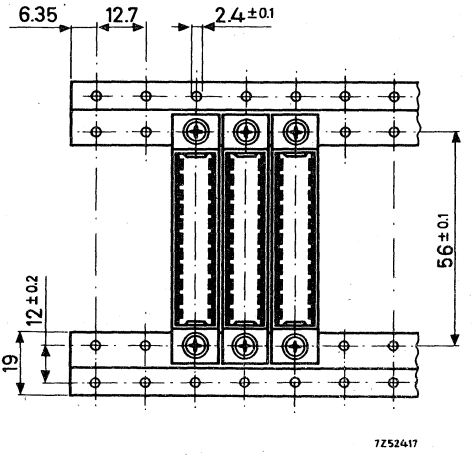
mm	inches
5.5 -0 -0.1	0.216 -0 -0.004
9	0.354
12.7	0.5
24	0.945
29	1.142
47	1.851
56 ± 0.15	2.205 ± 0.004
65.7 ± 0.2	2.587 ± 0.008

Auxiliary modules (3.NOR50, 4.NOR51, PSR50, LRD50, PDU50A, PDU50B and DCD50)

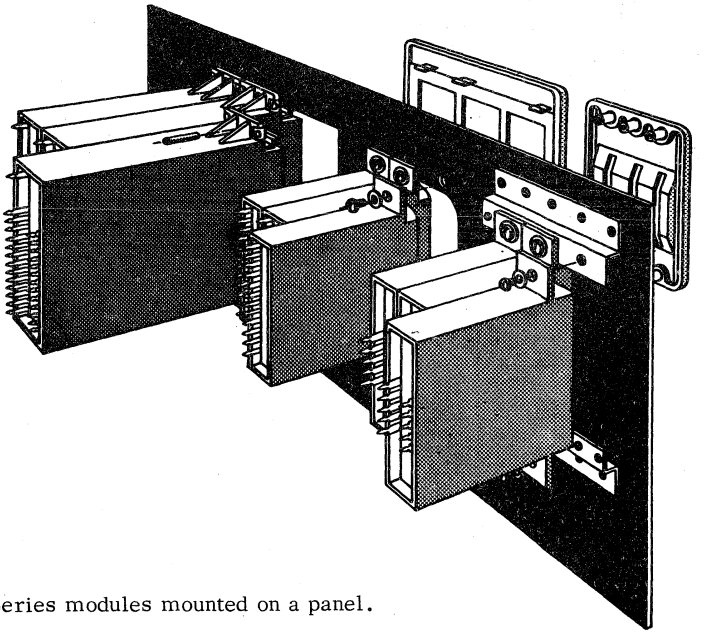
Auxiliary modules are to be fixed to a mounting panel with the aid of two metal bars (available in standard length of 21 positions).
The fixation of each module to the metal bar is done with two self tapping screws (4N x $\frac{1}{4}$ inch).



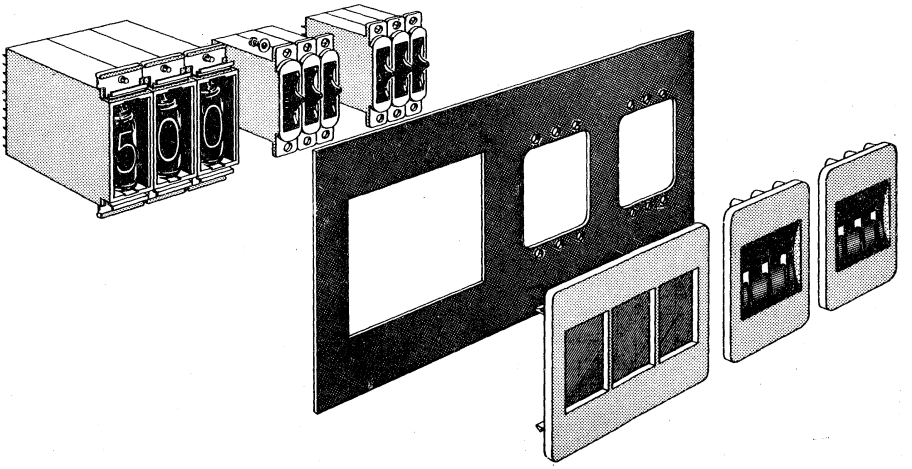
mm	inches
0.8 ± 0.1	0.032 ± 0.004
5 +0.2 0	0.197 +0.008 0
12 ± 0.2	0.472 ± 0.008
56 ± 0.1	2.205 ± 0.004



mm	inches
2.4 ± 0.1	0.094 ± 0.004
6.35	0.25
12 ± 0.2	0.472 ± 0.008
12.7	0.5
19	0.748
56 ± 0.1	2.205 ± 0.004



50-Series modules mounted on a panel.



CHARACTERISTICS

Ambient temperature range

Operating: −25 to +70 °C
−10 to +70 °C, for DCD50 at V_P = +24 V_{dc} ± 25%
Storage : −40 to +85 °C

Counting rate

Uni-directional: max. 50 kHz
Bi-directional : max. 12 kHz

Supply voltage

Logic supply: single rail, +24V_{dc} ± 10% 1)
Tube supply : high voltage, +250V ± 18%

Fan out

Decade counter: the counter units can be loaded with 6 different programmes.

NOR gate : each output may be loaded with the inputs of six other NOR's. The NOR50 and NOR51 are fully compatible with NOR units of the 60-Series.

1) Note that output units may be operated from a supply voltage of +24V_{dc}, ± 25%.

TEST SPECIFICATIONS

All modules of the 50-Series are designed to meet the tests below. Before and during manufacture samples of modules are regularly subjected to these tests.

1. Shock test according to method 202B of MIL-STD-202C, 3 blows 50 g in 3 perpendicular directions.
2. Vibration test according to method 201A of MIL-STD-202C.
   Frequency 10-55 Hz, amplitude 0.76 mm max., cycle time 1 min, 2 hours in 3 perpendicular directions.
3. Temperature-cycling test according to method 102A of MIL-STD-202; 5 cycles from -40 to +100 °C.
4. Long-term humidity test according to I.E.C.68, test C.
   Duration 21 days at 40 °C and R.H. = 90-95%.
5. Solderability according to method 210 of MIL-STD-202.

LOADING TABLE

NOTES

By expressing the input requirements and output capabilities of most modules in "DRIVE UNITS (D.U)", system design is greatly simplified.
Moreover input requirements of all modules are additive.

*) Also suitable for driving 2 x C_F/C_R of RIC50.

**) Two inputs in parallel or one input always floating.

type	function	input		output	
		terminal	required	terminal	available
NIC50	Uni-directional direct display counter	R	To be driven from Q_R of PSR50	Q_0-Q_9	To drive 6 x buffer NOR's + 1 x T-NIC50 + I_0-I_9 of 6 x MID50 + PDU50
		T	To be driven from Q_T of PSR50 or Q_0-Q_9 of NIC50		
RIC50	Bi-directional direct display counter	R	To be driven from Q_R of PSR50	Q_0-Q_9	To drive 6 x buffer NOR's + 1 x T-RIC50 + I_0-I_9 of 6 x MID50 + PDU50
		T_F/T_R	To be driven from Q_T of PSR50 or Q_0-Q_9 of RIC50		
		C_F/C_R	To be driven from Q of LRD50 or Q of NOR50/51		
MID50	Buffer memory with direct display	I_0-I_9	To be driven from Q_0-Q_9 of NIC50, RIC50 or MID50	Q_0-Q_9	To drive decimal input of PDU50 + I_0-I_9 of 3 x MID50
		T_C	To be driven from Q_R or Q_T of PSR50		
SID50	Driver plus and minus indicator tube	+ and - character	1 D.U.	none	Not applicable
3.NOR50	6 Input buffer NOR	G_1-G_6	To be driven from Q_0-Q_9 of NIC50 or RIC50	Q_1	2 D.U.
	Dual 4 input NOR	G_7-G_{14}	1 D.U.	Q_2/Q_3	6 D.U.*)
4.NOR51	Quadruple 4 input NOR	G_1-G_{16}	1 D.U.	Q_1-Q_4	6 D.U.*)

type	function	input		output	
		terminal	required	terminal	available
PSR50	Pulse shaper	B (via R = 39 kΩ)	2 D.U.	Q_T	2 x (T_R + T_F) - RIC50 + 2 D.U. or 4 x T-NIC50 + 2 D.U. or 6 x T_C-MID50
	Reset	T	1 D.U.	Q_R	6 x R-NIC50/RIC50 or 6 x T_C-MID50
		G	1 D.U.	Q_L	4 D.U.
LRD50	Lamp/relay driver	G_1-G_3	1 D.U.	Q	300 mA, 30V (abs.max.) or 6 x C_F/C_R -RIC50
PDU50A	Printer drive unit	I_0-I_9	To be driven from Q_0-Q_9 of NIC50, RIC50 or MID50	Q_0-Q_9	2 D.U.
		L	To be driven from L_1-L_3 of PDU50B		
PDU50B	Printer drive unit	C	To be driven from: -Q_T of PSR50 or -NOR unit**	L_1-L_3	To drive input L of PDU50A
		S_1-S_3	To be driven from: -Q_0-Q_9 of NIC50 or RIC50 -DCD50 -NOR unit**		
DCD50	Decade counter and divider	$T_A/T_C/T_D$ T_{B_1}/T_{B_2} S	0 D.U. 1 D.U. 1.5 D.U.	Q_A, $\overline{Q_A}$, Q_B, $\overline{Q_B}$, Q_C, $\overline{Q_C}$, Q_D, $\overline{Q_D}$	To drive 1 x T-NIC50/RIC50
		C_S	6 D.U.	Q_A, Q_B, $\overline{Q_B}$, Q_C, $\overline{Q_C}$	6 D.U. + 1 x T-DCD50 or 4 D.U. + 1 x B-PSR50
				$\overline{Q_A}$, Q_D, $\overline{Q_D}$	see data sheet

Survey of terminal location

terminals	indicator modules (Fig.A)				auxiliary modules (Fig.B)						
	NIC50	RIC50	MID50	SID50	3.NOR50	4.NOR51	PSR50	LRD50	PDU50A	PDU50B	DCD50
HV	V_{P3}	V_{P3}	V_{P3}	V_{P3}	not provided	not provided	not provided	not provided	not provided	not provided	not provided
A	not provided	not provided	LS	X	not provided	not provided	not provided	not provided	not provided	not provided	not provided
B	not provided	not provided	T_C	Y	not provided	not provided	not provided	not provided	not provided	not provided	not provided
C	not provided	not provided	I_0	Z	not provided	not provided	not provided	not provided	not provided	not provided	not provided
1	V_{P1}	V_{P1}	V_{P1}	V_{P1}	V_{P1}	V_{P1}	V_{P1}	not provided	I_1	V_{P1}	V_{P1}
2	0	0	0	0	0	0	0	0	I_2	0	0
3	not provided	C_F	I_1	not provided	G_1	G_1	Q_R	V_{P2}	I_3	K_1	$\overline{Q}_D$
4	not provided	C_R	I_2	not provided	G_2	G_2	Q_L	not provided	I_4	K_2	Q_D
5	F	F	I_3	not provided	G_3	G_3	Q_T	Q	I_5	L_1	Q_C
6	not provided	not provided	I_4	+	G_4	Q_2	i.c.	not provided	L	L_2	$\overline{Q}_C$
7	Q_5	Q_5	Q_5	-	G_5	Q_1	B	not provided	Q_1	L_3	T_{D_2}
8	Q_4	Q_4	Q_4	not provided	G_6	G_5	Z	G_1	Q_2	S_1	T_{D_1}
9	Q_3	Q_3	Q_3	not provided	D_1	G_6	A	G_2	Q_3	S_2	T_C
10	Q_2	Q_2	Q_2	not provided	D_2	G_7	G	G_3	Q_4	S_3	S_C
11	Q_1	Q_1	Q_1	not provided	Q_1	G_8	T	not provided	Q_5	C	S_D
12	not provided	not provided	I_9	~	G_7	G_9	not provided	not provided	Q_6	not provided	S_B
13	not provided	not provided	I_8	not provided	G_8	G_{10}	not provided	not provided	Q_7	not provided	Q_B
14	R	R	I_7	not provided	G_9	G_{11}	not provided	not provided	Q_8	not provided	$\overline{Q}_B$
15	not provided	T_R	I_6	not provided	G_{10}	G_{12}	not provided	not provided	Q_9	not provided	S_A
16	T	T_F	I_5	not provided	Q_3	Q_4	not provided	not provided	Q_0	not provided	Q_A
17	DP	DP	DP	not provided	Q_2	Q_3	not provided	not provided	L	not provided	$\overline{Q}_A$
18	Q_6	Q_6	Q_6	not provided	G_{11}	G_{13}	not provided	not provided	I_6	not provided	T_{B_1}
19	Q_7	Q_7	Q_7	not provided	G_{12}	G_{14}	not provided	not provided	I_7	not provided	T_{B_2}
20	Q_8	Q_8	Q_8	not provided	G_{13}	G_{15}	not provided	not provided	I_8	not provided	K
21	Q_9	Q_9	Q_9	not provided	G_{14}	G_{16}	not provided	not provided	I_9	not provided	T_A
22	Q_0	Q_0	Q_0	not provided	R_1	G_4	not provided	not provided	I_0	not provided	C_S

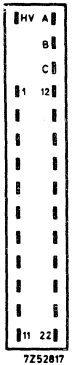


Fig.A.

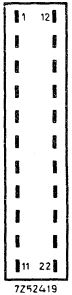
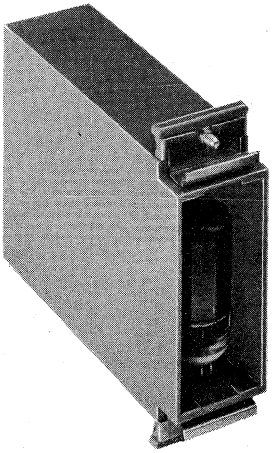


Fig.B.

NUMERICAL INDICATOR COUNTER



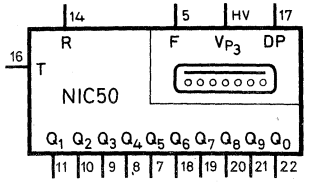
RZ 23932-3

Function

Uni-directional decade counter with direct numerical display for preset programmed control systems.
Maximum counting rate: 50 kHz.

DESCRIPTION

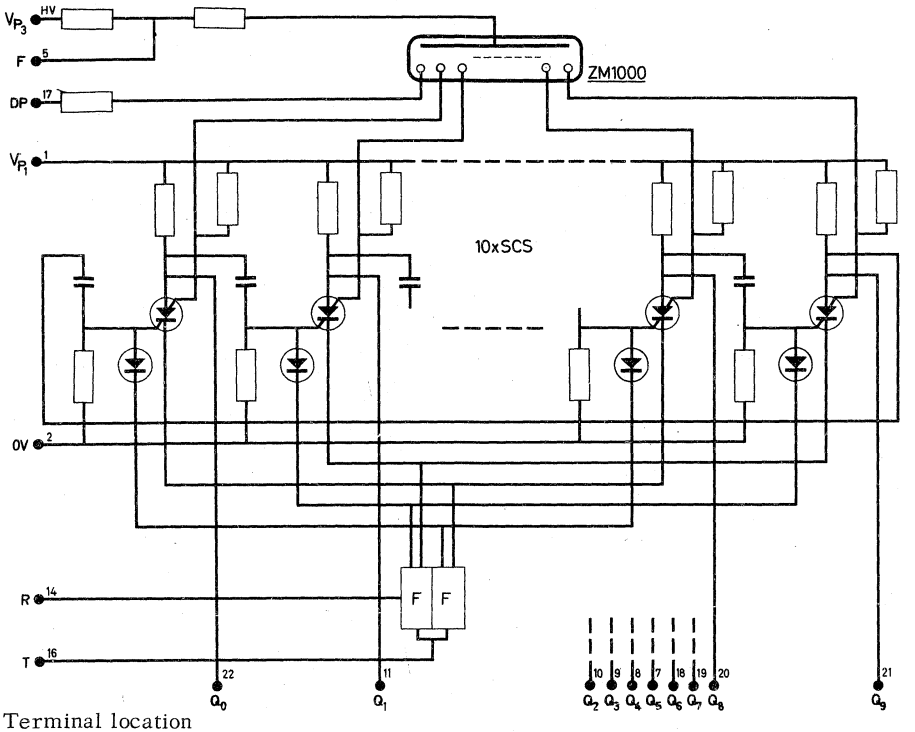
The NIC50 is a uni-directional decade counter coupled to the numerical indicator tube ZM1000, assembled in one plastic case. The ZM1000 is mounted at the front of the case, the input and output terminals are found at the rear.
Ten decimal outputs enable connection to other units for active counting operations. There is also a terminal for display of the decimal point in the ZM1000 at the left of any numeral.
Use is made of silicon controlled switches featuring a direct drive of the ZM1000.
Carry pulses to trigger a succeeding counter NIC50 are obtained from output Q_0 (terminal 22) at the nine to zero transition.
The trigger (counting) pulse and the reset pulse are delivered by the pulse shaper/reset unit PSR50.
Filtering of the high voltage from transients can be obtained by connecting a capacitor of approximately 0.1 μF between terminal F and the central earth point.



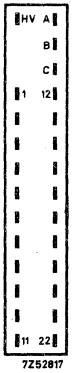
7Z52465

Drawing symbol

CIRCUIT DATA



Terminal location



HV = V_{p_3} = +250 V supply for numerical indicator tube
A = not provided
B = not provided
C = not provided
1 = V_{p_1} = +24 V supply
2 = 0 = common 0 V
3 = not provided
4 = not provided
5 = F = connection for filtering purposes
6 = not provided
7 = Q_5 = decimal output 5
8 = Q_4 = decimal output 4
9 = Q_3 = decimal output 3
10 = Q_2 = decimal output 2
11 = Q_1 = decimal output 1
12 = not provided
13 = not provided
14 = R = reset input
15 = not provided
16 = T = counting trigger input
17 = DP = input decimal point
18 = Q_6 = decimal output 6
19 = Q_7 = decimal output 7
20 = Q_8 = decimal output 8
21 = Q_9 = decimal output 9
22 = Q_0 = decimal output 0

Power supply	voltage	current
Tube supply	+250 V ± 18%	3 mA
Logic supply	+ 24 V ± 10%	12 mA

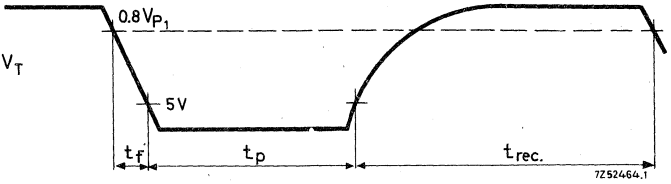
INPUT DATA

Trigger (counting) input T (terminal 16)

This input is to be driven by a negative going pulse, delivered by output Q_T of the unit PSR50, or by a preceding counter unit.

Voltage	V_T = from 0.8 V_{P_1} to 5 V
Required direct current	$-I_T$ = max. 1.5 mA (at V_T = 5 V)
Required transient charge when V_T changes from 0.8 V_{P_1} to 5 V in 1 μs	$-Q_T$ = max. 6.3 nC

Time data



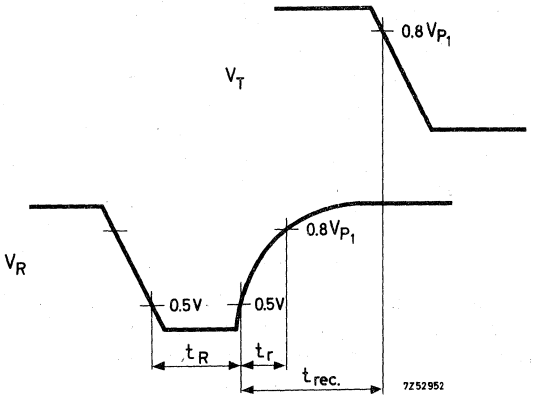
Fall time	t_f = max. 1 μs
Pulse duration	t_p = min. 4 μs
Recovery time	t_{rec} = max. 10 μs

Reset input R (terminal 14)

This input is to be driven by a LOW voltage level, delivered by output Q_R of the unit PSR50.

Required voltage	V_R = max. 0.5 V
Required direct current	I_R = max. 8.5 mA

Time data



Input pulse duration	t_R = min. 15 μs
Recovery time	t_{rec} = max. 50 μs
Trailing edge	t_r = max.1.2 μs

Decimal point input DP (terminal 17)

This input is to be driven by a LOW voltage level with the following requirements:

Decimal point ON

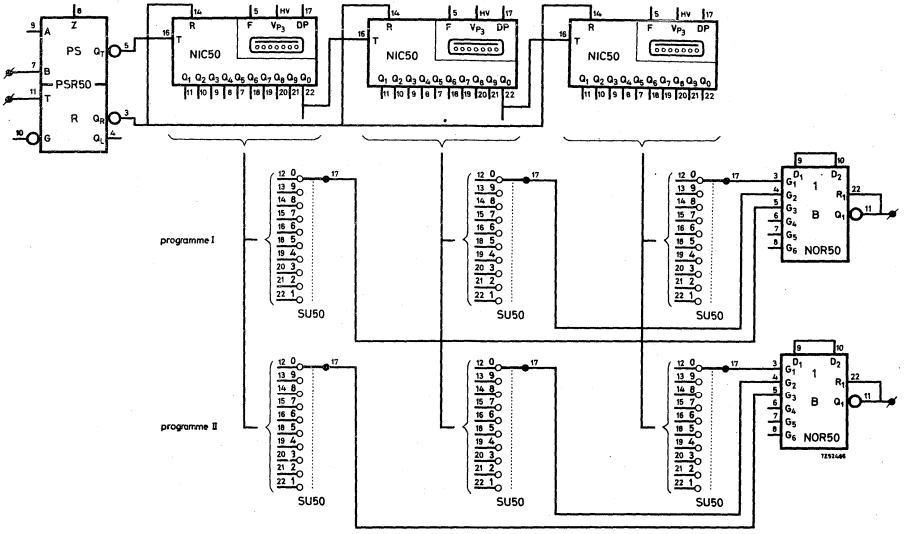
Voltage	V_{DP} = max. 0.5 V
Direct current	I_{DP} = 165 μA (typical)

Decimal point OFF

Voltage	V_{DP} = min. 50 V or terminal 17 floating

OUTPUT DATA

The digits 0-9 are available at the output terminals Q_0-Q_9.
These outputs are primarily intended to drive the buffer NOR in the unit 3.NOR50, in most cases via the 10 position preset switch SU50 as indicated below.



Each Q-output can be loaded with 6 buffer NOR's of the 3.NOR50 units simultaneously in excess of the carry pulse for the succeeding NIC50 counter. This means that 6 preset programmes can be applied as a maximum.

Output voltage LOW (SCS conducting)

Voltage	V_Q = max. 5 V
Available direct current	I_Q = max. 1.5 mA
Available transient charge when V_Q changes from 0.8 V_{P_1} to 5 V in 1 μs	Q_Q = max. 9.5 nC

Output voltage HIGH (SCS non conducting)

Voltage	V_Q = 0.8 V_{P_1} to V_{P_1}
Available direct current	$-I_Q$ = max. 0.32 mA

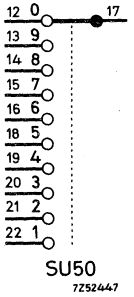
Wiring capacitance C_W = max. 200 pF

Time data

Delay between trigger input and positive going output t_{d_1} = max. 3 μs
Delay between trigger input and negative going output t_{d_2} = max. 4 μs

10 position preset switch

In the 50-Series for preset programmed counting, use is made of the 10 position thumbwheel switch SU50, which is identical to the existing type 10P1C, catalogue number 4311 027 82321.



Drawing symbol

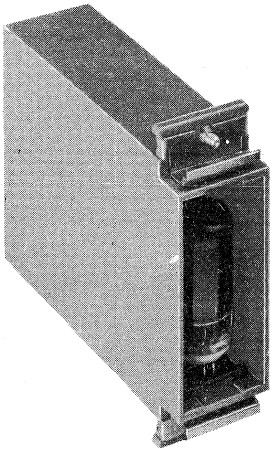
Terminal location

12 = input 0
13 = input 9
14 = input 8
15 = input 7
16 = input 6
17 = output (pole)
18 = input 5
19 = input 4
20 = input 3
21 = input 2
22 = input 1

The ten input terminals 0-9 have to be connected directly to the ten decimal output terminals Q_0-Q_9 of the decade counter NIC50.
The output terminal 17 has to be connected to one of the inputs of the buffer NOR in the unit 3.NOR50.

Note - For more specific data of the thumbwheel switch 10P1C, see data sheets of thumbwheel switches 4311 027 82...

REVERSIBLE INDICATOR COUNTER

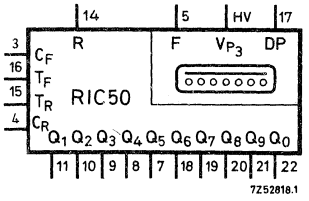


RZ 23932-3

Function	Bi-directional decade counter with direct numerical display for preset programmed control systems. Maximum counting rate: 12 kHz.

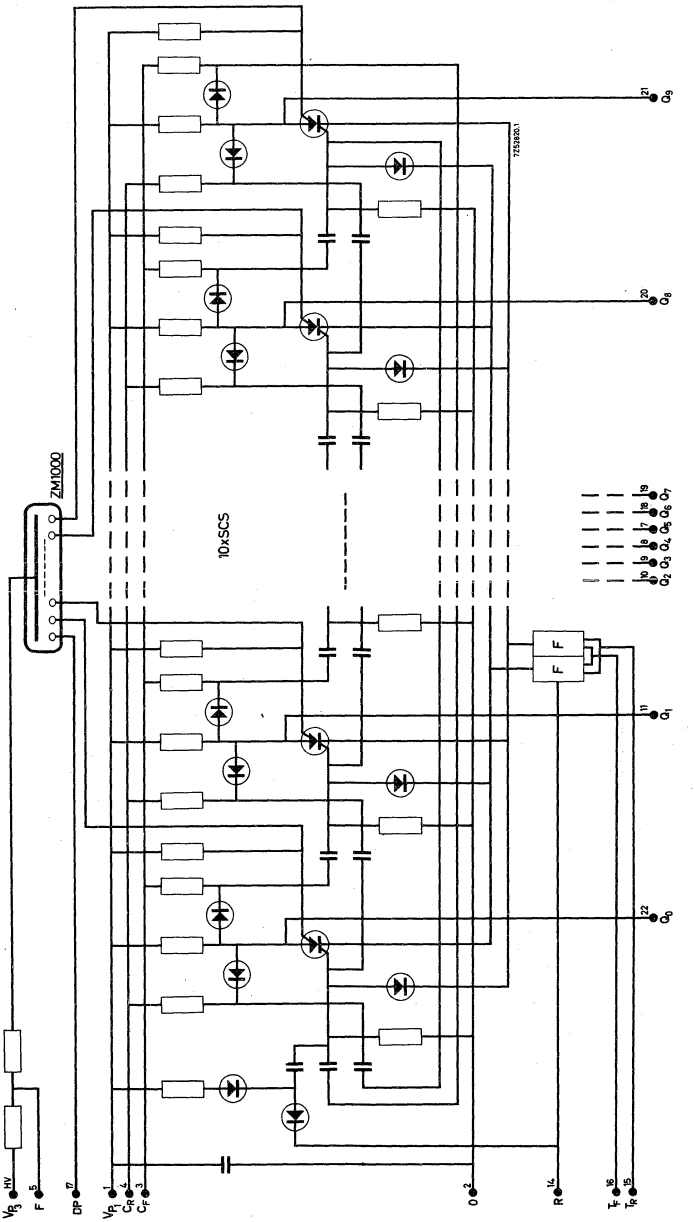
DESCRIPTION

The RIC50 is a bi-directional decade counter coupled to the numerical indicator tube ZM1000, assembled in one plastic case. The ZM1000 is mounted at the front of the case, the input and output terminals are found at the rear.
Ten decimal outputs enable connection to other units for active counting operations. There is also a terminal for display of the decimal point in the ZM1000 at the left of any numeral.
Use is made of silicon controlled switches featuring a direct drive of the ZM1000.
The trigger (counting) pulses and the reset pulse are delivered by the pulse shaper/reset unit PSR50.
Filtering of the high voltage from transients can be obtained by connecting a capacitor of approximately 0.1 μF between terminal F and the central earth point.

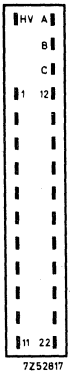


Drawing symbol

CIRCUIT DATA



Terminal location



HV = V_{p3} = +250 V supply for numerical indicator tube
A = not provided
B = not provided
C = not provided
1 = V_{p1} = +24 V supply
2 = 0 = common 0 V
3 = C_F = control forward direction
4 = C_R = control reverse direction
5 = F = connection for filtering purposes
6 = not provided
7 = Q_5 = decimal output 5
8 = Q_4 = decimal output 4
9 = Q_3 = decimal output 3
10 = Q_2 = decimal output 2
11 = Q_1 = decimal output 1
12 = not provided
13 = not provided
14 = R = reset input
15 = T_R = trigger input reverse counting
16 = T_F = trigger input forward counting
17 = DP = input decimal point
18 = Q_6 = decimal output 6
19 = Q_7 = decimal output 7
20 = Q_8 = decimal output 8
21 = Q_9 = decimal output 9
22 = Q_0 = decimal output 0

Power supply

	voltage	current
Tube supply	+250 V ± 18%	3 mA
Logic supply	+ 24 V ± 10%	23 mA

INPUT DATA

Counting conditions

The counting direction is determined by the voltage levels applied to C_F (terminal 3) and C_R (terminal 4).

Forward counting

V_{CF} = max. 1.6 V I_{CF} = max. 7.5 mA
V_{CR} = 0.95 V_{p1} to V_{p1}
} Each input to be driven by LRD50 or NOR unit

Counting pulse from PSR50 - Q_T to be applied to input T_F (terminal 16).

Reverse counting

V_{CR} = max. 1.6 V I_{CR} = max. 7.5 mA
V_{CF} = 0.95 V_{p1} to V_{p1}
} Each input to be driven by LRD50 or NOR unit

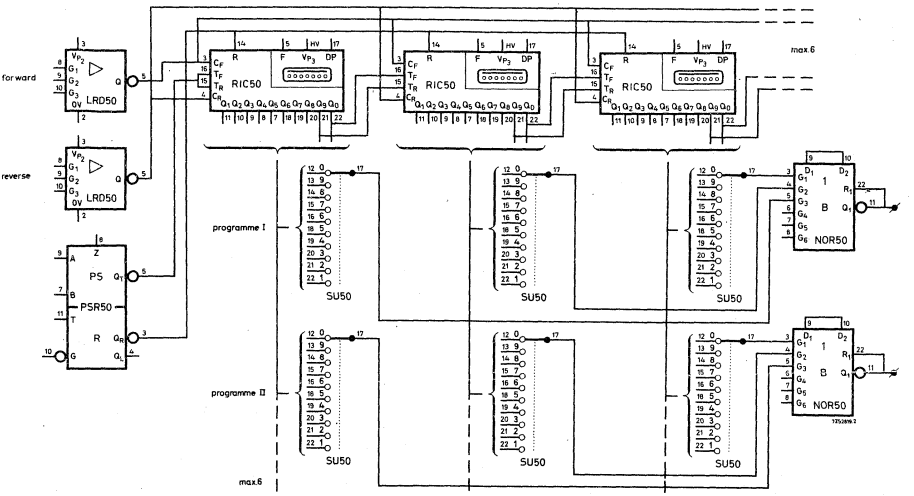
Counting pulse from PSR50 - Q_T to be applied to input T_R (terminal 15).

Note - When both control inputs C_F and C_R are HIGH the RIC50 is blocked for counting pulses.

When two units RIC50 are operating in series the following interconnections have to be made (see figure below).

For forward counting: Q_0 (terminal 22) of the preceding RIC50 has to be connected to T_F (terminal 16) of the succeeding RIC50.

For reverse counting: Q_9 (terminal 21) of the preceding RIC50 has to be connected to T_R (terminal 15) of the succeeding RIC50.



When the levels of the control voltages at C_F or C_R are changed a recovery time t_{rec} = min. 100 μs is to be observed.

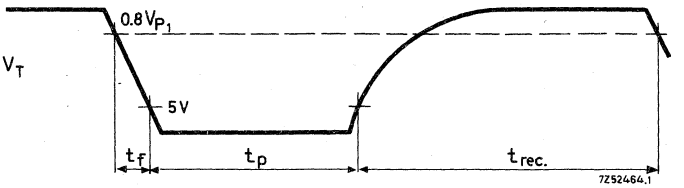
Trigger (counting) inputs T (terminals 16 and 15)

These inputs are to be driven by the negative going pulse, delivered by output Q_T of the unit PSR50 or by the corresponding output Q_0 (forward) or Q_9 (reverse) of the preceding counting decade RIC50.

Triggering edge	V_T = 0.8 V_{p_1} to 5 V
Required direct current	I_T = max. 1.5 mA (at V_T = 5 V)
Required transient charge when V_T changes from 0.8 V_{p_1} to 5 V in 1 μs	Q_T = max. 6.3 nC

When two trigger inputs are interconnected the above I_T and Q_T requirements have to be doubled.

Time data



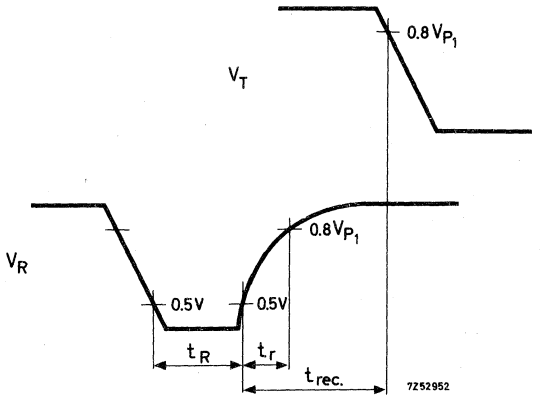
Fall time	t_f	= max. 1 μs
Pulse duration	t_p	= min. 4 μs
Recovery time	t_{rec}	= min. 15 μs
Time between two successive pulses		min. 85 μs

Reset input R (terminal 14)

This input is to be driven by a LOW voltage level, delivered by output Q_R of the unit PSR50.

Required voltage	V_R	= max. 0.5 V
Required direct current	I_R	= max. 8.5 mA

Time data



Pulse duration	t_R	= min. 15 μs
Recovery time	t_{rec}	= max. 80 μs
Trailing edge	t_r	= max. 1.2 μs

Decimal point input DP (terminal 17)

This input is to be driven by a LOW voltage level with the following requirements:

Decimal point ON

Voltage	V_{DP} = max. 0.5 V
Direct current	I_{DP} = 165 μA (typical)

Decimal point OFF

Voltage	V_{DP} = min. 50 V or terminal 17 floating

OUTPUT DATA

The digits 0-9 are available at the output terminals Q_0-Q_9.
These outputs are primarily intended to drive the buffer NOR in the unit 3.NOR50, in most cases via the 10 position preset switch SU50.
Each Q-output can be loaded with 6 buffer NOR's of the 3.NOR50 units simultaneously in excess of the carry pulses for the succeeding RIC50 counter. This means that 6 preset programmes can be applied as a maximum.

Output voltage LOW (SCS conducting)

Voltage	V_Q = max. 5 V
Available direct current	I_Q = max. 1.5 mA
Available transient charge when V_Q changes from 0.8 V_{p1} to 5 V in 1 μs	Q_Q = max. 9.5 nC

Output voltage HIGH (SCS non conducting)

Voltage	V_Q = 0.8 V_{p1} to V_{p1}
Available direct current	I_Q = max. 0.32 mA

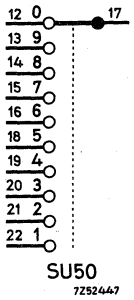
Wiring capacitance C_W = max. 200 pF

Time data

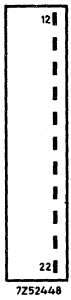
Delay between trigger input and positive going output t_{d1} = max. 3 μs.
Delay between trigger input and negative going output t_{d2} = max. 4 μs.

10 position preset switch

In the 50-Series for preset programmed counting, use is made of the 10 position thumbwheel switch SU50, which is identical to the existing type 10P1C, catalogue number 4311 027 82321.



Drawing symbol



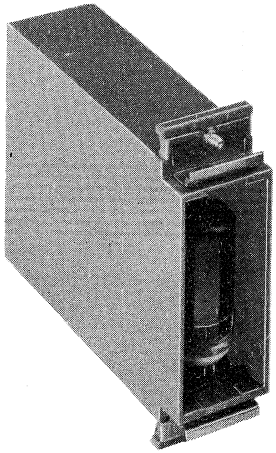
Terminal location

12 = input 0
13 = input 9
14 = input 8
15 = input 7
16 = input 6
17 = output (pole)
18 = input 5
19 = input 4
20 = input 3
21 = input 2
22 = input 1

The ten input terminals 0-9 have to be connected directly to the ten decimal output terminals Q_0-Q_9 of the reversible decade counters RIC50.
The output terminal 17 has to be connected to one of the inputs of the buffer NOR in the unit 3.NOR50.

Note - For more specific data of the thumbwheel switch 10P1C, see data sheets of thumbwheel switches 4311 027 82...

MEMORY INDICATOR DRIVER



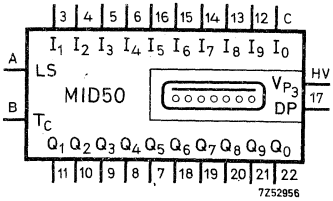
RZ 23932-3

Function

Integral buffer memory with direct numerical display for storage of information from decade counters NIC50 or RIC50.
Apart from numerical display, decimal output is available for e.g. printer drive.

DESCRIPTION

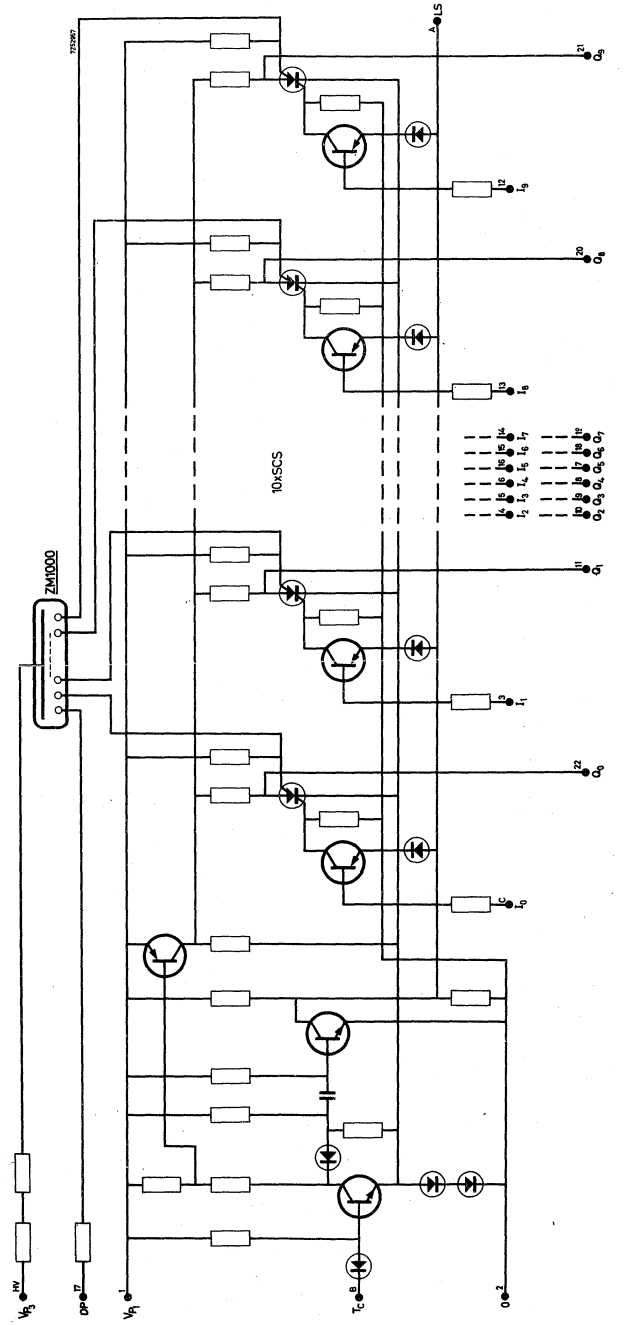
The MID50 is a buffer memory coupled to the numerical indicator tube ZM1000, assembled in one plastic case. The ZM1000 is mounted at the front of the case, the input and output terminals are found at the rear.
Use is made of silicon controlled switches featuring a direct drive of the ZM1000.
The ten decimal inputs (I_0-I_9) can be connected directly to the 10 corresponding outputs (Q_0-Q_9) of either the uni-directional decade counter NIC50 or the bi-directional decade counter RIC50, without influencing the output capability (fan out) of both types of counters.
By applying one single pulse to input T_C (terminal B) the decimal information is transferred from the decade counter into the buffer memory MID50 and remains there steadily displayed.
The MID50 is also provided with 10 decimal outputs for e.g. printer read-out *).
There is a terminal for display of the decimal point in the ZM1000 at the left of any numeral.



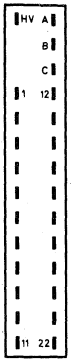
Drawing symbol

*) For this purpose printer drive units PDU50A and PDU50B are available.

CIRCUIT DATA



Terminal location



HV = V_{p_3} = +250 V supply for numerical indicator tube
A = LS = level shift facility
B = T_C = shift pulse input
C = I_0 = decimal input 0
1 = V_{p_1} = +24 V supply
2 = 0 = common 0 V
3 = I_1 = decimal input 1
4 = I_2 = decimal input 2
5 = I_3 = decimal input 3
6 = I_4 = decimal input 4
7 = Q_5 = decimal output 5
8 = Q_4 = decimal output 4
9 = Q_3 = decimal output 3
10 = Q_2 = decimal output 2
11 = Q_1 = decimal output 1
12 = I_9 = decimal input 9
13 = I_8 = decimal input 8
14 = I_7 = decimal input 7
15 = I_6 = decimal input 6
16 = I_5 = decimal input 5
17 = DP = input decimal point
18 = Q_6 = decimal output 6
19 = Q_7 = decimal output 7
20 = Q_8 = decimal output 8
21 = Q_9 = decimal output 9
22 = Q_0 = decimal output 0

Power supply

	voltage	current
Tube supply	+250 V ± 18%	3 mA
Logic supply	+ 24 V ± 10%	20 mA

INPUT DATA

Decimal inputs I_0-I_9

These inputs are to be fed by the decimal outputs Q_0-Q_9 of either the uni-directional decade counter NIC50 or the bi-directional decade counter RIC50.
One of the ten inputs must be fed with a LOW voltage level, the remaining nine inputs with a HIGH voltage level. By applying one transfer pulse to T_C (terminal B) that output Q becomes LOW of which the corresponding input I carries the LOW voltage, while simultaneously the corresponding figure of the indicator tube is lit. The other nine outputs of the MID50 will be HIGH. The decimal information of a NIC50 or RIC50 is transferred into the MID50 at the positive going edge of the transfer pulse

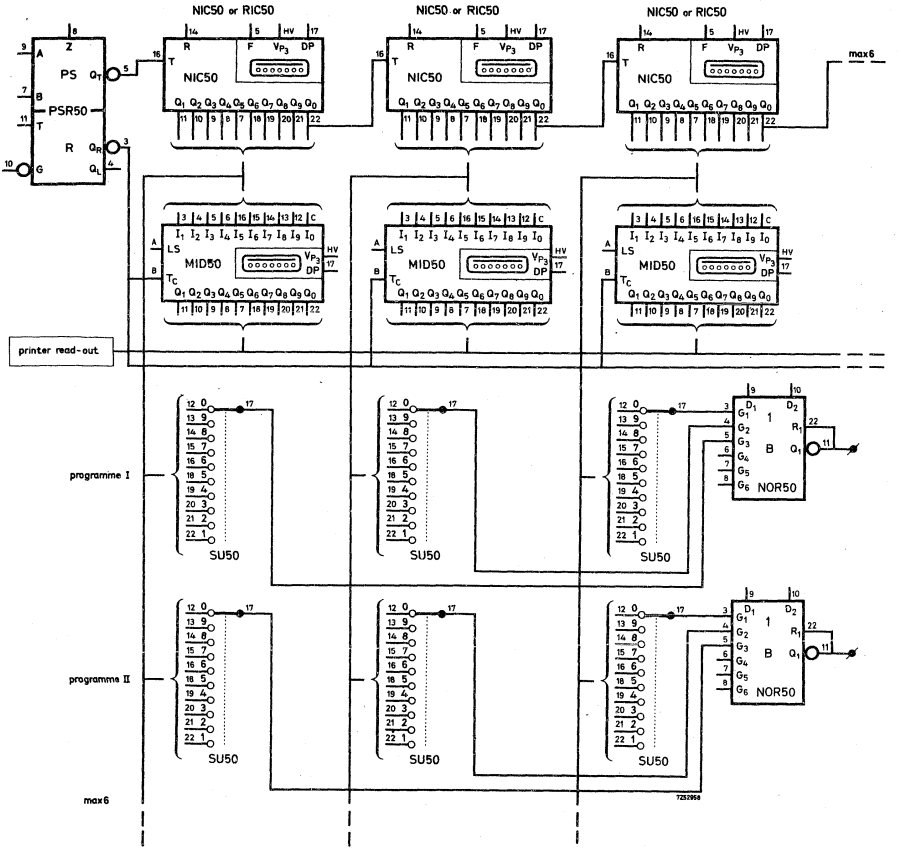
Voltage LOW

V_I = max. 5 V

I_I = max. 0.06 mA

Voltage HIGH

V_I = 0.8 V_{p_1} to V_{p_1}



Level shift input LS (terminal A)

By connecting a suitable zener diode between LS and 0 V and a resistor between LS and V_{P1}, the correct functional behaviour of the MID50 can be accomplished also when the inputs I_0-I_9 are fed with non-standard voltage levels (not derived from NIC50 or RIC50).

Transfer pulse input T_C (terminal B)

This input is driven by a pulse generated at output Q_R or Q_T of the unit PSR50. The transferring action takes place at the positive going edge. Maximum 6 inputs T_C can be driven simultaneously by output Q_R or Q_T of the PSR50.

Voltage LOW

V_B = max. 0.5 V

I_B = max. 0.5 mA

Voltage HIGH

V_B = 0.62 V_{p1} to V_{p1}

Decimal point input DP (terminal 17)

This input is to be driven by a LOW voltage level with the following requirements:

Decimal point ON

Voltage	V_{DP} = max. 0.5 V
Direct current	I_{DP} = 165 μA (typical)

Decimal point OFF

Voltage	V_{DP} = min. 50 V or terminal 17 floating

OUTPUT DATA

The digits 0-9 are available at the output terminals Q_0-Q_9. These outputs are primarily intended for either printer read-out purposes or shift register configurations.

Output voltage LOW (SCS conducting)

Voltage	V_Q = max. 3.5 V
Available direct current	I_Q = max. 0.2 mA *)

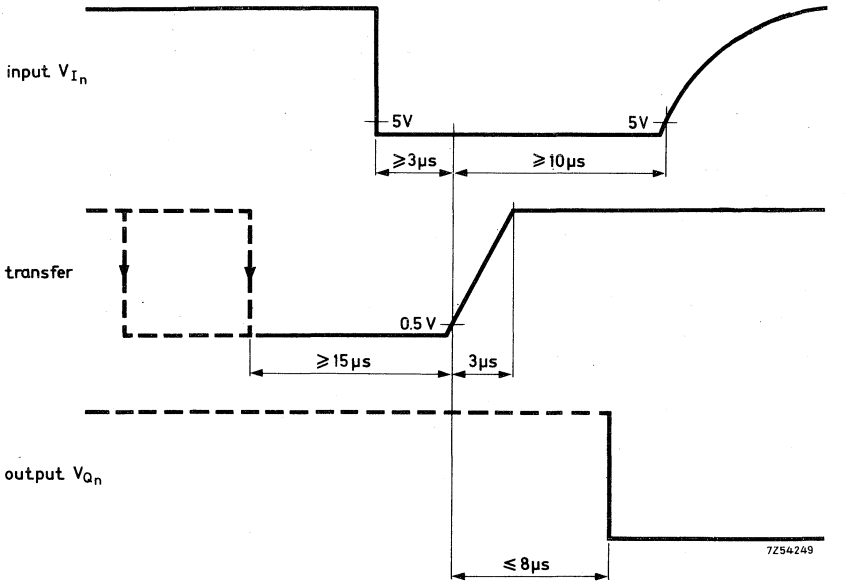
Output voltage HIGH (SCS non conducting)

Voltage	V_Q = 0.8 V_{p1} to V_{p1}
Available direct current	$-I_Q$ = max. 0.84 mA

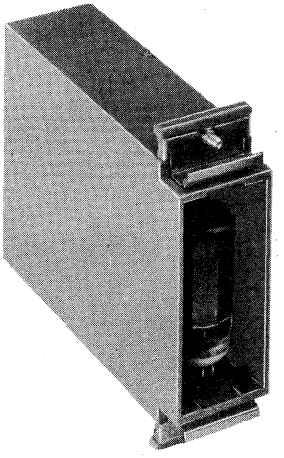
Wiring capacitance	C_W = max. 200 pF

*) The sum of the output currents I_{Q0}-I_{Q9} may not exceed 200 μA.

Time data


input V_{I_n}
5V
5V
≥3µs
≥10µs
transfer
0.5 V
≥15µs
3µs
output V_{Q_n}
≤8µs
7Z54249

SIGN INDICATOR DRIVER

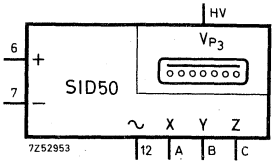


RZ 23932-3

Function	Driver of plus and minus character indicator tube. Characters ~, X, Y and Z are accessible

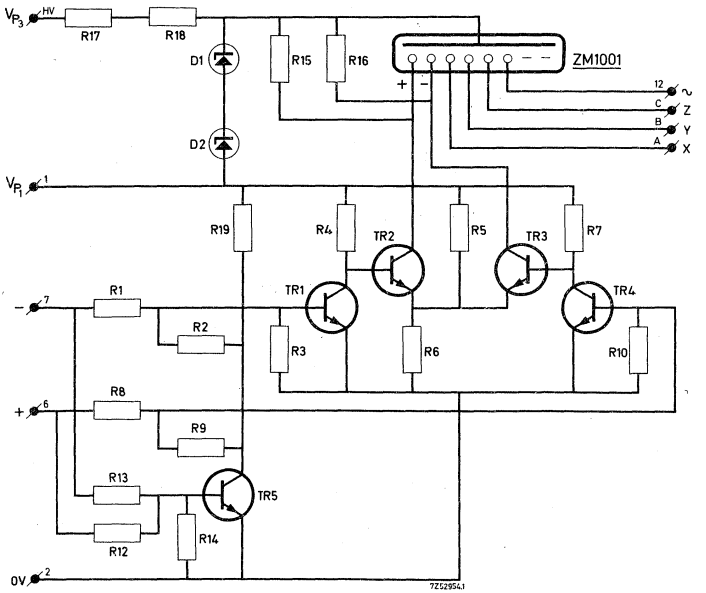
DESCRIPTION

The SID50 contains the plus and minus indicator tube ZM1001 and its driver stages in one plastic case. The ZM1001 is mounted at the front of the case, the connecting terminals are found at the rear.
A dark position of the ZM1001 can be obtained when both plus and minus inputs are driven by equal voltage levels.
The characters ~, X, Y and Z provided in the ZM1001 are also accessible.

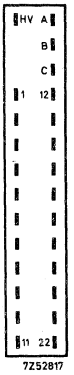


Drawing symbol

CIRCUIT DATA



Terminal location



HV =	V_{p3}	= +250 V supply for numerical indicator tube
A	= X	= X character
B	= Y	= Y character
C	= Z	= Z character
1	= V_{p1}	= +24 V supply
2	= 0	= common 0 V
3	= not provided	
4	= not provided	
5	= not provided	
6	= +	= input driving + character
7	= −	= input driving − character
8 to 11	= not provided	
12	= ~	= ~ character
13 to 22	= not provided	

Power supply

	voltage	current
Tube supply	+250 V ± 18%	2.8 mA
Logic supply	+ 24 V ± 10%	5.0 mA

INPUT DATA

Input terminals characters + and –

These inputs are to be driven by a HIGH voltage level to illuminate the corresponding character. A LOW level extinguishes the character.

HIGH voltage

V_+/V_- = 0.62 V_{p1} to V_{p1}

I_+/I_- = 0.17 mA (V = 13.4 V); EQUALS ONE D.U.*).

LOW voltage

V_+/V_- = max. 0.3 V

Characters ~, X, Y and Z

Visible : $V\sim/V_X/V_Y/V_Z$ = 0 to 10 V

Not visible: $V\sim/V_X/V_Y/V_Z$ = 60 to 120 V or floating

Dark : $V\sim/V_X/V_Y/V_Z$ = 80 to 120 V or floating

*) See also loading table.

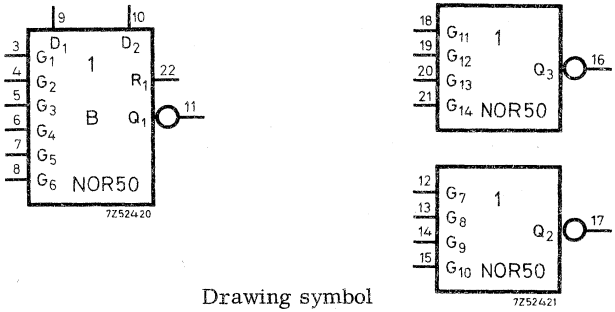
TRIPLE NOR GATE

Function

- 6 input buffer NOR for adapting the output levels of the NIC50 and the RIC50 to standard logic levels and
- dual 4 input NOR for logic purposes e.g. to form a memory function.

DESCRIPTION

The 3.NOR50 is intended to be used to memorize the count when the content of the unit(s) NIC50 or RIC50 corresponds with the preset position of the 10 position thumb-wheel switch SU50.



Drawing symbol

6 input buffer NOR

The 6 input buffer NOR is intended to adapt the output levels of the NIC50 or the RIC50 to the standard logic levels of the 4 input NOR's.
To this end each input of the 6 input buffer NOR is to be connected, directly or via the switch SU50, to one of the decimal outputs of the units NIC50 or RIC50.

Simplified truth table:

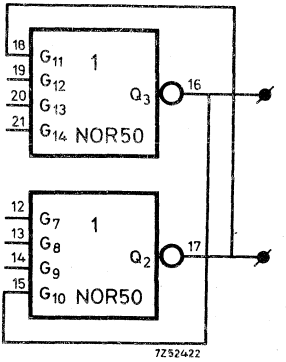
G_1	G_2	Q_1
H	H	L
L	H	L
H	L	L
L	L	H

All inputs (G_1 to G_6) must be LOW or floating for Q_1 is HIGH.

The 6 input buffer NOR can be provided with an intentional delay by interconnecting D_1 (terminal 9) and D2 (terminal 10) (see Time data). This intentional delay cancels hazardous (false) pulses that can occur during e.g. the transition from 499 to 500 at the transit counts 490 and 400, if preset programs have been set at these counts. The maximum delay can be decreased (the maximum counting rate increased) when an external capacitor is connected between D_1 and D_2.

Dual 4 input NOR

The 4 input NOR is intended for logic operations, such as memorizing the preset counts. To this end a memory function can be formed by cross connecting the two NOR's.

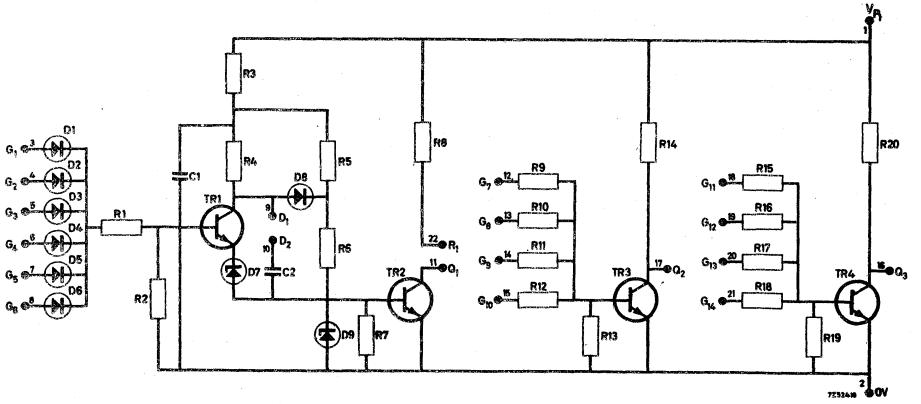


Simplified truth table:

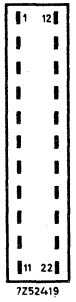
$G_7(G_{11})$	$G_8(G_{12})$	$Q_2(Q_3)$
H	H	L
H	L	L
L	H	L
L	L	H

All inputs G of a NOR must be LOW or floating for Q is HIGH.

CIRCUIT DATA



Terminal location



1 = V_{p_1}	= +24 V supply	12 = G_7	= input NOR2
2 = 0	= common 0 V	13 = G_8	= input NOR2
3 = G_1	= input buffer NOR1	14 = G_9	= input NOR2
4 = G_2	= input buffer NOR1	15 = G_{10}	= input NOR2
5 = G_3	= input buffer NOR1	16 = Q_3	= output NOR3
6 = G_4	= input buffer NOR1	17 = Q_2	= output NOR2
7 = G_5	= input buffer NOR1	18 = G_{11}	= input NOR3
8 = G_6	= input buffer NOR1	19 = G_{12}	= input NOR3
9 = D_1	= } when interconnected	20 = G_{13}	= input NOR3
10 = D_2	= } providing built-in delay	21 = G_{14}	= input NOR3
11 = Q_1	= output buffer NOR1	22 = R_1	= collector resistor buffer NOR1

Power supply

Voltage	V_{p_1} = 24 V ±10%
Current	I_{p_1} = 10.5 mA

INPUT DATA

6 input buffer NOR

Input HIGH: V_G = 0.8 V_{p_1} to V_{p_1}

I_G = 53 μA (V_G = 18.35 V)

Input LOW: V_G = 0 to 5.5 V

4 input NOR

Input HIGH: V_G = 0.62 V_{p_1} to V_{p_1}

I_G = 0.17 mA (V_G = 13.4 V); EQUALS ONE D.U.*)

Noise immunity: a voltage shift of 2 V on the minimum high level will not cause a change of the output voltage.

Input LOW: V_G = 0 to 0.3 V

Noise immunity: a voltage of +1 V with respect to the 0 V line applied to any one input (the other inputs at low level or floating) will not cause a change of the output voltage. The noise immunity can be increased by connecting unused inputs to 0 V.

*) See also loading table.

OUTPUT DATA

6 input buffer NOR

Output current: I_{Q_1} = 0.35 mA (V_{Q_1} = 13.4 V); EQUALS TWO D.U.*)

4 input NOR

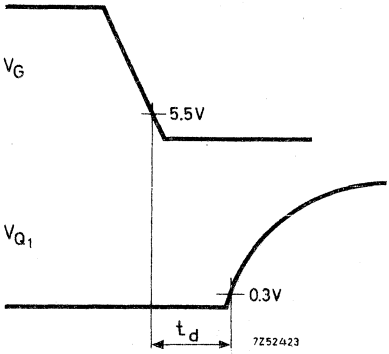
Output current: I_{Q_2/Q_3} = 1.02 mA (V_{Q_2/Q_3} = 13.4 V); EQUALS SIX D.U.*)

Time data

6 input buffer NOR

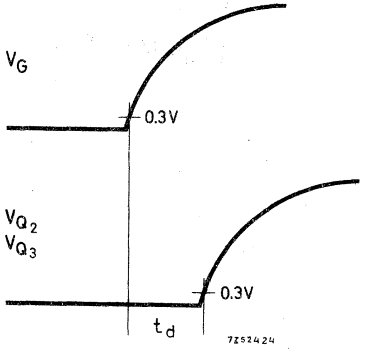
D_1 and D_2 interconnected: t_d = 7-18 μs

D_1 and D_2 not connected : t_d = 4 - 9 μs



4 input NOR

Delay, measured over two stages: t_d = max. 12 μs.
The delay is specified for C_w = 200 pF and worst input and output conditions.



*) See also loading table.

QUADRUPLE NOR GATE

Function

Quadruple 4 input NOR for logic operations e.g. to form memory functions.

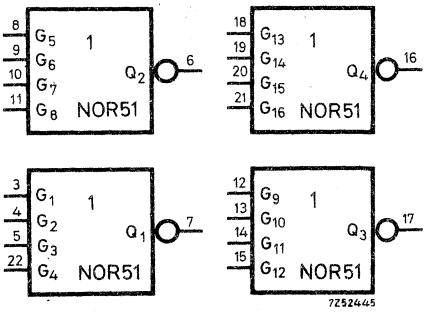
DESCRIPTION

The 4 input NOR is intended for logic operations. A memory function can be formed by cross connecting two NOR's.

Simplified truth table:

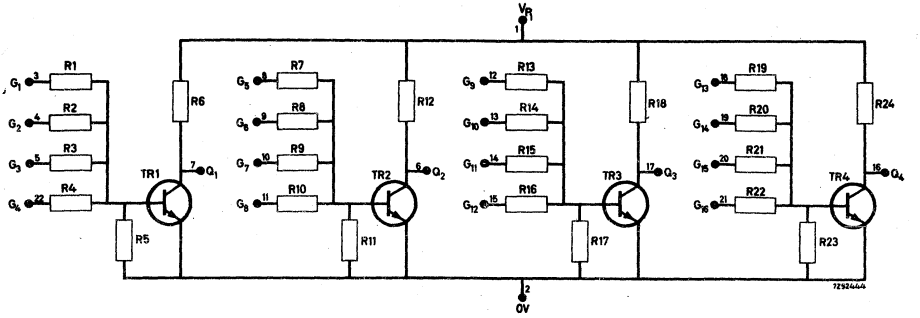
$G_1(G_5, G_9, G_{13})$	$G_2(G_6, G_{10}, G_{14})$	$Q_1(Q_2, Q_3, Q_4)$
H	H	L
H	L	L
L	H	L
L	L	H

All inputs G of a NOR must be LOW or floating for Q is HIGH.

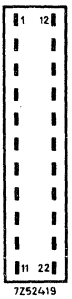


Drawing symbol

CIRCUIT DATA



Terminal location



1 = V_{p1}	= +24V supply	12 = G_9	= input NOR 3
2 = 0	= common 0 V	13 = G_{10}	= input NOR 3
3 = G_1	= input NOR 1	14 = G_{11}	= input NOR 3
4 = G_2	= input NOR 1	15 = G_{12}	= input NOR 3
5 = G_3	= input NOR 1	16 = Q_4	= output NOR 4
6 = Q_2	= output NOR 2	17 = Q_3	= output NOR 3
7 = Q_1	= output NOR 1	18 = G_{13}	= input NOR 4
8 = G_5	= input NOR 2	19 = G_{14}	= input NOR 4
9 = G_6	= input NOR 2	20 = G_{15}	= input NOR 4
10 = G_7	= input NOR 2	21 = G_{16}	= input NOR 4
11 = G_8	= input NOR 2	22 = G_4	= input NOR 1

Power supply

Voltage	V_{p1} = 24 V ± 10%
Current	I_{p1} = 8 mA

INPUT DATA

Input HIGH: V_G = 0.62 V_{p1} to V_{p1}

I_G = 0.17 mA (V_G = 13.4 V); EQUALS ONE D.U.*)

Noise immunity: a voltage shift of 2 V on the minimum high level will not cause a change of the output voltage.

Input LOW: V_G = 0 to 0.3 V

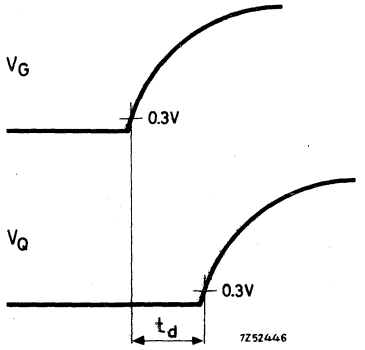
Noise immunity: a voltage of +1 V with respect to the 0 V line applied to any one G input (the other inputs at low level or floating) will not cause a change of the output voltage. The noise immunity can be increased by connecting unused inputs to 0 V.

OUTPUT DATA

Output current: I_Q = 1.02 mA (V_Q = 13.4 V); EQUALS SIX D.U.*)

Time data

Delay, measured over two stages: t_d = **max. 12 μs**
The delay is specified for Cw = 200 pF and worst input- and output conditions.



*) See also loading table.

PULSE SHAPER AND RESET UNIT

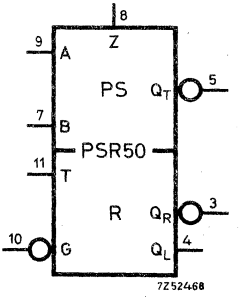
Function

Pulse shaper for converting input signals into counting pulses for the NIC50 and the RIC50, and

reset unit for generating pulses for resetting the NIC50 and the RIC50,
generating pulses for resetting memories formed by cross-connected 4 input NOR's,
generating transfer pulses for the MID50.

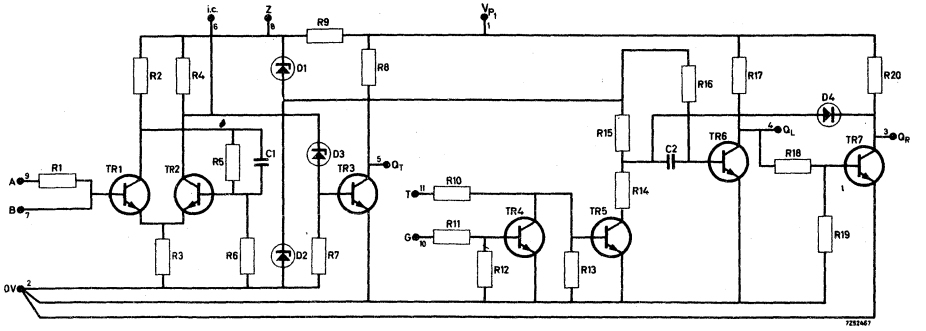
DESCRIPTION

The unit PSR50 contains a pulse shaper and a reset unit. The pulse shaper circuit consists of a Schmitt trigger followed by an inverting amplifier.
The circuit of the reset unit is a monostable multivibrator with one condition input and one trigger input.



Drawing symbol

CIRCUIT DIAGRAM



Terminal location

1 = V_{p1} = +24 V supply
2 = 0 = common 0 V
3 = Q_R = counter reset output
4 = Q_L = logic reset output
5 = Q_T = pulse shaper output
6 = internally connected
7 = B = direct base input pulse shaper
8 = Z = internally connected
9 = A = resistor input pulse shaper
10 = G = gate input reset unit
11 = T = trigger input reset unit
12 to 22 = not provided

Power supply

Voltage	V_{p1} = +24 V ± 10%
Current	I_{p1} = 23 mA nominal

PULSE SHAPER

A HIGH level at input B (terminal 7) produces a LOW level at output Q_T (terminal 5), a LOW level at input B produces a HIGH level at output Q_T.

The pulse shaper can be used as follows:

- as a pulse shaper driven by an external source (input transducers)
- as a pulse shaper driven by NOR's of the 50- or 60-Series
- in a relaxation oscillator circuit

INPUT DATA

Pulse shaper driven by an external source

The input voltage has to be applied to B (terminal 7).

HIGH level (operating)

Voltage	V_B = min. 4.0 V
Current	I_B = max. 0.06 mA

LOW level (operating)

Voltage	V_B = max. +1.36 V

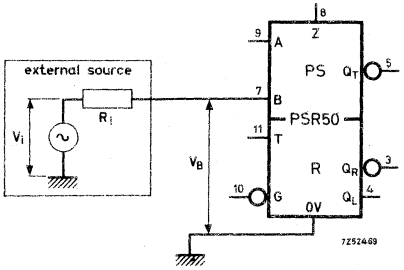
Limiting values

Voltage	V_B = max. +7.0 V min. −2 V
Current	I_B = max. 16 mA

Internal resistance of the driving external source

R_i = max. 33 kΩ

Hysteresis (difference between ON and OFF thresholds)



The hysteresis is affected by the R_i of the external source.
The relation is given by the following formula:

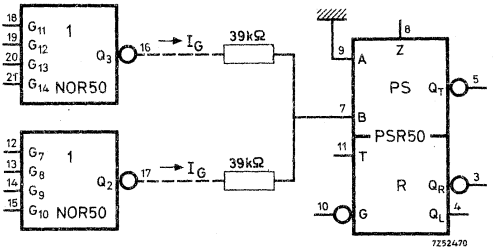
$$\Delta V_i = \text{min. } (1.5 - 0.0455\ R_i)\ V$$

$$\Delta V_B = \frac{\Delta V_i}{1 + 0.046\ R_i}\ V$$

R_i in kΩ and V in volt

Pulse shaper driven by a standard NOR

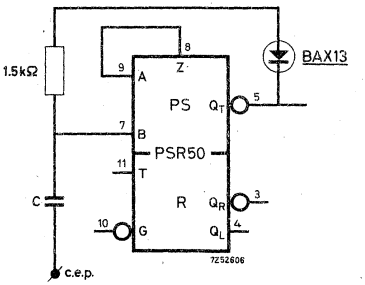
A (terminal 9) has to be connected to 0 (terminal 2).
The input voltage has to be applied to B (terminal 7), via a resistor of 39 kΩ (nominal).
I_G = max. 0.34 mA; EQUALS TWO D.U.*)



The maximum number of driving NOR's is two as shown in the diagram above.

Pulse shaper used in a relaxation oscillator circuit

For this application the connections must be made as shown in the circuitry below.



OUTPUT DATA

Available output suitable for driving three decade counters NIC50 or RIC50 simultaneously

Output voltage LOW

Voltage	V_{QT} = max. 0.5 V	
Direct current	I_{QT} = max. 25 mA max. 10 mA	(V_{QT} = 0.5 V) (V_{QT} = 0.3 V)
Transient charge	Q_{QT} = max. 30 nC	
Wiring capacitance at Q_T	C_W = max. 200 pF	

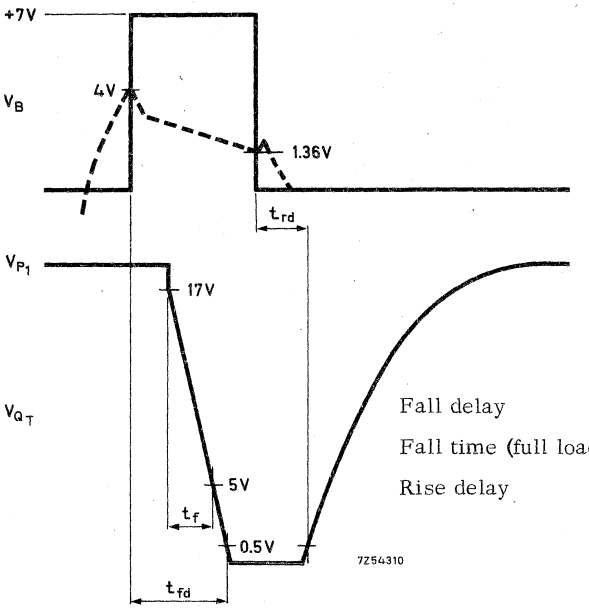
*) See also loading table.

Output voltage HIGH

Voltage	V_{QT} =	0.62 V_{P1} to V_{P1}
Direct current	$-I_{QT}$ =	max. 0.34 mA; EQUALS TWO D.U.*)

Wiring capacitance C_W = max. 200 pF

Time data (when the PSR50 is used in combination with 50-Series units)



Fall delay	t_{fd}	= max.	2 μs
Fall time (full load)	t_f	= max.	1 μs
Rise delay	t_{rd}	= max.	2 μs

RESET UNIT

Reset pulses are only generated when:

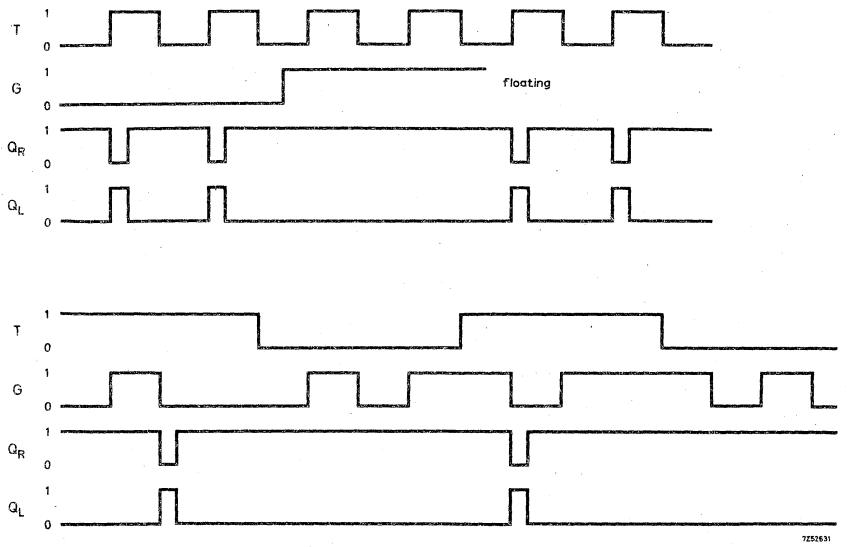
the HIGH level is applied to the trigger input T (terminal 11), and
the gate input G (terminal 10) is kept at the LOW level or left floating.

The unit generates two reset pulses simultaneously, namely:

from the logic reset output Q_L (terminal 4) for resetting d.c. memories built with NOR's
from the counter reset output Q_R (terminal 3) for resetting decade counters NIC50 and RIC50.

Note - A reset pulse is also generated when the G-input changes from the HIGH to the LOW level, whilst the T-input is at the HIGH level.

*) See also loading table.



INPUT DATA

Input HIGH

Voltage	$V_{T(G)}$ = 0.62 V_{P_1} to V_{P_1}
limiting value	$V_{T(G)}$ = +100 V
Current	$I_{T(G)}$ = 0.17 mA ($V_{T(G)}$ = 13.4 V); EQUALS ONE D.U.*)

Noise immunity: a voltage shift of 2 V on minimum HIGH level will not cause a change of the output voltage.

Input LOW

Voltage	$V_{T(G)}$ = max. 0.3 V
limiting value	$V_{T(G)}$ = −15 V

Noise immunity: a voltage of +1.25 V with respect to the 0 V terminal applied to either the T- or the G-input will not cause a change of the output voltage.

OUTPUT DATA

Output Q_L: capable of driving max. 4NOR's; EQUALS FOUR D.U.*)

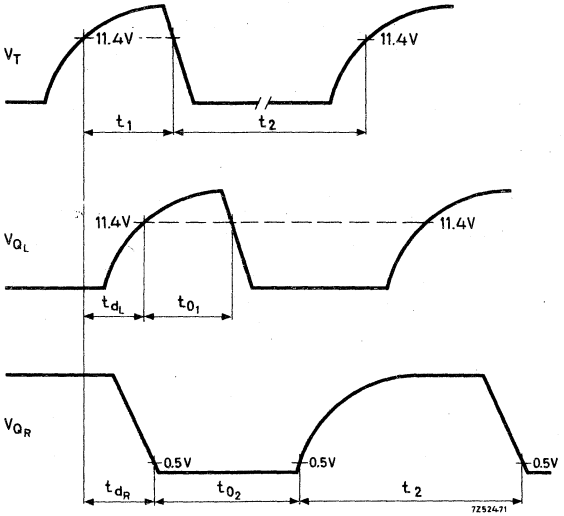
Voltage	V_{QL} = min. 0.53 V_{P_1}
Direct current	$-I_{QL}$ = max. 0.55 mA (V_{QL} = 11.4 V)

*) See also loading table.

Output Q_R: capable of driving the reset input of 6 decade counters NIC50 or RIC50 simultaneously

Voltage	V_{QR} = max. 0.5 V
Direct current	I_{QR} = max. 51 mA
Wiring capacitance	C_w = max. 200 pF at Q_R and Q_L

Time data



Input pulse duration	t_1	= min. 20 μs
Recovery time *)	t_2	= min. 20 μs
Output pulse duration	t_{0_1}	= min. 15 μs max. 45 μs
	t_{0_2}	= min. 15 μs max. 50 μs
Delay between V_T and V_{Q_L}	t_{d_L}	= max. 3 μs
Delay between V_T and V_{Q_R}	t_{d_R}	= max. 7 μs
Rise time at T	t_r	= max. 100 μs (between 0.5 V and 11.4 V)
Fall time at G	t_f	= max. 100 μs (between 11.4 V and 0.5 V)

*) The recovery time starts at the trailing edge of V_T when $t_1 > t_{0_2}$ or starts at the trailing edge of V_{Q_R} when $t_{0_2} > t_1$.

LAMP/RELAY DRIVER

Function — Low-power amplifier for driving lamps and relays

DESCRIPTION

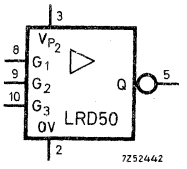
The circuit consists of an inverting amplifier preceded by a 3 input OR-gate.
The load has to be connected between output Q and the unstabilised +24 V supply voltage (abs. max. 30 V).
The load is energised when one or more inputs are HIGH (Q is LOW).
The output transistor is protected against voltage transients which occur when inductive loads are driven.

Simplified truth table:

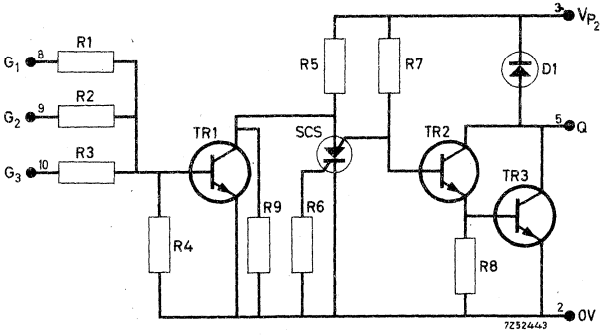
G_1	G_2	Q
H	H	L
H	L	L
L	H	L
L	L	H

All inputs G must be LOW or floating for Q is HIGH.

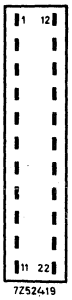
Drawing symbol



CIRCUIT DATA



Terminal location



1 = not provided
2 = 0 = common 0 V
3 = V_{p_2} = +24 V supply
4 = not provided
5 = Q = output
6 = not provided
7 = not provided
8 = G_1 = input
9 = G_2 = input
10 = G_3 = input
11 = not provided
12 to 22 = not provided

Power supply

Voltage	V_{p_2} = +24 V ±25%
Current	I_{p_2} = (4.4 + I_Q) mA

INPUT DATA

Output transistor ON

Input HIGH: : V_G = 0.62 V_{p_1} to V_{p_1}
I_G = max. 0.17 mA (V_G = 13.4 V); EQUALS ONE D.U.*)

Noise immunity: A voltage shift of 2 V on the minimum high level will not cause a change of the output voltage.

Output transistor OFF

Input LOW : V_G = max. 0.3 V

Noise immunity: A voltage of 1.25 V with respect to the 0 V line applied to any one input (other inputs at low level or floating) will not cause a change of the output voltage. The noise immunity can be increased by connecting unused inputs to 0 V.

OUTPUT DATA

Output transistor ON

I_Q = abs. max. 300 mA ($V_Q \leq$ 1.6 V)

Output transistor OFF

I_Q = max. 0.5 mA at V_Q = abs. max. 30 V.

*) See also loading table.

PRINTER DRIVE UNIT

Function — Intermediate stages to drive decimal input printers

DESCRIPTION

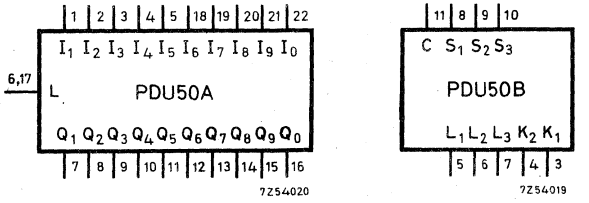
With the units PDU50A and PDU50B a complete printer drive circuit is formed. This circuit is intended to be used in combination with the NIC50, RIC50 or MID50 and a printer which requires decimal information at its inputs. A diagram for driving such a printer is given on the next page. One PDU50A unit, which contains ten inverter stages, must be used per decade.

The ten decimal inputs I_0 to I_9 can be connected directly to the ten corresponding outputs Q_0 to Q_9 of either the uni-directional decade counter NIC50 or the bi-directional decade counter RIC50 or the buffer memory MID50.

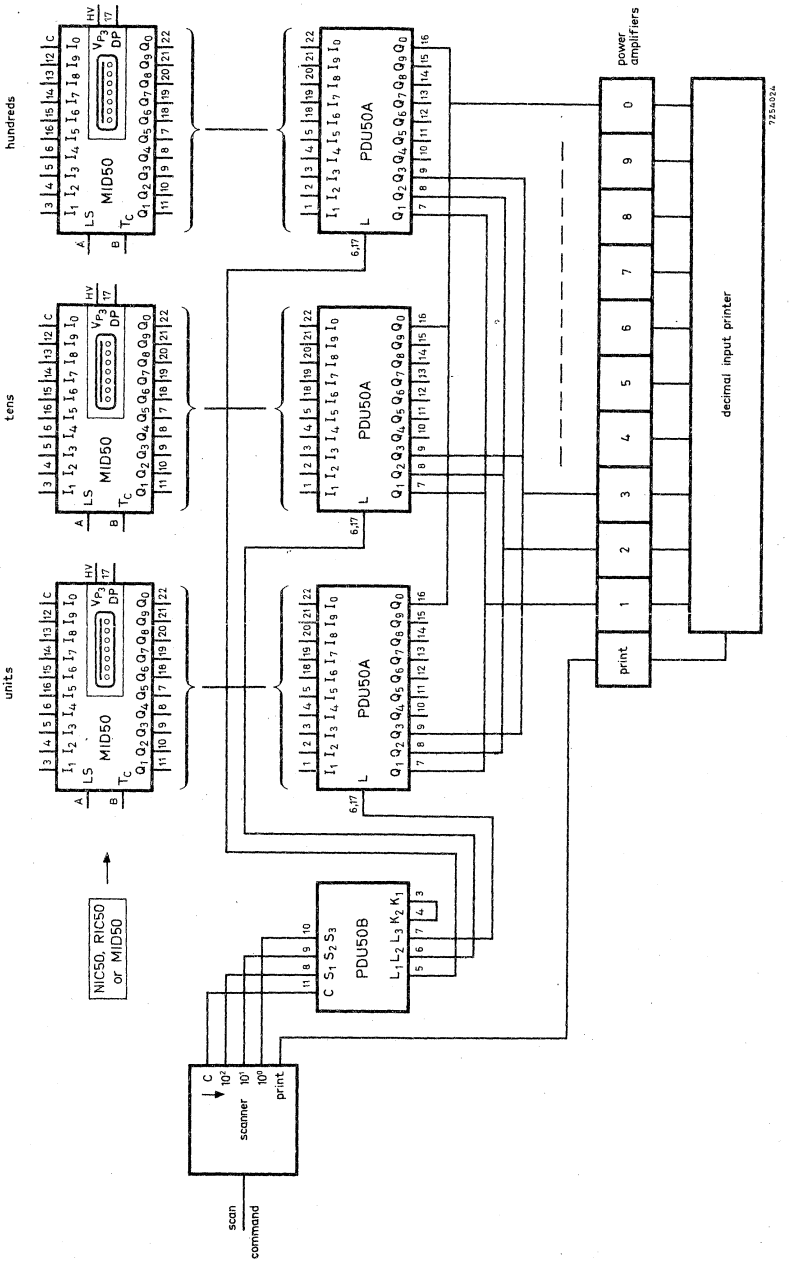
When a positive voltage is applied to control input L, that particular output Q will become HIGH, which has a LOW level at its input.

The PDU50B contains one clock control and three scan control circuits suitable to operate with a three decade counting system.

When simultaneously both the clock control input C and one of the scan control inputs S_1 to S_3 are at LOW level a positive voltage is available at the corresponding control output L_1 to L_3 of the PDU50B. Each control output of the PDU50B is connected to the control input L of the PDU50A.



Drawing symbols


hundreds
tens
units
MID50
PDU50A
PDU50B
NIC50, RIC50 or MID50
power amplifiers
decimal input printer
print
scanner
scan command
7250024

Summarising the functions of the PDU50A and PDU50B it becomes clear that a particular output Q of the PDU50A is at a HIGH level only, when the three following conditions are fulfilled:
- the corresponding input I of the PDU50A at a LOW level,
- the clock control input C of the PDU50B at a LOW level,
- the corresponding scan control input S_1 to S_3 of the PDU50B at a LOW level.

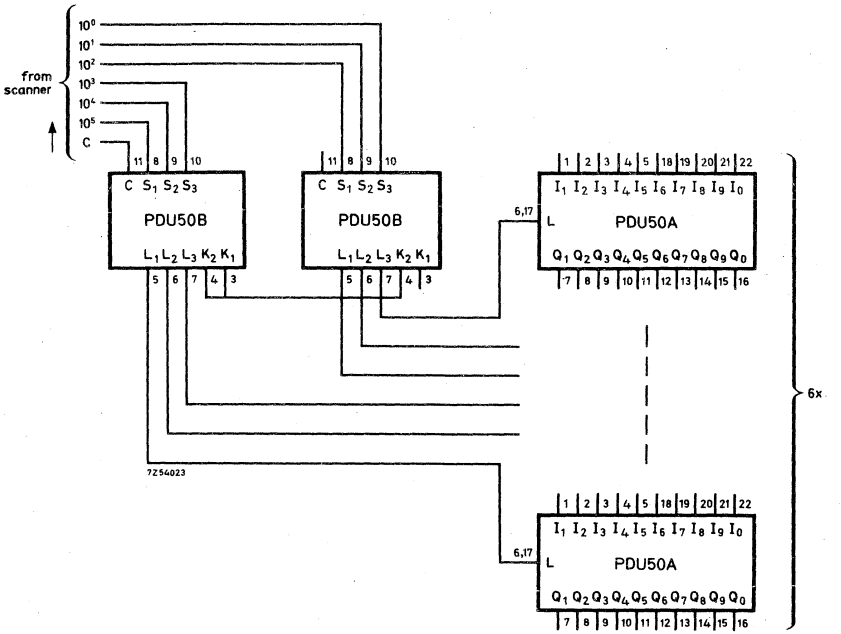
Note that only one output Q of the PDU50A is HIGH at a time as shown in the truth table below.

Truth table:

inputs			output
PDU50B		PDU50A	
C	S	I	Q
H	H	H	L
L	H	H	L
H	L	H	L
L	L	H	L
H	H	L	L
L	H	L	L
H	L	L	L
L	L	L	H

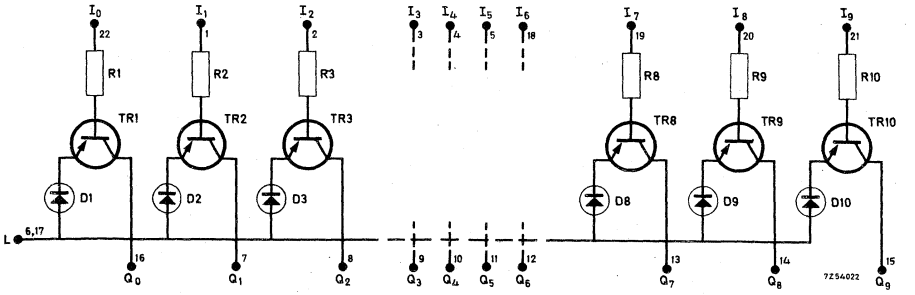
As the positive voltage derived from the PDU50B is fed to terminal L of only one PDU50A at a time it is permissible to common the corresponding outputs of all PDU50A units without any feedback consequences. These ten commoned PDU50A outputs are to be connected to ten power stages, of which the output power depends on the driving input requirements of the decimal input printers, e.g. the LRD50 supplies 300 mA/30V.

The description above holds for systems up to three decades, for which the terminals K_1 and K_2 of the PDU50B have to be interconnected.
When however more than three decades are required another PDU50B unit must be added to the system.
In this case terminals K_1 and K_2 need be interconnected for only one PDU50B.
For the other units PDU50B the terminals K_1 and K_2 are left open.
An interconnection diagram is given on the next page.

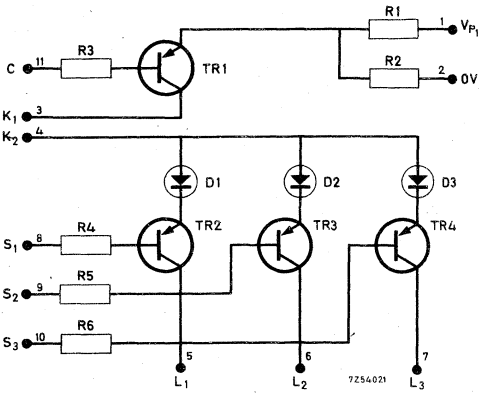


Note - When the input signal for the PDU50A is obtained from a MID50 unit either the clock pulse input C or all the scan inputs of the PDU50B must be at the HIGH level during the time the shift pulse input T_C of the MID50 is at the LOW level.

CIRCUIT DATA



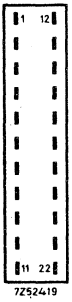
PDU50A



PDU50B

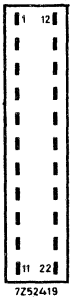
Terminal location

PDU50A



1 = I_1 = decimal input 1
2 = I_2 = decimal input 2
3 = I_3 = decimal input 3
4 = I_4 = decimal input 4
5 = I_5 = decimal input 5
6 = L = control input
7 = Q_1 = decimal output 1
8 = Q_2 = decimal output 2
9 = Q_3 = decimal output 3
10 = Q_4 = decimal output 4
11 = Q_5 = decimal output 5
12 = Q_6 = decimal output 6
13 = Q_7 = decimal output 7
14 = Q_8 = decimal output 8
15 = Q_9 = decimal output 9
16 = Q_0 = decimal output 0
17 = L = interconnected with 6
18 = I_6 = decimal input 6
19 = I_7 = decimal input 7
20 = I_8 = decimal input 8
21 = I_9 = decimal input 9
22 = I_0 = decimal input 0

PDU50B



1 = V_{p_1} = +24 V supply
2 = 0 = common 0 V
3 = K_1 = interconnecting point
4 = K_2 = interconnecting point
5 = L_1 = control output 1
6 = L_2 = control output 2
7 = L_3 = control output 3
8 = S_1 = scan control input 1
9 = S_2 = scan control input 2
10 = S_3 = scan control input 3
11 = C = clock control input
12 to 22 = not provided

Power supply PDU50B

Voltage V_{p_1} = 24 V ± 10%

Current I_{p_1} = 1 mA

INPUT DATA

PDU50A

Decimal inputs I_0 to I_9

These inputs are to be driven from decimal outputs Q_0 to Q_9 of either NIC50, RIC50 or MID50.
By applying a suitable, positive voltage to input L derived from output L_1, L_2 or L_3 of the PDU50B, that output Q becomes HIGH which has a LOW level at its input.

Voltage LOW:
V_I = max. 5 V
I_I = max. 35 μA

Voltage HIGH:
V_I = min. 0.8 V_{p_1}

PDU50B

Clock control input C (terminal 11)

Voltage LOW:
V_C = max. 5 V
I_C = max. 35 μA

Voltage HIGH:
V_C = min. 0.9 V_{p_1}

Scan control inputs S_1, S_2, S_3 (terminals 8, 9, 10)

Voltage LOW:
V_S = max. 5 V
I_S = max. 35 μA

Voltage HIGH:
V_S = min. 0.9 V_{p_1}

OUTPUT DATA

PDU50A

Output voltage LOW:
V_Q = max. 0.3 V

Output voltage HIGH:
I_Q = max. 0.34 mA (V_Q = 13.4 V); EQUALS TWO D.U.

PDU50B

Available output at the HIGH and LOW level (terminals L_1 to L_3) are adapted to the input requirements of the input terminal L of units PDU50A.

DECADE COUNTER AND DIVIDER

Function	Divider of 2, 3, 4, 5, 6, 8, 9, 10, 12 and 16
Ambient temperature range	
operating	−25 to +70 °C (at V_P = 24 V ±10%) −10 to +70 °C (at V_P = 24 V ±25%)
storage	−40 to +85 °C

DESCRIPTION

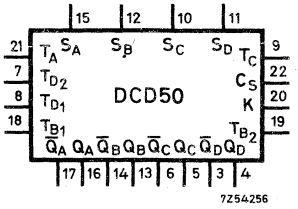
The DCD50 consists of four flip-flops. By correctly interconnecting the terminals a divider of 2, 3, 4, 5, 6, 8, 9, 10, 12 or 16 can be obtained. Each flip-flop is driven by a positive-going pulse. The flip-flops have one common reset input and four separate preset inputs, their condition being governed by a positive-going pulse applied to the appropriate terminal(s). When setting or presetting the DCD50 one sometimes has to apply a HIGH level signal to one of the trigger inputs of the second flip-flop (input K, via a diode).

Truth table (decade counter configuration):

	FF-A	FF-B	FF-C	FF-D
pulse	$\overline{Q_A}$	$\overline{Q_B}$	$\overline{Q_C}$	$\overline{Q_D}$
initial state	1	1	1	1
1	0	1	1	1
2	1	0	1	1
3	0	0	1	1
4	1	1	0	1
5	0	1	0	1
6	1	0	0	1
7	0	0	0	1
8	1	1	1	0
9	0	1	1	0

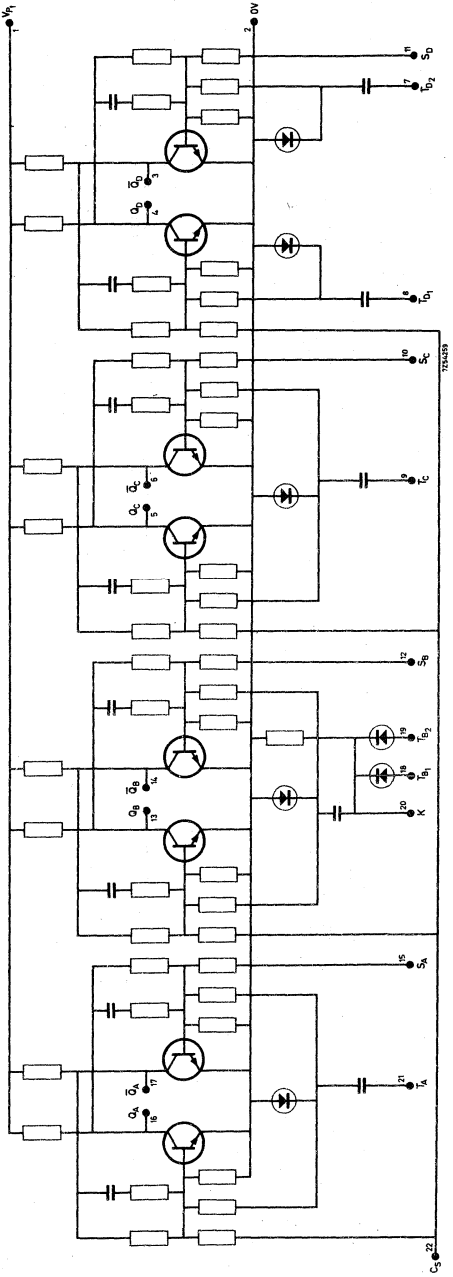
The table below shows the interconnections to be made externally for the various dividers:

divider	input	interconnection	output
2	8	7-8	$\overline{Q_D}$
	9	–	$\overline{Q_C}$
	18	–	$\overline{Q_B}$
	21	–	$\overline{Q_A}$
3	18	4-19, 7-14, 8-18	$\overline{Q_D}$
4	9	6-7-8	$\overline{Q_D}$
	21	17-18	$\overline{Q_B}$
5	18	4-19, 6-7, 8-18, 9-14	$\overline{Q_D}$
6	21	4-19, 7-14, 8-17-18	$\overline{Q_D}$
8	21	6-7-8, 9-17	$\overline{Q_D}$
9	18	4-19, 6-7, 8-18, 9-17, 14-21	$\overline{Q_D}$
10	21	4-19, 6-7, 8-17-18, 9-14	$\overline{Q_D}$
12	9	4-19, 6-21, 7-14, 8-17-18	$\overline{Q_D}$
16	21	6-7-8, 9-14, 17-18	$\overline{Q_D}$



Drawing symbol

CIRCUIT DIAGRAM



Terminal location

1 = V_{p_1} = +24 V supply
2 = 0 = common 0 V
3 = $\overline{Q_D}$ = output $\overline{Q}$ of flip-flop D
4 = Q_D = output Q of flip-flop D
5 = Q_C = output Q of flip-flop C
6 = $\overline{Q_C}$ = output $\overline{Q}$ of flip-flop C
7 = T_{D2} = trigger input T of flip-flop D
8 = T_{D1} = trigger input T of flip-flop D
9 = T_C = trigger input T of flip-flop C
10 = S_C = preset input of flip-flop C
11 = S_D = preset input of flip-flop D
12 = S_B = preset input of flip-flop B
13 = Q_B = output Q of flip-flop B
14 = $\overline{Q_B}$ = output $\overline{Q}$ of flip-flop B
15 = S_A = preset input of flip-flop A
16 = Q_A = output Q of flip-flop A
17 = $\overline{Q_A}$ = output $\overline{Q}$ of flip-flop A
18 = T_{B1} = trigger input T of flip-flop B
19 = T_{B2} = trigger input T of flip-flop B
20 = K = extender input of flip-flop B
21 = T_A = trigger input T of flip-flop A
22 = C_S = common reset input

Power supply

Voltage

V_{p_1} = +24 V ±10% (at T_{amb} = −25 to +70 °C)
V_{p_1} = +24 V ±25% (at T_{amb} = −10 to +70 °C)

Current

I_{p_1} = 25 mA nominal

INPUT DATA

Trigger inputs T_A, T_{B1}, T_{B2}, T_C, T_{D1} and T_{D2} (terminals 21, 18, 19, 9, 8 and 7)

The trigger inputs require a positive-going pulse.

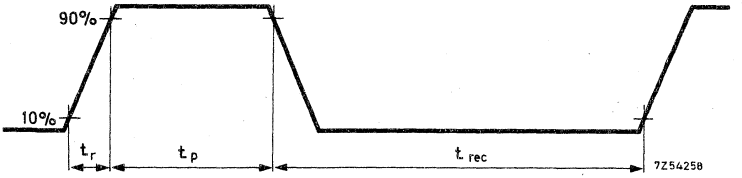
From another DCD50

	V_{p_1} = 24 V ±10%	V_{p_1} = 24 V ±25%
Triggering edge	from 0.3 V to 0.7 V_{p_1}	from 0.3 V to 0.8 V_{p_1}
Wiring capacitance C_w	C_w = max. 150 pF	

From a PSR50 (output Q_T) or from a NOR unit

	V_{p_1} = 24 V ±10%	V_{p_1} = 24 V ±25%
Triggering edge	from 0.3 V to 0.91 V_{p_1}	from 0.3 V to 0.83 V_{p_1}
Permissible load at output of driving unit	max. 1 D.U.	max. 2 D.U.
Wiring capacitance C_w	max. 150 pF	max. 50 pF

Time data



Fall time of negative-going input pulse to NOR-unit	t_f	= max.	2 μs
Rise time of input pulse to trigger input T of DCD50 from another unit than those mentioned above	t_r	= max.	1 μs
Pulse duration	t_p	= min.	4 μs
Recovery time for inputs T_A, T_C, T_{D1}, T_{D2}	t_{rec}	= min.	10 μs
	t_p+t_{rec}	= min.	30 μs
for inputs T_{B1}, T_{B2}	t_{rec}	= min.	80 μs, required at input: 1 D.U.
	t_{rec}	= min.	40 μs, with external resistor of 82 kΩ between K and 0; required at input: 2 D.U.
	t_{rec}	= min.	27.5 μs, with external resistor of 43 kΩ between K and 0; required at input: 3 D.U.
Noise margin	1.5 V		

Common reset input C_S (terminal 22) and preset inputs S_A, S_B, S_C and S_D (terminals 15, 12, 10 and 11)

Voltage LOW

V_S, V_{CS} = max. 0.3 V

Voltage HIGH

V_S, V_{CS} = min. 0.62 V_{P1}

I_S = min. 0.24 mA (V_S = 13.4 V); EQUALS 1.5 D.U.

I_{CS} = min. 0.96 mA (V_{CS} = 13.4 V); EQUALS 6 D.U.

Resetting

When a DCD50 is used as a divider of 3, 5 or 9 an inhibit pulse (HIGH level) must be applied to K (terminal 20) via a diode type BAX13 (cathode to K).

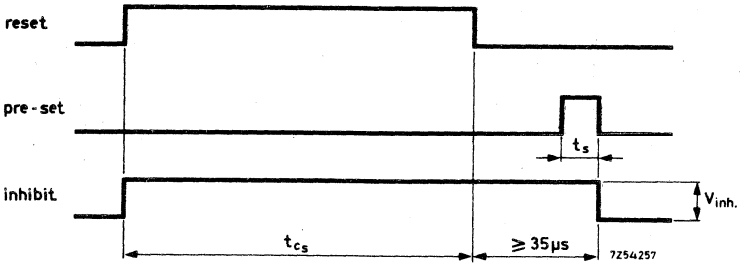
Presetting

When a DCD50 is used as a divider of 3, 5 or 9 and presetting via S_D (terminal 11) is required, an inhibit pulse must be applied to K (terminal 20) via a diode BAX13 (cathode to K).

When a DCD50 is used as divider of 6, 10 and 12 and presetting via S_A and S_D (terminals 15 and 11) is required, an inhibit pulse must be applied to K (terminal 20) via a diode BAX13 (cathode to K).

Time data

The reset pulse and the preset pulse must not be applied at the same time.



Reset pulse duration	t_{cs} = min. 20 µs per flip-flop
Preset pulse duration	t_s = min. 5 µs
Time delay between reset (preset) pulse and trigger input signal	t_{r-t} = min. 30 µs
Time delay between end of reset pulse and end of preset pulse	t_{r-p} = min. 35 µs

Inhibit pulse:

Voltage HIGH: $V_{inh} \geq V_{TB1\ (TB2)} - 1.5$ V

When inhibit pulses are applied the total reset time in a chain of dividers, built with the DCD50, can be reduced to t = (n + 1) 20 µs, where n = maximum number of flip-flops between two inhibited flip-flops.

OUTPUT DATA

The outputs of the four flip-flops are Q_A, $\overline{Q_A}$, Q_B, $\overline{Q_B}$, Q_C, $\overline{Q_C}$, Q_D and $\overline{Q_D}$.

Voltage LOW

V_Q = max. 0.3 V

Voltage HIGH

	V_{p1} = 24 V ± 10%	V_{p1} = 24 V ± 25%
Loadability	6 D.U.	4 D.U.

Loadability at V_{p1} = 24 V ± 10%

- Each output can be loaded with one trigger input of a NIC50.
- The outputs Q_A, Q_B, $\overline{Q_B}$, Q_C and $\overline{Q_C}$ can be loaded with 6 D.U. plus one trigger input of a next DCD50 (except T_{B_1}, and T_{B_2}) or with 4 D.U. plus one base input of a PSR50.
- For further output data and maximum pulse repetition frequency, see table on next page.

Wiring capacitance at each output: C_W = max. 150 pF

Note - For proper inhibiting of the trigger gate of the second flip-flop in the DCD50 the load at the inhibiting output must not exceed the load at the trigger input by more than 2 D.U.

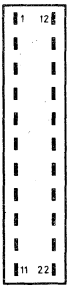
divider of	input		max. p.r.f. (kHz)			available output (D.U.)							
	terminal	required (D.U.)	without resistor *) **)	with 43 kΩ *) **)	with 82 kΩ *) **)	Q_A	$\overline{Q_A}$	Q_B	$\overline{Q_B}$	Q_C	$\overline{Q_C}$	Q_D	$\overline{Q_D}$
2	21	–	30			6	6						
	9	–	30							6	6		
	7-8	–	30									6	6
	18	3		30 18				6	6				
		2			22 12.5			6	6				
		1	12 6					6	6				
3	8-18	3		30 18				6	6			3	6
		2			22 12.5			6	6			4	6
		1	12 6					6	6			5	6
4	9	–	30							6	6	6	6
	21	–		30		6	3	6	6				
					24	6	4	6	6				
			12			6	5	6	6				
5	8-18	3		30 18				6	6	6	6	3	6
		2			22 12.5			6	6	6	6	4	6
		1	12 6					6	6	6	6	5	6
6	21	–		30		6	3	6	6			3	6
					24	6	4	6	6			4	6
			12			6	5	6	6			5	6
8	21	–	30			6	6			6	6	6	6
9	8-18	3		30 18		6	6	6	6	6	6	3	6
		2			22 12.5	6	6	6	6	6	6	4	6
		1	12 6			6	6	6	6	6	6	5	6
10	21	–		30		6	3	6	6	6	6	3	6
					24	6	4	6	6	6	6	4	6
			12			6	5	6	6	6	6	5	6
12	9	–			30	6	4	6	6	6	6	4	6
			24			6	5	6	6	6	6	5	6
16	21	–	30***)			6	6	6	6	6	6	6	5
				30		6	3	6	6	6	6	6	6
					24	6	4	6	6	6	6	6	6
			12			6	5	6	6	6	6	6	6

*) Input pulses according to "Time data".
**) Input pulses with $\frac{1}{2}$ T wave form.
***) Second flip-flop (B) is last in chain.

Preset switch

For decoding the DCD50 in preset programmed counting systems use has to be made of the decoding switch 1248N, catalogue number 4311 027 82221.

Note that:
- the outputs of the DCD50 have to be connected to the switch inputs as given below
- the internal resistance of the switch (terminal 12) has to be left floating.

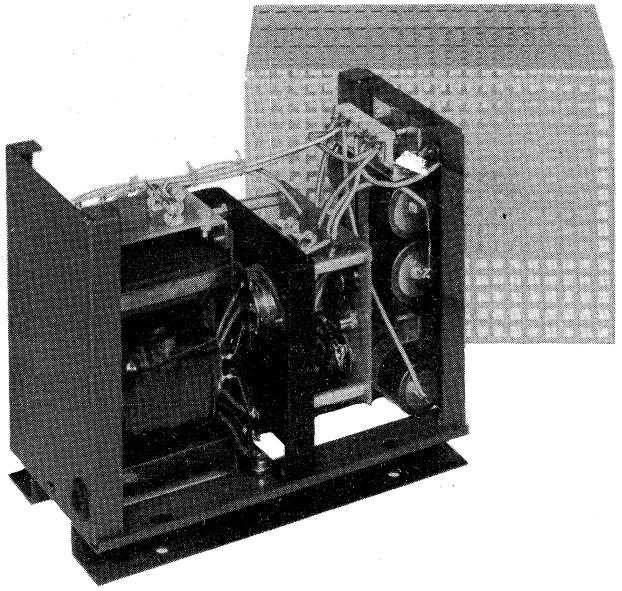


7Z52419

1 = not connected	12 = floating
2 = not connected	13 = not connected
3 = not connected	14 = not connected
4 = $\overline{Q_D}$	15 = $\overline{Q_A}$
5 = Q_D	16 = Q_A
6 = output (pole)	17 = output (pole)
7 = Q_B	18 = Q_C
8 = $\overline{Q_B}$	19 = $\overline{Q_C}$
9 = not connected	20 = not connected
10 = not connected	21 = not connected
11 = not connected	22 = not connected

Note - The output (pole) of the decoding switch may directly be connected to one of the inputs of a NOR in the 4.NOR51 unit.

POWER SUPPLY UNIT
for 50-Series direct display counters



RZ 24599-2

TECHNICAL PERFORMANCE

Operating ambient temperature range	−25 to +65 °C

The unit is provided with a temperature fuse (F1).

Input data

Input voltage	110, 120, 130, 220, 230, 240 V_{ac}, +10%, −15%
Input frequency	45 to 65 Hz

Output data

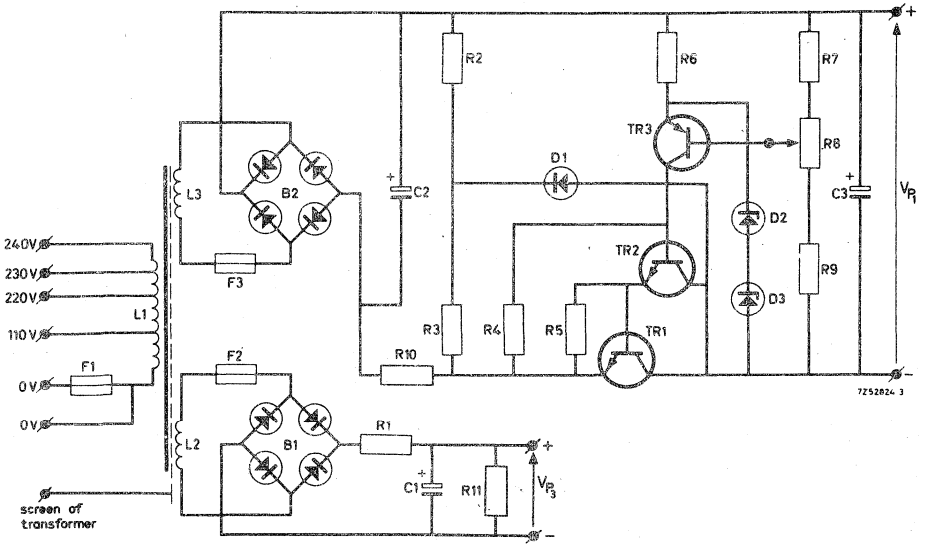
Logic supply (V_{P1})

Output voltage	+24 V ± 5%
Output current	0 to 250 mA
Internal resistance	0.5 Ω
Ripple voltage	10 mV_{rms}
Temperature coefficient	1 mV/deg C (typical value)
Fusing	easy replaceable fuse (630 mA slow, F3)

Provided with automatic short-circuit protection

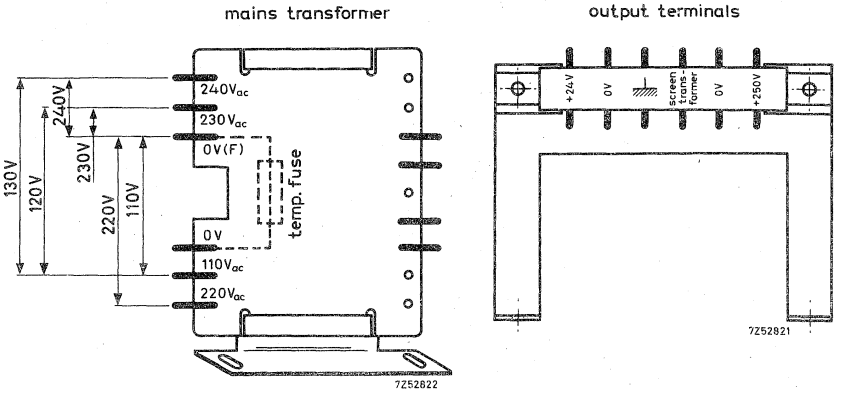
Numerical indicator tube supply (V_{P3})

Output voltage	+250 V ± 18%
Output current	max. 40 mA
Fusing	easy replaceable fuse (100 mA slow, F2)



Circuit diagram

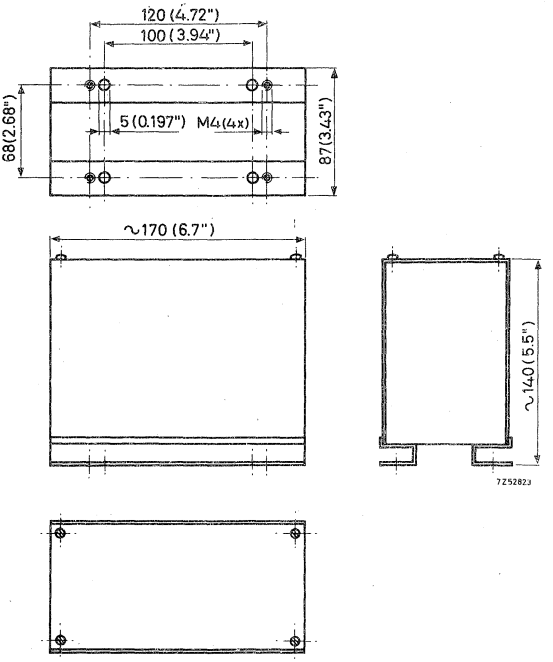
Terminal location



Note - Both input and output terminals are suitable for direct soldered connections.

MECHANICAL DATA

Housing	steel
Cover	perforated steel



Dimensions in mm, inch values between brackets

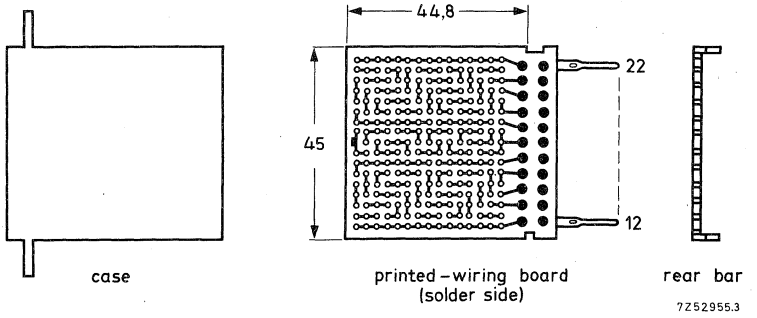
EMPTY CASE ASSEMBLY

Function

Empty case assembly for non-standard circuits

DESCRIPTION

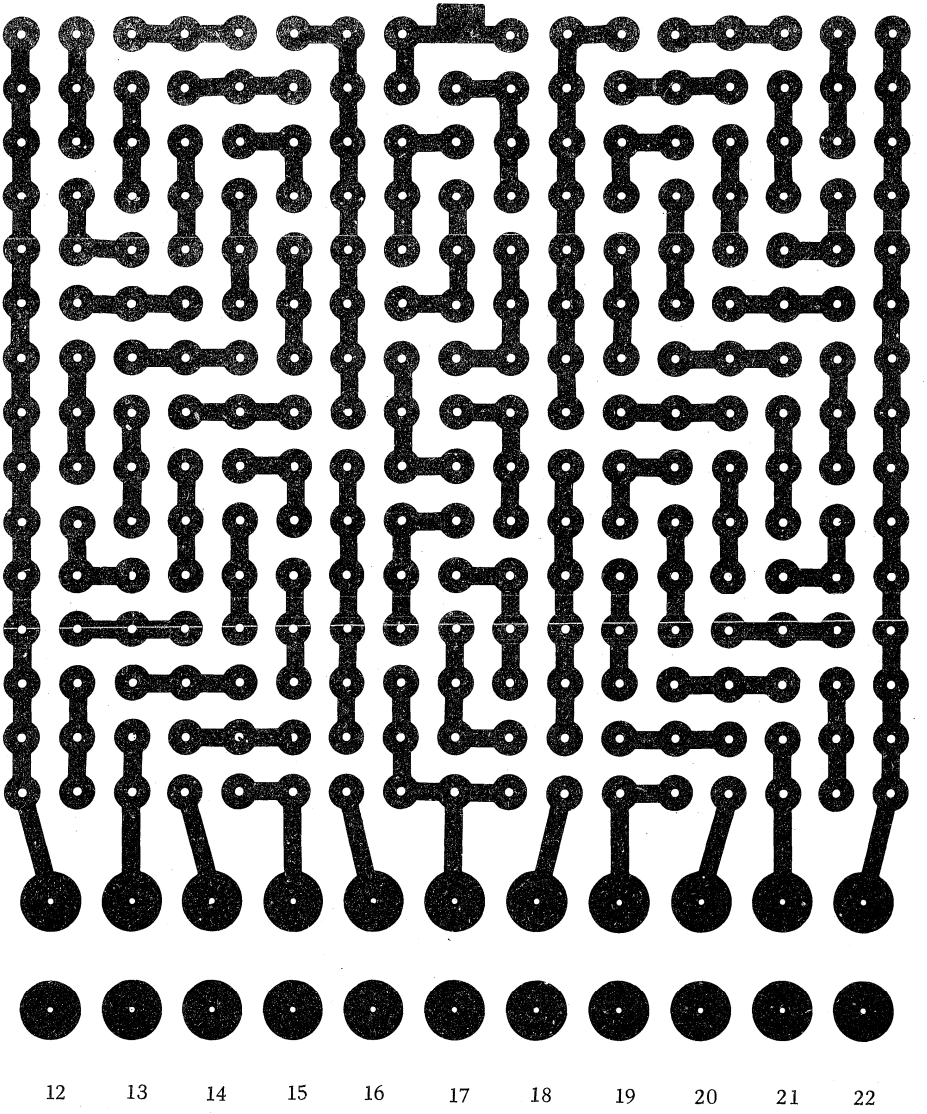
For non-standard circuit configurations an empty case assembly comprising a plastic case, a general purpose printed-wiring board and a rear bar is available in the 50-Series.
With these items non-standard circuits can be built in a technology similar to that of all auxiliary modules in the range.



Dimensions in mm

Printed-wiring board	
material	glass-epoxy with 254 plated-through holes
hole diameter	$0,8\ ^{+0,2}_{-0,05}$ mm
grid pitch	2,54 mm (0, 1 inch)
contacts	11; similar to those of all other 50-Series modules

Note: On the next page the layout of the printed wiring (solder side) is shown on a scale 3:1, which can be used as an aid for the designer.



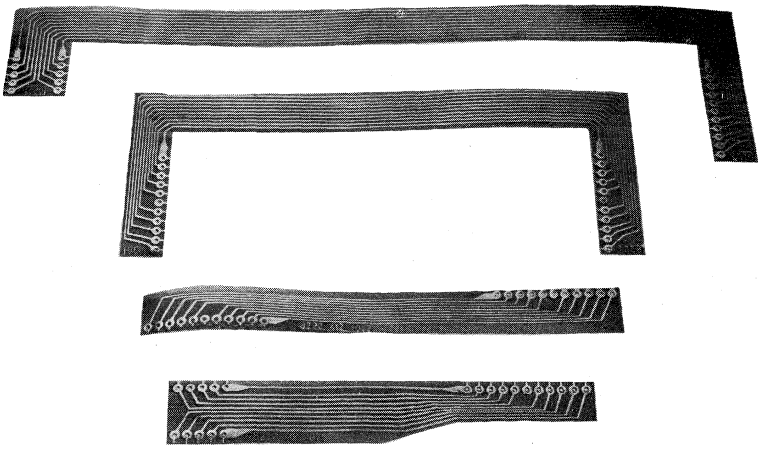
Layout of printed wiring (solder side); scale 3 : 1

Accessories for counter modules 50-Series

MOUNTING ACCESSORIES

For mounting accessories the sections "INTRODUCTION" and "CONSTRUCTION" of 50-Series, General should be consulted.

FLEXIBLE PRINTED WIRING



RZ 28179-3

The use of flexible printed wiring considerably shortens the time required to wire the modules, while allowing a neat and simple construction. Four types are available:

- Type HCS50, catalogue number 8222 412 10291, for interconnecting the ten output terminals of counters NIC50 or RIC50 to the corresponding terminals of the thumbwheel switches, when the modules are mounted on a horizontal axis
- Type HSS50, catalogue number 8222 412 10301, for interconnection between thumbwheel switches mounted on a horizontal axis
- Type VCS50, catalogue number 8222 412 10310 for interconnecting counters NIC50 and RIC50 and the thumbwheel switches, when these modules are mounted on a vertical axis
- Type VSS50, catalogue number 8222 412 10320 for interconnection between thumbwheel switches mounted on a vertical axis.

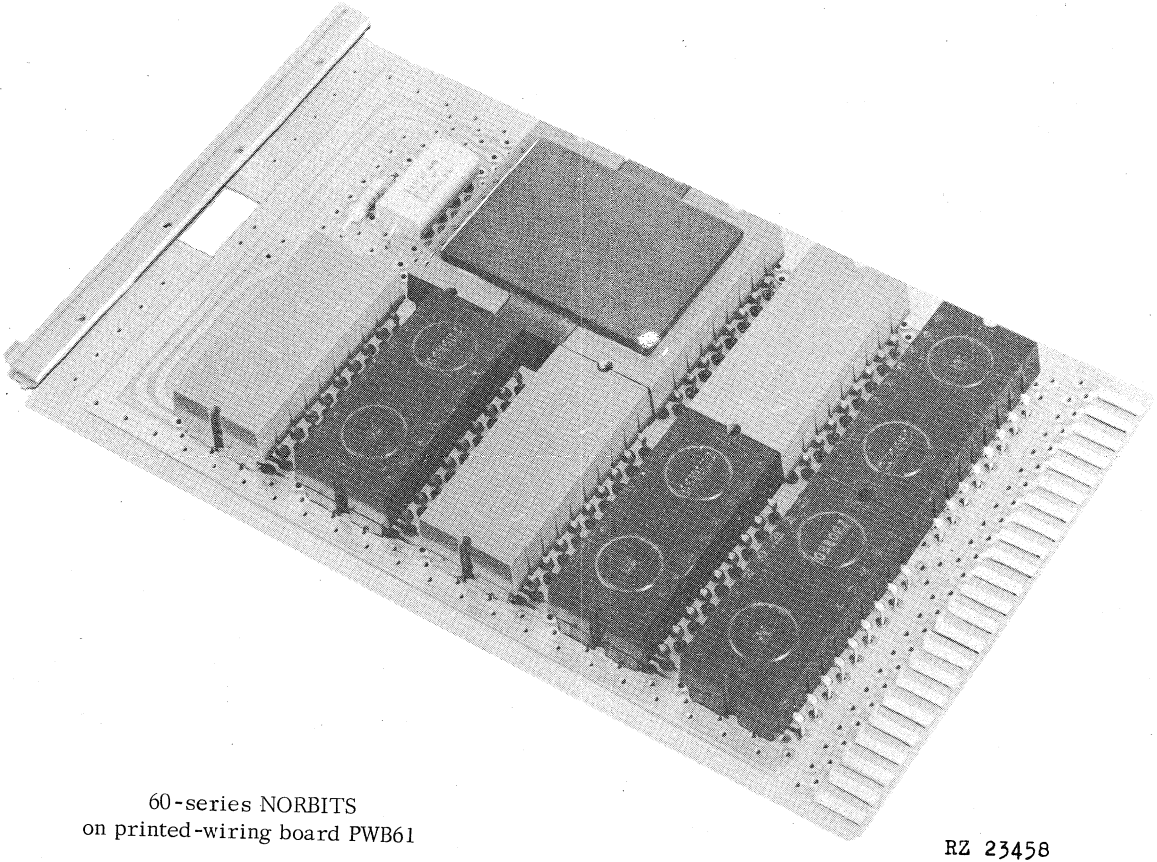
More complex installations, with combinations of vertical and horizontal mounting can be covered with the above four types of flexible printed wiring.

STICKERS

Stickers are drawing symbols of 50-Series modules printed on self-adhesive, transparent material. They can be used for fast preparation of system drawings.
The stickers are available in sheets. Each sticker can be separately detached from the sheet, without cutting.

sheet with modules of type	catalogue number for 50 sheets
NIC50 (4x) + SU50 (8x)	4322 026 70260
LRD50 (3x) + PSR50 (2x) + 3.NOR50 (3x) + 4.NOR51 (2x)	70270
RIC50 (4x) + SU50 (8x)	70430
MID50 (8x) + SID50 (4x)	70440
PDU50A (9x) + PDU50B (3x)	71910
DCD50	71920

NORbits 60-Series, 61-Series



60-series NORBITS
on printed-wiring board PWB61

RZ 23458

May 1969

60-Series NORbits

INTRODUCTION

The 60-Series, which uses NOR logic as a basis of operation, represents an important advance in static switching devices for industrial control systems. It comprises 7 circuit blocks having the following features in common:

- Single rail 24 V ± 25% supply, allowing the use of an inexpensive power supply - which helps to keep the cost down, particularly in small systems.
- Transfer moulded cases, giving optimum protection.
- Rigid terminals spaced at 0,2 in. pitch, permitting a variety of interconnection methods to be used (dip soldering, hand soldering, miniwire wrapping).
- Exceptionally good noise immunity.
- Easy to understand level logic, making it possible to carry out system tests with only a d.c. voltmeter.
- Silicon semiconductors throughout, ensuring reliable operation down to -10 °C and up to +70 °C.
- Low price.

Compatible input and output devices as well as a full range of mounting accessories are available.

The 60-Series comprises the following types:

2.NOR 60	Dual 4-input NOR gate
4.NOR 60	Quadruple 2x2 + 2x3 input NOR gate
2.IA 60	Dual Inverter Amplifier
2.LPA 60	Dual Low Power Amplifier
TU 60	Timer Unit
2.SF 60	Dual input Switch Filter
HPA60	High Power Amplifier
GLD60	Grounded Load Driver

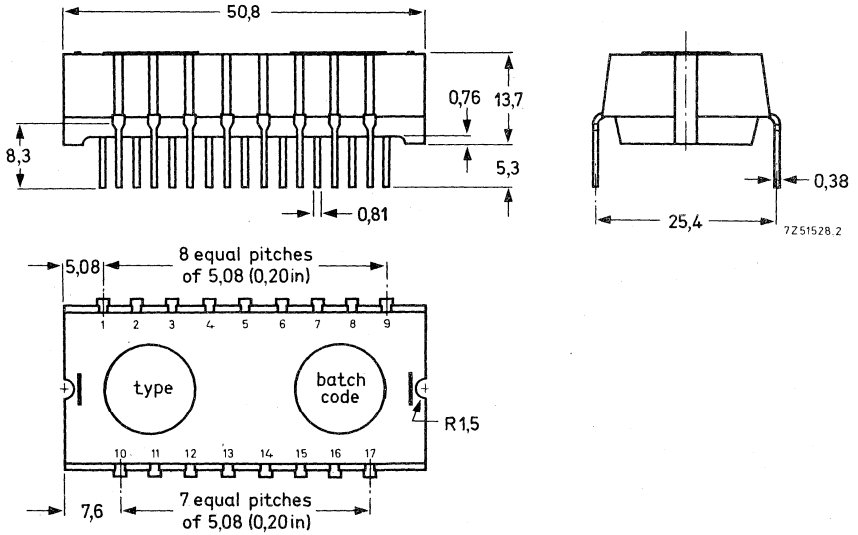
CONSTRUCTION

The circuit elements are housed in a transfer moulded encapsulation. The dimensions are as shown below. The pin connections for each unit are shown on the relevant data sheets. Pin numbering is moulded on both top and bottom of the unit. All pins are also accessible from the top of the unit to facilitate test requirements.

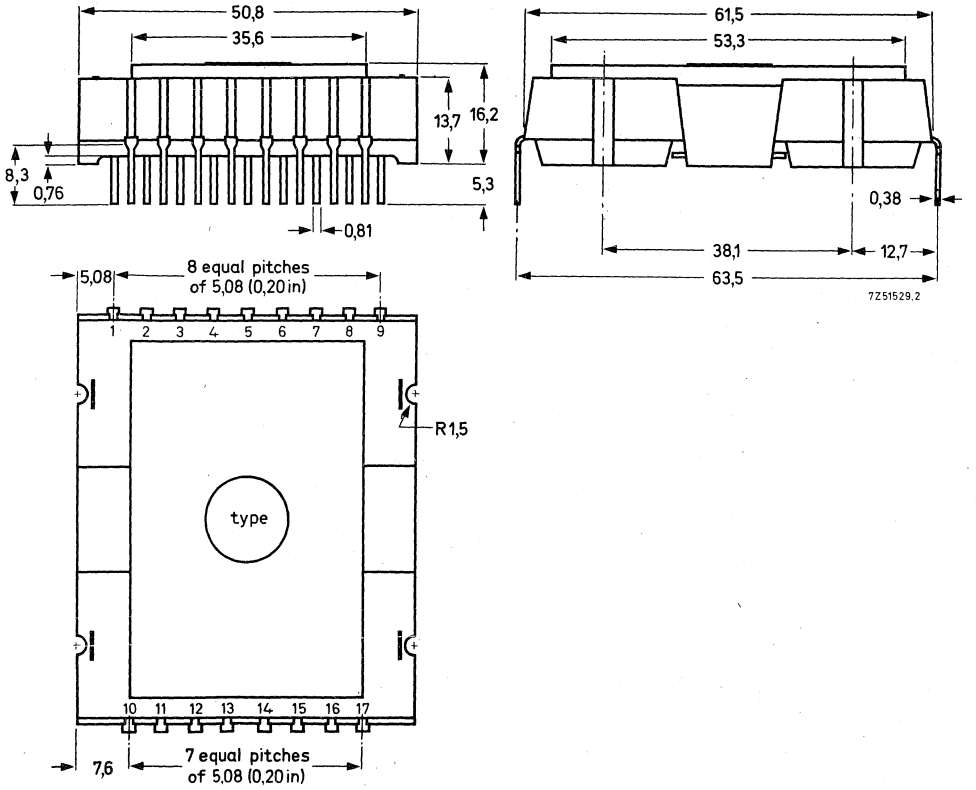
Mounting

The units may be mounted on printed-wiring boards, and a range of these is available with suitable metal mounting chassis. They may also be clamped in the moulded Universal Mounting Chassis UMC 60 or fixed with 3 mm screws.

Dimensions in mm (inch equivalents within brackets)



Size A (types 2.NOR60, 4.NOR60, 2.IA60, 2.LPA60, 2.SF60, TU60, GLD60)



Size B (type HPA60)

Terminals	suitable for soldering and Miniwrap
Wrap tool	Gardner Denver, bit number 506633
Wrap wire size	0,3 mm (0,012" = 28 U.S. gauge = 30 s.w.g.)
Mass, size A	30 g approx.
size B	85 g approx.
Colour coding	see data sheets of the units

TEST SPECIFICATIONS

All units meet the following test specifications:

Test	IEC 68	MIL-STD-202C
Dry heat life test	56 days at max. diss. max. temp. check at: 0-10/14d-56d.	Meth. 108A, Cond. D; check at 0-10/ 14d-56d.
Long-term damp heat non operating	Test C, 56 days check at 0-10/14d-56d.	Meth. 103B, Cond. D; check at 0-10/ 14d-56d.
Long-term damp heat operating	Test C, 56d. min., diss., check at 0-10/14d-56d.	ditto
Temp. cycle-test	Test Na, 30 min., 2-3 min in between; preferred: -40 °C; +85 °C	Meth. 107B, Cond. A: moderate temp.
Vibration	Test Fb; 10-500-10 Hz 1 octave/min ; ampl. 0.75 mm max.; 10 g max. 3 x 3 hrs.	Meth. 204A, Cond. A: 10-500-10 Hz: 15 min ampl. 0.75 max; 10 g max., 3 x 3 hrs.
Shock	-	Meth. 202B, 3 blows 50 g.
Robustness of terminations	Test $U_A + U_B$	Meth. 211A + (B or C)
Solderability + solder heat	Test T; at 0 hr and at 56d; no electr. test	Meth. 210, at 0 hr and at 56d; no electr. test
Corrosion resistance	1% SO_2 solution, 95% R.H., 35 °C, 1 day. Recovery 27 days.	

CHARACTERISTICS AND DEFINITIONS

AMBIENT TEMPERATURE LIMITS

Storage	T_{amb} = -40 °C to +85 °C
Operating	T_{amb} = -10 °C to +70 °C

SUPPLY VOLTAGE (V_S)

Single rail, +24 $V_{d.c.}$ ± 25% (18 to 30 V) or
+12 $V_{d.c.}$ ± 5% (11,4 to 12,6 V) at reduced ratings

LOGIC LEVELS

The operation of the "60"-series is based on positive logic, i.e. "1" level is a positive voltage that is more positive than "0" level, and "0" level is independent of supply voltage.
Logic "1" depends upon supply and loading of the output of the logic functional block.

Levels with V_S = 24 V ± 25%	Levels with V_S = 12 V ± 5%
0 V < "0" < +0.3 V	0 V < "0" < +0,3 V
11,4 V < "1" < V_S	8,3 V < "1" < V_S

D.C. NOISE IMMUNITY

"0" level Immunity: A d.c. voltage of +1 V with respect to the 0-volt line, applied to any one input (the other inputs floating) will not cause a change of output voltage.

"1" level Immunity:

a. With a supply voltage of 24 V ± 25%:
A variation of 2 V of the "1" input level will not cause a unit to change its output voltage.

b. With a supply voltage of 12 V ± 5%:
A variation of 0,25 V of the "1" input level will not cause a unit to change its output voltage.

DRIVE UNIT: Drive required on one input of a NOR 60 (with all other inputs returned to 0-volt line) to bring the output at "0" level (less than +0,3 V).

FAN OUT: Number of drive units that can be delivered by a logic function without exceeding the "1" level limits as defined above.
The fan out actually indicates the number of NOR gates that can be driven into saturation (thereby bringing the respective outputs at "0" level).

INPUT AND OUTPUT DATA

EXTENSION OF THE DRIVE UNIT CONCEPT

System design is greatly simplified by expression of the input requirements and fan out capabilities of the various units in integral multiples of the D.U. To check that the loadability of a particular unit is not exceeded, simply add the number of D.U.'s present at its output.

LOADING TABLE

The loading table shows the input requirements and output capability of the various units expressed in D.U.'s.

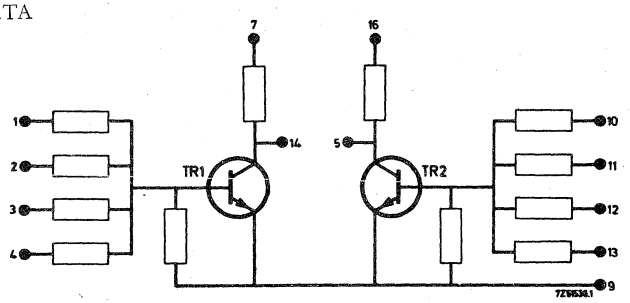
unit	input	V_S = 24 V ±25% output	V_S = 12 V ±5% output
2.NOR 60, per function	1 D.U.	6 D.U.	4 D.U.
4.NOR 60, per function	1 D.U.	6 D.U.	4 D.U.
2.IA 60, per function	2 D.U.	20 D.U.	13 D.U.
2.IA 60, connected as Low Power Amp.	2 D.U.	$R_{load} \geq 300\ \Omega$	$R_{load} \geq 150\ \Omega$
2.LPA 60 per function	2 D.U.	$R_{load} \geq 300\ \Omega$	$R_{load} \geq 150\ \Omega$
HPA60	1 D.U.	$R_{load} \geq 13,5\ \Omega$	$R_{load} \geq 6\ \Omega$
TU 60	1 D.U.	5 D.U.	3 D.U.
2.SF 60, per filter	100 $V_{d.c.}$	2 D.U.	2 D.U.
GLD 60 NOR function	1 D.U.	6 D.U.	-
GLD function	2 D.U.	900 D.U.	-

For matching non standard input signals to 60-Series inputs as well as matching non standard loads, the data sheets of the units give impedances and current requirements.

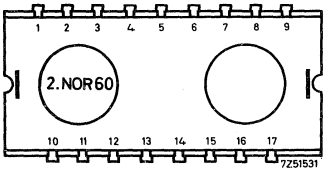
DUAL FOUR INPUT NOR GATE

Function	dual NOR (positive logic)
Case	size: A; colour: black

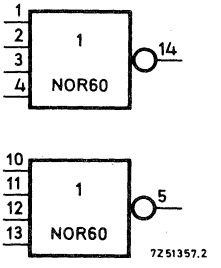
CIRCUIT DATA



Circuit diagram



Terminal location



Drawing symbols

1, 2, 3, 4 = input NOR 1
5 = output NOR 2
6 = n.c.
7 = for supply NOR 1 (V_S)
8 = n.c.
9 = 0 V common
10, 11, 12, 13 = input NOR 2
14 = output NOR 1
15 = n.c.
16 = for supply NOR 2 (V_S)
17 = n.c.

The unit contains two identical transistor-resistor NOR circuits. Each circuit has 4 inputs. If any input of a NOR is at "1" level the output of that NOR will be at "0" level.

CHARACTERISTICS

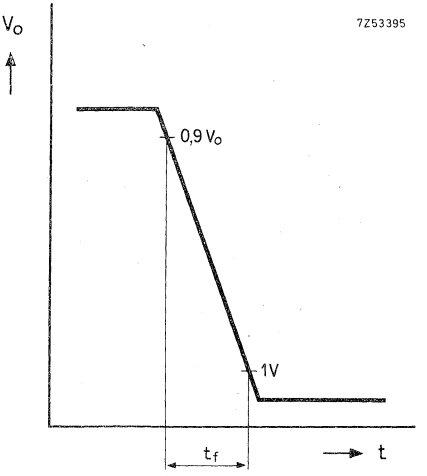
	at V_S = 24 V ± 25%	at V_S = 12 V ± 5%
Supply current at V_S nom	3,5 mA	1,75 mA
at V_S max	≤ 4,8 mA	≤ 1,95 mA
Input requirement	1 D.U.	1 D.U.
Output capability	6 D.U.	4 D.U.

	single input	two paralleled inputs	three paralleled inputs	four paralleled inputs
Input impedance [1]	90 kΩ	50 kΩ	35 kΩ	30 kΩ
Input current for "0" output [1][2]	0,13 mA	0,125 mA	0,.11 mA	0,1 mA

Switching speed

Fall time defined below $t_f \leq 1,25\ \mu s$

Fall delay time defined below $t_{fd} \leq 6\ \mu s$



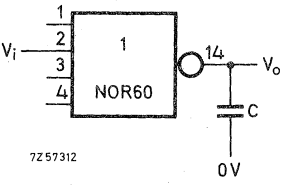


Fig. A

The fall time t_f is defined as the time required for the output voltage V_O to change from 90% of its full value to 1 V after application of a step input, the output being loaded with C = 200 pF (see Fig. A).

1) Unused inputs returned to 0-volt line.
2) At V_S = 30 V,

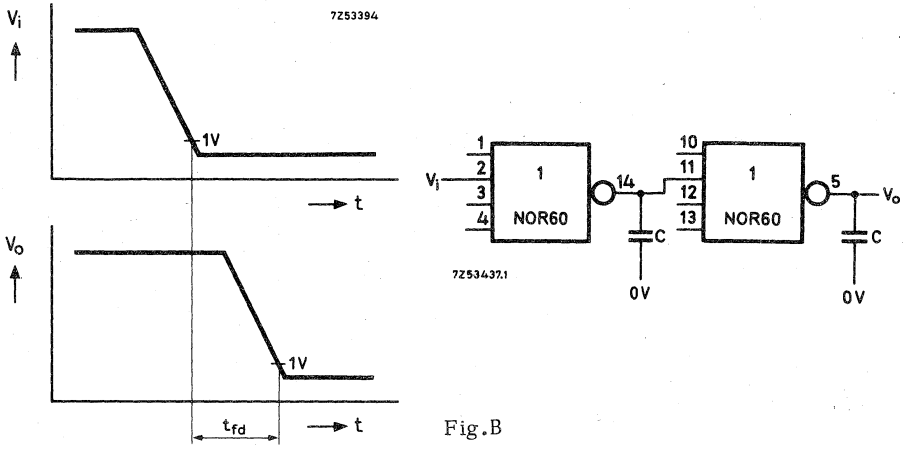


Fig.B

The fall delay time t_{fd} is defined as the time between the 1 V points of the negative-going input and output voltages of two cascaded NORs, each being loaded with C = 200 pF (see Fig.B).

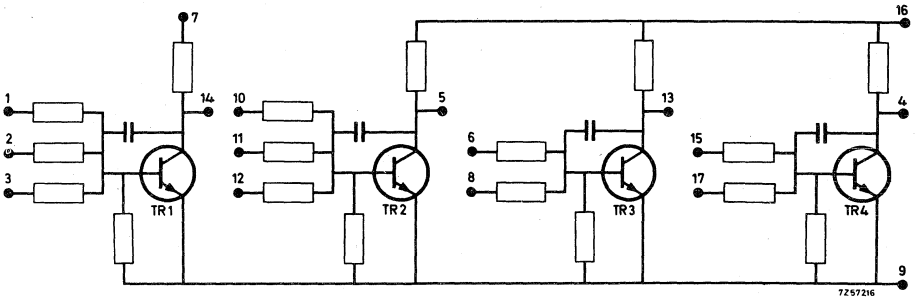
LIMITING VALUES (Destruction may occur when these values are exceeded)

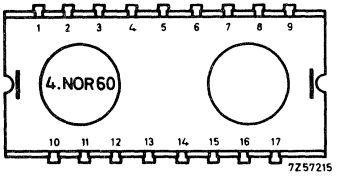
Supply voltage	V_S	max. 30	$V_{d.c.}$
		min. 0	V
Positive transient on V_S		max. 10	V during 10 μs
Positive input voltage	$+V_i$	max. 90	V
Negative input voltage	$-V_i$	max. 18	V

QUADRUPLE 2×2 + 2×3 INPUT NOR GATE

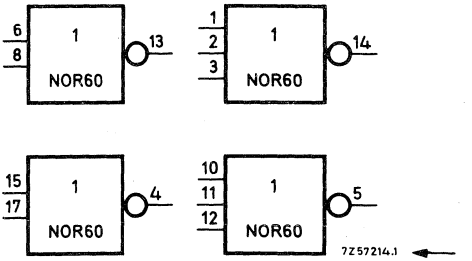
Function	quadruple NOR (positive logic)
Case	size: A; colour: black

CIRCUIT DATA





Terminal location



Drawing symbols

1, 2, 3 = input NOR 1
4 = output NOR 4
5 = output NOR 2
6, 8 = input NOR 3
7 = for supply NOR 1 (V_S)
9 = 0 V common
10, 11, 12 = input NOR 2
13 = output NOR 3
14 = output NOR 1
15, 17 = input NOR 4
16 = for supply NOR 2, 3, 4 (V_S)

The unit contains two identical 2-input and two identical 3-input NOR circuits. If any input of a NOR is at "1" level the output of that NOR will be at "0" level.

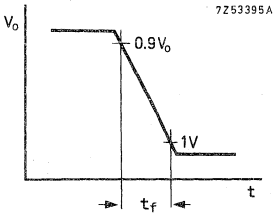
CHARACTERISTICS

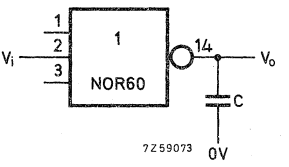
	at V_S = 24 V ±25%	at V_S = 12 V ±5%
Supply current at $V_{S\,nom}$	3,5 mA	1,75 mA
at $V_{S\,max}$	≤ 4,8 mA	≤ 1,95 mA
Input requirement	1 D.U.	1 D.U.
Output capability	6 D.U.	4 D.U.

	single input	two paralleled inputs	three paralleled inputs
Input impedance [1])	90 kΩ	50 kΩ	35 kΩ
Input current for "0" output [1][2])	0,13 mA	0,125 mA	0,11 mA

Switching speed

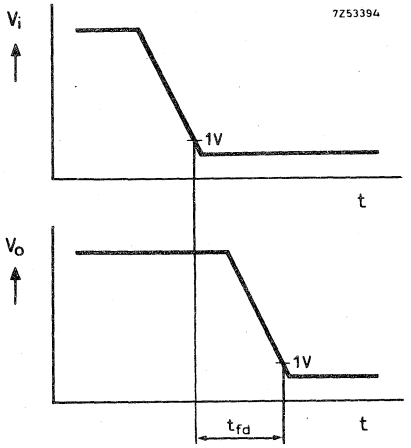
Fall time defined below	t_f ≤ 14 μs
Fall delay time defined below	t_{fd} ≤ 26 μs





The fall time t_f is defined as the time required for the output voltage V_O to change from 90% of its full value to 1 V after application of a step input, the output being loaded with C = 200 pF (see Fig.A).

[1]) Not used inputs returned to 0-volt line.
[2]) At V_S = 30 V.



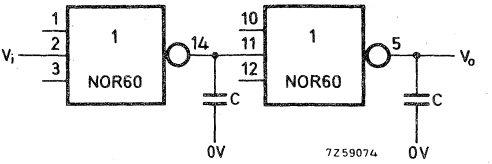


Fig.B

The fall delay time t_{fd} is defined as the time betweeb the 1 V points of the negative-going input and output voltages of two cascaded NORs, each being loaded with C = 200 pF (see Fig.B).

LIMITING VALUES (Destruction may occur when these values are exceeded)

Supply voltage	V_S	max. 30 V min. 0 V	d.c.
Positive transient on V_S		max. 10 V	for 10 μs
Positive input voltage	$+V_i$	max. 90 V	
Negative input voltage	$-V_i$	max. 24 V	

DUAL INVERTER AMPLIFIER

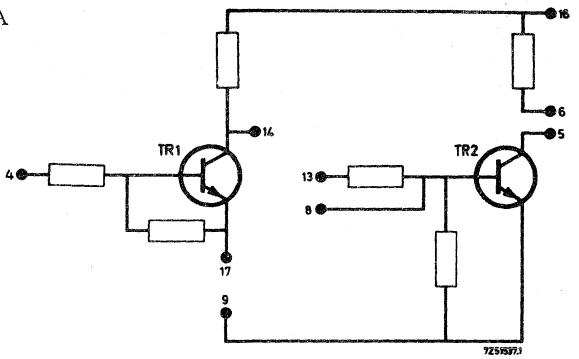
Function

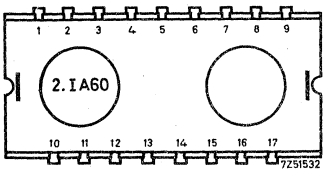
The unit comprises two identical Inverter Amplifiers. Use as a single inverting Low Power Amplifier is feasible.

Case

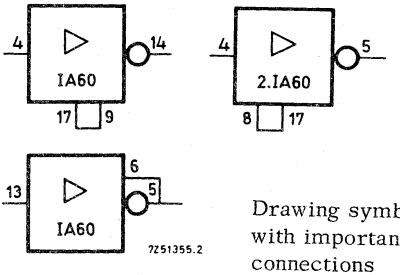
Size:A; colour: blue

CIRCUIT DATA





Terminal location



Drawing symbols with important connections

1, 2, 3 = n.c.
4 = input IA 1
5 = output IA 2
6 = collector resistor IA 2
7 = n.c.
8 = base of IA 2 transistor
9 = 0 V common
10, 11, 12 = n.c.
13 = input IA 2
14 = output IA 1
15 = n.c.
16 = for supply (V_S)
17 = emitter of IA 1 transistor

To obtain the dual I.A., pin 17 should be connected to pin 9 and pin 6 to pin 5.
A "1" level input (pin 4 or 13) will cause a "0" level output (pin 14 or 5-6 respectively).
To obtain the inverting L.P.A., pin 17 should be connected to pin 8 and the load connected between pins 5 and 16. When pin 4 is at "1" level, pin 5 will be at "0" level.

Notes to the load of the L.P.A.

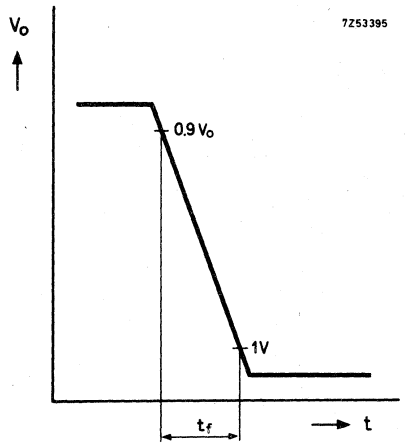
1. Care should be taken that the value of a varying load should not drop below the specified minimum.
2. Incandescent lamps have a "cold" resistance that is only a fraction of the value calculated from nominal voltage and current, so that turning on of the lamp may cause a surge current. It is advisable to use a pre-heating quiescent current to eliminate destructive surge currents.
3. Inductive loads will cause large voltage peaks upon switching off. To avoid destruction the load should be provided with a flywheeling diode, type BAX12. The anode should be connected to pin 5, the cathode to pin 16 (positive supply).

CHARACTERISTICS

	at V_S = 24 V ±25%		at V_S = 12 V ±5%	
	per I.A.	as L.P.A.	per I.A.	as L.P.A.
Supply current at $V_{S\,nom}$	10,9 mA	10,9 mA + I_{load}	5,5 mA	5,5 mA + I_{load}
Supply current at V_S max and "1" input	≤ 15,5 mA	≤ 114 mA R_{load} = 300 Ω	≤ 6,5 mA	≤ 89,9 mA R_{load} = 150 Ω
Input requirement	2 D.U.	2 D.U.	2 D.U.	2 D.U.
Output capability	20 D.U.	140 D.U. [1]	13 D.U.	
Minimum load resistance		300 Ω [1]		150 Ω [1]

Input impedance		45 kΩ
Input current for "0" output of I.A. at V_S = 30 V		0,285 mA
Switching speed		
Fall time defined below	t_f	≤ 1 μs
Fall delay time defined below	t_{fd}	≤ 3 μs

[1]) This load is permissible only if the input switched between "0" and "1" levels by a preceding 60 Series unit or other true digital input, avoiding excessive dissipation during transitions.



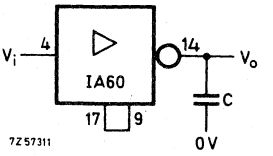
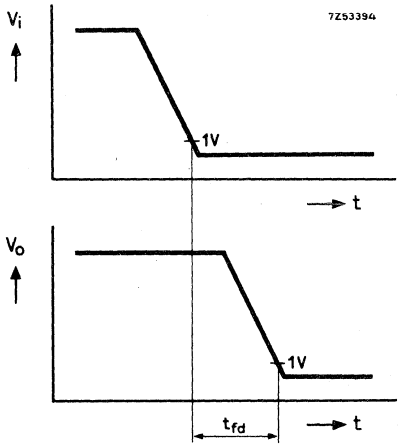


Fig.A

The fall time t_f is defined as the time required for the output voltage V_O to change from 90% of its full value to 1 V, after application of a step input, the output being loaded with C = 200 pF (see Fig.A).



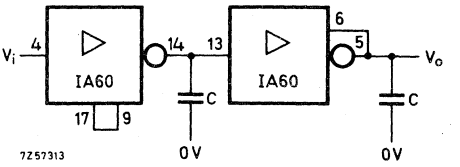


Fig.B

The fall delay time t_{fd} is defined as the time between the 1 V points of the negative-going input and output voltages of two cascaded Inverter Amplifiers, each being loaded with 200 pF (see Fig.B).

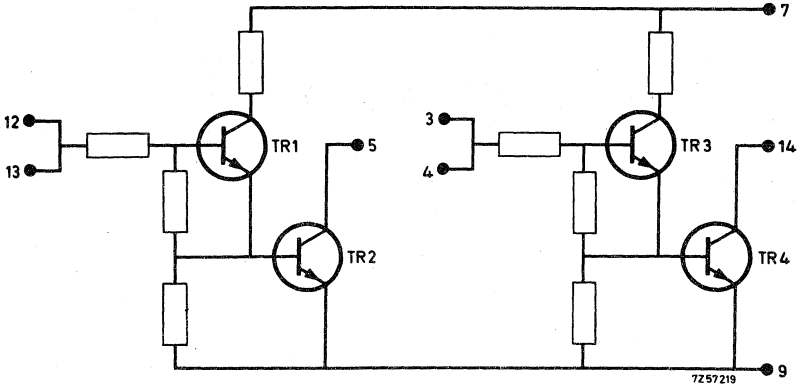
LIMITING VALUES (Destruction may occur if these values are exceeded)

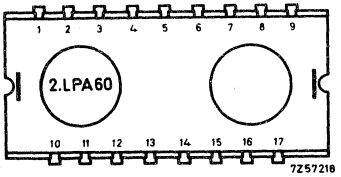
Supply voltage	V_s	max.	30	$V_{d.c.}$
		min.	0	V
Positive transient on V_s		max.	10	V during 10 μs
Positive input voltage	$+V_4$, $+V_{13}$	max.	70	V
Negative input voltage	$-V_4$, $-V_{13}$	max.	16	V
Positive voltage at pin 8	$+V_8$	max.	4	V via min. 500 Ω
Negative voltage at pin 8	$-V_8$	max.	5	V

DUAL LOW POWER AMPLIFIER

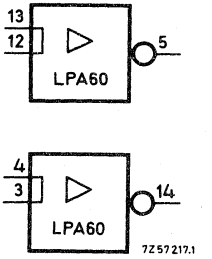
Function	The unit comprises two identical inverting Low Power Amplifiers
Case	size: A; colour: blue

CIRCUIT DATA





Terminal location



Drawing symbols

1, 2	=	n.c.
3, 4	=	input LPA2
5	=	output LPA1
6	=	n.c.
7	=	for supply (V_S)
8	=	n.c.
9	=	0 V common
10, 11	=	n.c.
12, 13	=	input LPA1
14	=	output LPA2
15, 16, 17	=	n.c.

The load should be connected between pins 5 and 7 for LPA1 and between pins 14 and 7 for LPA2.
When the input (12/13 or 3/4) is at "1" level, the output (5 or 14) will be at less than 1 V. This being no true "0" level, it is not recommended to use an LPA as a logic operator.

Notes to the loading

1. Care should be taken that the value of a varying load should not drop below the specified minimum.
2. Incandescent lamps have a "cold" resistance that is only a fraction of the value calculated from nominal voltage and current, so that turning on of the lamp may cause a surge current. It is advisable to use a pre-heating quiescent current to eliminate destructive surge currents.
3. Inductive loads will cause large voltage peaks upon switching off. To avoid destruction the load should be provided with a flywheeling diode, type BAX12. The anode should be connected to pin 5 (14), the cathode to pin 7 (positive supply).

CHARACTERISTICS

	at V_S = 24 V ±25%	at V_S = 12 V ±5%
Supply current at $V_{S\,nom}$, I_{load} = 0 mA	8 mA	4 mA
Supply current at $V_{S\,max}$ and "1" input, R_{load} = 300 Ω	≤ 108 mA	–
R_{load} = 150 Ω	–	≤ 89.9 mA
Input requirement	2 D.U.	2 D.U.
Output capability	100 mA	80 mA
Min. load resistance	300 Ω	150 Ω

Input impedance			45 kΩ
Input current for "0" output at V_S = 30 V			0.285 mA
Output voltage at "1" input			< 1 V
Switching speed			
Fall time (Fig.A)	t_f	≤	0.4 µs
Rise time (Fig.B and Fig.C)	t_r	≤	2 µs
Storage time (Fig.B and Fig.C)	t_s	≤	10 µs

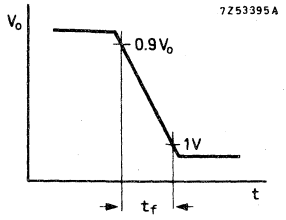


Fig.A

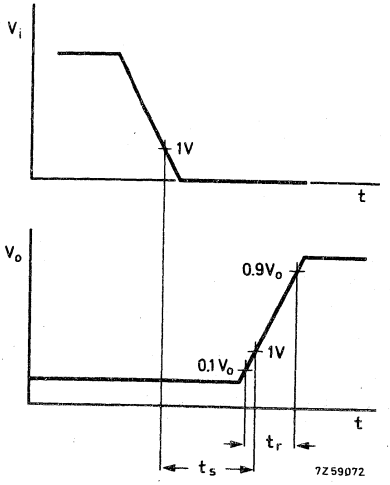


Fig.B

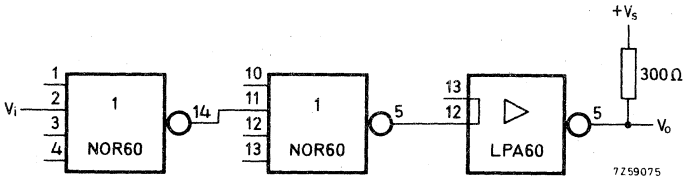


Fig.C

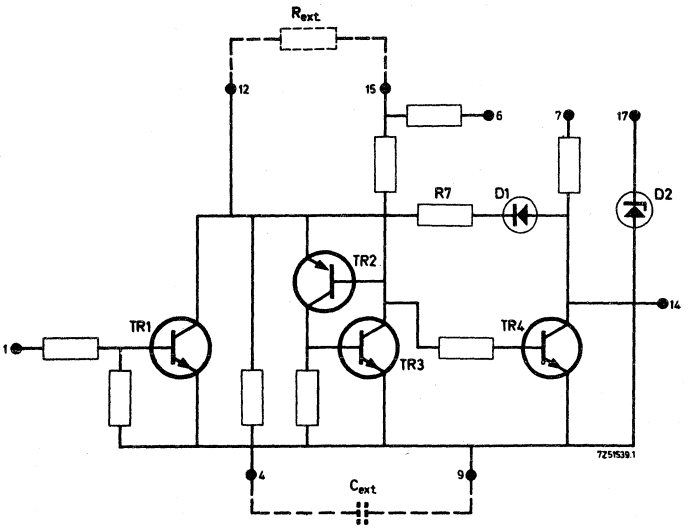
LIMITING VALUES (Destruction may occur if these values are exceeded)

Supply voltage	V_s	max. 30 $V_{d.c}$ min. 0 V	
Positive transient on V_s		max. 10 V	for 10 μs
Positive input voltage	$+V_i$	max. 70 V	
Negative input voltage	$-V_i$	max. 16 V	

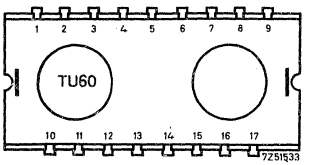
TIMER

Function	Gives an inverted output. The output of a "1" is delayed following a "0" input. No delay occurs when the input returns to "1"
Case	Size: A; colour: red

CIRCUIT DATA

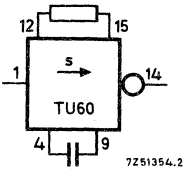


With the input at "1" the capacitor (C_{ext}) is discharged. When the input goes to "0", TR_1 ceases to conduct so that the capacitor is allowed to slowly charge until the base potential of TR_2 is exceeded. TR_2 starts to conduct and provides base current for TR_3, which speeds the turn-on of TR_2. TR_4 ceases to conduct and the output level changes from "0" to "1". Positive feedback is provided via D_1 and R_7.



Terminal location

1 = input
2, 3 = n.c.
4 = for external capacitor
5 = n.c.
6 = see instructions below
7 = positive supply
8 = n.c.
9 = 0 V common
10, 11 = n.c.
12 = for external resistor
13 = n.c.
14 = output
15 = for external resistor
16 = n.c.
17 = see instructions below



Drawing symbol with significant connections

Instructions for connection of the supply

When V_S = 24 V ±25% : connect 6 and 7, connect 15 and 17.

When V_S = 12 V ±5% : connect 15 and 7, do not connect 6 and 7.

CHARACTERISTICS

	at V_S = 24 V ±25%	at V_S = 12 V ±5%
Supply current at $V_{S\,nom}$	6.9 mA	1.9 mA
at $V_{S\,max}$	10.1 mA	2.1 mA
Input requirement	1 D.U.	1 D.U.
Output capability	5 D.U.	3 D.U.

Input impedance 90 kΩ

Input current for "0" output, at V_S = 30 V 0.125 mA

External resistance R_{ext} min. 100 kΩ, max. 1 MΩ

Leakage current of external capacitor when connected between

pins 4 and 9 max. 100 nA at 10 V

pins 15(+) and 4 max. 100 µA at 25 V

Delay time (see Fig.A)	t_{delay}	about R_{ext} C_{ext} s ($M\Omega$ x μF) [1]
Max. change of delay time with temperature (C_{ext} pins 4 and 9)		- 0,14 %/°C
Switching speed		
Fall time as defined below	t_f	$\leq$ 1 μs
Rise time as defined below	t_r	$\leq$ 6 μs
Timing requirements (see Fig.A)		
Set time	t_{set}	min. 11,9 C_{ext} ms (C_{ext} in μF)
Recovery time	t_{sec}	min. 11,9 C_{ext} ms
Start inhibit before end of delay	$t_{st\ inh}$	min. 18,9 C_{ext} ms
Inhibit duration	t_{inh}	min. 18,9 C_{ext} ms (A shorter t_{inh} gives a shorter delay)

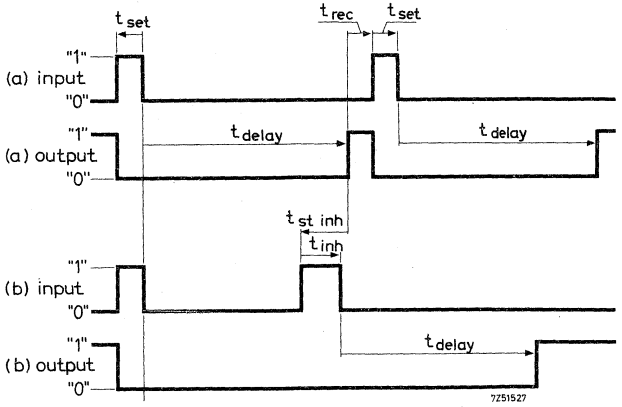


Fig.A

[1] For long delay times the 25 μF, 160 V_{rms} film capacitor, catalogue number 2222 325 50256 is recommended.

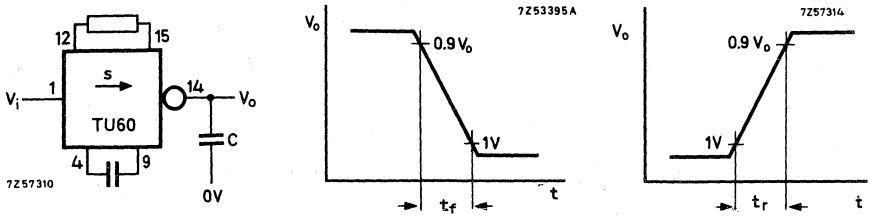


Fig.B

The fall time t_f is defined as the time required for the output voltage V_O to change from 90% of its full value to 1 V, after application of a step input and being loaded with C = 200 pF (see Fig.B).

The rise time t_r is defined as the time required for the output voltage V_O to change from 1 V to 90% of its full value, after application of a step input and being loaded with C = 200 pF (see Fig.B).

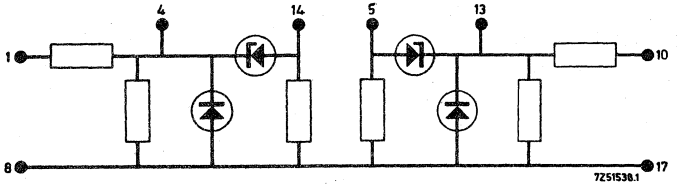
LIMITING VALUES (Destruction may occur if these values are exceeded)

Supply	V_S	max.	30 $V_{d.c.}$
		min.	0 V
Positive transient on V_S		max.	10 V for 10 µs
Positive input voltage	$+V_I$	max.	70 V
Negative input voltage	$-V_I$	max.	16 V
External resistance	R_{ext}	min.	820 Ω

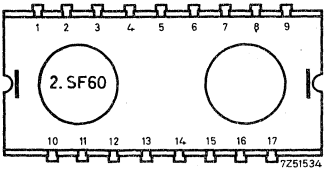
DUAL SWITCH FILTER

Function	Dual switch filter for eliminating the effects of contact bounce of mechanical switches
Case	size: A; colour: green

CIRCUIT DATA

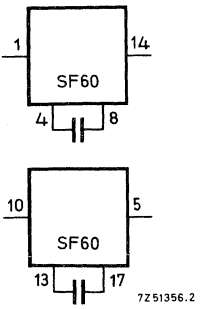


The circuit consists of two identical filters for minimising the effects of contact bounce and spurious interference on long leads between switch and system input. The switch filter also has the facility that 100 V are applied across the switch contacts, thus ensuring reliable switching.
The voltage divider enables the input to be presented with a high impedance load whilst the internal circuitry is presented with a lower impedance source. The time for which contact bounce is eliminated is determined by an external capacitor. The zener diode provides a threshold. The diode prevents that excessive base current is drawn from any driven NORBIT if a large negative voltage appears on the filter input. It also prevents that a reverse voltage is presented to the capacitor, which thus may be of a polarised type.



Terminal location

1	= input SF1	10	= input SF2
2, 3	= n.c.	11, 12	= n.c.
4	= for external capacitor of SF1	13	= for external capacitor of SF2
5	= output SF2	14	= output SF1
6, 7	= n.c.	15, 16	= n.c.
8	= 0 V common	17	= 0 V common (to be taken to central earth point)
9	= n.c.		



Drawing symbols with capacitor

Instructions

a. Capacitor working voltage ≥ 100 Vd.c.

b. Mount the unit as close as possible to the logic system input.

c. The common 0-volt line (8 or 17) must be returned to the central earth point of the system to avoid common impedance coupling.

CHARACTERISTICS (per filter)

Input voltage for "1" out	+100 V ±25%
Input current	< 3.3 mA
Input surge current peak	< 4.8 mA
Output capability	2 D.U.
Contact bounce elimination time	1,4 C ms (C in μF)

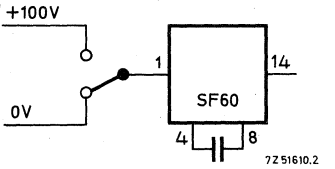


Fig.a

Switching speed (C in μF):	
Turn-on time	41 C ms
Max. operating frequency with 1 : 1 mark to space ratio for circuit Fig.a	$\frac{6.3}{C}$ Hz
Ditto for Fig.b	$\frac{11.08}{C}$ Hz

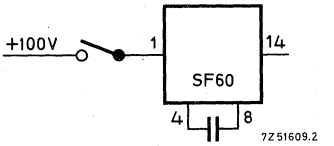


Fig.b

LIMITING VALUES (Destruction may occur if these values are exceeded)

Positive input voltage	$+V_1, +V_{10}$	max. 125 V
Negative input voltage	$-V_1, -V_{10}$	max. 100 V

HIGH POWER AMPLIFIER

Function	Power Amplifier for load switching
Case	Size: B; colour: black

CIRCUIT DATA

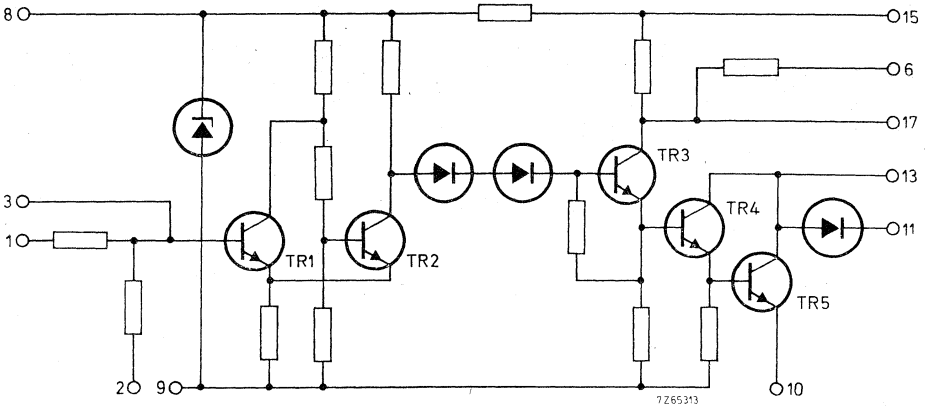


Fig. 1

The power amplifier consists of a Schmitt trigger followed by a buffer + driver stage, which provides adequate drive to the power transistor under all conditions of permissible supply voltage and input signal. The load should be connected between pin 13 and + of power supply. A "1" input will switch on the load current.

Notes:

1. Observe rules for $R_{load\ min}$.
2. Incandescent lamps have a "cold" resistance that is only a fraction of the value calculated from voltage and current so that turning on of a lamp may cause a current surge. It is often advisable to use a preheating quiescent current to eliminate destructive surge currents.
3. Inductive loads will cause large voltage peaks at switching off. To avoid destruction of output transistor the load should be shunted by a damping diode. By connecting terminal 11 to the supply line inductive loads up to a certain value can be handled by the internal diode.

4. Pin 10 serves to make a separate connection between a 0 V load supply line and the power supply unit to avoid common wire impedance with the 0 V logic supply line. Also, if a second supply unit is used for the HPA 60, common impedance with the 0 V logic supply line should be avoided in the interconnection between pins 9 (0 V logic supply) and 10 (0 V output stage).

Terminal location

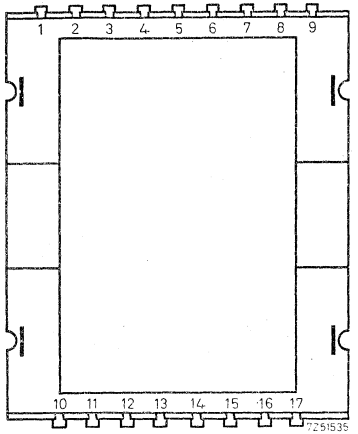
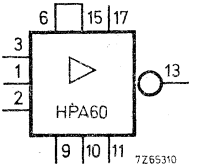


Fig. 2

1	= input
2	= base resistor of input transistor
3	= base of input transistor
4	= n.c.
5	= n.c.
6	= + supply, connect to 15
7	= n.c.
8	= zener diode
9	= 0 V logic supply
10	= 0 V output stage, see note 4
11	= damping diode
12	= n.c.
13	= output (load between 13 and supply)
14	= n.c.
15	= + supply, connect to 6
16	= n.c.
17	= collector of TR3

Fig. 3
Drawing symbol (one necessary interconnection indicated).



Additional instructions

a. If the input (pin 1) is driven by a standard "1" level from NOR 60, etc., connect pins 2 and 9.

b. If the supply voltage is 12 V ± 5%, connect a resistor of 330 Ω between pin 6 and 8, and a resistor of 1.5 kΩ between 15 and 17; both resistors ± 5%, $\frac{1}{4}$ W.

c. Wiring to pin 3 must be kept remote from the output circuitry.

d. When using pin 3 as a second input, the input resistor should be connected direct to the pin.

CHARACTERISTICS

	V_S = 24 V ± 25%	V_S = 12 V ± 5%
Supply current at V_S nom excluding I_{load}	18.8 mA	15.1 mA
Supply current at V_S max excluding I_{load}	< 26.2 mA	< 28.8 mA
Required load resistance at T_{amb} = 45 to 70 °C	> 13.5 Ω	> 6 Ω
at T_{amb} < 45 °C	> 12 Ω	> 5 Ω
Required input	1 D.U.	1 D.U.
Voltage on pin 13, TR5 conducting	max. 2.V	max. 2 V

	at pin 1	at pin 3
For switching on load current		
input voltage, 2–9 connected	> 6 V	> 1.6 V [1]
input current, 2–9 connected	75 µA	75 µA
2–9 not connected [2]	30 µA	30 µA
For switching off load current		
input voltage, 2–9 not connected [2]	< 1.15 V	< 1.15 V
On-off input voltage difference		
2–9 not connected [2]	–	> 0.5 V

Switching speed	maximum	typical
Fall time, t_f	0.2 µs	0.05 µs
Rise time, t_r	4.2 µs	0.3 µs

The fall time t_f is defined as the time required for the output voltage to change from 90% to 10% of its full value, after application of a step input, under conditions as shown in Fig. 4 (See also Fig. 5).

The rise time t_r is defined as the time required for the output voltage to change from 10% to 90% of its full value, after application of a step input, under conditions as shown in Fig. 4 (See also Fig. 6).

1) Via min. 500 Ω.
2) Source resistance must not exceed 56 kΩ.

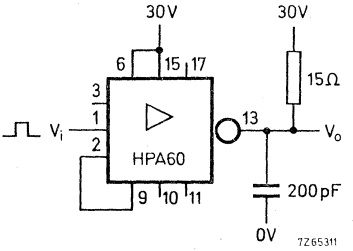


Fig. 4

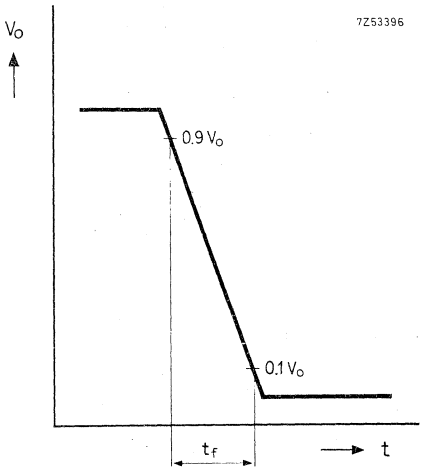


Fig. 5

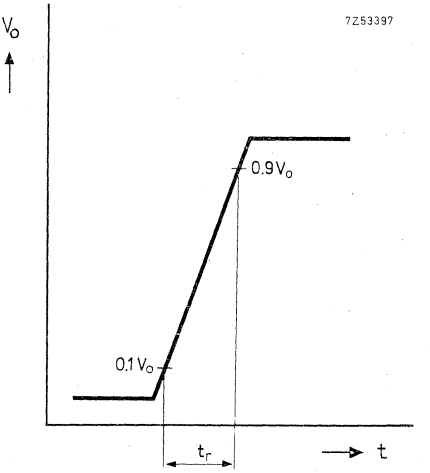


Fig. 6

By connecting terminal 11 to the supply line the following inductive loads can be handled by the internal damping diode:

R_L = 15 Ω	$L_L \leq$ 10 H
R_L = 20 Ω	$L_L \leq$ 14 H
R_L = 30 Ω	no restriction

Switch-off delay time for R_L = 30 Ω and L_L = 10 H is 770 ms.

LIMITING VALUES (Destruction may occur if these values are exceeded)

Supply voltage, V_S	max. 30 V d.c.
Positive transient on driver stage (pin 6 and 15)	max. 10 V for 10 µs
Positive voltage on power stage, pin 13	max. 55 V
Voltage at pin 1 (2–9 connected)	
positive	max. 100 V
negative	max. 15 V
Voltage at pin 3	
positive	max. 5 V via min. 500 Ω
negative	max. 4.5 V
Output current	5 A for 20 ms

OVERLOAD PROTECTION

Protection measures must be taken in applications in which overloading of the HPA 60 may occur, e.g. short circuiting of the load. The operating time of a fuse is far too slow to provide adequate protection in such cases, therefore another method must be used. The protection circuit described here uses a 2.IA 60 connected as a memory element, and serves well in many HPA 60 applications.
It will operate at a load current of 3 A. Removing one of two series-connected diodes will bring the "fault" condition of load current down to 2 A. Finer control of the load current level at which the protection circuit will operate may be achieved by replacing the resistor R by a wire-wound potentiometer.

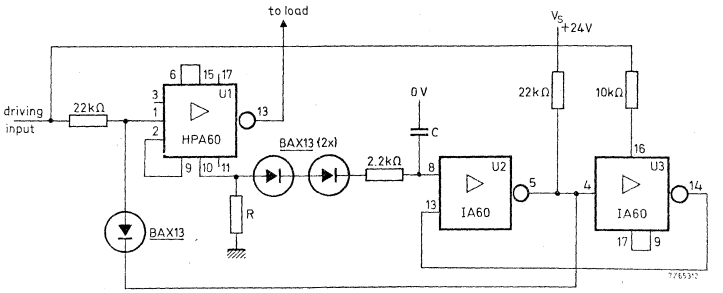


Fig.7

R = 0,39 Ω (2 W)
C = 100 nF

Load current information is provided by resistor R, and is fed to U2 (pin 8) via the series-connected diodes.
The capacitor C prevents the circuit from operating on transient currents of up to 5 A. If the load current is too high for the HPA 60, the output of U2, at pin 5, goes LOW. This LOW is fed back to U1, pin 1 , via the BAX13 diode. A LOW at the input of the HPA 60 switches it off.

When the overload is removed, the protection circuit remains in the fault condition because the memory element is still "set". The protection circuit can only be "reset" by removing the logic signal from the driving input, since U3 is fed with the HPA 60 driving input via pin 16.

The circuit shown here requires 6 D.U.

GROUNDED LOAD DRIVER

Function: - a 2 input power amplifier for switching d.c. loads, connected with one side to ground (GLD)
- a 2 input NOR gate
- monitor circuit for twin channel logic systems with fault display.

Case: Norbit block size A, colour black.

CIRCUIT DATA

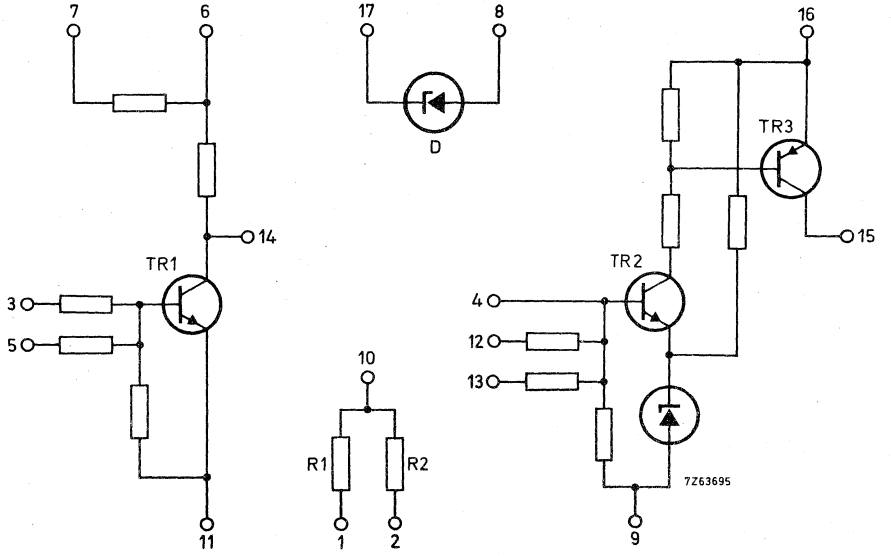


Fig. 1

The unit comprises two main circuits and auxiliary networks:
- A NOR gate with two inputs each requiring 1 D.U.. The output capability is 6 D.U..
- A grounded load driver (GLD) consisting of an input stage with two inputs and a PNP output stage. The load should be connected between the output terminal and 0 V common. A "1" input signal will switch on the load current.
- A voltage regulator diode (D) to couple the NOR to the GLD, or to isolate the load of the GLD from the resistance network (R1 and R2) when the complete unit is applied as a monitor circuit for twin channel logic systems with fault display.

Terminal location

1 = R1
2 = R2
3 = input NOR
4 = auxiliary input GLD
5 = input NOR
6 = positive supply V_S for NOR
7 = auxiliary supply
8 = voltage regulator diode, anode
9 = 0 V common GLD
10 = R1, R2
11 = emitter TR1, 0 V if used as NOR
12 = input GLD
13 = input GLD
14 = output NOR
15 = output GLD
16 = positive supply V_S for GLD
17 = voltage regulator diode, cathode

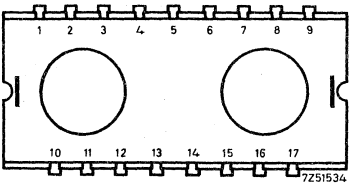


Fig. 2

Drawing symbols

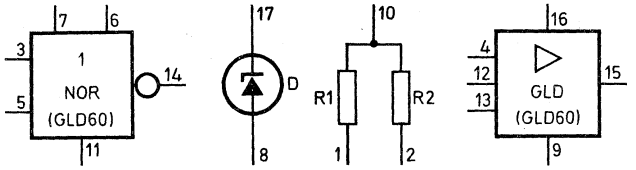


Fig. 3 NOR function auxiliary circuits GLD function

CHARACTERISTICS

7Z63686

	NOR (supply to pin 6)	GLD
Power supply voltage (V_S)	+24 V ±25%	+24 V ±25%
current	nom. 3,2 mA max. 4,1 mA	nom. 14,2 mA + I_{load} max. 19,1 mA + I_{load}
Input requirements, per terminal	1 D.U.	2 D.U.
Output capability	6 D.U.	900 D.U.
at maximum load resistance		3 kΩ
Minimum load resistance,		
- driven by signal on pins 12 and 13		75 Ω *) at T_{amb} = 45 °C 86 Ω *) at T_{amb} = 70 °C
- driven by NOR via D on pin 4 (supply to pins 7 and 16, connect pin 8 to 4, pin 14 to 17, pin 11 to 10, pin 12 or 13 to 0 V)		120 Ω *)

*) For use with incandescent lamps, series and/or bleed resistors might be required to avoid high inrush currents in connection with their "cold" resistance.
To limit large voltage peaks at switching of inductive loads these loads should be shunted by a damping diode, e.g. BAX12 (cathode to pin 15).

Resistor network

R1	3010 Ω
R2	1500 Ω

Voltage regulator diode

V_D	12 V

LIMITING VALUES (Destruction may occur if these values are exceeded)

Supply voltage V_S	max. +30 V d.c. min. 0 V d.c.
Positive transient on V_S	max. +10 V for 10 μs
Input voltage	
NOR (pins 3, 5)	max. +70 V min. −15 V
GLD (pins 12, 13)	max. +70 V min. − 4 V
Input current GLD (pin 4)	max. +20 mA *)
Output surge current	max. 1 A for 20 ms

APPLICATION INFORMATION

A GLD60 as a grounded load amplifier

1. The GLD 60 makes it possible to drive loads (relays, magnetic valves etc.) of which one side has been connected to ground, Fig. 4 illustrates also the suitability of the unit for systems which from the point of safety require that the load is not activated in case of short circuit to ground of the output.

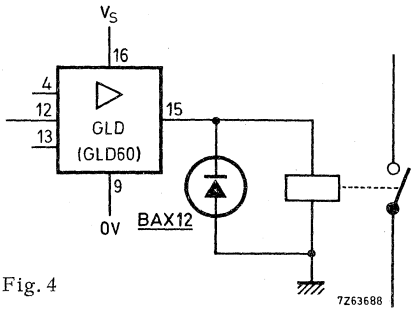


Fig. 4

2. High power grounded load drive.
Fig. 5 shows how higher loads can be driven. This circuit permits load resistances down to 8, 6 Ω (corresponding to a load current of 3, 5 A at V_S = 30 V).
The BDY60 is mounted on an aluminium heatsink of 150 cm^2, thickness 2 mm.
For inductive loads a flywheel diode D (BYX30/50) is required.

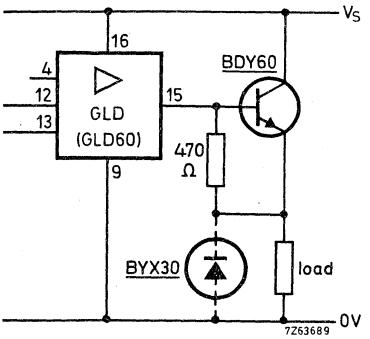


Fig. 5

*) Care should be taken not to apply a voltage > 1 V without current limiting resistance.

3. Short circuit protection of the GLD60.
If the load is short-circuited, the output transistor of the GLD60 can be damaged. This is prevented if the circuit depicted in Fig. 6 is applied. Too high a load current starts the BRY39 conducting. Consequently the input of the NOR goes "high" and its output "low", biasing input 4 of the GLD "low", in this way overruling the existing "high" on the system inputs. Once the BRY39 has started conducting, it will continue to do so until the push button is pressed.

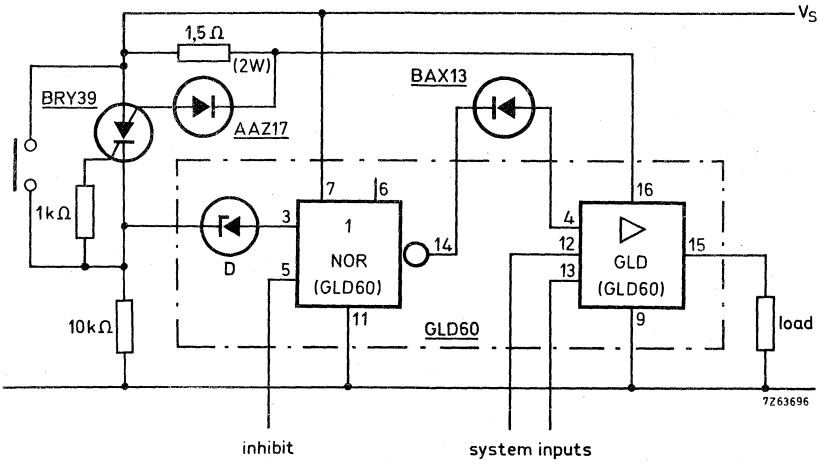


Fig. 6

B Monitoring and safeguarding twin channel systems

Fig. 7 shows the circuit build-up of a process control in which malfunctioning of one of the parallel identical logic systems or of the monitoring/safeguarding circuit causes an indication or switching to safe condition of the process to be controlled.
When the identical logic systems function properly their outputs are equal because their input conditions are identical. The equality of the outputs is monitored by the combination "2 x GLD60". Where parts of this monitoring combination are used in the channels before the point of comparison, they should be completely independent so that malfunction of one part in one channel cannot cause malfunction of the other part in the other channel. Consequently malfunction in this part of the monitoring combination will occur in one channel only and will have the same effect as malfunction of one of the logic systems. Similar considerations apply to the input connections of both logic systems.
Output V_{oA} can be used for power switching, and as an input condition for additional twin-channels (e.g. B_1 and B_2) in case the total control system comprises more twin channels.

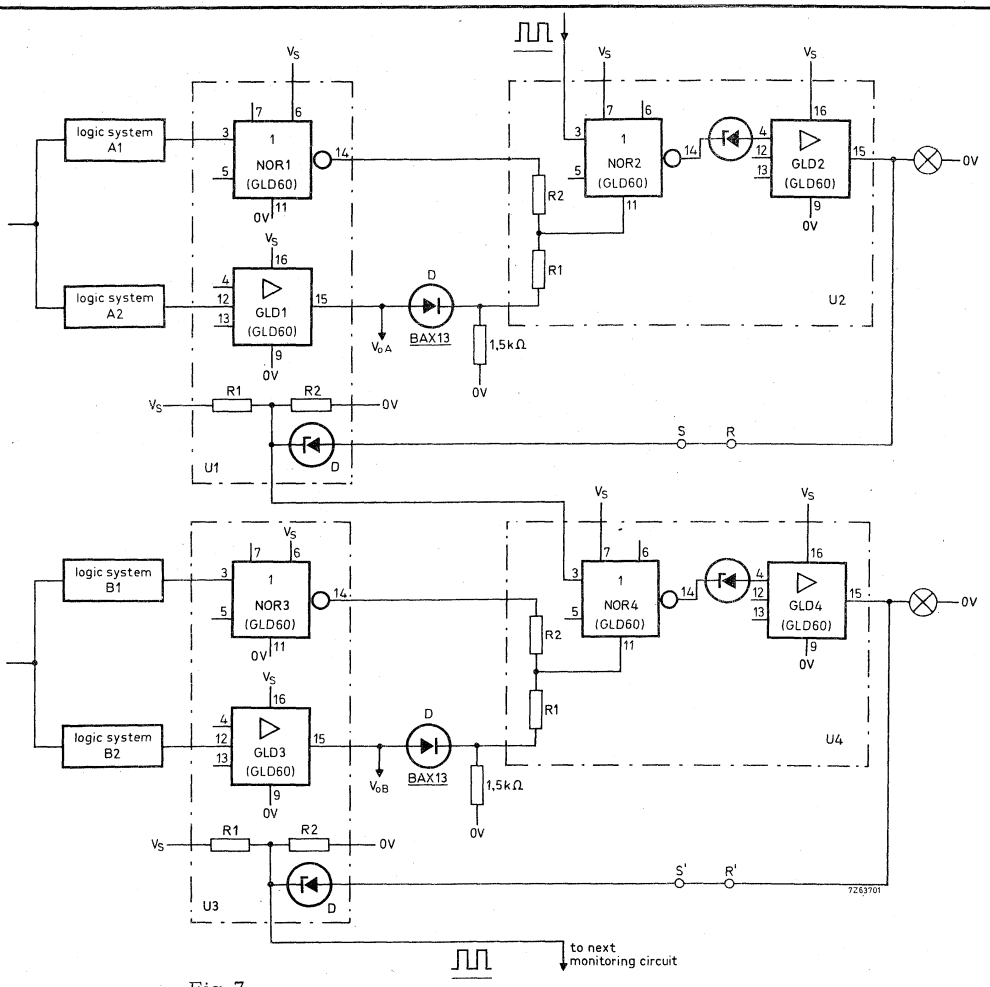


Fig.7

The actual circuit for comparing the outputs should be self-safeguarding which means that a malfunction should cause a fault indication, i.e. the part of the monitoring circuit between comparison circuit and pilot lamp has also to be monitored for malfunction. This is done by feeding a square wave to the input of this part, which is therefore monitored in a dynamic way. The output will alternate between on and off at the frequency of the square wave.

Malfunction of one of the components will cause a continuous on or off at the output. This also means that the pilot lamp is continuously monitored. Correct functioning of the whole system causes the pilot lamp to flicker (low square wave frequency e.g. 2 Hz) or to burn dimly (high square wave frequency e.g. 10 kHz).

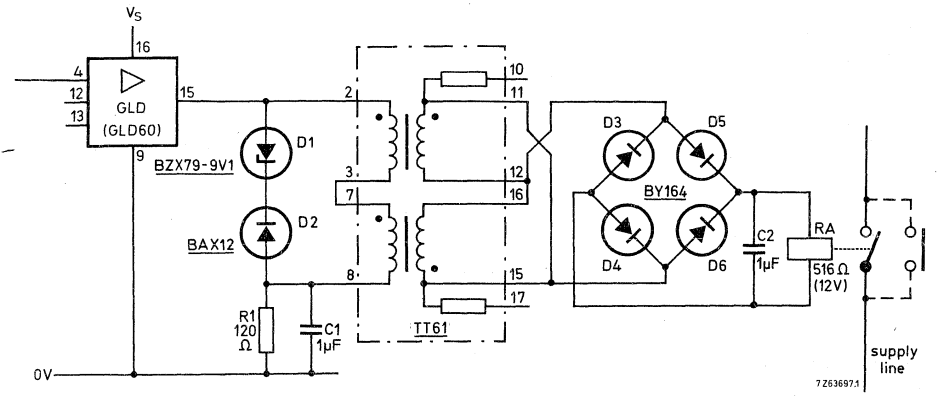


Fig. 8

The high frequency square wave output can also be fed via a transformer to a rectifier, see Fig. 8. Thus only a square wave output will cause a d.c. voltage which can be used to activate a relay. Any malfunction in the whole system will cause the relay to fall off and thereby switch the system to be controlled to a safe condition.
Note that if only one twin channel system has to be monitored or safeguarded the resistor of 1,5 kΩ and external diode BAX13 (Fig. 7) can be replaced by R2 and the voltage regulator diode inside unit U1.
The square wave interrogating signal fed to the monitor circuit should be symmetrical and vary between $V_S/3$ and V_S. Fig. 9 shows a suitable generator. The symmetry and the frequency are adjusted by means of the 10 kΩ potentiometer and the capacitor C respectively. Cycle time T = 1,5C ms approximately (C in µF).

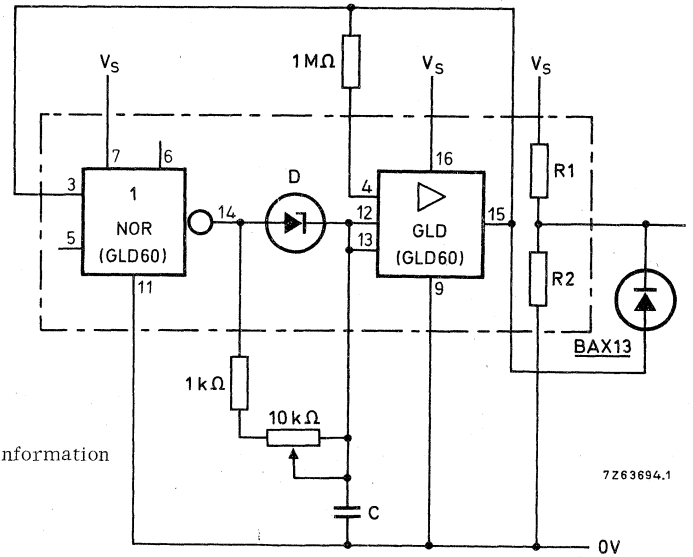


Fig. 9
Extended application information is given in A.I. 348.

61-Series NORbits

INTRODUCTION

The units of the 61-Series have been designed as an extension to the NORbit range in order to facilitate using NORbits in thyristorized power control circuits. By doing so, designers can cut system costs considerably: for one thing, the number of external components necessary will be reduced to a bare minimum, for another, mounting costs can be kept low as all units are housed in the NORbit size A encapsulation, and thus fit into a UMC60 chassis or can be fixed on the special printed-wiring boards for the 60-Series.
Furthermore, all units in the 61-Series offer the same outstanding features as those of the 60-Series, the chief ones being:

- high noise immunity
- rugged encapsulation with rigid terminals
- ample accessories
- single-rail 24 V $\pm$ 25% supply (except the DOA61)

The following units are available:

2.NOR61	Dual NOR-gate with diode-resistor networks
RSA61	Rectifier and synchronization assembly
UPA61	Universal power amplifier
DOA61	Differential amplifier
TT61	Dual thyristor trigger transformer,

For extended application information, see Application Book over the "61-Series".

Wiring Layout Stickers for the 61-Series are available under catalogue number 4322 026 71981.

UNIVERSAL POWER AMPLIFIER

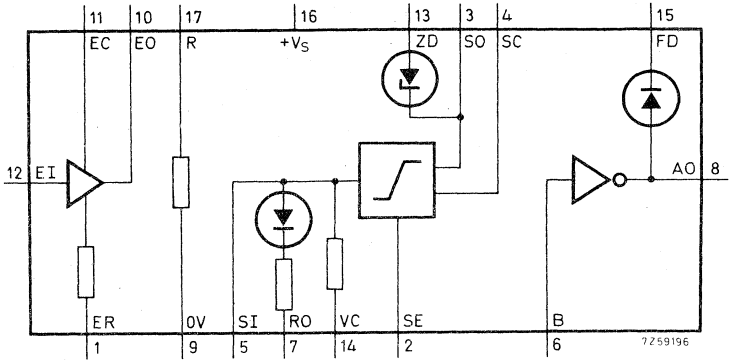
Function

1. D.C. switching amplifier.
2. Power oscillator for driving thyristor trigger transformers.
3. Phase shift module.
4. Current source for linear capacitor discharging.

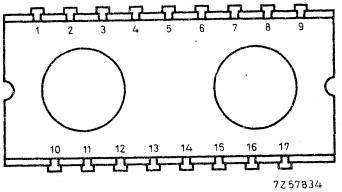
Case

Size: A; Colour: black.

CIRCUIT DATA



Quick reference circuit diagram

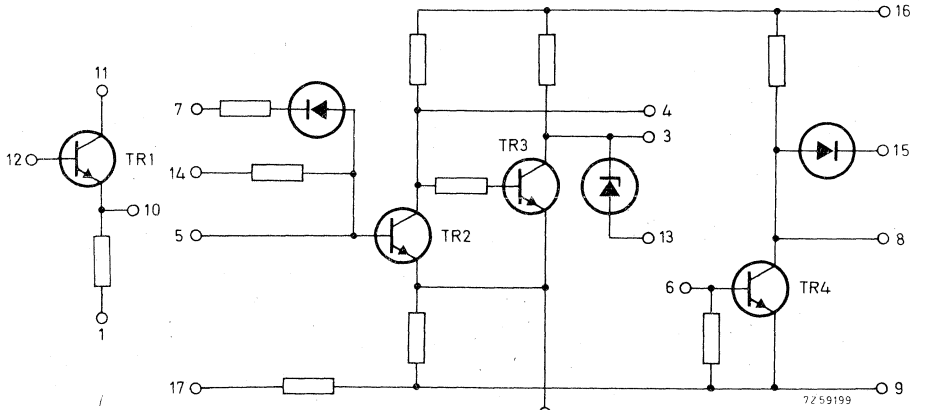


Terminal location

1 = emitter resistance follower
2 = emitter output Schmitt trigger
3 = output Schmitt trigger
4 = complementary output Schmitt trigger
5 = Schmitt trigger base input
6 = power stage base input
7 = oscillator feedback input
8 = power stage output
9 = 0 V common
10 = output emitter follower
11 = collector emitter follower
12 = base emitter follower
13 = restored "0" output Schmitt trigger
14 = input Schmitt trigger
15 = damping diode power stage
16 = supply voltage $+V_S$
17 = auxiliary resistor

Notes

1. For applications as a power amplifier with a min. permissible load resistance of 90 Ω, connect pin 13 to pin 6. A "1" at pin 14 will switch on the load between pins 8 and 16.
2. For applications as a power amplifier with a min. permissible load resistance of 30 Ω, connect pin 12, 13, 17 and 1 together, connect pin 10 to 6, and connect pin 11 to V_S via a resistor of 330 Ω, (2,5 W).
   A "1" at pin 14 will switch on the load between pin 8 and 16.
3. The load should be connected between pins 8 and 16. To avoid destruction resulting from large voltage peaks occurring at switching off of inductive loads, the damping diode in the circuit block has to be connected across the load (15 to 16).
4. Incandescent lamps have a "cold" resistance that is only a fraction of the value calculated from nominal voltage and current, so that turning on of the lamp may cause a surge current. It is advisable to use a pre-heating quiescent current to eliminate destructive surge currents.



Circuit diagram

CHARACTERISTICS

Pins 6 and 13 connected, unless otherwise specified.

Supply	at V_S = +24 V ± 25%	at V_S = +12 V ± 5%
Supply current at I_{load} = 0 mA	≤ 110 mA	≤ 9 mA
Supply current at "1" input (pin 14) *) V_S = 30 V, R_{load} = 30 Ω	1100 mA	

*) Connections as in Note 2 above.

Input	at V_S = +24 V ± 25%	at V_S = +12 V ± 5%
Drive at pin 14 for switching on load current	2 D.U.	2 D.U.
Input impedance at pin 14	92 kΩ	92 kΩ
Input voltage for switching on load current at pin 5 **)	≥ 8.2 V	≥ 4 V
at pin 14	≥ 11.4 V	≥ 5.3 V
Input voltage for switching off load current at pin 5 **)	≤ 1.6 V	≤ 1 V
at pin 14	≤ 1.8 V	≤ 1.2 V
On-off input voltage difference, R_{source} = 2200 Ω, at pin 5	≤ 4.8 V	≤ 2.0 V
at pin 14	≤ 4.9 V	≤ 2.1 V
Max. source resistance for pin 5	250 kΩ	
for pin 14	200 kΩ	
Output		
Min. load resistance - connections Note 1	90 Ω	
- connections Note 2	30 Ω	
Output voltage at "1" input at min. load resistance - connections Note 1	≤ 0.3 V	
- connections Note 2	≤ 1.3 V	

Switching speed.

Switch off delay at 625 mA and 10 H with pin 15 connected to 16	t_d		480 ms
Fall time) connected as in Note 2	t_f	≤	0.5 μs
Rise time) R_L = 30 Ω, V_S = 30 V	t_r	≤	10 μs

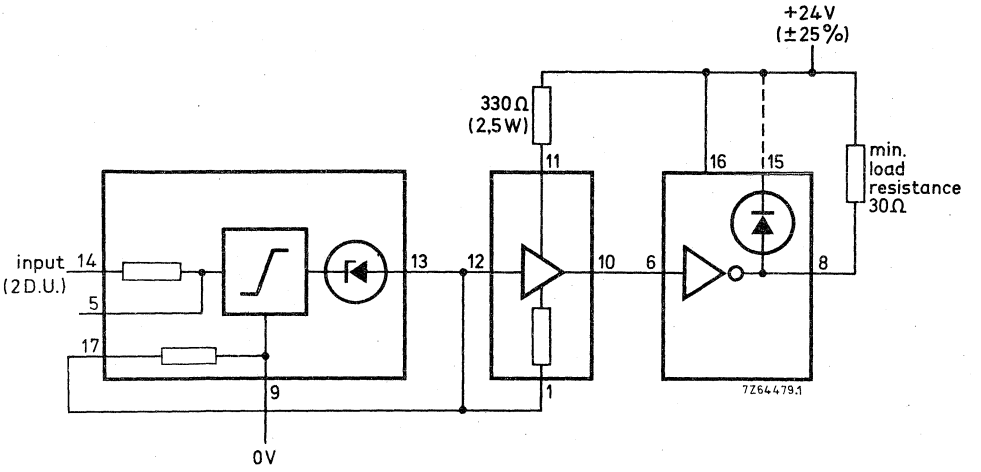
LIMITING VALUES

Supply voltage	V_S	max.	30 V
		min.	0 V
Positive transient on V_S, for 10 μs		max.	10 V
Input voltage at pin 14	$+V_{14}$	max.	70 V
	$-V_{14}$	min.	0 V
Input voltage at pin 5	$+V_5$	max.	30 V
via min. 2200 Ω	$-V_5$	min.	0 V
Output current for 20 ms		max.	5 A
for 20 ms each second		max.	2 A

*) Connections as in Note 2
**) Via min. 2200 Ω

APPLICATION INFORMATION

UPA61 as 30 ohms load power amplifier.



DUAL TRIGGER TRANSFORMER

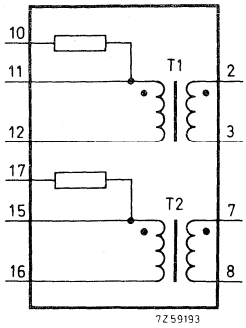
Function

Matching the pulse output from a power amplifier (e.g. UPA61) to thyristor gates.

Case

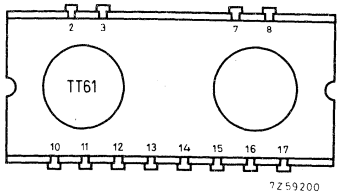
Size A; colour: black.

CIRCUIT DATA



Circuit diagram

2. Secondary winding T_1 (cathode thyristor)
3. Secondary winding T_1 (gate thyristor)
7. Secondary winding T_2 (cathode thyristor)
8. Secondary winding T_2 (gate thyristor)
10. Resistance connected to primary winding T_1
11. Primary winding T_1 (driving source)
12. Primary winding T_1 ($+V_S$)
13. Not connected
14. Not connected
15. Primary winding T_2 (driving source)
16. Primary winding T_2 ($+V_S$)
17. Resistance connected to primary winding T_2



Terminal location

CHARACTERISTICS

Frequency range	3 to 50 kHz [1]
Turns ratio primary: secondary	3 : 1
Inductance of primary winding	≥2, 2 mH
Leakage inductance referred to primary (secondary short-circuited)	≤ 65 µH
Primary winding resistance at T_{amb} = 25 °C	≤ 4 Ω
Primary series resistor	82 Ω
Secondary winding resistance at T_{amb} = 25 °C	≤ 0, 6 Ω
Output pulse in response to step input, circuit of Fig. 3, R_{eq} = 15 Ω:	
rise time (from 0, 3 to 3 V)	≤ 0, 6 µs
pulse duration, V_{pulse} = 3 V [1]	≥ 20 µs
Output current[2] at pins 2/3 (7/8) at T_{amb} = 25 °C in response to step input at pins 10/12 (16/17) (see Fig. 3):	
V_s = 18 V, R_{eq} = 15 Ω	≥200 mA
R_{eq} = 22 Ω	≥135 mA
V_s = 30 V, R_{eq} = 10 Ω	≥425 mA
R_{eq} = 15 Ω	≥320 mA

LIMITING VALUES

Primary switched voltage across pins 10/12 (17/16)	max. 30 V [3]
Primary switched current	
no series resistor, duty cycle 1 : 3 max.	max. 800 mA
82 Ω internal, duty cycle 1 : 3 max.	max. 170 mA
39 Ω external, duty cycle 1 : 2 max.	max. 200 mA
ET product per transformer primary at pins 11, 12 or 15, 16	600 Vµs
Peak pulse power per transformer for duty cycle 1:3, and T_{amb} = 25 °C [1]	17 W
D.C. test voltage between any pair of windings for 1 minute	4 kV
Continuous r.m.s. working voltage	max. 500 V

1) The minimum frequency has been specified with a view to core losses.
2) Minimum mean pulse magnitude over 20 µs.
3) If the UPA61 ceases to oscillate with the output transistor conducting, the primary series resistor may be damaged; circuit design must safeguard against this condition.

APPLICATION INFORMATION

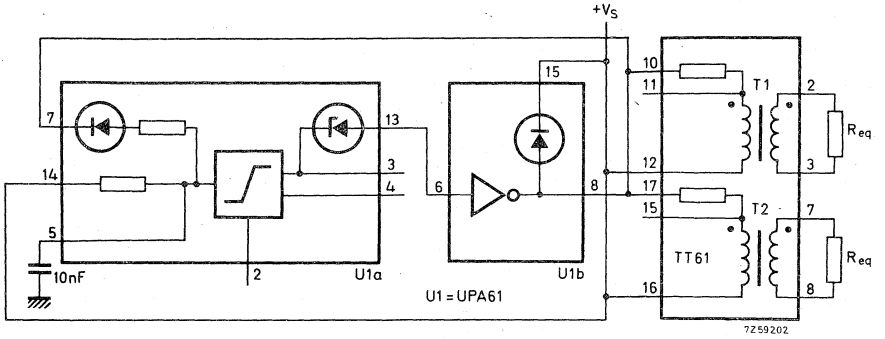


Fig. 3 Low power relaxation oscillator circuit (10 kHz)

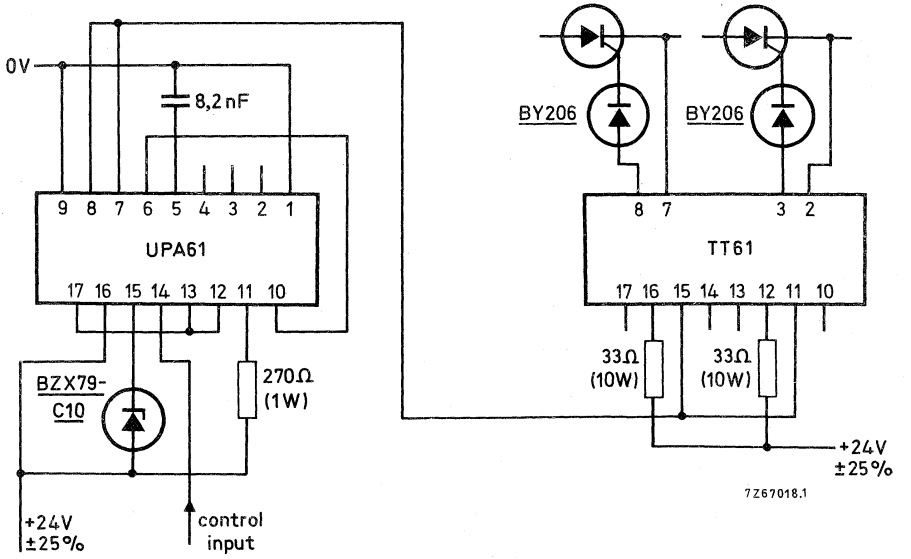


Fig. 4a High power relaxation oscillator circuit (10 kHz)

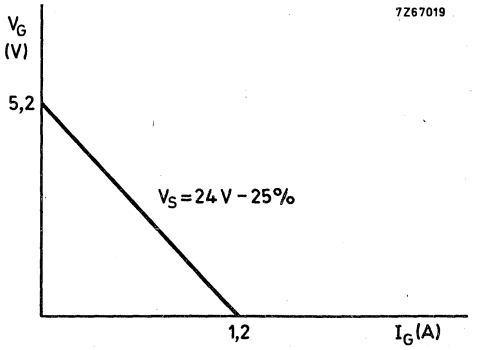


Fig. 4b Gate cathode thyristor voltage versus gate thyristor current

RECTIFIER AND SYNCHRONIZATION ASSEMBLY

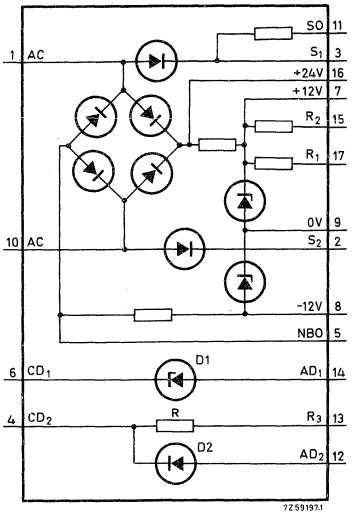
Function

- To provide an unregulated voltage of +24 V for Norbit systems
- To provide synchronization signals.
- To provide +12 V and −12 V (zener stabilized) for servo amplifiers.

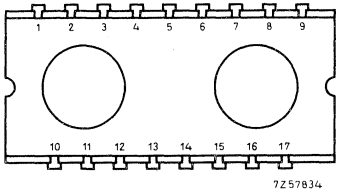
Case

Size: A; colour: black

CIRCUIT DATA



Circuit diagram



Terminal location

1 = A.C. input from supply transformer
2 = Synchronization voltage
3 = Synchronization voltage
4 = Cathode D_2
5 = Output rectifier bridge
6 = Cathode D_1
7 = +12 V output voltage
8 = −12 V output voltage
9 = 0 V from common supply
10 = A.C. input from supply transformer
11 = Synchronizing resistor output
12 = Anode D_2
13 = Resistor output cathode D_2
14 = Anode D_1
15 = +12 V, 150 kΩ source
16 = +24 V output voltage
17 = +12 V, 100 kΩ source

CHARACTERISTICS

Input

A.C. input voltage (r.m.s.)	2 x 20 V (+10, −15%)
A.C. input current	375 mA max.
Frequency	50 - 60 Hz
Source resistance	1 Ω min.
	4 Ω max.

Outputs

Pin number (9 connected to c.t. transformer)	Voltage	Current
16	+18 to +30 V	≤ 220 mA
7	+11 to +15 V	≤ 8 mA
8	−11 to −15 V	≤ 4 mA

In order to obtain the outputs specified, smoothing capacitors are required:

1. a 680 μF (−10, +50%), 40 V, capacitor connected between pins 16 and 9 to smooth the +24 V and +12 V.
2. a 100 μF (−10, +50%), 40 V, capacitor connected between pins 5 and 9 to smooth the −12 V.

Additional components

R : 2.2 kΩ; max. voltage 30 V r.m.s.

D_2 : max. reverse voltage 30 V;
max. forward current 200 mA

D_1 : nom. zener voltage 6.8 V;
max. dissipation 60 mW

LIMITING VALUES

Input voltage	2 x 22 V r.m.s.

APPLICATION INFORMATION

1. The output current of the −12 V output can be increased to 7 mA by connecting pin 4 to 5 and pin 8 to 13.
2. A mains synchronization signal is available at pin 11 when pins 3 and 2 are joined. The output at pins 2 and 3 takes the form of a zero voltage when the a.c. driving voltage passes through zero. At all other times a positive voltage is present on pins 2 and 3.

DUAL NOR-GATE WITH DIODE-RESISTOR NETWORKS

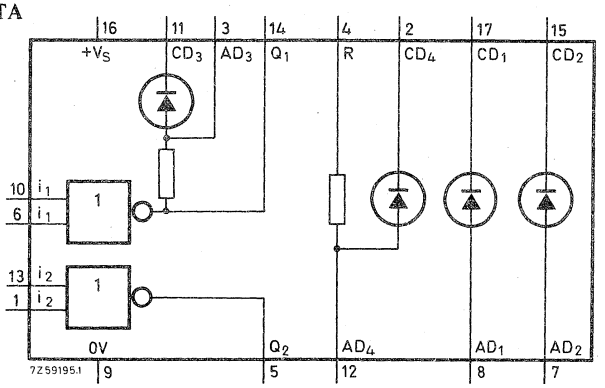
Function

Dual two-input transistor-resistor NOR-gate with diode gating facilities incorporated; specifically applicable as a d.c. counting/shifting stage.

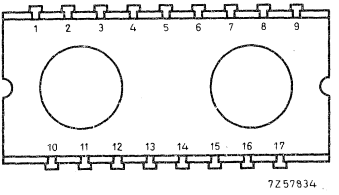
Case

Size: A; colour: black.

CIRCUIT DATA

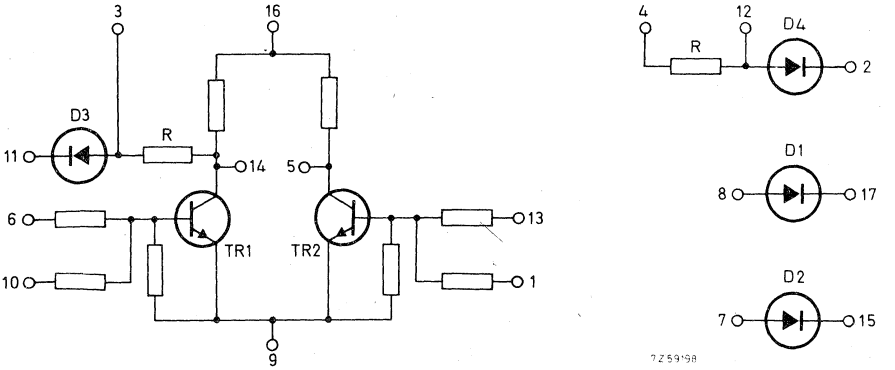


Quick reference circuit diagram



Terminal location

1 = Input NOR 2
2 = Cathode diode D_4
3 = Anode diode D_3
4 = Gate resistor
5 = Output NOR 2
6 = Input NOR 1
7 = Anode diode D_2
8 = Anode diode D_1
9 = 0 V common supply
10 = Input NOR 1
11 = Cathode diode D_3
12 = Anode diode D_4
13 = Input NOR 2
14 = Output NOR 1
15 = Cathode diode D_2
16 = $+V_S$ supply for NOR 1 and NOR 2
17 = Cathode diode D_1



Circuit diagram

CHARACTERISTICS

NOR-gate	at V_S = 24 V ±25%	at V_S = 12 V ±5%
Supply current at V_S nom	5.6 mA	2.8 mA
at V_S max	7.2 mA	3.1 mA
Input requirement	2 D.U.	2 D.U.
Output capability	10 D.U.	6 D.U.

	pins 6, 13	pins 10, 1	pins 6, 10 and 13, 1 in parallel
Input impedance [1]	63 kΩ	47 kΩ	32 kΩ
Input current for "0" output [1] [2]	92 μA	86 μA	75 μA

Switching speed

Fall time	$t_f \leq 1.5$ μs
→ Fall delay time	$t_{fd} \leq 6$ μs

Diode-resistor networks

Resistors R (22 kΩ) can be used as a load of 4 D.U. in a logic Norbit system.

[1]) Not used inputs returned to 0-volt line .
[2]) At V_S = 30 V

LIMITING VALUES

Supply voltage	V_S	max.	+30	V
		min.	0	V
Positive transient on V_S		max.	10	V for 10 μs
Positive input voltage	$+V_i$	max.	70	V
Negative input voltage	$-V_i$	max.	15	V
Reverse voltage of diodes		max.	50	V
Forward current of diodes		max.	75	mA
Repetitive peak forward current of diodes		max.	150	mA
Dissipation of resistor R		max.	50	mW

DIFFERENTIAL AMPLIFIER

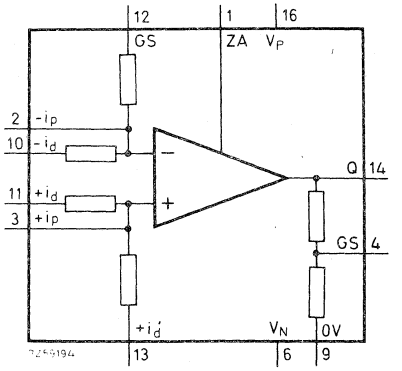
Function

Amplification, loop shaping and comparison with reference signals in analogue closed-loop systems. Many other applications are possible with the operational amplifier incorporated.

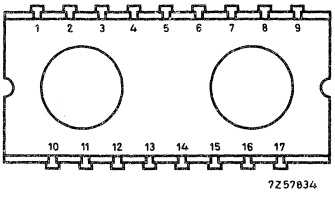
Case:

Size: A; colour: black

CIRCUIT DATA



Quick reference circuit diagram



Terminal location

1 = zero output voltage adjustment
2 = inverting input operational amplifier
3 = non-inverting input operational amplifier
4 = gain selection (100 x)
5 = n.c.
6 = negative supply voltage V_N
7 = n.c.
8 = n.c.
9 = 0 V common
10 = inverting input difference amplifier
11 = non-inverting input difference amplifier
12 = gain selection (10 x)
13 = 100 kΩ non-inverting input operational amplifier
14 = output and gain selection
15 = n.c.
16 = positive supply voltage V_p
17 = n.c.

CHARACTERISTICS

Ambient temperature range

Operating	0 to +70 °C
Storage	−40 to +85 °C

Power Supply

Supply voltages	V_p = +12 V V_N = −12 V	V_p = +15 V V_N = −15 V
Supply currents for I load = 0 mA	I_p = 2.2 mA I_N = 2.2 mA	I_p = 2.7 mA I_N = 2.7 mA

The circuit has been protected against reverse connection of supply voltages.

Voltage gain

With feedback, from input (pin 10) to output (pin 14)		
a. pin 12 connected to pin 14	10 x	
b. pin 12 connected to pin 4	100 x	
Without feedback, from input (between pins 2 and 3) to output (pin 14) - typical	32 000	45 000

Frequency response

The operational amplifier has a frequency response of 6 dB/oct, with unity gain bandwidth (for small signals)	1 MHz
3 dB down frequency for gains of 10 and 100 (at rated output voltage swing)	10 kHz

Rejection ratio

Connected as a difference amplifier with gain of 10 (inputs pin 10 and 11)	
- of supply voltage variations	to be established
- of common mode signals	to be established

Input

Minimum input voltage range, when connected as a difference amplifier with a gain of 10 (input pins 10 and 11)

common mode	± 7 V	± 10 V
differential voltage (for zero common mode voltage)	± 17 V	± 20 V

Circuit has been protected against too high voltages between the inputs of the operational amplifier.

Input resistance

-inverting input (pin 10)	10 kΩ
-non-inverting input (pin 11)	110 kΩ

Input voltage offset

Initial offset can be adjusted to zero with a potentiometer of 100 kΩ connected between 0 V line and positive supply voltage and the wiper connected to pin 1.

Equivalent input voltage offset drift with temperature (typ.)	10 μV/degC

Output

Minimum output voltage swing

at R_L = 10 kΩ	± 9 V	± 11 V
at R_L = 2 kΩ	± 7 V	± 9 V
Output current	≥ 5 mA	≥ 6 mA

Output resistance	
for a gain of 10	≤ 0.3 Ω
for a gain of 100	≤ 3 Ω
Maximum capacitive load	1 nF
Slewing rate (change of output voltage in response to step input voltage)	to be established

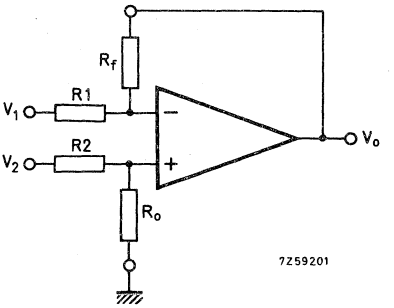
The output may be shorted to earth for any length of time.

APPLICATION INFORMATION

As shown, the DOA61 consists of an operational amplifier and feedback networks for closed loop gains of 10 and 100 times. Other gains can be obtained by applying one or more external resistors.

According to operational amplifier theory the transfer function of an amplifier with feedback networks as shown in the circuit diagram is given by

$$V_o = V_2 \frac{R_o}{R_1} \cdot \frac{R_1 + R_f}{R_o + R_2} - V_1 \frac{R_f}{R_1}$$ (See circuit below)



For $\frac{R_o}{R_2} = \frac{R_f}{R_1}$ the function can be simplified to: $V_o = \frac{R_f}{R_1} (V_2 - V_1)$

Networks incorporated into the circuit block are providing a difference amplifier, with a gain of 10 x.

Accessories for NORbits

SURVEY

MODULES

TT60 2722 032 00051	Dual thyristor trigger transformer for producing, in conjunction with a UPA60, two pulse currents of up to 400 mA.	
	Turns ratio pr. : sec. : sec.	3 : 1 : 1
	Dimensions (incl. pins)	34 x 34 x 49 mm
DCT61 9360 000 40000	Direct current transformer provides the linear conversion of a high d.c. current to a low d.c. voltage.	
	Input current range	0 to 160 A
	Output voltage range	0 to 15 V
	Dimensions	80 x 30 x 56 mm
SIM60 4322 026 38301	Logic simulator for 60-Series NORbits	
	Supply voltage	117/220/240 V; 50 or 60 Hz
	Housing	attaché case, 415 x 310 x 95 mm

POWER SUPPLY UNITS

LSU60 4322 000 01000 4322 000 01010	Power supply unit for small logic systems with 60-Series NORbits, to be built in chassis UMC60.	
	Input 01000 version	220 V, 45-400 Hz
	Input 01010 version	110 V, 45-400 Hz
	Output (d.c.)	150 mA, >18 V; 0 mA, <30 V
	Board dimensions	90 x 83 mm
PSU60 2722 151 00041 PSU61 2722 151 00051	Power supply units for 60-Series NORbits.	
	Input	240 V, 47-440 Hz
	Output (d.c.)	500 mA, >18 V; 0 mA, <30 V
	Extra d.c. output PSU61	100 V, 25 mA
	Dimensions	146 x 76 x 77 mm

MAINS FILTERS

MF 0,5 A 9390 213 00002	Mains filter for control systems consuming less than 0,5 A a.c.	
	Attenuation 0,1 - 10 MHz	50 dB
	A.C. limits	250 V, 0,5 A
	Dimensions	88 x 38 x 39 mm
MF 2,4 A 9390 253 30142	Mains filter for control systems consuming less than 2,4 A a.c.	
	Attenuation 0,5 - 10 MHz	40 dB
	A.C. limits	250 V, 2,4 A
	Dimensions	105 x 62 x 44 mm

CHASSIS AND HOLDERS

BB60 9390 198 00002	Breadboard block to hold 1 size A unit and to interlock with other BB60 blocks for easy assembly of circuits for teaching purposes.	
	Dimensions	56 x 38 x 14 mm
UMC60 4322 026 38330	Universal mounting chassis for 6 size A or 3 size B blocks or combination.	
	Material	plastic
	Dimensions	245 x 95 x 28 mm

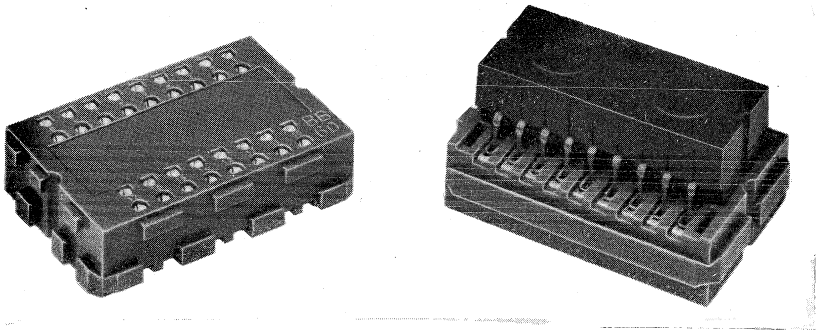
PRINTED–WIRING BOARDS

GPB60 4322 026 38600	Experimenters' printed-wiring boards	
GPB60/P 4322 026 38610	Material GPB60	glass-epoxy
	Material GPB60/P	phenol paper
	Accommodation	10 size A or 4 size B blocks
	Mating connector	F045 (0.2")
PWB60 4322 026 38790	Experimenters' printed-wiring board provided with 0 V tracks	
PWB60/P 4322 026 38800	Material PWB60	glass-epoxy
	Material PWB60/P	phenol paper
	Accommodation	10 size A blocks
	Mating connector	F047, F050, F053 (0.156")
PWB61 4322 026 38810	Experimenters' printed-wiring board provided with 0 V tracks	
	Material PWB61	glass-epoxy
	Material PWB61/P	phenol paper
	Accommodation	10 size A blocks
	Mating connector	F045 (0.2")
PWB62 4322 026 38780	Printed-wiring board with complete F054 connector, with 0 V and + tracks	
	Material	glass-epoxy
	Accommodation	4 size A or 2 size B blocks
PWB63 4322 026 73750	Printed-wiring board for use in UMC60.	
	Material	glass-epoxy
	Accommodation	6 size A or 3 size B blocks

STICKERS (drawing symbols on self-adhesive transparent material)

4322 026 36481	50 sheets of stickers for 60-Series Norbits (without 4.NOR60).
4322 026 71941	50 sheets of stickers for 60-Series Norbits (without 4.NOR60).
4322 026 71961	50 sheets of stickers for 60-Series Norbits (incl. TT60).
4322 026 71971	50 sheets of wiring layout stickers for 60-Series Norbits. Actual-size pin distances.
4322 026 71981	50 sheets of wiring layout stickers for 61-Series Norbits. Actual-size pin distances.

BREADBOARD BLOCK
for 60-series NORBITS

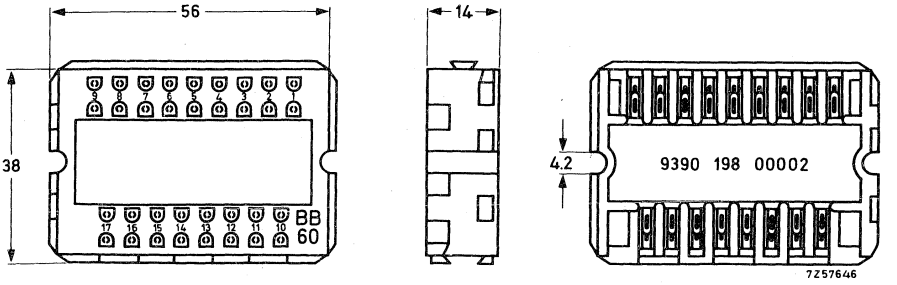


RZ 27447-18

APPLICATION

The "Breadboard Block", BB60, has been produced as an aid to 60-Series logic system design. Each block takes one size A unit from the 60-Series, and each block can be firmly locked on any of its edges to another BB60 block, thus a breadboard base can be built up to accommodate any size and complexity of logic circuit, interconnections being simply made with hook-up wire plugged into cup-shaped contacts. The BB60 blocks are ideal as experimenting and teaching aids. For instance, with four units 4. NOR60, one unit TU60 and one unit 2. LPA60 mounted on a base of six blocks BB60, it is easy to realize a large number of instructive logic circuits. Such a base of six blocks can be mounted in the Universal Mounting Chassis UMC60.

DESCRIPTION



(Dimensions in mm)

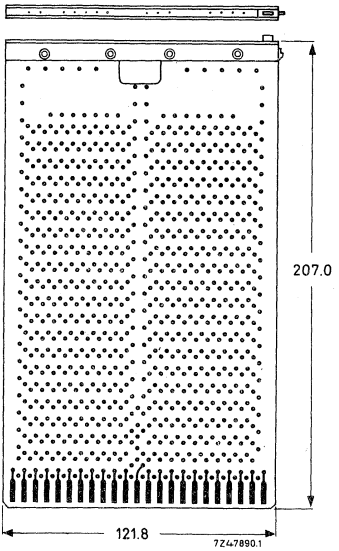
The right figure shows the underneath of the block with the 2 x 17 soldering lugs; the 60-Series units can be soldered directly onto these lugs. In the top view the cup-shaped contacts are visible; interconnecting wires or discrete components such as resistors can be plugged in on this side. There are two contacts for each terminal of a 60-Series unit, which facilitates multiple connections.

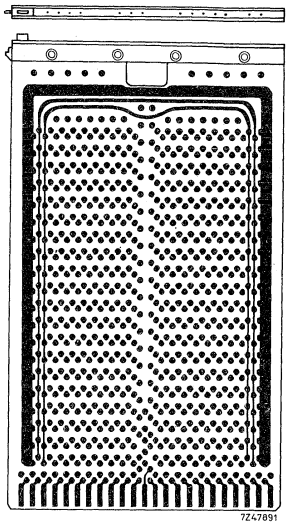
Body material	rigid grey plastic
Contacts	cup shaped, silver plated, suited for wires up to 1 mm diameter
Weight	20 g
Delivery	in packs of six, plus six sheets of wiring lay-out stickers for the 60-Series units.

The stickers are drawing symbols on self-adhesive transparent material, and they can be stuck to the top side of the breadboard blocks or be used for circuit drawings. The catalogue No. of a sheet is 9399 269 15301.

EXPERIMENTERS' PRINTED-WIRING BOARD

Experimenters' printed-wiring board (with extractor) with plated-through holes suitable for 60-Series NORbits.





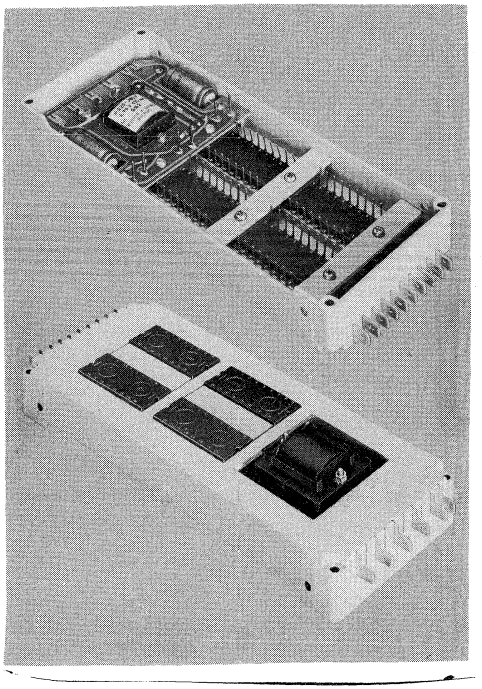
Accommodation of NORbits

size A	+ size B (HPA60)
10	0
8	1
6	2
3	3
0	4

Material of version GPB 60	glass-epoxy
of version GPB 60/P	phenol paper
Hole diameter	1,2 mm
Contacts	2x23, gold plated, pitch 0,2"
Mating connector	2422 020 52591 (type F045)

For more information, see Application Note "Printed-wiring boards for 60-Series Norbit Assemblies", No. 32/522/BE.

LOGIC SUPPLY UNIT



RZ 27077-11
RZ 27077-8

LSU60 mounted in UMC60

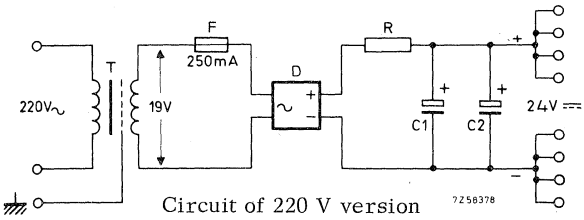
APPLICATION

The LSU60 is a power supply unit for small systems with 60-series NORbits. It is intended to be mounted in the universal mounting chassis UMC60. There is a version for 220 V mains (4332 000 01000) and one for 110 V mains (4332 000 01010).

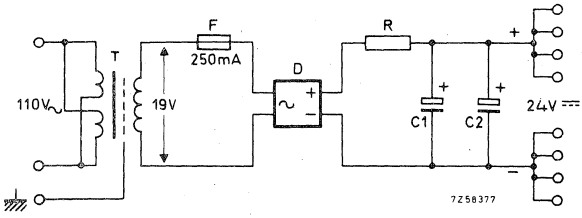
DESCRIPTION

The unit takes the same place as a size B Norbit block (HPA60). To mount the unit in the UMC60, the material between the two adjacent size A holes in the chassis should be removed, after which the unit can be fixed with 4 self-tapping screws.
Slots in the board of the LSU60 facilitate the connection of the input voltage and the output voltage to the Fastons of the UMC60, for external connection to the chassis. The other three pairs of output terminals are soldering tags intended for connection to Norbit blocks on the chassis. A 250 mA fuse (F) is inserted in the secondary part of the circuit. Its catalogue number is 4822 253 20011.

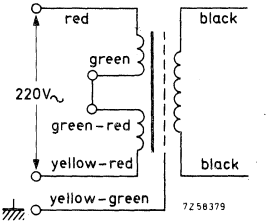
Circuit



Circuit of 220 V version



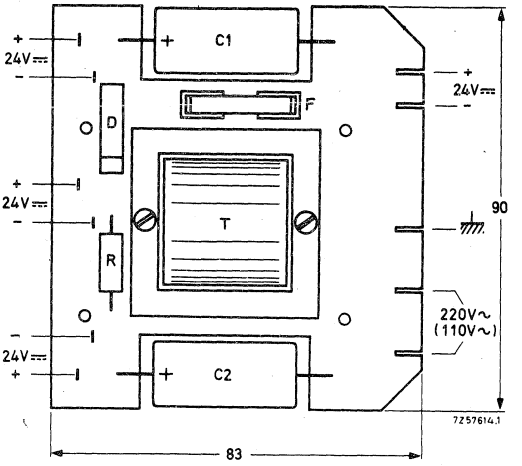
Circuit of 110 V version



Transformer of 110 V version changed for 220 V.

Outline and connections

Dimensions in mm



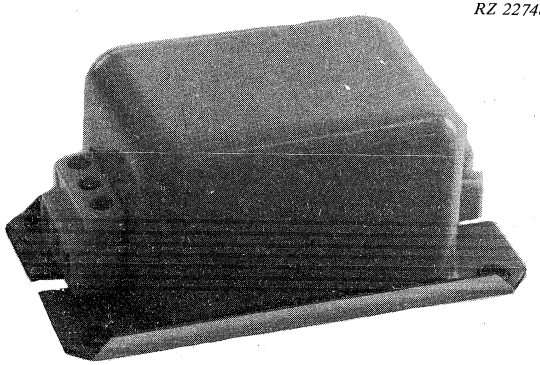
→ Weight approx 250 g

ELECTRICAL DATA

Input voltage	
version 4332 000 01000	220 V a.c., +10%, −15%
version 4332 000 01010	110 V a.c., +10%, −15%
Input frequency	45 to 400 Hz
Output voltage at 0 mA	< 30 V d.c.
at 150 mA	> 18 V d.c.
Temperature range	−10 to +70 °C
Test voltage for 1 min,	
across input terminals and earth	2 kV r.m.s.
across output terminals and earth	2 kV r.m.s.

0.5 A MAINS FILTER

RZ 22748-2



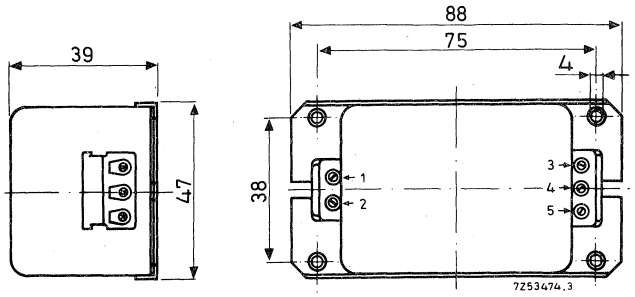
APPLICATION

This mains filter is intended for use between mains supply connection terminals and the mains inputs of control systems consuming less than 0.5 Amp. to provide an attenuation of 50 dB for frequencies between 100 kHz and 10 MHz.

CONSTRUCTION

Unit is potted in a metal housing.

Dimensions in mm



Weight: 280 g

TECHNICAL PERFORMANCE

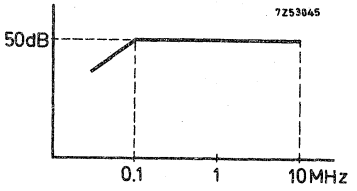
Maximum a.c. input voltage	250 V
Maximum a.c. current at T_{amb} = 40 °C at T_{amb} = 70 °C	0,75 A 0,5 A
Maximum surge current (20% duty cycle)	2,5 A
Insulation resistance between terminals and case	> 5 MΩ
Test voltages	
a) for 1 min. across terminals and case	3500 V d.c.
b) for 2 s across terminals 1 and 2, or 3 and 5	1625 V d.c.
c) for 2 s across terminals 3 and 4, or 4 and 5	1800 V a.c., 50 Hz
Operating temperature range	−25 to +70 °C
Storage temperature range	−25 to +85 °C

TEST SPECIFICATIONS

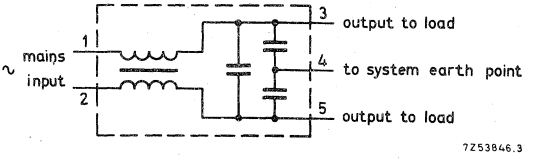
The filter has been designed to meet the tests of MIL-STD-202D

1. Thermal shock test according to method 107B, 5 cycles from −25 to +85 °C
2. Moisture resistance test according to method 106B
3. Humidity test according to method 103B, condition D 40 °C, 90 to 95% R.H.

Attenuation



Circuit diagram



2,4 A MAINS FILTER

APPLICATION

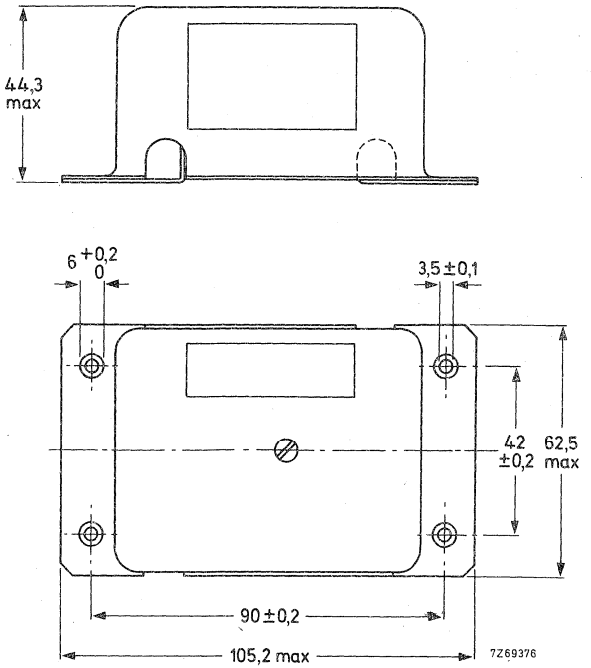
This mains filter can be used:
- either between mains supply connection terminals and the mains inputs of control systems, to suppress malfunctioning by transients,
- or between transient-generating equipment and its supply, to prevent high-frequency interference entering into the mains.

The attenuation for frequencies between 0,5 and 10 MHz, at 2,4 A supply current is 40 dB.

CONSTRUCTION

The unit is encapsulated in a metal housing.

Dimensions in mm

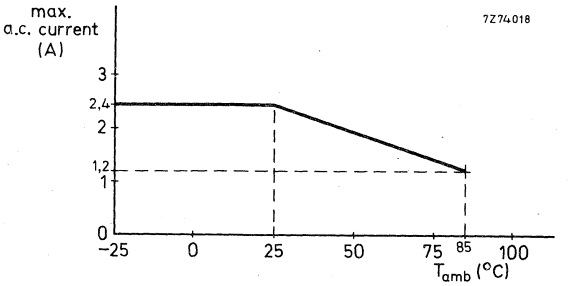


Weight: 275 g

ELECTRICAL DATA

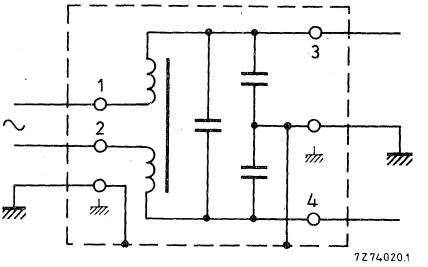
The values given below apply only to filters which are used in earthed installations.

Maximum input voltage	250 V a.c.
Maximum current at T_{amb} = 25 °C	2,4 A a.c.
at T_{amb} = 85 °C	1,2 A a.c.



Repetitive peak current, 50 Hz	≤ 10 A
Non-repetitive peak current for 2 s	≤ 10 A
Impedance at 2,4 A	0,925 Ω
Insulation resistance between terminals and case	> 5 MΩ
Test voltage	
for 2 s between terminals and case	2700 V d.c.
for 2 s between input or output terminals	1625 V d.c.
Attenuation between 0,5 and 10 MHz	> 40 dB

Circuit diagram



Operating and storage temperature range	−25 to + 85 °C

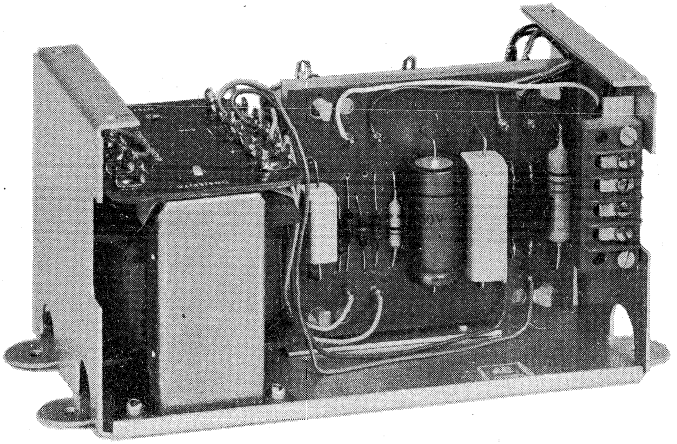
TEST SPECIFICATIONS

The filter meets the tests of MIL-STD-202E:

- thermal shock test according to method 107D, 5 cycles from −25 to + 85 °C
- moisture resistance test according to method 106D

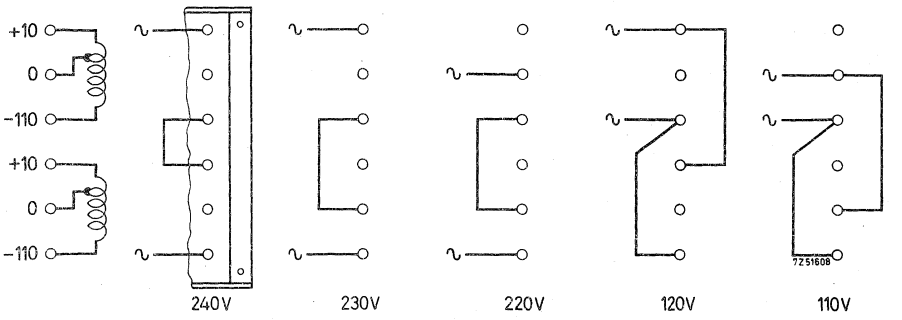
The capacitor used meets the requirements of VDE 0560-7.

POWER SUPPLY UNITS
for 60-series NORBITS

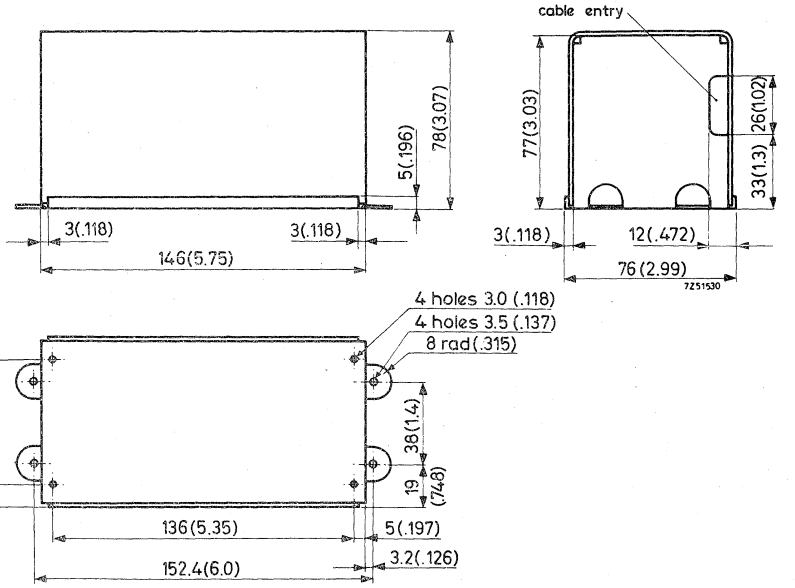


(Cap removed from unit.) RZ 23469-1

Input voltage	240, 230, 220, 120 or 100 V_{ac}, +10%, -15%
Input frequency	47 to 440 Hz
Output	< 30 V at 0 mA, > 18 V at 500 mA (for logic supply)
Additional output PSU 61	+100 V ±25% at 0 to 25 mA (for Switch Filters)
Operating ambient temperature	-10 to +60 °C
Test voltage between windings	2 kV



Input facilities of mains transformer



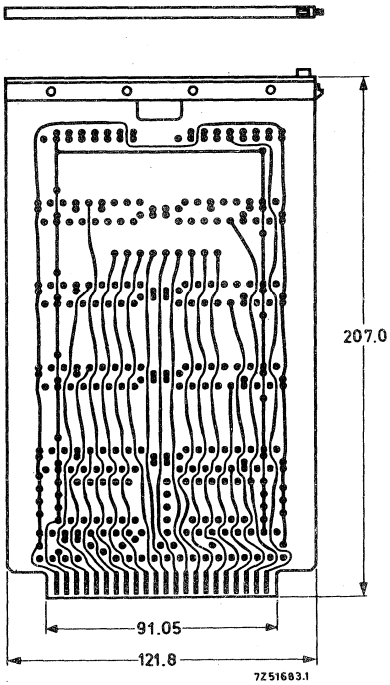
Dimensions in mm, inch values between brackets.

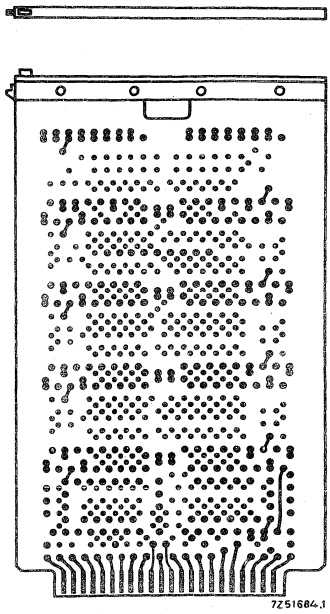
Case: aluminium

Weight: approx. 1000 g

EXPERIMENTERS' PRINTED-WIRING BOARDS
for 60-series NORBITS

Experimenters' printed-wiring boards (with extractor) with plated-through holes, and 0-volt supply line tracks for pins 9 and 16.



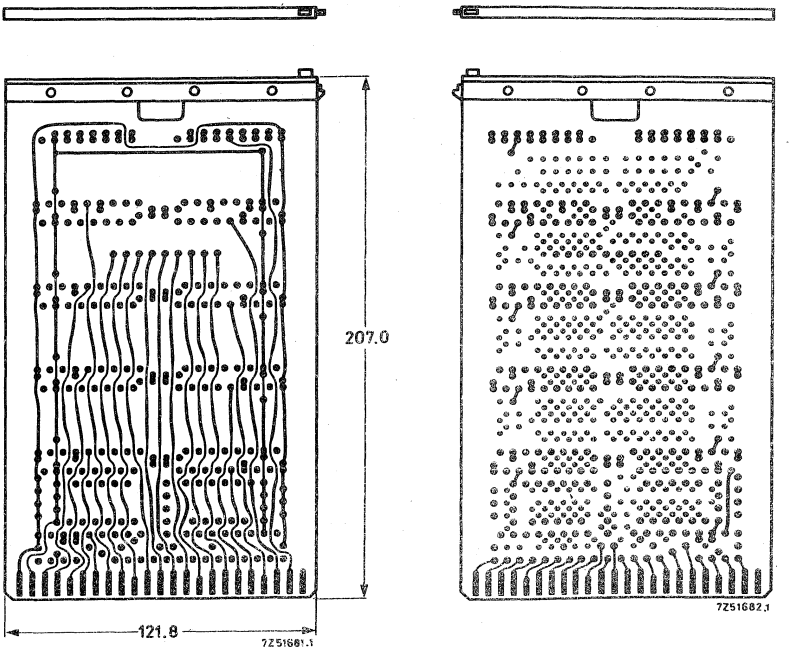


Accommodation	ten blocks size A
Material of version 4322 026 38790 of version 4322 026 38800	glass-epoxy (PWB 60) phenol paper (PWB 60/P)
Hole diameter	1.3 mm
Contacts	2x22, gold plated, pitch 0.156"
Mating connector	types F047, F050, F053

For more information, see Application Note "Printed-wiring boards for 60-series Norbit Assemblies", No. 32/522/BE.

EXPERIMENTERS' PRINTED-WIRING BOARDS for 60-series NORBITS

Experimenters' printed-wiring boards (with extractor) with plated-through holes, and 0-volt supply line tracks for pins 9 and 16.



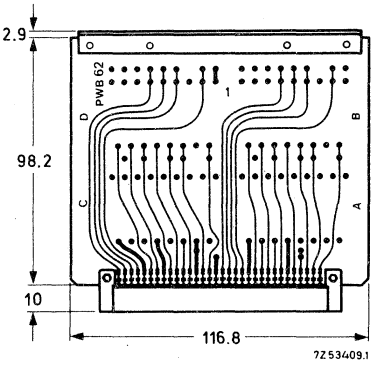
Accommodation	ten blocks size A
Material of version 4322 026 38810 of version 4322 026 38820	glass-epoxy (PWB 61) phenol paper (PWB 61/P)
Hole diameter	1.3 mm
Contacts	2x23, gold plated, pitch 0.2"
Mating connector	2422 020 52591 (type F045)

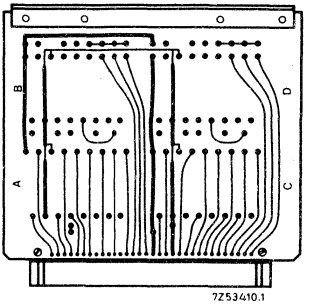
For more information, see Application Note "Printed-wiring boards for 60-series Norbit Assemblies", No. 32/522/BE.

PRINTED—WIRING BOARD
for 60—series NORBITS

Printed-wiring board with plated-through holes, extractor and complete F054 connector, of which the female part has been soldered to the board. All terminals of any Norbit mounted on the board are brought out. The 0-volt pins and the positive supply pins have been tracked together for all Norbits.

The board is especially useful for systems where a small number of types (board + blocks) is essential with a view to replacement.





Accommodation	size A + size B (HPA60)
	4 | 0
	2 | 1
	0 | 2
Material	glass-epoxy
Hole diameter	1.2 mm
Connector	
type	F054 (2422 025 89082)
contacts	2 x 32
contact pitch	2,54 mm (0,1")
terminations	suitable for mini wire-wrapping

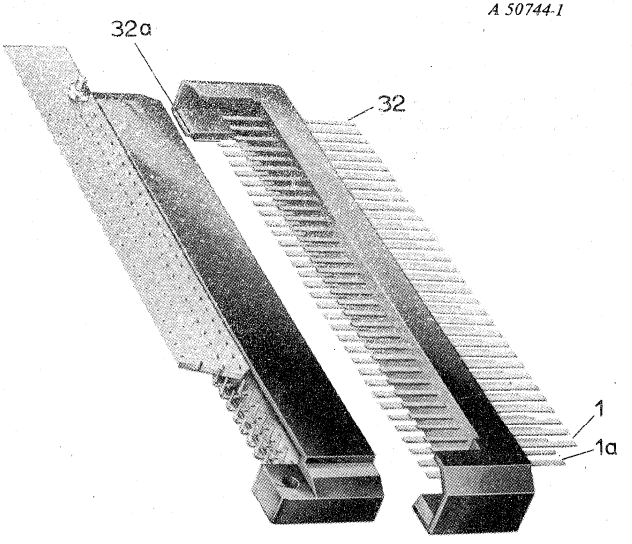
INTERCONNECTION DIAGRAM

The designer of an electronic circuit with Norbits mounted on PWB62 boards, can easily derive the necessary connecting instructions from the diagram depicted on the next page. With this diagram he can indicate the connections that are to be made. The diagram gives the numbers of the terminals of the circuit block, its position on the PWB62 and the numbers of the connector terminals (see photograph below).
The thin lines in the diagram represent the tracks of the printed circuit on the PWB62, so they indicate the interconnections between the Norbit terminals, and the connector pins.

All the designer has to do is to draw the connections which should be made by the wire man (see thick lines on the second diagram).

As an example we give an alarm circuit of which the designer has drawn the diagram in the upper part, and has indicated for the wire man on the lower part the external interconnections to be made. Moreover, outside the diagram the necessary connections to be made the supply with unit, the oscillator, switches, and so on, are indicated by the arrows.

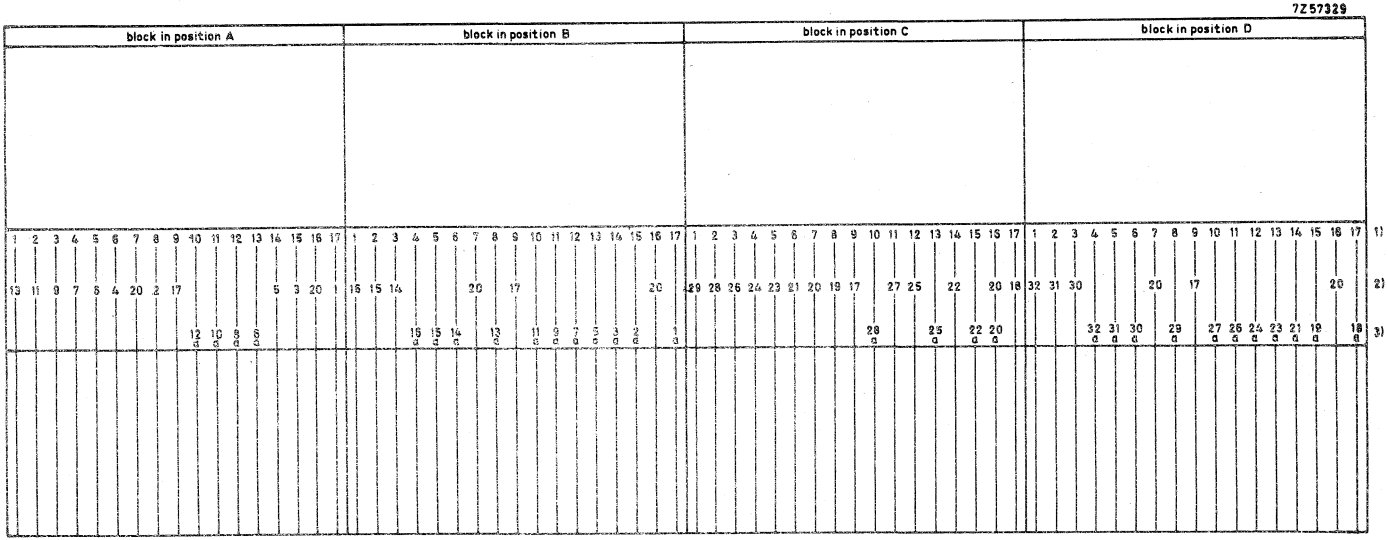
In this way the design engineer can draw the electronic circuit and the associated assembly instructions in one diagram.



Connector pin numbering as used in Interconnection Diagram.

Interconnection diagram (containing track data)

See example next page.

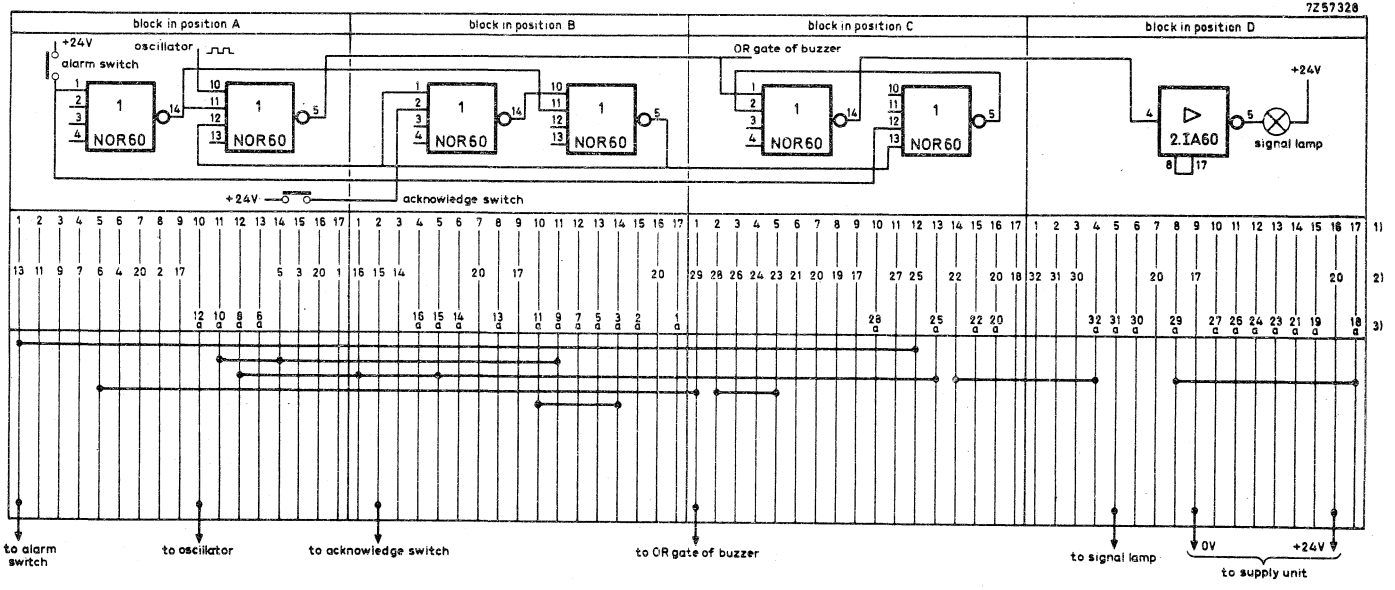


1) Terminal number of circuit block inserted in PWB62

2) Pin number of male F054 connector (see photograph) to which track on the "solder side" (bearing no type number) is connected.

3) Pin number of male F054 connector (see photograph) to which track on the "components side" (bearing type number) is connected.

Example

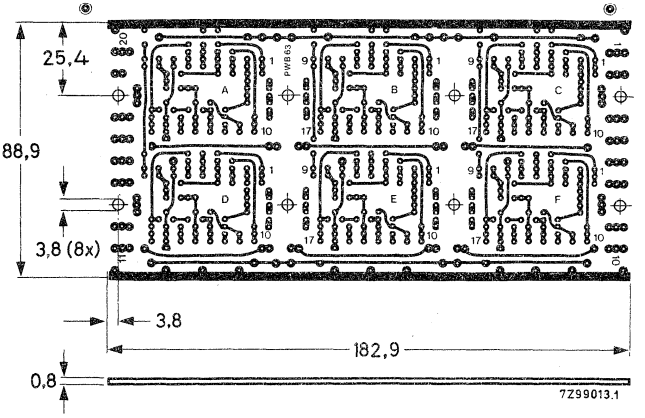


1) Terminal number of circuit block inserted in PWB62

2) Pin number of male F054 connector (se photograph) to which track on the "solder side" (bearing no type number) is connected

3) Pin number of male F054 connector (see photograph) to which track on the "components side" (bearing type number) is connected.

PRINTED-WIRING BOARD for UMC60

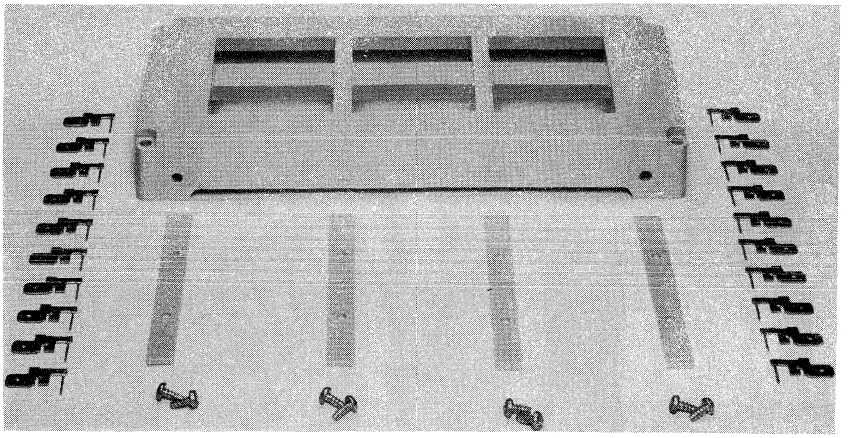


Single-sided printed-wiring board (with holes) intended for use in a Universal Mounting Chassis UMC 60.
Tracks have been laid such that only short jumpers need be used to obtain all kinds of logic functions with Norbits.

Accommodation (60-series blocks)	6 size A or 4 size A + 1 size B (HPA60) or 2 size A + 2 size B or 3 size B
Material	glass-epoxy
Board thickness	0,8 mm
Hole diameter	1,2 mm

UNIVERSAL MOUNTING CHASSIS

for 60-series NORBITS



RZ 26441-7

APPLICATION

Low cost mounting facility for:

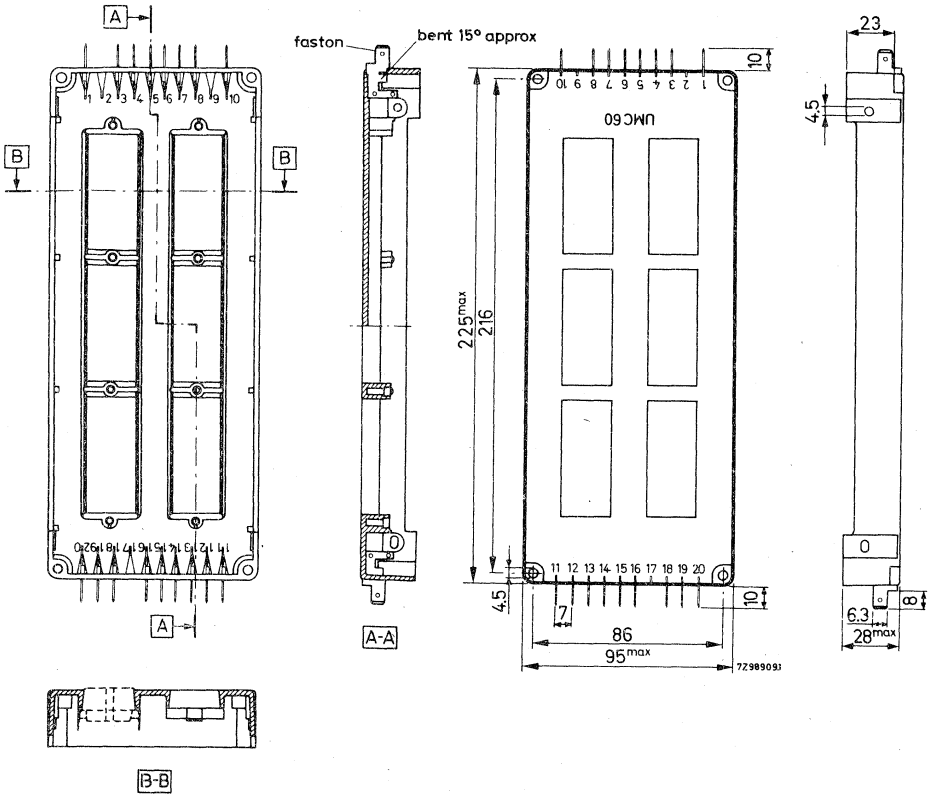
6 size A blocks,
or 4 size A blocks and 1 size B block (HPA60)
or 2 size A blocks and 2 size B blocks
or 3 size B blocks.

The chassis provides an alternative for mounting 60-series blocks on a printed-wiring board with connector.
Chassis can be bolted together side by side (Fig.4); they may also be stacked (Fig.5 and Fig.6) or hinged.

DESCRIPTION

The delivery includes a moulded polycarbonate chassis body, 4 moulded polycarbonate strips, 8 self-tapping screws and 20 standard 0.25 inch Fastons. Strips and screws are for clamping the circuit blocks into the holes in the chassis. The Fastons are for connections to the circuitry in the chassis.

To accommodate a size B block, it is necessary to remove the material between two size A holes, see Fig.1.
Interconnections between the terminal pins of the circuit blocks can be made by means of hand soldering or mini wire-wrapping; it is also feasible to use printed-wiring board PWB63 (catal. No. 4322 026 73750) in the chassis (see Fig.3).



Colour: grey

Dimensions in mm

Weight: 150 g approx.

ASSEMBLY AND USE

The Fastons are brought in from the outside of a chassis and then fixed by bending the slotted part on the inside over about 15°

The blocks are clamped into the chassis with the strips and the self-tapping screws.

For fixing two or more chassis together, 4 mm bolts and nuts may be used.

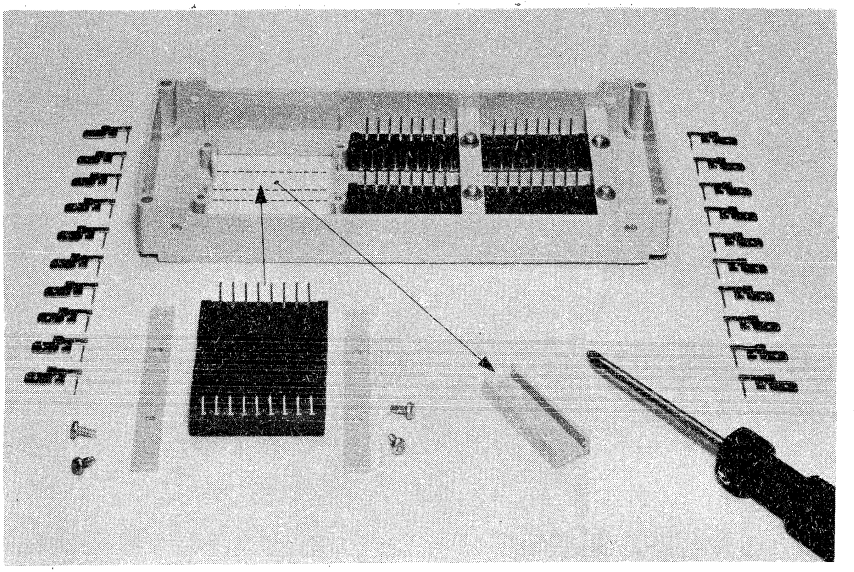


Fig.1

RZ 26441-6

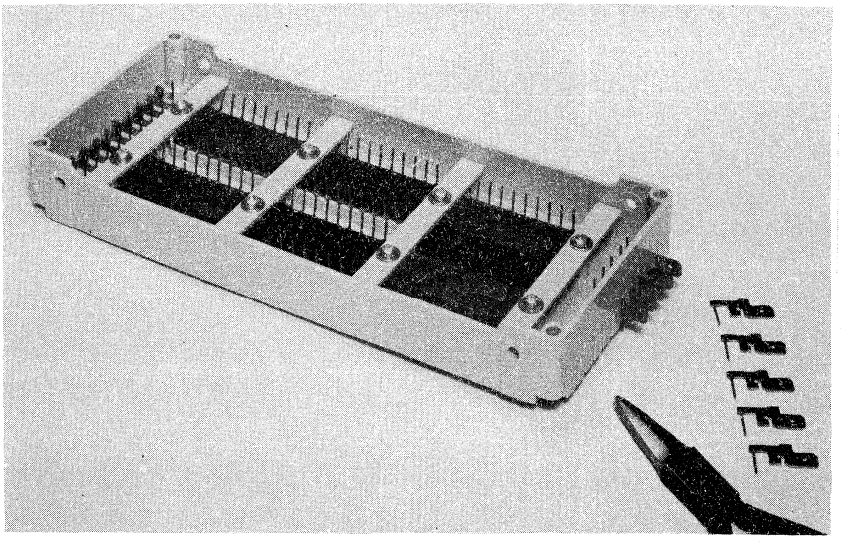


Fig.2

RZ 26441-5

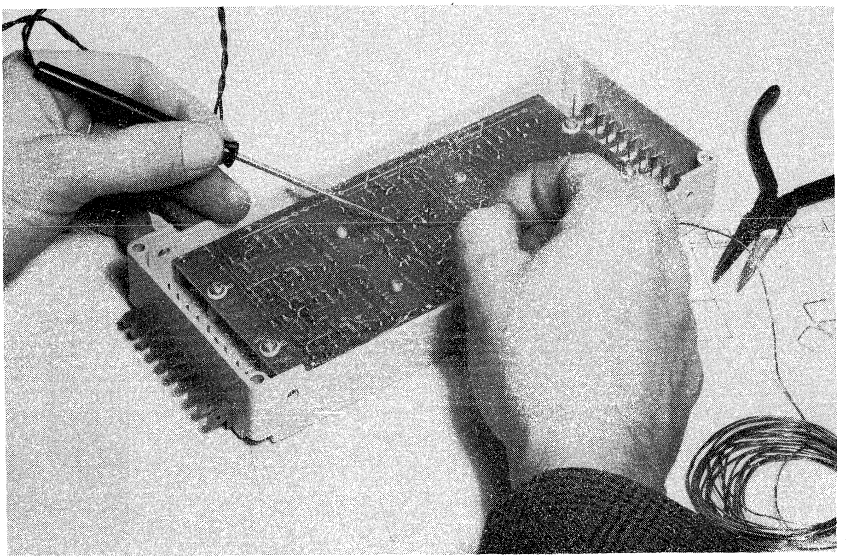


Fig.3 *RZ 26441-8*

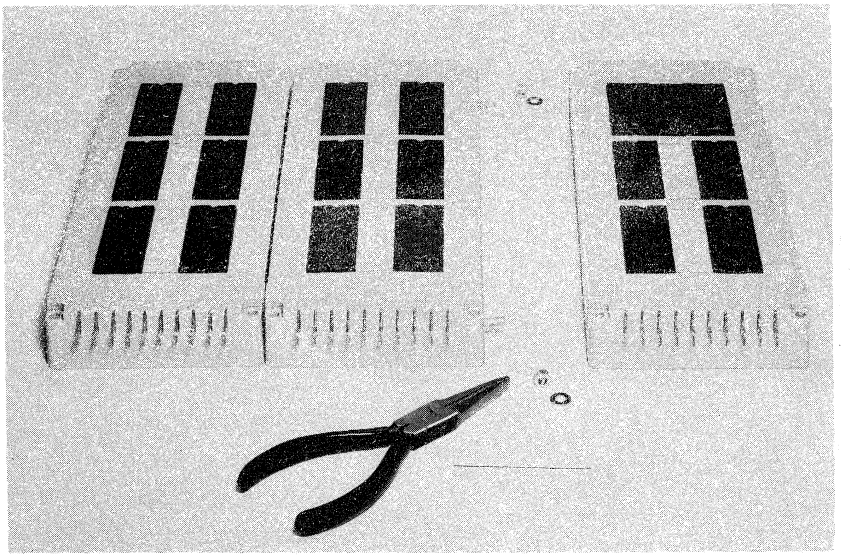


Fig.4 *RZ 26441-4*

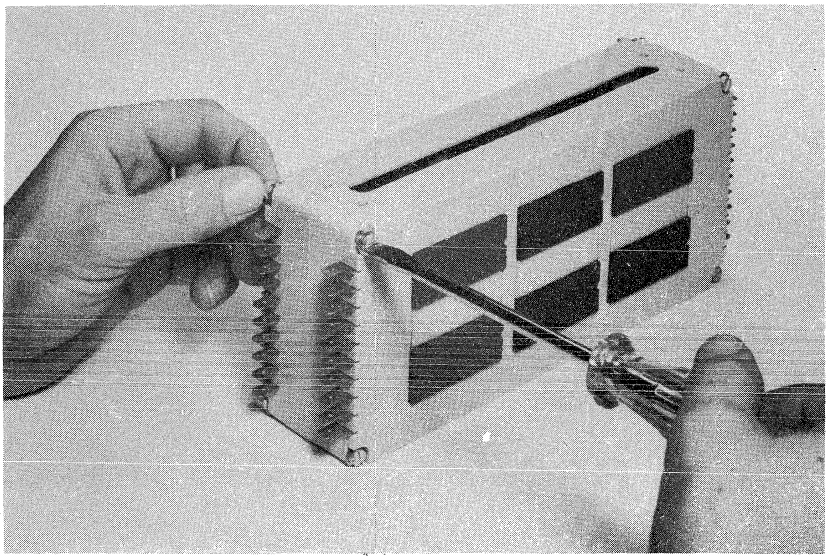


Fig.5

RZ 26441-9

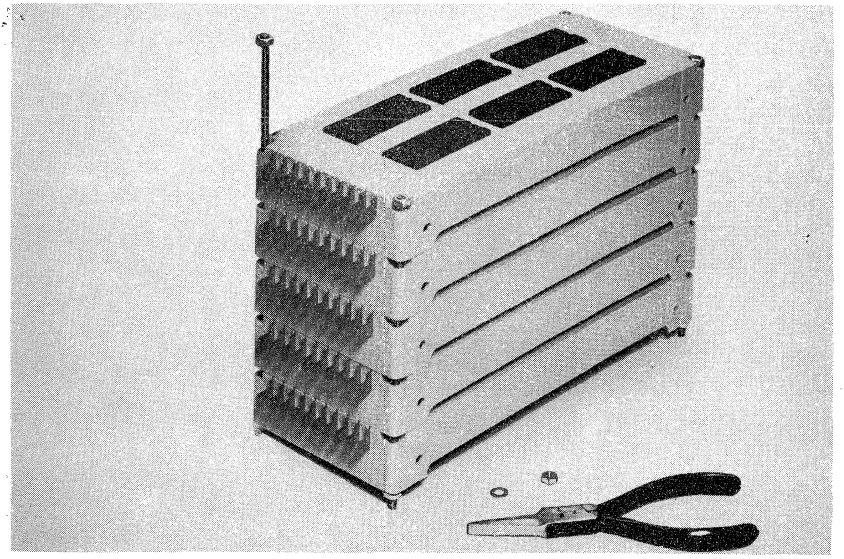
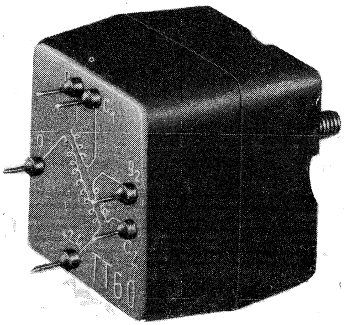


Fig.6

RZ 26441-10

THYRISTOR TRIGGER TRANSFORMER



A 51993

APPLICATION

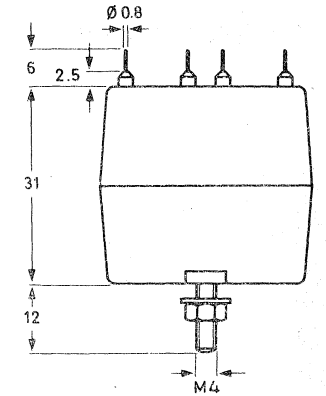
The TT60 can produce, in conjunction with the power amplifier UPA61, two pulse currents of up to 400 mA. This is sufficient gate current to trigger a pair of practically any type of thyristor.

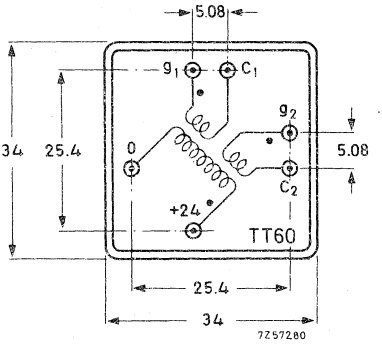
DESCRIPTION

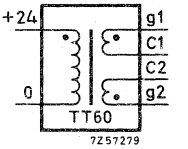
The transformer has been encapsulated in a mould.
A threaded stud permits the unit to be fixed to a support (This may be the thyristor heat sink, to obtain short gate and cathode leads).

For the hand soldering of wires to the pins 7 wire spirals, catal.No. 4022 220 64781, are packed with the transformer.

Dimensions in mm







Drawing symbol

Weight: 80 g approx.

TECHNICAL PERFORMANCE

Turns ratio primary : sec_1 : sec_2	3 : 1 : 1
Inductance of primary winding	≥ 6 mH
Leakage inductance referred to primary (both secondaries short-circuited)	≤ 18 μH
Primary winding resistance at T_{amb} = 25 °C	≤ 0.5 Ω
Secondary winding resistance at T_{amb} = 25 °C	≤ 0.1 Ω
Test voltage between the windings for 1 minute	5 kV

Output pulse in response to step input, circuit of Fig.A, R_{eq} = 13 Ω:	
rise time	≤ 0,75 μs
pulse duration	≥ 20 μs
Primary current (r.m.s.)	max. 600 mA
Primary switched current, duty cycle 1:4	max. 1800 mA
ET product primary	900 μVs
Operating ambient temperature	−10 to +85 °C
Storage temperature	−40 to +85 °C

APPLICATION INFORMATION

Pulse amplifier circuit

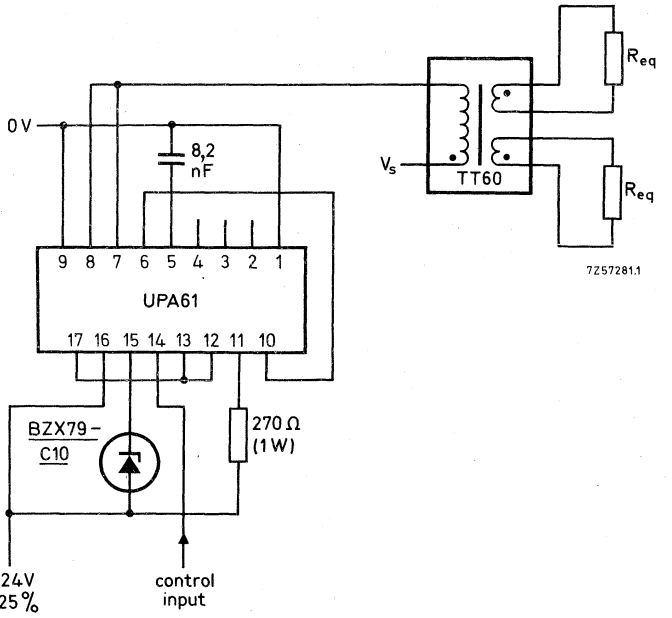


Fig. A

Power oscillator circuit

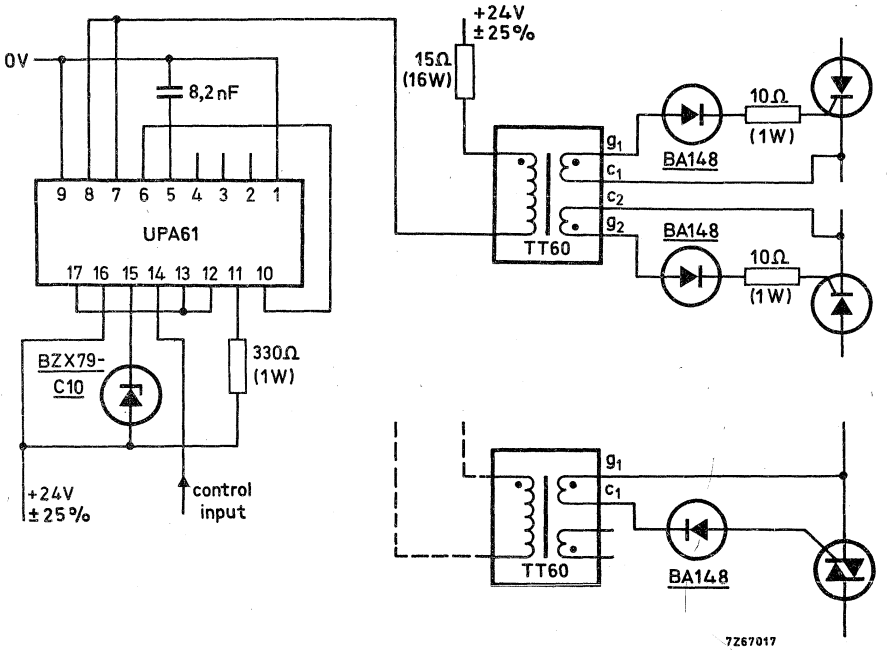


Fig. B shows the UPA61 as a 10 kHz power oscillator to trigger via TT60 a pair of thyristors or a triac.
Oscillation commences with a "high" (+ 12 V) on the control input (terminal 14 of the UPA61) ceasing when it becomes "low" (0 V).

DIRECT CURRENT TRANSFORMER

QUICK REFERENCE DATA	
Input current range	0 to 160 A
Output voltage range	0 to 15 V
Isolation voltage	5 kV
Sample frequency	5 kHz
Linearity	2%

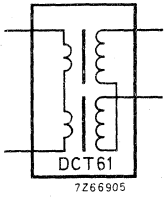
APPLICATION

When used in conjunction with the 60-series Norbit block UPA61 or GLD60 the DCT61 provides the linear conversion of a high d.c. current (up to 160A) to a low d.c. voltage (0 to 15 V) and also provides d.c. isolation between input and output.
The DCT61 is designed for use in d.c. power control circuits where it is necessary to supply information on the mains-connected d.c. load to the control circuit (low level) without forming a d.c. connection between the two parts. The ability to sample at high frequencies enables the DCT61 to produce the necessary supply information within one mains cycle (50/60 Hz).

DESCRIPTION

The DCT61 consists of two high-grade Ferroxcube toroids. Each toroid carries a secondary winding of 150 turns : these are connected in anti-series. The cores are encapsulated in a moulded body which is provided with two mounting holes. Connection to the secondary winding are made with 0,25 in Fastons.

The primary of the transformer is formed by passing the wire carrying the current to be measured through the aperture in the DCT61: the magnitude of this current will determine the number of primary turns required.



Symbol of the DCT61 with a primary winding.

MECHANICAL DATA

Dimensions (mm)

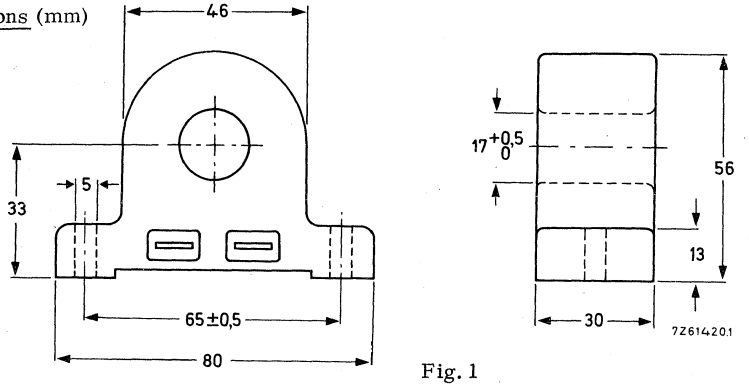


Fig. 1

Weight 155 g approximately

ELECTRICAL DATA

Ambient temperature range

Operating	−10 to + 70 °C
Storage	−40 to + 85 °C

	in conjunction with UPA61 (see Fig. 2a)	GLD60 (see Fig. 3a)
Primary input current	0 to 120 A	0 to 80 A
Primary input current with derated linearity (see Fig. 2b and 3b)	0 to 160 A	0 to 100 A
Test voltage	5 kV	
Sampling frequency	5 kHz	
Input/output linearity	2%	
Response time: trailing edge	1,4 ms	
leading edge	0,5 ms	
Output voltage (V_O)	0 to −12V	0 to +12 V
Output voltage variation due to supply voltage variation	0,4 %/%	
Output impedance	1 kΩ	
Load capability	10 kΩ	
Output ripple voltage, 5 kHz, on V_O (can be improved by adding extra filter network)	10%	

APPLICATION INFORMATION

Circuit of the d.c. current transformer with an supply voltage of −24 V

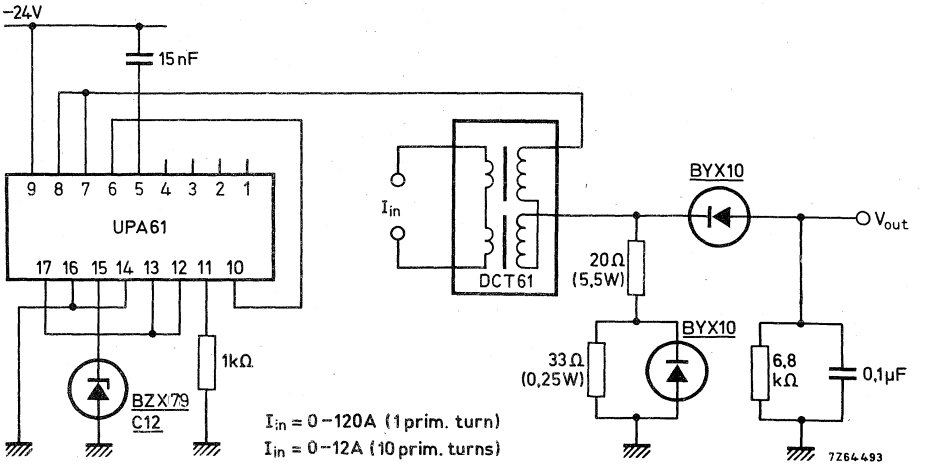


Fig. 2a Circuit of the DCT61 in conjunction with the UPA61.

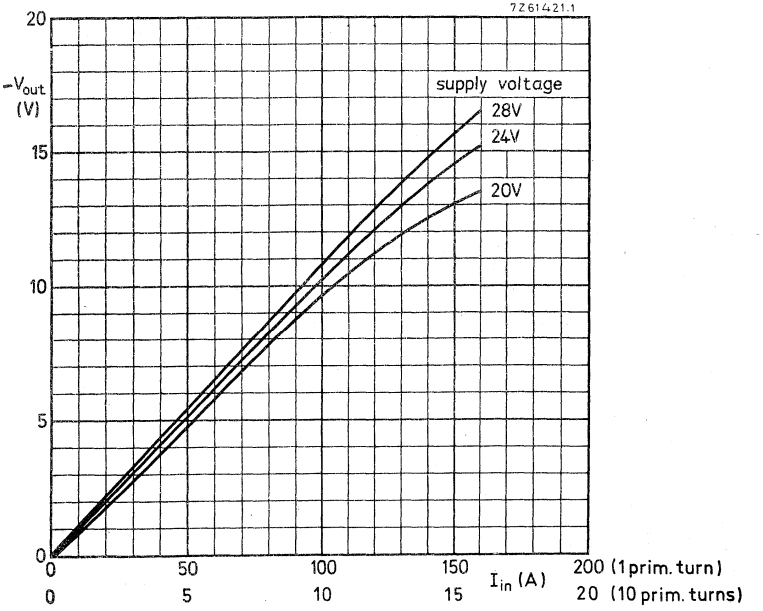


Fig. 2b Variation of d.c. output voltage with d.c. input current.

Circuit of d.c. current transformer with an supply voltage of +24 V

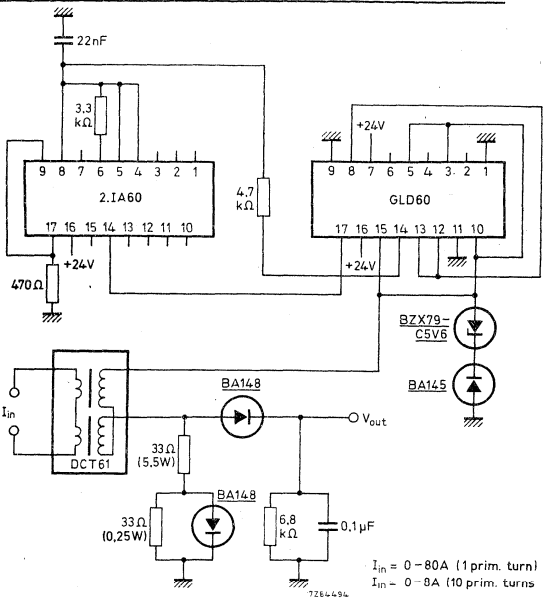


Fig. 3a Circuit of the DCT61 in conjunction with the GLD60.

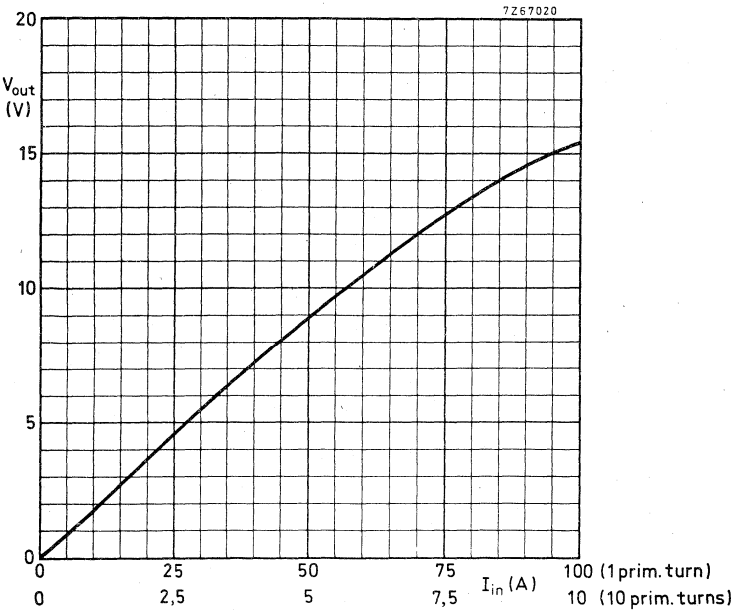
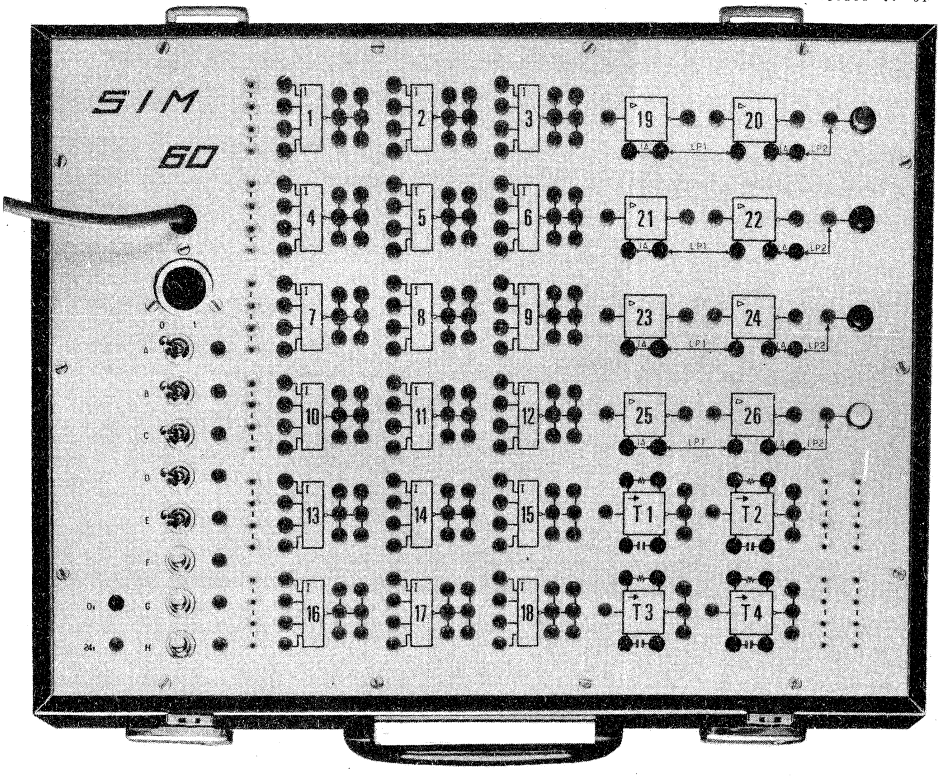


Fig. 3b Variation of d.c. output voltage with d.c. input current.

LOGIC SIMULATOR
for 60-Series NORbits

Purpose	logic system design simulation (breadboarding) and instruction
Supply voltage	117/220/240 V, 50 or 60 Hz
Housing	attaché case 415 x 310 x 95 mm
Weight	5,5 kg

730806 - 19 - 01



DESCRIPTION

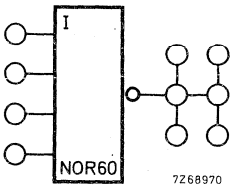
The SIM60 is a self-contained portable logic simulator, housed in a small light-weight attaché case, containing the following parts:

9 x	2. NOR60	5 x	toggle switch
4 x	2. IA60	3 x	push button
4 x	TU60	302 x	socket
1 x	power supply	10 x	patchcord, length 50 cm
4 x	indicator lamp	20 x	patchcord, length 30 cm
		10 x	patchcord, length 20 cm

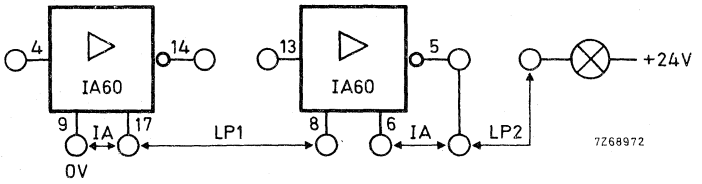
The circuit blocks are symbolized by rectangles and squares with adjoining input, output and auxiliary terminal sockets for patchcords. The fan-out of each block corresponds to the number of output sockets provided. Six groups of four auxiliary sockets (yellow) at the left and four groups at the right of the panel provide for concurrent application of signals to various control inputs.

Part description

2. NOR60 (see also relevant data sheet)
Units 1 to 18
18 NOR functions, each with 4 identical inputs and 6 paralleled output sockets.

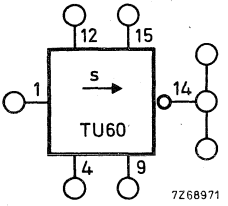


2. IA60 (see also relevant data sheet)
Units 19 to 26
8 inverting amplifiers;
Each 2. IA60 can be connected as an LPA60 to drive a load of 3 W at 24 V.



- To use the 2. IA60 as two inverting amplifiers, make the connections indicated by the arrows IA.
- To use the 2. IA60 as a single LPA60, make the connections indicated by the arrows LP1 and LP2.

TU 60 (see also relevant data sheet)
Units T1 to T4
Timer unit with 1 input and 3 paralleled output sockets. The time constant is determined by the resistance and capacitance connected externally between terminals 12-15 and 4-9, respectively.



Power supply (0 V, 24 V)

Suitable for operation from 117 V, 220 V or 240 V, 50 or 60 Hz, mains. Includes input cable and plug. Provides system 0 V and 24 V d.c. supply rails.

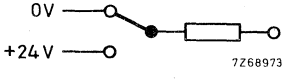
Indicator lamps

1 red
1 yellow
1 white
1 green

} can be used as output indicators for LPA60, one side connected to +24 V

Toggle switches (A to E) and push buttons (F toH)

To sumulate 1 or 0 input conditions and temporary 1 input signals, respectively.



output via internal current limiting resistance of 12 kΩ

Sockets

Colour indicates function:
Green = inputs
Red = outputs and 24 V
Black = other unit terminals and 0 V
Yellow = auxiliary sockets to multiply various signals

Note: The terminal socket marked '24 V' on the panel is connected directly to the +24 V supply rail, without current limiting resistor.

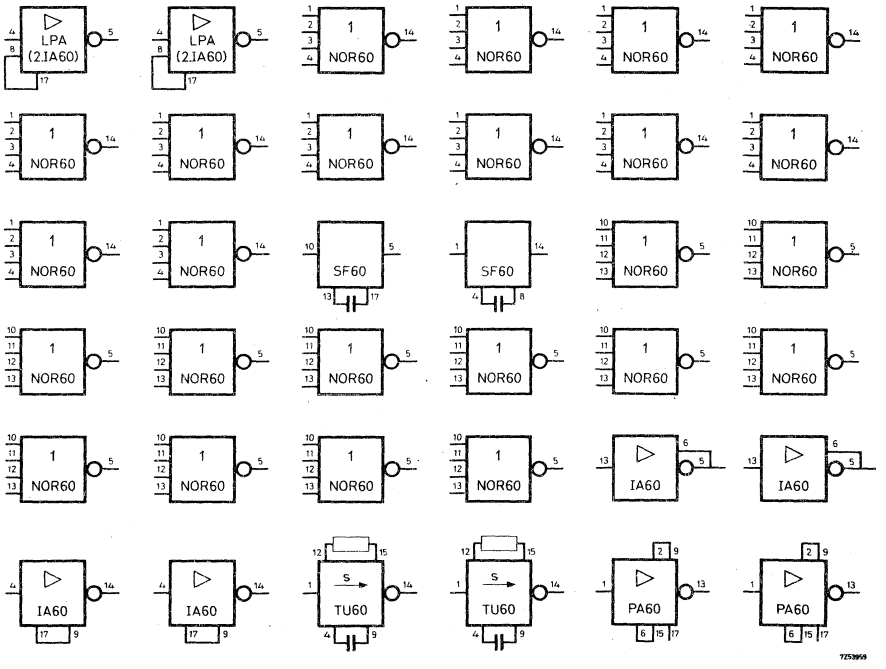
Application

Circuits for training purposes are given in Application Book "Control System Design Manual for 60-Series NORbits" under various headings.

CAUTION: Before plugging the SIM60 into the mains, be sure that the mains voltage selector on the panel is turned to the appropriate voltage.

STICKERS FOR THE 60-SERIES NORBITS

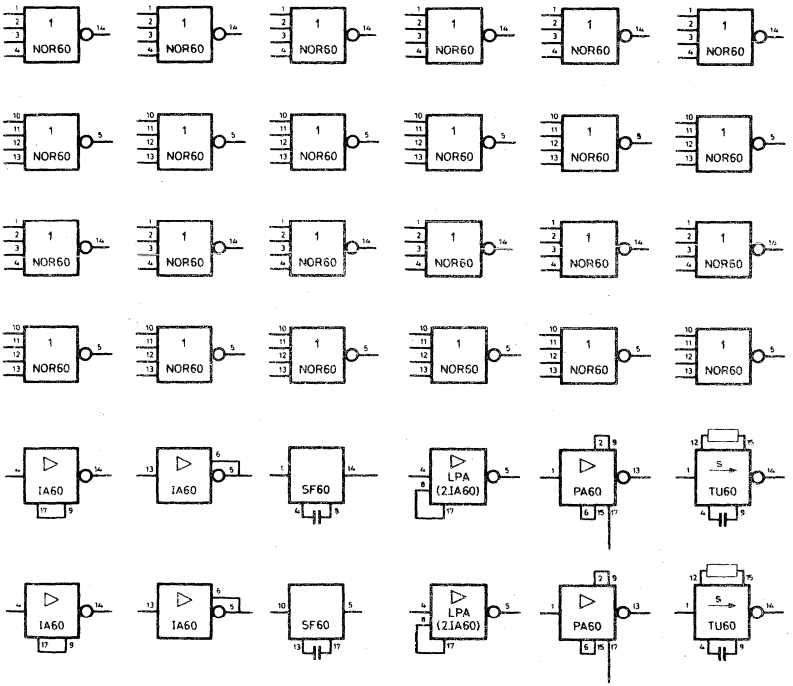
These are drawing symbols of NORBITS printed on self-adhesive, transparent material. They can be used for fast preparation of system drawings.
The stickers are available in sheets, each containing the arrangement of drawing symbols shown below. Each sticker can be separately detached from the sheet, without cutting. Catalogue number of 50 sheets: 4322 026 36481.



Sticker sheet without 4. NOR60 or TT60

STICKERS FOR THE 60-SERIES NORBITS

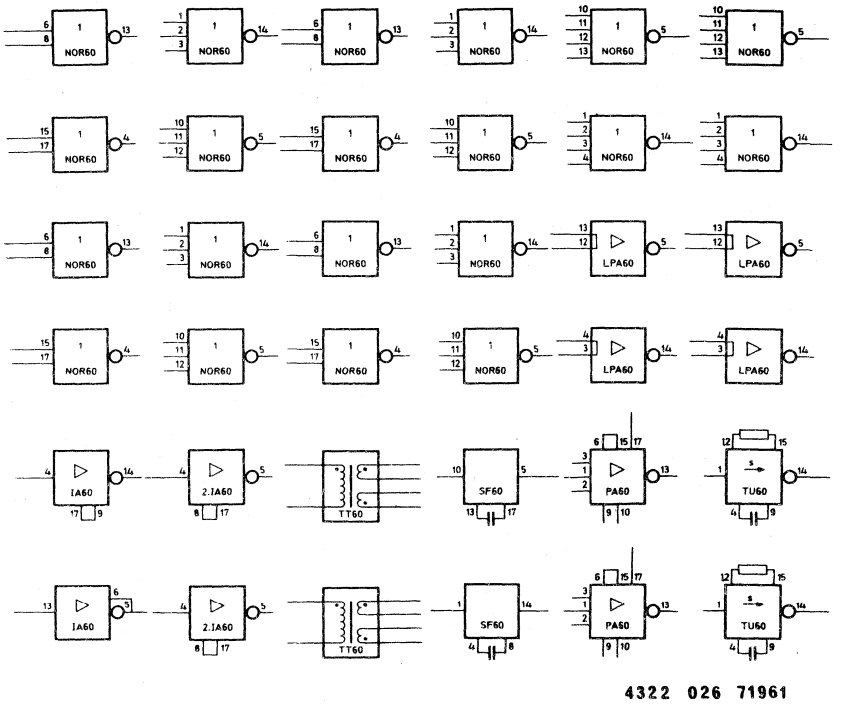
These are drawing symbols of NORBITS printed on self-adhesive, transparent material. They can be used for fast preparation of system drawings.
The stickers are available in sheets, each containing the arrangement of drawing symbols shown below. Each sticker can be separately detached from the sheet, without cutting. Catalogue number for 50 sheets: 4322 026 71941.



Sticker sheet without 4. NOR60 or TT60

STICKERS FOR THE 60-SERIES NORBITS

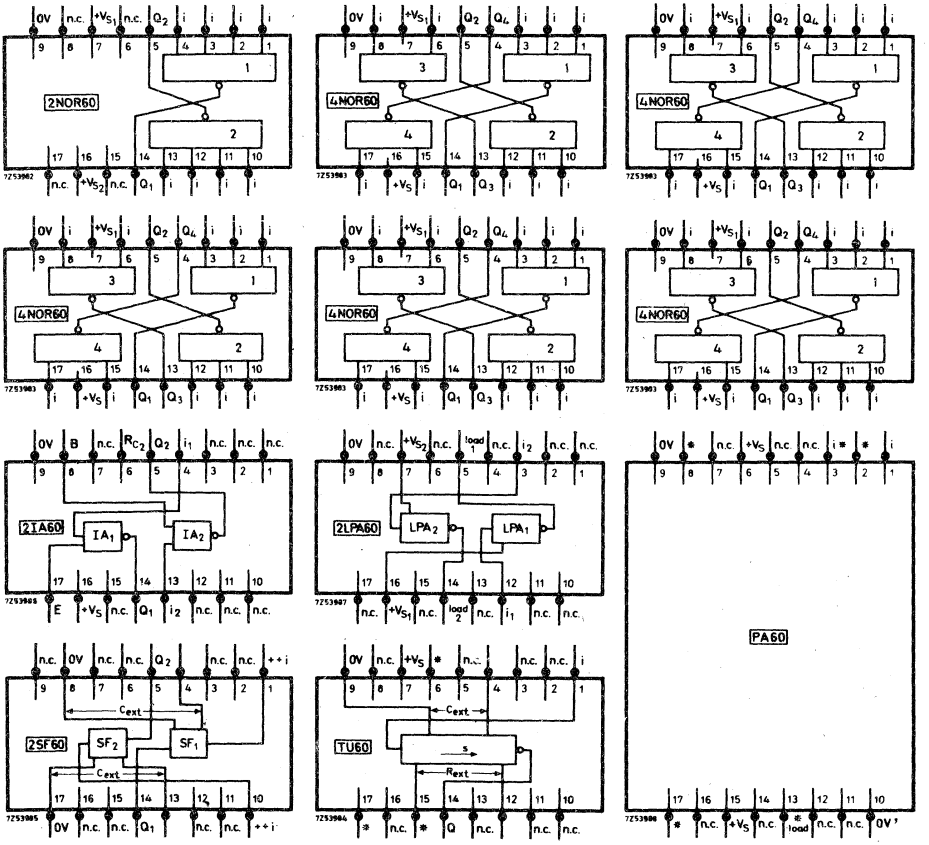
These are drawing symbols of NORBITS printed on self-adhesive, transparent material. They can be used for fast preparation of system drawings.
The stickers are available in sheets, each containing the arrangement of drawing symbols shown below. Each sticker can be separately detached from the sheet, without cutting. Catalogue number for 50 sheets: 4322 026 71961.



Sticker sheet with 4. NOR60 and TT60

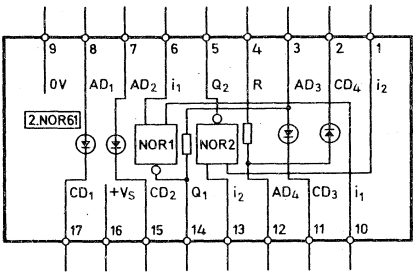
WIRING LAYOUT STICKERS
for the 60-series NORBITS

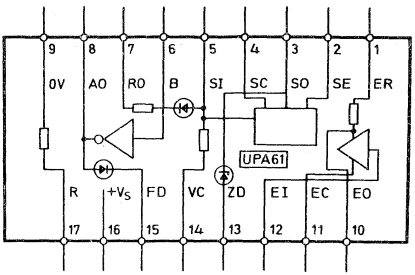
These are drawing symbols of 60-series blocks printed on self-adhesive, transparent material. They can be used for fast preparation of wiring layouts. All pin distances are actual size.
The stickers are available in sheets, each containing the arrangement of drawing symbols shown below. Each sticker can be separately detached from the sheet, without cutting. Catalogue number for 50 sheets: 4322 026 71971.

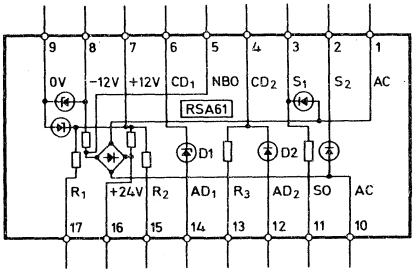


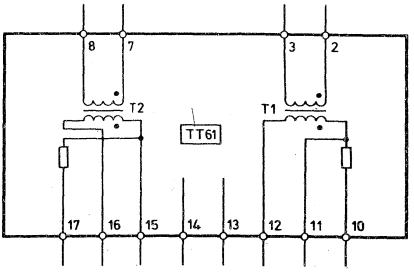
WIRING LAYOUT STICKERS for the 61-Series NORBITS

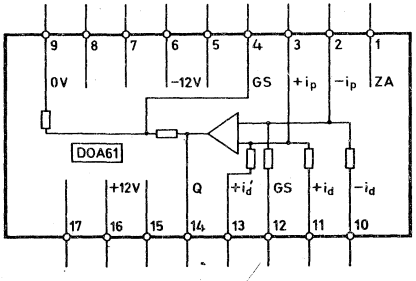
These are drawing symbols of 61-series blocks printed on self-adhesive, transparent material. They can be used for fast preparation of wiring layouts. All pin distances are actual size.
The stickers are available in sheets, each containing the five drawings shown below. Each sticker can be separately detached from the sheet, without cutting. Catalogue number for 50 sheets: 4322 026 71981.











Circuit blocks 90-Series

INTRODUCTION

The "90-Series" comprises a number of circuit blocks eminently suitable for use in industrial control systems.

As far as the environmental specification, the supply voltage and the encapsulation are concerned, the circuit blocks in this series are compatible with those of the 60-Series and they can therefore be successfully combined.

Operating on the principle of trigger logic (that is: the units are driven by voltage transients in contrast with those of the 60-Series which respond to voltage level), the 90-Series units allow the building of assemblies such as counters and shift registers simply and economically. They are so designed as to have a high noise immunity. However, care must be taken to avoid capacitive and inductive cross-talk between connecting wires.

Briefly, the features of the 90-Series are:

- Single rail 24 V $\pm$ 25 % supply, allowing the use of an inexpensive power supply, which helps to keep the cost down, particularly in small systems.
- Transfer moulded cases, giving optimum protection.
- Rigid terminals spaced at 0.2 in pitch, permitting a variety of interconnection methods to be used (dip soldering, hand soldering, mini wire-wrapping).
- Good noise immunity.
- Silicon semiconductors throughout, ensuring reliable operation down to -10 °C and up to +70 °C.
- Usable with the large number of accessories of the 60-Series.
- Easy-to-use loading table for system design.

The 90-Series comprises the following types:

FF90	Flip-flop
2.TG90	Twin-trigger gate
PS90	Pulse shaper

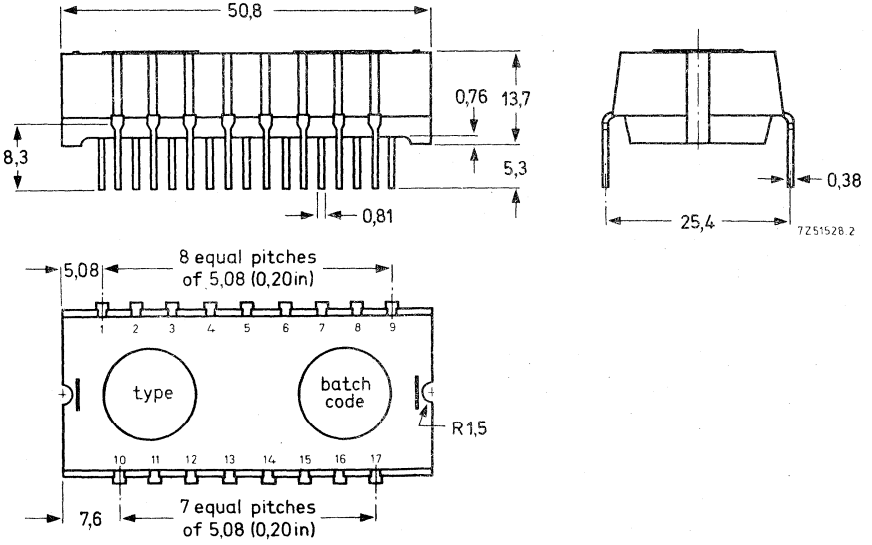
CONSTRUCTION

The circuit elements are housed in a transfer moulded encapsulation, which is identical to the "size A" block of the 60-series. The dimensions are as shown below. The pin connections for each unit are shown on the relevant data sheets. Pin numbering is moulded on both top and bottom of the unit. All pins are also accessible from the top of the unit to facilitate test requirements.

Mounting

The units may be mounted on printed-wiring boards, and a range of these is available with suitable metal housing chassis. They may also be clamped in the moulded Universal Mounting Chassis UMC 60 or fixed with 3 mm screws.

Dimensions in mm (inch equivalents within brackets)



TEST SPECIFICATIONS

All units meet the following test specifications:

Test	IEC 68	MIL-STD-202C
Dry heat life test	56 days at max. diss. max. temp. check at: 0-10/14d-56d.	Meth. 108A, Cond. D; check at 0-10/14d-56d.
Long-term damp heat non operating	Test C, 56 days check at 0-10/14 d-56d.	Meth. 103B, Cond. D; check at 0-10/14d-56d.
Long-term damp heat operating	Test C, 56d. min., diss., check at 0-10/14d-56d.	ditto
Temp. cycle-test	Test Na, 30 min., 2-3 min. in between; preferred: −40 °C; +85 °C and +125 °C.	Meth. 107B, Cond. A: moderate temp.
Vibration	Test Fb; 10-500-10 Hz 1 octave/min.; ampl. 0.75 mm max.; 10 g max. 3 x 3 hrs.	Meth. 204A, Cond. A: 10-500-10 Hz: 15 min. ampl. 0.75 max; 10 g max., 3 x 3 hrs.
Shock	–	Meth. 202B, 3 blows 50 g.
Robustness of terminations	Test $U_A + U_B$	Meth. 211A + (B or C)
Solderability + solder heat	Test T; at 0 hr and at 56d; no electr. test	Meth. 210, at 0 hr and at 56d; no electr. test

CHARACTERISTICS AND DEFINITIONS

AMBIENT TEMPERATURE LIMITS

Storage	T_{amb} = -40 °C to +85 °C
Operating	T_{amb} = -10 °C to +70 °C

SUPPLY VOLTAGE (V_S)

Single rail, +24 $V_{d.c.}$ ± 25% (18 to 30 V)

OUTPUT LEVEL

Logic '0'	0 to +0.3 V
Logic '1'	+12 to +30 V

TRIGGERING EDGE

The unit FF90 is driven by a negative-going transient (from "1" to "0" level). The maximum duration of the transient is, unless specified otherwise, 3 μs.

DRIVE UNIT (D.U.)

Drive required on Reset input of FF90 to bring output Q_1 to '1' level. [1])

ZERO UNIT (Z.U.)

Half the drive at '0' level required on one T terminal to trigger an FF90 unit.

FAN OUT

Number of drive units and zero units that can be delivered by a logic function, without exceeding the above defined limits for the logic levels.

[1]) This drive unit has also been specified as the drive required on one input of a NOR60 (with all other inputs returned to 0-volt line) to bring the output at '0' level.

INPUT AND OUTPUT DATA

System design is greatly simplified by expression of the input requirements and fan out capabilities of the various units in integral multiples of drive units (D.U.) and zero units (Z.U.). To check that the loadability of a particular unit is not exceeded simply add the number of D.U.'s or Z.U.'s present at its output.

FAN-OUT TABLE

The table shows the number D.U.'s and Z.U.'s, which can be delivered by the different units of the 90- and 60-series. The fan-outs are valid for a positive supply voltage of 24 V $\pm$ 25%.

unit	output capability '1' level (D.U.)	output capability '0' level (Z.U.)	notes and instructions
NOR of 2.NOR 60	6	12	2 inputs of the NOR must be connected in parallel. Signal must be derived from a chain of units that includes either a PS 90, an FF 90 or a TU 60.
2. IA 60; I.A. driven by an I.A.	20	50	Both the inverting and non-inverting connections can be used, but pins 5 and 6 must be interconnected. Signal must be derived from a chain of units that includes either a PS 90, an FF 90 or a TU 60.
NOR of 4.NOR 60	6	0	
LPA 60	-	0	No Z.U. available. Therefore, these units must not be used to drive an FF 90 or 2.TG90 directly.
TU 60	5	0	
SF 60	2	0	
PS 90	6	80	
FF 90	5	7	

FLIP-FLOP

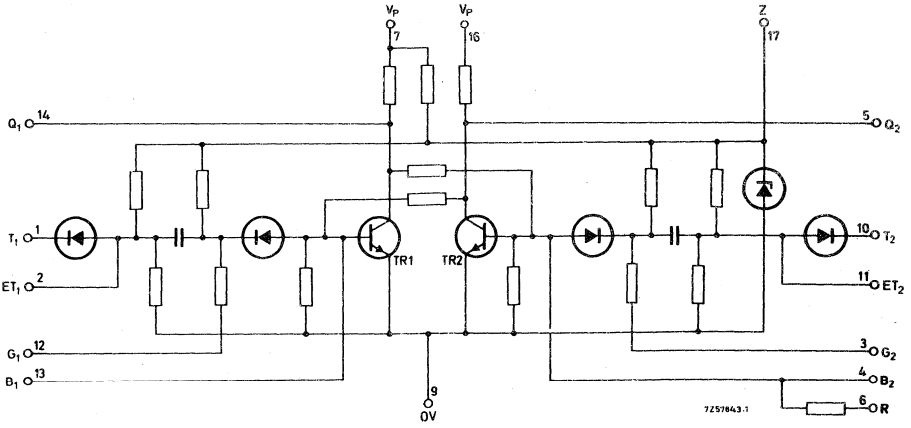
QUICK REFERENCE DATA	
Function	set-reset bistable multivibrator with trigger gates
Encapsulation	size: A block; colour: red
Max. counting speed (worst case)	5 kHz
Output capability	5 D.U., 7 Z.U.
Trigger input requirement	"1"-"0" edge of max. 3 μs; 2 Z.U.

APPLICATION

The FF90 has been intended to be used in counters, shift registers, etc.

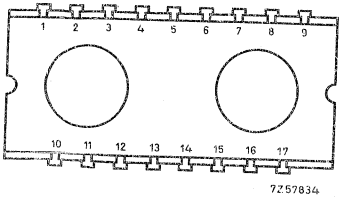
DESCRIPTION

Circuit

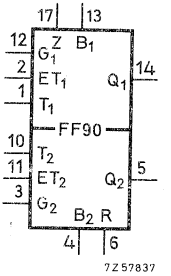


The unit comprises a set-reset bistable multivibrator which incorporates trigger gates. Switching is performed by applying a "1"-"0" edge of max. 3 μs at the trigger terminals (T_1 and T_2) which are controlled by gates (G_1 and G_2). The trigger inputs may be extended by the addition of external diodes to the extension terminals (ET_1 and ET_2) to provide an OR or inhibit facility. In addition, the circuit may be reset by applying a "1" level to the reset terminal (R) and may be set by applying a "1" level to the base of transistor 1 (B_1) via a resistor.

Terminal location



Drawing symbol



1 = T_1 = Trigger input 1
2 = ET_1 = Extension trigger input 1
3 = G_2 = Gate input 2
4 = B_2 = Transistor TR2 base
5 = Q_2 = Output 2
6 = R = Reset
7 = V_p = For positive supply (connect to pin 16)
8 = Not connected
9 = 0 V = 0 V common
10 = T_2 = Trigger input 2
11 = ET_2 = Extension trigger input 2
12 = G_1 = Gate input 1
13 = B_1 = Transistor TR_1 base
14 = Q_1 = Output 1
15 = Not connected
16 = V_p = For positive supply (connect to pin 7)
17 = Z = Zener diode*

* Caution: With the supplies connected ensure that pin 16 is not accidentally connected to pin 17, otherwise the zener diode will be damaged.

ELECTRICAL DATA

Power supply

Voltage	+24 V ± 25%
Current	< 21 mA

Input requirements (see also "Switching times")

function	input terminal	input requirement		notes and instructions
		'1' level (D.U.)	'0' level (Z.U.)	
reset (put Q1 to '1')	R	1	0	The Set and Reset inputs may be expanded by using up to 3 suitable diodes at each input. Ensure that the cathode of each diode is connected to the input. If the Set or Reset facilities are used, inputs must be held at '0' (and not left open-circuited) except during the command period.
set (put Q2 to '1')	B1 via 82 kΩ resistor 2)	1	0	
gate	G_1, G_2	2	1	'1' or open-circuit closes gate. '0' opens gate.
gate	G_1, G_2 via a diode 1) 2)	0	1	'1' or open-circuit closes gate. '0' opens gate. Ensure that the anode of the diode is connected to the input.
trigger	T_1, T_2	0	2	Only a '1'-'0' edge occurring within 3 μs triggers the flip-flop. If T_1 and T_2 are interconnected, 4 Z.U. are required.
trigger	ET_1, ET_2 via a diode 1) 2)	0	2	Only a '1'-'0' edge occurring within 3 μs triggers the flip-flop. If ET_1 and ET_2 are interconnected, 4 Z.U. are required. Ensure that the anode of each diode is connected to the input.

1) Diodes type BAX 13, BAX 16 or BAX 78 can be used.

2) If external components are used, ensure that they are mounted as close as possible to the appropriate input.

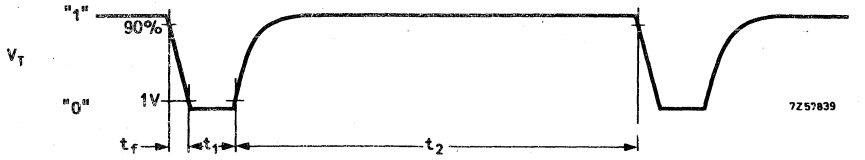
Output data

Output capability	5 D.U. and 7 Z.U.
Max. capacitive load	200 pF

Account must be taken of the load imposed by the gates when they are connected to the output terminals (Q_1, Q_2).

Switching times

Trigger



Max. fall time	t_{fmax}		3 μs
Min. pulse duration	t_{1min}		5 μs
Trigger recovery time	t_2	max.	99 μs
		typ.	73 μs

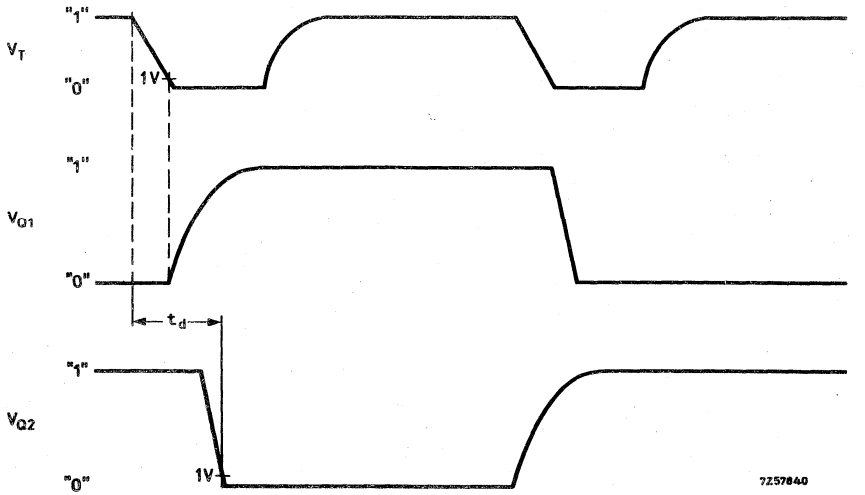
Gate

Gate recovery time	max.	137 μs
	typ.	100 μs

The signal at the gate must be present at least 137 μs (worst case) before the triggering edge is applied to T_1 or T_2. It is permitted to change the gate signal simultaneously with the triggering edge.

Switching delay

Delay between triggering edge and negative-going output.	t_d	max.	8 μs
		typ.	3 μs



Reset of Set: The appropriate terminal should be at a logical '1' for a minimum of 50 μs to reset or set the flip-flop.

Maximum Counting Speed (1 : 1 mark: space ratio) 5 kHz (worst case)

The worst case figure is related to the most disadvantageous connection or input condition that can be made.

APPLICATION INFORMATION

For connection as a divider of two connect pin 3 to pin 5 and pin 12 to pin 14.

More information is given in "Application Information 849, Counting and Shifting with 90-Series Modules."

TWIN-TRIGGER GATE

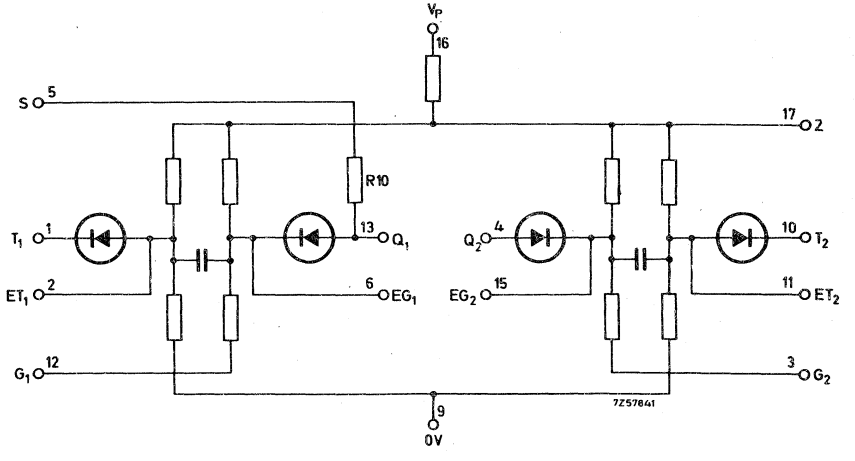
QUICK REFERENCE DATA	
Function	two trigger gates for use with FF90 only
Encapsulation	size: A block; colour: red
Output signal	suitable for triggering direct on transistor base of FF90 (B_1 and B_2)
Trigger input requirement	'1'-'0' edge of max. 3 μs; 2 Z.U.

APPLICATION

The 2.TG90 has been intended to provide two extra independent trigger gates for the FF90.

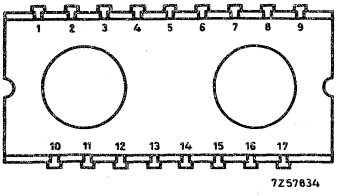
DESCRIPTION

Circuit

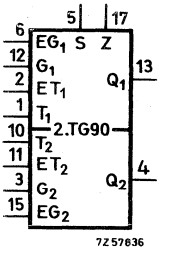


The unit comprises two gating circuits to perform extra independent trigger functions. The mode of operation is the same as for the trigger functions of the FF90. Switching is performed by applying a '1'-'0' edge of max. 3 μs at the trigger terminals (T1 and T2) which are controlled by gates (G_1 and G_2). The trigger inputs may be expanded by the addition of external diodes to the extension terminals (ET_1 and ET_2) to provide an OR or inhibit facility. The extra resistor (R_{10}), connected to terminal Q_1, provides the 'set' facility for the FF90.

Terminal location



Drawing symbol



1 = T_1 = Trigger input
2 = ET_1 = Extension trigger input 1
3 = G_2 = Gate input 2
4 = Q_2 = Output to B_2 (pin 4) of FF90
5 = S = Set terminal
6 = EG_1 = Extension gate input
8 = Not connected
9 = Not connected
9 = 0 V = 0 V common

10 = T_2 = Trigger input 2
11 = ET_2 = Extension trigger input 2
12 = G_1 = Gate input 1
13 = Q_1 = Output to B_1 (pin 13) of FF90
14 = Not connected
15 = EG_2 = Extension gate input
16 = V_P = For positive supply
17 = Z = Voltage reference terminal, connect to Z (pin 17) on FF90

ELECTRICAL DATA

Power supply

Voltage	+24 V ± 25%
Current	7.5 mA

Input requirements

function	input terminal	input requirement		notes and instructions
		'1' level (D.U.)	'0' level (Z.U.)	
set (put Q_2 of associated FF90 to '1')	S	1	0	The Set input may be expanded by using up to 3 suitable diodes on each input. Ensure that the cathode of each diode is connected to the input. If the Set facility is used, the input must be held at '0' (and not left open-circuited), except during the input period.
gate	G_1, G_2	2	1	'1' or open-circuit closes gate. '0' opens gate
gate	G_1, G_2 via diode 1) 2)	0	1	'1' or open-circuit closes gate. '0' opens gate. Ensure that the anode of the diode is connected to the input.
trigger	T_1, T_2	0	2	Only a '1'-'0' edge occurring within 3 μs triggers the flip-flop [3]). If T_1 and T_2 are interconnected, 4 Z.U. are required.
trigger	ET_1, ET_2 via diode 1) 2)	0	2	Only a '1'-'0' edge occurring within 3 μs triggers the flip-flop [3]). If ET_1 and ET_2 are interconnected, 4 Z.U. are required. A maximum of two diodes may be connected to each ET terminal. Ensure that the anode of each diode is connected to the input.

For notes see page 4.

Output data

The outputs Q_1, Q_2 are suitable only for use with one FF90; Q_1, Q_2 and Z of the 2.TG90 should be connected to B_1, B_2 and Z respectively of the FF90.
The inter-wiring capacitance should be limited at 50 pF (maximum). This capacitance will not be exceeded when a 2.TG90 is mounted next to an FF90.

1) Diodes type BAX 13, BAX 16 or BAX 78 can be used. Max. 2 diodes may be added.
2) If external components are used, ensure that they are mounted as close as possible to the appropriate input.
3) Switching times of the triggering signal are the same as for the FF90.

PULSE SHAPER

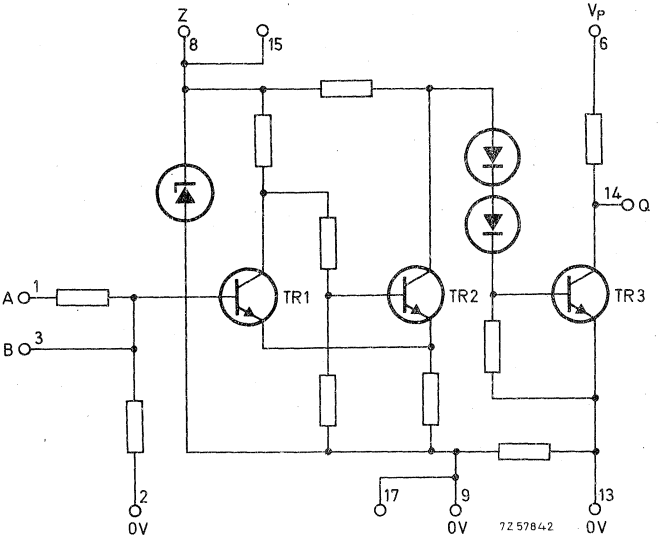
QUICK REFERENCE DATA	
Function	a. Driving the trigger inputs of one or more FF90 or 2.TG90 units b. Shaping signals to produce NORBIT 60 drive levels
Encapsulation	size: A block; colour: green
Output capability	6 D.U.; 40 Z.U.

APPLICATION

The PS90 has been intended to produce the triggering edge required for the FF90. The output levels are conforming to '1' and '0' of 60-Series logic.

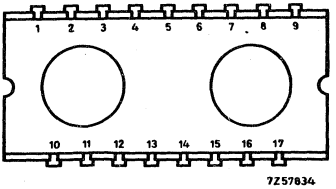
DESCRIPTION

Circuit

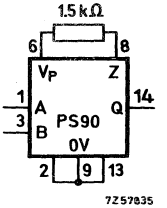


The unit contains a Schmitt trigger circuit followed by an inverting amplifier.

Terminal location



Drawing symbol



1 = A = Input via resistor
2 = 0 V = 0 V common (connect to pins 9 and 13)
3 = B = Input direct to base
4 = Not connected
5 = Not connected
6 = VP = For positive supply (connect also to pin 8 via 1.5 kΩ resistor*)
7 = Not connected
8 = Z = Zener diode ** internally connected to pin 15 (connect to pin 6 via 1.5 kΩ resistor *)
9 = 0 V = 0 V common, internal connection to pin 17 (connect also to pins 2 and 13)
10 = Not connected
11 = Not connected
12 = Not connected
13 = 0 V = 0 V common (connect also to pins 2 and 9)
14 = Q = Output
15 = Z = Internally connected to pin 8
16 = Not connected
17 = 0 V = Internally connected to pin 9.

* The 1.5 kΩ ± 10% resistor connected between pins 6 and 8 (15) has a dissipation of 0.35 W maximum.

** When the PS90 is mounted on PWB60 or PWB61, pins 7 and 16 are connected to the positive supply VP. Ensure therefore, that neither pins 7 and 8 nor pins 15 and 16 are interconnected. Otherwise, the Zener diode will be damaged.

ELECTRICAL DATA

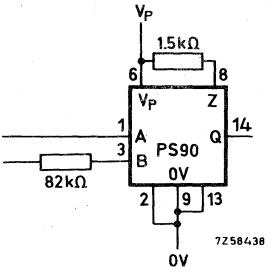
Power supply

Voltage	+24 V ± 25%
Current	< 21 mA

Input Data

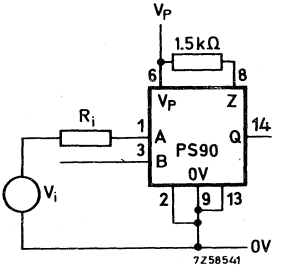
1. Unit driven by circuit block of 60 Series or 90 Series

The input requirement at pin 1 (pin 3 not connected) for '0' output is 1 D.U. One input may be added, namely an 82 kΩ resistor connected to pin 3 (input requirement is 1 D.U.). The circuit then performs as a 2-input NOR function. The 82 kΩ resistor should be mounted as close as possible to the unit.



2. Unit driven by any other circuit at pin 1 with pin 3 not connected.

	Operating	Limiting value
Input voltage to give '0' output	min. +6 V	+30 V
Input voltage to give '1' output	max. +1.5 V	−15 V



Hysteresis

ΔV_i min. = 0.55 + 0.003 Ri V (Ri in kΩ)
ΔV_i max. = 1.5 + 0.012 Ri V (Ri in kΩ)

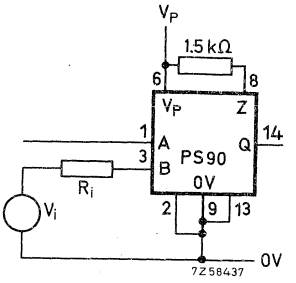
See also "Switching speed".

3. Unit driven by any other circuit at pin 3 with pin 1 not connected

	Operating	Limiting values
Input current to give '0' output	min. 50 μA	5 mA
Input current to give '1' output	max. 15 μA	0 mA

If driven by a voltage source, the source resistance should be minimum 500 Ω.

Max. positive voltage with R_i = 500 Ω +5 V
Max. positive voltage with R_i = 6,8 kΩ +30 V
With pin 2 not connected the max. source resistance is 50 kΩ and the max. negative voltage is 4 V.



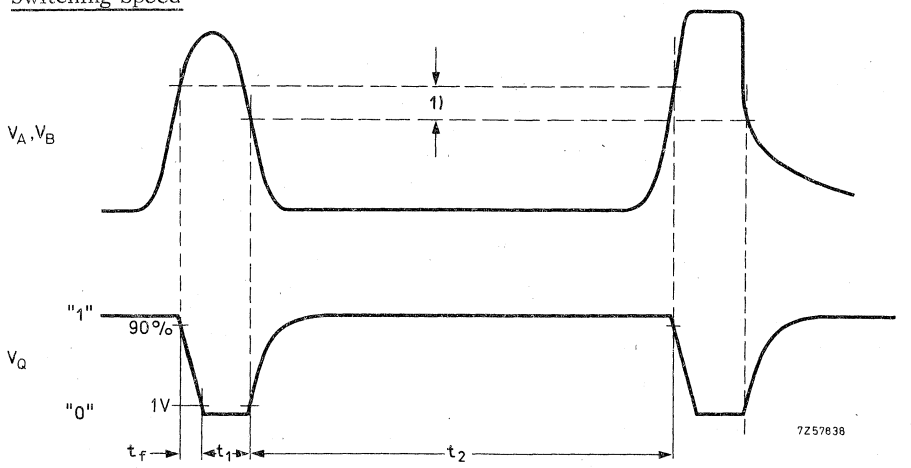
Hysteresis
ΔV_i min. = 0,32 + 0,003 R_i V (R_i in kΩ)
ΔV_i max. = 0,45 + 0,012 R_i V (R_i in kΩ)

See also "Switching speed".

Output Data

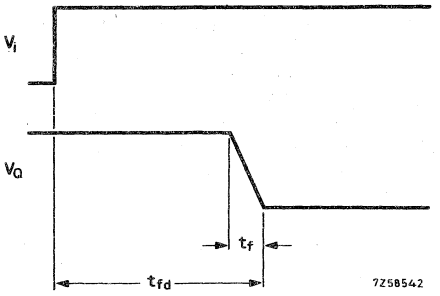
Output capability	6 D.U.
	40 Z.U.
Max. capacitive load	200 pF

Switching Speed



$t_f \leq 3\ \mu s$
t_1 and t_2 depend on input waveforms.
1) Hysteris ΔV_A or ΔV_B

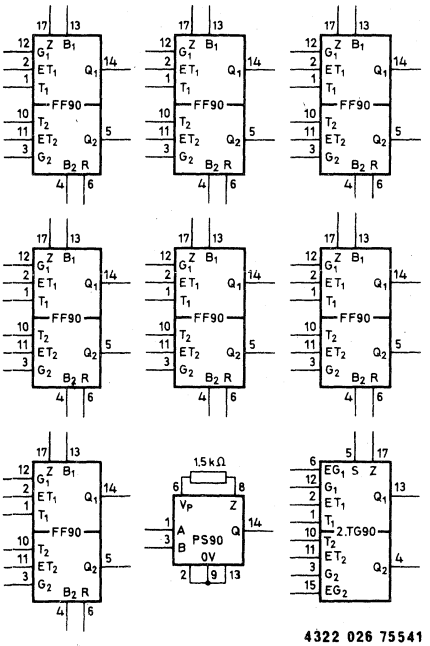
If a step function is applied to the input and the output is loaded with 200 pF the output signal is given by:



Fall time	$t_f < 0.25\ \mu s$
Fall delay time	$t_{fd} < 2.5\ \mu s$

STICKERS FOR THE 90-SERIES CIRCUIT BLOCKS

These are drawing symbols of CIRCUIT BLOCKS printed on self-adhesive, transparent material. They can be used for fast preparation of system drawings.
The stickers are available in sheets, each containing the arrangement of drawing symbols shown below. Each sticker can be separately detached from the sheet, without cutting. Catalogue number for 50 sheets: 4322 026 75541.



Chopper-stabilized operational amplifier CSA70

CHOPPER-STABILIZED OPERATIONAL AMPLIFIER

QUICK REFERENCE DATA	
Open loop gain	min. 10^7
Initial offset voltage	max. ± 10 μV
Average offset voltage drift with temperature	max. 0,1 μV/degC
Bias current	max. ± 70 pA
Noise voltage (0,01 to 1 Hz), peak to peak	0,7 μV

APPLICATION

The component possesses a high current and voltage stability therefore small d.c. and low-frequency signals receive accurate amplified reproduction. Changes due to environmental conditions such as temperature time and power supply voltages have only a minor influence on the circuit performance. Initial offsets are very small, therefore initial adjustments and periodic calibration can be eliminated in many applications.

DESCRIPTION

To obtain a high d.c. stability, the d.c. and low-frequency signals are chopped, amplified (a.c. amplifier) and then demodulated. The higher frequency component of the signal at the common input is fed via a capacitor directly to the wide-band amplifier (see block diagram, Fig. 1). Offset and drift of the wide-band amplifier is reduced by a factor equal to the gain of the a.c. amplifier.

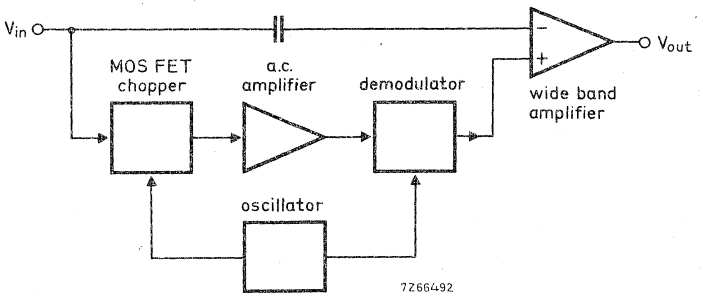


Fig. 1 Block diagram

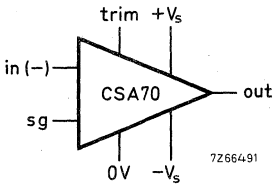


Fig. 2 Drawing symbol

sg = signal earth
in (-) = inverting input
out = output
$+V_S$ = positive supply voltage
$-V_S$ = negative supply voltage
0 V = common supply voltage
trim = offset voltage adjustment

MECHANICAL DATA

Dimensions (mm) and terminal location

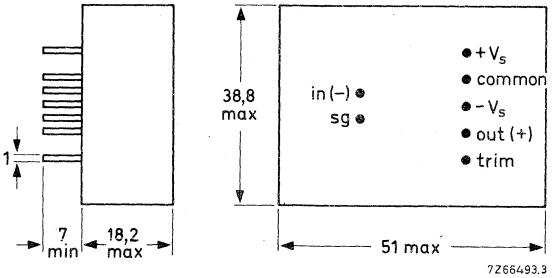


Fig. 3

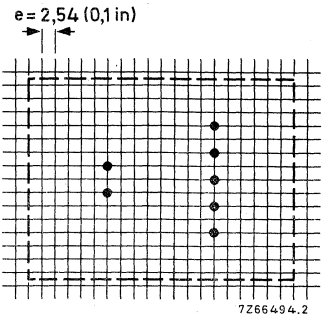


Fig. 4 Terminal location on 0,1 inch grid.

ELECTRICAL DATA

Ambient temperature +25 °C, supply voltages +15/-15 V, unless stated otherwise.

Ambient temperature range	
Operating, rated specification	0 to +60 °C
Storage	-40 to +85 °C
Power supply	
Voltage, rated specification	± 15 V ± 3%
derated specification	± 12 V to ± 18 V
Typ. current at +15/−15 V	+7/-7 mA + load current
at +12/−12 V	+4/-5 mA + load current
Open loop gain (R_L = 2 kΩ)	min. 10^7
Frequency response	
Unity gain bandwidth (small signal)	min. 0,5 MHz (frequency roll-off 6 dB/oct.)
Full power frequency	min. 5 kHz
Slewing rate	min. 0,3 V/μs
Overload recovery time	typ. 3 s, max. 5 s

For method which will substantially reduce recovery time, see circuit of Fig. 5.

Input data

	typical	maximum
Initial offset voltage (adjustable to zero with 100 kΩ potentiom.*)		± 10 μV
Average offset voltage drift with temperature		0,1 μV/degC
Average offset voltage drift with supply voltage		0,1 μV/%
Average offset voltage drift with time	1 μV/month	
Bias current		± 70 pA
Average bias current drift with temperature		0,7 pA/degC
Average bias current drift with supply voltage	0,4 pA/%	
Average bias current drift with time	10 pA/month	

*) Potentiometer to be connected between $+V_S$ and $-V_S$, slider to "trim".

Input voltage range	± 20 V
Noise voltage	
0,01 Hz to 1 Hz, p-p	0,7 μV
0,01 Hz to 10 Hz, p-p	5 μV
10 Hz to 5 kHz, r.m.s.	2,5 μV
Noise current	
0,01 Hz to 1 Hz, p-p	5 pA
0,01 Hz to 10 Hz, p-p	40 pA
Burst noise (popcorn noise) peak voltage of CSA70L, measured across 100 kΩ	< 15 μV
Input impedance	min. 200 kΩ

Output data	typical	minimum
Output voltage, R_L = 10 kΩ	± 14 V	± 12 V
R_L = 2 kΩ	± 13 V	± 10 V
Output current	± 12 mA	
Output resistance (without feedback)		max. 200 Ω

Continuous short circuit is allowed between the output and earth, or between the output and supplies.

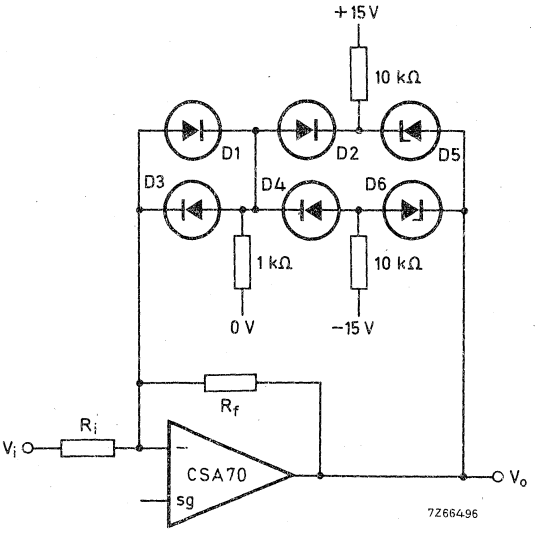


Fig. 5

D1 – D4 = BAW62

D5, D6 = BZX79/C10 or BZY88/C10

The resistors are carbon types, 1/8 W, 5%

APPLICATION INFORMATION

For extensive information on theoretical background and practical applications of operational amplifiers refer to our Application Book: "Measurement and Control using 40-series modules", order number 9399 263 05901.

1. Logarithmic amplifier (6 decade)

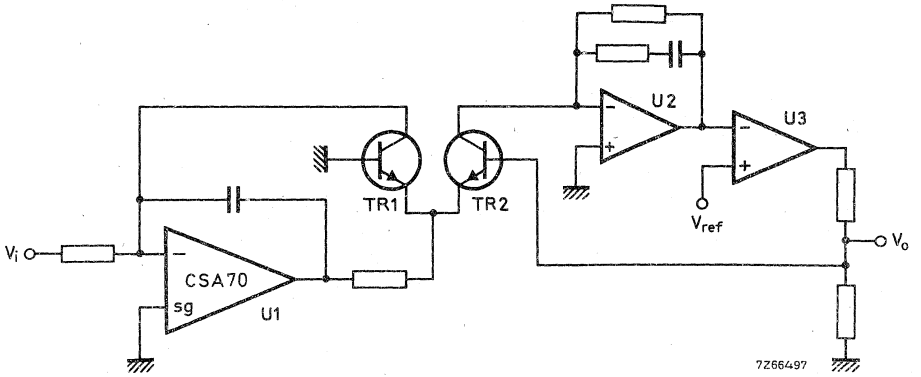


Fig. 6 V_i = 10 μV to 10 V.
TR1, TR2 = matched transistor pair, thermally coupled.
U2, U3 = general purpose amplifiers.

2. Inverting amplifier with very high input impedance

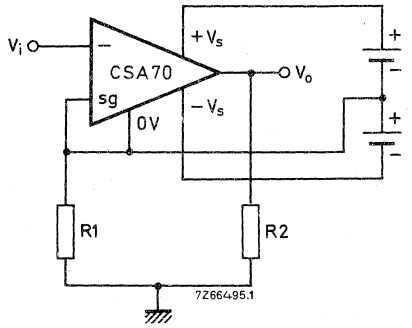


Fig. 7

$+V_S$ and $-V_S$ must be floating.*

$$V_O = \frac{R2}{R1} V_i$$

$Z_i > 100\ M\Omega$

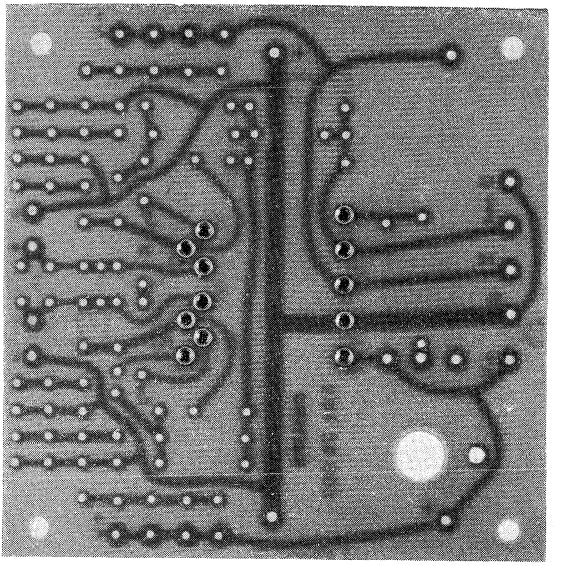
(Note that input floats with respect to supplies, and that gain can be chosen less than unity.)

*The isolated DC-DC converter IDC70 is suitable for this purpose. Data sheet available separately.

ACCESSORIES

1) A printed-wiring board (see photograph) providing plug-in facilities for the CSA 70 can be ordered separately under catalogue number 4332 000 00501.
This board will also accommodate a trimming potentiometer.

RZ 26423-5



2) Employing the AMP reusable component test receptacles type nr 380 598-2 enables the CSA 70 to be plugged into a printed-wiring board.

TEST SPECIFICATIONS

The unit has been designed to meet the tests of MIL-STD-202C below. Before and during manufacture samples of modules are regularly subjected to these tests.

1. Shock test according to method 202B; 3 blows 50 g in 3 perpendicular directions.
2. Vibration test according to method 204A; frequency 10-500 Hz 15 min, amplitude 0,75 mm max., 10 g max., 3 x 3 hours.
3. Temperature-cycling test according to method 102A; 5 cycles from −40 to + 85 °C.
4. Moisture resistance according to method 106C; R.H. 90 to 98%, temperature cycling +25 to +65 °C.
5. Solderability according to method 210.
6. Robustness of terminations according to method 211A and B.

PLC modules

MODULES FOR PROGRAMMABLE LOGIC CONTROLLERS

INTRODUCTION

The programmable logic controller (PLC) is used for the controlling of machines or processes. It can be easily programmed and re-programmed as required.

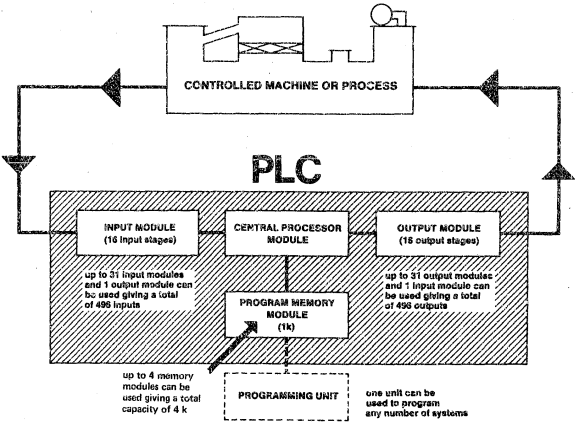
The modular design of the PLC enables a user to build a PLC which is 'tailor-made' for his control task. By specifying the number and the types of PLC modules that he requires, he avoids purchasing more of the expensive electronic capability than he needs.

The PLC modules are formed on standard double Eurocards. Optically coupled interface circuits, specifically designed for an industrial environment, provide excellent noise immunity and a high degree of isolation. The internationally accepted machine signal level of 24 V is used and generous tolerances on operational margins and thresholds ease compatibility headaches.
Besides the PLC modules, the PLC comprises a frame (19 in rack, connectors and wiring) and a standard power supply. The frame must conform to IEC297 or DIN41494 (for racks) and IEC130-14 or DIN41612 (for connectors). The adoption of these standards means that the frame and the power supply should be easily obtainable.

The following PLC modules are available.

type	description	catalogue no.
IM10	input module, 16 inputs, 24 V d.c.	4322 027 90430
IM11	input module, 16 inputs, 24 V a.c.	4322 027 90400
CP10	central processor, 32 registers	4322 027 90420
CP11	central processor, without registers	4322 027 90390
OM10	output module, 16 outputs, 24 V d.c.	4322 027 90440
MM10	program memory module, 1 k, non-volatile core RAM	4322 027 91400
PU10	programming unit	4322 027 90410

The diagram shows, in a simplified form, the function of each of the PLC modules. In operation the PLC cycles continuously through a data input/output cycle and a data processing cycle.



The input module converts the signals from the plant into a binary form acceptable to the central processor.

The central processor reads the data from the input module, performs logic equations on it in accordance with the program instructions and transfers the results to the output module.

The output module converts the binary data from the central processor to electrical signals suitable for the control of the plant.

The program memory is the store in which the set of instructions that comprise the program are stored. These instructions dictate the actions which must be taken in response to the condition of each input.

The programming unit is the means by which an operator can write a program, or changes to a program, into the program memory. The unit is portable and thus one may be used to serve any number of PLCs. It is also sufficiently inexpensive to make the permanent location of one in each PLC for monitoring or test purposes, a realistic and useful proposition.

GENERAL CHARACTERISTICS

Operating temperature range	0 to +60 °C
Storage temperature range	-40 to +70 °C
Dimensions	160 mm x 233 mm (double Eurocard) according to IEC297 or DIN41494
Supply voltage (d.c.)	V_P = 5 V ±5%; $\frac{dV_P}{dt} \leq$ 5 V/ms
Maximum number of input + output signals	512
Maximum program length	4 x 1024 words
Cycle time	0, 029 ($n_{IM} + n_{OM}$) + 1, 85 n_{MM} ms n_{IM} = number of input modules n_{OM} = number of output modules n_{MM} = number of memory modules

TESTS AND REQUIREMENTS

All modules are designed to meet the tests below.

Vibration test

IEC68-2, test method Fc: 5 to 55 Hz, amplitude 1, 5 mm or 5 g (whichever is less).

Shock test

IEC68-2, test method Ea: 3 shocks in 6 directions, pulse duration 11 ms, peak acceleration 50 g.

Rapid change of temperature test

IEC68-2, test method Na: 5 cycles of 2 h at -40 °C and 2 h at +70 °C.

Damp heat test

IEC68-2, test method Ca: 21 days at 40 °C, R.H. 90 to 95%.

CENTRAL PROCESSORS

DESCRIPTION

These central processors are modules intended for use in combination with the input module IM10 (or IM11), memory module MM10, output module OM10 and programming unit PU10 to assemble a programmable logic controller (PLC). The central processor is the heart of the logic controller; it asks the input modules for data and the program memory for instructions, processes the data according to these instructions, and applies the result to the output modules. It also generates the internal timing of the controller.

The processor actions take place in two distinct cycles: an input/output cycle and a data processing cycle.
During the input/output cycle the processor addresses each input stage in turn (counter/buffer register) and transfers the present data to the corresponding scratch-pad memory location, see Fig. 1. In the same cycle the processed data of the previous data processing cycle are clocked out from the scratch-pad memory into the latch flip-flops of the output modules. As the scratch-pad memory can hold up 512 bits of data the central processor can handle a maximum combination of 512 inputs, outputs, and intermediate results. Provision is made to prevent loss of information of the scratch-pad memory in the case of power failure.

During the data processing cycle the processor applies an address and a cycle initiate signal to the program memory, which in turn then apply a program word to the processor. The program word contains an instruction and an address, which comprise 13 data bits. An instruction consists of 4 bits of data; these are applied to the logic processing unit and the register processing unit. [1]) The other 9 bits of data form the scratch-pad memory address and are used to select the data bit at this memory location, and also one of the 32 8-bit registers. [1]) The logic processing unit only processes data from the scratch-pad memory. The register processing unit processes the data stored in one of the 8-bits registers, in conjunction with a working register (A-register). Due to the fact that a register is always selected when a scratch-pad memory address is selected, the results of register processing will be stored in the corresponding scratch-pad memory location (condition register). Data for the registers can be supplied by the program memory or by an external source. These data are stored in the registers during the data processing cycle.

[1]) Only present in the CP10.

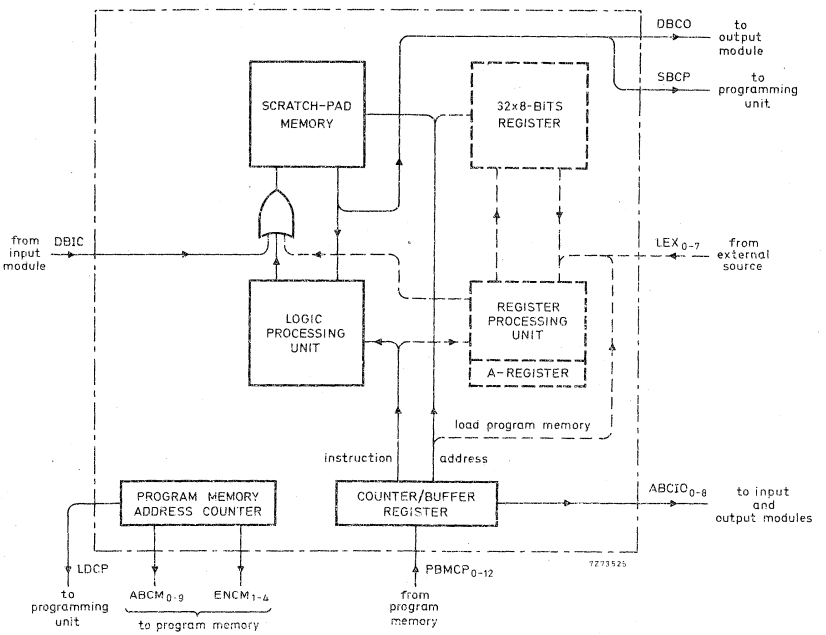


Fig. 1. Simplified block diagram of the central processor. Blocks drawn with broken lines are only extant in the CP10.

The central processor is built on an epoxy-glass printed-wiring board of 233, 4 mm x 160 mm (Euro-card system). The board is provided with two F068-I connectors (board parts); the corresponding panel parts are available under catalogue number 2422 025 89288 (pins for wire wrap), 2422 025 89298 (pins for dip soldering) or 2422 025 89326 (solder tags) [1]. The board has a metal screen at the components side, which is connected to the 0 V line.

[1]) For a general description of the Euro-card system see IEC 297 or DIN 41494 for 19-in racks and IEC 130-14 or DIN 41612 for connectors.

ELECTRICAL DATA

Supply

Supply voltage (d.c.)	V_P	5 V ± 5%
current	I_P	max. 2,1 A
		typ. 1,9 A

Battery back-up requirements to save contents of the scratch-pad memory in case of power failure.

Battery voltage	V_B	4,5 to 7,5 V
Battery current (V_P = 0 V)	I_B	typ. 3,5 mA at V_B = 5 V
Trickle charge current (V_P = 5 V)		typ. 2 mA at V_B = 5 V

Input data

All inputs meet the standard TTL specifications.

input	function	load	terminations (Fig. 4)	
			connector 1	connector 2
$PBMCP_0$	Program word bits from program memory.	1 TTL		a2, c2
$PBMCP_1$		1 TTL		a3, c3
$PBMCP_2$		1 TTL		a4, c4
$PBMCP_3$		1 TTL		a5, c5
$PBMCP_4$		1 TTL		a6, c6
$PBMCP_5$		1 TTL		a7, c7
$PBMCP_6$		1 TTL		a8, c8
$PBMCP_7$		1 TTL		a9, c9
$PBMCP_8$		1 TTL		a10, c10
$PBMCP_9$		1 TTL		a11, c11
$PBMCP_{10}$		1 TTL		a12, c12
$PBMCP_{11}$		1 TTL		a13, c13
$PBMCP_{12}$		1 TTL		a14, c14
MICC	Memory identification signal; this signal is connected to one of the four ENCM-outputs of the central processor.	2 TTL	a5	
SCPC	Store command from programming unit; initiates SCCM (see output data) when the central processor is in a data processing cycle.	2 TTL		a15, c15
DBIC	Data bit from input stage; data is stored in scratch-pad memory during input/output cycle.	3 TTL	c20	
CLCP	Clear signal from external source. When CLCP is LOW the central processor is kept in the start position of an input/output cycle; when CLCP is HIGH the central processor is running (see also SPCE).	2 TTL	a20	

input	function	load	terminations (Fig. 4)	
			connector 1	connector 2
SPCE	Scratch-pad clear enable line from external source. When SPCE is HIGH and CLCP goes from LOW to HIGH all scratch-pad places (except those which are addressed as an input) are set to zero in the first input/output cycle; when SPCE is LOW and CLCP goes from LOW to HIGH the central processor starts with a normal input/output cycle.	2 TTL	a22	
IDIC	Identification signal from input module; prepares central processor for data on DBIC to be written in the scratch-pad memory.	3 TTL	c24	
IDLC	Identification signal from last input or output module; indicates that the last input or output module has been selected.	2 TTL	c26	
LEX_0	Data inputs from an external source; eight data bits from an external source can be loaded into the A-register.	1 TTL	a6	
LEX_1		1 TTL	a7	
LEX_2		1 TTL	a8	
LEX_3		1 TTL	a9	
LEX_4		1 TTL	a10	
LEX_5		1 TTL	a11	
LEX_6		1 TTL	a12	
LEX_7		1 TTL	a13	

Output data

All outputs meet the standard TTL specifications.

output	function	loadability	terminations (Fig. 4)	
			connector 1	connector 2
$ABCIO_0$	Address bits to input and output modules. $ABCIO_{0-3}$ select the input or output stage, $ABCIO_{4-8}$ select the input or output modules.	32 TTL	c2	
$ABCIO_1$		32 TTL	c4	
$ABCIO_2$		32 TTL	c6	
$ABCIO_3$		32 TTL	c8	
$ABCIO_4$		32 TTL	c10	
$ABCIO_5$		32 TTL	c12	
$ABCIO_6$		32 TTL	c14	
$ABCIO_7$		32 TTL	c16	
$ABCIO_8$		32 TTL	c18	

output	function	loadability	terminations (Fig. 4)	
			connector 1	connector 2
$ABCM_0$	Address bits to program memory, initiated by program address counter.	10 TTL		a20, c20
$ABCM_1$		10 TTL		a21, c21
$ABCM_2$		10 TTL		a22, c22
$ABCM_3$		10 TTL		a23, c23
$ABCM_4$		10 TTL		a24, c24
$ABCM_5$		10 TTL		a25, c25
$ABCM_6$		10 TTL		a26, c26
$ABCM_7$		10 TTL		a27, c27
$ABCM_8$		10 TTL		a28, c28
$ABCM_9$		10 TTL		a29, c29
$ENCM_1$	Enable signal to program memory; four lines are necessary when program memory capacity is extended to 4 k	8 TTL	a1, c1	
$ENCM_2$		8 TTL	a2	
$ENCM_3$		8 TTL	a3	
$ENCM_4$		8 TTL	a4	
SCCM	Store command to program memory; level determines whether a program word is read out from program memory to central processor (LOW) or a new program word is written into the program memory (HIGH). SCCM=$\overline{SCPC}$.	10 TTL		a17, c17
CICM	Cycle initiate signal to program memory; depending on the level of SCCM, CICM starts read/restore or clear/write cycle (bipolar to reduce noise sensitivity).	9 TTL		a19, c19
$\overline{CICM}$				a18, c18
$\overline{CL}_{23}$	Inverted clock signal to programming unit.	10 TTL	a15	
CLCO	Clock signal to output module, stores data on DBCO into output stage during input/output cycle.	32 x OM10	a28	
DBCO	Data bit to output module; data is stored in output stage by CLCO.	31 TTL	c22	
SBCP	Status bit to programming unit; clocked by ϕ_{57} it indicates "1" or "0" at selected scratch-pad memory address.	1 TTL	a16	
LDCP	Synchronization signal to programming unit, synchronizes auxiliary address counter in programming unit with address counter in central processor.	10 TTL	a14	
ϕ_{57}	Clock signal for state indication on programming unit; occurs only during data processing cycle.	10 TTL		a16, c16

Alarm output (a26 of connector 1): open collector output, which indicates a LOW level when $V_P < 4,75$ V. V_{alarm}, LOW level $< 0,4$ V at $I_C = 3$ mA.

Time data

Scan time per input or output module	0,029 ms
Read time per 1 k memory module	1,85 ms
Total cycle time	0,029 $(n_{IM} + n_{OM}) + 1,85\ n_{MM}$ ms

n_{IM} = number of input modules
n_{OM} = number of output modules
n_{MM} = number of memory modules

Note - By removing a wire jump, marked "A", on the central processor board the scan time per input or output module is set to 7,4 ms.

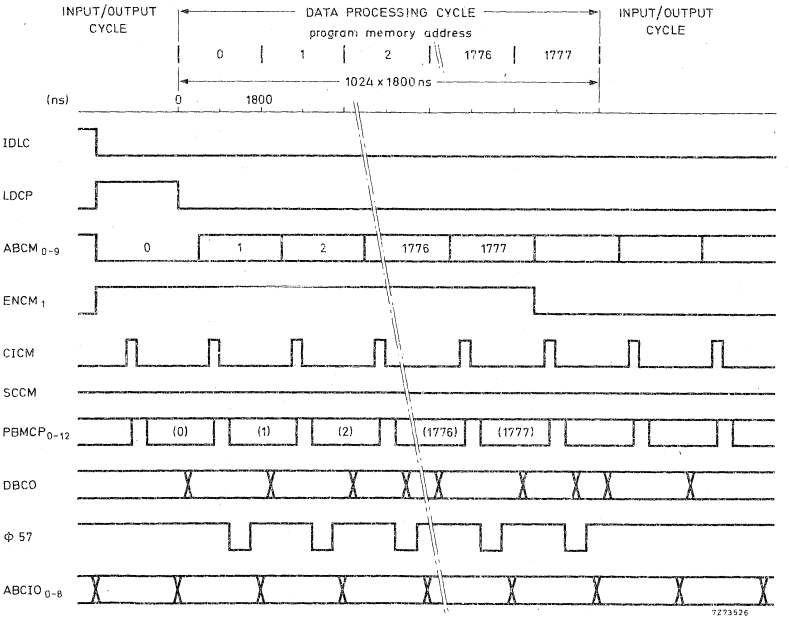


Fig. 2. Timing diagram of data processing cycle.

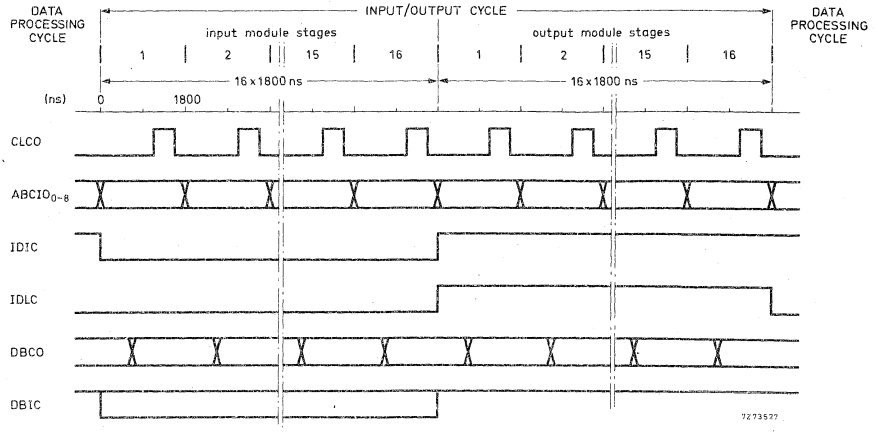


Fig. 3. Timing diagram of input/output cycle.

MECHANICAL DATA

Dimensions in mm

Outlines

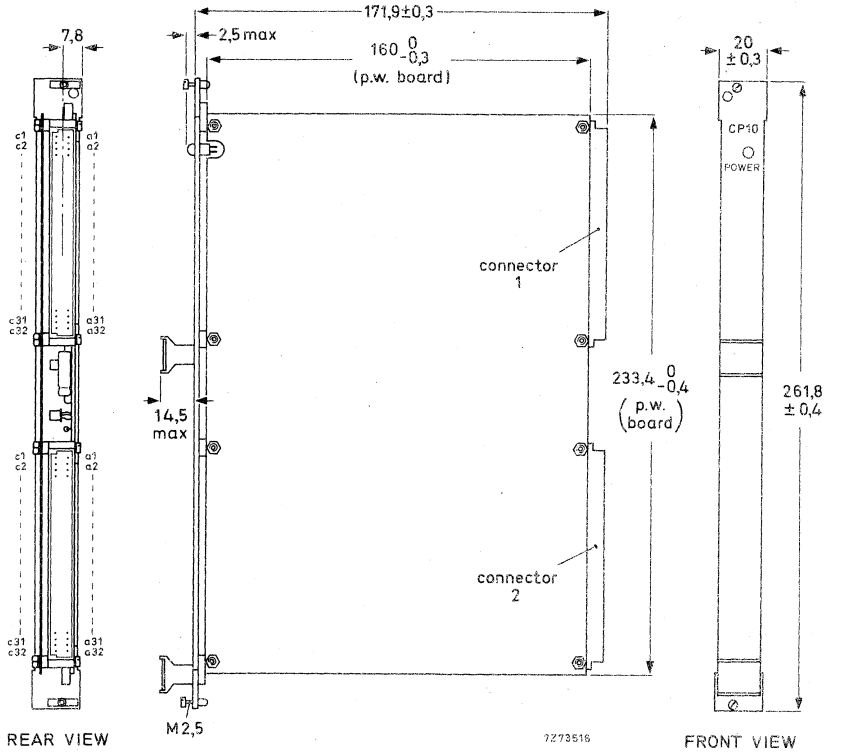


Fig. 4

Mass

400 g

Terminal location

connector 1			connector 2		
row c		row a	row c		row a
$ENCM_1$	1	$ENCM_1$	i.c.	1	i.c.
$ABCIO_0$	2	$ENCM_2$	$PBMCP_0$	2	$PBMCP_0$
n.c.	3	$ENCM_3$	$PBMCP_1$	3	$PBMCP_1$
$ABCIO_1$	4	$ENCM_4$	$PBMCP_2$	4	$PBMCP_2$
n.c.	5	MICC	$PBMCP_3$	5	$PBMCP_3$
$ABCIO_2$	6	LEX_0	$PBMCP_4$	6	$PBMCP_4$
n.c.	7	LEX_1	$PBMCP_5$	7	$PBMCP_5$
$ABCIO_3$	8	LEX_2	$PBMCP_6$	8	$PBMCP_6$
n.c.	9	LEX_3	$PBMCP_7$	9	$PBMCP_7$
$ABCIO_4$	10	LEX_4	$PBMCP_8$	10	$PBMCP_8$
n.c.	11	LEX_5	$PBMCP_9$	11	$PBMCP_9$
$ABCIO_5$	12	LEX_6	$PBMCP_{10}$	12	$PBMCP_{10}$
n.c.	13	LEX_7	$PBMCP_{11}$	13	$PBMCP_{11}$
$ABCIO_6$	14	$\overline{LDCP}$	$PBMCP_{12}$	14	$PBMCP_{12}$
n.c.	15	$\overline{CL}_{23}$	SCPC	15	SCPC
$ABCIO_7$	16	SBCP	$\phi 57$	16	$\phi 57$
n.c.	17	n.c.	$\overline{SCCM}$	17	$\overline{SCCM}$
$ABCIO_8$	18	n.c.	$\overline{CICM}$	18	$\overline{CICM}$
n.c.	19	n.c.	CICM	19	CICM
DBIC	20	CLCP	$ABCM_0$	20	$ABCM_0$
n.c.	21	n.c.	$ABCM_1$	21	$ABCM_1$
DBCO	22	SPCE	$ABCM_2$	22	$ABCM_2$
n.c.	23	n.c.	$ABCM_3$	23	$ABCM_3$
IDIC	24	n.c.	$ABCM_4$	24	$ABCM_4$
n.c.	25	n.c.	$ABCM_5$	25	$ABCM_5$
IDLC	26	alarm	$ABCM_6$	26	$ABCM_6$
n.c.	27	n.c.	$ABCM_7$	27	$ABCM_7$
0 V[1])	28	CLCO	$ABCM_8$	28	$ABCM_8$
n.c.	29	n.c.	$ABCM_9$	29	$ABCM_9$
n.c.	30	n.c.	V_B	30	V_B
V_P	31	V_P	V_P	31	V_P
0 V	32	0 V	0 V	32	0 V

n.c. = not connected.
i.c. = internal connection.

[1]) No supply line; only to be used as a ground connection for CLCO.

INPUT MODULES

DESCRIPTION

These input modules are intended for use in combination with the central processor CP10 (or CP11), memory module MM10, output module OM10 and programming unit PU10 to assemble a programmable logic controller (PLC).
The IM10 and IM11 are identical in many respects, but the IM10 is designed for d.c. inputs, whereas the IM11 is designed for a.c. and unsmoothed rectified inputs.
Each input module contains 16 addressable input stages, equipped with photocouplers to obtain electrical isolation between external and internal circuitry (Fig. 1). All inputs are floating with respect to each other.
Each input stage has a LED for status indication: it is lit when the input is active.
A delay circuit (delay time typ. 1 ms) is incorporated in each input stage of the IM10, to increase the noise immunity. The delay time can be increased by adding extra capacitance (approx. 0,5 μF/ms).
A rectifying and smoothing circuit is incorporated in each input stage of the IM11.

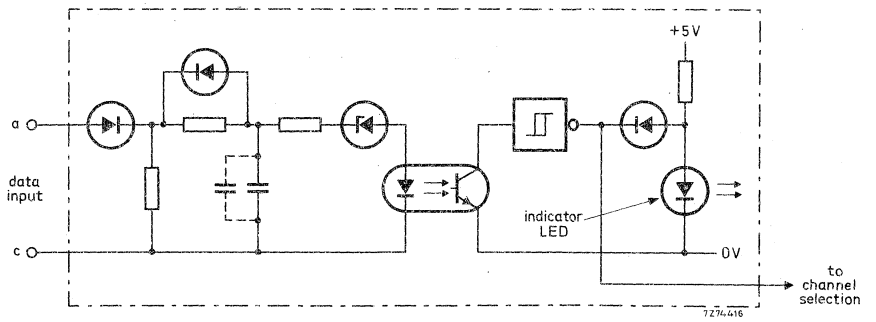


Fig. 1a. Circuit diagram of an input stage (IM10).

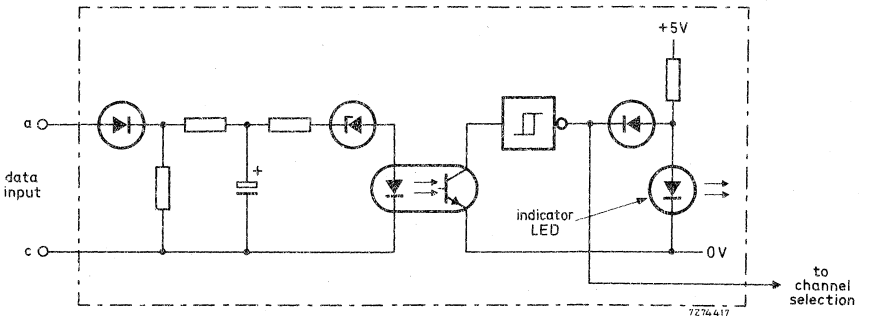


Fig. 1b. Circuit diagram of an input stage (IM11).

Each input module has nine address inputs ($ABCIO_{0-8}$) and five module identification inputs ($\overline{MID}_{0-4}$), which are accessible on the connectors at the rear (Fig. 2).

The circuit is built on an epoxy-glass printed-wiring board of 233, 4 mm x 160 mm (Euro-card system). The board is provided with two F068-I connectors (board parts); the corresponding panel parts are available under catalogue number 2422 025 89291 (pins for wire wrap), 2422 025 89299 (pins for dip soldering) or 2422 025 89327 (solder tags). [1]

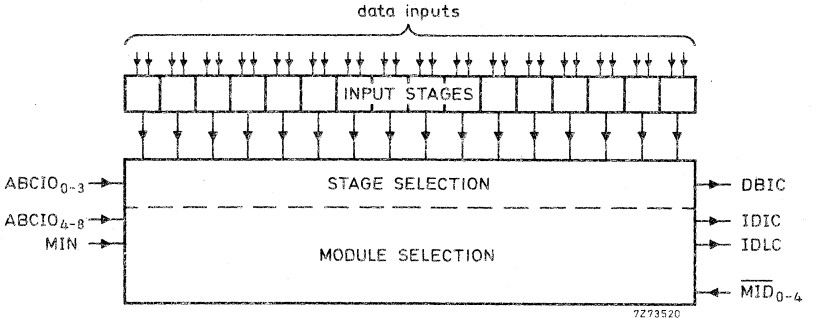


Fig. 2. Block diagram of the input modules.

[1] For a general description of the Euro-card system see IEC 297 or DIN 41494 for 19-in racks and IEC 130-14 or DIN 41612 for connectors.

ELECTRICAL DATA

Supply

Supply voltage (d.c.)	V_P	5 V ± 5%
current	I_P	max. 0,5 A
		typ. 0,45 A

Input data

The data inputs are DI_{XY0} to DI_{XY7} and DI_{XZ0} to DI_{XZ7}. They are accessible on connector 2, see "Terminal location".

Active voltage (V_{a-c}) [1]	24 V ± 25%	d.c. (for IM10) or a.c. values (for IM11)
Non-active voltage (V_{a-c}) [1]	0 to 7 V or floating	
Input current, active at V_{a-c} = 24 V	typ. 10 mA	

The inputs mentioned below meet the standard TTL specifications.

input	function	load	terminations of connector 1 (Fig. 3)
$ABCIO_0$	Address bits from central processor; $ABCIO_{0-3}$ select the input stage, $ABCIO_{4-8}$ select the input module.	1 TTL	a2, c2
$ABCIO_1$		1 TTL	a4, c4
$ABCIO_2$		1 TTL	a6, c6
$ABCIO_3$		1 TTL	a8, c8
$ABCIO_4$		1 TTL	a10
$ABCIO_5$		1 TTL	a12
$ABCIO_6$		1 TTL	a14
$ABCIO_7$		1 TTL	a16
$ABCIO_8$		1 TTL	a18
MIN	Module inhibit signal from external source; a low level applied to this input inhibits data on DBIC to be stored in the scratch-pad memory of the central processor.	2 TTL	c26
$\overline{MID}_0$	Module identification inputs; provide module with individual identity.	2 TTL	c10
$\overline{MID}_1$		2 TTL	c12
$\overline{MID}_2$		2 TTL	c14
$\overline{MID}_3$		2 TTL	c16
$\overline{MID}_4$		2 TTL	c18

[1] Voltage between terminal of row a and terminal of row c of connector 2.

Output data

All outputs (open collector) meet the standard TTL specifications.

output	function	loadability	terminations of connector 1 (Fig. 3)
DBIC	Data bit to central processor; data is stored in scratch-pad memory of central processor.	10 TTL	a20
IDIC	Identification signal to central processor (active LOW); prepares central processor for data on DBIC to be written in the scratch-pad memory.	10 TTL	c24
IDLC	Identification signal from last input module to central processor (active HIGH); only the IDLC output of the last input module has to be connected with the IDLC input of the central processor.	2 TTL	a26

MECHANICAL DATA

Dimensions in mm

Outlines

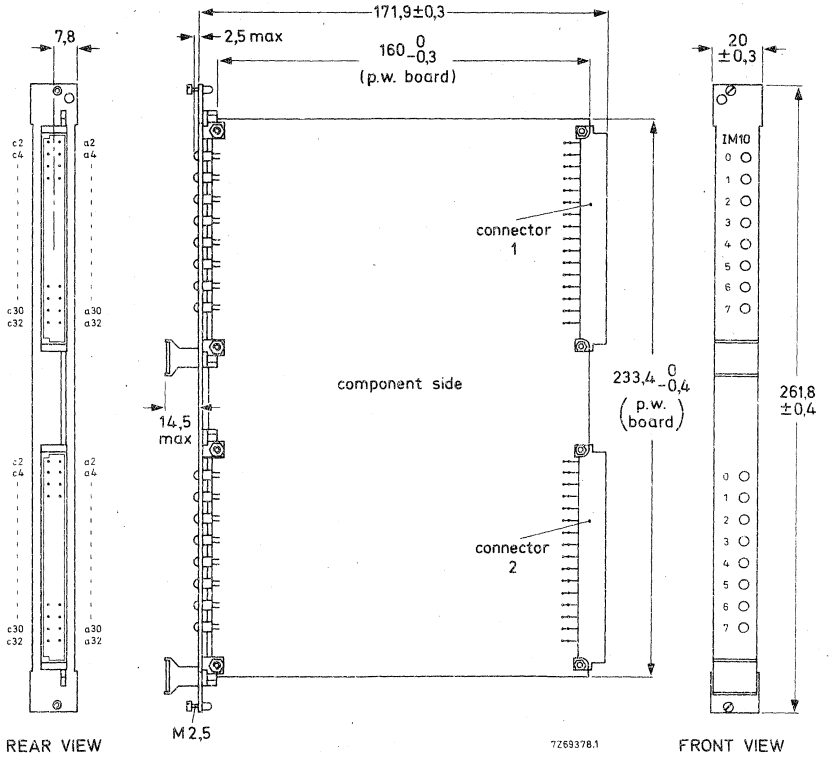


Fig. 3

Mass

250 g

Terminal location

connector 1			connector 2		
row c		row a	row c		row a
$ABCIO_0$	2	$ABCIO_0$	DI_{XY0}	2	DI_{XY0}
$ABCIO_1$	4	$ABCIO_1$	DI_{XY1}	4	DI_{XY1}
$ABCIO_2$	6	$ABCIO_2$	DI_{XY2}	6	DI_{XY2}
$ABCIO_3$	8	$ABCIO_3$	DI_{XY3}	8	DI_{XY3}
$\overline{MID}_0$	10	$ABCIO_4$	DI_{XY4}	10	DI_{XY4}
$\overline{MID}_1$	12	$ABCIO_5$	DI_{XY5}	12	DI_{XY5}
$\overline{MID}_2$	14	$ABCIO_6$	DI_{XY6}	14	DI_{XY6}
$\overline{MID}_3$	16	$ABCIO_7$	DI_{XY7}	16	DI_{XY7}
$\overline{MID}_4$	18	$ABCIO_8$	DI_{XZ0}	18	DI_{XZ0}
0 V[1])	20	DBIC	DI_{XZ1}	20	DI_{XZ1}
0 V[1])	22	n.c.	DI_{XZ2}	22	DI_{XZ2}
IDIC	24	n.c.	DI_{XZ3}	24	DI_{XZ3}
MIN	26	IDLC	DI_{XZ4}	26	DI_{XZ4}
n.c.	28	n.c.	DI_{XZ5}	28	DI_{XZ5}
V_P	30	V_P	DI_{XZ6}	30	DI_{XZ6}
0 V	32	0 V	DI_{XZ7}	32	DI_{XZ7}

n.c. = not connected.

1) No supply line; only to be used for coding of the $\overline{MID}_{0-4}$ lines.

MEMORY MODULE

DESCRIPTION

This memory module is intended for use in combination with the central processor CP10 (or CP11), input module IM10, output module OM10 and programming unit PU10 to assemble a programmable logic controller (PLC). The control program is stored in the memory module.

The memory module is a random access magnetic core memory system with a basic capacity of 1024 words of 13 bits (1 k 13) and a cycle time of 1 µs. The memory is complete in itself; it consists of a 3 D, 3-wire stack, timing selecting and inhibit circuitry, address and data registers, and a memory retention circuit including the 5 V sensing.

The memory module is built on three epoxy-glass printed-wiring boards. The module is provided with two F068-1 connectors (board parts, Euro-card system); the corresponding panel parts are available under catalogue number 2422 025 89288 (pins for wire wrap), 2422 025 89298 (pins for dip soldering) or 2422 025 89326 (solder tags) [1]).

ELECTRICAL DATA

Supply

Supply voltage (d.c.)	V_P	5 V ± 5%		
current (cycle time 1, 8 µs)	I_P	operating	max.	5,1 A
			typ.	4 A
		standby	max.	3,6 A
			typ.	3,3 A

Note: The memory is in standby position when ENCM is LOW.

Cooling

An air velocity of 0,2 m/s is required.

[1]) For a general description of the Euro-card system see IEC 297 or DIN 41494 for 19 in racks and IEC 130-14 or DIN 41612 for connectors.

Input data

All inputs meet the standard TTL specifications.

input	function	load	terminations (Fig. 3) connector 1	connector 2
CICM	Cycle initiate signal from central processor to program memory (bipolar to reduce noise sensitivity).	1 TTL		a19, c19
$\overline{\text{CICM}}$		1 TTL		a18, c18
SCCM	Store command from central processor; determines read/restore and clear/write cycle.	2 TTL		a17, c17
$ABCM_0$	Address bits from central processor.	2 TTL		a20, c20
$ABCM_1$		2 TTL		a21, c21
$ABCM_2$		2 TTL		a22, c22
$ABCM_3$		2 TTL		a23, c23
$ABCM_4$		2 TTL		a24, c24
$ABCM_5$		2 TTL		a25, c25
$ABCM_6$		2 TTL		a26, c26
$ABCM_7$		2 TTL		a27, c27
$ABCM_8$		2 TTL		a28, c28
$ABCM_9$		2 TTL		a29, c29
$ENCM_1$	Enable signal from central processor to select one out of four memory modules.	3 TTL	a1	
$ENCM_2$		3 TTL	a2	
$ENCM_3$		3 TTL	a3	
$ENCM_4$		3 TTL	a4	
$PBPM_0$	Program word bits from programming unit.	1 TTL	c1	
$PBPM_1$		1 TTL	c2	
$PBPM_2$		1 TTL	c3	
$PBPM_3$		1 TTL	c4	
$PBPM_4$		1 TTL	c5	
$PBPM_5$		1 TTL	c6	
$PBPM_6$		1 TTL	c7	
$PBPM_7$		1 TTL	c8	
$PBPM_8$		1 TTL	c9	
$PBPM_9$		1 TTL	c10	
$PBPM_{10}$		1 TTL	c11	
$PBPM_{11}$		1 TTL	c12	
$PBPM_{12}$		1 TTL	c13	
ENPB	Enables outputs $\overline{\text{PBMCP}}_{0\text{-}12}$; when LOW these outputs are enabled, when HIGH these outputs are disabled.	2 TTL	a6	

Output data

All outputs meet the standard TTL specifications.

output	function	loadability	terminations (Fig. 3) connector 1	connector 2
$PBMCP_0$	Program word bits from program memory to central processor and programming unit. Open collector output with pull-up resistor (3,9 kΩ).	9 TTL		a2, c2
$PBMCP_1$		9 TTL		a3, c3
$PBMCP_2$		9 TTL		a4, c4
$PBMCP_3$		9 TTL		a5, c5
$PBMCP_4$		9 TTL		a6, c6
$PBMCP_5$		9 TTL		a7, c7
$PBMCP_6$		9 TTL		a8, c8
$PBMCP_7$		9 TTL		a9, c9
$PBMCP_8$		9 TTL		a10, c10
$PBMCP_9$		9 TTL		a11, c11
$PBMCP_{10}$		9 TTL		a12, c12
$PBMCP_{11}$		9 TTL		a13, c13
$PBMCP_{12}$		9 TTL		a14, c14
$\overline{PBMCP}_0$	Inverted $PBMCP_{0-12}$ enabled by ENPB (three-state outputs).	10TTL	c17	
$\overline{PBMCP}_1$		10TTL	c18	
$\overline{PBMCP}_2$		10TTL	c19	
$\overline{PBMCP}_3$		10TTL	c20	
$\overline{PBMCP}_4$		10TTL	c21	
$\overline{PBMCP}_5$		10TTL	c22	
$\overline{PBMCP}_6$		10TTL	c23	
$\overline{PBMCP}_7$		10TTL	c24	
$\overline{PBMCP}_8$		10TTL	c25	
$\overline{PBMCP}_9$		10TTL	c26	
$\overline{PBMCP}_{10}$		10TTL	c27	
$\overline{PBMCP}_{11}$		10TTL	c28	
$\overline{PBMCP}_{12}$		10TTL	c29	
DA	Data available signal. This signal becomes LOW max. 150 ns after CICM (or $\overline{CICM}$), and goes HIGH as soon as the data become available at the outputs (max. 500 ns after CICM or $\overline{CICM}$). Open collector output with pull-up resistor (3,9 kΩ).	9 TTL		a16, c16

Time data

The relationship between the different input and output signals are given when the memory module is operating in a programmable logic controller system.

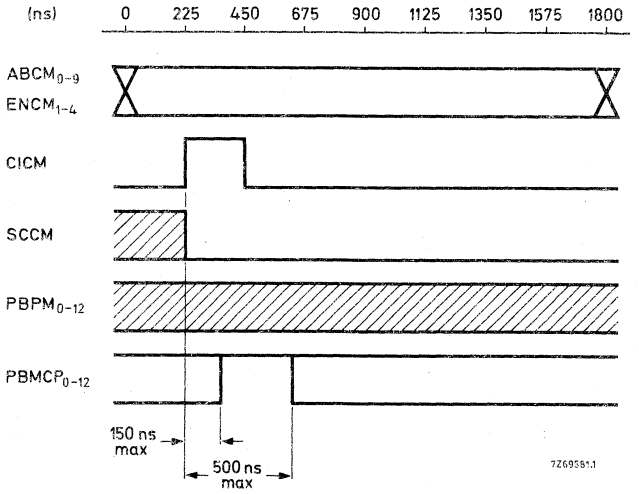


Fig. 1. Timing of read/restore mode.

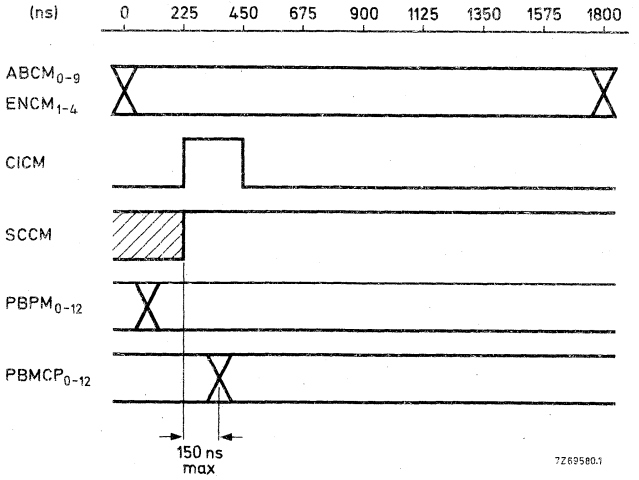


Fig. 2. Timing of clear/write mode.

MECHANICAL DATA

Dimensions in mm

Outlines

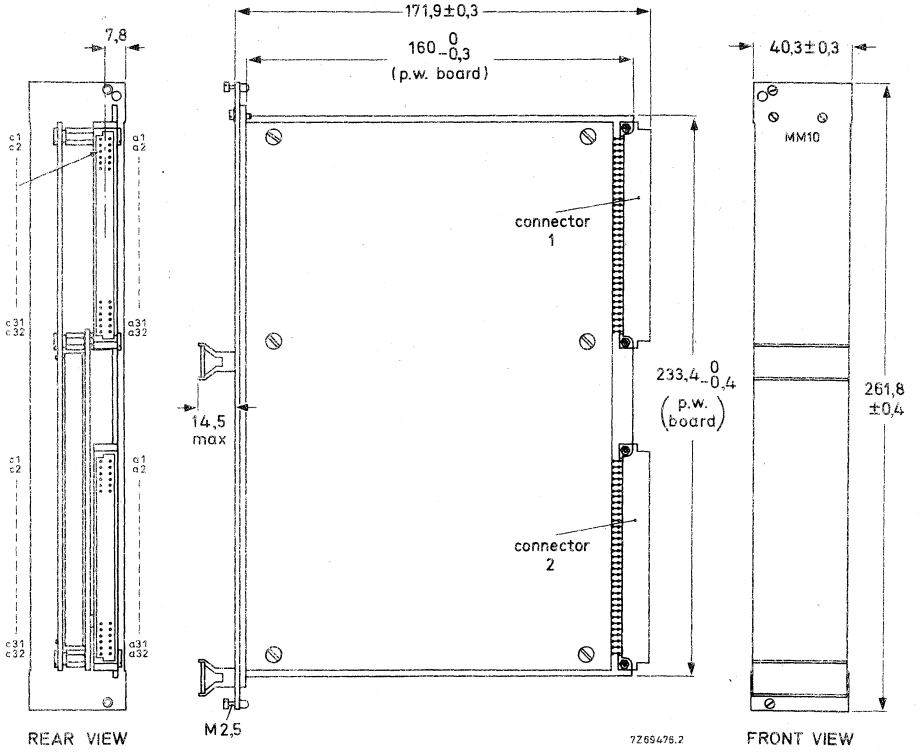


Fig. 3

Mass 780 g

Terminal location

connector 1

row c		row a
$PBPM_0$	1	$ENCM_1$
$PBPM_1$	2	$ENCM_2$
$PBPM_2$	3	$ENCM_3$
$PBPM_3$	4	$ENCM_4$
$PBPM_4$	5	n.c.
$PBPM_5$	6	ENPB
$PBPM_6$	7	n.c.
$PBPM_7$	8	n.c.
$PBPM_8$	9	n.c.
$PBPM_9$	10	n.c.
$PBPM_{10}$	11	n.c.
$PBPM_{11}$	12	n.c.
$PBPM_{12}$	13	n.c.
n.c.	14	n.c.
n.c.	15	n.c.
n.c.	16	n.c.
$\overline{PBMCP_0}$	17	n.c.
$\overline{PBMCP_1}$	18	n.c.
$\overline{PBMCP_2}$	19	n.c.
$\overline{PBMCP_3}$	20	n.c.
$\overline{PBMCP_4}$	21	n.c.
$\overline{PBMCP_5}$	22	n.c.
$\overline{PBMCP_6}$	23	n.c.
$\overline{PBMCP_7}$	24	n.c.
$\overline{PBMCP_8}$	25	n.c.
$\overline{PBMCP_9}$	26	n.c.
$\overline{PBMCP_{10}}$	27	n.c.
$\overline{PBMCP_{11}}$	28	n.c.
$\overline{PBMCP_{12}}$	29	n.c.
n.c.	30	n.c.
V_P	31	V_P
0 V	32	0 V

connector 2

row c		row a
n.c.	1	n.c.
$PBMCP_0$	2	$PBMCP_0$
$PBMCP_1$	3	$PBMCP_1$
$PBMCP_2$	4	$PBMCP_2$
$PBMCP_3$	5	$PBMCP_3$
$PBMCP_4$	6	$PBMCP_4$
$PBMCP_5$	7	$PBMCP_5$
$PBMCP_6$	8	$PBMCP_6$
$PBMCP_7$	9	$PBMCP_7$
$PBMCP_8$	10	$PBMCP_8$
$PBMCP_9$	11	$PBMCP_9$
$PBMCP_{10}$	12	$PBMCP_{10}$
$PBMCP_{11}$	13	$PBMCP_{11}$
$PBMCP_{12}$	14	$PBMCP_{12}$
i.c.	15	i.c.
DA	16	DA
$\overline{SCCM}$	17	$\overline{SCCM}$
$\overline{CICM}$	18	$\overline{CICM}$
CICM	19	CICM
$ABCM_0$	20	$ABCM_0$
$ABCM_1$	21	$ABCM_1$
$ABCM_2$	22	$ABCM_2$
$ABCM_3$	23	$ABCM_3$
$ABCM_4$	24	$ABCM_4$
$ABCM_5$	25	$ABCM_5$
$ABCM_6$	26	$ABCM_6$
$ABCM_7$	27	$ABCM_7$
$ABCM_8$	28	$ABCM_8$
$ABCM_9$	29	$ABCM_9$
i.c.	30	i.c.
V_P	31	V_P
0 V	32	0 V

n.c. = not connected.
i.c. = internal connection.

OUTPUT MODULE

DESCRIPTION

The output module is intended for use in combination with the central processor CP10 (or CP11), input module IM10 (or IM11), memory module MM10 and programming unit PU10 to assemble a programmable logic controller (PLC).

The output module contains 16 addressable output stages, equipped with photocouplers to obtain electrical isolation between external and internal circuitry (Fig. 1). All outputs are floating with respect to each other.
Each output stage has a suppressor diode, to allow it to switch inductive loads.
Each output stage also has a LED for status indication: it is lit when the output transistor is conducting.

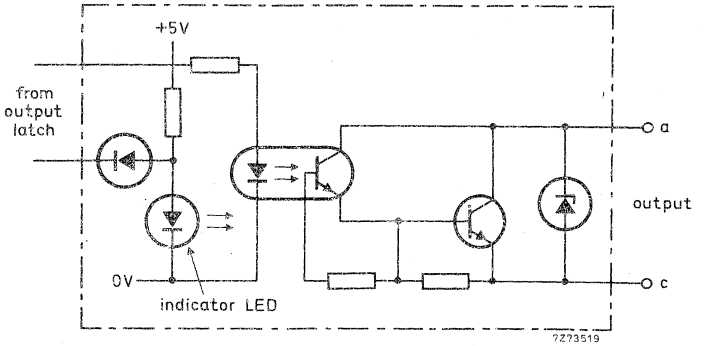


Fig. 1. Circuit diagram of an output stage.

The output module has nine address inputs ($ABCIO_{0-8}$) and five module identification inputs ($\overline{MID}_{0-4}$), which are accessible on the connectors at the rear (Fig. 2).

The circuit is built on an epoxy-glass printed-wiring board of 233,4 mm x 160 mm (Euro-card sytem). The board is provided with two F068-I connectors (board parts); the corresponding panel parts are available under catalogue number 2422 025 89291 (pins for wire wrap), 2422 025 89299 (pins for dip soldering) or 2422 025 89327 (solder tags) [1].

[1]) For a general description of the Euro-card system see IEC297 or DIN41494 for 19-in racks and IEC 130-14 or DIN41612 for connectors.

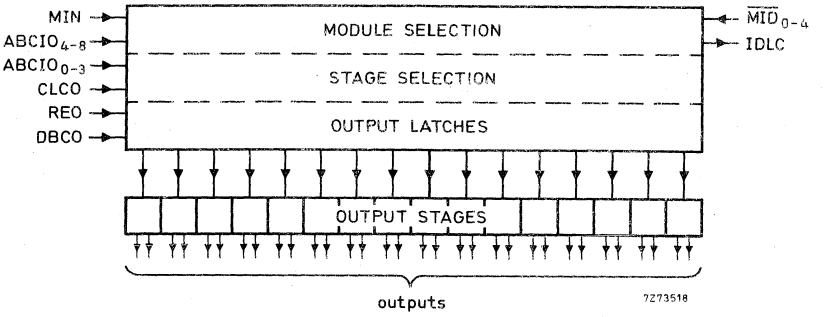


Fig. 2. Block diagram of the output module.

ELECTRICAL DATA

Supply

Supply voltage (d.c.)	V_P	5 V ± 5%
current	I_P	max. 1 A (all stages "ON")
		typ. 0,75 A (8 stages "ON", 8 stages "OFF")

Input data

All inputs meet the standard TTL specification except the CLCO-input.

input	function	load	terminations of connector 1 (Fig. 3)
$ABCIO_0$	Address bits from central processor; $ABCIO_{0-3}$ select the output stage, $ABCIO_{4-8}$ select the output module.	1 TTL	a2, c2
$ABCIO_1$		1 TTL	a4, c4
$ABCIO_2$		1 TTL	a6, c6
$ABCIO_3$		1 TTL	a8, c8
$ABCIO_4$		1 TTL	a10
$ABCIO_5$		1 TTL	a12
$ABCIO_6$		1 TTL	a14
$ABCIO_7$		1 TTL	a16
$ABCIO_8$		1 TTL	a18
DBCO	Data bit from central processor; data is stored in output stage by CLCO.	1 TTL	a22
MIN	Module inhibit signal from external source; a low level applied to this input inhibits data on DBCO to be stored in the output stage.	2 TTL	c26
REO	Reset output module line; a low level on this input will reset all output latches (output transistor non-conducting).	1 TTL	a24
$\overline{MID_0}$	Module identification inputs; provide module with individual identity.	2 TTL	c10
$\overline{MID_1}$		2 TTL	c12
$\overline{MID_2}$		2 TTL	c14
$\overline{MID_3}$		2 TTL	c16
$\overline{MID_4}$		2 TTL	c18
CLCO*	Clock signal from central processor to output module, stores data on DBCO into output stage during input/output cycle.	*	a28

*) Input with relatively high input resistance (typ. 40 kΩ).
CLCO-input, LOW level: max. 1 V;
HIGH level: min. 2,4 V.

Output data

The data outputs are DO_{XY0} to DO_{XY7} and DO_{XZ0} to DO_{XZ7}. They are accessible on connector 2, see "Terminal location".

Output transistor conducting : output current = max. 100 mA at V_{a-c}[1]) = max. 1,5 V

Output transistor non-conducting: output current = max. 10 µA at V_{a-c}[1]) = max. 30 V

Each data output has a suppressor diode, which allows the switching of loads with an inductance of max. 10 H.

[1]) Voltage between terminal of row a and terminal of row c of connector 2.

The output (open collector) below meets the standard TTL specifications.

output	function	loadability	terminations of connector 1 (Fig. 3)
IDLC	Identification signal from last output module to central processor (active HIGH); only the IDLC output of the last output module has to be connected with the IDLC input of the central processor.	2 TTL	a26

MECHANICAL DATA

Dimensions in mm

Outlines

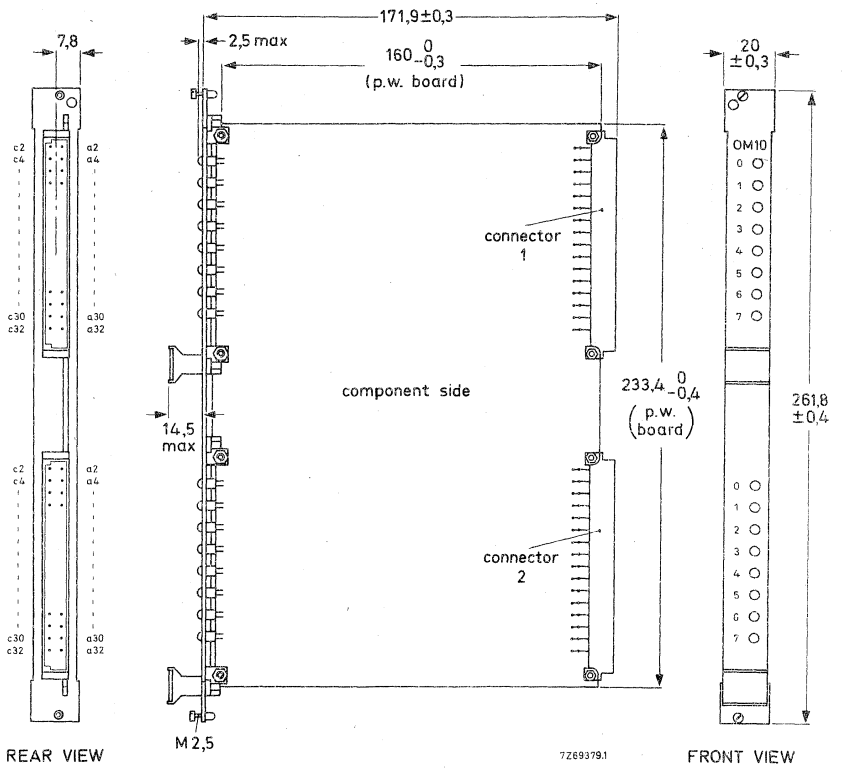


Fig. 3

Mass 230 g

Terminal location

connector 1

row c		row a
$ABCIO_0$	2	$ABCIO_0$
$ABCIO_1$	4	$ABCIO_1$
$ABCIO_2$	6	$ABCIO_2$
$ABCIO_3$	8	$ABCIO_3$
$\overline{MID_0}$	10	$ABCIO_4$
$\overline{MID_1}$	12	$ABCIO_5$
$\overline{MID_2}$	14	$ABCIO_6$
$\overline{MID_3}$	16	$ABCIO_7$
$\overline{MID_4}$	18	$ABCIO_8$
$0V^{1)}$	20	n.c.
$0V^{1)}$	22	DBCO
n.c.	24	REO
MIN	26	IDLC
$0V^{2)}$	28	CLCO
V_p	30	V_p
0V	32	0V

connector 2

row c		row a
DO_{XY0}	2	DO_{XY0}
DO_{XY1}	4	DO_{XY1}
DO_{XY2}	6	DO_{XY2}
DO_{XY3}	8	DO_{XY3}
DO_{XY4}	10	DO_{XY4}
DO_{XY5}	12	DO_{XY5}
DO_{XY6}	14	DO_{XY6}
DO_{XY7}	16	DO_{XY7}
DO_{XZ0}	18	DO_{XZ0}
DO_{XZ1}	20	DO_{XZ1}
DO_{XZ2}	22	DO_{XZ2}
DO_{XZ3}	24	DO_{XZ3}
DO_{XZ4}	26	DO_{XZ4}
DO_{XZ5}	28	DO_{XZ5}
DO_{XZ6}	30	DO_{XZ6}
DO_{XZ7}	32	DO_{XZ7}

n.c. = not connected.

1) No supply line; only to be used for coding of the $\overline{MID}_{0-4}$ lines.

2) No supply line; only to be used as a ground connection for CLCO.

PROGRAMMING UNIT

DESCRIPTION

The programming unit is intended for use in combination with the central processor CP10 (or CP11), input module IM10 (or IM11), memory module MM10 and output module OM10 to assemble a programmable logic controller (PLC).
The control program is written into the program memory with the aid of this unit, by means of the built-in keyboard, or from a punched tape.
The unit can also be used to read the contents of the program memory: eight seven-segments LED displays show the program line number (memory address) and the program word belonging to it. Each program word contains a scratch-pad memory address; the content of this address (1 or 0) is indicated by the status indicator LED.

Programming a system by means of the keyboard (or a punched tape) is only possible when the key switch of the programming unit is set to the on position. The key switch determines the authority of the unit: with a key the user has the complete command of the PLC, without a key he can only monitor its actions.

The keyboard comprises 13 keys (Fig. 3):
- 9 keys, marked 0 to 7 and *, with which the program word is typed in;
- 1 key, marked ENTER; by pressing this key the displayed program word is transferred to the program memory. As soon as the key is released the program memory is set to the read mode; the programming unit reads the contents of the program memory and the program word is again displayed as a check that it is written correctly into the program memory.
- 1 key marked STEP; by pressing this key the next memory address is selected. Each time this key is pressed the line number is incremented by one.
- 1 key, marked CIRC, a repetitive STEP key; by pressing this key the line number is incremented continuously with a frequency of approx. 50 Hz.
- 1 key, marked DECR; by pressing this key simultaneously with either the STEP or CIRC keys, the line number is decremented by one or continuously respectively.

When the key switch is in the off position only the STEP, CIRC and DECR keys are operative. When selecting a particular address by means of these keys, the program word is displayed and the status of the scratch-pad memory address specified in the program word is indicated. In this way the PLC can be monitored without disrupting the working system.

If a punched tape is used, it must be coded according to the ASCII code. The characters to be used for the ENTER and the STEP commands are > and < respectively.

The unit is so constructed that it can be plugged into the PLC; after loading the program into the memory module the PU10 can be removed to be used in another PLC system.

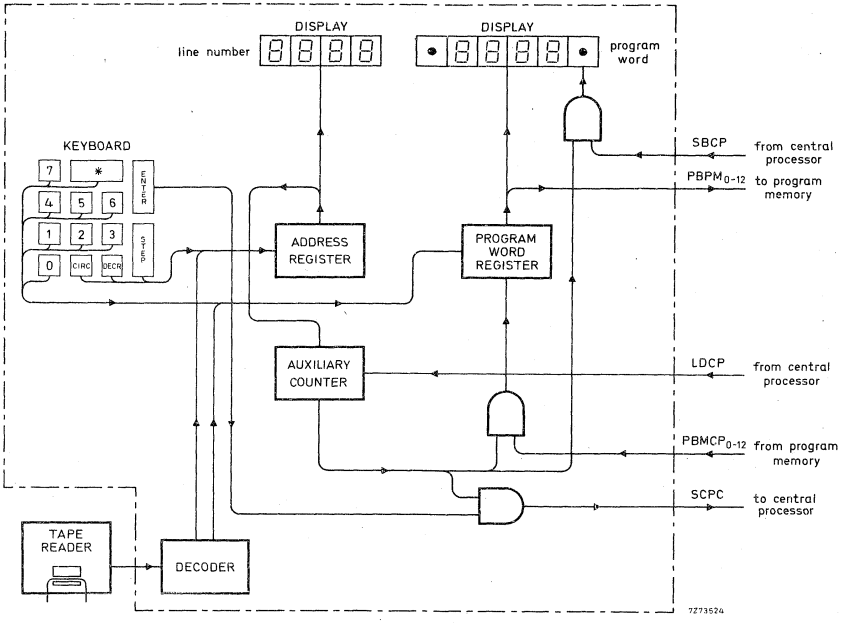


Fig. 1. Simplified block diagram of the programming unit.

The circuit is built on two epoxy-glass printed-wiring boards, mounted in a metal housing, which fits into the Euro-card system. The unit is provided with two F068-I connectors (board parts); the corresponding panel parts are available under catalogue number 2422 025 89291 (pins for wire wrap), 2422 025 89299 (pins for dip soldering) or 2422 025 89327 (solder tags) [1].

[1] For a general description of the Euro-card system see IEC 297 or DIN 41494 for 19-in racks and IEC 130-14 or DIN 41612 for connectors.

ELECTRICAL DATA

Supply

Supply voltage (d.c.)	V_p	5 V ± 5%
current	I_p	max. 2 A
		typ. 1,8 A

Input data

All inputs meet the standard TTL specifications.

input	function	load	terminations (Fig. 2)	
			connector 1	connector 2
$PBMCP_0$	Program word bits from program memory.	1 TTL		c2
$PBMCP_1$		1 TTL		a2
$PBMCP_2$		1 TTL		c4
$PBMCP_3$		1 TTL		a4
$PBMCP_4$		1 TTL		c6
$PBMCP_5$		1 TTL		a6
$PBMCP_6$		1 TTL		c8
$PBMCP_7$		1 TTL		a8
$PBMCP_8$		1 TTL		c10
$PBMCP_9$		1 TTL		a10
$PBMCP_{10}$		1 TTL		c12
$PBMCP_{11}$		1 TTL		a12
$PBMCP_{12}$		1 TTL		c14
LDCP	Synchronization input from central processor; synchronizes auxiliary address counter in programming unit with address counter in central processor.	1 TTL	a14	
$\overline{CL}_{23}$	Inverted clock input from central processor.	1 TTL	c16	
ϕ_{57}	Clock signal for status indication from central processor.	1 TTL		c16
SBCP	Status bit from central processor; clocked by ϕ_{57} it indicates state 1 or 0 at selected scratch-pad memory address.	1 TTL	a16	
TB_1	Tape bits (ASCII code) from tape reader	2 TTL	c18	
TB_2			a18	
TB_3			c20	
TB_4			a20	
TB_5			c22	
TB_6			a22	
TB_7			c24	

input	function	load	terminations (Fig. 2)	
			connector 1	connector 2
STROBE	Signal from tape-reader sprocket.	2 TTL	a24	
SLTP	Selection signal from tape reader or external switch; if tape reader is used the input must be connected to the logic LOW level.	2 TTL	c28	

Output data

All outputs meet the standard TTL specifications.

output	function	loada-bility	terminations (Fig. 2)	
			connector 1	connector 2
$PBPM_0$	Program word bits to program memory.	9 TTL	c2	
$PBPM_1$		9 TTL	a2	
$PBPM_2$		9 TTL	c4	
$PBPM_3$		9 TTL	a4	
$PBPM_4$		9 TTL	c6	
$PBPM_5$		9 TTL	a6	
$PBPM_6$		9 TTL	c8	
$PBPM_7$		9 TTL	a8	
$PBPM_8$		9 TTL	c10	
$PBPM_9$		9 TTL	a10	
$PBPM_{10}$		9 TTL	c12	
$PBPM_{11}$		9 TTL	a12	
$PBPM_{12}$		9 TTL	c14	
$\overline{ABP}_0$	Inverted address bits (line number bits to external printer).	10 TTL		c18
$\overline{ABP}_1$		10 TTL		a18
$\overline{ABP}_2$		10 TTL		c20
$\overline{ABP}_3$		10 TTL		a20
$\overline{ABP}_4$		10 TTL		c22
$\overline{ABP}_5$		10 TTL		a22
$\overline{ABP}_6$		10 TTL		c24
$\overline{ABP}_7$		10 TTL		a24
$\overline{ABP}_8$		10 TTL		c26
$\overline{ABP}_9$		10 TTL		a26
$\overline{ABP}_{10}$		10 TTL		c28
$\overline{ABP}_{11}$		10 TTL		a28
READY	Signal indicating that contents of program memory address counter agrees with line number.	10 TTL		a16

output	function	loadability	terminations (Fig. 2)	
			connector 1	connector 2
SCPC	Store command to central processor.	10 TTL		a14
BSP	Busy signal to external tape reader; the output becomes LOW when a correct code has been recognized, and becomes HIGH when this code has been stored.	10 TTL	c26	
$\overline{BSP}$	Inverted BSP.	10 TTL	a26	

Time data

If a tape reader is used for loading the control program into the program memory the following considerations have to be taken in account.

Delay time between the level changes on TB_{1-7} and strobe signal	t_1	min.	0 ns
Delay time between leading edge of strobe pulse and code recognition on BSP	t_2	max.	500 ns
Strobe pulse duration	t_s	min.	2 µs
		max.	10 ms

BSP becomes LOW when a correct code has been recognized and HIGH when this code has been stored. At this moment the tape reader can be started to give the next code.

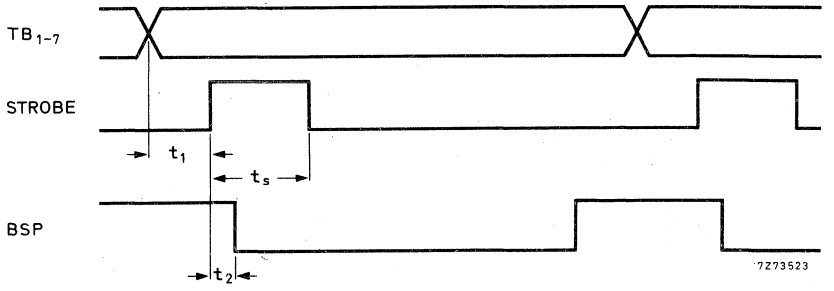


Fig. 2

MECHANICAL DATA

Dimensions in mm

Outlines

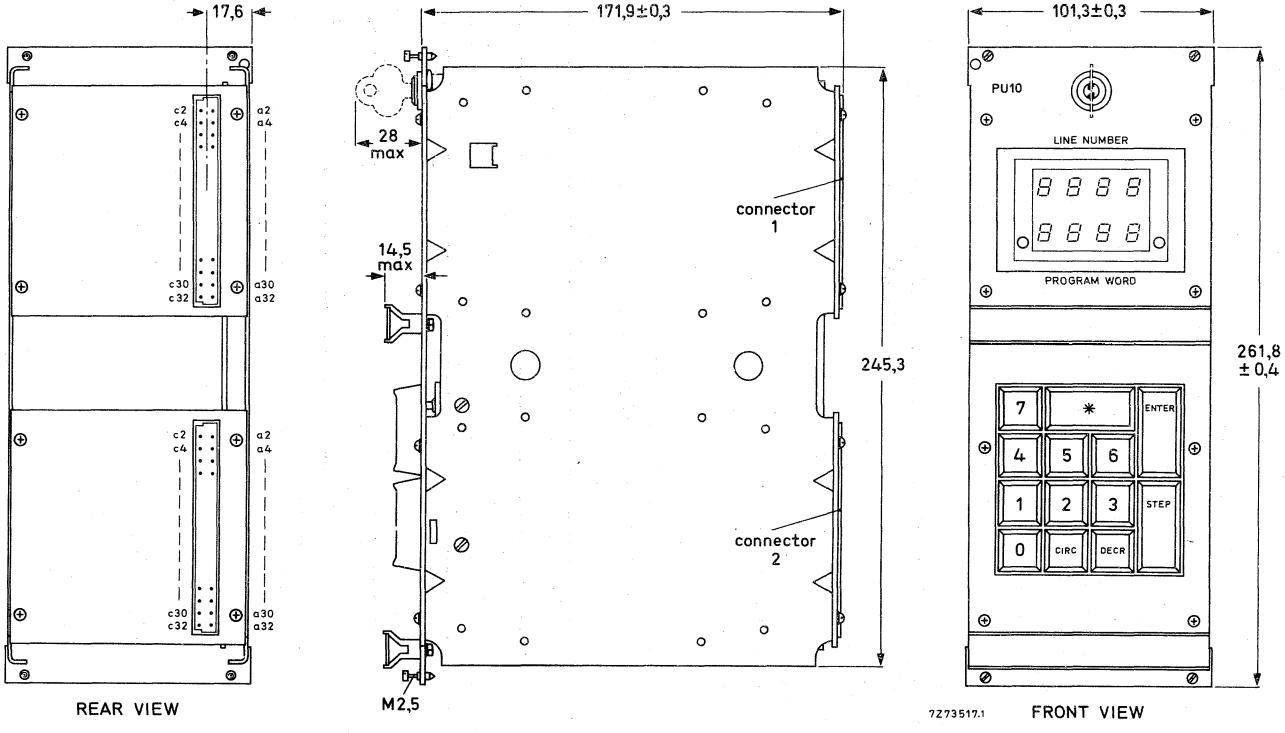


Fig. 3

Mass 1140 g

Terminal location

connector 1			connector 2		
row c		row a	row c		row a
$PBPM_0$	2	$PBPM_1$	$PBMCP_0$	2	$PBMCP_1$
$PBPM_2$	4	$PBPM_3$	$PBMCP_2$	4	$PBMCP_3$
$PBPM_4$	6	$PBPM_5$	$PBMCP_4$	6	$PBMCP_5$
$PBPM_6$	8	$PBPM_7$	$PBMCP_6$	8	$PBMCP_7$
$PBPM_8$	10	$PBPM_9$	$PBMCP_8$	10	$PBMCP_9$
$PBPM_{10}$	12	$PBPM_{11}$	$PBMCP_{10}$	12	$PBMCP_{11}$
$\overline{PBPM}_{12}$	14	LDCP	$PBMCP_{12}$	14	SCPC
$\overline{CL}_{23}$	16	SBCP	ϕ_{57}	16	READY
TB_1	18	TB_2	$\overline{ABP}_0$	18	$\overline{ABP}_1$
TB_3	20	TB_4	$\overline{ABP}_2$	20	$\overline{ABP}_3$
TB_5	22	TB_6	$\overline{ABP}_4$	22	$\overline{ABP}_5$
TB_7	24	$\overline{STROBE}$	$\overline{ABP}_6$	24	$\overline{ABP}_7$
BSP	26	$\overline{BSP}$	$\overline{ABP}_8$	26	$\overline{ABP}_9$
SLTP	28	n.c.	$\overline{ABP}_{10}$	28	$\overline{ABP}_{11}$
Vp	30	Vp	Vp	30	Vp
0 V	32	0 V	0 V	32	0 V

n.c. = not connected.

Input/output devices

INTRODUCTION

Input devices

Industrial control systems require compatible input devices that are capable of deriving signals representative of controlled or otherwise pertinent conditions. Though the information to be dealt with may take a variety of forms - e.g. presence, position, movement, rotation etc. - many different situations can be covered by a comparitively small selection of input devices.
The requirements of each situation determine the physical principle to be employed in the input device.
For reasons of speed and reliability it is preferable to avoid mechanical contact in deriving the input signal, and often an all-static method of derivation is required. Experience with input devices has made it clear that skilful use of them can greatly improve machine output and reliability.

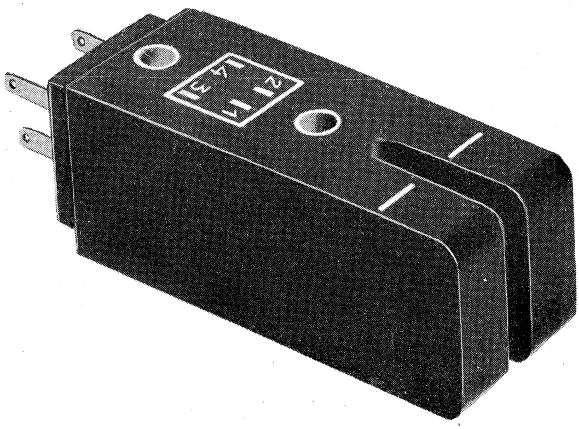
Output devices

It is often necessary to display numerical information concerning situations or values (e.g. position, temperature, time, weight, price, etc.). Our range of numerical display units has been designed to display numbers that are legible at a distance of tens of metres, to be applied in industry, in congress halls, for indoor sports, on platforms, etc.

In this series the following units are available:

VANE SWITCHED OSCILLATOR

720809-21-01



Supply voltage	12 V_{dc}
Operating-temperature range	-25 to +85 °C

APPLICATION

The vane switched oscillator can be applied as a static switching device, the switching action being determined by the position of a vane. For the vane any metal can be used.

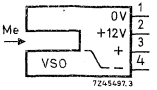
CONSTRUCTION

The vane switched oscillator consists of an oscillator and a diode rectifier. The latter is connected to a separate coupling winding of the oscillator coil, thus providing an isolated d.c. output.
The lay-out of the oscillator is such that upon inserting a suitable piece of metal (vane) in a gap between the oscillator coil windings, the oscillation stops and the d.c. output of the unit will drop to zero.
The complete circuit is encapsulated in epoxy resin.

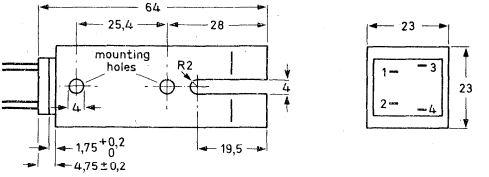
1 = −
2 = +
} supply

3 = +
4 = −
} output

Terminal location



Drawing symbol



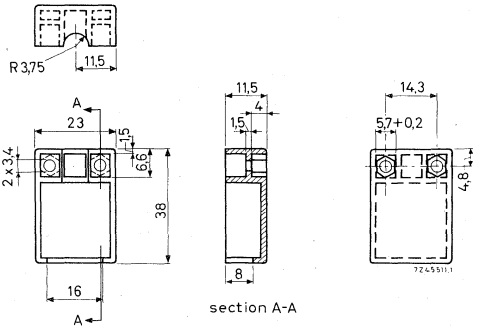
Dimensions (mm)

The weight (without cable anchoring cover) is 42 g.

The unit may be mounted in any position. Two mounting holes allow the use of 4 mm bolts. The bolts should be tightened with a torque of maximum 450 mNm provided that washers are used. Stacking of units is permitted. If two or more units are stacked (gaps in line), they must be placed back to back/front to front.

Connection can be made by 0,110 inch Fastons or by soldering.
A cable anchoring cover, consisting of two equal caps (as shown in the figure below), is supplied with each VSO.

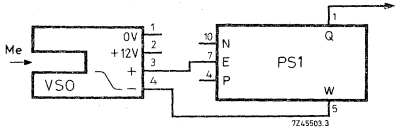
The lines on the arms of the VSO indicate the centre of the oscillator coil windings.

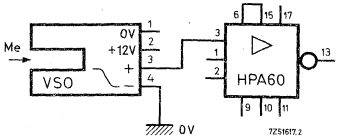


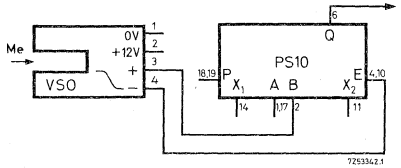
Cable anchoring cover

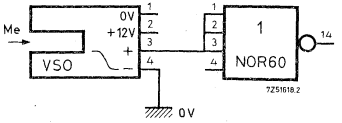
ELECTRICAL DATA

Supply voltage	12 V_{dc} ± 10% or +6 V_{dc} ± 10% and −6 V_{dc} ± 10% (with common 0 V)
Consumed current (in both oscillating and non-oscillating condition)	12 mA ± 10%
Output voltage	5,75 V ± 15% open circuit , isolated from the supply. Maximum permissible voltage between 1-2 and 3-4 is 100 V_p Suited for driving the pulse shaper types PS 1* and PS 10**, and for driving the Norbit HPA60 and 2.NOR60 if three inputs are connected in parallel.









Output impedance (without vane)	4,1 kΩ ± 10%
Maximum detection frequency	1 kHz
Noise (over supply lines)	< 100 mV_{p-p}
Ambient temperature range operating storage	 −25 to +85 °C −40 to +85 °C

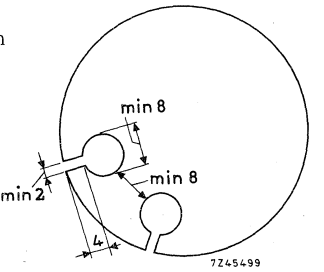
* circuit block 100 kHz series, catalog number 2722 001 11001
** circuit block 10-series , catalog number 2722 004 11001

APPLICATION INFORMATION (typical values)

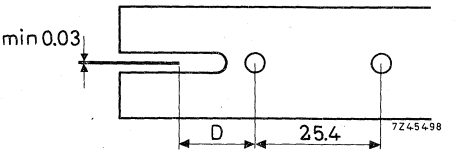
Vane material	any metal
Vane dimensions for aluminium:	
minimum width for a thickness of 2 mm	8 mm
minimum thickness	0,03 mm

As a rule of thumb the thickness of the vane should be about 10 x the electrical resistivity of the material used.

Instead of a vane a disc with holes of indicated dimensions may be used.



The data given below are based on a movement of an aluminium vane 50 x 50 x 2 mm in longitudinal direction.
The operating distance D (see figure below) is the distance at which the output just drops to zero (measured from the centre of the hole nearest to the gap).
Hysteresis is defined as the distance between the vane position at which oscillation ceases and that at which oscillation starts.

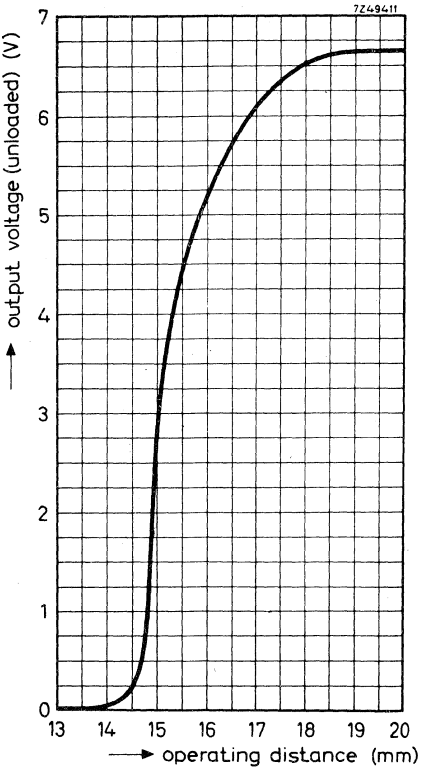


Operating distance D	
open circuit	14,6 ± 1,5 mm
with PS 1 or PS 10 (0 to 1)	15,3 ± 1 mm
Hysteresis	
open circuit	< 1 mm
with PS 1	0,03 mm
with PS 10	0,6 mm

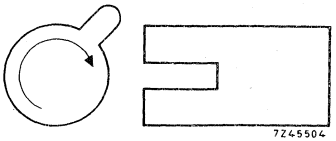
Variation of D with supply voltage

supply voltage	operating distance (mm)
nominal	D
nominal −5%	D +0,06
nominal +5%	D −0,06

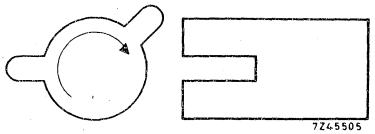
Variation of D with temperature (from −25 to +85 °C)	< 2.7 mm D is maximum at −25 °C
Variation of D with time (at T_{amb} = 25 °C and V_{supply} = 12 V ± 1%, reference point is half the unloaded output voltage of VSO without vane)	< 0.02 mm
Variation of output voltage with D	see typical curve, figure below. From the steep curve it can be seen that a switching point will be kept within very narrow mechanical tolerances.



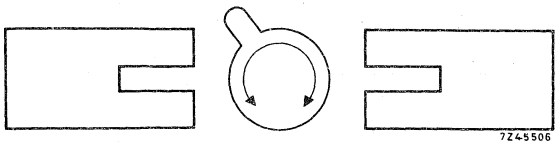
APPLICATION SUGGESTIONS



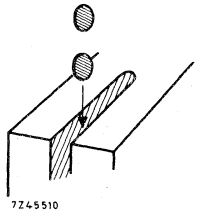
counting of revolutions



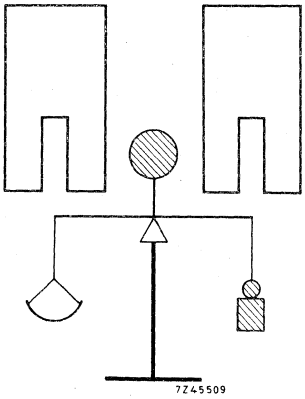
angular position switching (programming)



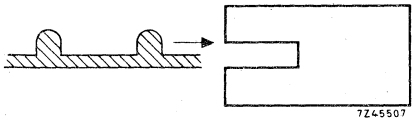
bidirectional counting



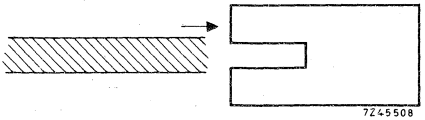
counting of small objects



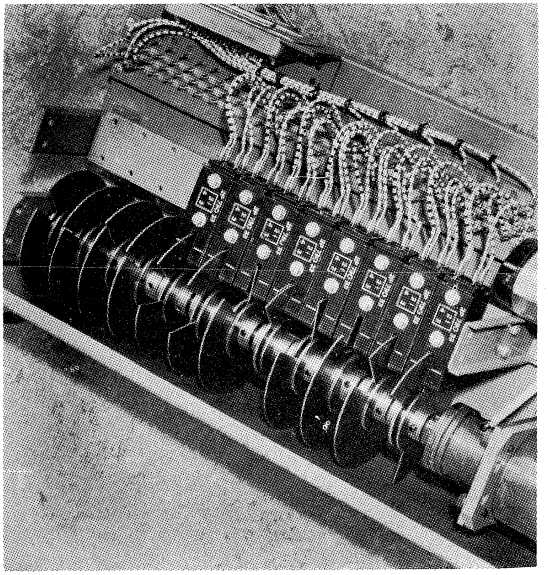
weighing or dosing



linear position switching (programming)

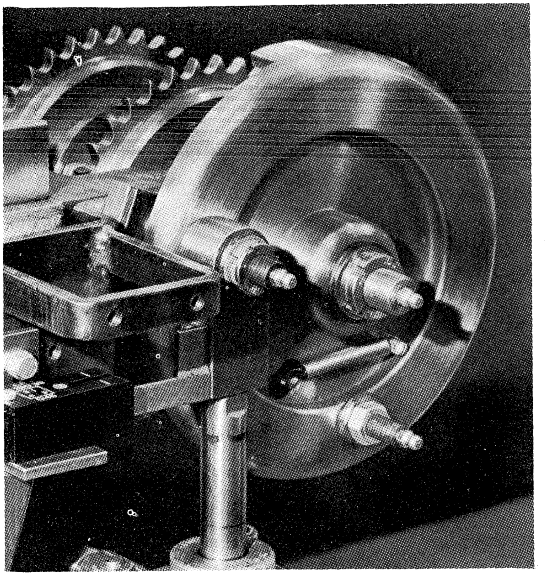


foil continuity check



Eight VSO's used in a disc programmer for control of a metal-working machine.

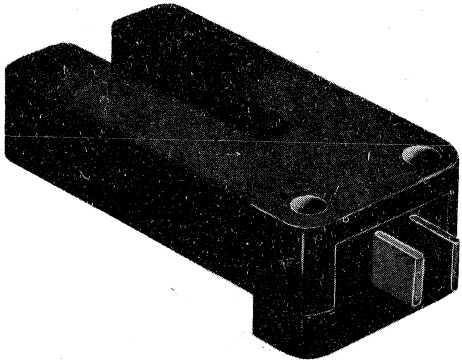
RK 9230-4



VSO control of pneumatic metal-forming machine.

RK 9230-5

IRON VANE SWITCHED REED



RZ21773-3

Maximum switching frequency	100 Hz
Operating-temperature range	−25 to +70 °C

APPLICATION

The iron vane switched reed can be applied as a limit switch, position indicator or as a signal source for low counting speeds.
In conjunction with d.c. amplifiers (UPA61, TT61 or TT60), the IVSR can be used for power switching.
As the IVSR is free from most of the difficulties encountered with mechanical switches, it can succesfully replace micro switches.

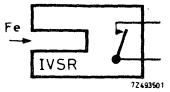
CONSTRUCTION

The IVSR consists of a magnet and a reed switch encapsulated in an U-shaped plastic housing.
When there is no piece of iron (vane) in the gap between the reed switch and the magnet, the reed switch is closed. Inserting a piece of iron of suitable dimensions in the gap reduces the magnetic flux through the reed to such an extent that the reed switch opens.
In this way it is possible to obtain signals that indicate the position of the iron vane.

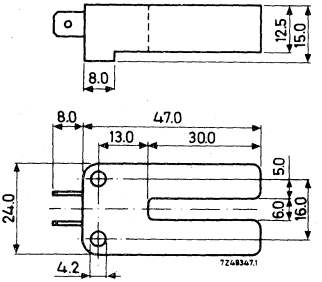
The weight is approximately 20 g.

The IVSR can be mounted in any position. Two mounting holes allow the use of 4 mm bolts. When IVSR's are mounted on a common support, the minimum distance between the housings is 36 mm, to avoid interaction. For mounting IVSR's over each other, this distance is 60 mm.

Connection can be made by means of 0,250" Fastons or by soldering.



Drawing symbol



Dimensions in mm

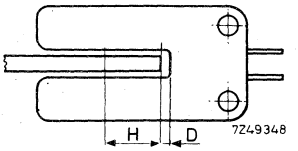
TECHNICAL PERFORMANCE

Load switching capacity (non inductive)	$\leq$ 1.2 VA
Voltage switching capacity	$\leq$ 32 V_{dc}
	$\leq$ 50 V_{ac}
Current switching capacity (non inductive)	$\leq$ 0.1 A_{dc}
Switching frequency	$\leq$ 100 Hz
Contact resistance, measured at 10 mV	
at open circuit	< 150 mΩ
Contact capacitance	$\leq$ 5 pF
Insulation resistance, measured at 250 V_{dc}	
at open circuit	$\geq 10^8$ Ω
Test voltage, measured at open circuit	
for 1 min	500 V_{dc}
Permissible operating-temperature range	-25 to +70 °C
Permissible storage-temperature range	-40 to +85 °C

APPLICATION INFORMATION (typical values)

Vane material	mild steel

The data given are based upon a movement of a mild steel vane 30 x 10 x 4 mm, placed centrally in the gap, in longitudinal direction.



The operating distance (D) is the distance between the front edge of the vane and the rear of the gap at which the reed switch opens.
The hysteresis (H) is defined as the distance between the vane position at which the reed switch opens and that at which the reed switch closes.

Operating distance	4 ± 3 mm
Hysteresis	10 ± 3 mm

APPLICATION SUGGESTIONS

As the reed switch is normally closed, the following two modes of operation can be distinguished:
- output voltage is present when there is no vane in the gap (Fig.a)
- output voltage is present when there is a vane in the gap (Fig.b)

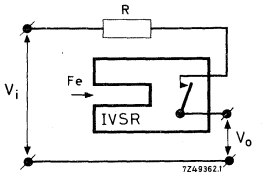


Fig.a

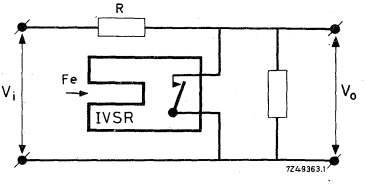


Fig.b

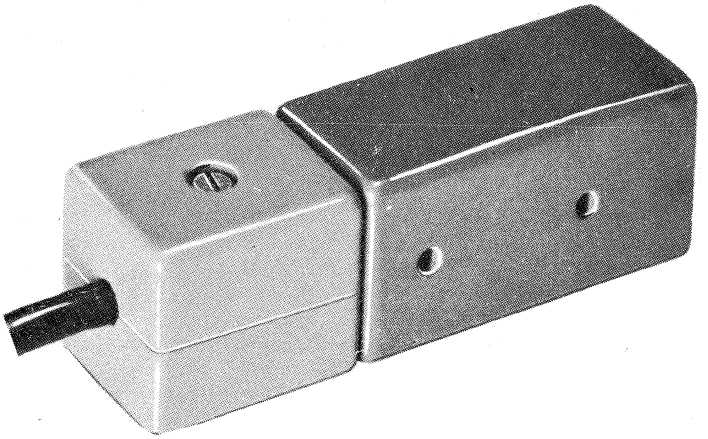
Notes

It is obvious that the IVSR should not be used in environments where iron dust or scraps might impair its operation.

It should be realised that capacitance directly across the switch terminals can be the cause of high currents through the switch at the moment of closing the contacts. This should be avoided by having sufficient resistance in the proper contact circuit.

In case the switch is used with electronic circuitry in which bounce might give rise to malfunctioning of the equipment, appropriate circuitry should be added to get rid of the bounce effect. The safe way out is the use of a one shot multivibrator.
Another solution that sometimes can be used, is applying a low pass RC network between the IVSR and the input of the equipment.

ELECTRONIC PROXIMITY DETECTOR



Supply voltage	12 V_{dc}
Maximum detection frequency	1 kHz
Operating-temperature range	−25 to +85 °C

GENERAL

The electronic proximity detector is a static switching device, the switching action being determined by the presence of a metallic object. The metal can be any electrically conducting material of rather arbitrary shape.
It can be applied as a detector for the presence, passage or position of metal parts and is a versatile tool in various industrial automation set-ups.

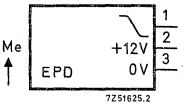
The EPD contains an oscillator which is link coupled to a detector. The detector is followed by an amplifier.
The oscillator coils and the coupling link are placed in a potcore half. In this way a well-defined field is set up in front of the open side of the potcore, located at the front side of the EPD. Bringing a piece of metal in this field the oscillator output and subsequently the output of the amplifier decreases, due to the loading effect of the eddy current losses in the metal.
When no piece of metal is near, the output voltage of the EPD is approximately 12 V. It will decrease in proportion to the reduction of the oscillator output, resulting from a metal object coming nearer.

The complete circuit is epoxy encapsulated in a polycarbonate housing.

The **mass** is approximately 120 g.

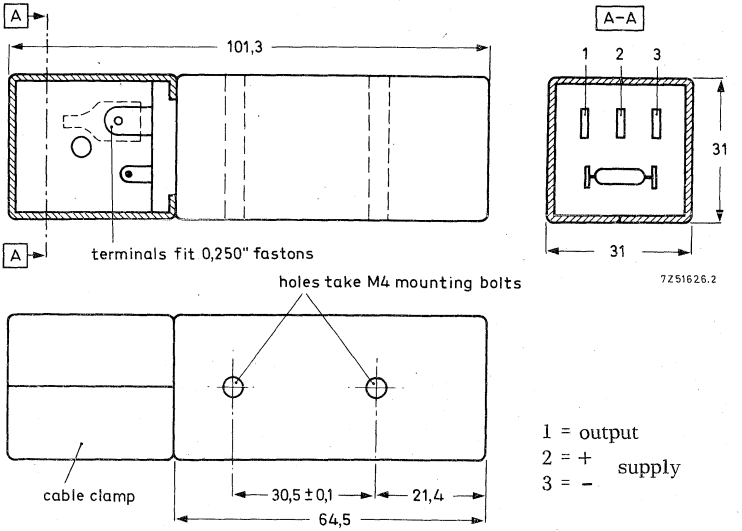
The unit may be mounted in any position. Two mounting holes allow the use of 4 mm bolts.

Connection can be made by 0,250" Fastons or by soldering. A cable clamp consisting of two equal caps is supplied with each EPD. This clamp permits either end or top entrance of a 3-core cable of 7 mm diameter.



Drawing symbol

Dimensions in mm



Note

The resistor between the two 0,110" Fastons is an adjustment resistor for the oscillator loop gain; it should not be changed.

TECHNICAL PERFORMANCE

Supply voltage, V_S (d.c.)	12 V ± 5% or +6 V ± 5% and −6 V ± 5% (with common 0 V) or 24 V via series resistor and 12 V zener diode, giving a stabilized supply voltage of 12 V. (See also Application Suggestions.)
limiting value	abs. max. 15 V* (destructive at $T_{amb} \geqslant 40$ °C)
Consumed current	max 17 mA
Output voltage, no object being detected object being detected	 approximately $V_S - 0{,}5$ V max 100 mV
Output resistance no object being detected object being detected	 700 Ω 3,4 kΩ
Hysteresis for output voltages of 100 mV – 11 V	0 mm
Output current no object being detected object being detected	 max 14 mA max 3,7 mA
Maximum detection frequency, mark to space ratio 1 : 1	1 kHz
Noise (over supply lines)	< 10 mV
Ambient temperature range operating storage	 −25 to +85 °C −40 to +85 °C

APPLICATION INFORMATION (typical values)

Detection graphs

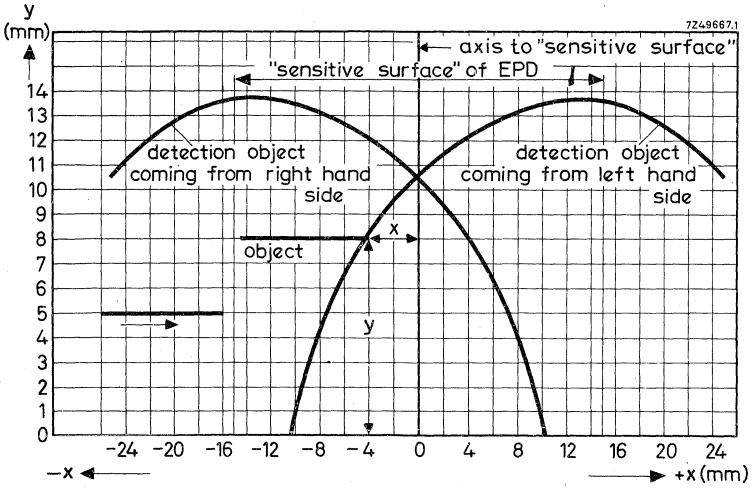
Detection of a rectangular mild steel reference object, 50 x 25 x 1 mm

Sensitive surface	surface of 31 x 31 mm at the opposite end of the EPD to the terminals
Axis	line perpendicular to the centre of the sensitive surface
Operating point	point at which the output voltage of the EPD is reduced to 100 mV (moment of detection)

* Reversal of supply voltage will damage the detector.

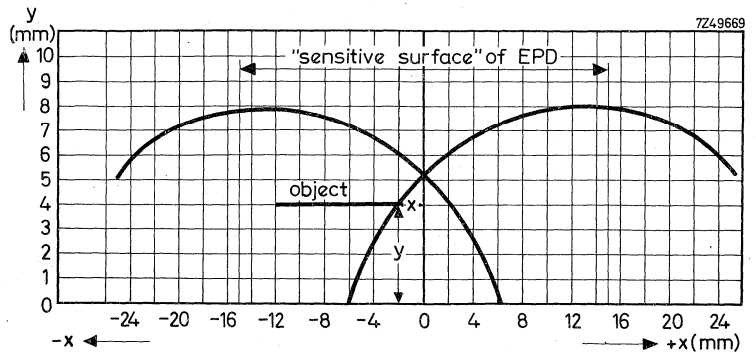
Operating distance — distance of the leading edge of the reference object to the axis at the operating point (x-operating distance)

Detection range — distance of the reference object to the sensitive surface (y-operating distance)



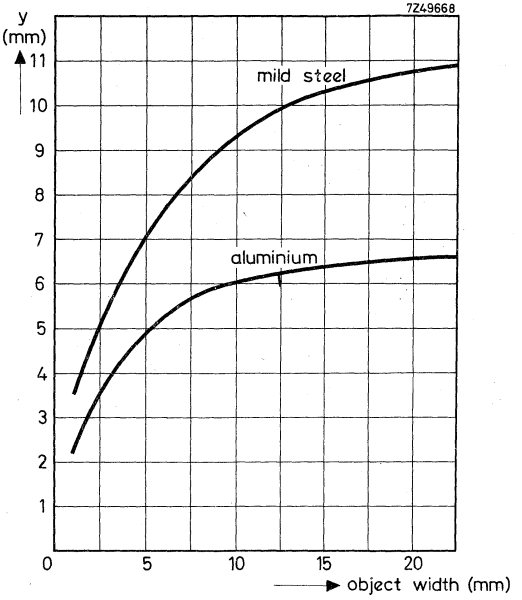
From the graph it can be seen that the object is detected before the axis is reached if it passes at a distance of < 10 mm from the sensitive surface. If it passes at a distance of e.g. 13.5 mm, the object is detected after the axis has been passed.

Detection of a rectangular aluminium reference object, 50 x 25 x 1 mm

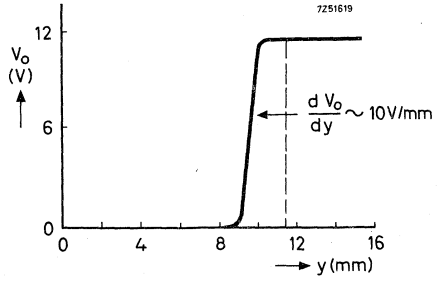


Detection of rectangular mild steel and aluminium reference objects (50 x 1 mm) with different widths

Object approaches the centre of the sensitive surface perpendicularly from in front.



Output voltage as a function of the position of a rectangular mild steel reference object, 50 x 25 x 1 mm



Upon frontal approach of the object to the sensitive surface, the output voltage of the EPD will change from over 11 V to 100 mV within 1 mm from the position in which the output voltage starts to change.
This characteristic is extremely important when the EPD is used as a position detector.

Notes:

The detection graphs may differ slightly from unit to unit.

Quite small objects can be detected when brought close to the sensitive surface. Thickness is relatively unimportant as eddy currents occur in penetration layer only.

Influence of supply voltage variations

A supply voltage variation of ±5% produces a change of ±0.1 mm in y-operating distance, at 10 mm from the sensitive surface.

Influence of temperature

With the reference object at a y-operating distance of 10 mm (at −25 °C) a change in temperature of both EPD and object will cause the y-operating distance to change less than 2 mm over the range from −25° to +85 °C.

Direction of approach

As the exterior field is rotation symmetrical the path along which the detection position is reached is immaterial.

Distance from metallic surroundings

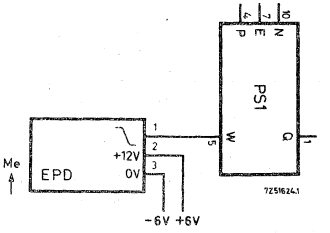
Clearance from metallic surrounding: 30 mm (this applies for sensitive front part of unit).

Spacing required between two detector axes with sensitive surface in the same plane: 60 mm.

Spacing required between two reference objects to give discrete detection: 50 mm. (This property can be put to use in feeder systems, a gap being used to initiate part supply restart.)

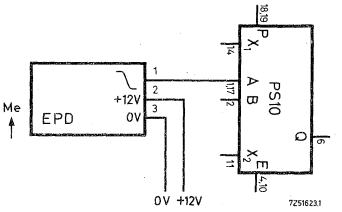
APPLICATION SUGGESTIONS *)

EPD in conjunction with 100 kHz-Series circuit blocks

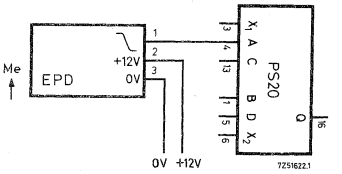


*) With long cables between EPD and subsequent electronics RC decoupling of interference can be employed.

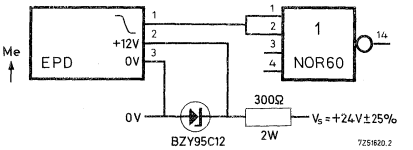
EPD in conjunction with 10-Series circuit blocks

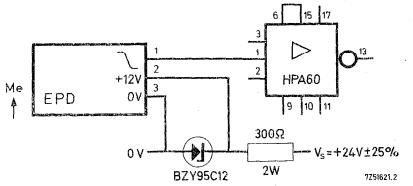


EPD in conjunction with 20-Series circuit blocks



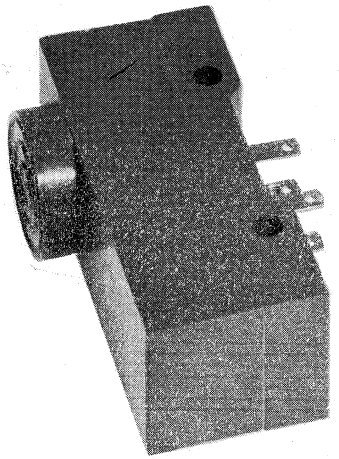
EPD in conjunction with 60-Series Norbits





MINIATURE ELECTRONIC PROXIMITY DETECTOR

QUICK REFERENCE DATA	
Supply voltage	24 V (d.c.) ±25%, or 12 V (d.c.) ± 5%
Maximum detection frequency	1 kHz
Operating temperature range	−25 to + 70 °C
Detection range	3 mm



RZ 28513-2

APPLICATION

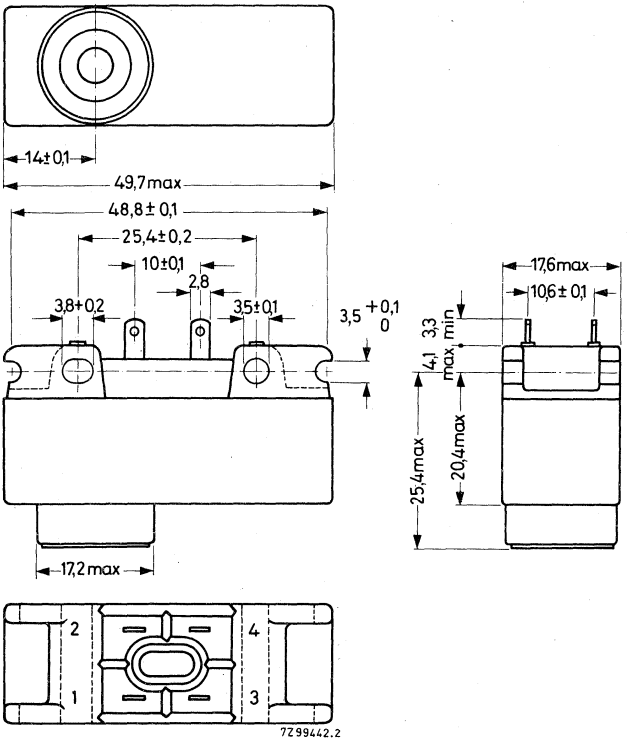
The EPD 60 can be applied as a static switching device, the switching action being determined by the position of a metal object. In this way a static equivalent for the well-known mechanical miniature switch is obtained.

DESCRIPTION

The circuit consists of an oscillator followed by a detector and an amplifier.
The oscillator coil, placed in a potcore half, which is located in the cylindrical part of the housing, sets up a well defined field.
If there is no metal object in the field of the coil the output is low, if a metal object of adequate size is brought far enough into the field, the oscillator will be damped in such a way that the output of the unit goes "high".
The unit is potted in a polydiallylphtalate resin housing, the dimensions of which are compatible with standard mechanical miniature switch housings, see photograph below. Connection to the unit can be made by means of 0.110 inch Fastons or by soldering.

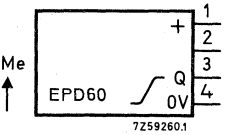
MECHANICAL DATA

Dimensions (mm)



Terminal location

Terminal 1 = +24 V
2 = +12 V (connect 2 and 1)
3 = output (Q)
4 = 0 V common



Drawing symbol

Colour red

Weight 30 g approximately

Mounting

The unit may be mounted in any position. Two mounting holes allow the use of 3 mm bolts. Two grooves in the short sides are provided for bar mounting. Any number of units may be stacked side by side.

ELECTRICAL DATA

Supply voltage (V_S) *)	+24 V ±25%, or +12 V ± 5%
Consumed current (nominal)	15 mA
Limiting value of V_S	
terminal 1	+35 V
terminal 2	+15 V
Ambient temperature range	
operating	−25 to +70 °C
storage	−40 to +70 °C
Maximum detection frequency	1 kHz
Noise on supply lines due to switching	< 5 mV

Output data

			V_S = +24 V		V_S = +12 V	
Output low	at I_Q	=	0	mA	0	mA
	max. V_Q	=	+0.3	V	+0.3	V
Output resistance		=	3	kΩ	3	kΩ
Output high	at − I_Q	=	0.41	mA	0.20	mA
	and at min. V_S	=	18.0	V	11.4	V
	at loading equivalent	=	3 D.U. in 24 V nom. 60-Series operation		2 D.U. in 12 V nom. 60-Series operation	
	V_Q	=	min.+11.4	V	min.+8.3	V
	max. V_Q	=	max.V_S		max.V_S	
Output resistance		=	15	kΩ	15	kΩ

External short-circuit (from Q to V_S and from Q to 0V common) is not destructive.

APPLICATION INFORMATION

The EPD 60 can be switched by moving either a ferrous or a non-ferrous metal object of any size and form in front of the detection head. If the object is ferrous the resulting damping on the oscillator is proportional to the volume of the object; in the case of a non-ferrous object it is governed by the conductivity of the material. Thus, a perfect conductor cannot be detected unless it is sufficiently thin and brought close to the detection head.

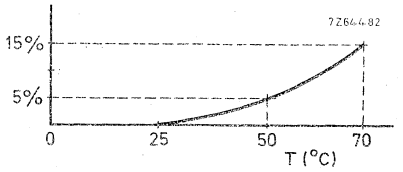
*) Accidental polarity reversal is not destructive.

Operating distance

The operating distance (X) is the distance between the centre of an object and the centre of the detection head at which the output is about to go "high" (measured axially)

For circular steel disc (ϕ15 mm), d = 0, 2 mm in centre of axis, X = 3 mm ± 10%

Influence of temperature in % of X_{nom}



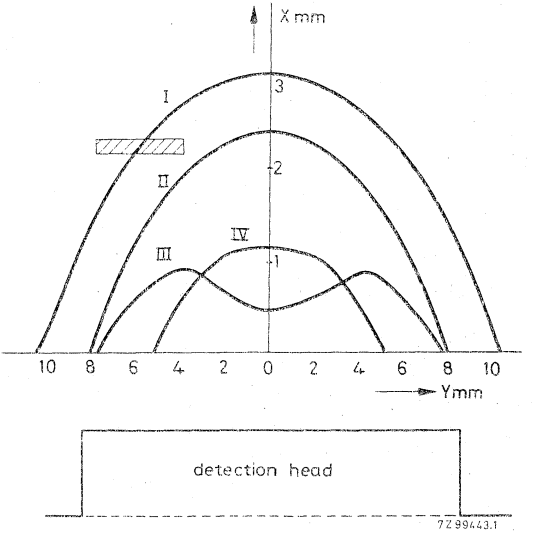
Influence of supply voltage (18 to 30 V) $\Delta X < 20\,\mu m$

Hysteresis $< 50\,\mu m$

For reference purposes four standard objects are used:

Object I : mild steel, circular disc Ø 15 mm, thickness 0.2 mm
Object II : mild steel, circular disc Ø 10 mm, thickness 0.2 mm
Object III : copper, circular disc Ø 15 mm, thickness 0.04 mm
Object IV : copper, circular disc Ø 10 mm, thickness 0.04 mm

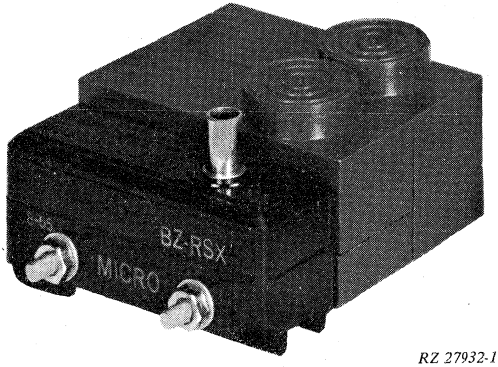
The graph below gives X for each of the four standard objects traversing the sensitive area of the detection head along any straight line parallel to the surface of the head, intersecting the axis of the head.



CLIMATIC TESTS

According to 60-series Norbits

Protection degree according to DIN 40.050 P55 (IP66)



RZ 27932-12

The photograph shows two EPD 60's together with a "Microswitch".

INDUCTIVE PROXIMITY DETECTOR

QUICK REFERENCE DATA	
Supply voltage (d.c.)	10 to 30 V
Maximum detection frequency	min. 1,5 kHz
Operating temperature range	−25 to +70 °C
Operating distance	1 mm
Protection degree	IP67

APPLICATION

The IPD080 can be applied as a detector for the presence, passage or position of metal parts and is a versatile tool in various industrial automation set-ups.

DESCRIPTION

The circuit consists of an oscillator, a detector, and a Schmitt trigger amplifier, housed in a chromium-plated brass tube. Three connecting leads (each having a 0,14 mm^2 cross-section) are brought out at one end and the oscillator coil is mounted at the other end. The oscillator coil sets up a well-defined magnetic field which, when clear, gives the circuit a HIGH output. If a metal object is brought into the magnetic field, the oscillator is damped and the circuit output goes LOW.
The tubular envelope is threaded and provided with two M8 nuts to enable mounting of the unit (see Fig. 1).
Except for the ganging the unit conforms CENELEC publication EN50008.

MECHANICAL DATA

Dimensions in mm

Outlines and connections

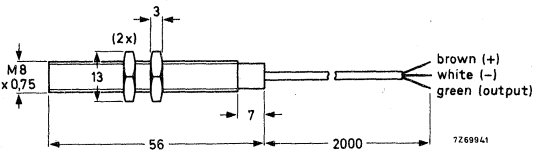


Fig. 1

Mass 45 g approximately

Mounting

The unit may be mounted in any position by means of the two nuts.

Degree of protection (IEC144) IP67

ELECTRICAL DATA

Unless otherwise specified all values apply at an ambient temperature of 25 °C.

Supply voltage V_S (d.c.)		10 to 30 V
current (no load)	V_S = 12 V	4,5 mA
	V_S = 24 V	9,2 mA
Ambient temperature range		
operating		−25 to +70 °C
storage		−40 to +85 °C

Output data

Detector activated	
voltage LOW	max. 1 V
minimum load resistance	450 Ω
Detector non-activated	
voltage HIGH	max. V_S
internal resistance	12 kΩ

The output is protected against inductive loads.

OPERATING DATA

The detection sensitivity is dependent on the dimensions and the material of the object in front of the detection head.
The operating distance X (see Fig. 2) is defined as the distance between the centre of the detected object and the surface of the detection head (measured axially), at which the circuit output switches from HIGH to LOW.

For a circular mild steel disc, diameter 6 mm, thickness 0,2 mm:

Operating distance (X)	1 mm ± 10%
Influence of temperature	2 µm/°C
Influence of supply voltage	1 µm/V
Hysteresis	3 to 10%
Reproducibility	5%
Maximum detection frequency	min. 1,5 kHz

Reduction factor on X for other metals of the same dimensions:

chromium	0,9
brass	0,5
aluminium	0,45
copper	0,4

Fig. 2 shows the operating distance curve for the above-mentioned mild steel disc. Y can be considered as any radial axis cutting the axial centre line of the detection head.

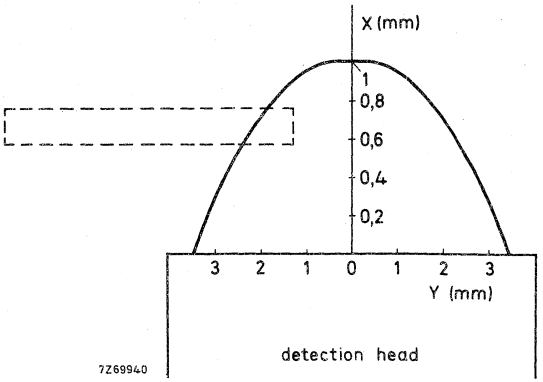


Fig. 2

TEST SPECIFICATIONS

Detector non-operative

1. Shock test according to IEC68-2-27 (test Ea):
   3 blows 50g for 11 ms, in 6 directions.
2. Vibration test according to IEC68-2-6 (test Fc):
   10 to 150 Hz, amplitude 0,76 mm or 10g maximum; sweep time 1 octave/min; 2 hours in 3 perpendicular directions.
3. Temperature shock test according to IEC68-2-14 (test Na):
   5 cycles from −40 to 85 °C, 1 cycle/2 h.
4. Accelerated damp heat test according to IEC68-2-30 (test Db):
   6 days 25 to 55 °C, R.H. up to 100% without condensation.

INDUCTIVE PROXIMITY DETECTOR

QUICK REFERENCE DATA	
Supply voltage (d.c.)	10 to 30 V
Maximum detection frequency	min. 1 kHz
Operating temperature range	−25 to +70 °C
Operating distance	2 mm
Protection degree	IP67

APPLICATION

The IPD120 can be applied as a detector for the presence, passage or position of metal parts and is a versatile tool in various industrial automation set-ups.

DESCRIPTION

The circuit consists of an oscillator, a detector, and a Schmitt trigger amplifier, housed in a chromium-plated brass tube. Three connecting leads (each having a 0,14 mm^2 cross-section) are brought out at one end and the oscillator coil is mounted at the other end. The oscillator coil sets up a well-defined magnetic field which, when clear, gives the circuit a HIGH output. If a metal object is brought into the magnetic field, the oscillator is damped and the circuit output goes LOW.
The tubular envelope is threaded and provided with two M12 nuts to enable mounting of the unit (see Fig. 1).
Except for the ganging the unit conforms CENELEC publication EN50008.

MECHANICAL DATA

Dimensions in mm

Outlines and connections

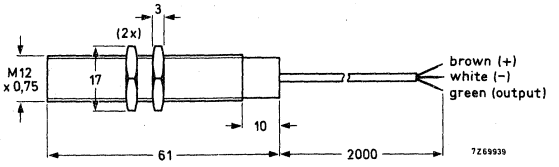


Fig. 1

Mass 55 g approximately

Mounting

The unit may be mounted in any position by means of the two nuts.

Degree of protection (IEC144) IP67

ELECTRICAL DATA

Unless otherwise specified all values apply at an ambient temperature of 25 °C.

Supply voltage V_S (d.c.)		10 to 30 V
current (no load)	V_S = 12 V	4,5 mA
	V_S = 24 V	9,2 mA
Ambient temperature range		
operating		−25 to +70 °C
storage		−40 to +85 °C

Output data

Detector activated	
voltage LOW	max. 1 V
minimum load resistance	450 Ω
Detector non-activated	
voltage HIGH	max. V_S
internal resistance	12 kΩ

The output is protected against inductive loads.

OPERATING DATA

The detection sensitivity is dependent on the dimensions and the material of the object in front of the detection head.
The operating distance X (see Fig. 2) is defined as the distance between the centre of the detected object and the surface of the detection head (measured axially), at which the circuit output switches from HIGH to LOW.

For a circular mild steel disc, diameter 9 mm, thickness 0,2 mm:

Operating distance (X)	2 mm ± 10%
Influence of temperature	2 µm/°C
Influence of supply voltage	1 µm/V
Hysteresis	3 to 10%
Reproducibility	5%
Maximum detection frequency	min. 1 kHz

Reduction factor on X for other metals of the same dimensions:

chromium	0,9
brass	0,5
aluminium	0,45
copper	0,4

Fig. 2 shows the operating distance curve for the above-mentioned mild steel disc. Y can be considered as any radial axis cutting the axial centre line of the detection head.

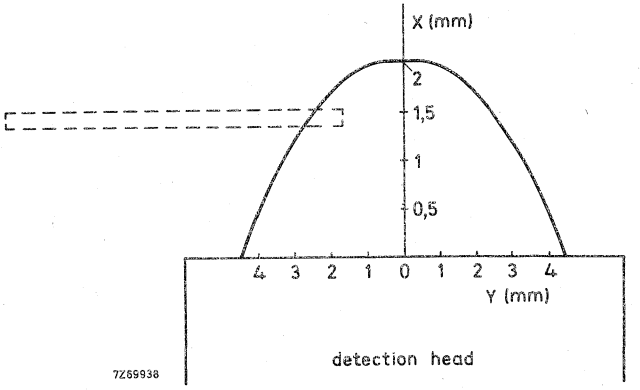


Fig. 2

TEST SPECIFICATIONS

Detector non-operative

1. Shock test according to IEC68-2-27 (test Ea):
   3 blows 50g for 11 ms, in 6 directions.
2. Vibration test according to IEC68-2-6 (test Fc):
   10 to 150 Hz, amplitude 0,76 mm or 10g maximum; sweep time 1 octave/min; 2 hours in 3 perpendicular directions.
3. Temperature shock test according to IEC68-2-14 (test Na):
   5 cycles from −40 to 85 °C, 1 cycle/2 h.
4. Accelerated damp heat test according to IEC68-2-30 (test Db):
   6 days 25 to 55 °C, R.H. up to 100% without condensation.

INDUCTIVE PROXIMITY DETECTOR

QUICK REFERENCE DATA	
Supply voltage (d.c.)	10 to 30 V
Maximum detection frequency	min. 0,5 kHz
Operating temperature range	−25 to +70 °C
Operating distance	5 mm
Protection degree	IP67

APPLICATION

The IPD180 can be applied as a detector for the presence, passage or position of metal parts and is a versatile tool in various industrial automation set-ups.

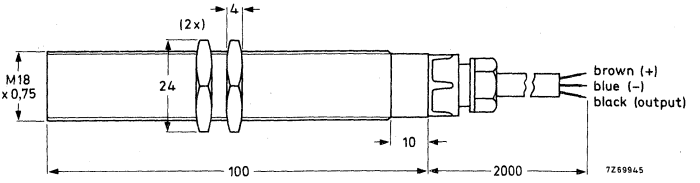
DESCRIPTION

The circuit consists of an oscillator, a detector, and a Schmitt trigger amplifier, housed in a chromium-plated brass tube. Three connecting leads (each having a 0,75 mm^2 cross-section) are brought out at one end and the oscillator coil is mounted at the other end. The oscillator coil sets up a well-defined magnetic field which, when clear, gives the circuit a HIGH output. If a metal object is brought into the magnetic field, the oscillator is damped and the circuit output goes LOW.
The tubular envelope is threaded and provided with two M18 nuts to enable mounting of the unit (see Fig. 1).
Except for the ganging the unit conforms CENELEC publication EN50008.

MECHANICAL DATA

Dimensions in mm

Outlines and connections



The unit is also available with a **screened cable** under type no. **IPD183,** cat. no. 2722 031 00142. The screen is not electrically connected to the housing.

Mass 200 g approximately

Mounting

The unit may be mounted in any position by means of the two nuts.

Degree of protection (IEC144) IP67

ELECTRICAL DATA

Unless otherwise specified all values apply at an ambient temperature of 25 °C.

Supply voltage V_S (d.c.)		10 to 30 V
current (no load)	V_S = 12 V	4,5 mA
	V_S = 24 V	9,2 mA
Ambient temperature range		
operating		−25 to +70 °C
storage		−40 to +85 °C

Output data

Detector activated	
voltage LOW	max. 1 V
minimum load resistance	450 Ω
Detector non-activated	
voltage HIGH	max. V_S
internal resistance	12 kΩ

The output is protected against inductive loads.

OPERATING DATA

The detection sensitivity is dependent on the dimensions and the material of the object in front of the detection head.
The operating distance X (see Fig. 2) is defined as the distance between the centre of the detected object and the surface of the detection head (measured axially), at which the circuit output switches from HIGH to LOW.

For a circular mild steel disc, diameter 14 mm, thickness 0,2 mm:

Operating distance (X)	5 mm ± 10%
Influence of temperature	2 µm/°C
Influence of supply voltage	1 µm/V
Hysteresis	3 to 10%
Reproducibility	5%
Maximum detection frequency	min. 0,5 kHz

Reduction factor on X for other metals of the same dimensions:

chromium	0,9
brass	0,5
aluminium	0,45
copper	0,4

Fig. 2 shows the operating distance curve for the above-mentioned mild steel disc. Y can be considered as any radial axis cutting the axial centre line of the detection head.

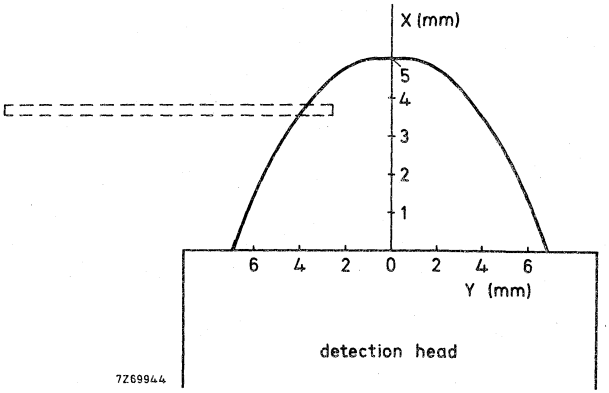


Fig. 2

TEST SPECIFICATIONS

Detector non-operative

1. Shock test according to IEC68-2-27 (test Ea):
   3 blows 50g for 11 ms, in 6 directions.
2. Vibration test according to IEC68-2-6 (test Fc):
   10 to 150 Hz, amplitude 0,76 mm or 10g maximum; sweep time 1 octave/min; 2 hours in 3 perpendicular directions.
3. Temperature shock test according to IEC68-2-14 (test Na):
   5 cycles from −40 to 85 °C, 1 cycle/2 h.
4. Accelerated damp heat test according to IEC68-2-30 (test Db):
   6 days 25 to 55 °C, R.H. up to 100% without condensation.

INDUCTIVE PROXIMITY DETECTOR

QUICK REFERENCE DATA	
Supply voltage	220/240 V +10, −15%; 50 Hz
Maximum detection frequency	min. 25 Hz
Operating temperature range	−25 to +70 °C
Operating distance	5 mm
Protection degree	IP67

APPLICATION

The IPD185 can be applied as a detector for the presence, passage or position of metal parts and is a versatile tool in various industrial automation set-ups.

DESCRIPTION

The circuit consists of an oscillator, a detector, a Schmitt trigger amplifier, and a thyristor, housed in a chromium-plated brass tube. Three connecting leads (each having a 0,75 mm^2 cross-section) are brought out at one end and the oscillator coil is mounted at the other end. The oscillator coil sets up a well-defined magnetic field which, when clear, results in an "open circuit" output. If a metal object is brought into the magnetic field, the oscillator is damped and the circuit acts as a "closed contact".
The tubular envelope is threaded and provided with two M18 nuts to enable mounting of the unit (see Fig. 1), and is connected to the earth lead.
Except for the ganging the unit conforms CENELEC publication EN50008.

MECHANICAL DATA

Dimensions in mm

Outlines and connections

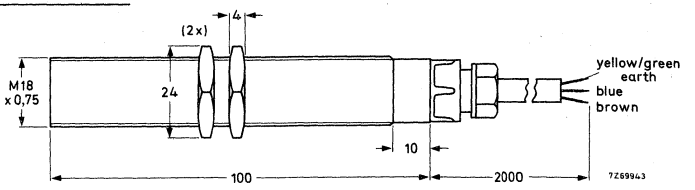


Fig. 1

Mass 200 g approximately

Mounting

The unit may be mounted in any position by means of the two nuts.

Degree of protection (IEC144) IP67

ELECTRICAL DATA

Unless otherwise specified all values apply at an ambient temperature of 25 °C.

Supply voltage V_S	220/240 V +10, −15%; 50 Hz
Ambient temperature range	
operating	−25 to +70 °C
storage	−40 to +85 °C
Output data	
Detector activated	
voltage LOW	7 V
load current	max. 0,25 A, see Fig. 2
	min. 10 mA
Detector non-activated	
voltage HIGH	V_S
leakage current	4 mA

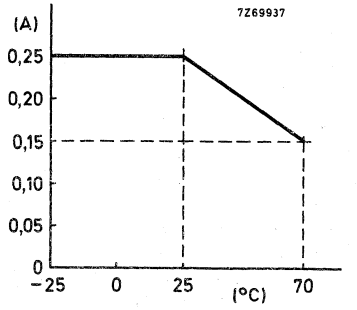


Fig. 2

OPERATING DATA

The detection sensitivity is dependent on the dimensions and the material of the object in front of the detection head.
The operating distance X (see Fig. 2) is defined as the distance between the centre of the detected object and the surface of the detection head (measured axially), at which the circuit output switches from HIGH to LOW.

For a circular mild steel disc, diameter 14 mm, thickness 0,2 mm:

Operating distance (X)	5 mm ± 10%
Influence of temperature	2 µm/°C
Influence of supply voltage	1 µm/V
Hysteresis	3 to 10%
Reproducibility	5%
Maximum detection frequency	min. 25 Hz
Reduction factor on X for other metals of the same dimensions:	
chromium	0,9
brass	0,5
aluminium	0,45
copper	0,4

Fig. 3 shows the operating distance curve for the above-mentioned mild steel disc. Y can be considered as any radial axis cutting the axial centre line of the detection head.

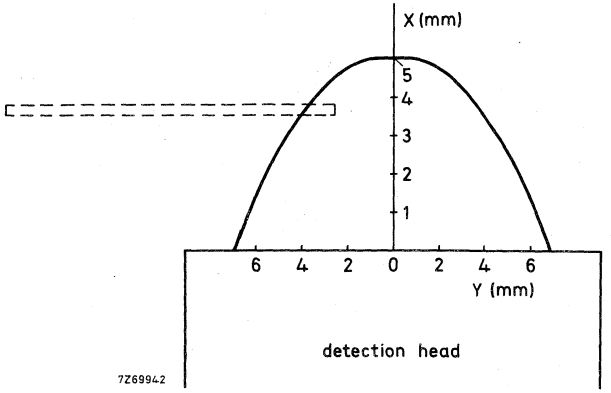


Fig. 3

TEST SPECIFICATIONS

Detector non-operative

1. Shock test according to IEC68-2-27 (test Ea):
   3 blows 50g for 11 ms, in 6 directions.
2. Vibration test according to IEC68-2-6 (test Fc):
   10 to 150 Hz, amplitude 0,76 mm or 10g maximum; sweep time 1 octave/min; 2 hours in 3 perpendicular directions.
3. Temperature shock test according to IEC68-2-14 (test Na):
   5 cycles from −40 to 85 °C, 1 cycle/2 h.
4. Accelerated damp heat test according to IEC68-2-30 (test Db):
   6 days 25 to 55 °C, R.H. up to 100% without condensation.

TIMERS
electronic time delay-on-relay

QUICK REFERENCE DATA	
Supply voltage	220 V/240 V +10, −15%
frequency	50 Hz ± 10%
Output function	s.p.d.t.
nominal r.m.s. voltage	240 V
nominal r.m.s. current	5 A
Mechanical life expectancy	min. 5×10^7 operations
Delay time (adjustable), TX810	5 to 100 s
TX811	10 to 300 s
Dimensions	45 x 70 x 109 mm
Mounting possibilities	rear, front, and rail
Protection degree (DIN 40050)	
terminals	IP20
package	IP40

APPLICATION

These timers have been designed for 220 V and 240 V operation in industrial control.

DESCRIPTION

The modules consist of an electronic timer and an industrial relay which includes a single-pole double-throw switch. The delay-time can be adjusted by a potentiometer, which is provided with a knob on the front of each module. After the module has been connected to the mains, and the delay-time has elapsed, the relay is energized and remains in this condition as long as the mains supply is not interrupted. However, a short interruption (see Fig. 2) neither changes the relay state, nor re-starts the timer. A delayed turn-on or a delayed turn-off action can be chosen.
The polycarbonate housing has standardized dimensions, and three mounting possibilities are incorporated (see Mounting).
For electrical connection the modules are provided with 0, 250 inch pierced tags (in accordance with DIN 46248, Blatt 3) for 0, 250 inch receptacles with dimples to ensure correct insertion depth, and rigidity.

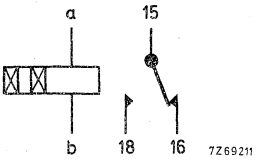


Fig. 1 Drawing symbol

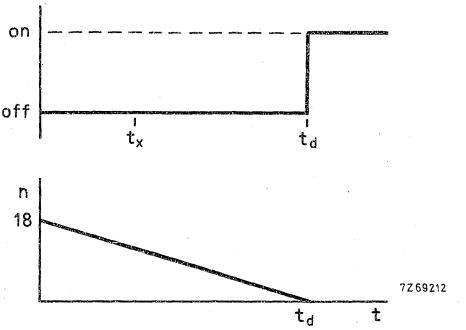


Fig. 2 $n = 18(\frac{t_d - t_x}{t_d})$

t_d = adjusted delay time
t_x = expired delay time
n = number of cycles of supply that may fall off without noticeable influence. Above n the timer will start again.

MECHANICAL DATA

Dimensions (mm) and terminal location

See Fig. 3.

The terminal configuration and coding are in accordance with DIN 46199, Blatt 5.

Connections

The tags of the timer are in accordance with DIN 46248, Blatt 3, suitable for receptacles to DIN 46247, Blatt 3.
It is recommended that pre-insulated receptacles be used.
Interconnections can be made if receptacles with crimp connection and flexible wire are used.

Mounting

Three ways of mounting are possible:

1. Two holes at the rear permit mounting onto a panel by means of M4 screws (to DIN 43604).
2. Snap-lock mounting on 35 mm "Euro" rail (to DIN 46277, Blatt 3).
3. An adapter is separately available for mounting into a front panel (see Accessories).

Mass

TX810	176 g
TX811	192 g

60±0,2
4,8
35±0,2
70
25
22
109
5
17
36
72692071
identification label
45
TX811 timer
SEC.
b
18
16
15
a
terminal location

Fig. 3

TECHNICAL PERFORMANCE

Ambient temperature range	
operating	−10 to +60 °C
storage	−25 to +70 °C
Supply	
mains voltage	220 V/240 V +10, −15%
mains frequency	50 Hz ± 10%
power consumption (cos φ = 0,6)	5 VA
Output	
function	s.p.d.t., break before make
switch contact material	heavy-current silver-cadmium oxide
life expectancy (mechanical)	up to 5 x 10^7 operations, see Figs 5 and 6
Contact ratings *)	
d.c. power	max. 250 W
a.c. power	max. 1000 VA
r.m.s. voltage	max. 264 V
r.m.s. current	max. 5 A
r.m.s. inrush current	max. 16 A
Test voltage between input and output (IEC 348)	2000 V, 50 Hz
Timing data	
delay time (t_d), TX810	5 to 100 s
TX811	10 to 300 s
setting inaccuracy	± max. 2% at 90% of full scale
reproducibility	within ± 1%
temperature coefficient of t_d, between 10 and 40 °C	−0,1%/°C
change of t_d with supply voltage	max. 0,02%/%
release time t_{rel}	max. 150 ms
recovery time t_{rec}	min. 1 s

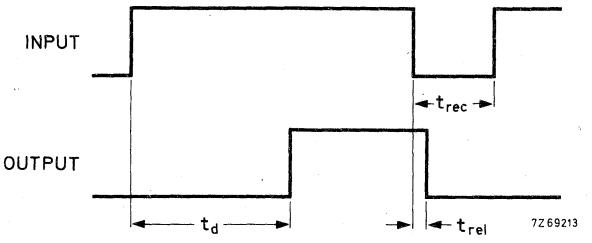


Fig. 4

*) With sufficient spark suppression and for minimum 10^5 operations.

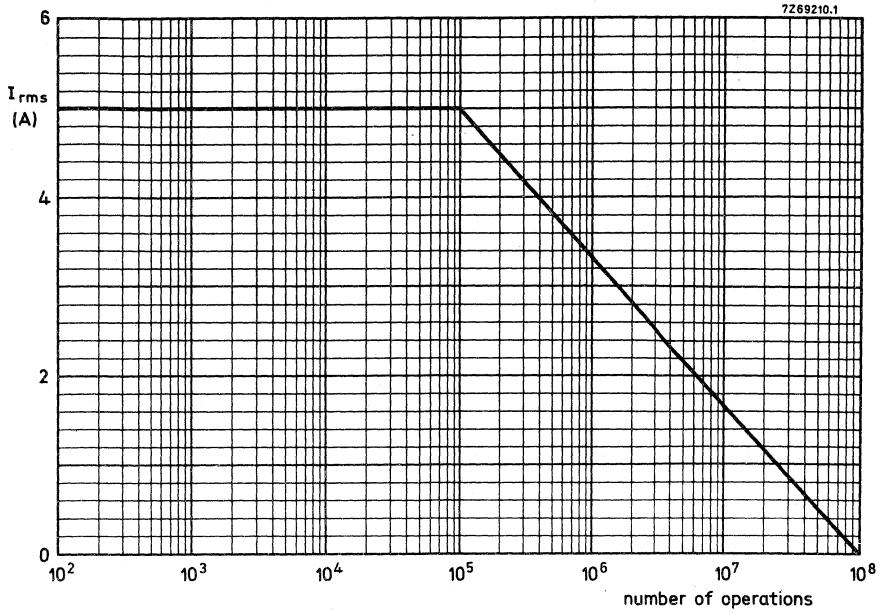


Fig. 5 Continuous current against number of operations at nominal voltage

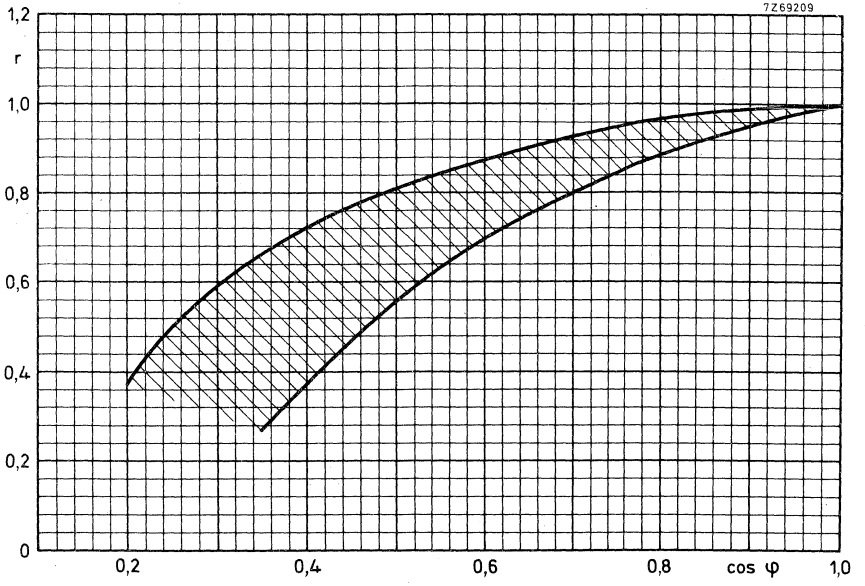


Fig. 6 Reduction factor r for life expectancy as a function of power factor cos φ

MECHANICAL PROTECTION AND ELECTRICAL SAFETY

The design of the timers is based on the following standards:

Test voltage	IEC 348, VDE 0435, VDE 0660 part 2, NLN - D - 97
Creepage and free-air distances	VDE 0110, class C
Protection	DIN 40050, Blatt 1, and IEC 144
terminals *)	class IP 20
package	class IP 40

*) In combination with receptacles the following classes are met:

non-insulated receptacle	class IP 00
pre-insulated receptacle	class IP 20
non-insulated receptacle with post-insulating boot	class IP 30
non-insulated receptacle with a cold crimp insulating sleeve	class IP 40

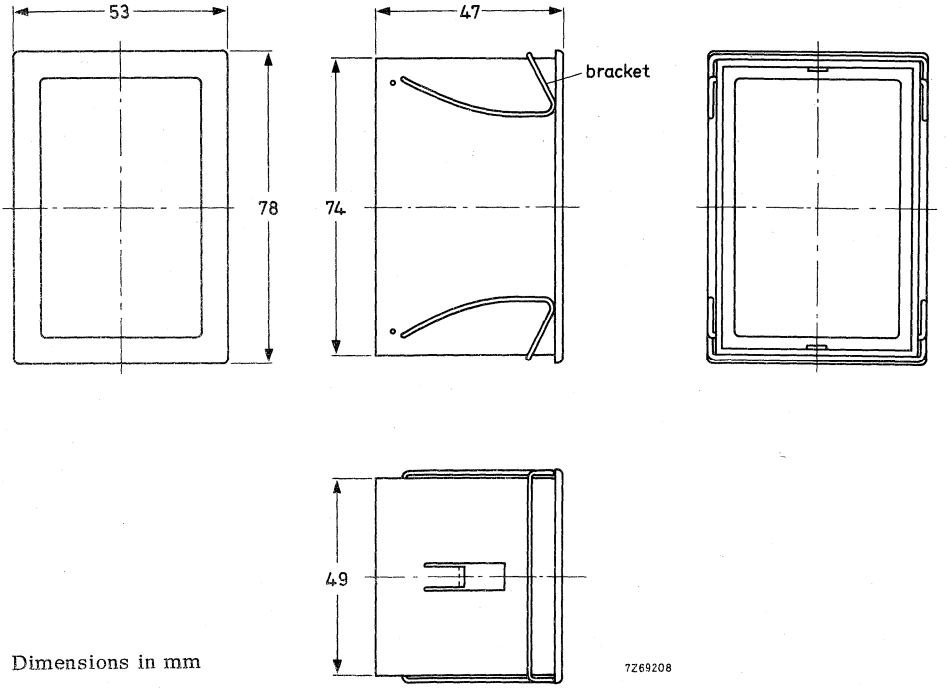
TEST SPECIFICATIONS

1. Shock test according to IEC68-2-27 (test Ea):
   3 blows 50g for 11 ms, in 6 directions.
2. Vibration test according to IEC68-2-6 (test Fc):
   10 to 55 Hz, max. amplitude 0,76 mm, sweep time 1 octave/min;
   2 hours in 3 perpendicular directions.
3. Temperature shock test according to IEC68-2-14 (test Na):
   5 cycles from -25 to 70 °C, 1 cycle/h.
4. Damp heat test according to IEC68-2-3 (test Ca):
   21 days at 40 °C, R.H. 90 to 95%.

ACCESSORIES

The timer can be equipped with a LED to indicate the energized state (relay on), on request.

For front-panel mounting a polycarbonate **adapter,** catalogue number 4322 026 79651, and brackets, catalogue number 4322 026 79642, are available. Two brackets are required per **adapter.** Fig. 7 shows the **adapter** with the brackets mounted.
Required aperture in panel 49,5 (+0,5) x 74,5 (+0,5) mm, maximum panel thickness 6 mm.



Dimensions in mm

Fig. 7

TIMER
electronic time delay-on-relay

QUICK REFERENCE DATA	
Supply voltage	220 V/240 V +10, −15%
frequency	50 Hz ± 10%
Output function	s.p.d.t.
nominal r.m.s. voltage	240 V
nominal r.m.s. current	5 A
Mechanical life expectancy	min. 5 x 10^7 operations
Delay time (adjustable)	1 to 99 s
Dimensions	45 x 70 x 109 mm
Mounting possibilities	rear, front and rail
Protection degree (DIN 40050)	
terminals	IP20
package	IP40

APPLICATION

This timer has been designed for 220 V and 240 V operation in industrial control.

DESCRIPTION

The module consists of an electronic timer and an industrial relay which includes a single-pole double-throw switch. The delay-time can be adjusted by two thumbwheel switches on the front of the module. After the module has been connected to the mains, and the delay-time has elapsed, the relay is energized and remains in this condition as long as the mains supply is not interrupted. However, a short interruption (see Fig. 2) neither changes the relay state, nor re-starts the timer.
A delayed turn-on or a delayed turn-off action can be chosen.
The polycarbonate housing has standardized dimensions, and three mounting possibilities are incorporated (see Mounting).
For electrical connection the module is provided with 0,250 inch pierced tags (in accordance with DIN 46248, Blatt 3) for 0,250 inch receptacles with dimples to ensure correct insertion depth, and rigidity.
The timer is provided with a LED which indicates the energized state (relay on).

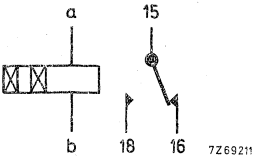


Fig. 1 Drawing symbol

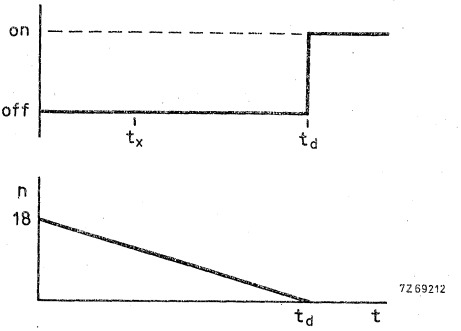


Fig. 2 $n = 18 \left(\frac{t_d - t_x}{t_d} \right)$

t_d = adjusted delay time
t_x = expired delay time
n = number of cycles of supply that may fall off without noticeable influence. Above n the timer will start again.

MECHANICAL DATA

Dimensions (mm) and terminal location

See Fig. 3.

The terminal configuration and coding are in accordance with DIN 46199, Blatt 5.

Connections

The tags of the timer are in accordance with DIN 46248, Blatt 3, suitable for receptacles to DIN 46247, Blatt 3.
It is recommended that pre-insulated receptacles be used.
Interconnections can be made if receptacles with crimp connection and flexible wire are used.

Mounting

Three ways of mounting are possible:

1. Two holes at the rear permit mounting onto a panel by means of M4 screws (to DIN 43604).
2. Snap-lock mounting on 35 mm "Euro" rail (to DIN 46277, Blatt 3).
3. An adapter is separately available for mounting into a front panel (see Accessories).

Mass 170 g

60±0,2
4,8
35±0,2
2,5
70
109
5
17
36
7Z70840
identification label
45
TX820 timer
SEC.
b
18
16
15
a
terminal location

Fig. 3

TECHNICAL PERFORMANCE

Ambient temperature range	
operating	−10 to +60 °C
storage	−25 to +70 °C
Supply	
mains voltage	220 V/240 V +10, −15%
mains frequency	50 Hz ± 10%
power consumption (cos φ = 0,6)	5 VA
Output	
function	s.p.d.t., break before make
switch contact material	heavy-current silver-cadmium oxide
life expectancy (mechanical)	up to 5 x 10^7 operations, see Figs 5 and 6
Contact ratings *)	
d.c. power	max. 250 W
a.c. power	max. 1000 VA
r.m.s. voltage	max. 264 V
r.m.s. current	max. 5 A
r.m.s. inrush current	max. 16 A
Test voltage between input and output (IEC 348)	2000 V, 50 Hz
Timing data	
delay time (t_d)	1 to 99 s
setting inaccuracy	± max. 1%, or ± max. 0,5 s
reproducibility	within ± 0,4%
temperature coefficient of t_d, between 10 and 40 °C	0,02%/°C
change of t_d with supply voltage	max. 0,02%/%
release time t_{rel}	max. 150 ms
recovery time t_{rec}	min. 1 s

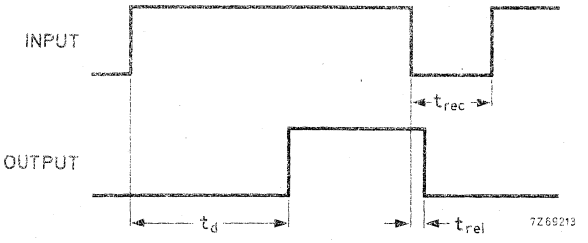


Fig. 4

*) With sufficient spark suppression and for minimum 10^5 operations.

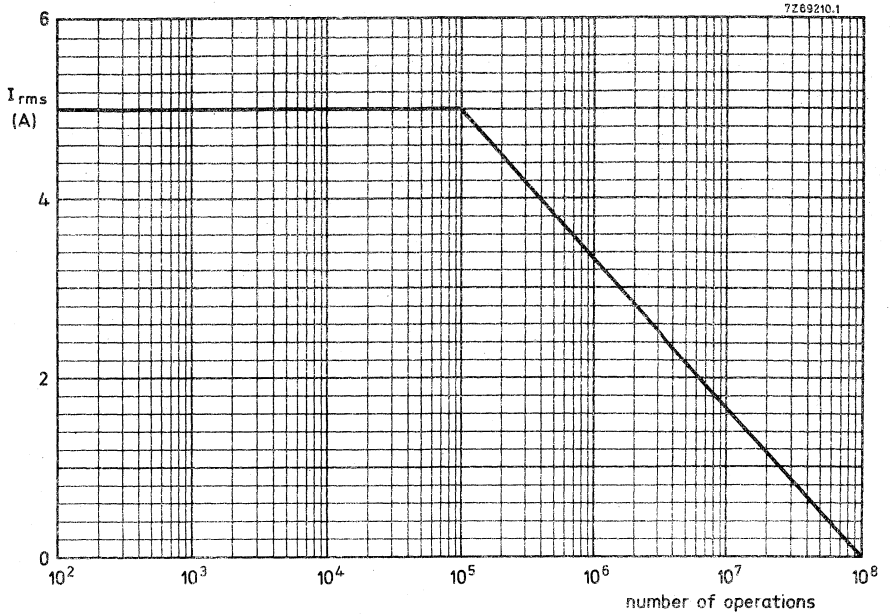


Fig. 5 Continuous current against number of operations at nominal voltage

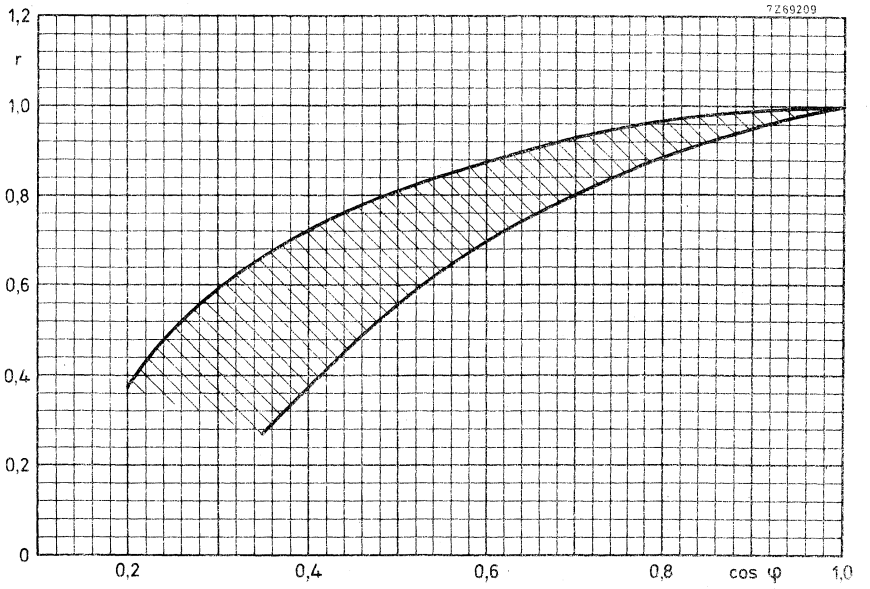


Fig. 6 Reduction factor r for life expectancy as a function of power factor cos φ

MECHANICAL PROTECTION AND ELECTRICAL SAFETY

The design of the timer is based on the following standards:

Test voltage	IEC 348, VDE 0435, VDE 0660 part 2, NLN - D - 97
Creepage and free-air distances	VDE 0110, class C
Protection	DIN 40050, Blatt 1, and IEC 144
terminals *)	class IP 20
package	class IP 40

*) In combination with receptacles the following classes are met:

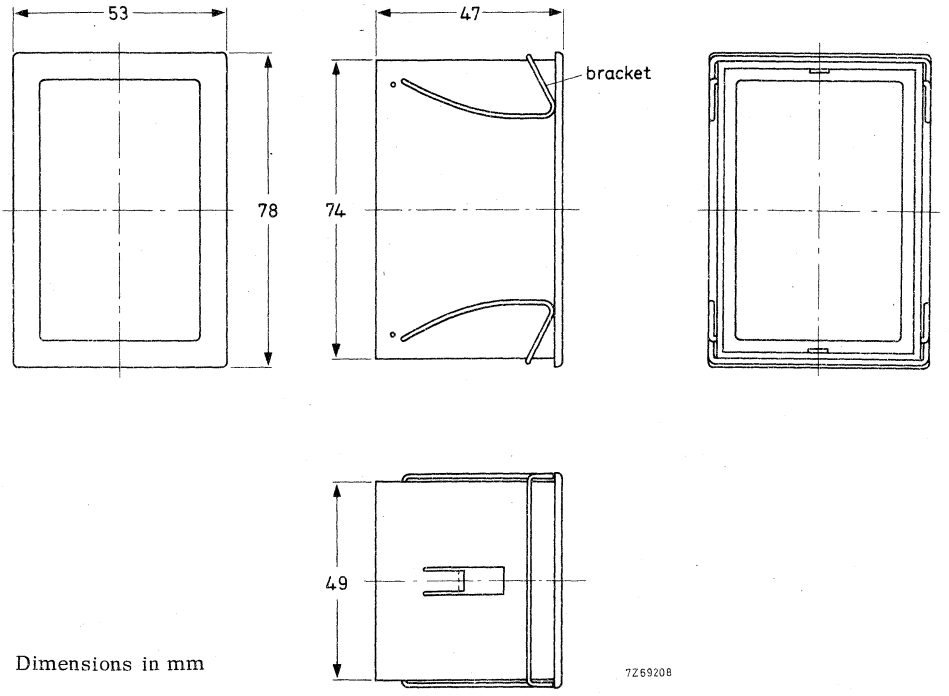
non-insulated receptacle	class IP 00
pre-insulated receptacle	class IP 20
non-insulated receptacle with post-insulating boot	class IP 30
non-insulated receptacle with a cold crimp insulating sleeve	class IP 40

TEST SPECIFICATIONS

1. Shock test according to IEC68-2-27 (test Ea):
   3 blows 50g for 11 ms, in 6 directions.
2. Vibration test according to IEC68-2-6 (test Fc):
   10 to 55 Hz, max. amplitude 0,76 mm, sweep time 1 octave/min;
   2 hours in 3 perpendicular directions.
3. Temperature shock test according to IEC68-2-14 (test Na):
   5 cycles from -25 to 70 °C, 1 cycle/h.
4. Damp heat test according to IEC68-2-3 (test Ca):
   21 days at 40 °C, R.H. 90 to 95%.

ACCESSORIES

For front-panel mounting a polycarbonate **adapter,** catalogue number 4322 026 79651, and brackets, catalogue number 4322 026 79642, are available. Two brackets are required per **adapter.** Fig. 7 shows the **adapter** with the brackets mounted.
Required aperture in panel 49, 5 (+0, 5) x 74, 5 **(+0, 5) mm, maximum panel thickness 6 mm.**



Dimensions in mm

Fig. 7

FLASHER

QUICK REFERENCE DATA	
Supply voltage	220 V/240 V +10, −15%
frequency	50 Hz ± 10%
Output function	s.p.d.t.
nominal r.m.s. voltage	240 V
nominal r.m.s. current	5 A
Mechanical life expectancy	min. 5×10^7 operations
Number of pulses	30/min to 120/min
Dimensions	45 x 70 x 109 mm
Mounting possibilities	rear, front and rail
Protection degree (DIN 40050)	
terminals	IP20
package	IP40

APPLICATION

This flasher has been designed for 220 V and 240 V operation as an intermittent switch for signal lamps and as a clock pulse generator.

DESCRIPTION

The item consists of an electronic low frequency pulse generator and an industrial relay which includes a single-pole double-throw switch. The module operates as soon as its power supply is switched on. The output pulse has a duty cycle of 50%. The pulse rate can be adjusted by a potentiometer, which is provided with a knob on the front of the module.

The polycarbonate housing has standardized dimensions, and three mounting possibilities are incorporated (see Mounting).
For electrical connection the module is provided with 0,250 inch pierced tags (in accordance with DIN 46248, Blatt 3) for 0,250 inch receptacles with dimples to ensure correct insertion depth, and rigidity.

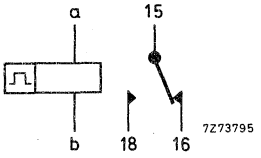


Fig. 1 Drawing symbol

MECHANICAL DATA

Dimensions (mm) and terminal location

See Fig. 2.

The terminal configuration and coding are in accordance with DIN 46199, Blatt 5.

Connections

The tags of the flasher are in accordance with DIN 46248, Blatt 3, suitable for receptacles to DIN 46247, Blatt 3.
It is recommended that pre-insulated receptacles be used.
Interconnections can be made if receptacles with crimp connection and flexible wire are used.

Mounting

Three ways of mounting are possible:

1. Two holes at the rear permit mounting into a panel by means of M4 screws (to DIN 43604).
2. Snap-lock mounting on 35 mm "Euro" rail (to DIN 46277, Blatt 3).
3. An adapter is separately available for mounting into a front panel (see Accessories).

Mass 173 g

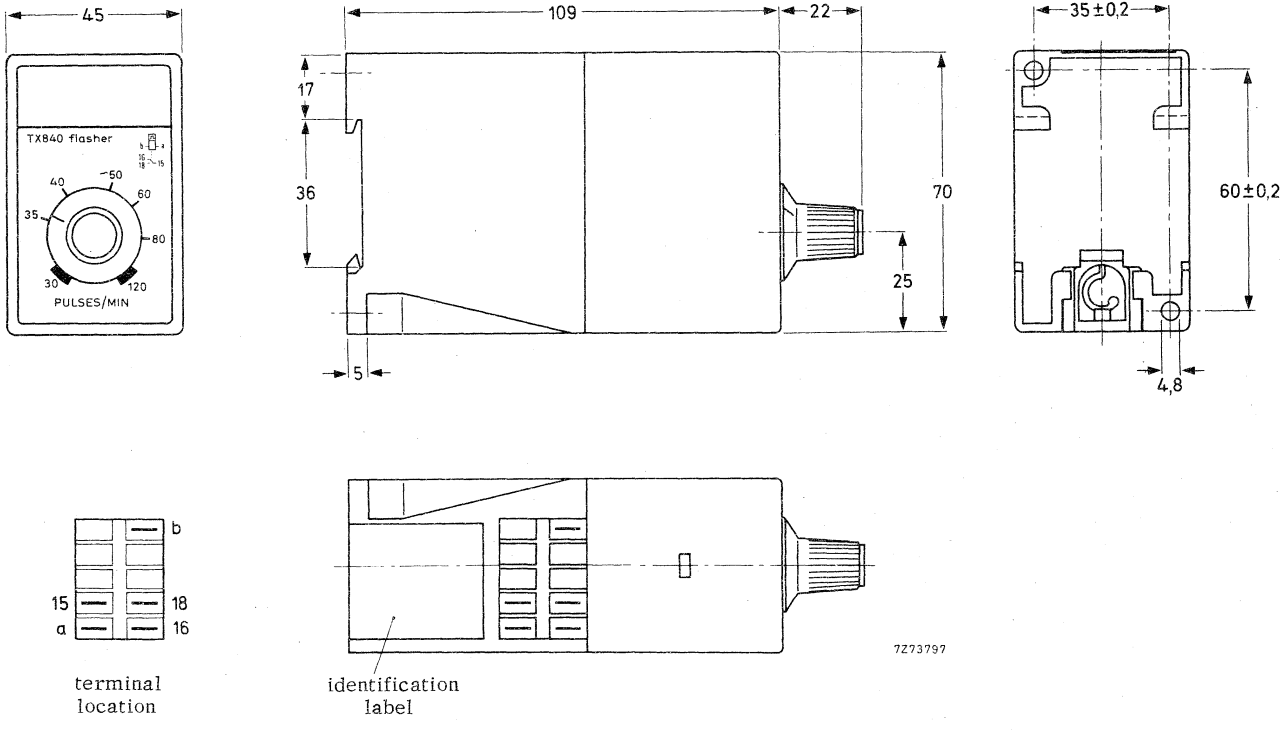

45
TX840 flasher
40
50
60
35
80
30
120
PULSES/MIN
109
22
17
36
70
25
5
35±0,2
60±0,2
4,8
b
15
18
a
16
terminal
location
identification
label
7Z73797

Fig. 2

TECHNICAL PERFORMANCE

Ambient temperature range	
operating	−10 to +60 °C
storage	−25 to +70 °C
Supply	
mains voltage	220 V/240 V +10, −15%
mains frequency	50 Hz ± 10%
power consumption ($\cos \varphi = 0,6$)	5 VA
Output	
function	s.p.d.t., break before make
switch contact material	heavy-current silver-cadmium oxide
life expectancy (mechanical)	up to 5×10^7 operations, see Figs 4 and 5
Contact ratings *)	
d.c. power	max. 250 W
a.c. power	max. 1000 VA
r.m.s. voltage	max. 264 V
r.m.s. current	max. 5 A
r.m.s. inrush current	max. 16 A
Test voltage between input and output (IEC 348)	2000 V, 50 Hz
Timing data	
number of pulses (f)	30/min to 120/min
duty cycle	50%
setting inaccuracy at 40 cycles/min	± max. 5%
stability of cycle time	within ± 1%
temperature coefficient of f, between 10 and 40 °C	−0,2%/°C
change of f with supply voltage	max. 0,02%/%

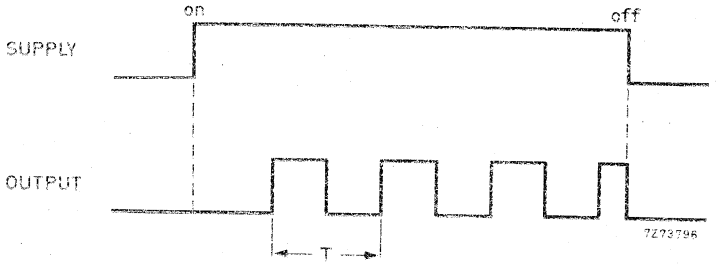


Fig. 3. T = cycle time.

*) With sufficient spark suppression and for minimum 10^5 operations.

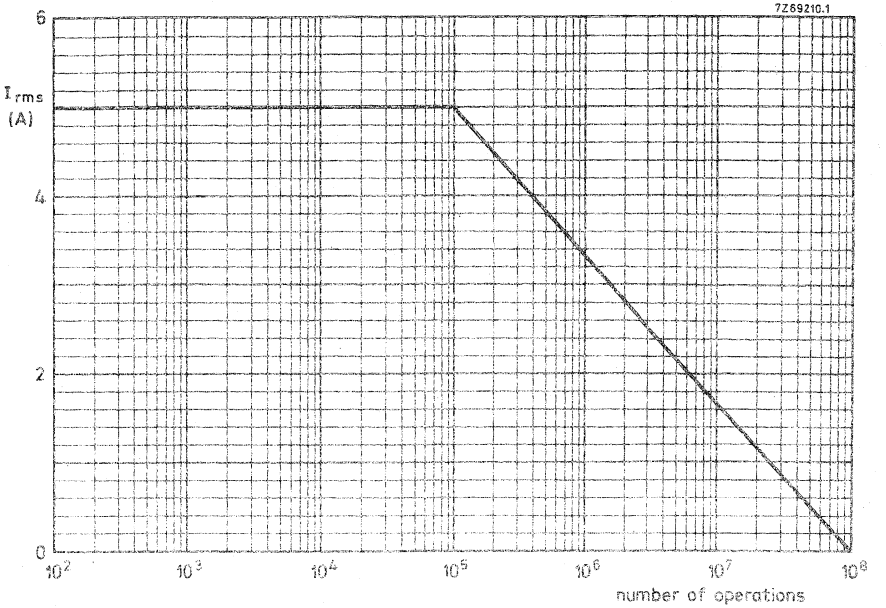


Fig. 4 Continuous current against number of operations at nominal voltage

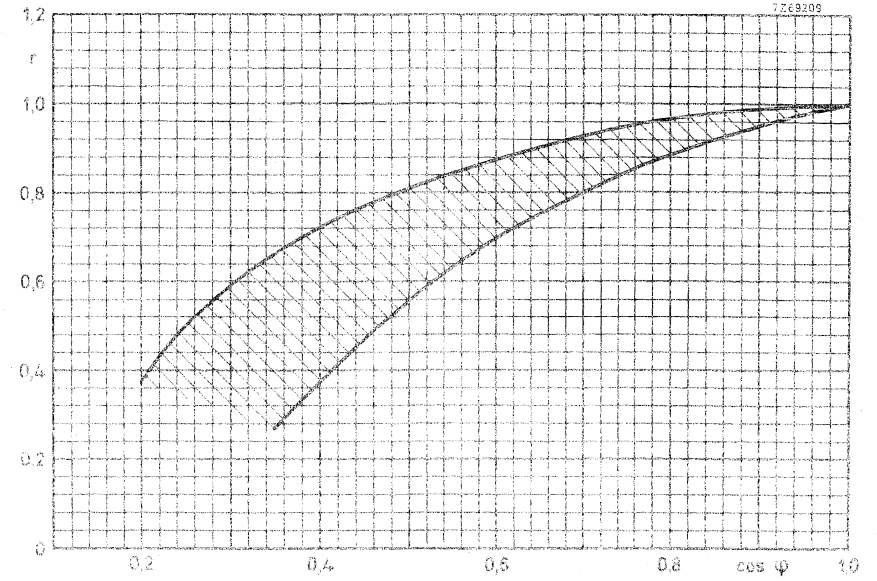


Fig. 5 Reduction factor r for life expectancy as a function of power factor cos φ

MECHANICAL PROTECTION AND ELECTRICAL SAFETY

The design of the flasher is based on the following standards:

Test voltage	IEC 348, VDE 0435, VDE 0660 part 2, NLN - D - 97
Creepage and free-air distances	VDE 0110, class C
Protection	DIN 40050, Blatt 1, and IEC 144
terminals*)	class IP20
package	class IP40

*) In combination with receptacles the following classes are met:

non-insulated receptacle	class IP00
pre-insulated receptacle	class IP20
non-insulated receptacle with post-insulating boot	class IP30
non-insulated receptacle with a cold crimp insulating sleeve	class IP40

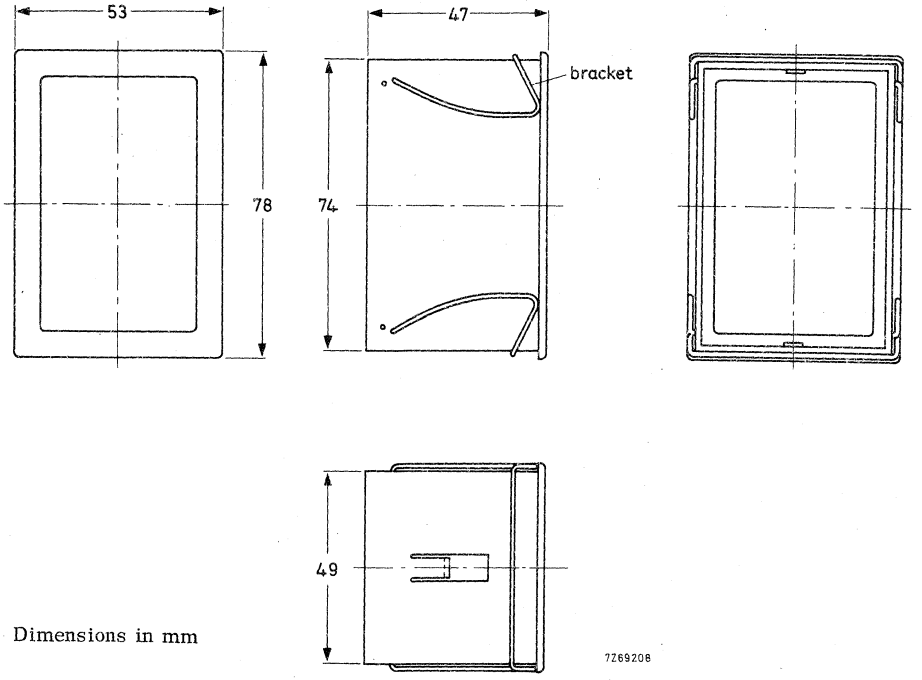
TEST SPECIFICATIONS

1. Shock test according to IEC68-2-27 (test Ea):
   3 blows 50g for 11 ms, in 6 directions.
2. Vibration test according to IEC68-2-6 (test Fc):
   10 to 55 Hz, max. amplitude 0,76 mm, sweep time 1 octave/min,
   2 hours in 3 perpendicular directions.
3. Temperature shock test according to IEC68-2-14 (test Na):
   5 cycles from -25 to 70 ^{o}C, 1 cycle/h.
4. Damp heat test according to IEC68-2-3 (test Ca):
   21 days at 40 ^{o}C, R.H. 90 to 95%.

ACCESSORIES

The flasher can be equipped with a LED to indicate the energized state (relay on), on request.

For front-panel mounting a polycarbonate adapter, catalogue number 4322 026 79651, and brackets, catalogue number 4322 026 79642, are available. Two brackets are required per adapter. Fig. 6 shows the adapter with the brackets mounted.
Required aperture in panel 49,5 (+0,5) x 74,5 (+0,5) mm, maximum panel thickness 6 mm.



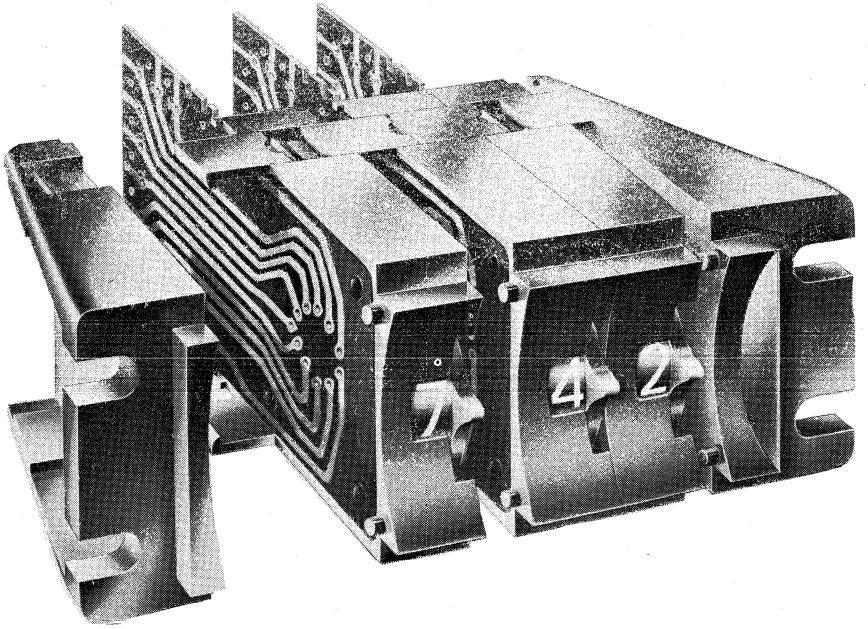
Dimensions in mm

Fig. 6

THUMBWHEEL SWITCHES
M version

QUICK REFERENCE DATA	
Contact resistance	≤ 100 mΩ
Operating temperature range paper epoxy p.w. board glass epoxy p.w. board	 −25 to +70 °C −55 to +85 °C
Current switching capability	0,5 A

A 52941 - 2



APPLICATION

These miniature thumbwheel switches have been developed for use as preset devices in digital systems which have to handle numerical data, or as positioning switches.

The dimensions of the M version are smaller than those of the T and the B versions and allow for easy operation.

CONSTRUCTION

Thumbwheel switches

Housing	black shock-resistant polycarbonate
Contact springs	heat-treated copper beryllium
Contact surface	721 alloy
Terminals	holes or tin-plated pins for wire wrapping
Thumbwheel	black polycarbonate provided with white figures or signs
Thumbwheel detent	steel spring
Printed-wiring board	paper epoxy or glass epoxy, gold-plated tracks on nickel
Stacking	switch housings are provided with "snap-in" hooks to eliminate tie bolts
Type identification	catalogue number suffix (last 5 digits) is given on the rear of the switch

End pieces

Housing	black shock-resistant polycarbonate
Types	for mounting with screws for mounting with brackets (rear mounting)

Outlines

Dimensions in mm

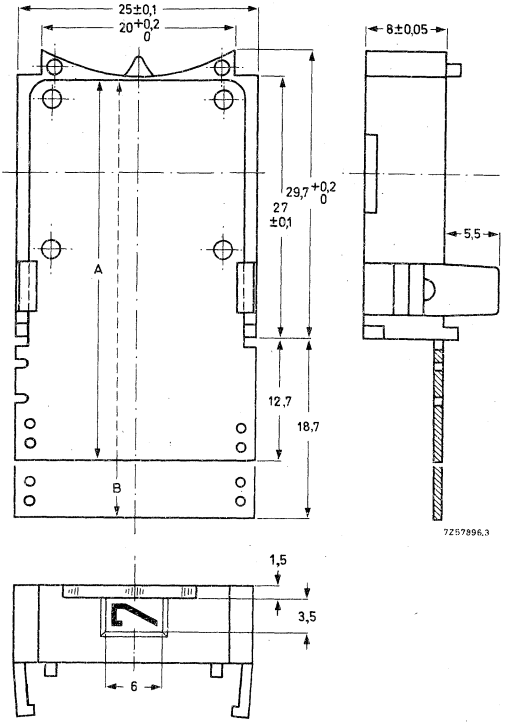


Fig. 1.
Thumbwheel switch,
A : short track plate, used in switches without diodes
B : long track plate, used in switches with diodes, and in type M10P2C.

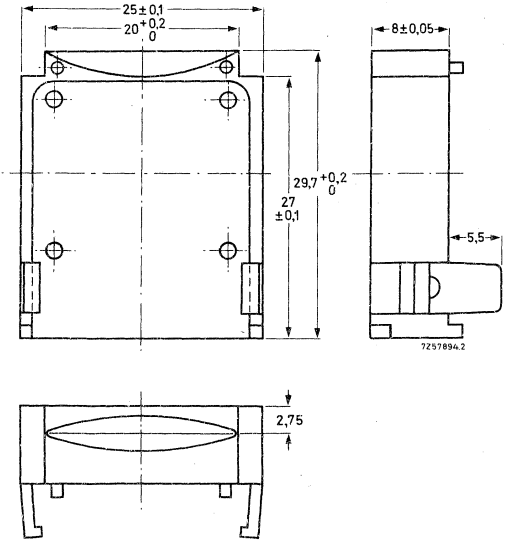


Fig. 2. Spacer.

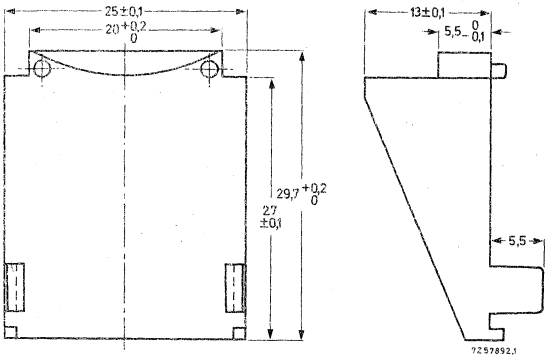


Fig. 3. Male end-piece for mounting with screws to the panel.

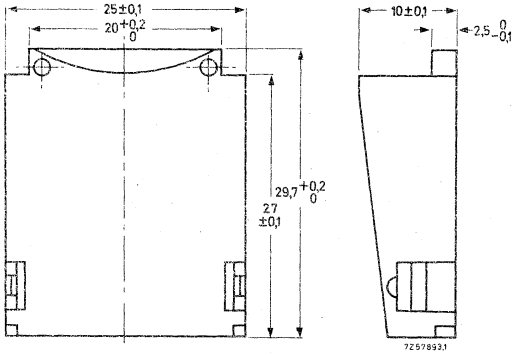


Fig. 4. Female end-piece for mounting with screws to the panel.

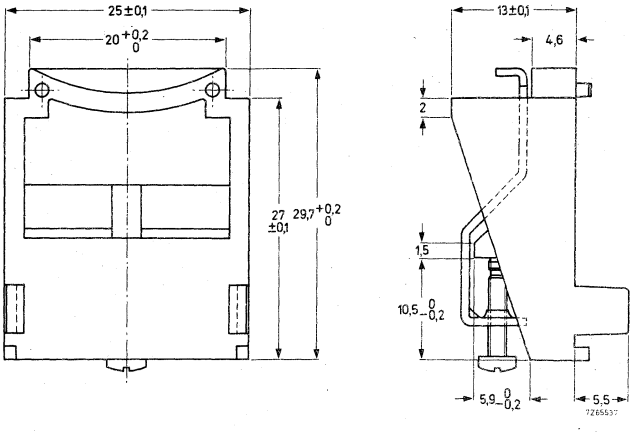


Fig. 5. Male end-piece with brackets.

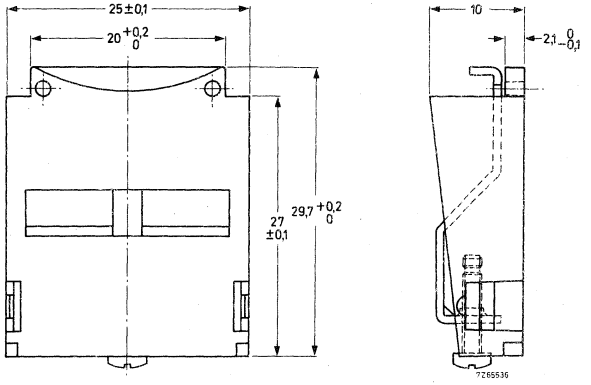


Fig. 6. Female end-piece with brackets.

Terminals

The switches are supplied with holes or with pins (Fig. 7) for connection.

They can be connected:
a. by soldering to the holes in the printed-wiring board
b. by wire-wrapping the pins (AWG26)
c. by reflow soldering the pins to a perpendicular external printed-wiring board (250 ± 2 °C, max. 6 s)

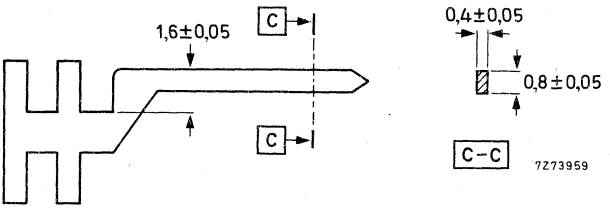


Fig. 7. Outlines of the pins for wire-wrapping.

The pitch of the holes on the p.w. board depends on the number of connections.

- for 10 connections or less (in general switches presenting only binary or only complementary output) the pitch is 2,54 mm or its multiple.
  If these switches are provided with pins, these pins are in line in position B as indicated in Fig. 8.
- for more than 10 connections the pitch is 2,3 mm or its multiple.
  If the switches are provided with pins, these pins are staggered according to Figs 8 and 9, to allow enough room for wire-wrapping tools.

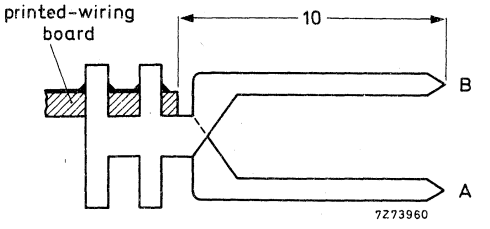


Fig. 8

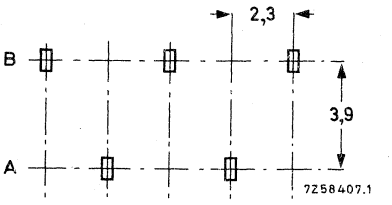


Fig. 9

Mass 10 g approximately

Numerals

	height x width (mm)	line thickness (mm)
10 position switch	5 x 3	0,7
12 position switch, 0 to 9	4 x 2,4	0,7
10	3,8 x 3,1	0,45
11	3,8 x 2,2	0,45

Mounting

The switches are "block mounted" to the panel with M3 screws or with mounting brackets, depending on the end-pieces used. Maximum permissible couple applied to the screws in the brackets 250 mNm.

Panel cut-outs for the two types are shown below. N = number of switches.

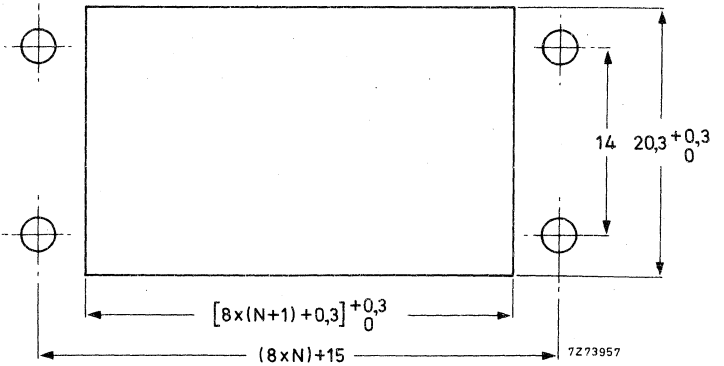


Fig. 10. Panel cut-out for switches and end-pieces for mounting with four M3 screws.

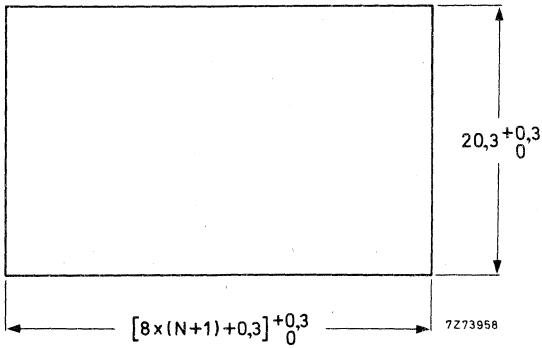


Fig. 11. Panel cut-out for switches and end-pieces with brackets.

TECHNICAL PERFORMANCE

D.C. working voltage	250 V
D.C. test voltage	750 V
Insulation resistance, measured at 100 V (d.c.) [1]	
NM version [2]	10^4 MΩ
M version [3]	10^5 MΩ
After humidity test	
NM version [2]	10^2 MΩ
M version [3]	10^3 MΩ
Power switching capability at resistive load	10 VA
Current switching capacity (d.c.) in purely resistive circuits	0,5 A
Maximum current carrying capacity (d.c.)	3 A
Contact resistance measured at 10 mA	< 100 mΩ
Capacitance measured at 1 MHz between one terminal and all others connected to earth	10 pF
Standard gate resistor	6,8 kΩ
Operating temperature range	
NM version [2]	−25 to +70 °C
M version [3]	−55 to +85 °C
Storage temperature range	
NM version [2]	−40 to +85 °C
M version [3]	−65 to +100 °C
Life	in excess of 10^6 commutations at a rate of 1 step/s
Operating torque	10 to 35 mNm
Quality control tests, IEC 68-2:	
test Aa, cold	−55 °C
test Ba, dry heat	100 °C
test C, damp heat	56 days
test F, vibration	to be established
test Na, temperature cycling	−55 to +100 °C
test Ea, shock	to be established
test T, solderability	0 hours and 56 days

[1] Between any pair of terminals and between any terminal and all others connected together.
[2] Paper epoxy printed-wiring board.
[3] Glass epoxy printed-wiring board.

SURVEY OF TYPES

description	type *)	catalogue number
Decimal switches		
10 position/1 common, engraving 0 to 9	M10P1C	4311 027 84000
	MW10P1C	4311 027 84010
	NM10P1C	4311 027 90130
10 position/2 commons, engraving 0 to 9	M10P2C	4311 027 84040
5 x 2 positions/1 common, engraving + -	M5x2P1C+-	4311 027 84940
	MW5x2P1C+-	4311 027 84950
5 x 2 positions/2 commons, engraving + -	M5x2P2C+-	4311 027 84920
	MW5x2P2C+-	4311 027 84930
Coding switches 1.2.4.8		
binary output	NM1248	4311 027 90230
	NMW1248	4311 027 90520
binary + complementary output	M1248C	4311 027 84160
	MW1248C	4311 027 84290
complementary output	NM1248CS	4311 027 90250
	NMW1248CS	4311 027 90360
Decoding switches 1.2.4.8, positive logic		
binary output	NM1248P	4311 027 90270
	NMW1248P	4311 027 90220
binary + complementary output	M1248PC	4311 027 84240
	MW1248PC	4311 027 84250
complementary output	NM1248PCS	**)
	NMW1248PCS	**)
Decoding switches 1.2.4.8, negative logic		
binary output	NM1248N	**)
	NMW1248N	4311 027 90310
binary + complementary output	M1248NC	4311 027 84200
	MW1248NC	4311 027 84210
complementary output	NM1248NCS	**)
	NMW1248NCS	**)

*) "N" in front of the number indicates that the switch has a paper epoxy printed-wiring board. This material is only used for single-sided boards. Double-sided boards, used in switches with binary and complementary output, are made of glass epoxy. Switches with single-sided glass epoxy printed-wiring boards can be supplied on request. "W" in the number indicates that the switch is provided with pins for wire wrapping.

**) Can be made available on request.

ACCESSORIES

Set of two end-pieces	
with screws	4311 027 84440
with brackets	4311 027 88800
Spacer	4311 027 84590
Spacer with decimal point	4311 027 84910

SPECIAL VERSIONS

Internally lit switches

White translucent rotor with black engraving. Lamp max. 5 V. Minimum life time 50 000 h (about 6 years). Lower voltage (applicable in dark room) extends the life time. Type number prefix is extended with an "L", for example LNM1248.

Limit stops

Rotation of the rotor can be limited to any position by means of stop pins (catalogue number 4311 027 84410). These are specially tooled parts which can be fitted by means of a pair of tweezers.
The stop pins can be installed by factory (or by customer).

Sealed switches

Contact chamber is sealed by an elastomer ring for protection against dust and sand. May be used in explosive and aggressive atmospheres. Type number prefix is extended with an "S", for example SNM1248.

Colour of housing/rotor

Rotors also available in red. Type number prefix is extended with an "R", for example RNM1248.
Other colours for rotor and housing can be considered, but only for order quantities in one batch and one colour of 10 000 pieces or more.

Special engraving

Special engraving requirements can be undertaken.
Due to cost of specific tooling, a minimum quantity of 5000 is recommended.

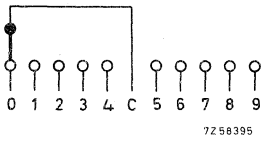
Twelve-position switches

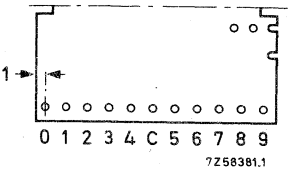
All switches can also be supplied with twelve positions on request. The symbols on the rotor are then smaller, however, the housing and the window are the same.

DIAGRAMS AND TERMINAL LOCATION

The terminals are shown at the solder side of the printed-wiring board. This is the side facing the housing. Two terminals are reserved for connection of a supply to the lamp in internally lit switches.

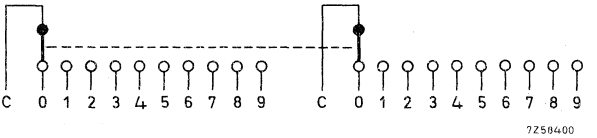
M10P1C, MW10P1C, NM10P1C

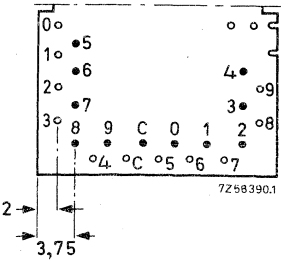




Pitch between holes is 2,30 mm.
Wrapping pins are staggered with the most left in position B (Fig. 8).

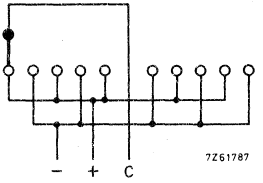
M10P2C

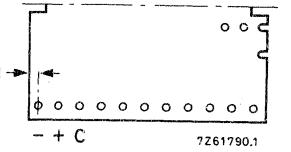




Pitch between holes is 2,30 mm.

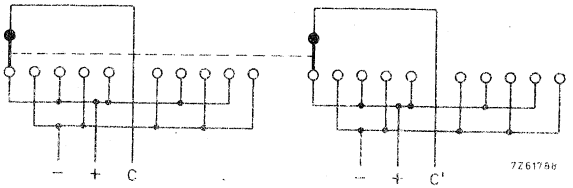
M 5x2 P1C+-, MW 5x2 P1C+-

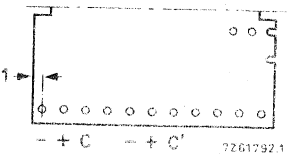




Pitch between holes is 2,30 mm.
Pins are staggered in positions B-A-B successively (Fig. 8).

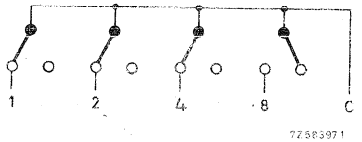
M 5x2 P2C + -, MW 5x2 P2C + -

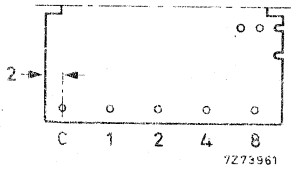




Pitch between holes is 2,30 mm.
Pins are staggered in positions B-A-B (2x) successively (Fig. 8).

NM1248, NMW1248



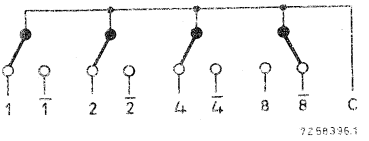


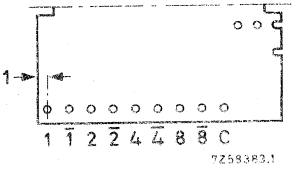
Pitch between holes is 5,08 mm.
Pins are in line in position B (Fig. 8).

Truth table

Index	1 2 4 8
0	0 0 0 0
1	1 0 0 0
2	0 1 0 0
3	1 1 0 0
4	0 0 1 0
5	1 0 1 0
6	0 1 1 0
7	1 1 1 0
8	0 0 0 1
9	1 0 0 1

M1248C, MW1248C



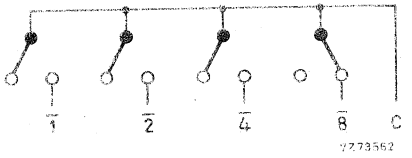


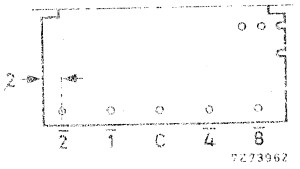
Pitch between holes is 2,50 mm.
Pins are staggered, with the most left in position B (Fig. 8).

Truth table

Index	1 2 4 8	1̄ 2̄ 4̄ 8̄
0	0 0 0 0	1 1 1 1
1	1 0 0 0	0 1 1 1
2	0 1 0 0	1 0 1 1
3	1 1 0 0	0 0 1 1
4	0 0 1 0	1 1 0 1
5	1 0 1 0	0 1 0 1
6	0 1 1 0	1 0 0 1
7	1 1 1 0	0 0 0 1
8	0 0 0 1	1 1 1 0
9	1 0 0 1	0 1 1 0

NM1248CS, NMW1248CS



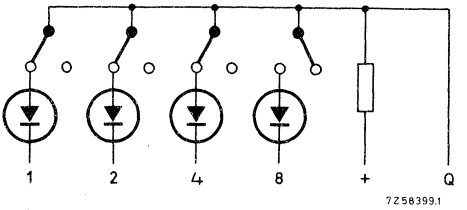


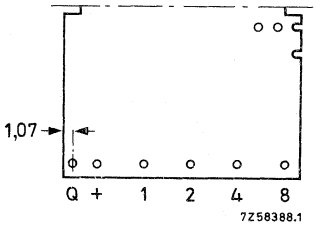
Pitch between holes is 5,08 mm.
Pins are in line in position B (Fig. 8).

Truth table

Index	1̄ 2̄ 4̄ 8̄
0	1 1 1 1
1	0 1 1 1
2	1 0 1 1
3	0 0 1 1
4	1 1 0 1
5	0 1 0 1
6	1 0 0 1
7	0 0 0 1
8	1 1 1 0
9	0 1 1 0

NM1248P, NMW1248P



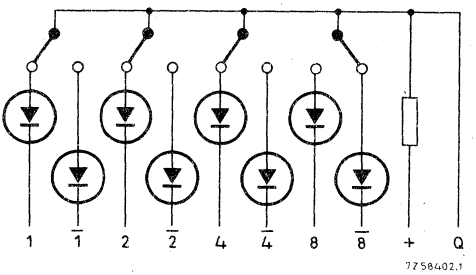


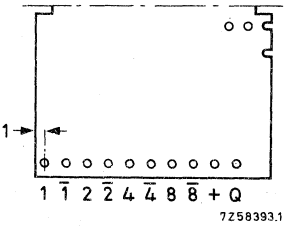
Pitch between holes is 2,54 mm and 5,08 mm. Pins are in line in position B, except the Q terminal (Fig. 8).

Truth table

Index	1 2 4 8
0	0 0 0 0
1	1 0 0 0
2	0 1 0 0
3	1 1 0 0
4	0 0 1 0
5	1 0 1 0
6	0 1 1 0
7	1 1 1 0
8	0 0 0 1
9	1 0 0 1

M1248PC, MW1248PC



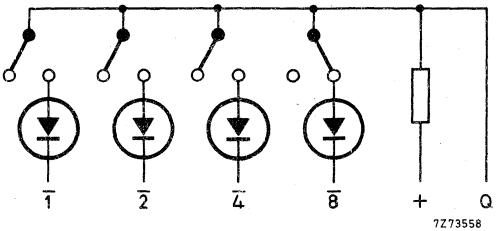


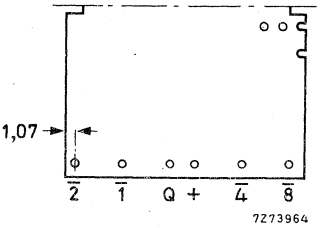
Pitch between holes is 2,30 mm. Pins are staggered with the most left in position B (Fig. 8).

Truth table

Index	1 2 4 8	$\bar{1}$ $\bar{2}$ $\bar{4}$ $\bar{8}$
0	0 0 0 0	1 1 1 1
1	1 0 0 0	0 1 1 1
2	0 1 0 0	1 0 1 1
3	1 1 0 0	0 0 1 1
4	0 0 1 0	1 1 0 1
5	1 0 1 0	0 1 0 1
6	0 1 1 0	1 0 0 1
7	1 1 1 0	0 0 0 1
8	0 0 0 1	1 1 1 0
9	1 0 0 1	0 1 1 0

NM1248PCS, NMW1248PCS



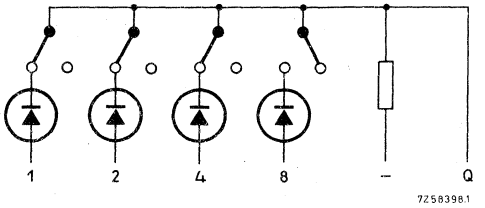


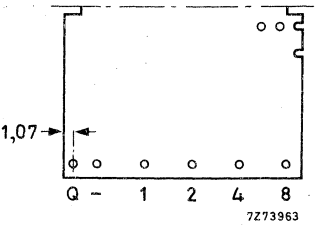
Truth table

Index	1̄ 2̄ 4̄ 8̄
0	1 1 1 1
1	0 1 1 1
2	1 0 1 1
3	0 0 1 1
4	1 1 0 1
5	0 1 0 1
6	1 0 0 1
7	0 0 0 1
8	1 1 1 0
9	0 1 1 0

Pitch between holes is 5,08 and 2,54 mm.
Pins are in line in position B (Fig. 8).

NM1248N, NMW1248N



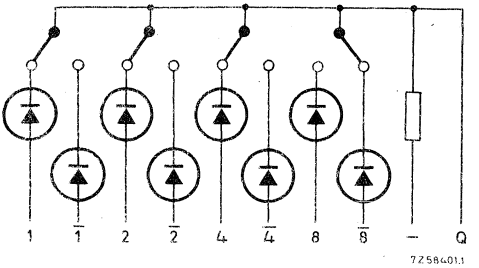


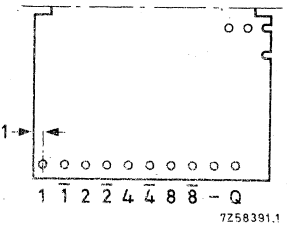
Truth table

Index	1 2 4 8
0	0 0 0 0
1	1 0 0 0
2	0 1 0 0
3	1 1 0 0
4	0 0 1 0
5	1 0 1 0
6	0 1 1 0
7	1 1 1 0
8	0 0 0 1
9	1 0 0 1

Pitch between holes is 2,54 mm and 5,08 mm.
Pins are in line in position B, except the Q terminal.

M1248NC, MW1248NC



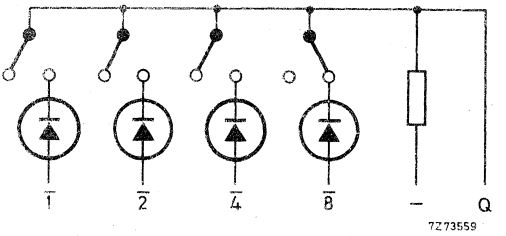


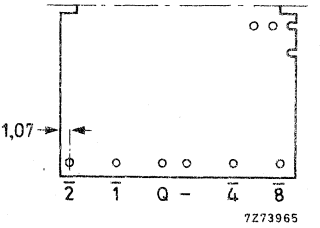
Pitch between holes is 2,30 mm.
Pins are staggered with the most left in position B (Fig. 8).

Truth table

Index	1 2 4 8	1̄ 2̄ 4̄ 8̄
0	0 0 0 0	1 1 1 1
1	1 0 0 0	0 1 1 1
2	0 1 0 0	1 0 1 1
3	1 1 0 0	0 0 1 1
4	0 0 1 0	1 1 0 1
5	1 0 1 0	0 1 0 1
6	0 1 1 0	1 0 0 1
7	1 1 1 0	0 0 0 1
8	0 0 0 1	1 1 1 0
9	1 0 0 1	0 1 1 0

NM1248NCS, NMW1248NCS





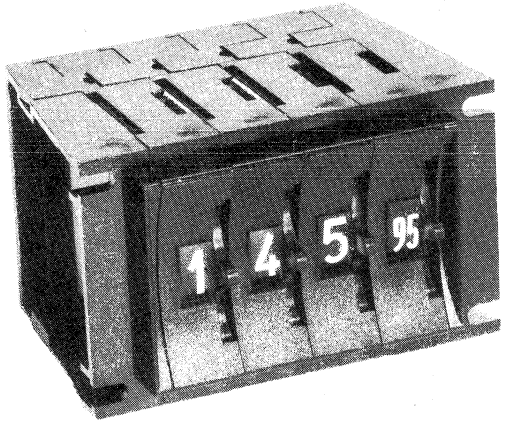
Pitch between holes is 5,08 mm and 2,54 mm.
Pins are in line in position B (Fig. 8).

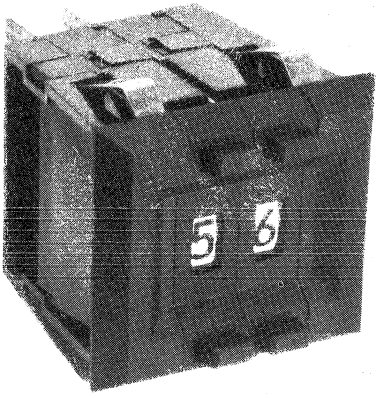
Truth table

Index	1̄ 2̄ 4̄ 8̄
0	1 1 1 1
1	0 1 1 1
2	1 0 1 1
3	0 0 1 1
4	1 1 0 1
5	0 1 0 1
6	1 0 0 1
7	0 0 0 1
8	1 1 1 0
9	0 1 1 0

THUMBWHEEL SWITCHES
T and B versions

QUICK REFERENCE DATA	
Contact resistance	≤ 100 mΩ
Operating temperature range	
paper epoxy p.w. board	−25 to +70 °C
glass epoxy p.w. board	−55 to +85 °C
Current switching capability	0,5 A





APPLICATION

These thumbwheel switches have been developed for use either as preset devices in digital systems which have to handle numerical data, or as positioning switches. There are two versions, both for block mounting: the T version is for direct thumb operation of the rotor; the B version is provided with two push-buttons, one for rotation to a higher figure (marked +), the other for rotation to a lower figure (marked −).

CONSTRUCTION

Thumbwheel switches

Housing	black shock-resistant polycarbonate
Contact springs	heat-treated phosphor bronze
Contact surface	721 alloy
Terminals	holes or tin-plated pins for wire wrapping
Thumbwheel	black polycarbonate provided with white figures or signs
Button (B version)	black polycarbonate with engraved + and − signs
Thumbwheel detent	steel spring
Printed-wiring board	paper epoxy or glass epoxy, gold-plated tracks on nickel
Stacking	switch housings are provided with "snap-in" hooks to eliminate tie bolts
Type identification	catalogue number suffix is given on the rear of the switch

End pieces

Housing		black shock-resistant polycarbonate
Types	T versions	for mounting with screws for mounting with brackets
	B version	for spring mounting

Outlines

Dimensions in mm

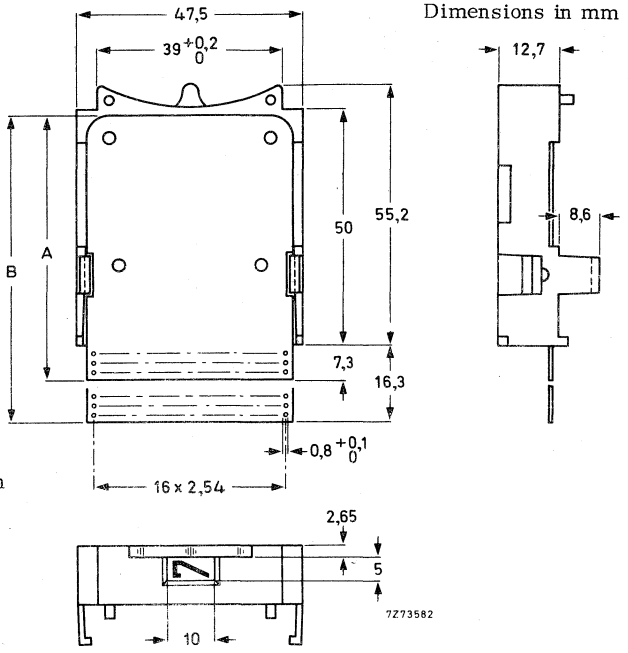


Fig. 1.
Thumbwheel switch, T version
A : short track plate, used in switches without diodes
B : long track plate, used in switches with diodes, and in type T10P2C.

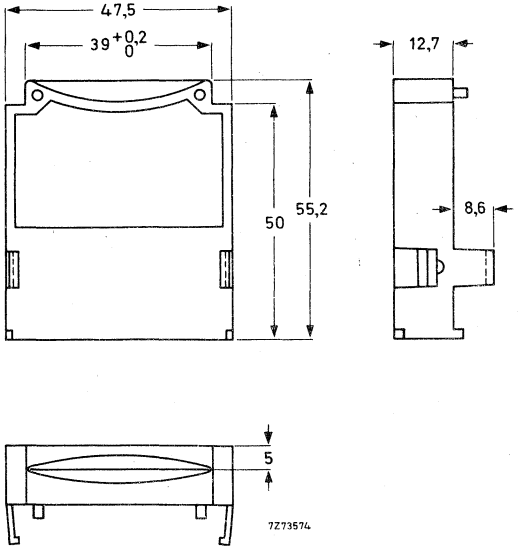


Fig. 2. Spacer for T version.

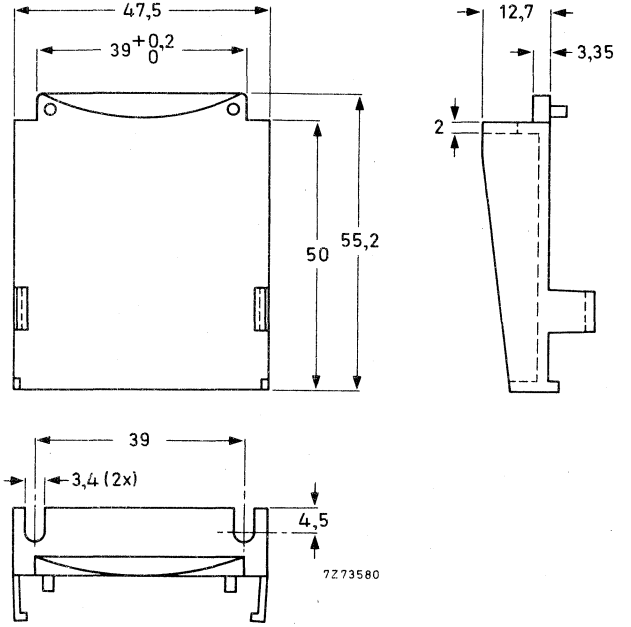


Fig. 3. Male end-piece, T version, for mounting with screws to the panel.

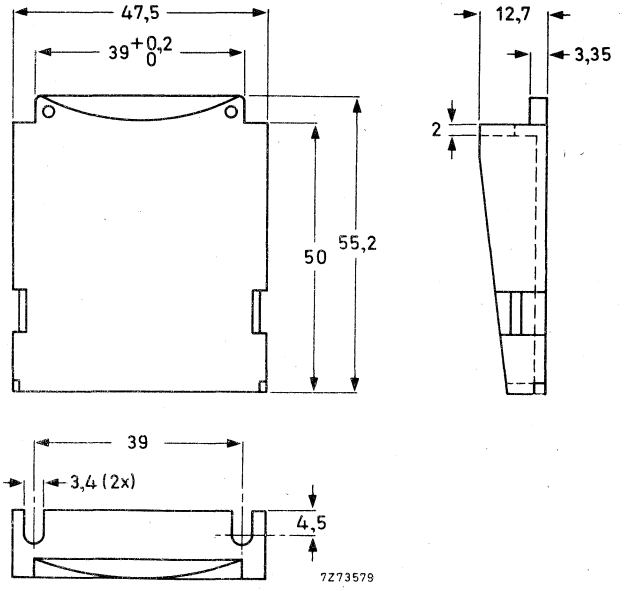


Fig. 4. Female end-piece, T version, for mounting with screws to the panel.

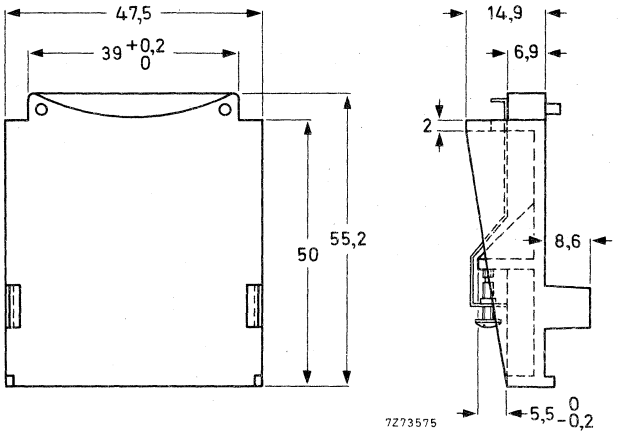


Fig. 5. Male end-piece with brackets, T version.

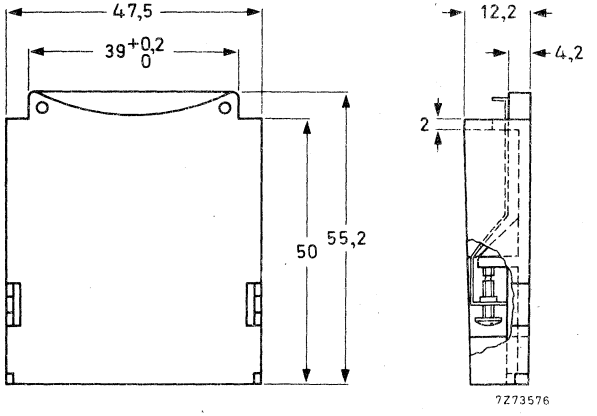


Fig. 6. Female end-piece with brackets, T version.

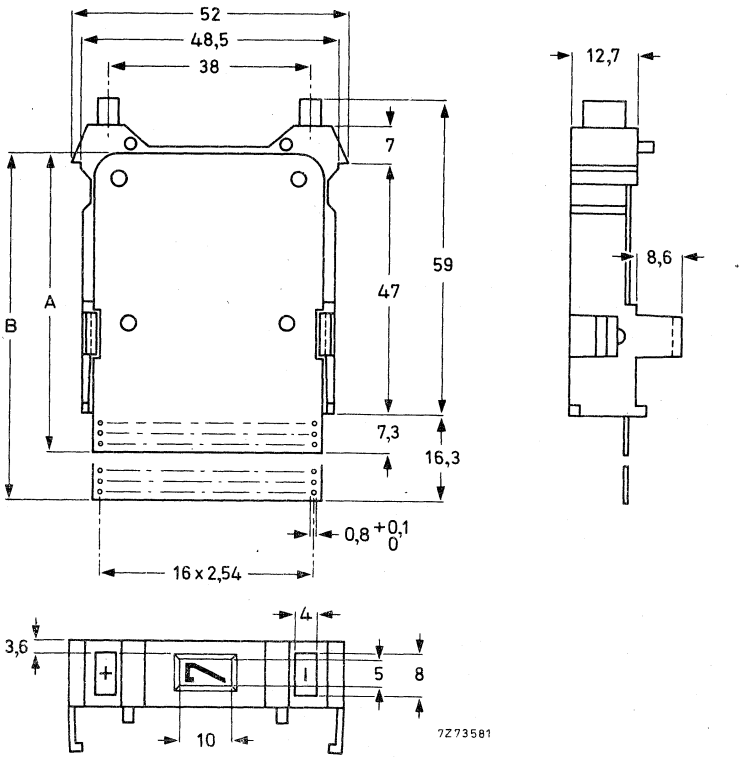


Fig. 7. Thumbwheel switch, B version
A : short track plate, used in switches without diodes
B : long track plate, used in switches with diodes, and in type B10P2C.

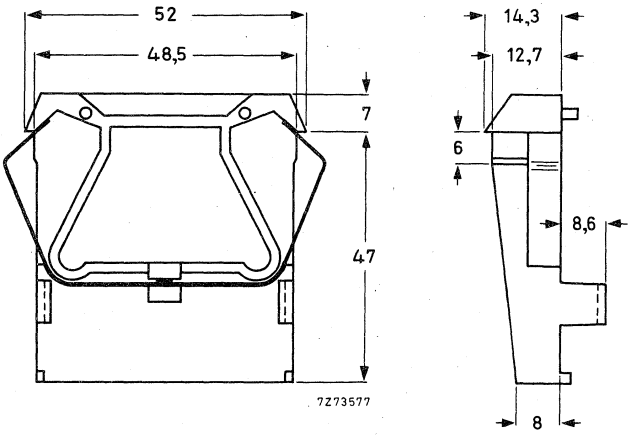


Fig. 8. Male end-piece (spring mounting), B version.

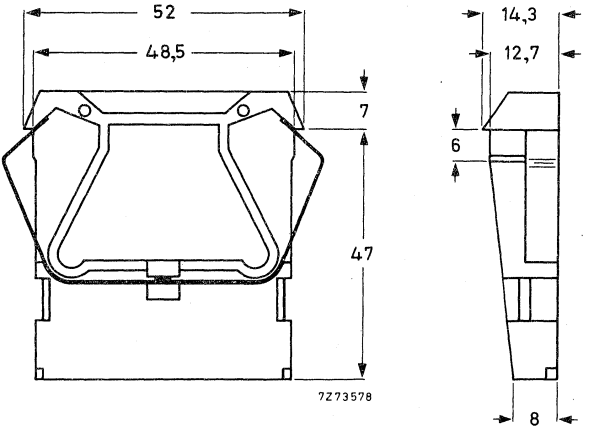


Fig. 9. Female end-piece (spring mounting), B version.

Terminals

The switches are provided with holes for connection. They can be supplied with pins for wire-wrapping on request.
The holes have a pitch of 2,54 mm (0,1 inch).

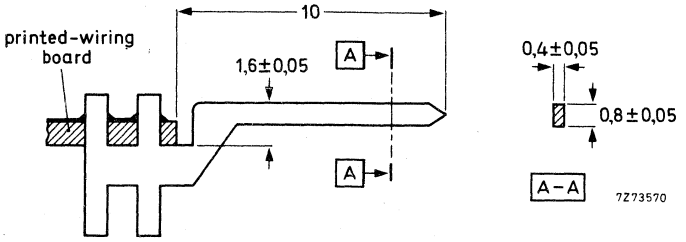


Fig. 10. Outlines of the pins for wire-wrapping.

Mass 23 g approximately

Numerals size 8 mm x 4,5 mm
line thickness 1,1 mm

Mounting

The T switches are "block mounted" to the panel with M3 screws or with mounting brackets, depending on the end-pieces used. Maximum permissible couple applied to the screws in the brackets 250 mNm.
The B switches are mounted by means of end-pieces with springs.
Panel cut-outs for the different versions are shown below.

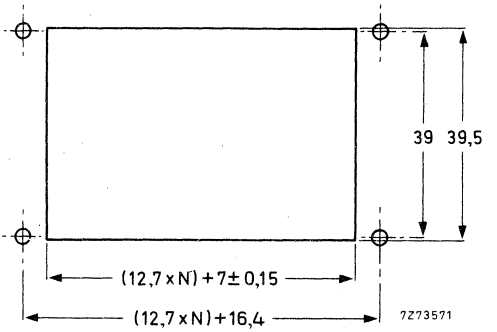


Fig. 11. Panel cut-out for T switches and end-pieces for mounting with four M3 screws.

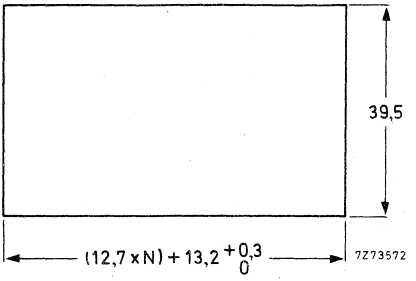


Fig. 12. Panel cut-out for T switches and end-pieces with brackets.

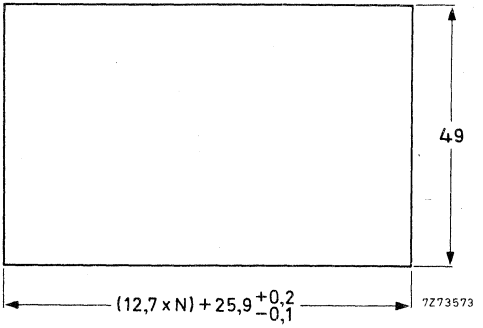


Fig. 13. Panel cut-out for B switches.

TECHNICAL PERFORMANCE

D.C. working voltage	250 V
D.C. test voltage	750 V
Insulation resistance, measured at 100 V (d.c.) [1]	
NT and NB version [2]	10^4 MΩ
T and B version [3]	10^5 MΩ
After humidity test	
NT and NB version [2]	10^2 MΩ
T and B version [3]	10^3 MΩ
Power switching capability at resistive load	10 VA
Current switching capacity (d.c.) in purely resistive circuits	0,75 A
Maximum current carrying capacity (d.c.)	3 A
Contact resistance measured at 10 mA	< 100 mΩ
Capacitance measured at 1 MHz between one terminal and all others connected to earth	1 pF
Standard gate resistor	6,8 kΩ
Operating temperature range	
NT and NB version [2]	−25 to +70 °C
T and B version [3]	−55 to +85 °C
Storage temperature range	
NT and NB version [2]	−40 to +85 °C
T and B version [3]	−65 to +100 °C
Life	in excess of 10^6 commutations at a rate of 1 step/s
Operating torque	35 to 70 mNm
Quality control tests, IEC 68-2:	
test Aa, cold	−55 °C
test Ba, dry heat	100 °C
test C, damp heat	56 days
test F, vibration	t.b.e.
test Na, temperature cycling	−55 to +100 °C
test Ea, shock	t.b.e.
test T, solderability	0 hours and 56 days

[1]) Between any pair of terminals and between any terminal and all others connected together.
[2]) Paper epoxy printed-wiring board.
[3]) Glass epoxy printed-wiring board.

SURVEY OF TYPES

description	type *)	catalogue number
Decimal switches		
10 position, 1 circuit switch, 0 to 9	NT10P1C	4311 027 91001
	NB10P1C	4311 027 93001
	T10P1C	4311 027 91091
10 position, 2 circuits switch, 0 to 9	T10P2C	4311 027 91011
	B10P2C	4311 027 93011
Coding switches 1.2.4.8		
binary output	NT1248	4311 027 91051
	NB1248	4311 027 93051
binary + complementary output	T1248C	4311 027 91041
	B1248C	4311 027 93041
complementary output	NT1248CS	4311 027 91061
	NB1248CS	4311 027 93061
Decoding switches 1.2.4.8, positive logic		
binary output	NT1248P	4311 027 91081
	NB1248P	4311 027 93081
binary + complementary output	T1248PC	4311 027 91021
	B1248PC	4311 027 93021
complementary output	NT1248PCS	t.b.e.
	NB1248PCS	t.b.e.
Decoding switches 1.2.4.8, negative logic		
binary output	NT1248N	t.b.e.
	NB1248N	t.b.e.
binary + complementary output	T1248NC	4311 027 91031
	B1248NC	4311 027 93031
complementary output	NT1248NCS	t.b.e.
	NB1248NCS	t.b.e.

*) "N" in front of the number indicates that the switch has a paper epoxy printed-wiring board. This material is only used for single-sided boards. Double-sided boards, used in switches with binary and complementary output, are made of glass epoxy.
Switches with single-sided glass epoxy printed-wiring boards can be supplied on request.
Switches with pins for wire wrapping can be supplied on request. The type number is then the same as in the Table above, but with the letter "W" inserted behind the T or the B, for example: TW1248C.

ACCESSORIES

Set of two end pieces for T switches	
with screws	4311 027 91100
with bracket	4311 027 91070
Spacer for T switches	4311 023 98010
Set of two end pieces for B switches	4311 027 93071

SPECIAL VERSIONS

Internally lit switches

White translucent rotor with black engraving. Lamp max. 5 V. Minimum life time 50 000 h (about 6 years). Lower voltage (applicable in darkroom) extends the life time. Type number prefix is extended with an "L", for example LNT1248.

Limit stops

Rotation of the rotor can be limited to any position by means of stop pins.
- for T switches these are self-tapping screws, diameter 2,18 mm, length 4,8 mm, and can be removed.
- for B switches these are specially tooled parts. They can be fitted by means of a pair of tweezers and cannot be removed.

The stop pins can be installed by customer or by factory.
Minimum quantities 1000 pieces.

Sealed switches

Contact chamber is sealed by a nylon ring, for protection against dust and sand. May be used in explosive and aggressive atmospheres. Type number prefix is extended with an "S", for example SNT1248.

Colour of housing/rotor

Rotors also available in red. Type number prefix is extended with an "R", for example RNT1248.
Other colours for rotor and housing can be considered, but only for order quantities in one batch and one colour of 10 000 pieces or more.

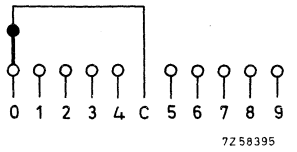
Special engraving

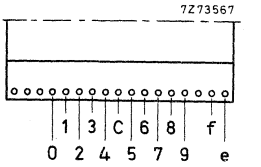
Special engraving requirements can be undertaken.
Due to cost of specific tooling, a minimum quantity of 5000 is recommended.

DIAGRAMS AND TERMINAL LOCATION

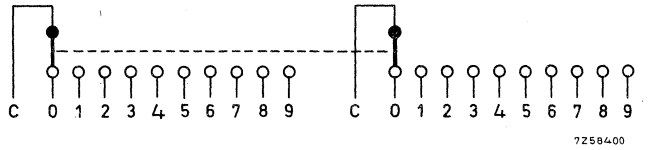
The terminals are shown at the solder side of the printed-wiring board. This is the side facing the housing. Terminals e and f are for connection of a supply to the lamp in internally lit switches.

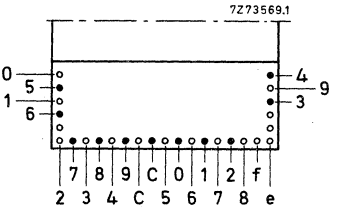
NT10P1C, NB10P1C
T10P1C



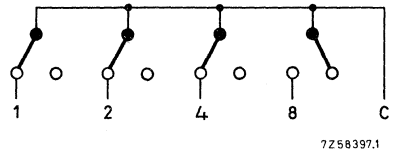


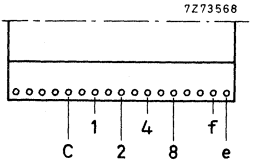
T10P2C, B10P2C





NT1248, NB1248

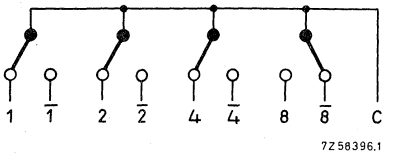


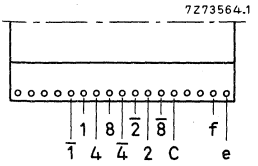


Truth table

Index	1 2 4 8
0	0 0 0 0
1	1 0 0 0
2	0 1 0 0
3	1 1 0 0
4	0 0 1 0
5	1 0 1 0
6	0 1 1 0
7	1 1 1 0
8	0 0 0 1
9	1 0 0 1

T1248C, B1248C

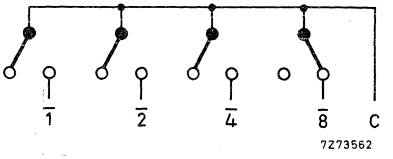


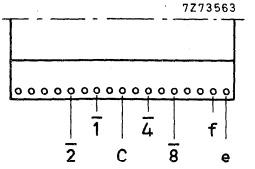


Truth table

Index	1 2 4 8	1̄ 2̄ 4̄ 8̄
0	0 0 0 0	1 1 1 1
1	1 0 0 0	0 1 1 1
2	0 1 0 0	1 0 1 1
3	1 1 0 0	0 0 1 1
4	0 0 1 0	1 1 0 1
5	1 0 1 0	0 1 0 1
6	0 1 1 0	1 0 0 1
7	1 1 1 0	0 0 0 1
8	0 0 0 1	1 1 1 0
9	1 0 0 1	0 1 1 0

NT1248CS, NB1248CS

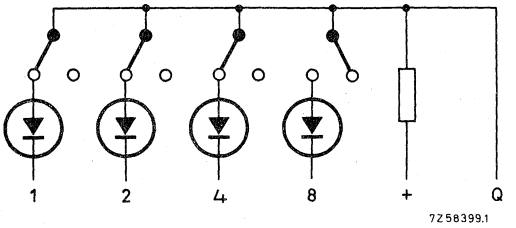


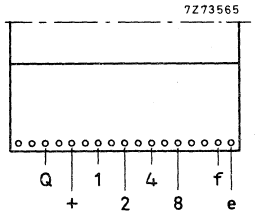


Truth table

Index	1̄ 2̄ 4̄ 8̄
0	1 1 1 1
1	0 1 1 1
2	1 0 1 1
3	0 0 1 1
4	1 1 0 1
5	0 1 0 1
6	1 0 0 1
7	0 0 0 1
8	1 1 1 0
9	0 1 1 0

NT1248P, NB1248P

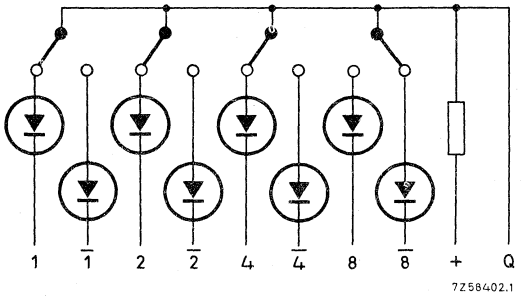


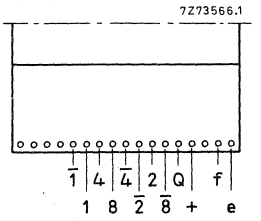


Truth table

Index	1 2 4 8
0	0 0 0 0
1	1 0 0 0
2	0 1 0 0
3	1 1 0 0
4	0 0 1 0
5	1 0 1 0
6	0 1 1 0
7	1 1 1 0
8	0 0 0 1
9	1 0 0 1

T1248PC, B1248PC

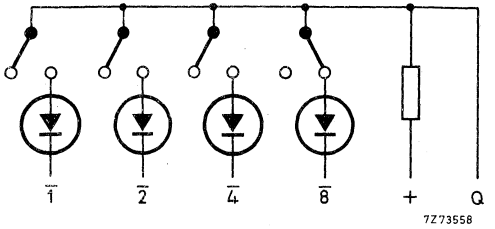


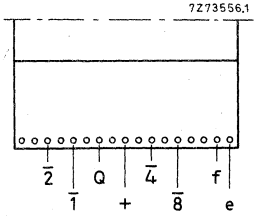


Truth table

Index	1 2 4 8	1̄ 2̄ 4̄ 8̄
0	0 0 0 0	1 1 1 1
1	1 0 0 0	0 1 1 1
2	0 1 0 0	1 0 1 1
3	1 1 0 0	0 0 1 1
4	0 0 1 0	1 1 0 1
5	1 0 1 0	0 1 0 1
6	0 1 1 0	1 0 0 1
7	1 1 1 0	0 0 0 1
8	0 0 0 1	1 1 1 0
9	1 0 0 1	0 1 1 0

NT1248PCS, NB1248PCS

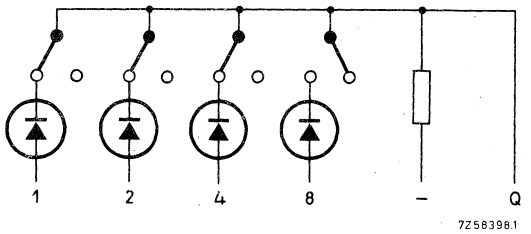


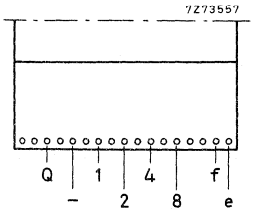


Truth table

Index	1̄ 2̄ 4̄ 8̄
0	1 1 1 1
1	0 1 1 1
2	1 0 1 1
3	0 0 1 1
4	1 1 0 1
5	0 1 0 1
6	1 0 0 1
7	0 0 0 1
8	1 1 1 0
9	0 1 1 0

NT1248N, NB1248N

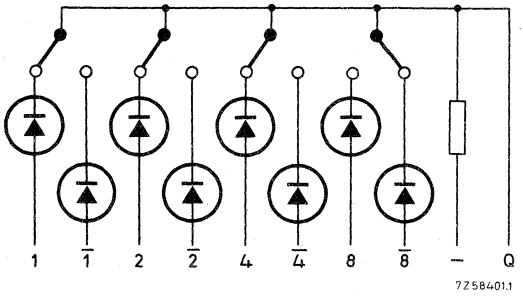


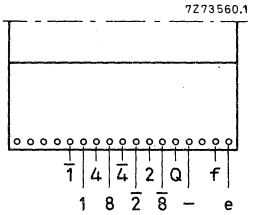


Truth table

Index	1 2 4 8
0	0 0 0 0
1	1 0 0 0
2	0 1 0 0
3	1 1 0 0
4	0 0 1 0
5	1 0 1 0
6	0 1 1 0
7	1 1 1 0
8	0 0 0 1
9	1 0 0 1

T1248NC, B1248NC

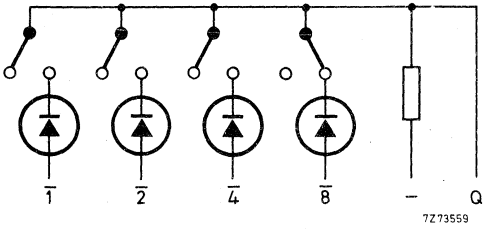


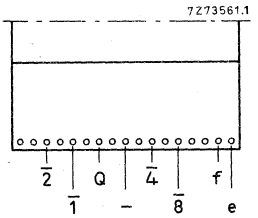


Truth table

Index	1 2 4 8	1̄ 2̄ 4̄ 8̄
0	0 0 0 0	1 1 1 1
1	1 0 0 0	0 1 1 1
2	0 1 0 0	1 0 1 1
3	1 1 0 0	0 0 1 1
4	0 0 1 0	1 1 0 1
5	1 0 1 0	0 1 0 1
6	0 1 1 0	1 0 0 1
7	1 1 1 0	0 0 0 1
8	0 0 0 1	1 1 1 0
9	1 0 0 1	0 1 1 0

NT1248NCS, NB1248NCS





Truth table

Index	1̄ 2̄ 4̄ 8̄
0	1 1 1 1
1	0 1 1 1
2	1 0 1 1
3	0 0 1 1
4	1 1 0 1
5	0 1 0 1
6	1 0 0 1
7	0 0 0 1
8	1 1 1 0
9	0 1 1 0

NUMERICAL DISPLAY UNIT
for direct figure selection

QUICK REFERENCE DATA	
Display figures	0 to 9, in 5x7 dot matrix
Type of matrix lamps	6 V, 50 mA; incandescent
Height of figure	140 mm
Legibility	70 m (approximately) within an angle of 120°

APPLICATION

The unit provides a simple and inexpensive means of showing numerical information such as score display for indoor sports, stock exchange rates, and the numbers of departure platforms and quays. Figure selection is direct by means of, say, a switch.

DESCRIPTION

The numerals are formed in a 5x7 matrix of 6 V, 50 mA incandescent lamps (E 10 fitting), measuring approximately 140 mm x 100 mm. The lamp holders together with a diode matrix are mounted on a printed-wiring board in a black polystyrene housing.
A spring-mounted white plastic reflector block ensures maximum light intensity, while a translucent red acrylic reflection-free plate acts as the cover of the housing and ensures that a clear red spot is obtained when a lamp is lit. The numerals, 0 to 9, are clearly visible from more than 70 m over an angle of 120°.
The red cover is easily removed for mounting or for lamp replacement.
For electrical connection the module is provided with 0,250 inch pierced tags (in accordance with DIN 46248, Blatt 3) for 0,250 inch receptacles with dimples to ensure correct insertion depth, and rigidity.

MECHANICAL DATA

Dimensions (mm)

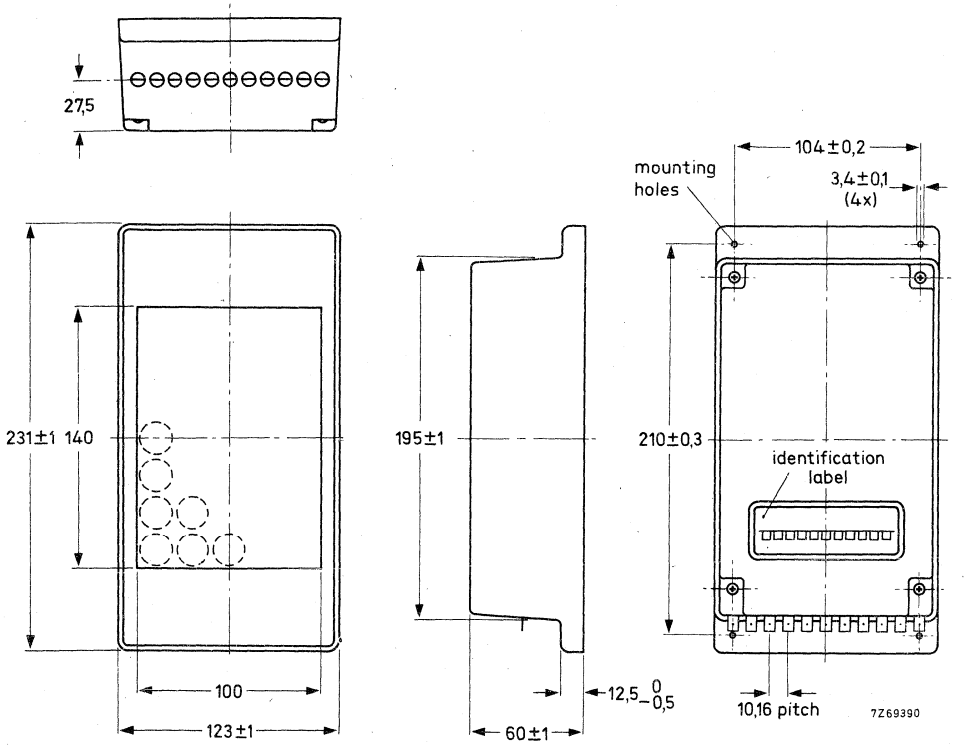


Fig. 1

Terminal location

Terminal location is shown in Fig. 2. To display a numeral, connect +6 V to the relevant terminal.

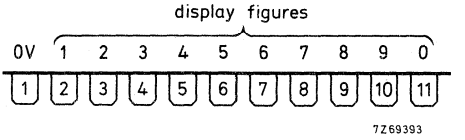


Fig. 2

Mass

510 g (approximately)

Mounting

Access to four mounting holes for M3 screws is achieved after removal of the red cover (see Fig. 1). The cover is removed by pressing both corners on a long side simultaneously. The lock profiles will then disengage. If not, the blade of a knife, screwdriver or similar object can be used with due care to lever out the cover at the corners of one long side.
To avoid damage to housing or cover, never apply a lever to the short sides of the unit where the lock profiles are situated. The cover is replaced (matt side up) by pressing in the middle of both sides until the lock profiles engage.

DISPLAY AND ELECTRICAL DATA

Display figures	0 to 9, in 5x7 dot matrix
Type of matrix lamp	6 V, 50 mA; incandescent, E 10 fitting type no 7121D cat. no 9234 406 101..
Height of figure	140 mm
Legibility	70 m (approximately) within an angle of 120°
Supply voltage	+6 V + 10% *)
current	max. 850 mA
peak current	8 A for 10 ms
Ambient temperature range	
operating	-10 to +60 °C
storage	-10 to +70 °C

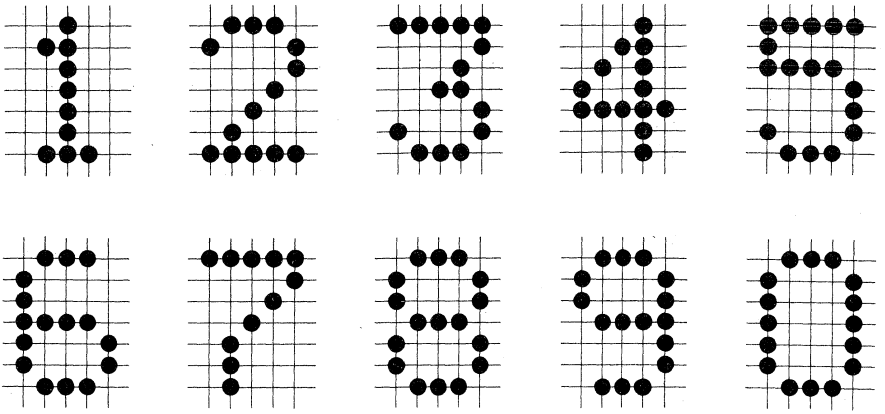


Fig. 3. Numeral make-up 7Z74027

*) At lower voltages the life-time of the lamps is increased, but the light intensity is decreased.

APPLICATION INFORMATION

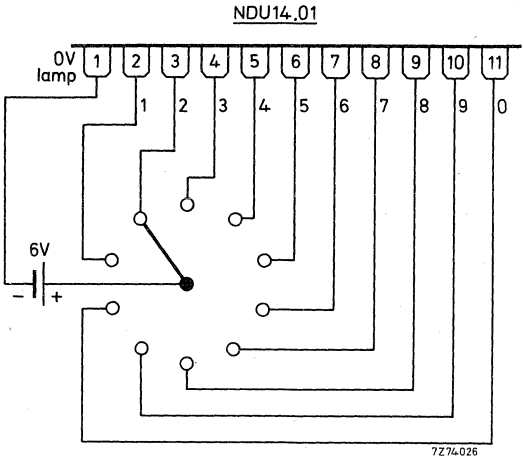


Fig. 4. Connections to the unit when used with a rotary switch

NUMERICAL DISPLAY UNIT
with decimal counter

QUICK REFERENCE DATA	
Display figures	0 to 9, in 5x7 dot matrix
Type of matrix lamps	6 V, 50 mA; incandescent
Height of figure	140 mm
Legibility	70 m (approximately) within an angle of 120°
Counter inputs	4 to 30 V

APPLICATION

This unit is very suitable for numerical display in industry (e.g. for counting), at auctions (prices) and congresses (number of votes). It counts the number of pulses supplied to the input terminal.

DESCRIPTION

The numerals are formed in a 5x7 matrix of 6 V, 50 mA incandescent lamps (E 10 fitting), measuring approximately 140 mm x 100 mm. Two printed-wiring boards are mounted in the black polystyrene housing: one board with the lamp holders and a diode matrix, and the other with a decimal counter. A spring-mounted white plastic reflector block ensures maximum light intensity, while a translucent red acrylic reflection-free plate acts as the cover of the housing and ensures that a clear red spot is obtained when a lamp is lit. The numerals 0 to 9 are clearly visible from 70 m over an angle of 120°. The red cover is easily removed for mounting and for lamp replacement.
For electrical connection the modules are provided with 0,250 inch pierced tags (in accordance with DIN 46248, Blatt 3) for 0,250 inch receptacles with dimples to ensure correct insertion depth, and rigidity.
The numeral displayed depends on the number of pulses entered after a reset signal. After every ten pulses a carry signal is available at the clock output terminal CL_o for multi-decade counting. It is connected to the clock input terminal CL_i of the following unit.
Applying the correct signal to the reset input brings the counter and the display to zero. Reset is automatic when switching on the 5 V supply to the logic circuit.
When the display enable output terminal DE_o is connected to the display enable input terminal of the following unit, it permits blanking of a multi-decade counter by a relatively small enable/disable signal.

MECHANICAL DATA

Dimensions (mm)

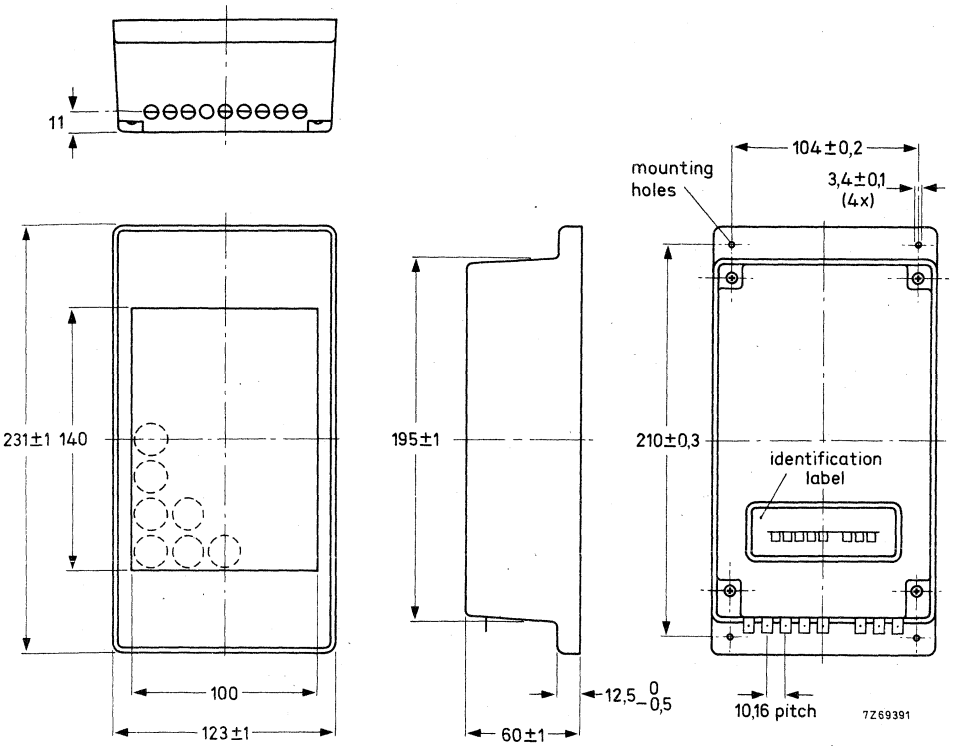


Fig. 1

Terminal location

Terminal 1 = 0 V of lamp
2 = 0 V of logic
3 = 6 V of lamp and 5 V of logic
4 = display enable input
5 = display enable output
6 = not present
7 = clock input
8 = clock output
9 = reset input

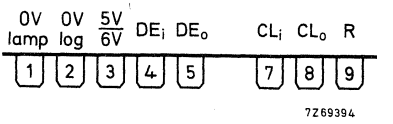


Fig. 2

Mass

580 g (approximately)

Mounting

Access to four mounting holes for M3 screws is achieved after removal of the red cover (see Fig. 1). The cover is removed by pressing both corners on a long side simultaneously. The lock profiles will then disengage. If not, the blade of a knife, screwdriver or similar object can be used with due care to lever out the cover at the corners of one long side.
To avoid damage to housing or cover, never apply a lever to the short sides of the unit where the lock profiles are situated. The cover is replaced (matt side up) by pressing in the middle of both sides until the lock profiles engage.

DISPLAY AND ELECTRICAL DATA

Display figures	0 to 9, in 5 x 7 dot matrix
Type of matrix lamp	6 V, 50 mA; incandescent, E 10 fitting type no 7121D cat. no 9234 406 101..
Height of figure	140 mm
Legibility	70 m (approximately) within an angle of 120°

Supply

for lamps,	voltage (V_{lamp})	+6 V + 10% *)
	current	max. 850 mA
	peak current	8 A for 10 ms
for logic,	voltage (V_{log})	+5 V ± 5%
	current	typ. 90 mA
	switch-on time (t_s)	max. 250 ms (for automatic reset)

Ambient temperature range

operating	−10 to +60 °C
storage	−10 to +70 °C

Logic input data

Voltage level (V_i)		
	HIGH	min. +4 V max. +30 V
	LOW	min. −15 V max. +1 V
Active level		
	DE_i	HIGH **)
	CL_i	HIGH
	R	HIGH
Resistance (all inputs)		min. 10 kΩ
Time data for clock and reset inputs		see Fig. 3

*) At lower voltages the life-time of the lamps is increased, but the light intensity is decreased.

**) The figure is displayed for as long as the input is floating or LOW. The state of this input has no influence on the counter, only on the display.

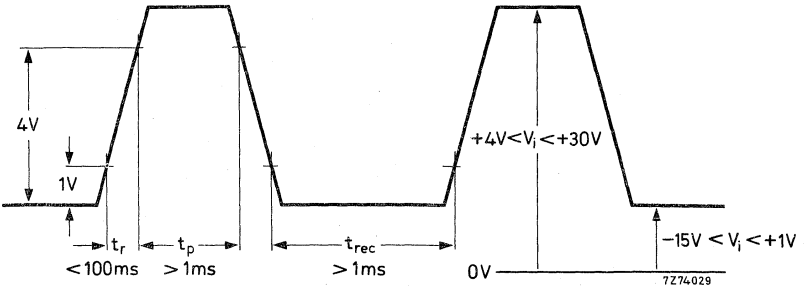


Fig. 3. Timing diagram

Logic output data (fan-out)

Clock output (CL_o)	1 CL_i
Display enable output (DE_o)	1 DE_i

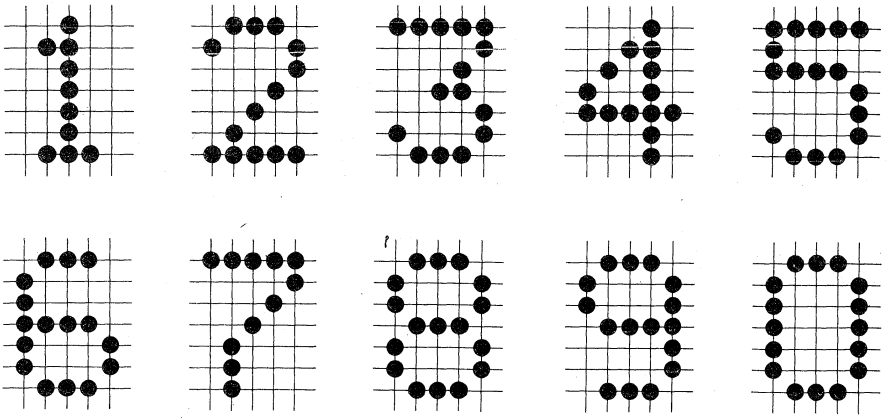


Fig. 4. Numeral make-up

APPLICATION INFORMATION

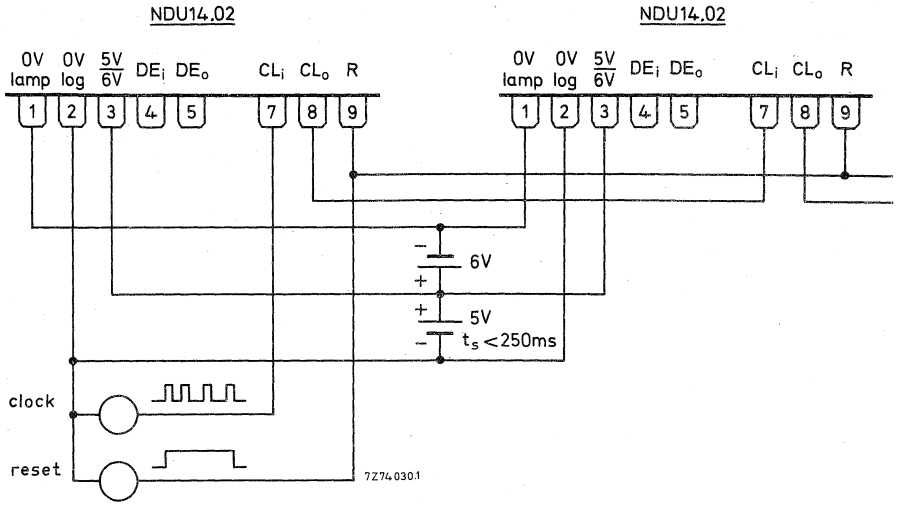


Fig. 5. Connections required when the units are used in multi-decade counters

NUMERICAL DISPLAY UNIT
with BCD-code input

QUICK REFERENCE DATA	
Display figures	0 to 9, in 5x7 dot matrix
Type of matrix lamps	6 V, 50 mA; incandescent
Height of figure	140 mm
Legibility	70 m (approximately) within an angle of 120°
BCD inputs	TTL level

APPLICATION

The NDU 14.03 has been designed to provide the display for binary counters with BCD outputs, e.g. digital clocks and systems in which any number sequence must be displayed (counting back, weighing, computer outputs, binary coding thumbwheel switches).

DESCRIPTION

The numerals are formed in a 5x7 matrix of 6 V, 50 mA incandescent lamps (E 10 fitting), measuring approximately 140 mm x 100 mm. Two printed-wiring boards are mounted in the black polystyrene housing: one board with the lamp holders and a diode matrix, and the other with a decoder. A spring-mounted white plastic reflector block ensures maximum light intensity, while a translucent red acrylic reflection-free plate acts as the cover of the housing and ensures that a clear red spot is obtained when a lamp is lit. The numerals 0 to 9 are clearly visible from 70 m over an angle of 120°. The red cover is easily removed for mounting and for lamp replacement.
For electrical connection the module is provided with 0,250 inch pierced tags (in accordance with DIN 46248, Blatt 3) for 0,250 inch receptacles with dimples to ensure correct insertion depth, and rigidity.
Input signals in BCD code are required to display a figure. The built-in decoder translates these signals into drive signals for the lamps.
The unit is provided with display enable input and output.

MECHANICAL DATA

Dimensions (mm)

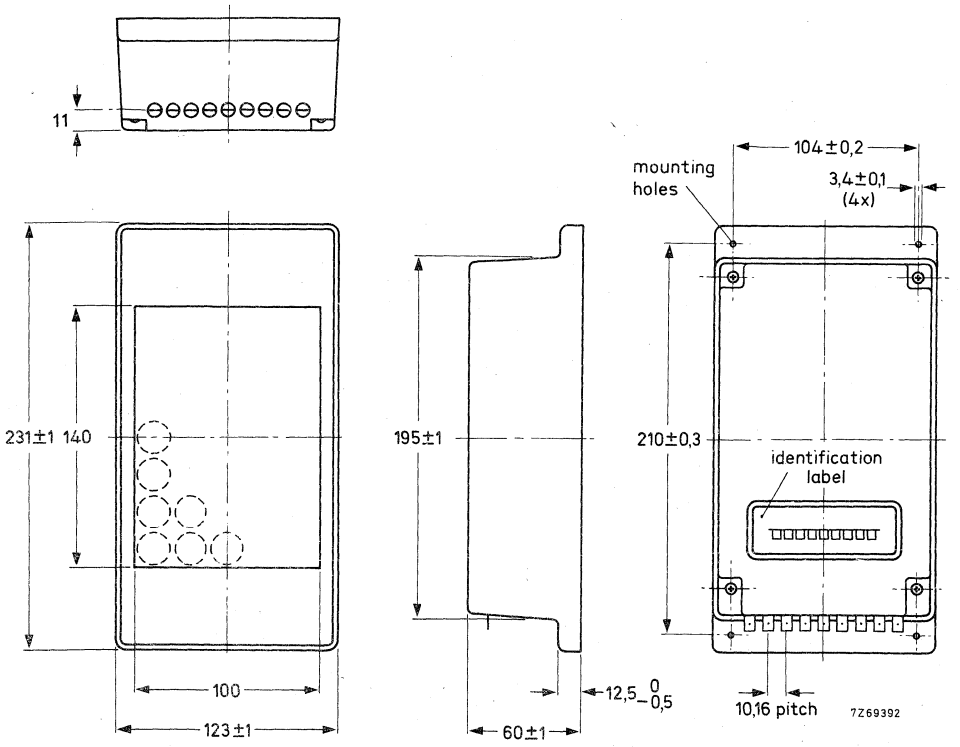


Fig. 1

Terminal location

Terminal 1 = 0 V of lamp
2 = 0 V of logic
3 = 6 V of lamp and 5 V of logic
4 = display enable input
5 = display enable output
6 = } BCD-input
7 = }
8 = }
9 = }

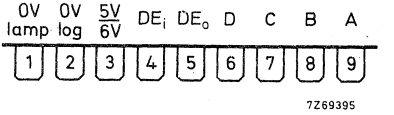


Fig. 2

Mass

580 g (approximately)

Mounting

Access to four mounting holes for M3-screws is achieved after removal of the red cover (see Fig. 1). The cover is removed by pressing both corners on a long side simultaneously. The lock profiles will then disengage. If not, the blade of a knife, screwdriver or similar object can be used with due care to lever out the cover at the corners of one long side.
To avoid damage to housing or cover, never apply a lever to the short sides of the unit where the lock profiles are situated. The cover is replaced (matt side up) by pressing in the middle of both sides until the lock profiles engage.

DISPLAY AND ELECTRICAL DATA

Display figures	0 to 9, in 5x7 dot matrix
Type of matrix lamp	6 V, 50 mA; incandescent, E 10 fitting type no 7121D cat. no 9234 406 101..
Height of figure	140 mm
Legibility	70 m (approximately) within an angle of 120°
Supply	
for lamps, voltage (V_{lamp})	+6 V + 10% *)
current	max. 850 mA
peak current	8 A for 10 ms
for logic, voltage (V_{log})	+5 V ±5%
current	typ. 90 mA
Ambient temperature range	
operating	−10 to +60 °C
storage	−10 to +70 °C
Logic input data (TTL logic)	
A,B,C,D inputs (see truth table)	
Level HIGH, voltage	min. 2 V max. 5,5 V
current	max. 40 µA
LOW, voltage	min. 0 V max. 0,8 V
current	−max. 1,6 mA

*) At lower voltage the life-time of the lamps is increased, but the light intensity is decreased.

Display enable input

Voltage level HIGH	min. +4 V max. +30 V
LOW	min. −15 V max. +1 V
Active (disable) level DE_i	HIGH **)
Resistance	min. 10 kΩ

Truth table

Combinations not included in the table give no display.

display figure	A	B	C	D
0	L	L	L	L
1	H	L	L	L
2	L	H	L	L
3	H	H	L	L
4	L	L	H	L
5	H	L	H	L
6	L	H	H	L
7	H	H	H	L
8	L	L	L	H
9	H	L	L	H

Logic output data (fan-out)

Display enable output (DE_o)	1 DE_i

**) The figure is displayed for as long as the input is floating or LOW.
The state of this input has no influence on the counter, only on the display.

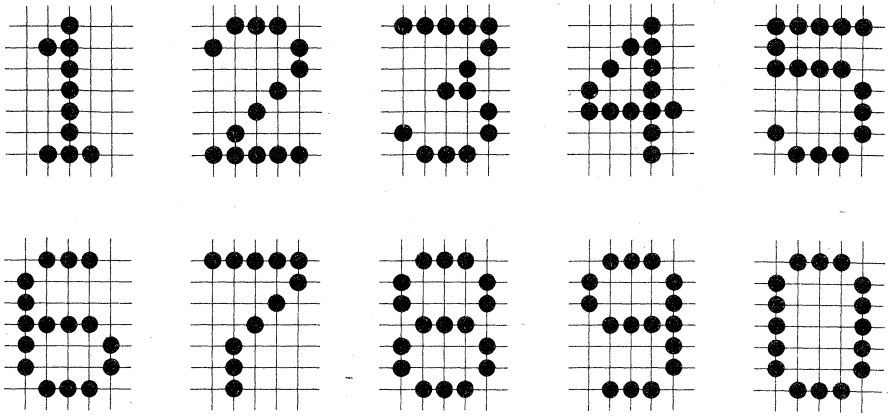


Fig. 3. Numeral make-up

APPLICATION INFORMATION

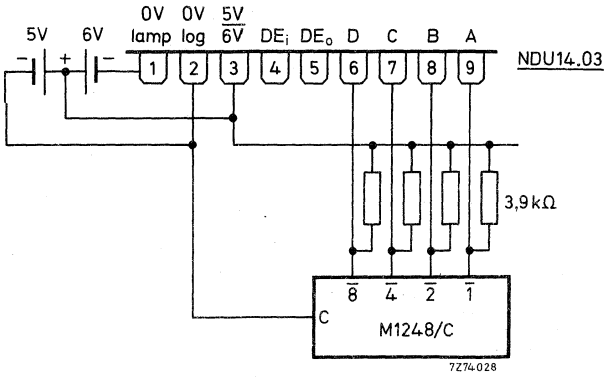


Fig. 4. Connections to the unit when used with the M1248/C thumbwheel switch.

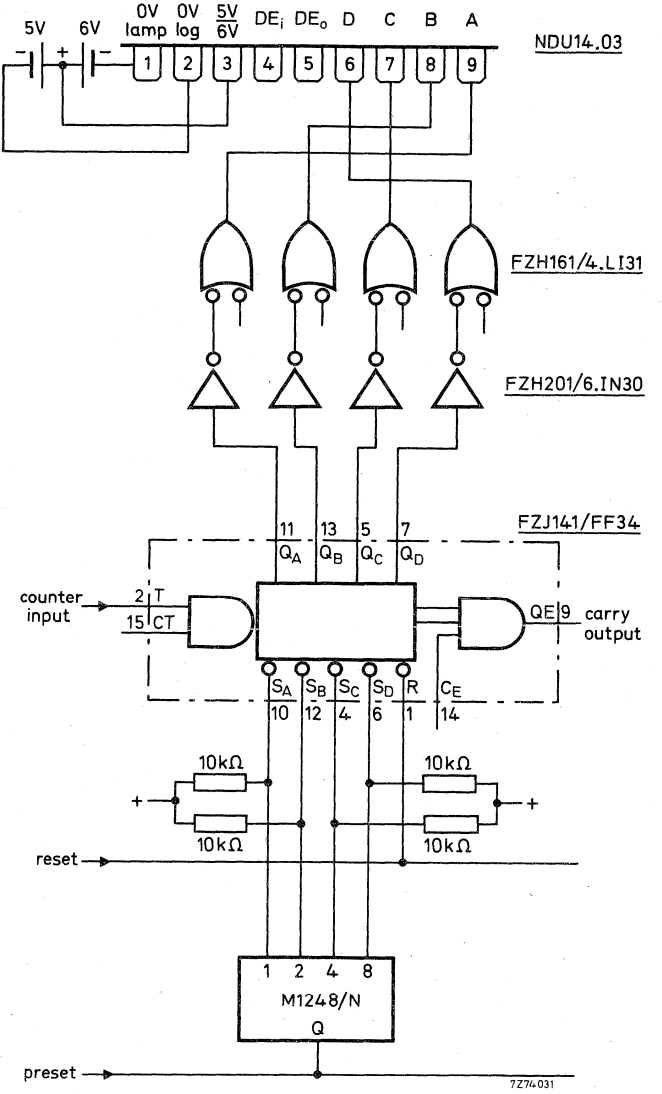
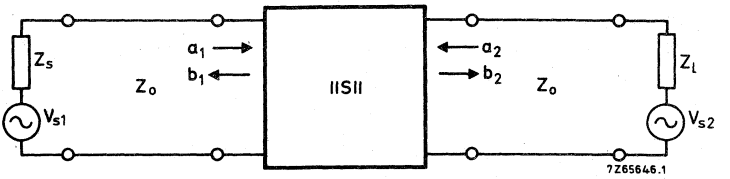


Fig. 5. Decimal counter with preset based on FZ/30 series modules using the NDU 14.03 as the display unit.

Hybrid circuits

SCATTERING PARAMETERS

In distinction to the conventional h, y and z-parameters, s-parameters relate to travelling wave conditions. The figure below shows a two-port network with the incident and reflected waves a_1, b_1, a_2 and b_2.



$$a_1 = \frac{V_{i1}}{\sqrt{Z_o}} \qquad a_2 = \frac{V_{i2}}{\sqrt{Z_o}} \qquad 1)$$

$$b_1 = \frac{V_{r1}}{\sqrt{Z_o}} \qquad b_2 = \frac{V_{r2}}{\sqrt{Z_o}}$$

Z_o = characteristic impedance of the transmission line in which the two-port is connected.

V_i = incident voltage

V_r = reflected (generated) voltage

The four-pole equations for s-parameters are:

$$b_1 = s_{11}a_1 + s_{12}a_2$$
$$b_2 = s_{21}a_1 + s_{22}a_2$$

Using the subscripts i for 11, r for 12, f for 21 and o for 22, it follows that:

$$s_i = s_{11} = \frac{b_1}{a_1}\bigg|_{a_2 = 0}$$

$$s_r = s_{12} = \frac{b_1}{a_2}\bigg|_{a_1 = 0}$$

$$s_f = s_{21} = \frac{b_2}{a_1}\bigg|_{a_2 = 0}$$

$$s_o = s_{22} = \frac{b_2}{a_2}\bigg|_{a_1 = 0}$$

1) The squares of these quantities have the dimension of power.

The s-parameters can be named and expressed as follows:

$s_i = s_{11}$ = Input reflection coefficient.
The complex ratio of the reflected wave and the incident wave at the input, under the conditions $Z_l = Z_o$ and $V_{s2} = 0$.

$s_r = s_{12}$ = Reverse transmission coefficient.
The complex ratio of the generated wave at the input and the incident wave at the output, under the conditions $Z_s = Z_o$ and $V_{s1} = 0$.

$s_f = s_{21}$ = Forward transmission coefficient.
The complex ratio of the generated wave at the output and the incident wave at the input, under the conditions $Z_l = Z_o$ and $V_{s2} = 0$

$s_o = s_{22}$ = Output reflection coefficient.
The complex ratio of the reflected wave and the incident wave at the output, under the conditions $Z_s = Z_o$ and $V_{s1} = 0$.

HYBRID INDUCTIVE PROXIMITY SWITCH

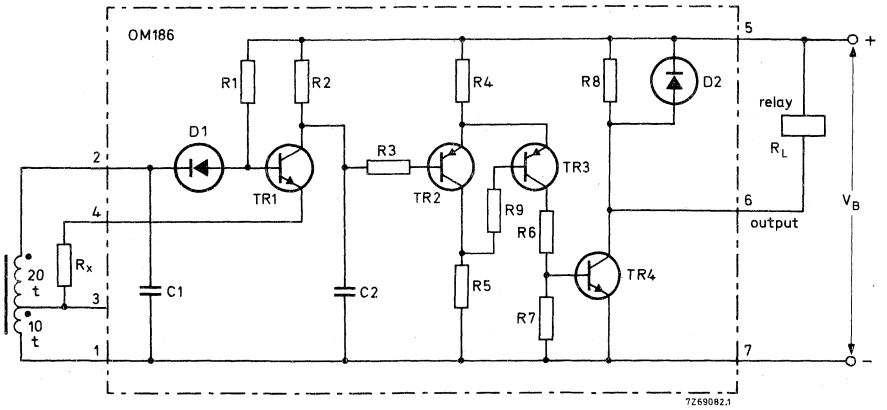
Unpotted hybrid integrated circuit intended for proximity switches in tubular construction. Positive supply voltage.

The circuit consists of an oscillator, a rectifier stage, a level switch and an output stage. The load, which may be the coil of an electro magnetic relay, should be connected in series with the output. A metallic object in the proximity of the oscillator coil attenuates the oscillator; when the object is within switching distance, the level switch changes state, the output transistor conducts and the relay is energized. The oscillator coil is not incorporated in the OM186. The level switch has about 5% hysteresis so that false switching due to the remaining ripple of the rectifier stage is avoided. The output transistor is protected by a diode against transients from the inductive load.

The device is a thick-film circuit deposited on a ceramic substrate. It may be potted, together with the oscillator coil and a resistor (R_X), in a non-magnetic tube of 5, 5 mm inner diameter.

QUICK REFERENCE DATA				
Supply voltage	$+V_B$		4,5 to 30	V
Load resistance	R_L	min.	120	Ω
Switching distance R_X = 330 Ω	x	typ.	1,5	mm
Hysteresis of switching distance	Δx		3 to 10	%
Switching frequency	f	<	5	kHz
Operating ambient temperature (potted)	T_{amb}		−25 to +65	°C

CIRCUIT DIAGRAM



RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	$+V_B$	max.	30	V
Load resistance	R_L	min.	120	Ω
Storage temperature	T_{stg}	−40 to +70		°C
Operating ambient temperature (potted)	T_{amb}	−25 to +65		°C

CHARACTERISTICS

Conditions (unless otherwise specified)

Supply voltage	$+V_B$	4,5 to 30		V
Load resistance	R_L	>	120	Ω
External resistance of oscillator	R_x	see switching distance below		
Ambient temperature (potted)	T_{amb}	−25 to +65		°C

Performance

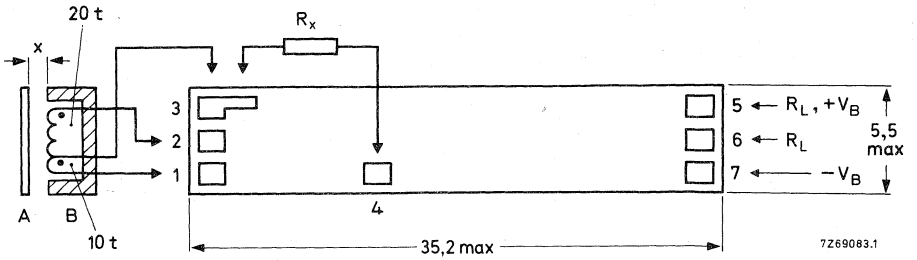
Supply current (output current not included) $+V_B$ = 24 V	$+I_B$	typ.	7	mA
Output voltage low (attenuated) at V_B = 24 V; R_L = 120 Ω	$+V_{OL}$	<	1	V
at V_B = 5 V; R_L = 500 Ω	$+V_{OL}$	<	0,25	V
Output voltage high (non-attenuated)	V_{OH}	approx. V_B		
Switching distance at oscillation coil, 10 + 20 turns; potcore 5,8 mm				
R_x = 180 Ω	x	typ.	0,6	mm [1]
R_x = 330 Ω	x	typ.	1,5	mm [1]
R_x = 400 Ω	x	typ.	2,5	mm [1]
Hysteresis of switching distance	Δx	3 to 10		%
Switching frequency	f	<	5	kHz

1) The switching distance x depends on the oscillator coil, the material of the metallic object and R_x. For measuring purposes a steel sheet of 1 mm thickness can be used. R_x must not be chosen outside the range 180 to 400 Ω.

MECHANICAL DATA

Dimensions in mm

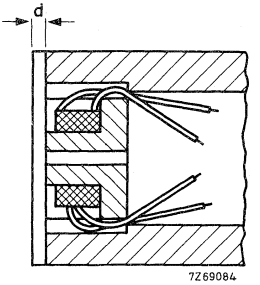
Mechanical outline and connections



A = Metallic object
B = Open potcore or potcore half with coil.

Example of Ferroxcube potcore half: type P9/5, material 3B7 or 3H1.

Insertion of potcore in brass tube



If a plastic protection cap is incorporated, its thickness d should be as small as possible, because it forms a part of the switching distance x.

The brass tube should not extend beyond the potcore.

Soldering recommendation

Use normal 60/40 solder with 2 to 4% silver.

Potting recommendations

First cover the hybrid IC with about 0,5 mm of DC 3140 (Dow Corning), let it harden and then, when the parts are inserted in the tube, fill up the tube with Stycast 2850 (Emerson and Cuming).

HYBRID INDUCTIVE PROXIMITY SWITCH

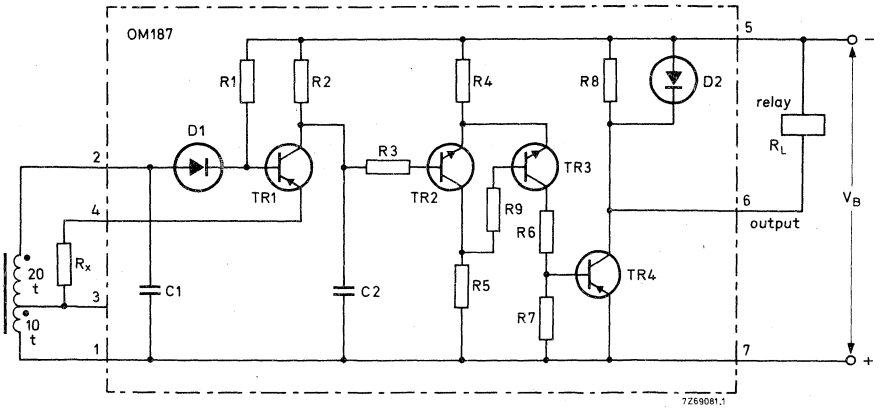
Unpotted hybrid integrated circuit intended for proximity switches in tubular construction. Negative supply voltage.

The circuit consists of an oscillator, a rectifier stage, a level switch and an output stage. The load, which may be the coil of an electro magnetic relay, should be connected in series with the output. A metallic object in the proximity of the oscillator coil attenuates the oscillator; when the object is within switching distance, the level switch changes state, the output transistor conducts and the relay is energized. The oscillator coil is not incorporated in the OM187. The level switch has about 5% hysteresis so that false switching due to the remaining ripple of the rectifier stage is avoided. The output transistor is protected by a diode against transients from the inductive load.

The device is a thick-film circuit deposited on a ceramic substrate. It may be potted, together with the oscillator coil and a resistor (R_X), in a non-magnetic tube of 5,5 mm inner diameter.

QUICK REFERENCE DATA				
Supply voltage	$-V_B$		4,5 to 30	V
Load resistance	R_L	min.	120	Ω
Switching distance R_X = 330 Ω	x	typ.	1,5	mm
Hysteresis of switching distance	Δx		3 to 10	%
Switching frequency	f	<	5	kHz
Operating ambient temperature (potted)	T_{amb}		−25 to +65	°C

CIRCUIT DIAGRAM



RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage	$-V_B$	max. 30	V
Load resistance	R_L	min. 120	Ω
Storage temperature	T_{stg}	−40 to +70	°C
Operating ambient temperature (potted)	T_{amb}	−25 to +65	°C

CHARACTERISTICS

Conditions (unless otherwise specified)

Supply voltage	$-V_B$	4,5 to 30	V
Load resistance	R_L	> 120	Ω
External resistance of oscillator	R_x	see switching distance below	
Ambient temperature (potted)	T_{amb}	−25 to +65	°C

Performance

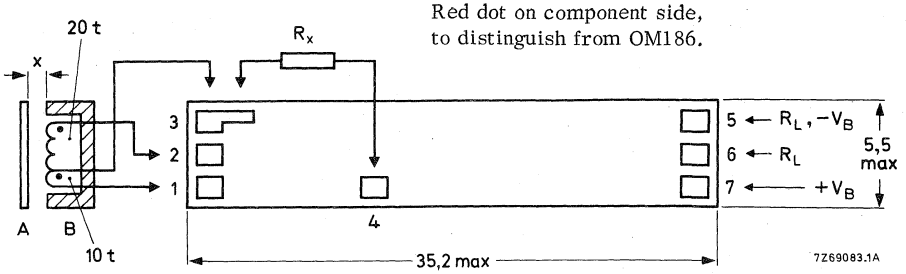
Supply current (output current not included) $-V_B$ = 24 V	$-I_B$	typ. 7	mA
Output voltage low (attenuated) at V_B = 24 V; R_L = 120 Ω	$-V_{OL}$	< 1	V
at V_B = 5 V; R_L = 500 Ω	$-V_{OL}$	< 0,25	V
Output voltage high (non-attenuated)	V_{OH}	approx. V_B	
Switching distance at oscillator coil, 10 + 20 turns; potcore 5,8 mm			
R_x = 180 Ω	x	typ. 0,6	mm [1]
R_x = 330 Ω	x	typ. 1,5	mm [1]
R_x = 400 Ω	x	typ. 2,5	mm [1]
Hysteresis of switching distance	Δx	3 to 10	%
Switching frequency	f	< 5	kHz

[1] Ths switching distance x depends on the oscillator coil, the material of the metallic object and R_x. For measuring purposes a steel sheet of 1 mm thickness can be used. R_x must not be chosen outside the range 180 to 400 Ω.

MECHANICAL DATA

Dimensions in mm

Mechanical outline and connections

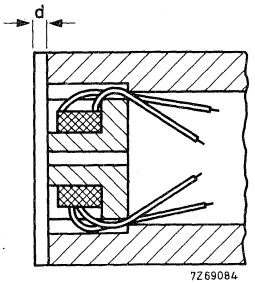


Red dot on component side, to distinguish from OM186.

A = Metallic object
B = Open potcore or potcore half with coil.

Example of Ferroxcube potcore half: type P9/5, material 3B7 or 3H1.

Insertion of potcore in brass tube



If a plastic protection cap is incorporated, its thickness d should be as small as possible, because it forms a part of the switching distance x.

The brass tube should not extend beyond the potcore.

Soldering recommendation

Use normal 60/40 solder with 2 to 4% silver.

Potting recommendations

First cover the hybrid IC with about 0,5 mm of DC 3140 (Dow Corning), let it harden and then, when the parts are inserted in the tube, fill up the tube with Stycast 2850 (Emerson and Cuming).

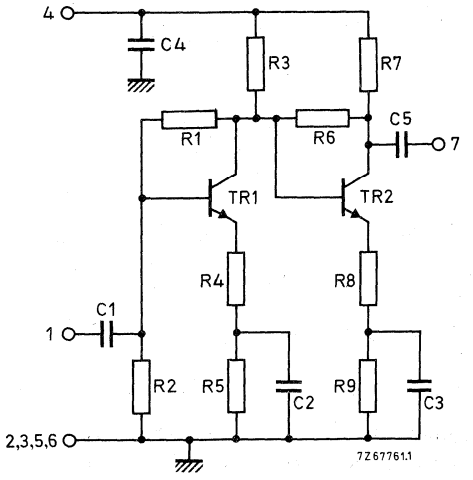
HYBRID VHF/UHF WIDE-BAND AMPLIFIER

Two-stage wide-band amplifier in the hybrid technique, designed for use in mast-head booster amplifiers, as pre-amplifier in MATV systems, and as general-purpose amplifier for v.h.f. and u.h.f. applications

QUICK REFERENCE DATA				
Frequency range	f		40 to 860	MHz
Source and load (characteristic) impedance	$R_S = R_\ell = Z_o$	=	75	Ω
Transducer gain	$G_{tr} = \|s_f\|^2$	typ.	15,5	dB
Flatness of frequency response	$\pm\Delta\|s_f\|^2$	typ.	1	dB
Output voltage at −60 dB intermodulation distortion (DIN45004, 3-tone)	$V_{o(rms)}$	>	92	dBμV
Noise figure	F	typ.	5,5	dB
D.C. supply voltage	V_B	=	24	V ± 10%
Operating ambient temperature	T_{amb}	−20 to +70		°C

ENCAPSULATION 7-pin, in-line, resin-coated body, see MECHANICAL DATA

CIRCUIT DIAGRAM



RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Operating ambient temperature	T_{amb}		−20 to +70	°C
Storage temperature	T_{stg}		−40 to +125	°C
D.C. supply voltage	V_B	max.	28	V
Peak voltages on pins 1 and 7	V_{1M}, V_{7M}	max.	28	V
	$-V_{1M}$, V_{7M}	max.	10	V
Peak incident powers on pins 1 and 7	P_{I1M}, P_{I7M}	max.	100	mW

CHARACTERISTICS

Measuring conditions

→ V.H.F.-U.H.F. test socket	catalogue no. 3504 110 01840 *			
Ambient temperature	T_{amb}	=	25	°C
D.C. supply voltage	V_B	=	24	V
Source impedance and load impedance	R_s, R_ℓ	=	75	Ω
Characteristic impedance of h.f. connections	Z_o	=	75	Ω
Frequency range	f		40 to 860	MHz

Performance

Supply current	I_B	typ.	23	mA
Transducer gain	$G_{tr} = \lvert s_f \rvert^2$		13 to 18	dB
		typ.	15,5	dB
Flatness of frequency response	$\pm\Delta \lvert s_f \rvert^2$	typ.	1	dB
Individual maximum v.s.w.r.				
input	$VSWR_{(i)}$	typ.	2,2	**
output	$VSWR_{(o)}$	typ.	2,5	**
Back attenuation				
f = 100 MHz	$\lvert s_r \rvert^2$	typ.	30	dB
f = 860 MHz	$\lvert s_r \rvert^2$	typ.	24	dB
Output voltage at −60 dB intermodulation distortion (DIN45004, par. 6.3: 3-tone)	$V_{o(rms)}$	>	92	dBμV
		typ.	94	dBμV
Noise figure	F	typ.	5,5	dB

s-parameters	$s_f = s_{21}$	$s_i = s_{11}$
	$s_r = s_{12}$	$s_o = s_{22}$

* This socket can be made available for customer reference purposes.
** Highest value, for a sample, occurring in the frequency range.

OPERATING CONDITIONS

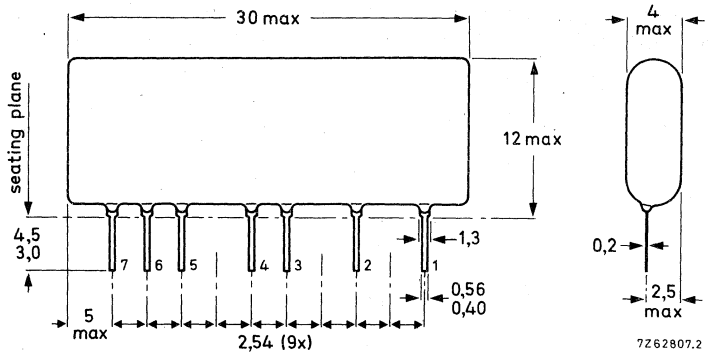
Ambient temperature range	T_{amb}		−20 to +70	°C
D.C. supply voltage	V_B	=	24	V ±10%
Frequency range	f		40 to 860	MHz
Source impedance and load impedance	R_s, R_ℓ	=	75	Ω

MECHANICAL DATA

Dimensions in mm

Encapsulation

The device is resin coated.



Terminal connections

1	= Input
2, 3, 5, 6	= Common
4	= Supply (+)
7	= Output

Soldering recommendations

Hand soldering

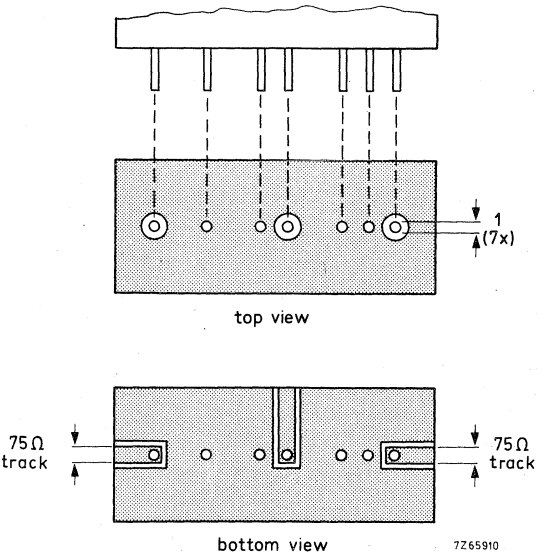
Maximum contact time for a soldering-iron temperature of 260 °C; up to seating plane: 5 s

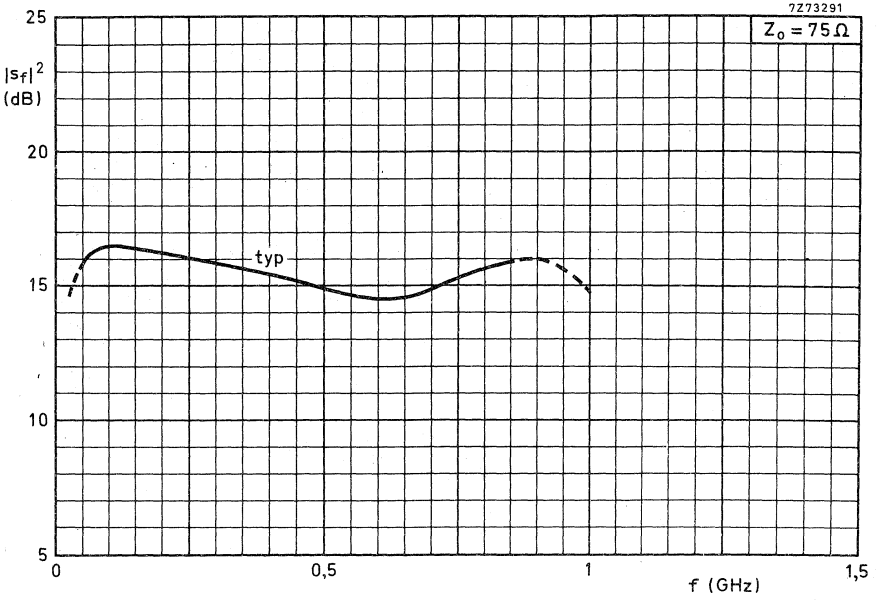
Dip or wave soldering

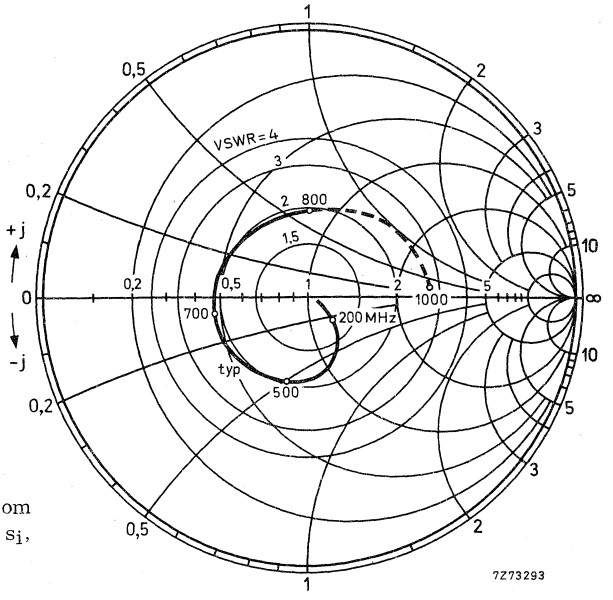
260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.
The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

Mounting recommendations

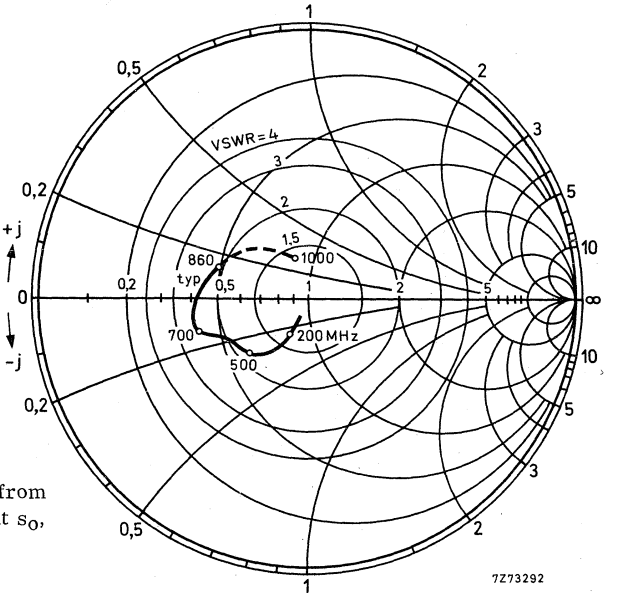
The module should preferably be mounted on double-sided printed-circuit board, see the example shown below.
Input and output should be connected to 75 Ω tracks.
The connections to the "common" pins should be as close to the seating plane as possible.







Input impedance derived from input reflection coefficient s_i, co-ordinates in ohm x 75.



Output impedance derived from output reflection coefficient s_o, co-ordinates in ohm x 75.

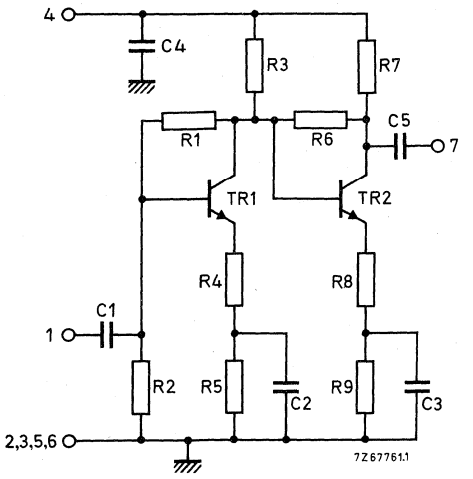
HYBRID VHF/UHF WIDE BAND AMPLIFIER

Two-stage wide-band amplifier in the hybrid technique, designed for use in mast-head booster-amplifiers, as pre-amplifier in MATV systems, and as general-purpose amplifier for v.h.f. and u.h.f. applications.

QUICK REFERENCE DATA				
Frequency range	f		40 to 860	MHz
Source and load (characteristic) impedance	$R_S = R_\ell = Z_o$	=	75	Ω
Transducer gain	$G_{tr} = \lvert s_f \rvert^2$	typ.	15,5	dB
Flatness of frequency response	$\pm\Delta \lvert s_f \rvert^2$	typ.	1	dB
Output voltage at −60 dB intermodulation distortion (DIN45004, 3-tone)	$V_{o(rms)}$	>	98	dBμV
Noise figure	F	typ.	6	dB
D.C. supply voltage	V_B	=	24	V ±10%
Operating ambient temperature	T_{amb}		−20 to +70	°C

ENCAPSULATION 7-pin, in-line, resin-coated body, see MECHANICAL DATA

CIRCUIT DIAGRAM



RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Operating ambient temperature	T_{amb}		−20 to +70	°C
Storage temperature	T_{stg}		−40 to +125	°C
D.C. supply voltage	V_B	max.	28	V
Peak voltages on pins 1 and 7	V_{1M}, V_{7M}	max.	28	V
	$-V_{1M}$, $-V_{7M}$	max.	10	V
Peak incident powers on pins 1 and 7	P_{I1M}, P_{I7M}	max.	100	mW

CHARACTERISTICS

Measuring conditions

V.H.F.-U.H.F. test socket	catalogue no. 3504 110 01840 *			
Ambient temperature	T_{amb}	=	25	°C
D.C. supply voltage	V_B	=	24	V
Source impedance and load impedance	R_s, R_ℓ	=	75	Ω
Characteristic impedance of h.f. connections	Z_o	=	75	Ω
Frequency range	f	=	40 to 860	MHz

Performance

Supply current	I_B	typ.	33	mA
Transducer gain	$G_{tr} = \lvert s_f \rvert^2$		13 to 18	dB
		typ.	15,5	dB
Flatness of frequency response	$\pm\Delta \lvert s_f \rvert^2$	typ.	1	dB
Individual maximum v.s.w.r.				
input	$VSWR_{(i)}$	typ.	2,5	**
output	$VSWR_{(o)}$	typ.	2,0	**
Back attention				
f = 100 MHz	$\lvert s_r \rvert^2$	typ.	30	dB
f = 860 MHz	$\lvert s_r \rvert^2$	typ.	26	dB
Output voltage				
at −60 dB intermodulation distortion	$V_{o(rms)}$	>	98	dBμV
(DIN45004, par. 6.3: 3-tone)		typ.	100	dBμV
Noise figure	F	typ.	6	dB

s-parameters:	$s_f = s_{21}$	$s_i = s_{11}$
	$s_r = s_{12}$	$s_o = s_{22}$

* This socket can be made available for customer reference purposes.
** Highest value, for a sample, occurring in the frequency range.

OPERATING CONDITIONS

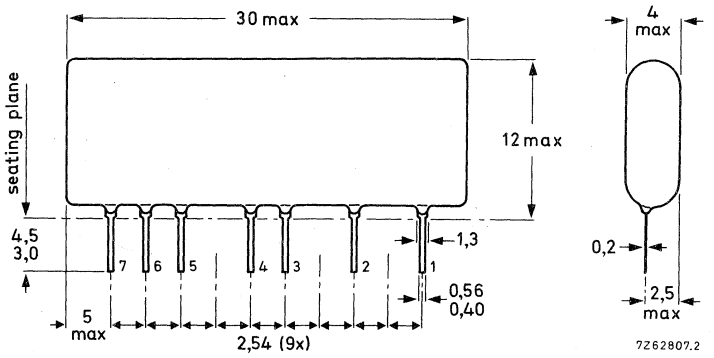
Ambient temperature range	T_{amb}		−20 to + 70	°C
D.C. supply voltage	V_B	=	24	V ±10%
Frequency range	f		40 to 860	MHz
Source impedance and load impedance	R_s, R_ℓ	=	75	Ω

MECHANICAL DATA

Dimensions in mm

Encapsulation

The device is resin coated.



Terminal connections

1	= Input
2, 3, 5, 6	= Common
4	= Supply (+)
7	= Output

Soldering recommendations

Hand soldering

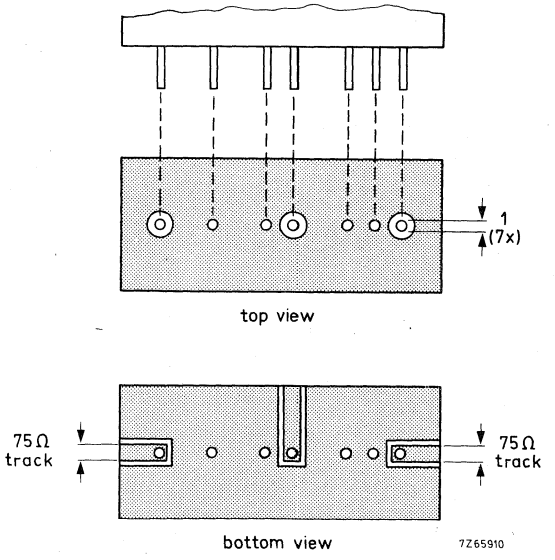
Maximum contact time for a soldering-iron temperature of 260 °C; up to seating plane: 5 s

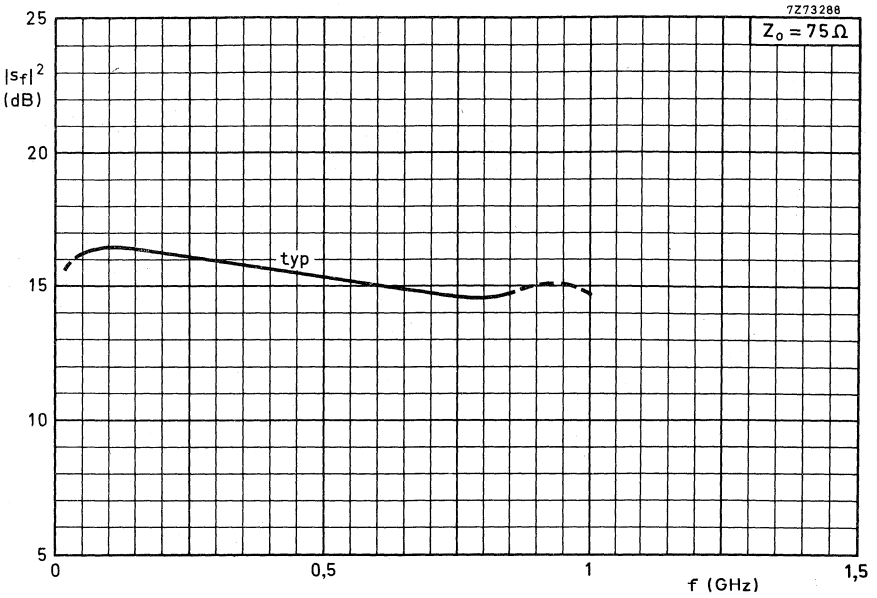
Dip or wave soldering

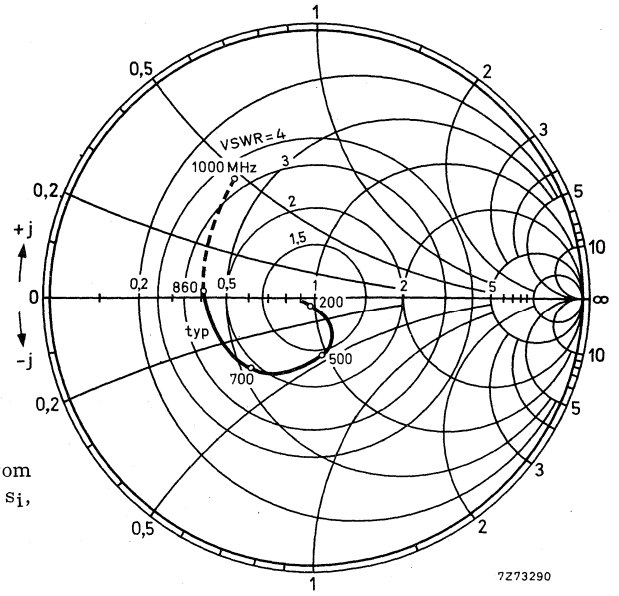
260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.
The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

Mounting recommendations

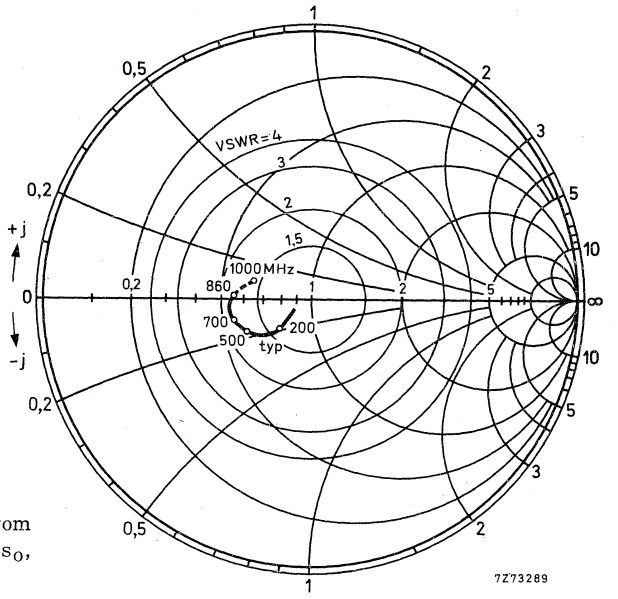
The module should preferably be mounted on double-sided printed-circuit board, see the example shown below.
Input and output should be connected to 75 Ω tracks.
The connections to the "common" pins should be as close to the seating plane as possible.







Input impedance derived from input reflection coefficient s_i, co-ordinates in ohm x 75.



Output impedance derived from output reflection coefficient s_O, co-ordinates in ohm x 75.

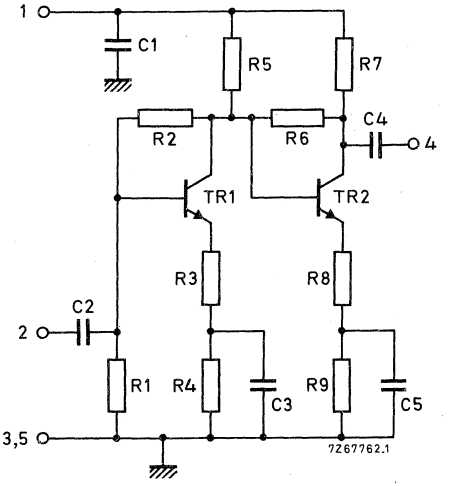
HYBRID VHF/UHF WIDE-BAND AMPLIFIER

Two-stage wide-band amplifier in the hybrid technique, designed for use as distribution amplifier in MATV and CATV systems and as general-purpose amplifier for v.h.f. and u.h.f. applications. Except for the encapsulation coating, the OM322 and OM175 have the same specification. OM322 will replace OM175.

QUICK REFERENCE DATA				
Frequency range	f		40 to 860	MHz
Source and load (characteristic) impedance	$R_S = R_\ell = Z_o$		75	Ω
Transducer gain	$G_{tr} = \lvert s_f \rvert^2$	typ.	15	dB
Flatness of frequency response	$\pm\Delta \lvert s_f \rvert^2$	typ.	0,3	dB
Output voltage at −60 dB intermodulation distortion (DIN45004, 3-tone)	$V_{o(rms)}$	>	103	dBμV
Noise figure	F	typ.	7	dB
D.C. supply voltage	V_B	=	24	V ±10%
Operating ambient temperature	T_{amb}	−20 to +70		°C

ENCAPSULATION 5-lead, resin coated body on metal base, see MECHANICAL DATA

CIRCUIT DIAGRAM



RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Operating ambient temperature	T_{amb}	−20 to	+70	°C
Operating mounting-base temperature	T_{mb}	max.	100	°C
Storage temperature	T_{stg}	−40 to	+125	°C
D.C. supply voltage	V_B	max.	28	V
Peak voltages on pins 2 and 4	V_{2M}, V_{4M}	max.	28	V
	$-V_{2M}$, $-V_{4M}$	max.	10	V
Peak incident powers on pins 2 and 4	P_{I2M}, P_{I4M}	max.	100	mW

CHARACTERISTICS

Measuring conditions

Ambient temperature	T_{amb}	=	25	°C
D.C. supply voltage	V_B	=	24	V
Source impedance and load impedance	R_s, R_ℓ	=	75	Ω
Characteristic impedance of h.f. connections	Z_o	=	75	Ω
Frequency range	f	= 40 to	860	MHz

Performance

Supply current	I_B	typ.	60	mA
Transducer gain	$G_{tr} = \lvert s_f \rvert^2$	14 to	16	dB
		typ.	15	dB
Flatness of frequency response	$\pm\Delta \lvert s_f \rvert^2$	typ.	0,3	dB
		<	0,5	dB
Individual maximum v.s.w.r.				
input	$VSWR_{(i)}$	typ.	1,7	[1]
output	$VSWR_{(o)}$	typ.	1,7	[1]
Back attenuation				
f = 100 MHz	$\lvert s_r \rvert^2$	typ.	31	dB
f = 860 MHz	$\lvert s_r \rvert^2$	typ.	25	dB
Output voltage at −60 dB intermodulation distortion (DIN45004, par. 6.3: 3-tone)	$V_{o(rms)}$	>	103	dBμV
		typ.	105	dBμV
Noise figure	F	typ.	7	dB

s-parameters:		
	$s_f = s_{21}$	$s_i = s_{11}$
	$s_r = s_{12}$	$s_o = s_{22}$

[1]) Highest value, for a sample, occurring in the frequency range.

OPERATING CONDITIONS

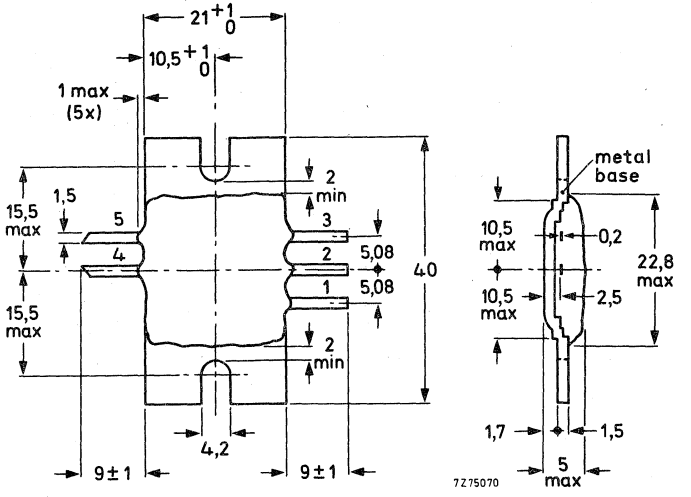
Ambient temperature range	T_{amb}		−20 to +70	°C
D.C. supply voltage	V_B	=	24	V ±10%
Frequency range	f		40 to 860	MHz
Source impedance and load impedance	R_S, R_ℓ	=	75	Ω

MECHANICAL DATA

Dimensions in mm

Encapsulation

The device is resin coated and mounted on a metal mounting base.



Terminal connections

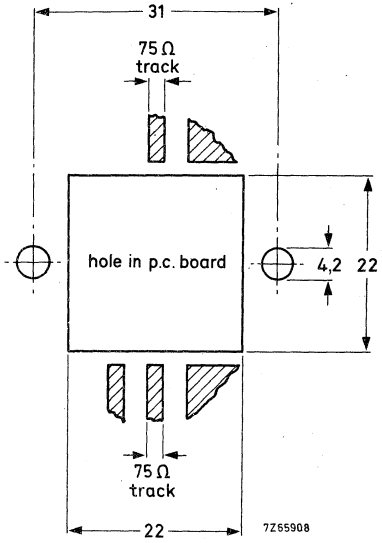
1	= Supply (+)
2	= Input
3 and 5	= Common (internally connected to metal base)
4	= Output

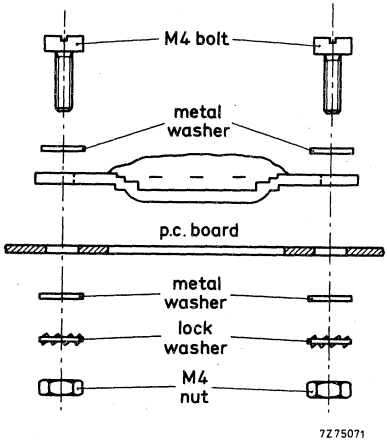
Soldering recommendations

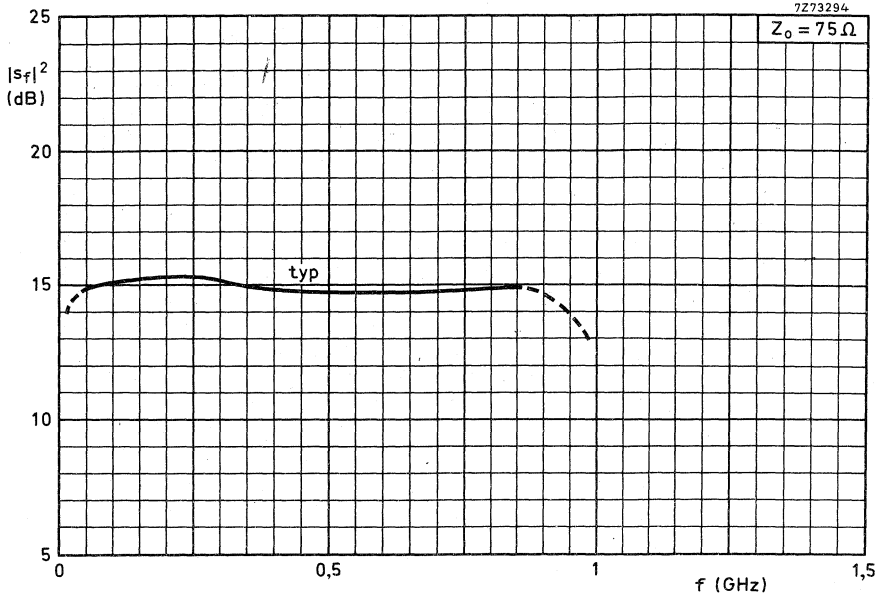
Maximum contact time for a soldering-iron temperature of 260 °C 5 s

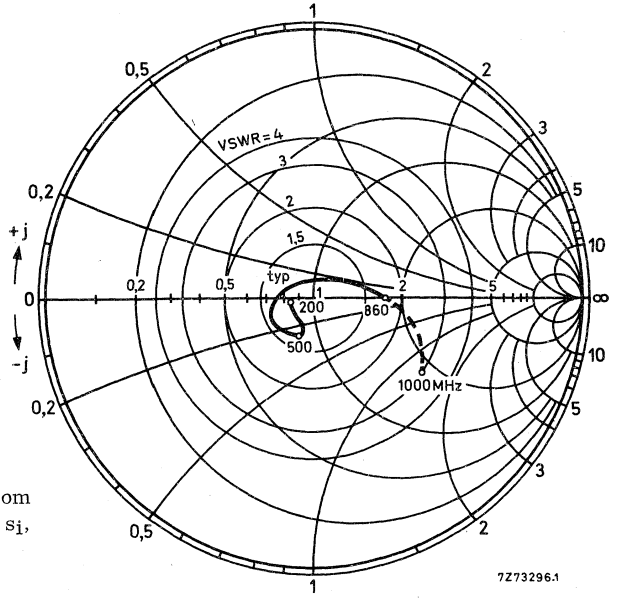
Mounting recommendations

The module should preferably be mounted on a double-sided printed-circuit board, see the examples shown below. Input and output should be connected to 75 Ω tracks.

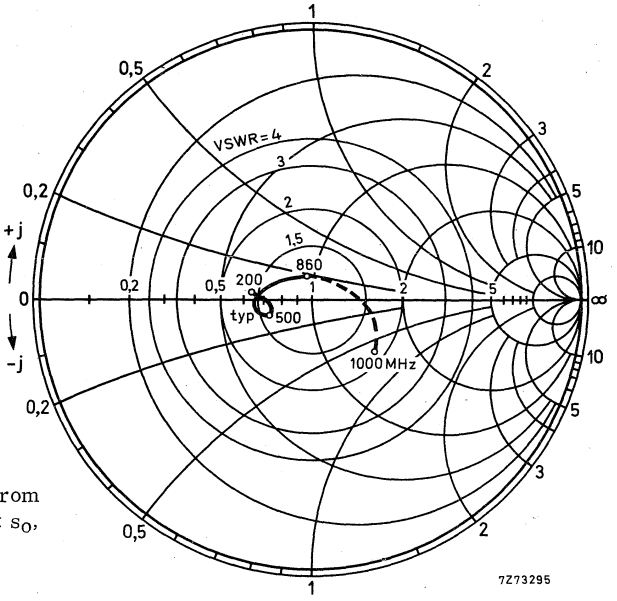








Input impedance derived from input reflection coefficient s_i, co-ordinates in ohm x 75



Output impedance derived from output reflection coefficient s_o, co-ordinates in ohm x 75

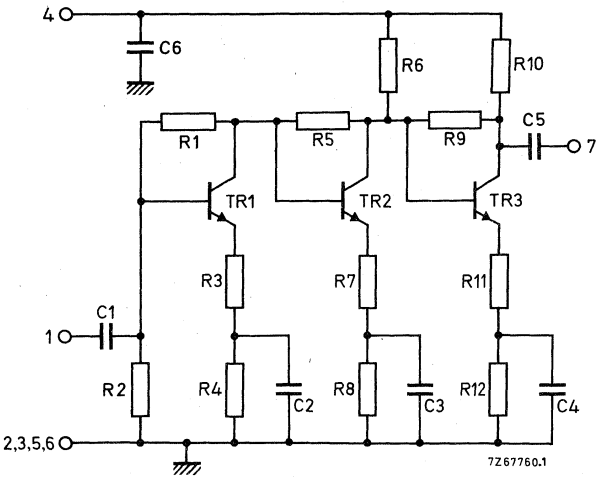
HYBRID VHF/UHF WIDE-BAND AMPLIFIER

Three-stage wide-band amplifier in the hybrid technique, designed for use in mast-head booster-amplifiers, as pre-amplifier in MATV systems, and as general-purpose amplifier for v.h.f. and u.h.f. applications.

QUICK REFERENCE DATA				
Frequency range	f		40 to 860	MHz
Source and load (characteristic) impedance	$R_S = R_\ell = Z_o$	=	75	Ω
Transducer gain	$G_{tr} = \|s_f\|^2$	typ.	27	dB
Flatness of frequency response	$\pm\Delta \|s_f\|^2$	typ.	1,6	dB
Output voltage at −60 dB intermodulation distortion (DIN45004, 3-tone)	$V_{o(rms)}$	>	98	dBμV
Noise figure	F	typ.	5,5	dB
D.C. supply voltage	V_B	=	24	V ±10%
Operating ambient temperature	T_{amb}		−20 to +70	°C

ENCAPSULATION 7-pin, in-line, resin-coated body, see MECHANICAL DATA

CIRCUIT DIAGRAM



RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Operating ambient temperature	T_{amb}	−20 to +70		°C
Storage temperature	T_{stg}	−40 to +125		°C
D.C. supply voltage	V_B	max.	28	V
Peak voltages on pins 1 and 7	V_{1M}, V_{7M}	max.	28	V
	$-V_{1M}$, $-V_{7M}$	max.	10	V
Peak incident powers on pins 1 and 7	P_{I1M}, P_{I7M}	max.	100	mW

CHARACTERISTICS

Measuring conditions

→ V.H.F.-U.H.F. test socket	catalogue no. 3504 110 01840 *			
Ambient temperature	T_{amb}	=	25	°C
D.C. supply voltage	V_B	=	24	V
Source impedance and load impedance	R_s, R_ℓ	=	75	Ω
Characteristic impedance of h.f. connections	Z_o	=	75	Ω
Frequency range	f	=	40 to 860	MHz

Performance

Supply current	I_B	typ.	35	mA
Transducer gain	$G_{tr} = \lvert s_f \rvert^2$		23 to 31	dB
		typ.	27	dB
Flatness of frequency response	$\pm\Delta \lvert s_f \rvert^2$	typ.	1,6	dB
Individual maximum v.s.w.r.				
input	$VSWR_{(i)}$	typ.	1,9	**
output	$VSWR_{(o)}$	typ.	3,2	**
Back attenuation				
f = 100 MHz	$\lvert s_r \rvert^2$	typ.	46	dB
f = 860 MHz	$\lvert s_r \rvert^2$	typ.	40	dB
Output voltage at −60 dB intermodulation distortion (DIN45004, par. 6.3: 3-tone)	$V_{o(rms)}$	>	98	dBμV
		typ.	101	dBμV
Noise figure	F	typ.	5,5	dB

s-parameters:	$s_f = s_{21}$	$s_i = s_{11}$
	$s_r = s_{12}$	$s_o = s_{22}$

* This socket can be made available for customer reference purposes.
** Highest value, for a sample, occurring in the frequency range.

OPERATING CONDITIONS

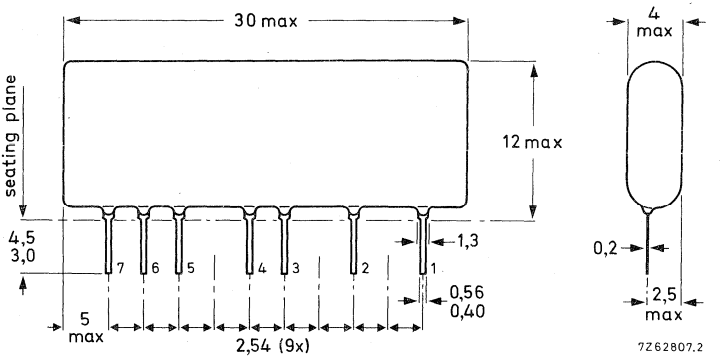
Ambient temperature range	T_{amb}		−20 to + 70	°C
D. C. supply voltage	V_B	=	24	V ±10%
Frequency range	f		40 to 860	MHz
Source impedance and load impedance	R_s, R_ℓ	=	75	Ω

MECHANICAL DATA

Dimensions in mm

Encapsulation

The device is resin coated.



Terminal connections

1	= Input
2, 3, 5, 6	= Common
4	= Supply (+)
7	= Output

Soldering recommendations

Hand soldering

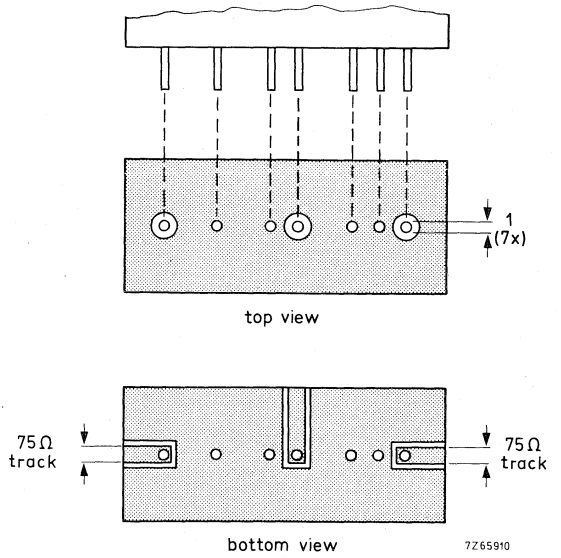
Maximum contact time for a soldering-iron temperature of 260 °C; up to seating plane: 5 s

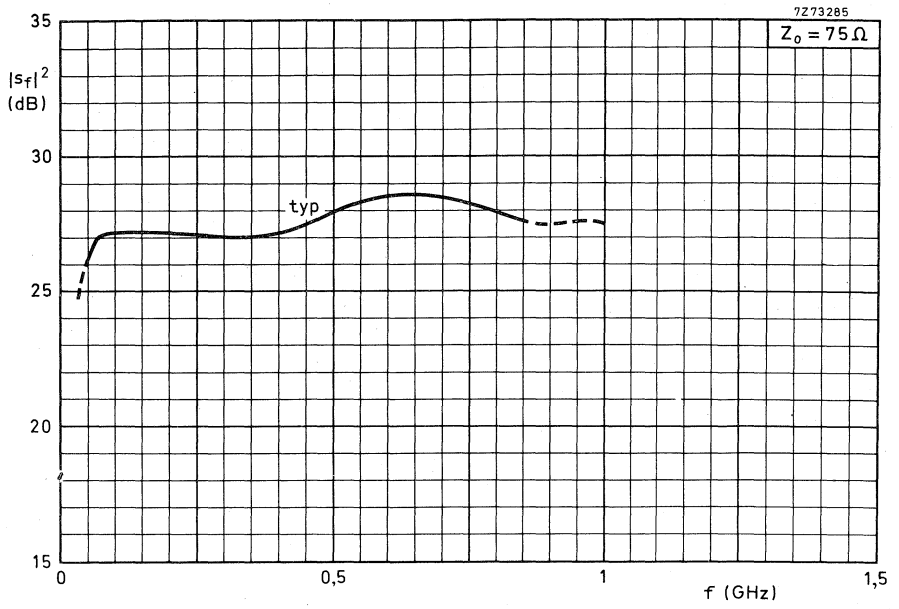
Dip or wave soldering

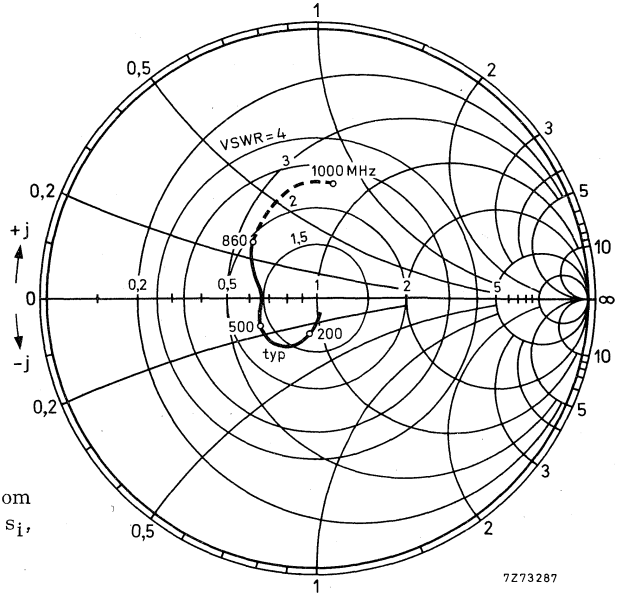
260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.
The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

Mounting recommendations

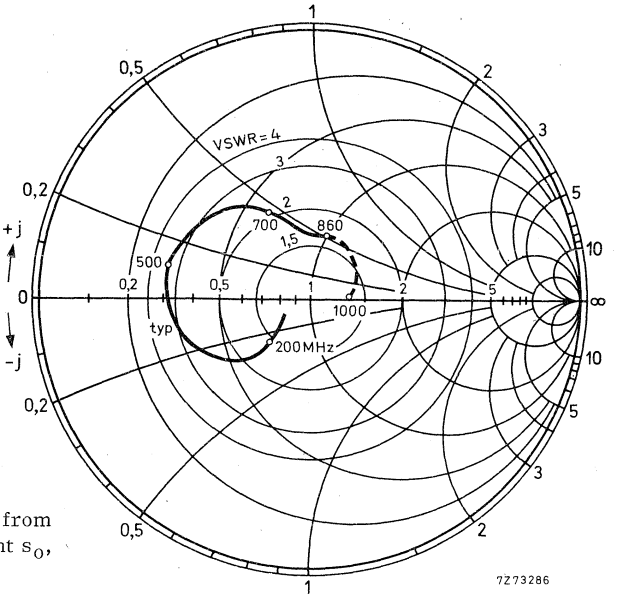
The module should preferably be mounted on double-sided printed-circuit board, see the example shown below.
Input and output should be connected to 75 Ω tracks.
The connections to the "common" pins should be as close to the seating plane as possible.







Input impedance derived from input reflection coefficient s_i, co-ordinates in ohm x 75.



Output impedance derived from output reflection coefficient s_o, co-ordinates in ohm x 75.

HYBRID V.H.F./U.H.F. WIDE-BAND AMPLIFIER

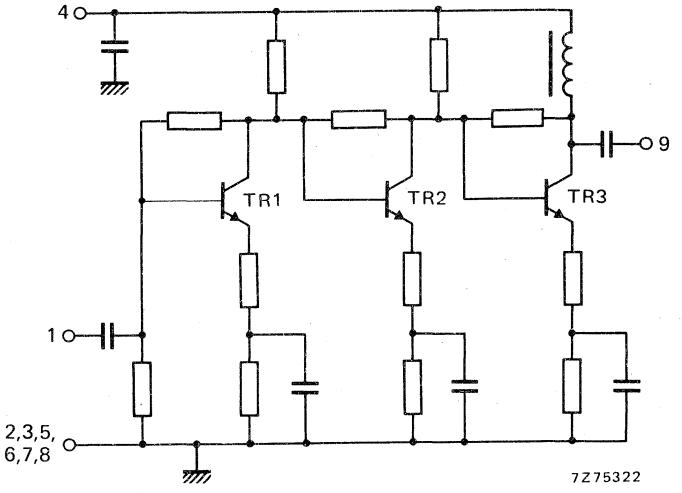
Three-stage wide-band amplifier in the hybrid technique, designed for use in MATV systems, and as general purpose amplifier for v.h.f. and u.h.f. applications requiring a high output level.

QUICK REFERENCE DATA

Frequency range	f	40 to 860	MHz
Source and load (characteristic) impedance	$R_s = R_\ell = Z_o$	= 75	Ω
Transducer gain	$G_{tr} = \lvert s_f \rvert^2$	typ 26	dB
Flatness of frequency response	$\pm\Delta \lvert s_f \rvert^2$	typ 1	dB
Output voltage at −60 dB intermodulation distortion (DIN45004, 3-tone); f = 470 MHz	$V_{o(rms)}$	typ 112	dBμV
Noise figure	F	typ 9,8	dB
D.C. supply voltage	V_B	= 24	V ± 10%
Operating mounting-base temperature	T_{mb}	−30 to +100	°C

ENCAPSULATION 9-pin, in-line, resin-coated body on a right-angled metal mounting tab, see MECHANICAL DATA

CIRCUIT DIAGRAM



RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Operating mounting-base temperature	T_{mb}	−30 to +100	°C
Storage temperature	T_{stg}	−40 to +125	°C
D.C. supply voltage	V_B	max 28	V
Peak voltages on pin 1	V_{1M}	max 28	V
	$-V_{1M}$	max 24	V
Peak voltages on pin 9	V_{9M}	max 28	V
	$-V_{9M}$	max 4	V
Peak incident powers on pins 1 and 9	P_{I1M}, P_{I9M}	max 100	mW

CHARACTERISTICS

Measuring conditions

V.H.F.—U.H.F. test socket	catalogue no. 3504 110 01830*		
Mounting base temperature	T_{mb}	= 25	°C
D.C. supply voltage	V_B	= 24	V
Source impedance and load impedance	R_s, R_ℓ	= 75	Ω
Characteristic impedance of h.f. connections	Z_o	= 75	Ω
Frequency range	f	= 40 to 860	MHz

Performance

Supply current	I_B		110 to 120	mA
		typ.	115	mA
Transducer gain	$G_{tr} = \lvert s_f \rvert^2$		23 to 29	dB
		typ	26	dB
Flatness of frequency response	$\pm\Delta \lvert s_f \rvert^2$	typ	1	dB
Individual maximum v.s.w.r.				
input	$VSWR_{(i)}$	typ	2,3	**
output	$VSWR_{(o)}$	typ	1,8	**
Back attenuation				
f = 100 MHz	$\lvert s_r \rvert^2$	typ	44	dB
f = 650 MHz	$\lvert s_r \rvert^2$	typ	41	dB
f = 860 MHz	$\lvert s_r \rvert^2$	typ	43	dB

* This socket can be made available for customer reference purposes.

** Highest value, for a sample, occurring in the frequency range.

Output voltage at −60 dB intermodulation distortion (DIN45004, par. 6.3: 3-tone)				
f = 40–230 MHz	$V_{o(rms)}$	>	113	dBμV
		typ	114	dBμV
f = 470 MHz	$V_{o(rms)}$	typ	112	dBμV
f = 860 MHz	$V_{o(rms)}$	typ	110	dBμV
Noise figure				
channel 2	F	typ	7	dB
channel 65	F	typ	9,8	dB

s-parameters:	$s_f = s_{21}$	$s_i = s_{11}$
	$s_r = s_{12}$	$s_o = s_{22}$

OPERATING CONDITIONS

Mounting-base temperature range	T_{mb}	−30 to +100		°C
D.C. supply voltage	V_B	=	24	V ± 10%
Frequency range	f	40 to 860		MHz
Source impedance and load impedance	R_s, R_ℓ	=	75	Ω

THERMAL DATA

a. The maximum permissible temperature at the mounting base is 100 °C.

b. When the mounting tab is screwed to a double-sided printed-circuit board with dimensions 37 mm x 51 mm, its temperature will be 57 °C above the temperature of the surrounding free air.

c. When a heatsink is fixed to the mounting tab and the pins are soldered into a double-sided printed-circuit board with dimensions 37 mm x 51 mm, the tab will reach the temperatures stated in the following table.

Notes:

1. When the device is fixed only to a heatsink, not to a printed-circuit board, the values of the second column of the table should be increased by 2 °C and those of the third column decreased by 2 °C.
2. The user is free to realize proper cooling by using differently shaped sinks, or, preferably, by fixing the tab to any convenient part of the equipment (e.g. a wall of the metal cabinet).

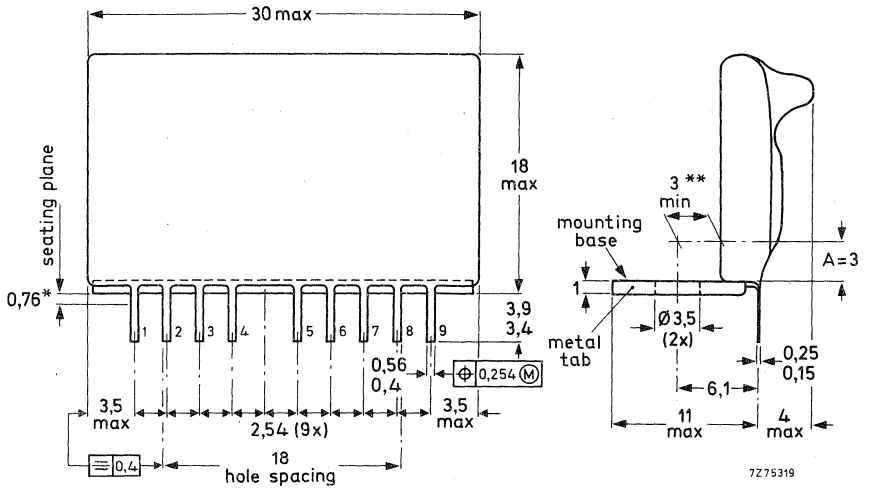
heatsink data thickness 1 mm	$T_{mb} - T_{amb}$ °C	$T_{amb\,max}$ °C
Bright aluminium heatsink L-shaped bar; length 100 mm, height 65 mm	27,5	72,5
Blackened aluminium heatsink L-shaped bar; length 50 mm, height 70 mm	26,5	73,5

MECHANICAL DATA

Dimensions in mm

Encapsulation

The amplifier is resin coated and has a metal mounting tab at a right angle to the encapsulated part.



Terminal connections

1	= Input
2, 3, 5, 6, 7, 8	= Common, connected to mounting tab
4	= Supply (+)
9	= Output

Soldering recommendations

Hand soldering

Maximum contact time for a soldering-iron temperature of 260 °C up to the seating plane is 5 s.

Dip or wave soldering

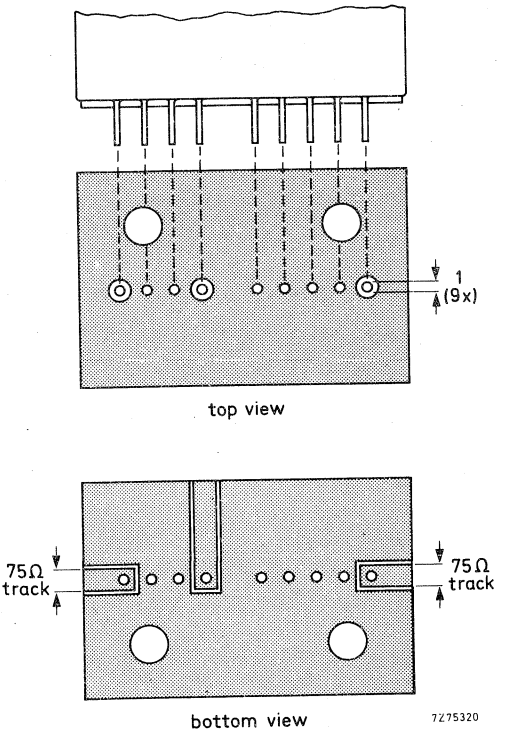
260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds. The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

* Tolerance applies within this zone.

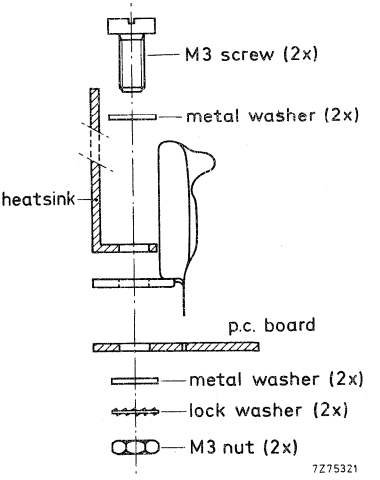
** Distance applies within zone A.

Mounting recommendations

The module should preferably be mounted on a double-sided printed-circuit board, see the following example. An example is also given of heatsink mounting.
Input and output should be connected to 75 Ω tracks.
The connections to the common pins should be as close to the seating plane as possible.



Printed-circuit board holes and tracks.



Example of heatsink mounting

Peripheral devices

MOSAIC PRINTERS

INTRODUCTION

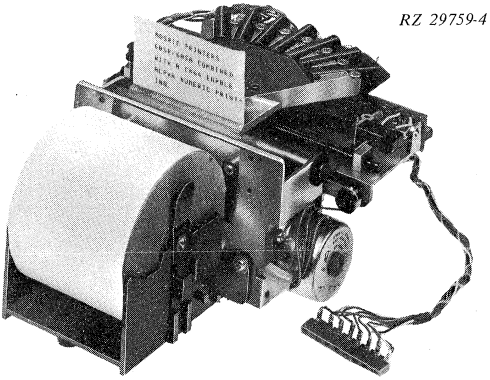
The Mosaic Printers, types 60SR and 60SA, can print all characters that can be formed within a 5x7 dot matrix. The printing speed is 50 characters per second. One line of maximum 20 characters is printed in one second. Both types print on a standard paper roll of 60 mm width.
The 60SR, equipped with an inked-ribbon system, prints on ordinary paper, the 60SA is designed for printing on 3M's self-action paper.
The printers are controlled by a module, containing the circuits for character generation and printer head drive.
The character modules available are:

CM20 for printing the numerals 0 to 9, and 10 symbols (see relevant data sheet)
CM64 for complete alpha-numeric printing with a total capacity of 64 different characters

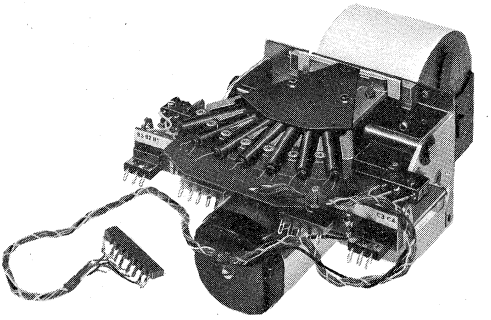
Each character is basically formed within a 5x7 dot matrix, with 5 columns of 7 dots each. The dots are printed by means of 7 needles, with blunt tips, one above the other. The needles are controlled by 7 solenoids and the 7 combinations needle--solenoid are mounted on a printer head. The needles strike the paper from the rear, the characters being read from the front.
The printer head moves from left to right during the printing operation in the normal reading sense. During the return of the printer head the paper is automatically transported upwards.

The Character Module selects and drives the relevant solenoids required to print the character selected at the address inputs. Address input selection and character printing is performed serially, the character being printed immediately after input selection is completed. The logic voltage levels for all input and output terminals are adapted to the commonly used DTL and TTL integrated circuit ranges.

RZ 29759-4

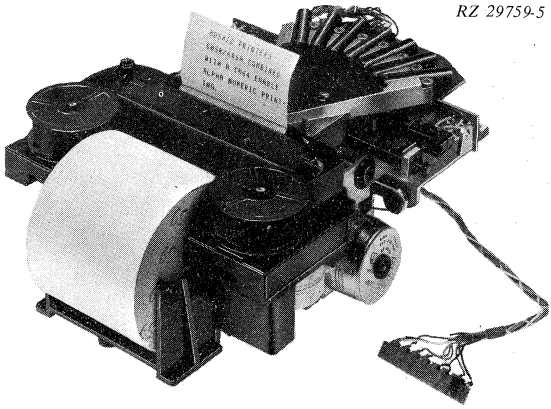


RZ 29759-2

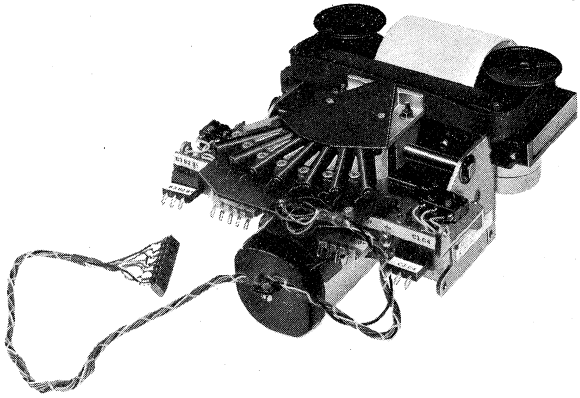


Mosaic printer, type 60SA (cat.no 4311 111 03370).

RZ 29759-5



RZ 29759-3



Mosaic printer, type 60SR (cat.no 4311 111 03380), equipped with inked-ribbon system.

DESCRIPTION OF THE MOSAIC PRINTERS

Main parts (see Fig. 1).

The printer consists of a metal frame which supports the following elements:

1. The cross-slide that carries the printer head on which the 7 solenoids and corresponding needles are mounted in a horizontal plane. When energized the solenoids drive the needles in the direction of the paper roll against the pressure of a spring.
   Although the solenoids are positioned in a horizontal plane, the needles are so guided that their tips are vertically positioned at the printing end.
   For easy replacement the printer head is fixed to the cross-slide by two screws.

2. The anvil on which the needles strike.
   With printer type 60SA, the paper is positioned between needles and anvil.
   With printer type 60SR, one finds the needles, next the paper, then the ribbon and finally the anvil. So, by pushing the paper against the ribbon, each needle tip causes a black dot appear on the paper.

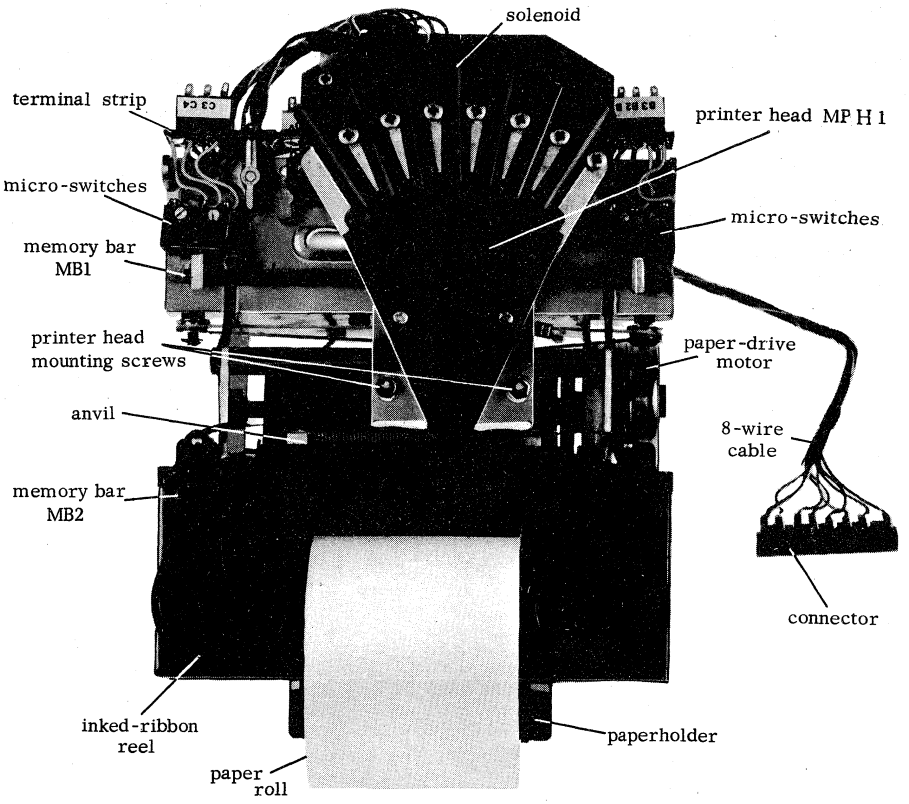
3. Two motors in the case of printer type 60SA.
   Four motors in the case of printer type 60SR.

   The synchronous motors and their drive mechanisms have the following functions:
   - driving the cross-slide, one motor
   - driving the paper roll, one motor
   - driving the inked-ribbon, two motors (for 60SR only)

4. Six micro-switches and one memory bar (see Fig. 2) for the following functions:

   - Switch A : For stopping the paper-drive motor. It is connected in series with switch E and operated at the end of the line by the memory bar (MB1)
   - Switch B : Free. It may be used for indication purposes or for switching off the start signal for the Character Module at the end of the line.
   - Switch C : Commutates the direction of rotation of the printer-head motor; is operated by the memory bar.
   - Switch D : Takes over function of external pushbutton "Start printer". Operates as soon as printer head leaves its rest (extreme left) position.
   - Switch E : Starts the paper-drive motor.
     Connected in series with switch A.
   - Switch F : Supplies signal "start printing" when the printer head motor attains its constant speed.

RZ 29759-6R


solenoid
terminal strip
printer head MP H 1
micro-switches
micro-switches
memory bar
MB1
printer head
mounting screws
paper-drive
motor
anvil
8-wire
cable
memory bar
MB2
connector
inked-ribbon
reel
paperholder
paper
roll

5. For type 60SR only:
   Inked-ribbon transport mechanism.
   By means of screws this mechanism is connected at the front to the metal frame. It carries microswitch G and memory bar MB2 controlling the direction of rotation of the two inked-ribbon drive motors RM.

Operation (see Figs 2 and 3)

The printer head is assumed to be in the rest position (extreme left). When the terminals C_3 and C_4 are interconnected (in Fig. 6 "Start printer"), the printer-head motor HM is energized via switch C3-1 and starts moving from left to right (print direction). As soon as it leaves the rest position, switch D takes over the function of the external push-button. After 80 to 100 ms the motor HM attains its constant speed; switch F is then released and gives the signal "Start printing" to the electronic control circuitry. The printing operation can now start. During the movement of the printer head the switch E is operated. The contact E1-3 is opened, to prevent the paper-drive motor from starting as soon as switch A2-3 is closed (at the end of the line). At the end of the line the memory bar actuates commutating switch A so that contacts A1-3 are closed. At the same time switch C is operated and via its contacts C3-2 the motor HM is reversely energized. The printer head is then returned to its rest position. During this return movement switch E is released and via contacts E1-3 and A1-3 the paper-drive motor PM is started. After some time switch F will be operated similarly, interrupting the signal "Start printing".
When the printing head has reached its rest position (extreme left), first switch D is operated, causing the motor HM to stop. Also, memory bar MB1 is operated, commutating the switches A, B and C. Because switch A is switched over to contacts A2-3 the paper-drive motor stops. This ends the operation cycle.

In the 60SR, the ink ribbon is driven by motors RM. When the ribbon spool is empty, the memory bar MB2 is shifted as a result of the tension of the ink ribbon. This operates switch G so reversing the rotation of motors RM and the ink ribbon is then re-wound on the empty spool.

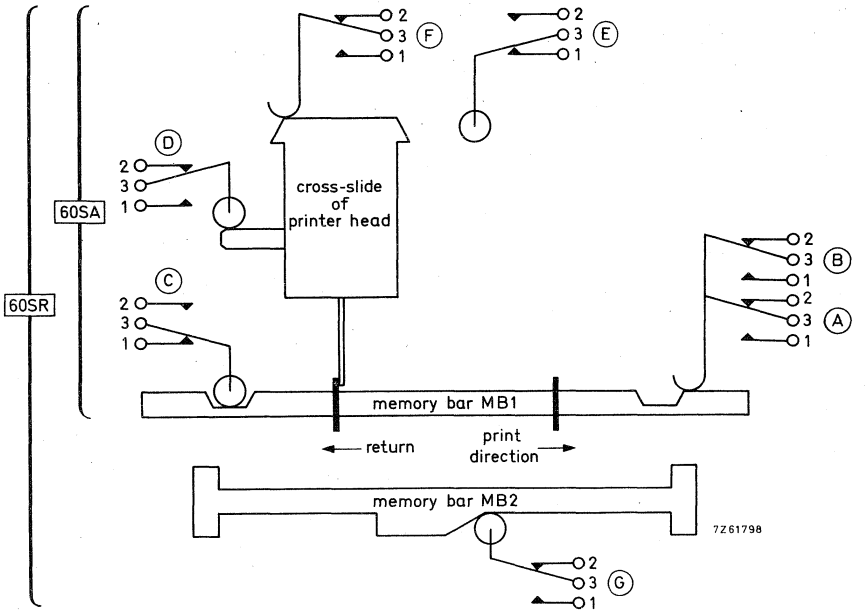


Fig. 2. Operation diagram

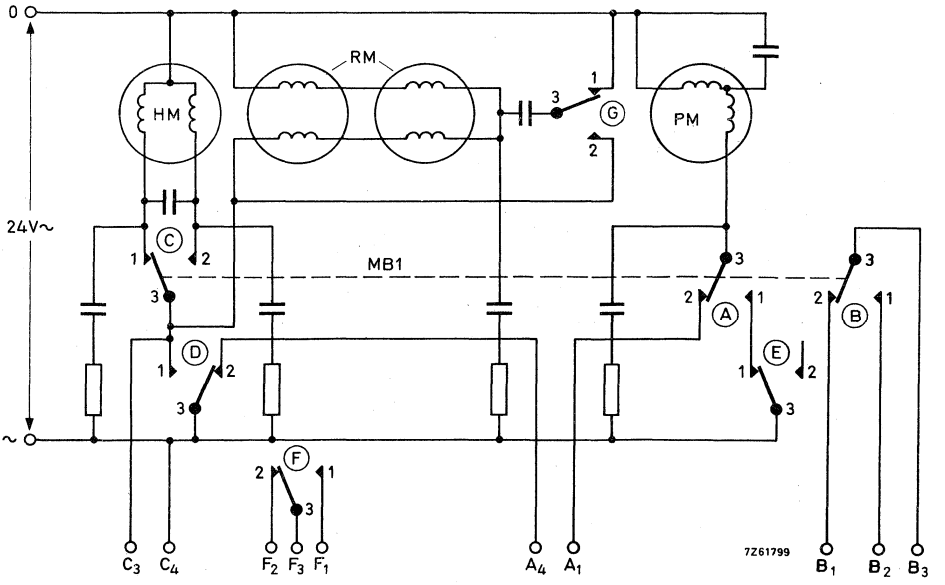
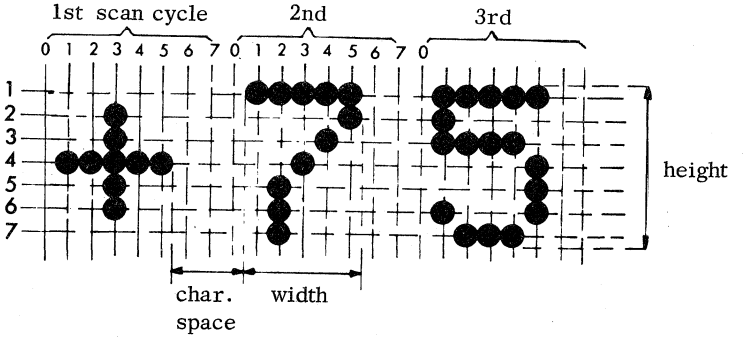


Fig. 3. Circuit diagram

TECHNICAL DATA

Character width	max.	1,5 mm
height		$2.5\ ^{+0.15}_{-0.05}$ mm
Needle diameter		0,35 mm
Character spacing		min. 3 columns, min. 0,7 mm



Printing speed	50 characters per second
Column capacity	adjustable between approx 18 and 20
Line spacing	approx. 5 mm
Line speed	60 lines of max. 20 characters per min.
Paper transport speed	25 mm/s
Data entry	serial entry
Interconnection time C_3-C_4 to start printer	min. 30 ms
Temperature range	
operating	0 to +55 °C
storage	−25 to +55 °C
Power supply	
- Printer head, voltage / current	see Data sheets of Character Modules
- Motors,	
voltage	24 V ± 10%, 50 Hz
current of	
printer head motor	200 mA
paper transport motor	60 mA
inked-ribbon transport motors (type 60SR only)	90 mA per motor
Overall dimensions,	
width	148 mm (5.83 in)
depth	210 mm (8.26 in)
height	76 mm (2.99 in)
Weight, type 60SR	2 kg approximately
type 60SA	1.5 kg approximately

Mounting

Both printers are provided with 7 mounting holes, positioned as shown in Fig. 5.

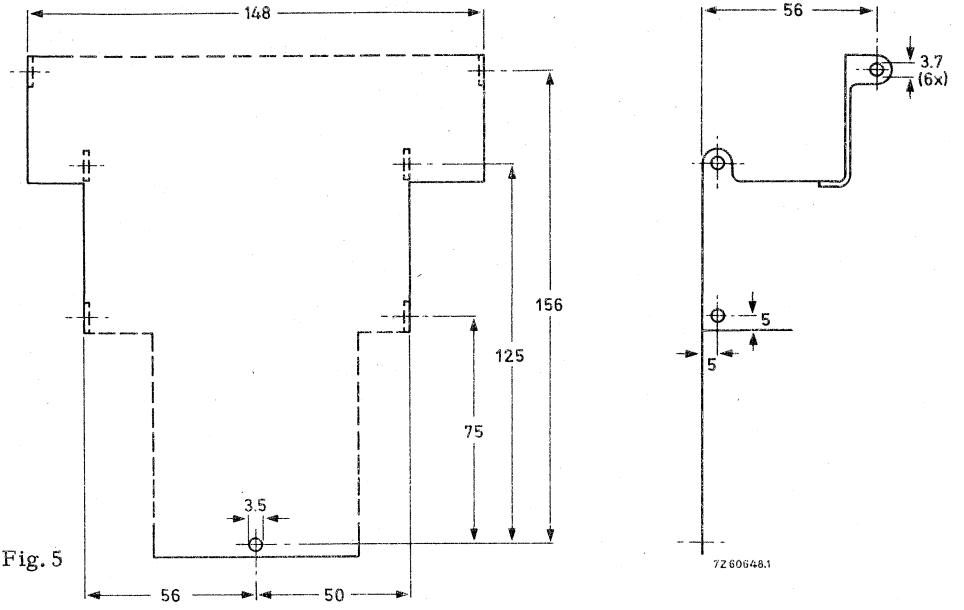


Fig. 5

The 6 holes of 3.7 mm should be used for fixation with self-tapping screws of 4 mm

Electrical connections

The printer head is equipped with a 9-wires flexible cable of which 8-wires are to be connected to the character module and 1 wire to the earth point on the rear panel of the printer. The 8-wire connection is pluggable at the character module.
To the rear of the frame-work a small p.w. board is mounted. The pluggable connections are shown below (see also Fig. 3).

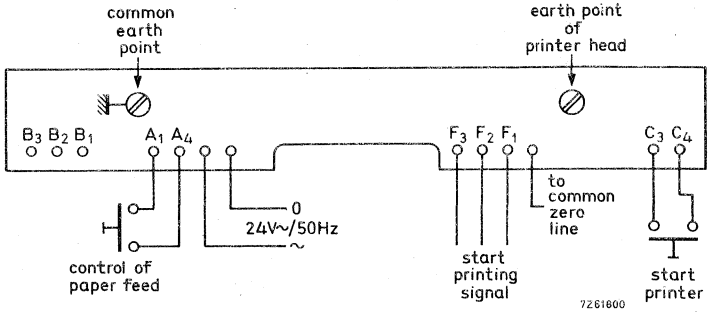


Fig. 6

ACCESSORIES

Printpapers

Normal paper (catalogue number 2811 063 10001)

-length	36 m approximately
-width	59 ± 1 mm
-external diameter	max. 73 mm
-internal diameter	max. 12 mm
-force factor	64 g/m^2
	e.g. Velin AFNOR VII-1 type
-thickness	approx. 0.1 mm

Selfprinting paper (catalogue number 2811 063 10051)

-length	36 m approximately
-width	59 ± 1 mm
-external diameter	73 mm max.
-internal diameter	12 mm
-force factor	45 g/m^2
-colour	white
	green-yellow
-name	3M's action paper

Inked-ribbon (catalogue number 2811 062 06001)

-reel	DIN 2103
-external diameter	40 mm
-axe diameter	11 mm
-length of the ribbon	min. 8, max. 10 m
-width of the ribbon	13 mm
-ribbon quality	silk, monocolour (black)

Character modules

-CM20, 20-character module, see relevant Data sheet
-CM64, 64-character module

64-CHARACTER MODULE FOR MOSAIC PRINTERS

QUICK REFERENCE DATA	
The CM64 consists of	a CC64, 64-character circuit a AC64, amplifier circuit
Characters *)	@ABCDEFGHIJKLMNOPQ RSTUVWXYZ[\]^_ !"£ $%&'()*+,-./012345 6789:;<=>?
Address input	6 bits

*) Also obtainable with other characters on request

APPLICATION

The CM64 is intended to operate in conjunction with the mosaic printers 60SR and 60SA.

DESCRIPTION

The module comprises the electronic circuitry for alpha-numeric selection and supplies the driving power for character printing.
The 64 characters, stored in a Read Only Memory (MOS-ROM) formed within a 5 x 7 dot matrix (5 vertical columns of 7 dots per column), are selected by means of a 6-bit address signal (in accordance with the USASCII-code, but the character # has been replaced by £).
With 7 needles placed in a vertical row the characters are printed by driving the appropriate needles of the 7- needle vertical colomn in the 5 colomn positions of the printer head. Spacing between two adjacent characters is equal to 3 column positions.
The CM64 consists of 2 glass-epoxy printed-wiring boards which fit into our miniature mounting chassis. One printed-wiring board, the 64 Character Circuit (CC64) comprises the start circuit, oscillator, column counter, input and output gates, and the 64 Character MOS-ROM of 2240 bits. On the other printed-wiring board, the Amplifier Circuit (AC64), are 7 amplifier circuits for driving the 7 needle solenoids of the printer head.
The character is printed immediately after the input selection is done and the start signal is given. Address input selection and character printing are performed serially. The logic voltage levels for all input and output terminals are adapted to commonly used 5-volt logic integrated circuit ranges (e.g. DTL and TTL).

DIMENSIONS (mm) AND TERMINAL LOCATION

Character circuit CC64 , see Fig. 1.

Terminals on printed-wiring connector

1 = Q_{osc}	oscillator output	21 = I_4	address input
3 = I_{st}	start input	22 = I_5	address input
7 = V_{P1}	+5 V supply	23 = I_6	address input
8 = V_{P1}	+5 V supply	24 = Q_{DN}	"demand new character" output
10 = Q_D	4th output column counter	25 = V_{P2}	+14 V supply
11 = Q_C	3rd output column counter	26 = V_N	−14 V supply
12 = Q_B	2nd output column counter	29 = O_1	character output
13 = Q_A	1st output column counter	30 = O_2	character output
15 = 0 V	common 0-line	31 = O_3	character output
16 = 0 V	common 0-line	32 = O_4	character output
17 = I_7	inhibit input	33 = O_5	character output
18 = I_1	address input	34 = O_6	character output
19 = I_2	address input	35 = O_7	character output
20 = I_3	address input		

Requirements for electrical connection

Terminals 7 and 8 of the printed-wiring connector must be interconnected.

Terminals 15 and 16 of the printed-wiring connector must be interconnected.

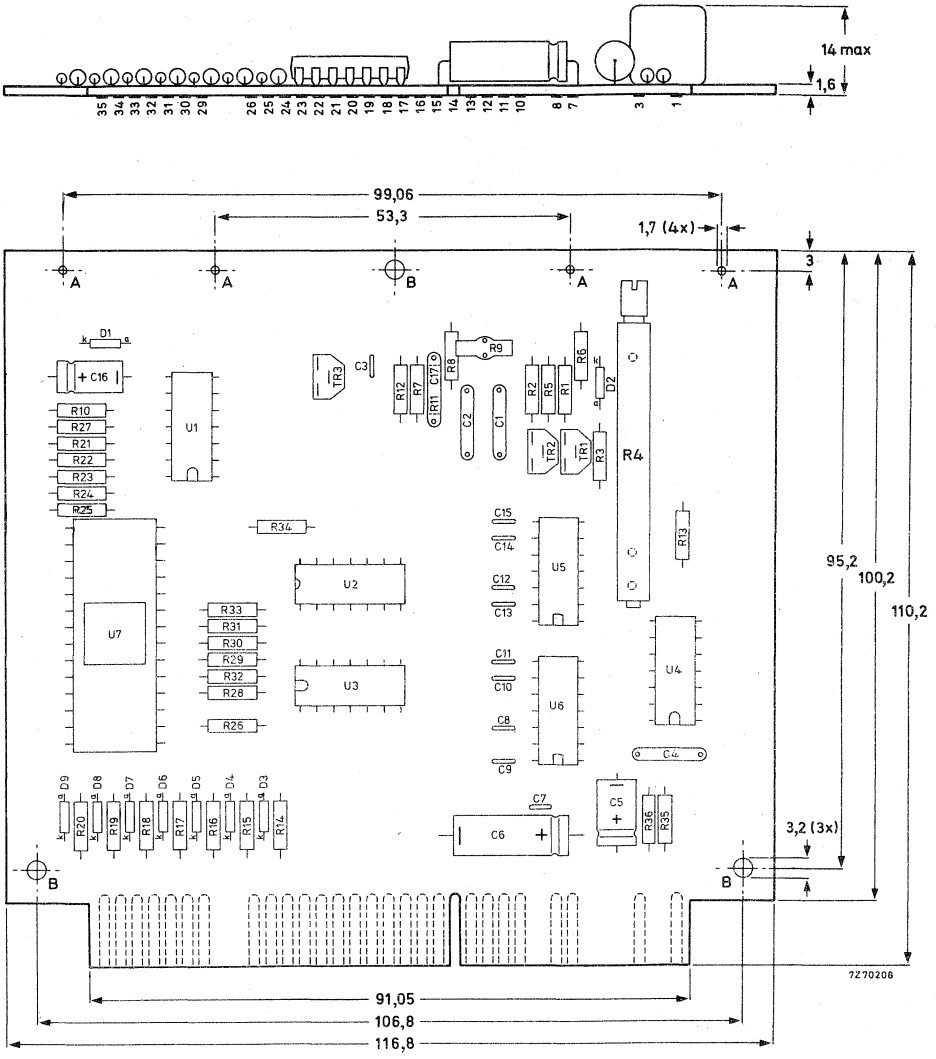


Fig. 1

Holes A are provided for mounting of an extractor.
Holes B are provided for screw-mounting the module.

Amplifier circuit CC64 see Fig. 2.

Terminals an printed-wiring connector

1 = supply printer head
3 = Q_7 , output solenoid 7
5 = Q_6 , output solenoid 6
7 = Q_5 , output solenoid 5
9 = Q_4 , output solenoid 4
11 = Q_3 , output solenoid 3
13 = Q_2 , output solenoid 2
15 = Q_1 , output solenoid 1
22 = V_{P3}, +24 V supply
23 = V_{P3}, +24 V supply
24 = 0 V , of V_{P3} supply
25 = 0 V , of V_{P3} supply
26 = 0 V , of V_{P1} supply
27 = V_{P1}, +5 V supply
29 = G_1 , control input
30 = G_2 , control input
31 = G_3 , control input
32 = G_4 , control input
33 = G_5 , control input
34 = G_6 , control input
35 = G_7 , control input

Pins on the printed-wiring board *)

36 = supply printer head
37 = Q_7 , output solenoid 7
38 = Q_6 , output solenoid 6
39 = Q_5 , output solenoid 5
40 = Q_4 , output solenoid 4
41 = Q_3 , output solenoid 3
42 = Q_2 , output solenoid 2
43 = Q_1 , output solenoid 1

*) These pins are provided for supply and control of the printer head MPH1 via its cable connector.

Requirements for electrical connection

Terminal 1 is only to be used for supply of the printer head of the mosaic printer.

Terminals 22 and 23 of the printed-wiring connector must be interconnected.

Terminals 24 and 25 of the printed-wiring connector must be interconnected.

7

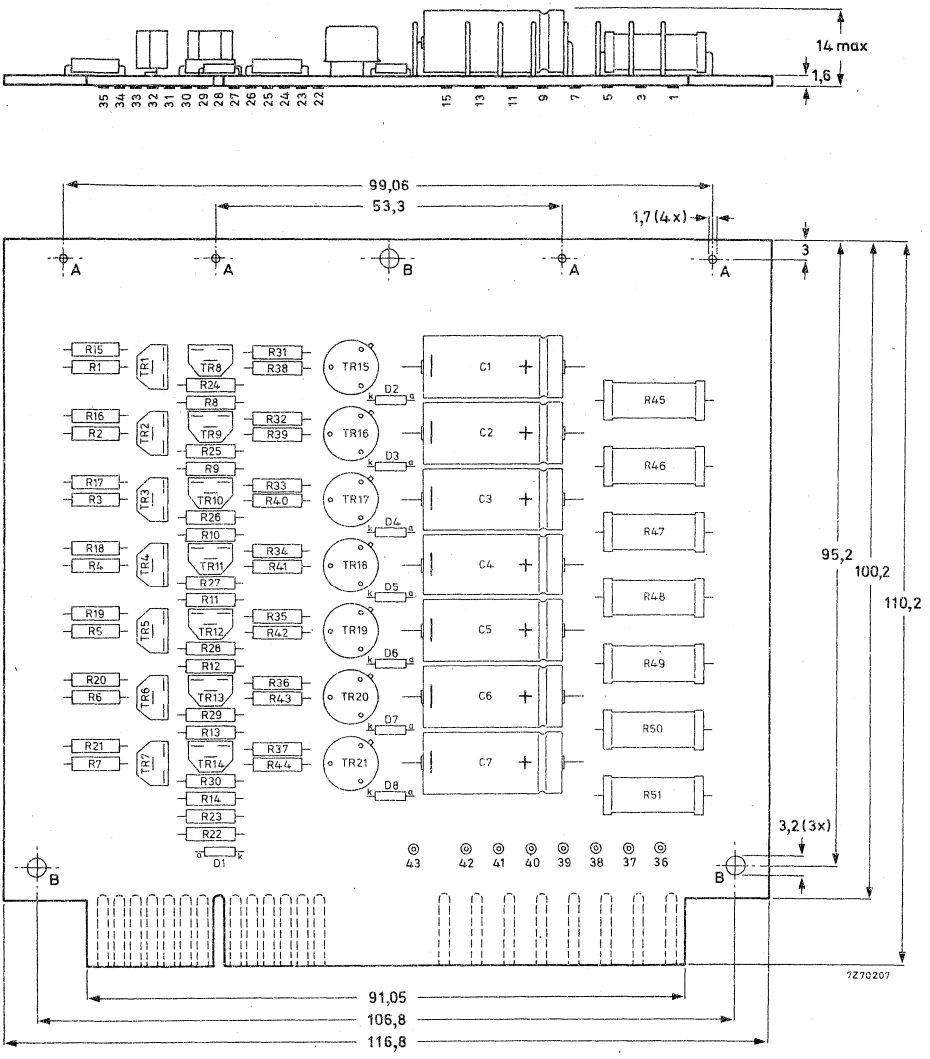


Fig. 2

Holes A are provided for mounting of an extractor.
Holes B are provided for screw-mounting the module.

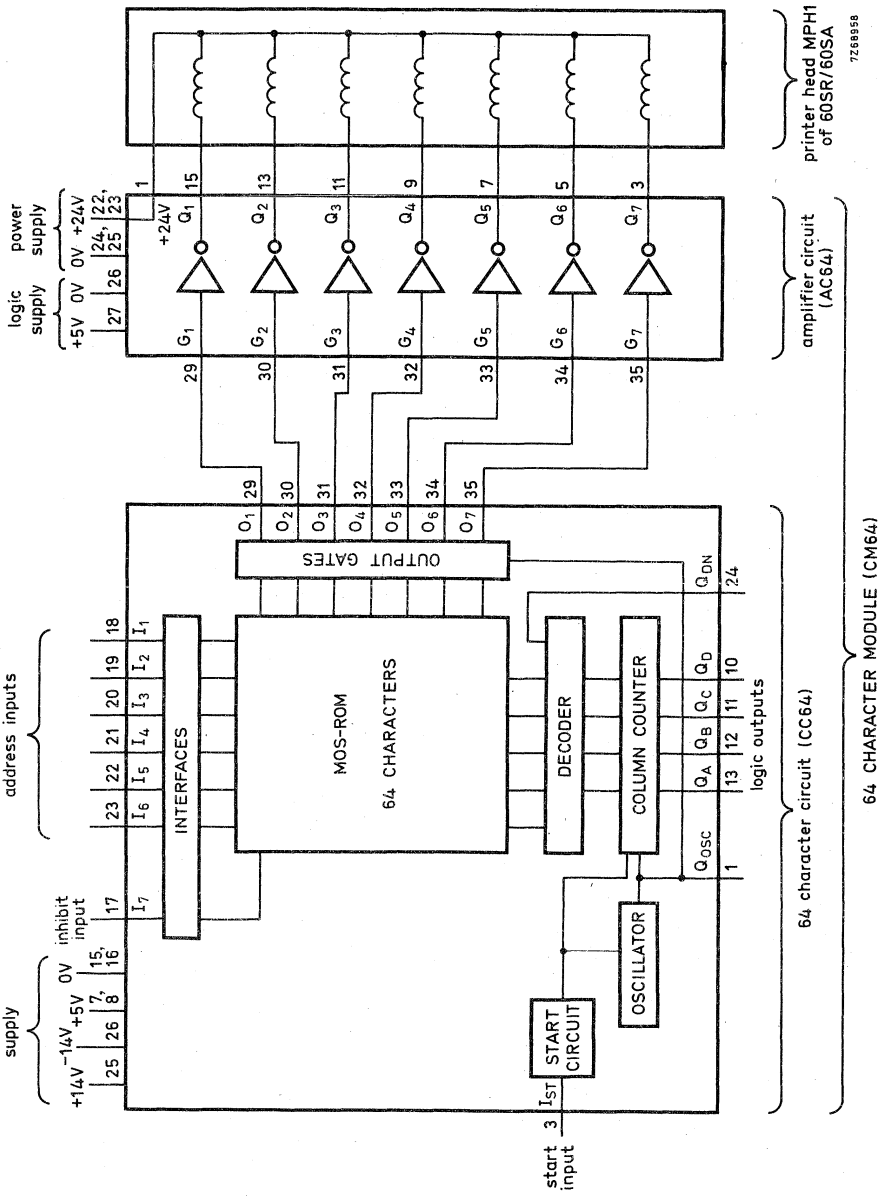


Fig. 3. Block diagram of the CM64

OPERATION

The heart of the system is a MOS-Read-Only-Memory with a total capacity of 2240 bits. For each character, 5 x 7 bits are reserved resulting in a content of maximum 64 characters. Statically operated the ROM has 6 address-inputs to select the required character. The address selecting codes for the various characters are in conformity with the USASCII code. Once a character is selected the column inputs of the ROM have to be scanned sequentially by the column counter.
By scanning the 5 column inputs, 5 groups of 7 bits each are obtained to form the character selected. The 7 output lines of the ROM control the 7 amplifier stages required for energizing the 7 solenoids of the printer head. (See Fig. 3).

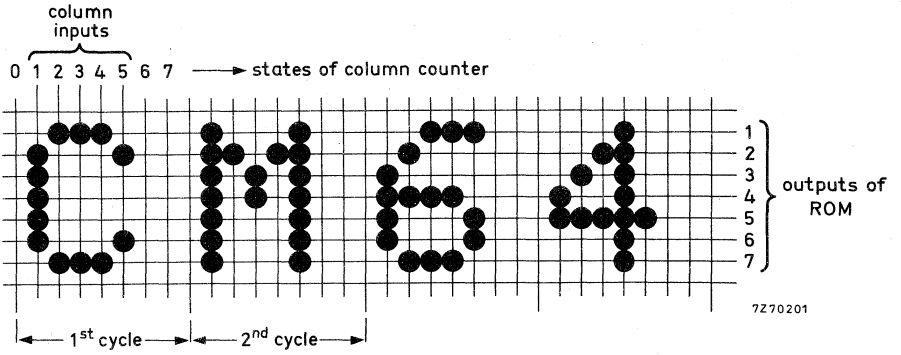


Fig. 4

The column counter is an 8-position counter. The 0-position is the start, or reset, position. The next 5 positions (1 to 5) are used to drive sequentially the 5 column inputs of the ROM. Positions 6 and 7, and the 0-position of the successive scanning cycle, define the spacing between two adjacent characters. In position 6 of the counter a "Demand New Character" signal is generated. This signal is an indication that the code on the address inputs may be changed.
The column scanning frequency is derived from an oscillator with a frequency of approximately 400 Hz. The frequency of the oscillator can be adjusted to match the CM64 to the printing speed of the mosaic printer, i.e. 20 characters on one line.
The oscillator is started and stopped by the start circuit.
After starting the oscillator first generates a HIGH-level signal at its output. When the output level of the oscillator becomes LOW, the column counter changes state (to position 1) and the first column input is scanned. At the following HIGH-level of the oscillator signal, the output gates are opened, allowing the first selected group of 7 bits to be printed. Similarly the remaining 4 columns are selected and printed, to complete the whole character. As soon as the column counter has left its start position, the signal to the start input is no longer required, because a feedback signal from the column counter maintains oscillation.
After completion of one cycle of 8 steps, the feedback signal stops the oscillator automatically. A new start signal is required to initiate a new cycle. When the start signal is applied continuously the feedback signal is overruled and the character printing is not stopped.

TECHNICAL DATA

Power supplies

Character circuit CC64:

V_{P1}		4,75 to 5,25	V
I_{P1} at V_{P1} = 5 V		100	mA
V_{P2}		12 to 15	V
I_{P2} at V_{P2} = 14 V		40	mA
V_N		−12 to −14	V
I_N at V_N = −14 V	max.	0,5	mA
Power consumption		1	W

Amplifier circuit AC64:

V_{P1}		4,75 to 5,25	V
I_{P1} at V_{P1} = 5 V		180	mA
V_{P3}		21,6 to 26,4	V
I_{P3}		see note	
Power consumption		20	W

Ambient temperature range

Character circuit CC64	operating	0 to +70	°C
	storage	−25 to +70	°C
Amplifier circuit AC64	operating	0 to +55	°C
	storage	−25 to +70	°C

Note

Supply V_{P3} is only to drive the 7 solenoids of the printer head MPH1.
Current I_{P3} is max. 6 A (0,85 A per solenoid) during approx. 1,25 ms, with a period time of 2,5 ms. In practice I_{P3} has an average peak value of 1,7 A.
As the connection wire from the power supply to the AC64 has some inductance, it is recommended that a capacitor be connected (approximately 30 µF per meter of wire) between the supply terminals 22 + 23 and 24 + 25 of the AC64 board.

Ratings Limiting values in accordance with Absolute Maximum System (IEC 134)

Supply voltage	V_{P1}	max.	5,5	V
	V_{P2}	max.	15	V
	V_N	max.	−15	V
	V_{P3}	max.	26,4	V
Input voltage (all inputs)				
CC64	V_i	max.	5,5	V
AC64	V_G	max.	5,5	V
Output peak current of				
AC64	I_{Qp}	max.	1	A

STATIC DATA

Character circuit CC64

Character address inputs I_1 to I_6 (TTL-compatible)

Input voltage HIGH	V_{IH}	min.	+2,0	V
Input current at V_{IH} = +2,4 V, V_{P1} = +5,25 V	I_{IH}	max.	40	μA
Input voltage LOW	V_{IL}	max.	+0,8	V
Input current at V_{IL} = +0,4 V, V_{P1} = +5,25 V	$-I_{IL}$	max.	1,6	mA

Inhibit input I_7 (TTL-compatible)

Input conditions	Character generation is enabled when I_7 signal is HIGH			
Input voltage HIGH	V_{IH}	min.	+2,0	V
Input current at V_{IH} = +2,4 V, V_{P1} = +5,25 V	I_{IH}	max.	40	μA
Input voltage LOW	V_{IL}	max.	+0,8	V
Input current at V_{IL} = +0,4 V, V_{P1} = +5,25 V	$-I_{IL}$	max.	1,6	mA

Start input I_{st}

Input conditions	Column counter is started when I_{st} signal is LOW			
Input voltage HIGH	V_{IH}	min.	+2,0	V
Input current at V_{IH} = +2,4 V, V_{P1} = +5,25 V	I_{IH}	max.	40	μA
Input voltage LOW	V_{IL}	max.	+0,6	V
Input current at V_{IL} = +0,2 V, V_{P1} = +5,25 V	$-I_{IL}$	max.	1,6	V

Character outputs O_1 to O_7

Output conditions			HIGH corresponds to a dot LOW corresponds to a blank	
Output voltage HIGH at $-I_{OH}$ = 0,5 mA	V_{OH}	min.	(V_{P2}-7)	V
Output voltage HIGH at $-I_{OH}$ = 1 mA	V_{OH}	min.	(V_{P2}-14,5)	V
Output current for a blank	$-I_{OL}$	max.	10	µA

The outputs are intended to drive the inputs G_1 to G_7 of the amplifier circuit AC64.

Oscillator output Q_{osc} (TTL-compatible), V_{P1} = +4,75 V

Output voltage HIGH at $-I_Q$ = max. 40 µA	V_{QH}	min.	+2,4	V
Output voltage LOW at I_Q = max. 1,6 mA	V_{QL}	max.	+0,4	V
Fan-out			1 TTL gate load	

'Demand new character' output Q_{DN} (TTL-compatible), V_{P1} = +4,75 V

Output voltage HIGH at $-I_Q$ = max. 320 µA	V_{QH}	min.	+2,4	V
Output voltage LOW at I_Q = max. 12,8 mA	V_{QL}	max.	+0,4	V
Fan-out			8 TTL gate loads	

Column counter outputs Q_A to Q_D (TTL-compatible), V_{P1} = +4,75 V

Output voltage HIGH at $-I_Q$ = max. 80 µA	V_{QH}	min.	+2,4	V
Output voltage LOW at I_Q = max. 3,2 mA	V_{QL}	max.	+0,4	V
Fan-out			2 TTL gate loads	

State table:

positions of column counter	Q_A	Q_B	Q_C	Q_D
0	0	0	0	0
1	1	0	0	0
2	1	1	0	0
3	1	1	1	0
4	1	1	1	1
5	0	1	1	1
6	0	0	1	1
7	0	0	0	1

logic "1" is the HIGH-state
logic "0" is the LOW-state

Amplifier circuit AC64

Control inputs G_1 to G_7

The correct input signals are supplied by the outputs O_1 to O_7 of the CC64.

If the AC64 is to be supplied with input signals from a source other than the CC64, then the following input levels must be used.

Input voltage HIGH	V_{GH}	min.	+2,4	V
Input current at V_{GH} = +2,4 V [1]	I_{GH}	max.	0,4	mA
Input current at V_{GH} = +4,75 V	I_{GH}	max.	1,0	mA
Input voltage LOW	V_{GL}	max.	1,0	V
Input current at V_{GL} = +1,0 V	I_{GL}	max.	20	µA
Input current at V_{GL} = 0 V	$-I_{GL}$	max.	1,0	mA

Outputs Q_1 to Q_7

These drive the seven solenoids in the printer head MPH1 of the Mosaic Printers 60SA and 60SR. The common return lead from the MPH1 must be connected to terminal 1 or tag 36.

Output peak current	I_{Qp}	max.	1	A

DYNAMIC DATA

Character circuit CC64

Scanning time for one column [2]	t_{sc}	min.	1,8	ms
		max.	3,3	ms
Cycle time for one character	t_{char}		$8 \times t_{sc}$	
Output activation time during one scan	t_{act}	typ.	1,2	ms
Hold time for address information [3]	t_a		$5 \times t_{sc}$	
Hold time for start signal	t_{st}	min.	1,5	ms
Duration of 'Demand new character' signal	t_{DN}		$1 \times t_{sc}$	

1) TTL compatible

2) t_{sc} may be adjusted by means of potentiometer R4 (see Fig. 1) to match the CM64 to the printer speed.

3) The address information must be present during positions 1 to 5 of the column counter.

Amplifier circuit AC64

Input pulse requirements for controlling the printer head MPH1 of the Mosaic Printers 60SA and 60SR.

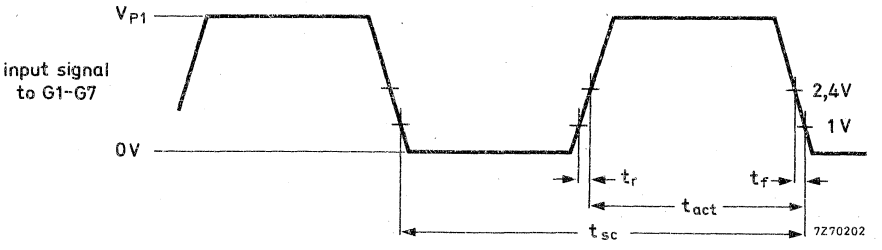


Fig. 5

Rise and fall time	t_r, t_f	max.	25	µs
Signal HIGH duration (solenoids energized)	t_{act}	typ.	1,2	ms
Signal repetition time	t_{sc}	min.	1,8	ms
		max.	3,3	ms

By varying the signal repetition time t_{sc} the maximum number of characters printed across the paper may be adjusted between 18 and 20.

Time diagram of one character cycle

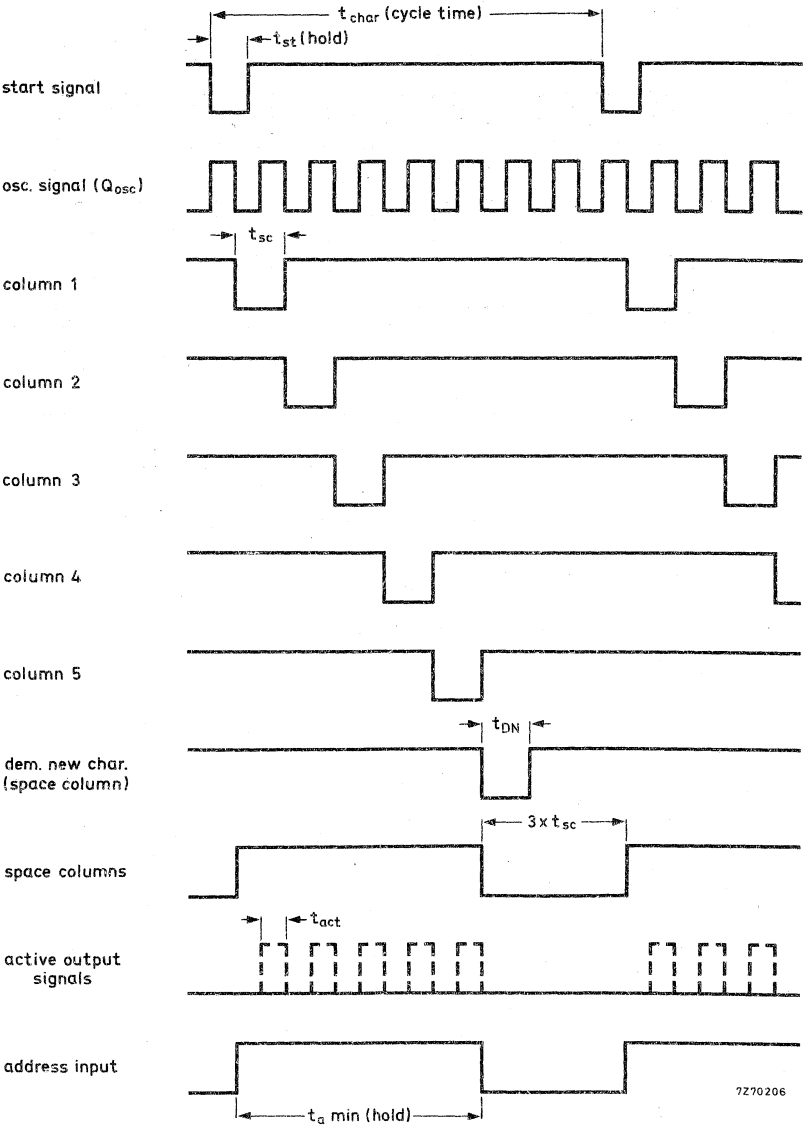
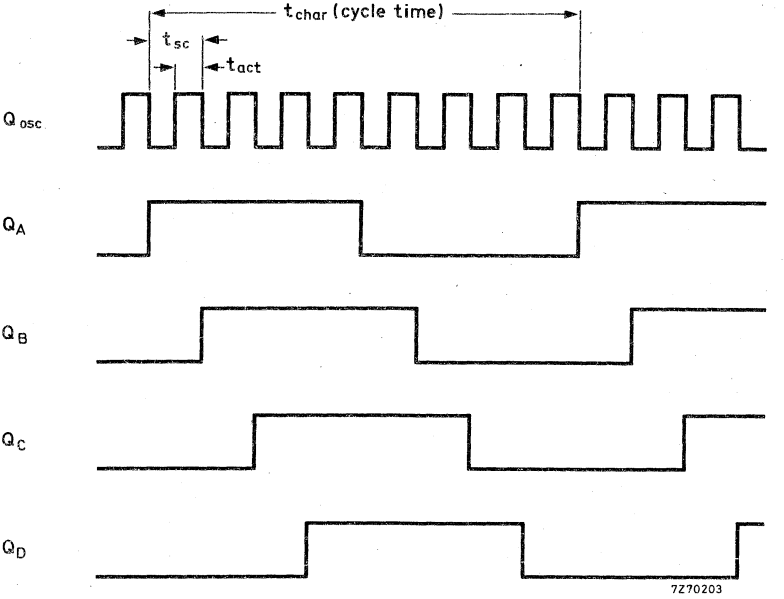


Fig. 6

Time diagram of the column counter outputs (CC64)



See also state table under Static data

Fig. 7

CHARACTER SELECTION GUIDE

The address inputs I_1 to I_6 of the Character Circuit CC64 conform to the USASCII code (except for the sign ≠, this is replaced by £) as given in the table below.

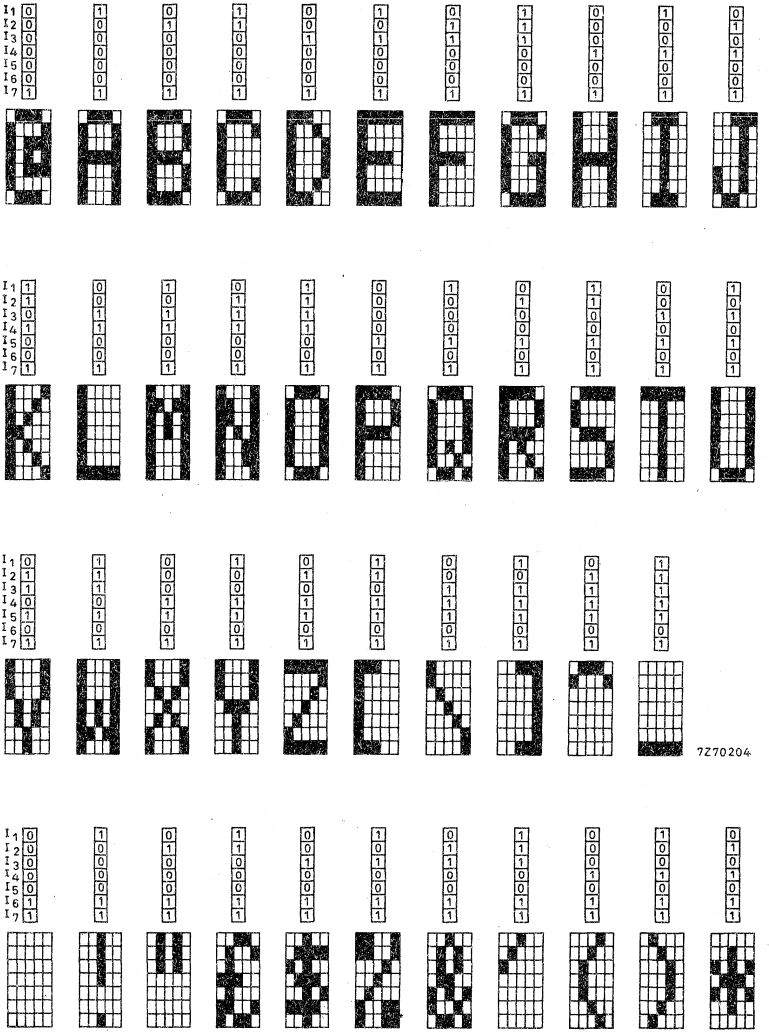
USASCII CODE

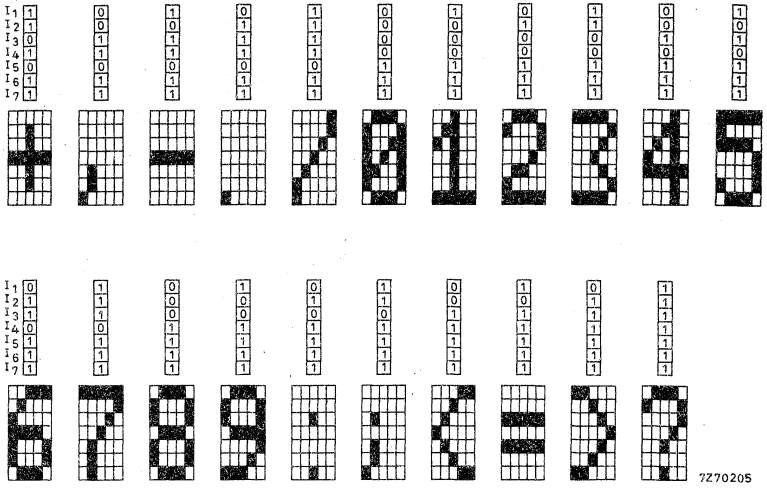
address inputs											
I_1	I_2	I_3	I_4	I_5	I_6	I_5	I_6	I_5	I_6	I_5	I_6
				0	0	1	0	0	1	1	1
0	0	0	0	@		P		space		ϕ	
1	0	0	0	A		Q		!		1	
0	1	0	0	B		R		"		2	
1	1	0	0	C		S		£		3	
0	0	1	0	D		T		$		4	
1	0	1	0	E		U		%		5	
0	1	1	0	F		V		&		6	
1	1	1	0	G		W		'		7	
0	0	0	1	H		X		(		8	
1	0	0	1	I		Y		)		9	
0	1	0	1	J		Z		*		:	
1	1	0	1	K		[		+		;	
0	0	1	1	L		\		,		<	
1	0	1	1	M		]		–		=	
0	1	1	1	N		^		.		>	
1	1	1	1	O		–		/		?	

Logic "1" is the more positive voltage : min. 2 V
Logic "0" is the less positive voltage : max. 0, 8 V

CHARACTER PRESENTATION

As already mentioned, each character is built-up within a 5 by 7 dot matrix. The character presentation is shown below. I_1 to I_6 are address inputs, I_7 is the inhibit input.





GENERAL RECOMMENDATIONS

To avoid the effects of any interference pulses on the system it is recommended that each supply terminal (+5 V, +14 V, −14 V, and +24 V) on each panel be connected directly to the relevant supply source. Each 0 V terminal of the CM64, and the 0 V terminals of each supply source, should be connected directly to a central earth point (C.E.P.).
As the connection wire from the power supply to the AC64 has some inductance, it is recommended that a capacitor be connected (approximately 30 μF per meter of wire) between the supply terminals 22 + 23 and 24 + 25 of the AC64 board.

ACCESSORIES

	catalogue number
Printed-wiring connector, type F061 single-sided, 35 contacts	
version for soldering	2422 048 13503
version for wire-wrapping	2422 048 13523
Set of 25 extractors, comprising 25 holders, 100 fixing bushes, 25 text strips, 1 extractor tool	4322 026 38462
Miniature mounting chassis	4322 026 38310

Ferrite core memory products

FERRITE CORE MEMORY PRODUCTS

Our magnetic core memories are complete memory systems consisting of digital circuits and a ferrite core matrix stack, all of own manufacture, assembled in units for standard mounting methods. Below a survey is given of our core memory systems and a table of our standard type of ferrite memory cores.

CORE MEMORY SYSTEMS

capacity	type number	cycle time	access time	dimensions in (mm)		
		μs	μs	width	height	depth
1k/8	FI-2	4	0,6	82	121,8	205
1k/8	FI-22	1,2	0,28	21	208	197
1k/13	FI-27	1	0,5	26,8	233,4	160
8k/8 16k/8	FI-138 FI-148	1,5	0,6	55	233,4	220
4k/18 (16, 12)	FI-75	0,75	0,3	34 17	208 208	310* 310**
16k/18	FI-69	0,7	0,3	42 14	233 233	160* 160**
16k/36	Q-14	1,4	0,6	51 20	292 292	366* 366**

* Dimensions of memory module.
** Dimensions of control module.

FERROXCUBE MEMORY CORES, standard range

core type	temperature range	C4*	nominal operating conditions T_{amb} = 25 °C, D.R. = 0,50			relevant typical output characteristics V_{ref} = 0,1 rV_1				
			I	t_r	t_d	uV_1	rV_1	wV_z	t_p	t_s
		mA/°C	mA	μs	μs	mV	mV	mV	μs	μs
18H51	medium	1,3	555	0,05	0,30	45,5	44	5	0,120	0,240
18H53	medium	1,3	560	0,05	0,30	45,5	44	4,5	0,135	0,250
18H61	medium	1,4	644	0,05	0,25	55	53	5	0,110	0,210
18H62	wide		656	0,05	0,30	55,5	54	5	0,115	0,190
18H81	medium	2,0	800	0,05	0,20	66	64	6	0,095	0,170
18H83	medium	2,0	833	0,05	0,30	55	54	4	0,105	0,190
20H83	standard	3,5	890	0,05	0,23	49	48	4	0,105	0,190
20H92	medium	1,4	973	0,05	0,26	52	51	4	0,110	0,210

- internal ref. no.
- first figure of nominal current at 25 °C
- basic Ferroxcube grade
- outer diameter in mil

* Rate of change of full drive current for constant uV_1.

CONTENTS

COUNTER MODULES 50-SERIES

Accessories for counter modules 50-Series

NORBITS 60-SERIES AND 61-SERIES

60-Series NORbits

PLC MODULES

INPUT/OUTPUT DEVICES

HYBRID CIRCUITS

Electronic components and materials for professional, industrial and consumer uses from the world-wide Philips Group of Companies

Argentina: FAPESA I.y.C., Av. Crovara 2550, Tablada, Prov. de BUENOS AIRES, Tel. 652-7438/7478.
Australia: PHILIPS INDUSTRIES HOLDINGS LTD., Elcoma Division, 67 Mars Road, LANE COVE, 2066, N.S.W., Tel. 42 1261.
Austria: ÖSTERREICHISCHE PHILIPS BAUELEMENTE Industrie G.m.b.H., Triester Str. 64, A-1101 WIEN, Tel. 62 91 11.
Belgium: M.B.L.E., 80, rue des Deux Gares, B-1070 BRUXELLES, Tel 523 00 00.
Brazil: IBRAPE, Caixa Postal 7383, Av. Paulista 2073-S/Loja, SAO PAULO, SP, Tel. 287-7144.
Canada: PHILIPS ELECTRONICS LTD., Electron Devices Div., 601 Milner Ave., SCARBOROUGH, Ontario, M1B 1M8, Tel. 292-5161.
Chile: PHILIPS CHILENA S.A., Av. Santa Maria 0760, SANTIAGO, Tel. 39-40 01.
Colombia: SADAPE S.A., P.O. Box 9805, Calle 13, No. 51 + 39, BOGOTA D.E. 1., Tel. 600 600.
Denmark: MINIWATT A/S, Emdrupvej 115A, DK-2400 KØBENHAVN NV., Tel. (01) 69 16 22.
Finland: OY PHILIPS AB, Elcoma Division, Kaivokatu 8, SF-00100 HELSINKI 10, Tel. 1 72 71.
France: R.T.C. LA RADIOTECHNIQUE-COMPELEC, 130 Avenue Ledru Rollin, F-75540 PARIS 11, Tel. 355-44-99.
Germany: VALVO, UB Bauelemente der Philips G.m.b.H., Valvo Haus, Burchardstrasse 19, D-2 HAMBURG 1, Tel. (040) 3296-1.
Greece: PHILIPS S.A. HELLENIQUE, Elcoma Division, 52, Av. Syngrou, ATHENS, Tel. 915 311.
Hong Kong: PHILIPS HONG KONG LTD., Comp. Dept., Philips Ind. Bldg., Kung Yip St., K.C.T.L. 289, KWAI CHUNG, N.T. Tel. 12-24 51 21.
India: PHILIPS INDIA LTD., Elcoma Div., Band Box House, 254-D, Dr. Annie Besant Rd., Prabhadevi, BOMBAY-25-DD, Tel. 457 311-5.
Indonesia: P.T. PHILIPS-RALIN ELECTRONICS, Elcoma Division, 'Timah' Building, Jl. Jen. Gatot Subroto, JAKARTA, Tel. 44 163.
Ireland: PHILIPS ELECTRICAL (IRELAND) LTD., Newstead, Clonskeagh, DUBLIN 14, Tel. 69 33 55.
Italy: PHILIPS S.P.A., Sezione Elcoma, Piazza IV Novembre 3, I-20124 MILANO, Tel. 2-6994.
Japan: NIHON PHILIPS CORP., Shuwa Shinagawa Bldg., 26-33 Takanawa 3-chome, Minato-ku, TOKYO (108), Tel. 448-5611.
(IC Products) SIGNETICS JAPAN, LTD., TOKYO, Tel. (03) 230-1521.
Korea: PHILIPS ELECTRONICS (KOREA) LTD., Philips House, 260-199 Itaewon-dong, Yongsan-ku, C.P.O. Box 3680, SEOUL, Tel. 44-4202.
Mexico: ELECTRONICA S.A. de C.V., Varsovia No. 36, MEXICO 6, D.F., Tel. 5-33-11-80.
Netherlands: PHILIPS NEDERLAND B.V., Afd. Elonco, Boschdijk 525, NL-4510 EINDHOVEN, Tel. (040) 79 33 33.
New Zealand: Philips Electrical Ind. Ltd., Elcoma Division, 2 Wagener Place, St. Lukes, AUCKLAND, Tel. 867 119.
Norway: ELECTRONICA A/S., Vitaminveien 11, P.O. Box 29, Grefsen, OSLO 4, Tel. (02) 15 05 90.
Peru: CADESA, Jr. Ilo, No. 216, Apartado 10132, LIMA, Tel. 27 73 17.
Philippines: ELDAC, Philips Industrial Dev. Inc., 2246 Pasong Tamo, MAKATI-RIZAL, Tel. 86-89-51 to 59.
Portugal PHILIPS PORTUGESA S.A.R.L., Av. Eng. Duharte Pacheco 6, LISBOA 1, Tel. 68 31 21.
Singapore: PHILIPS SINGAPORE PTE LTD., Elcoma Div., POB 340, Toa Payoh CPO, Lorong 1, Toa Payoh, SINGAPORE 12, Tel. 53 88 11.
South Africa: EDAC (Pty.) Ltd., South Park Lane, New Doornfontein, JOHANNESBURG 2001, Tel. 24/6701.
Spain: COPRESA S.A., Balmes 22, BARCELONA 7, Tel. 301 63 12.
Sweden: A.B. ELCOMA, Lidingövägen 50, S-10 250 STOCKHOLM 27, Tel. 08/67 97 80.
Switzerland: PHILIPS A.G., Elcoma Dept., Edenstrasse 20, CH-8027 ZÜRICH, Tel. 01/44 22 11.
Taiwan: PHILIPS TAIWAN LTD., 3rd Fl., San Min Building, 57-1, Chung Shan N. Rd, Section 2, P.O. Box 22978, TAIPEI, Tel. 5513101-5.
Turkey: TÜRK PHILIPS TICARET A.S., EMET Department, Inonu Cad. No. 78-80, ISTANBUL, Tel. 43 59 10.
United Kingdom: MULLARD LTD., Mullard House, Torrington Place, LONDON WC1E 7HD, Tel. 01-580 6633.
United States: (Active devices & Materials) AMPEREX SALES CORP., 230, Duffy Avenue, HICKSVILLE, N.Y. 11802, Tel. (516) 931-6200.
(Passive devices) MEPCO/ELECTRA INC., Columbia Rd., MORRISTOWN, N.J. 07960, Tel. (201) 539-2000.
(IC Products) SIGNETICS CORPORATION, 811 East Arques Avenue, SUNNYVALE, California 94086, Tel. (408) 739-7700.
Uruguay: LUZILECTRON S.A., Rondeau 1567, piso 5, MONTEVIDEO, Tel. 9 43 21.
Venezuela: IND. VENEZOLANAS PHILIPS S.A., Elcoma Dept., A. Ppal de los Ruices, Edif. Centro Colgate, Apdo 1167, CARACAS, Tel. 36 05 11.

A3

Printed in The Netherlands

9399 261 30301